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# 78K0/Dx2

# User's Manual: Hardware

# RENESAS MCU 78K0 Microcontrollers

78K0/DE2:	μPD78F0836(A)	μPD78F0844(A)	
	μPD78F0836(A2)	μPD78F0844(A2)	
	µPD78F0837(A)	µPD78F0845(A)	
	μPD78F0837(A2)	μPD78F0845(A2)	
78K0/DF2:	μPD78F0838(A)	µPD78F0842(A)	μPD78F0848(A)
	μPD78F0838(A2)	μPD78F0842(A2)	μPD78F0848(A2)
	μPD78F0839(A)	µPD78F0843(A)	µPD78F0849(A)
	μPD78F0839(A2)	μPD78F0843(A2)	μPD78F0849(A2)
	μPD78F0840(A)	μPD78F0846(A)	
	μPD78F0840(A2)	μPD78F0846(A2)	
	μPD78F0841(A)	μPD78F0847(A)	
	μPD78F0841(A2)	μPD78F0847(A2)	

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#### NOTES FOR CMOS DEVICES

- (1) VOLTAGE APPLICATION WAVEFORM AT INPUT PIN: Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between VIL (MAX) and VIH (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between VIL (MAX) and VIH (MIN).
- (2) HANDLING OF UNUSED INPUT PINS: Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.
- (3) PRECAUTION AGAINST ESD: A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.
- (4) STATUS BEFORE INITIALIZATION: Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.
- (5) POWER ON/OFF SEQUENCE: In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current. The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.
- (6) INPUT OF SIGNAL DURING POWER OFF STATE : Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.

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# INTRODUCTION

Readers	This manual is intended for user engineers who wish to understand the functions of the conventional-specification products of the 78K0/Dx2 and design and develop application systems and programs for these devices. The target products are as follows.	
	<ul> <li>78K0/DE2: μPD78F0836(A), 78F0837(A), 78F0844(A), 78F0845(A), 78F0836(A2), 78F0837(A2), 78F0844(A2), 78F0845(A2)</li> <li>78K0/DF2: μPD78F0838(A), 78F0839(A), 78F0840(A), 78F0841(A), 78F0842(A), 78F0843(A), 78F0846(A), 78F0847(A), 78F0848(A), 78F0849(A), 78F0838(A2), 78F0839(A2), 78F0840(A2), 78F0841(A2), 78F0842(A2), 78F0843(A2), 78F0846(A2), 78F0847(A2), 78F0848(A2), 78F0849(A2)</li> </ul>	
Purpose	This manual is intended to give users an understanding of the functions described in the <b>Organization</b> below.	
Organization	The 78K0/Dx2 manual is separated into two parts: this manual and the instructions edition (common to the 78K0 Series).	
	78K0/Dx278K/0 SeriesUser's ManualUser's Manual(This Manual)Instructions	
	<ul> <li>Pin functions</li> <li>Internal block functions</li> <li>Interrupts</li> <li>Other on-chip peripheral functions</li> <li>Electrical specifications</li> <li>CPU functions</li> <li>Instruction set</li> <li>Explanation of each instruction</li> </ul>	
How to Read This Manual	It is assumed that the readers of this manual have general knowledge of electrical engineering, logic circuits, and microcontrollers.	
	<ul> <li>When using this manual as the manual for (A) and (A2) grade products:</li> <li>→ Only the quality grade differs between (A) grade products and (A2) grade products. Read the part number as follows.</li> <li>µPD78F0836 → µPD78F0836(A), 78F0836(A2)</li> <li>µPD78F0837 → µPD78F0837(A), 78F0837(A2)</li> <li>µPD78F0838 → µPD78F0838(A), 78F0838(A2)</li> <li>µPD78F0839 → µPD78F0839(A), 78F0839(A2)</li> <li>µPD78F0840 → µPD78F0840(A), 78F0840(A2)</li> <li>µPD78F0841 → µPD78F0841(A), 78F0840(A2)</li> <li>µPD78F0842 → µPD78F0842(A), 78F0842(A2)</li> <li>µPD78F0843 → µPD78F0842(A), 78F0842(A2)</li> <li>µPD78F0843 → µPD78F0843(A), 78F0843(A2)</li> <li>µPD78F0844 → µPD78F0844(A), 78F0844(A2)</li> <li>µPD78F0845 → µPD78F0845(A), 78F0845(A2)</li> <li>µPD78F0846 → µPD78F0845(A), 78F0846(A2)</li> <li>µPD78F0847 → µPD78F0847(A), 78F0847(A2)</li> <li>µPD78F0848 → µPD78F0848(A), 78F0848(A2)</li> <li>µPD78F0848 → µPD78F0849(A), 78F0849(A2)</li> </ul>	

	<ul> <li>To gain a general unders         <ul> <li>→ Read this manual in revised points. The revised points. The revised points. The revised points and spece</li> <li>How to interpret the regise</li> <li>→ For a bit number encl in the assembler, and compiler.</li> </ul> </li> <li>To check the details of a point of the assembler of the specement.</li> </ul>	standing of functions: the order of the <b>CONTENTS</b> . The mark <r> shows major evised points can be easily searched by copying an "<r>" in ifying it in the "Find what:" field. ster format: osed in brackets, the bit name is defined as a reserved word d is already defined in the header file named sfrbit.h in the C</r></r>
	<ul> <li>→ Refer to APPENDIX</li> <li>To know details of the 78</li> <li>→ Refer to the separa (U12326E).</li> </ul>	BKO microcontroller instructions: te document <b>78K/0 Series Instructions User's Manual</b>
Conventions	Data significance: Active low representations: Note: Caution: Remark: Numerical representations:	Higher digits on the left and lower digits on the right $\overline{\times \times \times}$ (overscore over pin and signal name) Footnote for item marked with <b>Note</b> in the text. Information requiring particular attention Supplementary information Binary $\cdots \times \times \times \times$ or $\times \times \times \times B$ Decimal $\cdots \times \times \times \times$ Hexadecimal $\cdots \times \times \times H$
Related Documents	The related documents ind	licated in this publication may include preliminary versions.

However, preliminary versions are not marked as such.

#### **Documents Related to Devices**

Document Name	Document No.
78K0/Dx2 User's Manual	This manual
78K/0 Series Instructions User's Manual	U12326E

# Documents Related to Development Tools (Hardware) (User's Manuals)

Document Name	Document No.
QB-78K0DX2 In-Circuit Emulator	U19952E
QB-MINI2 On-Chip Debug Emulator with Programming Function	U18371E

#### **Documents Related to Flash Memory Programming**

Document Name		Document No.
PG-FP5 Flash Memory Programmer User's Manual		U18865E
QB-Programmer Programming GUI Operation User's Manual	Operation	U18527E

# Caution The related documents listed above are subject to change without notice. Be sure to use the latest version of each document when designing.

#### Documents Related to Development Tools (Software)

Document Name		Document No.
RA78K0 Ver.3.80 Assembler Package	Operation	U17199E
User's Manual <sup>Note 1</sup>	Language	U17198E
	Structured Assembly Language	U17197E
78K0 Assembler Package RA78K0 Ver.4.01 Operating Precautions (Notification Document) Note 1		ZUD-CD-07-0181-E
CC78K0 Ver.3.70 C Compiler	Operation	U17201E
User's Manual <sup>Note 2</sup>	Language	U17200E
78K0 C Compiler CC78K0 Ver. 4.00 Operating Precautions (Notification Document) <sup>Note 2</sup>		ZUD-CD-07-0103-E
SM+ System Simulator	Operation	U18601E
User's Manual	User Open Interface	U18212E
ID78K0-QB Ver.2.94 Integrated Debugger User's Manual	Operation	U18330E
ID78K0-QB Ver.3.00 Integrated Debugger User's Manual	Operation	U18492E
PM plus Ver.5.20 <sup>Note 3</sup> User's Manual		U16934E
PM+ Ver.6.30 <sup>Note 4</sup> User's Manual		U18416E

**Notes 1.** This document is installed into the PC together with the tool when installing RA78K0 Ver. 4.01. For descriptions not included in "78K0 Assembler Package RA78K0 Ver. 4.01 Operating Precautions", refer to the user's manual of RA78K0 Ver. 3.80.

- This document is installed into the PC together with the tool when installing CC78K0 Ver. 4.00. For descriptions not included in "78K0 C Compiler CC78K0 Ver. 4.00 Operating Precautions", refer to the user's manual of CC78K0 Ver. 3.70.
- 3. PM plus Ver. 5.20 is the integrated development environment included with RA78K0 Ver. 3.80.
- **4.** PM+ Ver. 6.30 is the integrated development environment included with RA78K0 Ver. 4.01. Software tool (assembler, C compiler, debugger, and simulator) products of different versions can be managed.

#### Other Documents

Document Name	Document No.
SEMICONDUCTOR SELECTION GUIDE – Products and Packages –	X13769X
Semiconductor Device Mount Manual	Note
Quality Grades on NEC Semiconductor Devices	C11531E
NEC Semiconductor Device Reliability/Quality Control System	C10983E
Guide to Prevent Damage for Semiconductor Devices by Electrostatic Discharge (ESD)	C11892E

Note See the "Semiconductor Device Mount Manual" website (http://www.necel.com/pkg/en/mount/index.html).

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# 78K0/Dx2 RENESAS MCU

# CHAPTER 1 OUTLINE

### 1.1 Features

- O Minimum instruction execution time can be changed from high speed (0.1  $\mu$ s: @ 20 MHz operation with highspeed system clock) to ultra low-speed (114  $\mu$ s: @ 32.768 kHz operation with subsystem clock)
- O General-purpose register: 8 bits  $\times$  32 registers (8 bits  $\times$  8 registers  $\times$  4 banks)
- Ο Internal CAN controller (for μPD78F0844, 78F0845, 78F0846, 78F0847, 78F0848, and 78F0849 only)
- Stepper motor controller/driver with zero point detection (ZPD):
   2 channels (for 78K0/DE2) / 0 / 2 / 4 channels (for 78K0/DF2)
- O LCD controller/driver (seg  $\times$  com): 24  $\times$  4 (for 78K0/DE2) / 28  $\times$  4 / 32  $\times$  4 / 40  $\times$  4 (for 78K0/DF2)
- O ROM, RAM capacities

Part Number	Item	CAN [channel]	Stepper Motor Controller	LC controlle (seg ×	CD er/driver com)	Program Memor (ROM	m y )	Data M [by	lemory tes]
78K0/DE2 (64 pins)	78K0/DF2 (80 pins)		/driver [channels]	78K0/DE2	78K0/DF2	[KB]		Internal High- speed RAM <sup>Note</sup>	Internal Expansion RAM <sup>Note</sup>
_	μPD78F0838	-	0	-	40  imes 4	Flash	24	1024	1024
_	μPD78F0839					memory <sub>Note</sub>	48		2048
μPD78F0836	μPD78F0840		2	24  imes 4	$32 \times 4$		24		1024
μPD78F0837	μPD78F0841						48		2048
_	μPD78F0842		4	-	<b>28</b> imes <b>4</b>		24		1024
_	μPD78F0843						48		2048
μPD78F0844	μPD78F0846	1	2	24  imes 4	32 × 4		32		1024
μPD78F0845	μPD78F0847						60		2048
_	μPD78F0848		4	_	28 × 4		32		1024
_	μPD78F0849						60		2048

- **Note** The internal flash memory, internal high-speed RAM capacities, and internal expansion RAM capacities can be changed using the internal memory size switching register (IMS) and the internal expansion RAM size switching register (IXS).
- O On-chip single-power-supply flash memory
- O Self-programming (with boot swap function)
- O On-chip debug function
- O On-chip power-on-clear (POC) circuit and low-voltage detector (LVI)
- O Short startup is possible via the CPU default start using the on-chip internal high-speed oscillator
- O On-chip watchdog timer (operable with on-chip internal low-speed oscillator clock)
- O On-chip sound generator
- O On-chip multiplier/divider
- O On-chip clock output/buzzer output controller

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- O I/O ports: 47 (for 78K0/DE2) / 63 (for 78K0/DF2) (N-ch open drain: 2)
- O Timer: 9 channels
- Serial interface: 3 (for 78K0/DE2) / 5 (for 78K0/DF2) channels
   (CAN: 1 channel, UART (LIN (Local Interconnect Network)-bus supported): 1 channel (78K0/DF2 only),
   CSI/UART<sup>Note</sup>: 1 channel, CSI: 1 channel (78K0/DF2 only), I<sup>2</sup>C: 1 channel)

Note Select either of the functions of these alternate-function pins.

- O 10-bit resolution A/D converter: 4 (for 78K0/DE2) / 8 (for 78K0/DF2) channels
- O Supply voltage:  $V_{DD} = 4.0$  to 5.5 V when 20 MHz,  $V_{DD} = 2.7$  to 5.5 V when 10 MHz
  - (with internal high-speed oscillator clock or subsystem clock:  $V_{DD} = 2.7$  to 5.5 V)
- O Operating ambient temperature: T<sub>A</sub> = -40 to +85°C ((A) grade products), -40 to +105°C ((A2) grade products)
- Caution The 78K0/Dx2 has an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.

## **1.2 Applications**

O Automotive dashboard control



# 1.3 Ordering Information

# • Flash memory version

Part Number	Package	Quality Grade
μPD78F0836GBA-GAH-G	64-pin plastic LQFP (fine pitch) (10 $\times$ 10)	Special
μPD78F0836GBA2-GAH-G	64-pin plastic LQFP (fine pitch) (10 $\times$ 10)	Special
μPD78F0837GBA-GAH-G	64-pin plastic LQFP (fine pitch) (10 $\times$ 10)	Special
μPD78F0837GBA2-GAH-G	64-pin plastic LQFP (fine pitch) (10 $\times$ 10)	Special
μPD78F0838GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0838GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0839GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0839GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0840GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0840GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0841GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0841GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0842GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0842GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0843GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0843GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0844GBA-GAH-G	64-pin plastic LQFP (fine pitch) (10 $\times$ 10)	Special
μPD78F0844GBA2-GAH-G	64-pin plastic LQFP (fine pitch) (10 $\times$ 10)	Special
μPD78F0845GBA-GAH-G	64-pin plastic LQFP (fine pitch) (10 $\times$ 10)	Special
μPD78F0845GBA2-GAH-G	64-pin plastic LQFP (fine pitch) (10 $\times$ 10)	Special
μPD78F0846GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0846GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0847GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0847GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0848GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0848GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0849GKA-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special
μPD78F0849GKA2-GAK-G	80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	Special

**Remark** All these products are lead free products.



# 78K0/Dx2

# 1.4 Pin Configuration (Top View)

78K0/DE2 (μPD78F0836, 78F0837, 78F0844, 78F0845)
 64-pin plastic LQFP (fine pitch) (10 × 10)



Note The alternate functions CTxD and CRxD are for the  $\mu$ PD78F0844, 78F0845 only.

## Cautions 1. Make AVss the same potential as Vss.

- 2. Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu$ F: recommended).
- 3. ANI0/P20 to ANI3/P23 are set in the analog input mode after release of reset.

**Remark** The functions within arrowheads (< >) can be assigned by setting the input switch control register (ISC).

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Cautions 1. Make AVss the same potential as Vss.

- 2. Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu$ F: recommended).
- 3. ANI0/P20 to ANI7/P27 are set in the analog input mode after release of reset.

**Remark** The functions within arrowheads (< >) can be assigned by setting the input switch control register (ISC).



78K0/DF2 (μPD78F0840, 78F0841, 78F0846, 78F0847)
 80-pin plastic LQFP (fine pitch) (12 × 12)



**Note** The alternate functions CTxD and CRxD are for the  $\mu$ PD78F0846, 78F0847 only.

Cautions 1. Make AVss the same potential as Vss.

- 2. Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu$ F: recommended).
- 3. ANI0/P20 to ANI7/P27 are set in the analog input mode after release of reset.

**Remark** The functions within arrowheads (< >) can be assigned by setting the input switch control register (ISC).





**Note** The alternate functions CTxD and CRxD are for the  $\mu$ PD78F0848, 78F0849 only.

Cautions 1. Make AVss the same potential as Vss.

- 2. Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu$ F: recommended).
- 3. ANI0/P20 to ANI7/P27 are set in the analog input mode after release of reset.

**Remark** The functions within arrowheads (< >) can be assigned by setting the input switch control register (ISC).



# Pin Identification

ANI0 to ANI7:	Analog input	REGC:	Regulator capacitance
AVREF:	Analog reference voltage	RESET:	Reset
AVss:	Analog ground	RxD60, RxD61:	Receive data
BUZ:	Buzzer output	SCK10, SCK11:	Serial clock input/output
COM0 to COM3:	Common output	SCL0:	Serial clock input/output
CRxD:	Receive data for CAN	SDA0:	Serial data input/output
CTxD:	Transmit data for CAN	SEG0 to SEG39:	Segment output
EVDD:	Power supply for port	SGO:	Sound generator output
EVss:	Ground for port	SGOA:	Sound generator amplitude PWM output
EXCLK:	External clock input	SGOF:	Sound generator frequency output
	(Main system clock)	SI10, SI11:	Serial data input
EXCLKS:	External clock input	SM11 to SM14,	
	(Subsystem clock)	SM21 to SM24,	
EXLVI:	External potential input	SM31 to SM34,	
	for low-voltage detector	SM41 to SM44:	Stepper motor outputs
FLMD0:	Flash programming mode	SMVDD:	Stepper motor controller/driver supply
INTP0 to INTP4,			voltage
INTPR60, INTPR	61:	SMVss:	Stepper motor controller/driver ground
	External interrupt input	SO10, SO11:	Serial data output
OCD0A, OCD0B,		SSI11:	Serial interface chip select input
OCD1A OCD1B:	On-chip debug input/output	TIO50, TIO51,	
P00 to P07:	Port 0	TIOP00, TIOP01,	
P10 to P17:	Port 1	TIOP10, TIOP11,	
P20 to P27:	Port 2	TIOP20, TIOP21,	
P30 to P37:	Port 3	TIOP30, TIOP31,	
P60, P61:	Port 6	TIOP40, TIOP41:	Timer input and timer output
P70 to P77:	Port 7	TxD60, TxD61:	Transmit data
P80 to P87:	Port 8	VDD:	Power supply
P90 to P97:	Port 9	Vss:	Ground
P120 to P124	Port 12	X1, X2:	Crystal oscillator (High-speed system clock)
PCL:	Programmable clock output	XT1, XT2:	Crystal oscillator (Subsystem clock)
		ZPD14, ZPD24,	
		ZPD34, ZPD44:	Zero point detection input



### 1.5 Block Diagram

• 78K0/DE2 (μPD78F0836, 78F0837, 78F0844, 78F0845)



**Note** μPD78F0844, 78F0845 only.









• 78K0/DF2 (μPD78F0840, 78F0841, 78F0846, 78F0847)



**Note** *μ*PD78F0846, 78F0847 only.



• 78K0/DF2 (μPD78F0842, 78F0843, 78F0848, 78F0849)



**Note** *μ*PD78F0848, 78F0849 only.



# 1.6 Outline of Functions

• 78K0/DE2 without CAN (µPD78F0836, 78F0837)

			(1/2)		
	Item	μPD78F0836	μPD78F0837		
Internal Flash memory memory (self-programming (bytes) supported) <sup>Note</sup>		24 K	48 K		
	High-speed RAM <sup>Note</sup>	1	к		
	Expansion RAM <sup>Note</sup>	1 K	2К		
CAN buffer	RAM		-		
High-speed (oscillation f	system clock requency)	Crystal/ceramic oscillation (X1), external main s 4 to 20 MHz: $V_{DD} = 4.0$ to 5.5 V, 4 to 10 MHz: V	ystem clock input (EXCLK) / <sub>DD</sub> = 2.7 to 5.5 V		
Internal high clock (oscill	n-speed oscillation ation frequency)	On-chip internal oscillation (8 MHz (TYP.): $V_{DD} = 2.7$ to 5.5 V)			
Internal low- clock (oscilla	-speed oscillation ation frequency)	On-chip internal oscillation (240 kHz (TYP.))			
Subsystem (oscillation f	clock requency)	Crystal oscillation (XT1), external subsystem clock input (EXCLKS) (32.768 kHz: $V_{DD}$ = 2.7 to 5.5 V)			
General-pur	pose registers	8 bits $\times$ 32 registers (8 bits $\times$ 8 registers $\times$ 4 banks)			
Minimum in	struction execution	0.1 $\mu$ s/0.2 $\mu$ s/0.4 $\mu$ s/0.8 $\mu$ s/1.6 $\mu$ s (high-speed system clock: @ f <sub>MAIN</sub> = 20 MHz operation)			
time		0.25 $\mu$ s/0.5 $\mu$ s/1.0 $\mu$ s/2.0 $\mu$ s/4.0 $\mu$ s (TYP.) (internal oscillator clock: @ foscs = 8 MHz (TYP.) operation)			
		122 $\mu$ s (subsystem clock: when operating at fxT	= 32.768 kHz)		
Instruction set		<ul> <li>16-bit operation</li> <li>Multiply/divide (16 bits × 16 bits, 32 bits ÷ 16 bits)</li> <li>Bit manipulate (set, reset, test, and Boolean operation)</li> <li>BCD adjust, etc.</li> </ul>			
I/O ports		Total :     47       CMOS I/O     45       N-ch open-drain I/O     2 (5 V tolerant / N-ch open-drain output selectable)			
Timers		<ul> <li>16-bit timer/event counter: 5 channels</li> <li>8-bit timer/event counter: 2 channels</li> <li>Watch timer: 1 channel</li> <li>Watchdog timer: 1 channel</li> </ul>			
	Timer outputs	12 (PWM output: Maximum 11)			
Clock output		<ul> <li>78.125 kHz, 156.25 kHz, 312.5 kHz, 625 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (high-speed system clock: 10 MHz)</li> <li>32.768 kHz (subsystem clock: 32.768 kHz)</li> </ul>			
Buzzer outp	ut	1.22 kHz, 2.44 kHz, 4.88 kHz, 9.77 kHz (high-sp	beed system clock: 10 MHz)		
A/D converter		10-bit resolution × 4 channels			

**Note** The internal flash memory capacity, internal high-speed RAM capacity, and internal expansion RAM capacity can be changed using the internal memory size switching register (IMS) and the internal expansion RAM size switching register (IXS).

			(2/2)		
	Item	μPD78F0836	μPD78F0837		
Serial	CAN	_			
interface	LIN-UART/CSINote 1	1 ch			
	I <sup>2</sup> C bus	1 ch			
LCD controller (seg × com)	r/driver	24 × 4			
Sound genera	tor	1 ch			
Stepper motor (with ZPD)	controller/driver	2 ch			
Multiplier/divid	ler	• 16 bit × 16 bit = 32 bit (Multiplication)			
		32 bit ÷ 16 bit = 32 bit remainder of 16 bits (Division)			
Vectored	Internal	19			
interrupt source	External <sup>Note 2</sup>	6			
Reset		Reset using RESET pin			
		Internal reset by watchdog timer			
		Internal reset by power-on-clear			
		Internal reset by low-voltage detector			
On-chip debug function		Provided			
Supply voltage	е	$V_{DD} = 2.7 \text{ to } 5.5 \text{ V}$			
Operating am	bient temperature	$T_A = -40$ to $+85^{\circ}C$ , $-40$ to $+105^{\circ}C$			
Package		64-pin plastic LQFP (fine pitch) ( $10 \times 10$ )			

**Notes 1.** Select either of the functions of these alternate-function pins.

2. The external interrupt sources INTP3 and INTP4 can not be used at the same time.



#### • 78K0/DF2 without CAN (μPD78F0838, 78F0839, 78F0840, 78F0841, 78F0842, 78F0843)

				(1/2)		
Item		μPD78F0838	μPD78F0840	μPD78F0842		
		μPD78F0839	μPD78F0841	μPD78F0843		
InternalFlash memory24 K/48 Kmemory(self-programming(bytes)supported)						
	High-speed RAM <sup>Note</sup>		1 K			
	Expansion RAM <sup>Note</sup>		1 K			
CAN buffe	er RAM		-			
High-spee (oscillation	ed system clock n frequency)	Crystal/ceramic oscillation (X1), external main system clock input (EXCLK) 4 to 20 MHz: $V_{DD} = 4.0$ to 5.5 V, 4 to 10 MHz: $V_{DD} = 2.7$ to 5.5 V				
Internal hi clock (osc	gh-speed oscillation illation frequency)	On-chip internal oscillation (8 MHz (TYP.): VDD = 2.7 to 5.5 V)				
Internal lo clock (osc	w-speed oscillation illation frequency)	On-chip internal oscillation (240	kHz (TYP.))			
Subsyster (oscillation	n clock n frequency)	Crystal oscillation (XT1), external subsystem clock input (EXCLKS) (32.768 kHz: V <sub>DD</sub> = 2.7 to 5.5 V)				
General-p	urpose registers	8 bits $\times$ 32 registers (8 bits $\times$ 8 registers $\times$ 4 banks)				
Minimum	instruction execution	0.1 μs/0.2 μs/0.4 μs/0.8 μs/1.6 μs (high-speed system clock: @ f <sub>MAIN</sub> = 20 MHz operation)				
time		0.25 $\mu$ s/0.5 $\mu$ s/1.0 $\mu$ s/2.0 $\mu$ s/4.0 $\mu$ s (TYP.) (internal oscillator clock: @ fosca = 8 MHz (TYP.) operation)				
		122 $\mu$ s (subsystem clock: when	operating at fxt = 32.768 kHz)			
Instructior	n set	<ul> <li>16-bit operation</li> <li>Multiply/divide (16 bits × 16 bits, 32 bits ÷ 16 bits)</li> <li>Bit manipulate (set, reset, test, and Boolean operation)</li> <li>BCD adjust, etc.</li> </ul>				
I/O ports		Total :       63         CMOS I/O       61         N-ch open-drain I/O       2 (5 V tolerant / N-ch open-drain output selectable)				
Timers		<ul> <li>16-bit timer/event counter: 5 channels</li> <li>8-bit timer/event counter: 2 channels</li> <li>Watch timer: 1 channel</li> <li>Watchdog timer: 1 channel</li> </ul>				
	Timer outputs	12 (PWM output: Maximum 11)				
Clock output		<ul> <li>78.125 kHz, 156.25 kHz, 312.5 kHz, 625 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (high-speed system clock: 10 MHz)</li> <li>32.768 kHz (subsystem clock: 32.768 kHz)</li> </ul>				
Buzzer ou	itput	1.22 kHz, 2.44 kHz, 4.88 kHz, 9	.77 kHz (high-speed system cloc	k: 10 MHz)		
A/D converter		10-bit resolution × 8 channels				

**Note** The internal flash memory capacity, internal high-speed RAM capacity, and internal expansion RAM capacity can be changed using the internal memory size switching register (IMS) and the internal expansion RAM size switching register (IXS).



					(2/2)	
Item			μPD78F0838	μPD78F0840	μPD78F0842	
			μPD78F0839	μPD78F0841	μPD78F0843	
Serial	CAN		-			
interface	3-wire CSI		1 ch			
	LIN-UART		1 ch			
	LIN-UART/CSINote 1		1 ch			
	I <sup>2</sup> C bus		1 ch			
LCD controller/driver (seg × com)		er	40 × 4	32 × 4	28 × 4	
Sound generator			1 ch			
Stepper motor controller/driver (with ZPD)		troller/driver	-	2 ch	4 ch	
Multiplier/divider			<ul> <li>16 bit × 16 bit = 32 bit (Multiplication)</li> <li>32 bit ÷ 16 bit = 32 bit remainder of 16 bits (Division)</li> </ul>			
Vectored		Internal		22		
interrupt so	ources	External Note 2		7		
Reset			Reset using RESET pin			
			Internal reset by watchdog timer			
			Internal reset by power-on-clear			
			Internal reset by low-voltage detector			
On-chip debug function			Provided			
Supply voltage			$V_{DD} = 2.7 \text{ to } 5.5 \text{ V}$			
Operating ambient temperature			$T_A = -40$ to $+85^{\circ}C$ , $-40$ to $+105^{\circ}C$			
Package			80-pin plastic LQFP (fine pitch) (12 × 12)			

**Notes 1.** Select either of the functions of these alternate-function pins.

2. The external interrupt sources INTP3 and INTP4 can not be used at the same time.



### • 78K0/DE2 with CAN (μPD78F0844, 78F0845)

			(1/2)	
Item		<i>µ</i> PD78F0844	μPD78F0845	
Internal memory (bytes)	Flash memory (self-programming supported) <sup>Note</sup>	32 K	60 K	
	High-speed RAM <sup>Note</sup>	1 K		
	Expansion RAM <sup>Note</sup>	1 K	2К	
CAN buffer	RAM	288 bytes		
High-speed system clock (oscillation frequency)		Crystal/ceramic oscillation (X1), external main system clock input (EXCLK) 4 to 20 MHz: V <sub>DD</sub> = 4.0 to 5.5 V, 4 to 10 MHz: V <sub>DD</sub> = 2.7 to 5.5 V		
Internal high-speed oscillation clock (oscillation frequency)		On-chip internal oscillation (8 MHz (TYP.): VDD = 2.7 to 5.5 V)		
Internal low-speed oscillation clock (oscillation frequency)		On-chip internal oscillation (240 kHz (TYP.))		
Subsystem	clock	Crystal oscillation (XT1), external subsystem clock input (EXCLKS)		
(oscillation 1	requency)	(32.768 kHz: V <sub>DD</sub> = 2.7 to 5.5 V)		
General-pu	pose registers	8 bits × 32 registers (8 bits × 8 registers × 4 banks)		
Minimum in	struction execution	0.1 $\mu$ s/0.2 $\mu$ s/0.4 $\mu$ s/0.8 $\mu$ s/1.6 $\mu$ s (high-speed system clock: @ fmain = 20 MHz operation)		
time		0.25 $\mu$ s/0.5 $\mu$ s/1.0 $\mu$ s/2.0 $\mu$ s/4.0 $\mu$ s (TYP.) (internal oscillator clock: @ fosca = 8 MHz (TYP.) operation)		
		122 $\mu$ s (subsystem clock: when operating at fxT = 32.768 kHz)		
Instruction set		<ul> <li>16-bit operation</li> <li>Multiply/divide (16 bits × 16 bits, 32 bits ÷ 16 bits)</li> <li>Bit manipulate (set, reset, test, and Boolean operation)</li> <li>BCD adjust, etc.</li> </ul>		
I/O ports		Total : 47		
		CMOS I/O 45 N-ch open-drain I/O 2 (5 V tolerant / N-ch open-drain output selectable)		
Timers		16-bit timer/event counter: 5 channels     Watch timer: 1 channel     Watchdog timer: 1 channel		
	Timer outputs	12 (PWM output: Maximum 11)		
Clock output		<ul> <li>78.125 kHz, 156.25 kHz, 312.5 kHz, 625 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (high-speed system clock: 10 MHz)</li> <li>32.768 kHz (subsystem clock: 32.768 kHz)</li> </ul>		
Buzzer output		1.22 kHz, 2.44 kHz, 4.88 kHz, 9.77 kHz (high-speed system clock: 10 MHz)		
A/D converter		10-bit resolution × 4 channels		

**Note** The internal flash memory capacity, internal high-speed RAM capacity, and internal expansion RAM capacity can be changed using the internal memory size switching register (IMS) and the internal expansion RAM size switching register (IXS).



			(2/2)	
Item		μPD78F0844	μPD78F0845	
Serial interface	CAN	1 ch		
	LIN-UART/CSINote 1	1 ch		
	I <sup>2</sup> C bus	1 ch		
LCD controller/driver (seg × com)		24 × 4		
Sound genera	tor	1 ch		
Stepper motor (with ZPD)	controller/driver	2 ch		
Multiplier/divid	er	<ul> <li>16 bit × 16 bit = 32 bit (Multiplication)</li> <li>32 bit ÷ 16 bit = 32 bit remainder of 16 bits (Division)</li> </ul>		
Vectored interrupt source	Internal	22		
	External <sup>Note 2</sup>	6		
Reset		<ul> <li>Reset using RESET pin</li> <li>Internal reset by watchdog timer</li> <li>Internal reset by power-on-clear</li> <li>Internal reset by low-voltage detector</li> </ul>		
On-chip debu	g function	Provided		
Supply voltage	Э	V <sub>DD</sub> = 2.7 to 5.5 V		
Operating am	bient temperature	T <sub>A</sub> = -40 to +85°C, -40 to +105°C		
Package		64-pin plastic LQFP (fine pitch) (10 $\times$ 10)		

**Notes 1.** Select either of the functions of these alternate-function pins.

2. The external interrupt sources INTP3 and INTP4 can not be used at the same time.



### • 78K0/DF2 with CAN (μPD78F0846, 78F0847, 78F0848, 78F0849)

			(1/2)	
ltem		μPD78F0846	μPD78F0848	
		μPD78F0847	μPD78F0849	
Internal memory (bytes)	Flash memory (self-programming supported) <sup>Note</sup>	32 K/60 K		
	High-speed RAM <sup>Note</sup>	1 K		
	Expansion RAM <sup>Note</sup>	2 K		
CAN buffer RAM		288 bytes		
High-speed system clock (oscillation frequency)		Crystal/ceramic oscillation (X1), external main system clock input (EXCLK) 4 to 20 MHz: $V_{DD} = 4.0$ to 5.5 V, 4 to 10 MHz: $V_{DD} = 2.7$ to 5.5 V		
Internal high-speed oscillation clock (oscillation frequency)		On-chip internal oscillation (8 MHz (TYP.): $V_{DD} = 2.7$ to 5.5 V)		
Internal low-speed oscillation clock (oscillation frequency)		On-chip internal oscillation (240 kHz (TYP.))		
Subsyster	n clock	Crystal oscillation (XT1), external subsystem clock input (EXCLKS)		
(oscillation	n frequency)	(32.768 kHz: V <sub>DD</sub> = 2.7 to 5.5 V)		
General-purpose registers		8 bits $\times$ 32 registers (8 bits $\times$ 8 registers $\times$ 4 banks)		
Minimum i	nstruction execution	0.1 $\mu$ s/0.2 $\mu$ s/0.4 $\mu$ s/0.8 $\mu$ s/1.6 $\mu$ s (high-speed system clock: @ fmain = 20 MHz operation)		
time		0.25 $\mu$ s/0.5 $\mu$ s/1.0 $\mu$ s/2.0 $\mu$ s/4.0 $\mu$ s (TYP.) (internal oscillator clock: @ fosca = 8 MHz (TYP.) operation)		
		122 $\mu$ s (subsystem clock: when operating at fxt = 32.768 kHz)		
Instruction set		<ul> <li>16-bit operation</li> <li>Multiply/divide (16 bits × 16 bits, 32 bits ÷ 16 bits)</li> <li>Bit manipulate (set, reset, test, and Boolean operation)</li> <li>BCD adjust, etc.</li> </ul>		
I/O ports		Total :         63           CMOS I/O         61           N-ch open-drain I/O         2 (5 V tolerant / N-ch	n open-drain output selectable)	
Timers		<ul> <li>16-bit timer/event counter: 5 channels</li> <li>8-bit timer/event counter: 2 channels</li> <li>Watch timer: 1 channel</li> <li>Watchdog timer: 1 channel</li> </ul>		
	Timer outputs	12 (PWM output: Maximum 11)		
Clock output		<ul> <li>78.125 kHz, 156.25 kHz, 312.5 kHz, 625 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (high-speed system clock: 10 MHz)</li> <li>32.768 kHz (subsystem clock: 32.768 kHz)</li> </ul>		
Buzzer output		1.22 kHz, 2.44 kHz, 4.88 kHz, 9.77 kHz (high-speed system clock: 10 MHz)		
A/D converter		10-bit resolution × 8 channels		

**Note** The internal flash memory capacity, internal high-speed RAM capacity, and internal expansion RAM capacity can be changed using the internal memory size switching register (IMS) and the internal expansion RAM size switching register (IXS).


			(2/2)						
	Item	μPD78F0846	μPD78F0848						
		μPD78F0847	μPD78F0849						
Serial	CAN	10	ch						
interface	3-wire CSI	10	1 ch						
	LIN-UART	10	ch						
	LIN-UART/CSI <sup>Note</sup>	10	ch						
	I <sup>2</sup> C bus	10	ch						
LCD controller/driver (seg × com)		32 × 4	28 × 4						
Sound genera	ator	1 ch							
Stepper motor controller/driver (with ZPD)		2 ch	4 ch						
Multiplier/divid	der	• 16 bit × 16 bit = 32 bit (Multiplication)							
		32 bit ÷ 16 bit = 32 bit remainder of 16 bits (Division)							
Vectored	Internal	25							
interrupt sour	Ces External Note 2	7							
Reset		Reset using RESET pin							
		Internal reset by watchdog timer							
		Internal reset by power-on-clear							
		Internal reset by low-voltage detector							
On-chip debug function		Provided							
Supply voltag	je	V <sub>DD</sub> = 2.7 to 5.5 V							
Operating arr	nbient temperature	$T_A = -40 \text{ to } +85^{\circ}\text{C}, -40 \text{ to } +105^{\circ}\text{C}$							
Package		80-pin plastic LQFP (fine pitch) (12 $\times$ 12)	80-pin plastic LQFP (fine pitch) ( $12 \times 12$ )						

Notes 1. Select either of the functions of these alternate-function pins.

2. The external interrupt sources INTP3 and INTP4 can not be used at the same time.



• Outline of timers

An outline of the timer is shown below.

			16-Bit Timer/     8-Bit Timer/     W       Event Counters P0 to P4     Event Counters     50 and 51       TMP0     TMP1     TMP2     TMP3     TMP4     TM50     TM51				Watch Timer	Watchdog Timer		
Operation	Interval timer	1 ch	1 ch	1 ch	1 ch	1 ch	1 ch	1 ch	1 channel <sup>Note</sup>	1 channel
mode	External event counter	1 ch	1 ch	1 ch	1 ch	1 ch	1 ch	1 ch	_	_
Function	Timer output	2	2	2	2	2	1	1	-	_
	External trigger pulse output	1	1	1	1	1	-	-	-	-
	PWM output	1	2	2	2	2	1	1	-	_
	Pulse width measurement	2	2	2	2	2	-	-	-	-
	Square-wave output	-	-	-	-	-	1	1	-	-
	Interrupt source	2	2	3	3	2	1	1	1	-

Note In the watch timer, the watch timer function and interval timer function cannot be used simultaneously.



# **CHAPTER 2 PIN FUNCTIONS**

# 2.1 Pin Function List

There are four types of pin I/O buffer power supplies: AVREF, EVDD, SMVDD, and VDD. The relationship between these power supplies and the pins is shown below.

Power Supply	Corresponding Pins
AVREF	P20 to P23, P24 to P27 <sup>Note</sup>
EVDD	Port pins other than P20 to P27, P80 to P87, P90 to P97, and P121 to P124
SMVDD	<ul> <li>P80 to P87</li> <li>P90 to P97<sup>Note</sup></li> </ul>
Vdd	P121 to P124     Non-port pins

Table 2-1	Pin I/O B	uffer Power	Supplies
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Note 78K0/DF2 only.

This section explains the names and functions of the pins of the 78K0/Dx2.



## (1) Port pins

• 78K0/DE2 (µPD78F0836, 78F0837, 78F0844, 78F0845)

Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
P00	I/O	Port 0.	Ext.: PD	Input	SEG12/TIOP40
P01		8-bit I/O port.	Int.: HZ		SEG13/TIOP41
P02		Input/output can be specified in 1-bit units.			SEG14/TIO50
P03		specified by a software setting.			SEG15/TIO51
P04					SEG16/TIOP01
P05					SEG17/TIOP11
P06					SEG18/TIOP21
P07					SEG19/TIOP31
P10	I/O	Port 1.	HZ	Input	SCK10/INTP4
P11		8-bit I/O port. Input/output can be specified in 1-bit units. Use of an on-chip pull-up resistor can be specified by a software setting.			SI10
P12					SO10/INTP2
P13			Ext.: PD		SEG23/TIOP30/TxD60
P14			Int.: HZ		SEG22/TIOP20/RxD60/ INTPR60
P15					SEG21/TIOP10
P16					SEG20/TIOP00
P17			HZ		INTP0/ <tiop30></tiop30>
P20 to P23	I/O	Port 2. 4-bit I/O port. Input/output can be specified in 1-bit units.	ΗZ	Input	ANI0 to ANI3
P30	I/O	Port 3.	Ext.: PD	Input	SEG4
P31		8-bit I/O port.	Int.: HZ		SEG5/OCD1A
P32	-	Use of an on-chip pull-up resistor can be			SEG6/OCD1B
P33 to P37		specified by a software setting.			SEG7 to SEG11
P60	I/O	Port 6.	HZ	Input	SCL0/INTP1
P61		2-bit I/O port Input/output can be specified in 1-bit units. Use of an on-chip pull-up resistor can be specified by a software setting.			SDA0/INTP3

Table 2-2.	Port Pins for 78K0/DE2 (1/2)

- Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance
  - 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).



Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
P70	I/O	Port 7. 4-bit I/O port.	HZ	Input	CRxD <sup>Note</sup> / <rxd60 intpr60=""></rxd60>
P71		Input/output can be specified in 1-bit units.			CTxD <sup>Note</sup> / <txd60></txd60>
P72		Use of an on-chip pull-up resistor can be specified by a software setting.			SGOA/PCL
P73					SGO/SGOF/BUZ
P80 to P82	I/O	Port 8. 8-bit I/O port. Input/output can be specified in 1-bit units.	Ext.: PD	Input	SM11 to SM13
P83			Int.: HZ		SM14/ZPD14
P84 to P86					SM21 to SM23
P87					SM24/ZPD24
P120	I/O	Port 12. 5-bit I/O port. Only for P120, use of an on-chip pull-up resistor	ΗZ	Input	EXLVI
P121					X1/OCD0A
P122					X2/EXCLK/OCD0B
P123					XT1
P124					XT2/EXCLKS

Table 2-2. Port Pins for 78K0/DE2 (2/2)

**Note** *μ*PD78F0844 and 78F0845 only.



Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance

78K0/DF2 (μPD78F0838, 78F0839, 78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, 78F0849)

Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
P00	I/O	Port 0.	Ext.: PD	Input	SEG12/TIOP40
P01		8-bit I/O port.	Int.: HZ		SEG13/TIOP41
P02		Input/output can be specified in 1-bit units.			SEG14/TIO50
P03		specified by a software setting.			SEG15/TIO51
P04					SEG16/TIOP01
P05					SEG17/TIOP11
P06					SEG18/TIOP21
P07					SEG19/TIOP31
P10	I/O	Port 1.	HZ	Input	SCK10/TxD61/INTP4
P11		8-bit I/O port. Input/output can be specified in 1-bit units. Use of an on-chip pull-up resistor can be specified by a software setting.			SI10/RxD61/INTPR61
P12	_				SO10/INTP2
P13			Ext.: PD		SEG23/TIOP30/TxD60
P14			Int.: HZ		SEG22/TIOP20/RxD60/ INTPR60
P15					SEG21/TIOP10
P16					SEG20/TIOP00
P17			HZ		INTP0/ <tiop30></tiop30>
P20 to P27	I/O	Port 2. 8-bit I/O port. Input/output can be specified in 1-bit units.	HZ	Input	ANI0 to ANI7
P30	I/O	Port 3.	Ext.: PD	Input	SEG4
P31		8-bit I/O port.	Int.: HZ		SEG5/OCD1A
P32		Use of an on-chip pull-up resistor can be			SEG6/OCD1B
P33 to P37		specified by a software setting.			SEG7 to SEG11
P60	I/O	Port 6.	HZ	Input	SCL0/INTP1
P61		2-bit I/O port Input/output can be specified in 1-bit units. Use of an on-chip pull-up resistor can be specified by a software setting.			SDA0/INTP3

|--|

Note Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance

- Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance
  - 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

Table 2-3.	Port Pins for 78K0/DF2 (2/2)	
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Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
P70	I/O	Port 7. 8-bit I/O port.	HZ	Input	CRxD <sup>Note1</sup> / <rxd60 intpr60=""></rxd60>
P71		Input/output can be specified in 1-bit units.			CTxD <sup>Note1</sup> / <txd60></txd60>
P72		Use of an on-chip pull-up resistor can be specified by a software setting			SGOA/PCL
P73		specified by a software setting.			SGO/SGOF/BUZ
P74			Ext.: PD		SEG24 <sup>Note2</sup> /SCK11
P75			Int.: HZ		SEG25 <sup>Note2</sup> /SI11
P76					SEG26 <sup>Note2</sup> /SO11
P77					SEG27 <sup>Note2</sup> /SSI11/ <tiop20></tiop20>
P80 to P82	I/O	Port 8. 8-bit I/O port.	Ext.: PD Int.: HZ	Input	SEG24 to SEG26 <sup>Note3</sup> SM11 to SM13 <sup>Note2</sup>
P83		Input/output can be specified in 1-bit units.			SEG27 <sup>Note3</sup> SM14/ZPD14 <sup>Note2</sup>
P84 to P86					SEG28 to SEG30 <sup>Note3</sup> SM21 to SM23 <sup>Note2</sup>
P87					SEG31 <sup>Note3</sup> SM24/ZPD24 <sup>Note2</sup>
P90 to P92	I/O	Port 9. 8-bit I/O port.	Ext.: PD Int.: HZ	Input	SEG32 to SEG34 <sup>Note4</sup> SM31 to SM33 <sup>Note5</sup>
P93		Input/output can be specified in 1-bit units.			SEG35 <sup>Note4</sup> SM34/ZPD34 <sup>Note5</sup>
P94 to P96					SEG36 to SEG38 <sup>Note4</sup> SM41 to SM43 <sup>Note5</sup>
P97					SEG39 <sup>Note4</sup> SM44/ZPD44 <sup>Note5</sup>
P120	I/O	Port 12.	HZ	Input	EXLVI
P121	1	5-bit I/O port.			X1/OCD0A
P122		Only for P120, use of an on-chip pull-up resistor			X2/EXCLK/OCD0B
P123		sur so opconica by a contrate setting.			XT1
P124					XT2/EXCLKS

**Notes 1.** *μ*PD78F0846, 78F0847, 78F0848, and 78F0849 only.

- **2.** For *μ*PD78F0842, 78F0843, 78F0848, and 78F0849.
- **3.** For μPD78F0838 to 78F0841, 78F0846, and 78F0847.
- **4.** For μPD78F0838 and 78F0839.
- **5.** For μPD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849.
- Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance
  - 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

## (2) Non-port pins

• 78K0/DE2 (µPD78F0836, 78F0837, 78F0844, 78F0845)

Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
ANI0 to ANI3	Input	A/D converter analog input	HZ	Input	P20 to P23
AVREF	_	A/D converter reference voltage input and positive power supply for port 2	-	-	_
AVss	-	A/D converter ground potential. Make the same potential as EVss or Vss.	-	-	_
BUZ	Output	Buzzer output	HZ	Input	P73/SGO/SGOF
COM0 to COM3	Output	LCD controller/driver common signal outputs	L	_	-
CRxD <sup>Note</sup>	Input	CAN receive data input	HZ	Input	P70/ <rxd60 intpr60=""></rxd60>
CTxD <sup>Note</sup>	Output	CAN transmit data output	HZ	Input	P71/ <txd60></txd60>
EXCLK	Input	External clock input for main system clock	HZ	Input	P122/X2/OCD0B
EXCLKS	Input	External clock input for subsystem clock	HZ	Input	P124/XT2
EXLVI	Input	Potential input for external low-voltage detection	HZ	Input	P120
FLMD0		Flash memory programming mode setting		-	
INTP0	Input	External interrupt request input for which the	HZ	Input	P17/ <tiop30></tiop30>
INTP1		valid edge (rising edge, falling edge, or both			P60/SCL0
INTP2		rising and falling edges) can be specified.			P12/SO10
INTP3					P61/SDA0
INTP4	]				P10/SCK10
INTPR60			Ext.: PD Int.: HZ		P14/SEG22/TIOP20/ RxD60
<intpr60></intpr60>	]		HZ		P70/CRxD <sup>Note</sup> / <rxd60></rxd60>
OCD0A	I/O	On-chip debug mode setting connection	HZ	Input	P121/X1
OCD0B	]				P122/X2/EXCLK
OCD1A	]		Ext.: PD		P31/SEG5
OCD1B			Int.: HZ		P32/SEG6
PCL	Output	Clock output (for trimming of high-speed system clock, subsystem clock)	HZ	Input	P72/SGOA
REGC	_	This is the pin for connecting regulator output (2.5 V) stabilization capacitance for internal operation. Connect this pin to Vss via a capacitor (0.47 to 1 $\mu$ F: recommended).	_	_	_

**Note** *μ*PD78F0844 and 78F0845 only.

- Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance, L: Low level output
  - 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
RESET	Input	System reset input	_	-	-
RxD60	Input	Serial data input to asynchronous serial interface	Ext.: PD Int.: HZ	Input	P14/SEG22/TIOP20/ INTPR60
<rxd60></rxd60>			HZ		P70/CRxD <sup>Note</sup> / <intpr60></intpr60>
SCK10	I/O	Clock input/output for serial interface	HZ	Input	P10/INTP4
SCL0	I/O	Clock input/output for I <sup>2</sup> C 5 V tolerant/N-ch open-drain output selectable.	HZ	Input	P60/INTP1
SDA0	I/O	Serial data I/O for I <sup>2</sup> C 5 V tolerant/N-ch open-drain output selectable.	HZ	Input	P61/INTP3
SEG0 to SEG3	Output	LCD controller/driver segment signal outputs	Ext.: PD Int.: L	-	-
SEG4			Ext.: PD	Input	P30
SEG5			Int.: HZ		P31/OCD1A
SEG6					P32/OCD1B
SEG7 to SEG11					P33 to P37
SEG12					P00/TIOP40
SEG13					P01/TIOP41
SEG14					P02/TIO50
SEG15					P03/TIO51
SEG16					P04/TIOP01
SEG17					P05/TIOP11
SEG18					P06/TIOP21
SEG19					P07/TIOP31
SEG20					P16/TIOP00
SEG21					P15/TIOP10
SEG22					P14/TIOP20/RxD60/ INTPR60
SEG23					P13/TIOP30/TxD60
SGO	Output	Sound generator output	HZ	Input	P73/SGOF/BUZ
SGOA		Sound generator amplitude PWM output			P72/PCL
SGOF		Sound generator frequency output			P73/SGO/BUZ
SI10	Input	Serial data input to serial interface	HZ	Input	P11

Table 2-4. Non-port Pins for 78K0/DE2 (2/4)

**Note**  $\mu$ PD78F0844 and 78F0845 only.

- Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance, L: Low level output
  - 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
SM11	Output	Stepper motor 1 output sin +	Ext.: PD	Input	P80
SM12		Stepper motor 1 output sin –	Int.: HZ		P81
SM13		Stepper motor 1 output cos +	]		P82
SM14		Stepper motor 1 output cos -	]		P83/ZPD14
SM21		Stepper motor 2 output sin +			P84
SM22		Stepper motor 2 output sin –	]		P85
SM23		Stepper motor 2 output cos +	]		P86
SM24		Stepper motor 2 output cos -	1		P87/ZPD24
SMVDD	-	Stepper motor controller/driver supply voltage	-	_	-
SMVss	-	Stepper motor controller/driver ground potential	-	-	-
SO10	Output	Serial data output from serial interface	HZ	Input	P12/INTP2
TIO50	I/O	External count clock input/timer output (TM50)	Ext.: PD	Input	P02/SEG14
TIO51		External count clock input/timer output (TM51)	Int.: HZ		P03/SEG15
TIOP00	I/O	External event count input/capture trigger input/external trigger input/timer output (TMP0)	Ext.: PD Int.: HZ	Input	P16/SEG20
TIOP01		Capture trigger input/timer output (TMP0)	1		P04/SEG16
TIOP10		External event count input/capture trigger input/external trigger input/timer output (TMP1)			P15/SEG21
TIOP11		Capture trigger input/timer output (TMP1)	1		P05/SEG17
TIOP20		External event count input/capture trigger input/external trigger input/timer output (TMP2)			P14/SEG22/RxD60/ INTPR60
TIOP21		Capture trigger input/timer output (TMP2)	]		P06/SEG18
TIOP30		External event count input/capture trigger			P13/SEG23/TxD60
<tiop30></tiop30>		input/external trigger input/timer output (TMP3)	HZ		P17/INTP0
TIOP31		Capture trigger input/timer output (TMP3)	Ext.: PD		P07/SEG19
TIOP40		External event count input/capture trigger input/external trigger input/timer output (TMP4)	Int.: HZ		P00/SEG12
TIOP41		Capture trigger input/timer output (TMP4)	1		P01/SEG13
TxD60	Output	Serial data output from asynchronous serial interface	Ext.: PD Int.: HZ	Input	P13/SEG23/TIOP30
<txd60></txd60>			HZ		P71/CTxD <sup>Note</sup>
Vdd/EVdd	_	Positive power supply (except for ports)/positive power supply for ports	-	_	-
Vss/EVss	_	Ground potential (except for ports)/ground potential for ports	-	_	_

Table 2-4. Non-port Pins for 78K0/DE2 (3/4)

**Note**  $\mu$ PD78F0844 and 78F0845 only.

Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset,

- PD: Pull down, HZ: High impedance
- 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
X1	Input	Connecting resonator for high-speed system clock	HZ	Input	P121/OCD0A
X2	-				P122/EXCLK/OCD0B
XT1	Input	Connecting resonator for subsystem clock	HZ	Input	P123
XT2	-				P124/EXCLKS
ZPD14	Input	Zero point detection input	Ext.: PD	Input	P83/SM14
ZPD24			Int.: HZ		P87/SM24

Table 2-4. Non-port Pins for 78K0/DE2 (4/4)

**Remark** Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance



## 78K0/Dx2

78K0/DF2 (µPD78F0838, 78F0839, 78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, 78F0849)

Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
ANI0 to ANI7	Input	A/D converter analog input	HZ	Input	P20 to P27
AVREF	-	A/D converter reference voltage input and positive power supply for port 2	_	_	_
AVss	_	A/D converter ground potential. Make the same potential as EVss or Vss.	_	-	-
BUZ	Output	Buzzer output	HZ	Input	P73/SGO/SGOF
COM0 to COM3	Output	LCD controller/driver common signal outputs	L	-	-
CRxD <sup>Note</sup>	Input	CAN receive data input	HZ	Input	P70/ <rxd60 intpr60=""></rxd60>
CTxD <sup>Note</sup>	Output	CAN transmit data output	HZ	Input	P71/ <txd60></txd60>
EXCLK	Input	External clock input for main system clock	HZ	Input	P122/X2/OCD0B
EXCLKS	Input	External clock input for subsystem clock	HZ	Input	P124/XT2
EXLVI	Input	Potential input for external low-voltage detection	HZ	Input	P120
FLMD0	-	Flash memory programming mode setting	-	_	_
INTP0	Input	External interrupt request input for which the	HZ	Input	P17/ <tiop30></tiop30>
INTP1		valid edge (rising edge, falling edge, or both rising and falling edges) can be specified			P60/SCL0
INTP2	]				P12/SO10
INTP3	]				P61/SDA0
INTP4	]				P10/SCK10/TxD61
INTPR60			Ext.: PD		P14/SEG22/TIOP20/
	-			-	
	4				
	1/0	On-chin debug mode setting connection	H7	Input	P121/X1
OCDOB	1,0	on one debug mode setting connection	112	mpar	P122/X2/EXCLK
	-		Fxt · PD		P31/SEG5
OCD1B	4		Int.: HZ		P32/SEG6
PCL	Output	Clock output (for trimming of high-speed system clock, subsystem clock)	HZ	Input	P72/SGOA
REGC	-	This is the pin for connecting regulator output (2.5 V) stabilization capacitance for internal operation. Connect this pin to Vss via a capacitor (0.47 to 1 $\mu$ F: recommended).	_	_	-
RESEI	Input	System reset input	-	-	-

## Table 2-5. Non-port Pins for 78K0/DF2 (1/4)

**Note** *μ*PD78F0846, 78F0847, 78F0848, and 78F0849 only.

- Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance, L: Low level output
  - 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

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Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
RxD60	Input	Serial data input to asynchronous serial interface	Ext.: PD Int.: HZ	Input	P14/SEG22/TIOP20/ INTPR60
<rxd60></rxd60>			HZ		P70/CRxD <sup>Note1</sup> / <intpr60></intpr60>
RxD61					P11/SI10/INTPR61
SCK10	I/O	Clock input/output for serial interface	HZ	Input	P10/TxD61/INTP4
SCK11			Ext.: PD Int.: HZ		P74/ SEG24 <sup>Note2</sup>
SCL0	I/O	Clock input/output for I <sup>2</sup> C 5 V tolerant/N-ch open-drain output selectable.	HZ	Input	P60/INTP1
SDA0	I/O	Serial data I/O for I <sup>2</sup> C 5 V tolerant/N-ch open-drain output selectable.	HZ	Input	P61/INTP3
SEG0 to SEG3	Output	LCD controller/driver segment signal outputs	Ext.: PD Int.: L	-	_
SEG4			Ext.: PD	Input	P30
SEG5			Int.: HZ		P31/OCD1A
SEG6					P32/OCD1B
SEG7 to SEG11					P33 to P37
SEG12	_				P00/TIOP40
SEG13					P01/TIOP41
SEG14					P02/TIO50
SEG15	-				P03/TIO51
SEG16	-				P04/TIOP01
SEG17	-				P05/TIOP11
SEG18	-				P06/TIOP21
SEG19	-				P07/TIOP31
SEG20	-				P16/TIOP00
SEG21	-				P15/TIOP10
SEG22					P14/TIOP20/RxD60/ INTPR60
SEG23					P13/TIOP30/TxD60
SEG24					P74/SCK11 <sup>Note2</sup> P80 <sup>Note3</sup>
SEG25					P75/SI11 <sup>Note2</sup> P81 <sup>Note3</sup>

Table 2-5. Non-port Pins for 78K0/DF2 (2/4)

**Notes 1.** *μ*PD78F0846, 78F0847, 78F0848, and 78F0849 only.

- **2.** For μPD78F0842, 78F0843, 78F0848, and 78F0849.
- **3.** For μPD78F0838, 78F0839, 78F0840, 78F0841, 78F0846, and 78F0847.

Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset,

- PD: Pull down, HZ: High impedance, L: Low level output
- 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

SEG26

Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
26	Output	LCD controller/driver segment signal outputs	Ext.: PD Int.: HZ	Input	P76/SO11 <sup>Note1</sup> P82 <sup>Note2</sup>
27					P77/SSI11 <sup>Note1</sup> / <tiop2 P83<sup>Note2</sup></tiop2 
28 to SEG31 <sup>Note3</sup>					P84 to P87
32 to SEG39 <sup>Note4</sup>					P90 to P97
	Output	Sound generator output	HZ	Input	P73/SGOF/BUZ
4		Sound generator amplitude PWM output			P72/PCL
=		Sound generator frequency output			P73/SGO/BUZ

Table 2-5. Non-port Pins for 78K0/DF2 (3/4)

SEG27					P77/SSI11 <sup>Note1</sup> / <tiop20> P83<sup>Note2</sup></tiop20>
SEG28 to SEG31 Note3					P84 to P87
SEG32 to SEG39 <sup>Note4</sup>					P90 to P97
SGO	Output	Sound generator output	HZ	Input	P73/SGOF/BUZ
SGOA		Sound generator amplitude PWM output			P72/PCL
SGOF		Sound generator frequency output			P73/SGO/BUZ
SI10	Input	Serial data input to serial interface	HZ	Input	P11/RxD61/INTPR61
SI11			Ext.: PD		P75/
N			Int.: HZ	ļ	SEG25 <sup>Note1</sup>
SM11 <sup>Note5</sup>	Output	Stepper motor 1 output sin +	Ext.: PD	Input	P80
SM12 <sup>Note5</sup>		Stepper motor 1 output sin –	Int.: HZ		P81
SM13 <sup>Note5</sup>		Stepper motor 1 output cos +			P82
SM14 <sup>Note5</sup>		Stepper motor 1 output cos –			P83/ZPD14
SM21 <sup>Note5</sup>		Stepper motor 2 output sin +			P84
SM22 <sup>Note5</sup>		Stepper motor 2 output sin –			P85
SM23 <sup>Note5</sup>		Stepper motor 2 output cos +			P86
SM24 <sup>Note5</sup>		Stepper motor 2 output cos –			P87/ZPD24
SM31 <sup>Note6</sup>		Stepper motor 3 output sin +			P90
SM32 <sup>Note6</sup>		Stepper motor 3 output sin –			P91
SM33 <sup>Note6</sup>		Stepper motor 3 output cos +			P92
SM34 <sup>Note6</sup>		Stepper motor 3 output cos –			P93/ZPD34
SM41 <sup>Note6</sup>		Stepper motor 4 output sin +			P94
SM42 <sup>Note6</sup>		Stepper motor 4 output sin –			P95
SM43 <sup>Note6</sup>		Stepper motor 4 output cos +			P96
SM44 <sup>Note6</sup>		Stepper motor 4 output cos –			P97/ZPD44
SMVDD	_	Stepper motor controller/driver supply voltage	_	_	_
SMVss	-	Stepper motor controller/driver ground potential	_	_	_
SO10	Output	Serial data output from serial interface	HZ	Input	P12/INTP2
SO11			Ext.: PD		P76/
			Int.: HZ		SEG26 <sup>Note1</sup>

**Notes 1.** For *μ*PD78F0842, 78F0843, 78F0848, and 78F0849.

- **2.** For μPD78F0838, 78F0839, 78F0840, 78F0841, 78F0846, and 78F0847.
- **3.** μPD78F0838, 78F0839, 78F0840, 78F0841, 78F0846, and 78F0847 only.
- **4.** *μ*PD78F0838 and 78F0839 only.
- **5.** *μ*PD78F0842, 78F0843, 78F0848, and 78F0849 only.
- **6.** μPD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849 only.

Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance

> 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

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Pin Name	I/O	Function	During Reset	After Reset	Alternate Function
SSI11	Input	Serial interface chip select input	Ext.: PD Int.: HZ	Input	P77/ <tiop20>/ SEG27<sup>Note1</sup></tiop20>
TIO50	I/O	External count clock input/timer output (TM50)	Ext.: PD	Input	P02/SEG14
TIO51		External count clock input/timer output (TM51)	Int.: HZ		P03/SEG15
TIOP00	I/O	External event count input/capture trigger input/external trigger input/timer output (TMP0)	Ext.: PD Int.: HZ	Input	P16/SEG20
TIOP01		Capture trigger input/timer output (TMP0)			P04/SEG16
TIOP10		External event count input/capture trigger input/external trigger input/timer output (TMP1)			P15/SEG21
TIOP11		Capture trigger input/timer output (TMP1)	1		P05/SEG17
TIOP20		External event count input/capture trigger input/external trigger input/timer output (TMP2)	1		P14/SEG22/RxD60/ INTPR60
<tiop20></tiop20>					P77/SSI11/ SEG27 <sup>Note1</sup>
TIOP21		Capture trigger input/timer output (TMP2)	1		P06/SEG18
TIOP30		External event count input/capture trigger	1		P13/SEG23/TxD60
<tiop30></tiop30>		input/external trigger input/timer output (TMP3)	HZ		P17/INTP0
TIOP31		Capture trigger input/timer output (TMP3)	Ext.: PD		P07/SEG19
TIOP40		External event count input/capture trigger input/external trigger input/timer output (TMP4)	Int.: HZ		P00/SEG12
TIOP41		Capture trigger input/timer output (TMP4)	1		P01/SEG13
TxD60	Output	Serial data output from asynchronous serial interface	Ext.: PD Int.: HZ	Input	P13/SEG23/TIOP30
<txd60></txd60>			HZ		P71/CTxD <sup>Note2</sup>
TxD61					P10/SCK10/INTP4
Vdd/EVdd	-	Positive power supply (except for ports)/positive power supply for ports	-	-	-
Vss/EVss	_	Ground potential (except for ports)/ground potential for ports	-	-	-
X1	Input	Connecting resonator for high-speed system clock	HZ	Input	P121/OCD0A
X2	_				P122/EXCLK/OCD0B
XT1	Input	Connecting resonator for subsystem clock	HZ	Input	P123
XT2	-				P124/EXCLKS
ZPD14 <sup>Note3</sup>	Input	Zero point detection input	Ext.: PD	Input	P83/SM14
ZPD24 <sup>Note3</sup>	]		Int.: HZ		P87/SM24
ZPD34 <sup>Note4</sup>	]				P93/SM34
ZPD44 <sup>Note4</sup>	]				P97/SM44

Table 2-5. Non-port Pins for 78K0/DF2 (4/4)

**Notes 1.** For *µ*PD78F0842, 78F0843, 78F0848, and 78F0849.

- **2.** *μ*PD78F0846, 78F0847, 78F0848, and 78F0849 only.
- **3.** μPD78F0842, 78F0843, 78F0848, and 78F0849 only.
- **4.** *μ*PD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849 only.
- Remarks 1. Ext. (external reset): POC reset or pin reset, Int. (internal reset): WDT reset or LVI reset, PD: Pull down, HZ: High impedance
  - 2. The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

# 2.2 Description of Pin Functions

## 2.2.1 P00 to P07 (port 0)

P00 to P07 function as an 8-bit I/O port. These pins also function as timer I/O and segment signal outputs for the LCD controller/driver.

The following operation modes can be specified in 1-bit units.

## (1) Port mode

P00 to P07 function as 8-bit I/O port. P00 to P07 can be set to input or output in 1-bit units using port mode register 0 (PM0). Use of an on-chip pull-up resistor can be specified by pull-up resistor option register 0 (PU0).

## (2) Control mode

P00 to P07 function as timer I/O and segment signal outputs for the LCD controller/driver.

## (a) TIO50, TIO51

These are the pins for inputting an external count clock to 8-bit timer/event counter 50 and timer output.

## (b) TIOP01, TIOP11, TIOP21, TIOP31, TIOP41

These are the pins for capture trigger inputs and timer outputs (TMP0 to TMP4).

## (c) TIOP40

This is the pin for external event count input, capture trigger input, external trigger input, and timer output (TMP4).

## (d) SEG12 to SEG19

These are the segment signal output pins for the LCD controller/driver.



## 2.2.2 P10 to P17 (port 1)

P10 to P17 function as an 8-bit I/O port. These pins also function as pins for serial interface data I/O, clock I/O, timer I/O, external interrupt request input, and segment signal outputs for the LCD controller/driver.

The following operation modes can be specified in 1-bit units.

## (1) Port mode

P10 to P17 function as an 8-bit I/O port. P10 to P17 can be set to input or output in 1-bit units using port mode register 1 (PM1). Use of an on-chip pull-up resistor can be specified by pull-up resistor option register 1 (PU1).

## (2) Control mode

P10 to P17 function as serial interface data I/O, clock I/O, timer I/O, and segment signal outputs for the LCD controller/driver.

## (a) SI10

This is a serial interface serial data input pin.

#### (b) SO10

This is a serial interface serial data output pin.

#### (c) SCK10

This is a serial interface serial clock I/O pin.

## (d) RxD60, RxD61<sup>Note</sup>

These are the serial data input pins of the asynchronous serial interface.

Note RxD61 is for 78K0/DF2 only.

## (e) TxD60, TxD61<sup>Note</sup>

These are the serial data output pins of the asynchronous serial interface.

Note TxD61 is for 78K0/DF2 only.

#### (f) TIOP00, TIOP10, TIOP20, TIOP30

These are the pins for external event count inputs, capture trigger inputs, external trigger inputs, and timer outputs (TMP0 to TMP3).

#### (g) INTP0, INTP2, INTP4, INTPR60, INTPR61<sup>Note</sup>

These are external interrupt request input pins for which the valid edge (rising edge, falling edge, or both rising and falling edges) can be specified.

Note INTPR61 is for 78K0/DF2 only.

#### (h) SEG20 to SEG23

These are the segment signal output pins for the LCD controller/driver.



## 2.2.3 P20 to P27 (port 2)

P20 to P27 function as an 8-bit I/O port in 78K0/DF2 and P20 to P23 function as a 4-bit I/O port in 78K0/DE2. These pins also function as pins for A/D converter analog input.

The following operation modes can be specified in 1-bit units.

## (1) Port mode

P20 to P27 function as an 8-bit I/O port in 78K0/DF2 and P20 to P23 function as a 4-bit I/O port in 78K0/DE2. These ports can be set to input or output in 1-bit units using port mode register 2 (PM2).

## (2) Control mode

P20 to P27 function as A/D converter analog input pins (ANI0 to ANI7 in 78K0/DF2, ANI0 to ANI3 in 78K0/DE2). When using these pins as analog input pins, see **11.6 (5) P20/ANI0 to P27/ANI7**.

Caution P20/ANI0 to P27/ANI7 are set in the analog input mode after release of reset.

## 2.2.4 P30 to P37 (port 3)

P30 to P37 function as an 8-bit I/O port. These pins also function as pins for segment signal outputs for the LCD controller/driver.

The following operation modes can be specified in 1-bit units.

#### (1) Port mode

P30 to P37 function as an 8-bit I/O port. P30 to P37 can be set to input or output in 1-bit units using port mode register 3 (PM3). Use of an on-chip pull-up resistor can be specified by pull-up resistor option register 3 (PU3).

## (2) Control mode

P30 to P37 function as segment signal outputs for the LCD controller/driver.

## (a) SEG4 to SEG11

These pins are the segment signal output pins for the LCD controller/driver.

#### Caution Be sure to pull the P31/SEG5/OCD1A pin down before a reset release, to prevent malfunction.

**Remark** P31/SEG5 and P32/SEG6 can be used as on-chip debug mode setting pins (OCD1A, OCD1B) when the on-chip debug function is used. For how to connect an in-circuit emulator supporting on-chip debugging (QB-MINI2), see **CHAPTER 27 ON-CHIP DEBUG FUNCTION**.



# 2.2.5 P60, P61 (port 6)

P60 and P61 function as a 2-bit I/O port. P60 and P61 can be set to input port or output port in 1-bit units using port mode register 6 (PM6). P60 and P61 use of an on-chip pull-up resistor can be specified by pull-up resistor option register 6 (PU6).

## (1) Port mode

P60 and P61 function as a 2-bit I/O port. P60 and P61 can be set to input or output in 1-bit units using port mode register 6 (PM6). Use of an on-chip pull-up resistor can be specified by pull-up resistor option register 6 (PU6).

## (2) Control mode

P60 and P61 function as serial clock I/O and data I/O for IICO.

#### (a) INTP1, INTP3

These are the external interrupt request input pins for which the valid edge (rising edge, falling edge, or both rising and falling edges) can be specified.

#### (b) SCL0

This is a serial clock I/O pin for serial interface IIC0.

#### (c) SDA0

This is a serial data I/O pin for serial interface IIC0.

## 2.2.6 P70 to P77 (port 7)

P70 to P73 function as a 4-bit I/O port in 78K0/DE2 and P70 to P77 function as an 8-bit I/O port in 78K0/DF2. These pins also function as output pins for the sound generator, clock output pins, buzzer output pins, CAN I/F I/O, serial interface data I/O and clock I/O, timer I/O, and segment output pins for the LCD controller/driver.

The following operation modes can be specified in 1-bit units.

#### (1) Port mode

P70 to P73 function as a 4-bit I/O port in 78K0/DE2 and P70 to P77 function as an 8-bit I/O port in 78K0/DF2. P70 to P77 can be set to input or output in 1-bit units using port mode register 7 (PM7). Use of an on-chip pull-up resistor can be specified by pull-up resistor option register 7 (PU7).

#### (2) Control mode

These pins function as output pins for the sound generator, clock output pins, buzzer output pins, CAN I/F I/O, serial interface data I/O and clock I/O, timer I/O, and segment output pins for the LCD controller/driver.

#### (a) SGOA

This is the amplitude PWM output pin for the sound generator.

#### (b) SGO

This is the output pin for the sound generator.

#### (c) SGOF

This is the frequency output pin for the sound generator.

#### (d) PCL

This is a clock output pin.



## (e) BUZ

This is a buzzer output pin.

## (f) RxD60

This is the serial data input pin of the asynchronous serial interface.

## (g) TxD60

This is the serial data output pin of the asynchronous serial interface.

## (h) INTPR60

This is an external interrupt request input pin for which the valid edge (rising edge, falling edge, or both rising and falling edges) can be specified.

- (i) CRxD (µPD78F0844, 78F0845, 78F0846, 78F0847, 78F0848, and 78F0849 only) This is the CAN serial receive data input pin.
- (j) CTxD (µPD78F0844, 78F0845, 78F0846, 78F0847, 78F0848, and 78F0849 only) This is the CAN serial transmit data output pin.
- (k) SCK11 (78K0/DF2 only) This is the serial interface serial clock I/O pin.
- (I) SI11 (78K0/DF2 only) This is a serial interface serial data input pin.
- (m) SO11 (78K0/DF2 only) This is a serial interface serial data output pin.

# (n) SSI11 (78K0/DF2 only)

This is the serial interface chip select input pin.

## (o) TIOP20 (78K0/DF2 only)

This is the pin for external event count input, capture trigger input, external trigger input, and timer output (TMP2).

(p) SEG24 to SEG27 (µPD78F0842, 78F0843, 78F0848, and 78F0849 only)

These pins are the segment signal output pins for the LCD controller/driver.



## 2.2.7 P80 to P87 (port 8)

P80 to P87 function as an 8-bit I/O port. These pins also function as stepper motor controller/driver outputs/inputs or LCD segment outputs.

The following operation modes can be specified in 1-bit units.

## (1) Port mode

P80 to P87 function as an 8-bit I/O port. P80 to P87 can be set to input or output in 1-bit units using port mode register 8 (PM8).

## (2) Control mode

P80 to P87 function as stepper motor controller/driver outputs/inputs or LCD segment outputs.

- (a) SEG24 to SEG31 (μPD78F0838, 78F0839, 78F0840, 78F0841, 78F0846, and 78F0847 only) These are the segment signal output pins for the LCD controller/driver.
- (b) SM11 to SM14, SM21 to SM24 (μPD78F0836, 78F0837, 78F0842, 78F0843, 78F0844, 78F0845, 78F0848, and 78F0849 only)

These are the output pins for the stepper motor controller/driver.

(c) ZPD14, ZPD24 (μPD78F0836, 78F0837, 78F0842, 78F0843, 78F0844, 78F0845, 78F0848, and 78F0849 only)

These are the Zero Point Detection (ZPD) input pins for the stepper motor controller/driver.

#### 2.2.8 P90 to P97 (port 9) (78K0/DF2 only)

P90 to P97 function as an 8-bit I/O port. These pins also function as stepper motor controller/driver outputs/inputs or LCD segment outputs.

The following operation modes can be specified in 1-bit units.

#### (1) Port mode

P90 to P97 function as an 8-bit I/O port. P90 to P97 can be set to input or output in 1-bit units using port mode register 9 (PM9).

#### (2) Control mode

P80 to P87 function as stepper motor controller/driver outputs/inputs or LCD segment outputs.

#### (a) SEG32 to SEG39 (µPD78F0838, 78F0839 only)

These are the segment signal output pins for the LCD controller/driver.

(b) SM31 to SM34, SM41 to SM44 (μPD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849 only)

These are the output pins for the stepper motor controller/driver.

(c) ZPD34, ZPD44 (μPD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849 only)

These are the Zero Point Detection (ZPD) input pins for the stepper motor controller/driver.

## 2.2.9 P120 to P124 (port 12)

P120 to P124 function as a 5-bit I/O port. These pins also function as external clock input for main system clock, external clock input for subsystem clock and potential input for external low-voltage detection. The following operation modes can be specified in 1-bit units.

## (1) Port mode

P120 to P124 function as a 5-bit I/O port. P120 to P124 can be set to input or output using port mode register 12 (PM12). Only for P120, use of an on-chip pull-up resistor can be specified by pull-up resistor option register 12 (PU12).

## (2) Control mode

P120 to P124 function as potential input for external low-voltage detection, resonator connection for main system clock, resonator connection for subsystem clock, external clock input for main system clock and external clock input for subsystem clock.

## (a) EXLVI

This is a potential input pin for external low-voltage detection.

## (b) X1, X2

These are the pins for connecting a resonator for high-speed system clock. When supplying an external clock, input a signal to the X1 pin and input the inverse signal to the X2 pin.

- Caution Connect P121/X1 as follows when writing the flash memory with a flash programmer.
   P121/X1: When using this pin as a port, connect it to Vss via a resistor (10 kΩ: recommended) (in the input mode) or leave it open (in the output mode).
   The above connection is not necessary when writing the flash memory by means of self programming.
- **Remark** The P121/X1 and P122/X2/EXCLK pins can be used as on-chip debug mode setting pins (OCD0A, OCD0B) when the on-chip debug function is used. For how to connect an in-circuit emulator supporting on-chip debugging (QB-MINI2), see **CHAPTER 27 ON-CHIP DEBUG FUNCTION**.

#### (c) EXCLK

This is an external clock input pin for main system clock.

#### (d) XT1, XT2

These are the pins for connecting a resonator for subsystem clock. When supplying an external clock, input a signal to the XT1 pin and input the inverse signal to the XT2 pin.

#### (e) EXCLKS

This is an external clock input pin for subsystem clock.

## 2.2.10 AVREF

This is the A/D converter reference voltage input pin. When the A/D converter is not used, connect this pin directly to  $V_{DD/E}V_{DD}$ .

#### 2.2.11 AVss

This is the A/D converter ground potential pin. Even when the A/D converter is not used, always use this pin with the same potential as the Vss/EVss pin.



## 2.2.12 RESET

This is the active-low system reset input pin.

## 2.2.13 REGC

This is the pin for connecting regulator output (2.5 V) stabilization capacitance for internal operation. Connect this pin to Vss via a capacitor (0.47 to 1  $\mu$ F: recommended).



#### Caution Keep the wiring length as short as possible for the broken-line part in the above figure.

#### 2.2.14 VDD/EVDD

 $V_{\text{DD}}$  is the positive power supply pin for other than ports.  $EV_{\text{DD}}$  is the positive power supply pin for ports.

#### 2.2.15 Vss/EVss

Vss is the ground potential pin for other than ports. EVss is the ground potential pin for ports.

#### 2.2.16 FLMD0

This is a pin for setting flash memory programming mode.

Connect to Vss/EVss in the normal operation mode. In flash memory programming mode, be sure to connect this pin to the flash memory programmer.

## 2.2.17 SEG0 to SEG3

These are the segment signal output pins for the LCD controller/driver.

#### 2.2.18 COM0 to COM3

These are the common signal output pins for the LCD controller/driver.

#### 2.2.19 SMVDD

This is the power supply voltage pin for the stepper motor controller/driver.

#### 2.2.20 SMVss

This is the ground pin for the stepper motor controller/driver.



# 2.3 Pin I/O Circuits and Recommended Connection of Unused Pins

The following table shows the types of pin I/O circuits and the recommended connections of unused pins. Refer to **Figure 2-1 Pin I/O Circuit List** for the configuration of the I/O circuit of each type.

Pin Name	I/O Circuit Type	I/O		Recommended Connection of Unused Pins
P00/SEG12/TIOP40	17-W	I/O	Input:	Independently connect to Vss via a resistor.
P01/SEG13/TIOP41			Output:	Leave open.
P02/SEG14/TIO50				
P03/SEG15/TIO51				
P04/SEG16/TIOP01				
P05/SEG17/TIOP11				
P06/SEG18/TIOP21				
P07/SEG19/TIOP31				
P10/SCK10/INTP4	5-AW			
P11/SI10				
P12/SO10/INTP2				
P13/SEG23/TIOP30/TxD60	17-W			
P14/SEG22/TIOP20/RxD60/INTPR60				
P15/SEG21/TIOP10				
P16/SEG20/TIOP00				
P17/INTP0/ <tiop30></tiop30>	5-AW			
P20/ANI0 to P23/ANI3 <sup>Note 1</sup>	11-G	I/O	Input:	Independently connect to $V_{\text{DD}}$ or $V_{\text{SS}}$ via a resistor.
			Output:	Leave open.
P30/SEG4	17-V	I/O	Input:	Independently connect to Vss via a resistor.
P31/SEG5/OCD1A <sup>Note 2</sup>	17-W		Output:	Leave open.
P32/SEG6/OCD1B <sup>Note 2</sup>				
P33/SEG7 to P35/SEG9				
P36/SEG10	17-V			
P37/SEG11	17-W			

# Table 2-6. Pin I/O Circuit Types (1/8) (a) 78K0/DE2 (μPD78F0836, 78F0837, 78F0844, 78F0845) (1/2)

Notes 1. P20/ANI0 to P27/ANI3 are set in the analog input mode after release of reset.

 Use the recommended connection above in I/O port mode (see Figure 5-5 Format of Clock Operation Mode Select Register (OSCCTL)) when these pins are not used.



# Table 2-6. Pin I/O Circuit Types (2/8) (a) 78K0/DE2 (μPD78F0836, 78F0837, 78F0844, 78F0845) (2/2)

Pin Name	I/O Circuit Type	I/O	Recommended Connection of Unused Pins
P60/SCL0/INTP1	5-AH	I/O	Input: Independently connect to VDD or Vss via a resistor.
P61/SDA0/INTP3			Output: Leave open.
P70/CRxD <sup>Note 1</sup> / <rxd60 intpr60=""></rxd60>	5-AH	I/O	Input: Independently connect to VDD or Vss via a resistor.
P71/CTxD <sup>Note 1</sup> / <txd60></txd60>	5-AG		Output: Leave open.
P72/SGOA/PCL			
P73/SGO/SGOF/BUZ			
P80/SM11 to P82/SM13	5-AU	I/O	Input: Independently connect to SMVss via a resistor.
P83/SM14/ZPD14	5-AX		Output: Leave open.
P84/SM21 to P86/SM23	5-AU		
P87/SM24/ZPD24	5-AX		
P120/EXLVI	5-AH	I/O	Input: Independently connect to VDD or Vss via a resistor.
P121/X1/OCD0A <sup>Note 2, 3</sup>	37-D		Output: Leave open.
P122/X2/EXCLK/OCD0B <sup>Note 2</sup>			
P123/XT1 <sup>Note 2</sup>			
P124/XT2/EXCLKS <sup>Note 2</sup>			
SEG0 to SEG3	17-U	Output	Leave open.
COM0 to COM3	18-G		
RESET	2	Input	-
AVREF	-	-	Connect directly to VDD.
AVss	-	-	Connect directly to Vss.
SMVDD	-	-	Connect directly to VDD.
SMVss	_	_	Connect directly to Vss.
FLMD0	38	Input	Connect directly to Vss.

**Notes 1.** *μ*PD78F0844 and 78F0845 only.

- Use the recommended connection above in I/O port mode (see Figure 5-5 Format of Clock Operation Mode Select Register (OSCCTL)) when these pins are not used.
- Connect P121/X1 as follows when writing the flash memory with a flash memory programmer.
   P121/X1: When using this pin as a port, connect it to EVss via a resistor (10 kΩ: recommended) (in the input mode) or leave it open (in the output mode).

The above connection is not necessary when writing the flash memory by means of self programming.



# Table 2-6. Pin I/O Circuit Types (3/8) (b) 78K0/DF2 (μPD78F0838, 78F0839) (1/2)

Pin Name	I/O Circuit Type	I/O		Recommended Connection of Unused Pins
P00/SEG12/TIOP40	17-W	I/O	Input:	Independently connect to Vss via a resistor.
P01/SEG13/TIOP41			Output:	Leave open.
P02/SEG14/TIO50				
P03/SEG15/TIO51				
P04/SEG16/TIOP01				
P05/SEG17/TIOP11				
P06/SEG18/TIOP21				
P07/SEG19/TIOP31				
P10/SCK10/TxD61/INTP4	5-AH			
P11/SI10/RxD61/INTPR61				
P12/SO10/INTP2				
P13/SEG23/TIOP30/TxD60	17-W			
P14/SEG22/TIOP20/RxD60/INTPR60				
P15/SEG21/TIOP10				
P16/SEG20/TIOP00				
P17/INTP0/ <tiop30></tiop30>	5-AH			
P20/ANI0 to P27/ANI7 <sup>Note 1</sup>	11-G	I/O	Input:	Independently connect to $V_{\text{DD}}$ or $V_{\text{SS}}$ via a resistor.
			Output:	Leave open.
P30/SEG4	17-V	I/O	Input:	Independently connect to Vss via a resistor.
P31/SEG5/OCD1A <sup>Note 2</sup>	17-W		Output:	Leave open.
P32/SEG6/OCD1B <sup>Note 2</sup>				
P33/SEG7 to P35/SEG9				
P36/SEG10	17-V			
P37/SEG11	17-W			
P60/SCL0/INTP1	5-AH	I/O	Input:	Independently connect to $V_{DD}$ or $V_{SS}$ via a resistor.
P61/SDA0/INTP3			Output:	Leave open.

Notes 1. P20/ANI0 to P27/ANI7 are set in the analog input mode after release of reset.

 Use the recommended connection above in I/O port mode (see Figure 5-5 Format of Clock Operation Mode Select Register (OSCCTL)) when these pins are not used.



# Table 2-6. Pin I/O Circuit Types (4/8) (b) 78K0/DF2 (μPD78F0838, 78F0839) (2/2)

Pin Name	I/O Circuit Type	I/O	Recommended Connection of Unused Pins
P70/ <rxd60 intpr60=""></rxd60>	5-AH	I/O	Input: Independently connect to Vss via a resistor.
P71/ <txd60></txd60>	5-AG		Output: Leave open.
P72/SGOA/PCL			
P73/SGO/SGOF/BUZ			
P74/SCK11	5-AW		
P75/SI11			
P76/SO11	5-AU		
P77/SSI11/ <tiop20></tiop20>	5-AW		
P80/SEG24 to P87/SEG31	17-X	I/O	Input: Independently connect to SMVss via a resistor.
P90/SEG32 to P93/SEG35	17-W		Output: Leave open.
P94/SEG36 to P97/SEG39	17-X		
P120/EXLVI	5-AH	I/O	Input: Independently connect to $V_{DD}$ or $V_{SS}$ via a resistor.
P121/X1/OCD0A <sup>Note 1, 2</sup>	37-D		Output: Leave open.
P122/X2/EXCLK/OCD0B <sup>Note 1</sup>			
P123/XT1 <sup>Note 1</sup>			
P124/XT2/EXCLKS <sup>Note 1</sup>			
SEG0 to SEG3	17-U	Output	Leave open.
COM0 to COM3	18-G		
RESET	2	Input	_
AV <sub>REF</sub>	-	-	Connect directly to VDD.
AVss	-	-	Connect directly to Vss.
SMVDD	-	-	Connect directly to VDD.
SMVss	-	-	Connect directly to Vss.
FLMD0	38	Input	Connect directly to Vss.

Notes 1. Use the recommended connection above in I/O port mode (see Figure 5-5 Format of Clock Operation Mode Select Register (OSCCTL)) when these pins are not used.

Connect P121/X1 as follows when writing the flash memory with a flash memory programmer.
P121/X1: When using this pin as a port, connect it to Vss via a resistor (10 kΩ: recommended) (in the input mode) or leave it open (in the output mode).

The above connection is not necessary when writing the flash memory by means of self programming.



Table 2-6. Pin I/O Circuit Types (5/8)
(c) 78K0/DF2 (µPD78F0840, 78F0841, 78F0846, 78F0847) (1/2)

Pin Name	I/O Circuit Type	I/O		Recommended Connection of Unused Pins
P00/SEG12/TIOP40	17-W	I/O	Input:	Independently connect to Vss via a resistor.
P01/SEG13/TIOP41			Output:	Leave open.
P02/SEG14/TIO50				
P03/SEG15/TIO51				
P04/SEG16/TIOP01				
P05/SEG17/TIOP11				
P06/SEG18/TIOP21				
P07/SEG19/TIOP31				
P10/SCK10/TxD61/INTP4	5-AH			
P11/SI10/RxD61/INTPR61				
P12/SO10/INTP2				
P13/SEG23/TIOP30/TxD60	17-W			
P14/SEG22/TIOP20/RxD60/INTPR60				
P15/SEG21/TIOP10				
P16/SEG20/TIOP00				
P17/INTP0/ <tiop30></tiop30>	5-AH			
P20/ANI0 to P27/ANI7 <sup>Note 1</sup>	11-G	I/O	Input:	Independently connect to $V_{\text{DD}}$ or $V_{\text{SS}}$ via a resistor.
			Output:	Leave open.
P30/SEG4	17-V	I/O	Input:	Independently connect to Vss via a resistor.
P31/SEG5/OCD1A <sup>Note 2</sup>	17-W		Output:	Leave open.
P32/SEG6/OCD1B <sup>Note 2</sup>				
P33/SEG7 to P35/SEG9				
P36/SEG10	17-V			
P37/SEG11	17-W			
P60/SCL0/INTP1	5-AH	I/O	Input:	Independently connect to $V_{\text{DD}}$ or $V_{\text{SS}}$ via a resistor.
P61/SDA0/INTP3			Output:	Leave these pins open after clearing the output latch of the port to "0".

Notes 1. P20/ANI0 to P27/ANI7 are set in the analog input mode after release of reset.

2. Use the recommended connection above in I/O port mode (see Figure 5-5 Format of Clock Operation Mode Select Register (OSCCTL)) when these pins are not used.



# Table 2-6. Pin I/O Circuit Types (6/8) (c) 78K0/DF2 (μPD78F0840, 78F0841, 78F0846, 78F0847) (2/2)

Pin Name	I/O Circuit Type	I/O	Recommended Connection of Unused Pins
P70/CRxD <sup>Note 1</sup> / <rxd60 intpr60=""></rxd60>	5-AH	I/O	Input: Independently connect to Vss via a resistor.
P71/CTxD <sup>Note 1</sup> / <txd60></txd60>	5-AG		Output: Leave open.
P72/SGOA/PCL			
P73/SGO/SGOF/BUZ			
P74/SCK11	5-AW		
P75/SI11			
P76/SO11	5-AU		
P77/SSI11/ <tiop20></tiop20>	5-AW		
P80/SEG24 to P87/SEG31	17-X	I/O	Input: Independently connect to SMVss via a resistor.
P90/SM31 to P92/SM33	5-AW		Output: Leave open.
P93/SM34/ZPD34	5-AV		
P94/SM41 to P96/SM43	5-AU		
P97/SM44/ZPD44	5-AX		
P120/EXLVI	5-AH	I/O	Input: Independently connect to VDD or VSS via a resistor.
P121/X1/OCD0A <sup>Note 2, 3</sup>	37-D		Output: Leave open.
P122/X2/EXCLK/OCD0B <sup>Note 2</sup>			
P123/XT1 <sup>Note 2</sup>			
P124/XT2/EXCLKS <sup>Note 2</sup>			
SEG0 to SEG3	17-U	Output	Leave open.
COM0 to COM3	18-G		
RESET	2	Input	_
AVREF	_	-	Connect directly to VDD.
AVss	-	-	Connect directly to Vss.
SMVDD	_	-	Connect directly to VDD.
SMVss	_	_	Connect directly to Vss.
FLMD0	38	Input	Connect directly to Vss.

**Notes 1.** *μ*PD78F0846 and 78F0847 only.

- 2. Use the recommended connection above in I/O port mode (see Figure 5-5 Format of Clock Operation Mode Select Register (OSCCTL)) when these pins are not used.
- Connect P121/X1 as follows when writing the flash memory with a flash memory programmer.
   P121/X1: When using this pin as a port, connect it to Vss via a resistor (10 kΩ: recommended) (in the input mode) or leave it open (in the output mode).
   The above connection is not necessary when writing the flash memory by means of self programming.



Table 2-6. Pin I/O Circuit Types (7/8)
(d) 78K0/DF2 (µPD78F0842, 78F0843, 78F0848, 78F0849) (1/2)

Pin Name	I/O Circuit Type	I/O		Recommended Connection of Unused Pins
P00/SEG12/TIOP40	17-W	I/O	Input:	Independently connect to Vss via a resistor.
P01/SEG13/TIOP41			Output:	Leave open.
P02/SEG14/TIO50				
P03/SEG15/TIO51				
P04/SEG16/TIOP01				
P05/SEG17/TIOP11				
P06/SEG18/TIOP21				
P07/SEG19/TIOP31				
P10/SCK10/TxD61/INTP4	5-AH			
P11/SI10/RxD61/INTPR61				
P12/SO10/INTP2				
P13/SEG23/TIOP30/TxD60	17-W			
P14/SEG22/TIOP20/RxD60/INTPR60				
P15/SEG21/TIOP10				
P16/SEG20/TIOP00				
P17/INTP0/ <tiop30></tiop30>	5-AH			
P20/ANI0 to P27/ANI7 <sup>Note 1</sup>	11-G	I/O	Input:	Independently connect to $V_{\text{DD}}$ or $V_{\text{SS}}$ via a resistor.
			Output:	Leave open.
P30/SEG4	17-V	I/O	Input:	Independently connect to Vss via a resistor.
P31/SEG5/OCD1A <sup>Note 2</sup>	17-W		Output:	Leave open.
P32/SEG6/OCD1B <sup>Note 2</sup>				
P33/SEG7 to P35/SEG9				
P36/SEG10	17-V			
P37/SEG11	17-W			
P60/SCL0/INTP1	5-AH	I/O	Input:	Independently connect to $V_{\text{DD}}$ or $V_{\text{SS}}$ via a resistor.
P61/SDA0/INTP3			Output:	Leave these pins open after clearing the output latch of the port to "0".

Notes 1. P20/ANI0 to P27/ANI7 are set in the analog input mode after release of reset.

2. Use the recommended connection above in I/O port mode (see Figure 5-5 Format of Clock Operation Mode Select Register (OSCCTL)) when these pins are not used.



# Table 2-6. Pin I/O Circuit Types (8/8) (d) 78K0/DF2 (μPD78F0842, 78F0843, 78F0848, 78F0849) (2/2)

Pin Name	I/O Circuit Type	I/O	Recommended Connection of Unused Pins
P70/CRxD <sup>Note 1</sup> / <rxd60 intpr60=""></rxd60>	5-AH	I/O	Input: Independently connect to Vss via a resistor.
P71/CTxD <sup>Note 1</sup> / <txd60></txd60>	5-AG		Output: Leave open.
P72/SGOA/PCL			
P73/SGO/SGOF/BUZ			
P74/SEG24/SCK11	17-W		
P75/SEG25/SI11			
P76/SEG26/SO11	17-V		
P77/SEG27/SSI11/ <tiop20></tiop20>	17-W		
P80/SM11 to P82/SM13	5-AU	I/O	Input: Independently connect to SMVss via a resistor.
P83/SM14/ZPD14	5-AX		Output: Leave open.
P84/SM21 to P86/SM23	5-AU		
P87/SM24/ZPD24	5-AX		
P90/SM31 to P92/SM33	5-AW		
P93/SM34/ZPD34	5-AV		
P94/SM41 to P96/SM43	5-AU		
P97/SM44/ZPD44	5-AX		
P120/EXLVI	5-AH	I/O	Input: Independently connect to VDD or Vss via a resistor.
P121/X1/OCD0A <sup>Note 2, 3</sup>	37-D		Output: Leave open.
P122/X2/EXCLK/OCD0B <sup>Note 2</sup>			
P123/XT1 <sup>Note 2</sup>	]		
P124/XT2/EXCLKS <sup>Note 2</sup>			
SEG0 to SEG3	17-U	Output	Leave open.
COM0 to COM3	18-G		
RESET	2	Input	_
AVREF	-	-	Connect directly to VDD.
AVss	-	-	Connect directly to Vss.
SMVDD	_	_	Connect directly to VDD.
SMVss	-	-	Connect directly to Vss.
FLMD0	38	Input	Connect directly to Vss.

**Notes 1.** *μ*PD78F0848, and 78F0849 only.

- Use the recommended connection above in I/O port mode (see Figure 5-5 Format of Clock Operation Mode Select Register (OSCCTL)) when these pins are not used.
- Connect P121/X1 as follows when writing the flash memory with a flash memory programmer.
   P121/X1: When using this pin as a port, connect it to Vss via a resistor (10 kΩ: recommended) (in the input mode) or leave it open (in the output mode).
   The above connection is not necessary when writing the flash memory by means of self programming.



Figure 2-1. Pin I/O Circuit List (1/5)







Figure 2-1. Pin I/O Circuit List (2/5)











Figure 2-1. Pin I/O Circuit List (4/5)





Figure 2-1. Pin I/O Circuit List (5/5)


## CHAPTER 3 CPU ARCHITECTURE

#### 3.1 Memory Space

Products in the 78K0/Dx2 can each access a 24, 32, 48, or 64 KB memory space. **Figures 3-1** to **3-4** show the memory maps.

- Cautions 1. Regardless of the internal memory capacity, the initial values of the internal memory size switching register (IMS) and internal expansion RAM size switching register (IXS) of the 78K0/Dx2 is fixed (IMS = CFH, IXS = 0CH). Therefore, set the value corresponding to each product as indicated below.
  - 2. To set the memory size, set IMS and then IXS. Set the memory size so that the internal ROM and internal expansion RAM areas do not overlap.

 Table 3-1. Set Values of Internal Memory Size Switching Register (IMS)

 and Internal Expansion RAM Size Switching Register (IXS)

Fla	sh Memory Version	IMS	IXS
78K0/DE2	78K0/DF2		
μPD78F0836	μPD78F0838, 78F0840, 78F0842	C6H	0AH
μPD78F0844	μPD78F0846, 78F0848	C8H	
μPD78F0837	μPD78F0839, 78F0841, 78F0843	ССН	08H
μPD78F0845	μPD78F0847, 78F0849	CFH	





Figure 3-1. Memory Map (µPD78F0836, 78F0838, 78F0840, 78F0842)

- **2.** During on-chip debugging, use of this area is disabled since it is used as the communication command area (269 bytes).
- 3. When boot swap is not used:Set the option bytes to 0080H to 0084H.When boot swap is used:Set the option bytes to 0080H to 0084H and 1080H to 1084H.
- 4. Writing boot cluster 0 can be prohibited depending on the setting of security (see 26.8 Security Settings).



Figure 3-2. Memory Map (µPD78F0844, 78F0846, 78F0848)

- **2.** During on-chip debugging, use of this area is disabled since it is used as the communication command area (269 bytes).
- When boot swap is not used: Set the option bytes to 0080H to 0084H.
   When boot swap is used: Set the option bytes to 0080H to 0084H and 1080H to 1084H.
- 4. Writing boot cluster 0 can be prohibited depending on the setting of security (see 26.8 Security Settings).





- **2.** During on-chip debugging, use of this area is disabled since it is used as the communication command area (269 bytes).
- When boot swap is not used: Set the option bytes to 0080H to 0084H.
   When boot swap is used: Set the option bytes to 0080H to 0084H and 1080H to 1084H.
- 4. Writing boot cluster 0 can be prohibited depending on the setting of security (see 26.8 Security Settings).



Figure 3-4. Memory Map (µPD78F0845, 78F0847, 78F0849)

- **2.** During on-chip debugging, use of this area is disabled since it is used as the communication command area (269 bytes).
- When boot swap is not used: Set the option bytes to 0080H to 0084H.
   When boot swap is used: Set the option bytes to 0080H to 0084H and 1080H to 1084H.
- 4. Writing boot cluster 0 can be prohibited depending on the setting of security (see 26.8 Security Settings).

## 78K0/Dx2

**Remark** The flash memory is divided into blocks (one block = 1 KB). For correspondence between the address values and block numbers in the flash memory, see the following table.



## Table 3-2. Correspondence between Address Values and Block Numbers in Flash Memory

Address Value	Block Number						
0000H to 03FFH	00H	4000H to 43FFH	10H	8000H to 83FFH	20H	C000H to C3FFH	30H
0400H to 07FFH	01H	4400H to 47FFH	11H	8400H to 87FFH	21H	C400H to C7FFH	31H
0800H to 0BFFH	02H	4800H to 4BFFH	12H	8800H to 8BFFH	22H	C800H to CBFFH	32H
0C00H to 0FFFH	03H	4C00H to 4FFFH	13H	8C00H to 8FFFH	23H	CC00H to CFFFH	33H
1000H to 13FFH	04H	5000H to 53FFH	14H	9000H to 93FFH	24H	D000H to D3FFH	34H
1400H to 17FFH	05H	5400H to 57FFH	15H	9400H to 97FFH	25H	D400H to D7FFH	35H
1800H to 1BFFH	06H	5800H to 5BFFH	16H	9800H to 9BFFH	26H	D800H to DBFFH	36H
1C00H to 1FFFH	07H	5C00H to 5FFFH	17H	9C00H to 9FFFH	27H	DC00H to DFFFH	37H
2000H to 23FFH	08H	6000H to 63FFH	18H	A000H to A3FFH	28H	E000H to E3FFH	38H
2400H to 27FFH	09H	6400H to 67FFH	19H	A400H to A7FFH	29H	E400H to E7FFH	39H
2800H to 2BFFH	0AH	6800H to 6BFFH	1AH	A800H to ABFFH	2AH	E800H to EBFFH	ЗАН
2C00H to 2FFFH	0BH	6C00H to 6FFFH	1BH	AC00H to AFFFH	2BH	EC00H to EFFFH	3BH
3000H to 33FFH	0CH	7000H to 73FFH	1CH	B000H to B3FFH	2CH		
3400H to 37FFH	0DH	7400H to 77FFH	1DH	B400H to B7FFH	2DH		
3800H to 3BFFH	0EH	7800H to 7BFFH	1EH	B800H to BBFFH	2EH		
3C00H to 3FFFH	0FH	7C00H to 7FFFH	1FH	BC00H to BFFFH	2FH		



### 3.1.1 Internal program memory space

The internal program memory space stores the program and table data. Normally, it is addressed with the program counter (PC).

78K0/Dx2 products incorporate internal ROM (flash memory), as shown below.

	Part Number		Internal ROM
78K0/DE2	78K0/DF2	Structure	Capacity
μPD78F0836	μPD78F0838, 78F0840, 78F0842	Flash memory	24576 $\times$ 8 bits (0000H to 5FFFH)
μPD78F0837	μPD78F0839, 78F0841, 78F0843		49152 $\times$ 8 bits (0000H to BFFFH)
μPD78F0844	μPD78F0846, 78F0848		32768 $\times$ 8 bits (0000H to 7FFFH)
μPD78F0845	μPD78F0847, 78F0849		61440 $\times$ 8 bits (0000H to EFFFH)

#### Table 3-3. Internal ROM Capacity

The internal program memory space is divided into the following areas.

#### (1) Vector code area

The 64-byte area 0000H to 003FH is reserved as a Vector code area. The program start addresses for branch upon reset signal input or generation of each interrupt request are stored in the Vector code area. Of the 16-bit address, the lower 8 bits are stored at even addresses and the higher 8 bits are stored at odd addresses.

Vector Code Address	Interrupt Source	Vector Code Address	Interrupt Source
0000H	RESET input, POC, LVI, WDT	0020H	INTP2/INTCSI10
0002H	INTCK2	0022H <sup>Note2</sup>	INTPR61
0004H	INTLVI	0024H <sup>Note2</sup>	INTSR61
0006H	INTP0	0026H <sup>Note2</sup>	INTST61
0008H	INTP1/INTIIC0	0028H <sup>Note2</sup>	INTCSI11
000AH	INTP3/INTP4	002AH	INTTM50/INTTP2OV
000CH	INTTP0CC0	002CH	INTTP2CC0
000EH	INTTP0CC1	002EH	INTTP2CC1
0010H	INTTP1CC0	0030H	INTAD
0012H	INTTP1CC1	0032H	INTWT/INTWTI
0014H <sup>Note1</sup>	INTC0ERR/INTC0WUP	0034H	INTTM51/INTTP3OV
0016H <sup>Note1</sup>	INTCOREC	0036H	INTTP3CC0
0018H <sup>Note1</sup>	INTCOTRX	0038H	INTTP3CC1
001AH	INTPR60	003AH	INTTP4CC0
001CH	INTSR60	003CH	INTTP4CC1
001EH	INTST60	003EH	BRK

#### Table 3-4. Vector Code

**Notes 1.** μPD78F0844, 78F0845, 78F0846, 78F0847, 78F0848, 78F0849 only.

2. 78K0/DF2 only.



#### (2) CALLT instruction table area

The 64-byte area 0040H to 007FH can store the subroutine entry address of a 1-byte call instruction (CALLT).

#### (3) Option byte area

The option byte area is assigned to the 1-byte area of 0080H. Refer to CHAPTER 25 OPTION BYTE for details.

#### (4) CALLF instruction entry area

The area 0800H to 0FFFH can perform a direct subroutine call with a 2-byte call instruction (CALLF).

#### (5) On-chip debug security ID setting area

A 10-byte area of 0085H to 008EH and 1085H to 108EH can be used as an on-chip debug security ID setting area. Set the on-chip debug security ID of 10 bytes at 0085H to 008EH when the boot swap is not used and at 0085H to 008EH and 1085H to 108EH when the boot swap is used. For details, see CHAPTER 27 ON-CHIP **DEBUG FUNCTION.** 

#### 3.1.2 Internal data memory space

78K0/Dx2 products incorporate the following RAM.

#### (1) Internal high-speed RAM

	Part Number	Internal High-Speed RAM
78K0/DE2	78K0/DF2	
μPD78F0836	μPD78F0838, 78F0840, 78F0842	1024 × 8 bits (FB00H to FEFFH)
μPD78F0837	μPD78F0839, 78F0841, 78F0843	
μPD78F0844	μPD78F0846, 78F0848	
μPD78F0845	μPD78F0847, 78F0849	

#### Table 3-5. Internal High-Speed RAM Capacity

The 32-byte area FEE0H to FEFFH is assigned to four general-purpose register banks consisting of eight 8-bit registers per one bank.

This area cannot be used as a program area in which instructions are written and executed.

The internal high-speed RAM can also be used as a stack memory.

#### (2) Internal expansion RAM

Table 3-6.	Internal	Expansion	RAM	Capacity
------------	----------	-----------	-----	----------

Part	Number	Internal Expansion RAM
78K0/DE2	78K0/DF2	
μPD78F0836, 78F0844	μPD78F0838, 78F0840, 78F0842, 78F0846, 78F0848	1024 $\times$ 8 bits (F400H to F7FFH)
μPD78F0837, 78F0845	μΡD78F0839, 78F0841, 78F0843, 78F0847, 78F0849	2048 × 8 bits (F000H to F7FFH)

The internal expansion RAM can also be used as a normal data area similar to the internal high-speed RAM, as well as a program area in which instructions can be written and executed.

The internal expansion RAM cannot be used as a stack memory.



#### 3.1.3 Special function register (SFR) area

On-chip peripheral hardware special function registers (SFRs) are allocated in the area FF00H to FFFFH (refer to **Table 3-7. Special Function Register List**).

#### Caution Do not access addresses to which SFRs are not assigned.

#### 3.1.4 Extended function register (EFR) area

On-chip peripheral hardware extended function registers (EFRs) are allocated in the area F980H to F9CFH and F9F8H to F9FFH (refer to **Table 3-8. Extended Function Register List**).

#### Caution Do not access addresses to which EFRs are not assigned.

- **Remark** The following methods are available to specify the EFRs to undergo manipulation during instruction execution.
  - 1. Direct addressing
  - 2. Register indirect addressing
  - 3. Based addressing
  - 4. Based indexed addressing

#### 3.1.5 Data memory addressing

Addressing refers to the method of specifying the address of the instruction to be executed next or the address of the register or memory relevant to the execution of instructions.

Several addressing modes are provided for addressing the memory relevant to the execution of instructions for the 78K0/Dx2, based on operability and other considerations. For areas containing data memory in particular, special addressing methods designed for the functions of special function registers (SFR) and general-purpose registers are available for use. **Figure 3-5** to **3-8** show correspondence between data memory and addressing. For details of each addressing mode, refer to **3.4 Operand Address Addressing**.





# Figure 3-5. Correspondence between Data Memory and Addressing (µPD78F0836, 78F0838, 78F0840, 78F0842)

- **Notes 1.** During on-chip debugging, use of this area is disabled since it is used as the user data backup area for communication.
  - **2.** During on-chip debugging, use of this area is disabled since it is used as the communication command area (269 bytes).

RENESAS



#### Figure 3-6. Correspondence between Data Memory and Addressing (µPD78F0844, 78F0846, 78F0848)

- **Notes 1.** During on-chip debugging, use of this area is disabled since it is used as the user data backup area for communication.
  - 2. During on-chip debugging, use of this area is disabled since it is used as the communication command area (269 bytes).



# Figure 3-7. Correspondence between Data Memory and Addressing (µPD78F0837, 78F0839, 78F0841, 78F0843)

- **Notes 1.** During on-chip debugging, use of this area is disabled since it is used as the user data backup area for communication.
  - **2.** During on-chip debugging, use of this area is disabled since it is used as the communication command area (269 bytes).

RENESAS



#### Figure 3-8. Correspondence between Data Memory and Addressing (µPD78F0845, 78F0847, 78F0849)

- **Notes 1.** During on-chip debugging, use of this area is disabled since it is used as the user data backup area for communication.
  - **2.** During on-chip debugging, use of this area is disabled since it is used as the communication command area (269 bytes).

## 3.2 Processor Registers

78K0/Dx2 products incorporate the following processor registers.

#### 3.2.1 Control registers

The control registers control the program sequence, statuses and stack memory. The control registers consist of a program counter (PC), a program status word (PSW) and a stack pointer (SP).

#### (1) Program counter (PC)

counter.

The program counter is a 16-bit register that holds the address information of the next program to be executed. In normal operation, the PC is automatically incremented according to the number of bytes of the instruction to be fetched. When a branch instruction is executed, immediate data and register contents are set. Reset signal generation sets the reset Vector code values at addresses 0000H and 0001H to the program

#### Figure 3-9. Format of Program Counter



#### (2) Program status word (PSW)

The program status word is an 8-bit register consisting of various flags set/reset by instruction execution. Program status word contents are automatically stacked upon interrupt request generation or PUSH PSW instruction execution and are restored upon execution of the RETB, RETI and POP PSW instructions. Reset signal sets the PSW to 02H.

#### Figure 3-10. Format of Program Status Word



## (a) Interrupt enable flag (IE)

This flag controls the interrupt request acknowledge operations of the CPU.

When 0, the IE flag is set to the interrupt disabled (DI) state, and all maskable interrupt requests are disabled. Other interrupt requests are all disabled.

When 1, the IE flag is set to the interrupt enabled (EI) state and interrupt request acknowledgement is controlled with an in-service priority flag (ISP), an interrupt mask flag for various interrupt sources, and a priority specification flag.

The IE flag is reset (0) upon DI instruction execution or interrupt acknowledgement and is set (1) upon EI instruction execution.

## (b) Zero flag (Z)

When the operation result is zero, this flag is set (1). It is reset (0) in all other cases.



#### (c) Register bank select flags (RBS0 and RBS1)

These are 2-bit flags to select one of the four register banks. In these flags, the 2-bit information that indicates the register bank selected by SEL RBn instruction

#### (d) Auxiliary carry flag (AC)

execution is stored.

If the operation result has a carry from bit 3 or a borrow at bit 3, this flag is set (1). It is reset (0) in all other cases.

#### (e) In-service priority flag (ISP)

This flag manages the priority of acknowledgeable maskable vectored interrupts. When this flag is 0, low-level vectored interrupt requests specified by a priority specification flag register (PR0L, PR0H, PR1L, PR1H) (refer to **19.3 (3) Priority specification flag registers (PR0L, PR0H, PR1L, PR1H)**) can not be acknowledged. Actual request acknowledgement is controlled by the interrupt enable flag (IE).

#### (f) Carry flag (CY)

This flag stores overflow and underflow upon add/subtract instruction execution. It stores the shift-out value upon rotate instruction execution and functions as a bit accumulator during bit operation instruction execution.

#### (3) Stack pointer (SP)

This is a 16-bit register to hold the start address of the memory stack area. Only the internal high-speed RAM area can be set as the stack area.

#### Figure 3-11. Format of Stack Pointer



The SP is decremented ahead of write (save) to the stack memory and is incremented after read (restored) from the stack memory.

Each stack operation saves/restores data as shown in Figures 3-12 and 3-13.

## Caution Since rest signal generation makes the SP contents undefined, be sure to initialize the SP before using the stack.



## Figure 3-12. Data to Be Saved to Stack Memory

## (a) PUSH rp instruction (when SP = FEE0H)



## (b) CALL, CALLF, CALLT instructions (when SP = FEE0H)



#### (c) Interrupt, BRK instructions (when SP = FEE0H)





## Figure 3-13. Data to Be Restored from Stack Memory

## (a) POP rp instruction (when SP = FEDEH)



## (b) RET instruction (when SP = FEDEH)



## (c) RETI, RETB instructions (when SP = FEDDH)





## 3.2.2 General-purpose registers

General-purpose registers are mapped at particular addresses (FEE0H to FEFFH) of the data memory. The general-purpose registers consists of 4 banks, each bank consisting of eight 8-bit registers (X, A, C, B, E, D, L, and H).

Each register can be used as an 8-bit register, and two 8-bit registers can also be used in a pair as a 16-bit register (AX, BC, DE, and HL).

These registers can be described in terms of function names (X, A, C, B, E, D, L, H, AX, BC, DE, and HL) and absolute names (R0 to R7 and RP0 to RP3).

Register banks to be used for instruction execution are set by the CPU control instruction (SEL RBn). Because of the 4-register bank configuration, an efficient program can be created by switching between a register for normal processing and a register for interrupts for each bank.

## Figure 3-14. Configuration of General-Purpose Registers



#### (a) Absolute name

#### (b) Function name





## 3.2.3 Special Function Registers (SFRs)

Unlike a general-purpose register, each special function register has a special function. SFRs are allocated to the FF00H to FFFFH area.

Special function registers can be manipulated like general-purpose registers, using operation, transfer and bit manipulation instructions. The manipulatable bit units, 1, 8, and 16, depend on the special function register type.

Each manipulation bit unit can be specified as follows.

• 1-bit manipulation

Specify the symbol reserved by the assembler for the 1-bit manipulation instruction operand (sfr.bit). This manipulation can also be specified with an address.

• 8-bit manipulation

Specify the symbol reserved by the assembler for the 8-bit manipulation instruction operand (sfr). This manipulation can also be specified with an address.

• 16-bit manipulation

Specify the symbol reserved by the assembler for the 16-bit manipulation instruction operand (sfrp). When specifying an address, describe an even address.

 Table 3-7. Special Function Register List gives a list of the special function registers. The meanings of items in the table are as follows.

Symbol

Symbol indicating the address of a special function register. It is a reserved word in the RA78K0, and is defined by the header file "sfrbit.h" in the CC78K0. When using the RA78K0, ID78K0-NS, ID78K0, or SM78K0, symbols can be written as an instruction operand.

• R/W

Indicates whether the corresponding special function register can be read or written.

- R/W: Read/write enable
- R: Read only
- W: Write only
- Manipulatable bit units

Indicates the manipulatable bit unit (1, 8, or 16). "-" indicates a bit unit for which manipulation is not possible.

After reset

Indicates each register status upon reset signal generation.

Target

Indicates available products for a special function register.

- "--": for all products.
- CAN:  $\mu$ PD78F0844, 78F0845, 78F0846, 78F0847, 78F0848, and 78F0849 only.
- DF2: 78K0/DF2 (μPD78F0838, 78F0839, 78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849) only.



Address	Specia	I Function Register (SFR)	Symbol	R/W	Mani	pulatable Bi	t Unit	After	Target
		Name	-		1 Bit	8 Bits	16 Bits	Reset	_
FF00H	Port regis	ter 0	P0	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF01H	Port regis	ter 1	P1	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF02H	Port regis	ter 2	P2	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF03H	Port regis	ter 3	P3	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF06H	Port regis	ter 6	P6	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF07H	Port regis	ter 7	P7	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF08H	Port regis	ter 8	P8	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF09H	Port regis	ter 9	P9	R/W	$\checkmark$	$\checkmark$	-	00H	DF2
FF0AH	Receive b	ouffer register 60	RXB60	R	-	$\checkmark$	-	FFH	-
<b>FF0BH</b>	Transmit	buffer register 60	TXB60	R/W	-	$\checkmark$	-	FFH	-
FF0CH	Port regis	ter 12	P12	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF0DH	LCD port	function register 3	LCDPF3	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF0EH	Port outp	ut mode control register 6	POM6	R/W	$\checkmark$	$\checkmark$	-	00H	-
<b>FF0FH</b>	Serial I/O	shift register 10	SIO10	R	-	$\checkmark$	-	00H	-
FF10H	16-bit tim	er P4 control register 0	TP4CTL0	R/W		$\checkmark$	-	00H	-
FF11H	16-bit tim	er P4 control register 1	TP4CTL1	R/W	$\checkmark$	$\checkmark$	_	00H	-
FF12H	16-bit tim	er P4 I/O control register 0	TP4IOC0	R/W	$\checkmark$	$\checkmark$	-	00H	_
FF13H	16-bit tim	er P4 I/O control register 1	TP4IOC1	R/W	$\checkmark$	$\checkmark$	-	00H	_
FF14H	16-bit tim	er P4 I/O control register 2	TP4IOC2	R/W	$\checkmark$	$\checkmark$	_	00H	_
FF15H	16-bit tim	er P4 option register 0	TP4OPT0	R/W	$\checkmark$	$\checkmark$	_	00H	_
FF16H	8-bit time	r counter 50	TM50	R	_	$\checkmark$	_	00H	_
FF17H	8-bit time	r compare register 50	CR50	R/W	_	$\checkmark$	_	00H	_
FF18H	10- bit A/	D conversion result register	ADCR	R	_	_	$\checkmark$	0000H	
FF19H		8-bit A/D conversion result register	ADCRH	R	_	$\checkmark$	_	00H	_
FF1AH	LCD port	function register ALL	LCDPFALL	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF1BH	LCD port	function register 0	LCDPF0	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF1FH	8-bit time	r counter 51	TM51	R	-	$\checkmark$	-	00H	-
FF20H	Port mod	e register 0	PM0	R/W	$\checkmark$	$\checkmark$	-	FFH	-
FF21H	Port mod	e register 1	PM1	R/W	$\checkmark$	$\checkmark$	-	FFH	-
FF22H	Port mod	e register 2	PM2	R/W	$\checkmark$	$\checkmark$	-	FFH	=
FF23H	Port mod	e register 3	PM3	R/W	$\checkmark$	$\checkmark$	-	FFH	-
FF26H	Port mod	e register 6	PM6	R/W	$\checkmark$	$\checkmark$	-	FFH	-
FF27H	Port mod	e register 7	PM7	R/W	$\checkmark$	$\checkmark$	-	FFH	-
FF28H	Port mod	e register 8	PM8	R/W	$\checkmark$	$\checkmark$	-	FFH	-
FF29H	Port mod	e register 9	PM9	R/W	$\checkmark$	$\checkmark$	-	FFH	DF2
FF2AH	A/D conv	erter mode register	ADM	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF2BH	Analog in register	put channel specification	ADS	R/W	$\checkmark$	$\checkmark$	_	00H	_

Table 3-7. Special Function Register List (1/6)



Address	Special Function Register (SFR)	Symbol	R/W	Manipulatable Bit Unit		After	Target	
	Name			1 Bit	8 Bits	16 Bits	Reset	
FF2CH	Port mode register 12	PM12	R/W	$\checkmark$	$\checkmark$	_	FFH	_
FF2DH	A/D port configuration register	ADPC	R/W	$\checkmark$	$\checkmark$	_	00H	-
FF2EH	Asynchronous serial interface operation mode register 61	ASIM61	R/W	$\checkmark$	$\checkmark$	_	01H	DF2
FF2FH	Asynchronous serial interface reception error status register 61	ASIS61	R	I	$\checkmark$	_	00H	DF2
FF30H	Pull-up resistor option register 0	PU0	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF31H	Pull-up resistor option register 1	PU1	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF33H	Pull-up resistor option register 3	PU3	R/W	$\checkmark$	$\checkmark$	_	00H	-
FF36H	Pull-up resistor option register 6	PU6	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF37H	Pull-up resistor option register 7	PU7	R/W	$\checkmark$	$\checkmark$	_	00H	_
FF38H	Asynchronous serial interface transmission status register 61	ASIF61	R	-	$\checkmark$	_	00H	DF2
FF39H	Clock selection register 61	CKSR61	R/W	-	$\checkmark$	-	00H	DF2
FF3AH	Receive buffer register 61	RXB61	R	-	$\checkmark$	-	FFH	DF2
FF3BH	Transmit buffer register 61	TXB61	R/W	-	$\checkmark$	-	FFH	DF2
FF3CH	Pull-up resistor option register 12	PU12	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF3DH	SM port mode control register <sup>Note</sup>	SMPC	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF3EH	Baud rate generator control register 61	BRGC61	R/W	_	$\checkmark$	_	FFH	DF2
FF3FH	Asynchronous serial interface control register 61	ASICL61	R/W	$\checkmark$	$\checkmark$	_	16H	DF2
FF40H	Clock output selection register	CKS	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF41H	8-bit timer compare register 51	CR51	R/W	-	$\checkmark$	-	00H	-
FF42H	CAN module last out-pointer register	COLOPT	R	-	$\checkmark$	-	Undefined	CAN
FF43H	8-bit timer mode control register 51	TMC51	R/W	$\checkmark$	$\checkmark$	-	00H	-
FF44H	CAN module receive history list	CORGPT	R/W	_	-	$\checkmark$	xx02H	CAN
FF45H	register							
FF47H	Serial I/O shift register 11	SIO11	R	-	$\checkmark$	-	00H	DF2
FF48H	External interrupt rising edge enable register	EGP	R/W	$\checkmark$	V	_	00H	-
FF49H	External interrupt falling edge enable register	EGN	R/W	$\checkmark$	$\checkmark$	_	00H	-
FF4AH	CAN module transmit history list	COTGPT	R/W	-	-	$\checkmark$	xx02H	CAN
FF4BH	register							
FF4CH	CAN global control register	COGMCTRL	R/W	-	-	$\checkmark$	0000H	CAN
FF4DH								
FF4EH	Transmit buffer register 11	SOTB11	R/W	_	$\checkmark$	_	00H	DF2
FF4FH	Input switch control register	ISC	R/W			_	00H	_

Table 3-7. Special Function Register List (2/6)

**Note** This register is disabled in the  $\mu$ PD78F0838 and 78F0839.



Address	Special Function Register (SFR)	Sv	mbol	R/W	Manii	oulatable B	it Unit	After	Target
	Name	- ,			1 Bit	8 Bits	16 Bits	Reset	
FF50H	Asynchronous serial interface operation mode register 60	ASIM60	)	R/W	$\checkmark$	$\checkmark$	_	01H	-
FF53H	Asynchronous serial interface reception error status register 60	ASIS60		R	-	$\checkmark$	-	00H	-
FF54H	Input noise filter control register 0 for 16-bit timer P0, P1	TIPNF0		R/W	$\checkmark$	$\checkmark$	-	00H	_
FF55H	Asynchronous serial interface transmission status register 60	ASIF60		R	_	$\checkmark$	_	00H	_
FF56H	Clock selection register 60	CKSR6	0	R/W	-	$\checkmark$	-	00H	_
FF57H	Baud rate generator control register 60	BRGC6	0	R/W	-	$\checkmark$	-	FFH	-
FF58H	Asynchronous serial interface control register 60	ASICL6	0	R/W	$\checkmark$	$\checkmark$	-	16H	-
FF59H	Input noise filter control register 1 for 16-bit timer P2, P3	TIPNF1		R/W	$\checkmark$	$\checkmark$	-	00H	-
FF5AH	LCD mode register	LCDMD	)	R/W	$\checkmark$	$\checkmark$	_	00H	-
FF5BH	LCD display mode register	LCDM		R/W	$\checkmark$	$\checkmark$	-	00H	-
FF5CH	LCD clock control register 0	LCDC0		R/W	$\checkmark$	$\checkmark$	-	00H	-
FF60H	DMU remainder data register 0	SDR0	SDR0L	R	_	$\checkmark$	$\checkmark$	00H	-
FF61H			SDR0H	R	_	$\checkmark$		00H	-
FF62H	DMU multiplication/division data	MDA0L	MDA0LL	R	-	$\checkmark$	$\checkmark$	00H	-
FF63H	register A0L		MDA0LH	R	-	$\checkmark$		00H	-
FF64H	DMU multiplication/division data	MDA0H	MDA0HL	R/W	_	$\checkmark$	$\checkmark$	00H	-
FF65H	register A0H		MDA0HH	R/W	-	$\checkmark$		00H	-
FF66H	DMU multiplication/division data	MDB0	MDB0L	R/W	-	$\checkmark$	$\checkmark$	00H	-
FF67H	register B0		MDB0H	R/W	-	$\checkmark$		00H	-
FF68H	DMU multiplier/divider control register 0	DMUCC	)	R/W	$\checkmark$	V	-	00H	-
FF69H	Input noise filter control register 2 for 16-bit timer P4	TIPNF2		R/W	$\checkmark$	$\checkmark$	-	00H	_
FF6AH	Timer clock selection register 50	TCL50		R/W	$\checkmark$	$\checkmark$	-	00H	-
FF6BH	8-bit timer mode control register 50	TMC50		R/W	$\checkmark$	$\checkmark$	-	00H	-
FF6CH	16-bit timer P4 capture/compare	TP4CC	R0	R/W	-	-	$\checkmark$	0000H	-
FF6DH	register 0								
FF6EH	CAN global clock selection register	COGMC	S	R/W	-	$\checkmark$	-	0FH	CAN
FF6FH	CAN global automatic block transmission delay setting register	COGMA	BTD	R/W	-	$\checkmark$	-	00H	CAN
FF70H	CAN module mask 1 register L	COMAS	K1L	R/W	-	-		Undefined	CAN
FF71H									
FF72H	CAN module mask 1 register H	COMAS	K1H	R/W	_	_		Undefined	CAN
FF73H									

Table 3-7. Special Function Register List (3/6)



Address	Special Function Register (SFR) Name	R) Name Symbol R/W Manipulatable Bit		Bit Unit	it Unit After Reset			
				1 Bit	8 Bits	16 Bits	1	ĺ
FF74H	CAN module mask 2 register L	C0MASK2L	R/W	_	_	$\checkmark$	Undefined	CAN
FF75H	1							ĺ
FF76H	CAN module mask 2 register H	C0MASK2H	R/W	_	-		Undefined	CAN
FF77H	1							
FF78H	CAN module mask 3 register L	C0MASK3L	R/W	_	-	$\checkmark$	Undefined	CAN
FF79H	1							
FF7AH	CAN module mask 3 register H	C0MASK3H	R/W		_		Undefined	CAN
FF7BH								
FF7CH	CAN module mask 4 register L	C0MASK4L	R/W	_ I		$\checkmark$	Undefined	CAN
FF7DH								
FF7EH	CAN module mask 4 register H	C0MASK4H	R/W	<b>-</b>	_	$\checkmark$	Undefined	CAN
FF7FH								
FF80H	Serial operation mode register 10	CSIM10	R/W	$\checkmark$	$\checkmark$	-	00H	_
FF81H	Serial clock selection register 10	CSIC10	R/W	$\checkmark$	$\checkmark$		00H	
FF84H	Transmit buffer register 10	SOTB10	R/W		$\checkmark$		00H	_
FF88H	Serial operation mode register 11	CSIM11	R/W	$\checkmark$	$\checkmark$		00H	DF2
FF89H	Serial clock selection register 11	CSIC11	R/W	$\checkmark$	$\checkmark$		00H	DF2
FF8AH	CAN module time stamp register	COTS	R/W	_ I		$\checkmark$	0000H	CAN
FF8BH								
FF8CH	Timer clock selection register 51	TCL51	R/W	$\checkmark$			00H	-
FF8FH	Watch timer operation mode register	WTM	R/W	$\checkmark$	$\checkmark$		00H	_
FF90H	CAN module control register	COCTRL	R/W	_	_	$\checkmark$	0000H	CAN
FF91H								
FF92H	CAN module last error code register	COLEC	R/W		$\checkmark$		00H	CAN
FF93H	CAN module information register	COINFO	R		$\checkmark$		00H	CAN
FF94H	CAN module error counter register	COERC	R	<b>_</b> _		$\checkmark$	0000H	CAN
FF95H								
FF96H	CAN module interrupt enable register	COIE	R/W			$\checkmark$	0000H	CAN
FF97H								
FF98H	CAN module interrupt status register	COINTS	R/W	_	-	$\checkmark$	0000H	CAN
FF99H								
FF9BH	Watchdog timer enable register	WDTE	R/W		$\checkmark$		1AH/9AH <sup>Note</sup>	
FF9CH	CAN module bit rate register	COBTR	R/W	_ I	-	$\checkmark$	370FH	CAN
FF9DH								
FF9EH	CAN module bit rate prescaler register	COBRP	R/W		$\checkmark$	<u> </u>	FFH	CAN
FF9FH	CAN module last in-pointer register	COLIPT	R			<b>—</b>	Undefined	CAN

Table 3-7. Special Function Register List (4/6)

**Note** The reset value of WDTE is determined by setting of option byte.



Address	Special Function Register (SFR)	Symbol	R/W	Manip	oulatable B	it Unit	After	Target
	Name			1 Bit	8 Bits	16 Bits	Reset	
FFA0H	Internal oscillator mode register	RCM	R/W	$\checkmark$	$\checkmark$	-	00H <sup>Note1</sup>	-
FFA1H	Main clock mode register	MCM	R/W	$\checkmark$	$\checkmark$	_	00H	_
FFA2H	Main OSC control register	MOC	R/W	$\checkmark$	$\checkmark$	_	80H	I
FFA3H	Oscillation stabilization time counter status register	OSTC	R	$\checkmark$	$\checkmark$	-	00H	-
FFA4H	Oscillation stabilization time select register	OSTS	R/W	$\checkmark$	$\checkmark$	_	05H	I
FFA5H	SG0 control register	SG0CTL	R/W	$\checkmark$	$\checkmark$	_	00H	ļ
FFA6H	SG0 amplitude register	SG0PWM	R/W	-	-	$\checkmark$	0000H	-
FFA7H								
FFA8H	SG0 frequency low register	SG0FL	R/W	_	-	$\checkmark$	0000H	-
FFA9H								
FFAAH	SG0 frequency high register	SG0FH	R/W	_	_	$\checkmark$	0000H	-
FFABH								
FFACH	Reset control flag register	RESF	R	_	$\checkmark$	_	00H <sup>Note 2</sup>	ļ
FFAEH	CAN global automatic block	COGMABT	R/W	_	_	$\checkmark$	0000H	CAN
FFAFH	transmission control register							
FFB0H	I <sup>2</sup> C shift register 0	IIC0	R/W	_	$\checkmark$	_	00H	ļ
FFB1H	I <sup>2</sup> C control register 0	IICC0	R/W	$\checkmark$	$\checkmark$	_	00H	1
FFB2H	Slave address register 0	SVA0	R/W	_	$\checkmark$	_	00H	1
FFB3H	I <sup>2</sup> C clock selection register 0	IICCL0	R/W	$\checkmark$	$\checkmark$	_	00H	-
FFB4H	I <sup>2</sup> C function expansion register 0	IICX0	R/W	$\checkmark$	$\checkmark$	_	00H	I
FFB5H	I <sup>2</sup> C status register 0	IICS0	R	_	$\checkmark$	_	00H	-
FFB7H	l <sup>2</sup> C flag register 0	IICF0	R/W	$\checkmark$	$\checkmark$	-	00H	-
FFBAH	16-bit timer P4 capture/compare	TP4CCR1	R/W	-	_	$\checkmark$	0000H	-
FFBBH	register 1							
FFBCH	16-bit timer P4 counter read buffer	TP4CNT	R/W	-	-	$\checkmark$	0000H	_
FFBDH	register							
FFBEH	Low-voltage detection register	LVIM	R/W	$\checkmark$	$\checkmark$	-	00H	_
FFBFH	Low-voltage detection level selection register	LVIS	R/W	$\checkmark$	$\checkmark$	-	00H	_

Table 3-7. Special Function Register List (5/6)

**Notes 1.** The value of this register is 00H immediately after a reset release but automatically changes to 80H after internal high-speed oscillator has been stabilized.

2. This value varies depending on the reset source.



Address	Special Function Register (SFR) Name	Symbol		R/W	Manipulatable Bit Unit		After	Target	
					1 Bit	8 Bits	16 Bits	Reset	
FFE0H	Interrupt request flag register 0L	IF0	IF0L	R/W	$\checkmark$	$\checkmark$	$\checkmark$	00H	-
FFE1H	Interrupt request flag register 0H		IF0H	R/W	$\checkmark$	$\checkmark$		00H	-
FFE2H	Interrupt request flag register 1L	IF1	IF1L	R/W	$\checkmark$	$\checkmark$	$\checkmark$	00H	-
FFE3H	Interrupt request flag register 1H		IF1H	R/W	$\checkmark$	$\checkmark$		00H	-
FFE4H	Interrupt mask flag register 0L	MK0	MK0L	R/W	$\checkmark$	$\checkmark$	$\checkmark$	FFH	-
FFE5H	Interrupt mask flag register 0H		MK0H	R/W	$\checkmark$	$\checkmark$		FFH	-
FFE6H	Interrupt mask flag register 1L	MK1	MK1L	R/W	$\checkmark$	$\checkmark$	$\checkmark$	FFH	-
FFE7H	Interrupt mask flag register 1H		MK1H	R/W	$\checkmark$	$\checkmark$		DFH	-
FFE8H	Priority specification flag register 0L	PR0	PROL	R/W	$\checkmark$	$\checkmark$	$\checkmark$	FFH	-
FFE9H	Priority specification flag register 0H		PR0H	R/W	$\checkmark$	$\checkmark$		FFH	-
FFEAH	Priority specification flag register 1L	PR1	PR1L	R/W	$\checkmark$	$\checkmark$	$\checkmark$	FFH	-
FFEBH	Priority specification flag register 1H		PR1H	R/W	$\checkmark$	$\checkmark$		FFH	-
FFEFH	Clock operation mode select register	OSCCTL		R/W	$\checkmark$	$\checkmark$	-	00H	-
FFF0H	Internal memory size switching register <sup>Note</sup>	IMS		R/W	-	$\checkmark$	-	CFH	-
FFF4H	Internal expansion RAM size switching register <sup>Note</sup>	IXS		R/W	-	V	_	0CH	-
FFFBH	Processor clock control register	PCC		R/W	$\checkmark$	$\checkmark$	_	01H	_

Table 3-7. Special Function Register List (6/6)

**Note** Regardless of the internal memory capacity, the initial values of the internal memory size switching register (IMS) and internal expansion RAM size switching register (IXS) of the 78K0/Dx2 is fixed (IMS = CFH, IXS = 0CH). Therefore, set the value corresponding to each product as indicated below.

Fla	sh Memory Version	IMS	IXS
78K0/DE2 78K0/DF2			
μPD78F0836	μPD78F0838, 78F0840, 78F0842	C6H	0AH
μPD78F0844	μPD78F0846, 78F0848	C8H	
μPD78F0837	μPD78F0839, 78F0841, 78F0843	ССН	08H
µPD78F0845	μPD78F0847, 78F0849	CFH	



#### 78K0/Dx2

## 3.2.4 Extended Function Registers (EFRs)

Unlike a general-purpose register, each extended function register has a special function.

EFRs are allocated to the F890H to F89H and FF00H to FFFFH areas. SFRs other than those in the SFR area (FF00H to FFFFH) are allocated to this area.

Extended function registers can be manipulated like general-purpose registers, using operation, transfer and bit manipulation instructions. The manipulatable bit units, 1, 8, and 16, depend on the extended function register type. Each manipulation bit unit can be specified as follows.

• 1-bit manipulation

Specify the EFR address for the HL register and specify the bit to be manipulated as the 1-bit manipulation instruction operand ([HL].bit).

8-bit manipulation
 Specify the symbol reserved by the assembler for the 8-bit manipulation instruction operand (sfr).

This manipulation can also be specified with an address.

• 16-bit manipulation

Specify the symbol reserved by the assembler for the 16-bit manipulation instruction operand (sfrp). When specifying an address, describe an even address.

**Table 3-8. Extended Function Register List** gives a list of the extended function registers. The meanings of items in the table are as follows.

• Symbol

Symbol indicating the address of a special function register. It is a reserved word in the RA78K0, and is defined by the header file "sfrbit.h" in the CC78K0. When using the RA78K0, ID78K0-NS, ID78K0, or SM78K0, symbols can be written as an instruction operand.

• R/W

Indicates whether the corresponding special function register can be read or written.

R/W: Read/write enable

- R: Read only
- W: Write only
- Manipulatable bit units

Indicates the manipulatable bit unit (1, 8, or 16). "-" indicates a bit unit for which manipulation is not possible.

After reset

Indicates each register status upon reset signal generation.

• Target

Indicates available products for a special function register.

"--": for all products.

#### Caution Do not access addresses to which EFRs are not assigned.

Remark For SFRs in the SFR area, see 3.2.3 Special Function Registers (SFRs).



Address	Extended Function Register (EFR)	Symbol R/W		Manipulatable Bit Unit			After	Target
	Name			1 Bit	8 Bits	16 Bits	Reset	
F980H	16-bit timer P0 control register 0	TP0CTL0	R/W	$\checkmark$	$\checkmark$	—	00H	-
F981H	16-bit timer P0 control register 1	TP0CTL1	R/W	$\checkmark$	$\checkmark$	_	00H	_
F982H	16-bit timer P0 I/O control register 0	TP0IOC0	R/W	$\checkmark$	$\checkmark$	Ι	00H	_
F983H	16-bit timer P0 I/O control register 1	TP0IOC1	R/W	$\checkmark$	$\checkmark$	-	00H	-
F984H	16-bit timer P0 I/O control register 2	TP0IOC2	R/W	$\checkmark$	$\checkmark$	I	00H	-
F985H	16-bit timer P0 option register 0	TP0OPT0	R/W	$\checkmark$	$\checkmark$	Ι	00H	_
F986H	16-bit timer P0 capture/compare	TP0CCR0	R/W	_	-	$\checkmark$	0000H	-
F987H	register 0							
F988H	16-bit timer P0 capture/compare	TP0CCR1	R/W	_	-	$\checkmark$	0000H	-
F989H	register 1							
F98AH	16-bit timer P0 counter read buffer	TP0CNT	R	_	-	$\checkmark$	0000H	-
F98BH	register							
F990H	16-bit timer P1 control register 0	TP1CTL0	R/W	$\checkmark$	$\checkmark$	-	00H	-
F991H	16-bit timer P1 control register 1	TP1CTL1	R/W	$\checkmark$	$\checkmark$	-	00H	-
F992H	16-bit timer P1 I/O control register 0	TP1IOC0	R/W	$\checkmark$	$\checkmark$	-	00H	-
F993H	16-bit timer P1 I/O control register 1	TP1IOC1	R/W	$\checkmark$	$\checkmark$	-	00H	-
F994H	16-bit timer P1 I/O control register 2	TP1IOC2	R	$\checkmark$	$\checkmark$	-	00H	-
F995H	16-bit timer P1 option register 0	TP1OPT0	R/W	$\checkmark$	$\checkmark$	-	00H	-
F996H	16-bit timer P1 capture/compare	TP1CCR0	R/W	-	-	$\checkmark$	0000H	-
F997H	register 0							
F998H	16-bit timer P1 capture/compare	TP1CCR1	R/W	_	-	$\checkmark$	0000H	-
F999H	register 1							
F99AH	16-bit timer P1 counter read buffer	TP1CNT	R	_	-	$\checkmark$	0000H	-
F99BH	register							
F9A0H	16-bit timer P2 control register 0	TP2CTL0	R/W	$\checkmark$	$\checkmark$	-	00H	-
F9A1H	16-bit timer P2 control register 1	TP2CTL1	R/W	$\checkmark$	$\checkmark$	I	00H	-
F9A2H	16-bit timer P2 I/O control register 0	TP2IOC0	R/W	$\checkmark$	$\checkmark$	I	00H	_
F9A3H	16-bit timer P2 I/O control register 1	TP2IOC1	R/W	$\checkmark$	$\checkmark$	I	00H	-
F9A4H	16-bit timer P2 I/O control register 2	TP2IOC2	R	$\checkmark$	$\checkmark$	I	00H	-
F9A5H	16-bit timer P2 option register 0	TP2OPT0	R/W	$\checkmark$	$\checkmark$	-	00H	-
F9A6H	16-bit timer P2 capture/compare	TP2CCR0	R/W	-	-	$\checkmark$	0000H	-
F9A7H	register 0							
F9A8H	16-bit timer P2 capture/compare	TP2CCR1	R/W	_	-	$\checkmark$	0000H	-
F9A9H	register 1							
F9AAH	16-bit timer P2 counter read buffer	TP2CNT	R	_	_	$\checkmark$	0000H	_
F9ABH	register							

## Table 3-8. Extended Function Register List (1/2)



Address	Extended Function Register (EFR)	Symbol		R/W	Manip	Manipulatable Bit Unit		After	Target
	Name				1 Bit	8 Bits	16 Bits	Reset	
F9B0H	16-bit timer P3 control register 0	TP3CTL0		R/W			-	00H	-
F9B1H	16-bit timer P3 control register 1	TP3CTL1		R/W	$\checkmark$	$\checkmark$	-	00H	-
F9B2H	16-bit timer P3 I/O control register 0	TP3IOC0		R/W		$\checkmark$		00H	_
F9B3H	16-bit timer P3 I/O control register 1	TP3IOC1		R/W	$\checkmark$	$\checkmark$		00H	_
F9B4H	16-bit timer P3 I/O control register 2	TP3IOC2		R	$\checkmark$	$\checkmark$		00H	_
F9B5H	16-bit timer P3 option register 0	TP3OPT0		R/W	$\checkmark$	$\checkmark$	_	00H	_
F9B6H	16-bit timer P3 capture/compare	TP3CCR0		R/W	_	_	$\checkmark$	0000H	_
F9B7H	register 0								
F9B8H	16-bit timer P3 capture/compare	TP3CCR1		R/W	-	-		0000H	-
F9B9H	register 1								
F9BAH	16-bit timer P3 counter read buffer	<b>TP3CNT</b>		R	-	-		0000H	-
F9BBH	register								
F9C0H	MTRC timer mode control register 0	MCNTC0		R/W	$\checkmark$	$\checkmark$		00H	_
F9C2H	MTRC compare register 10	MCMP1HW	MCMP10	R/W	_	$\checkmark$	$\checkmark$	00H	Note1
F9C3H	MTRC compare register 11	 	MCMP11	R/W	_	$\checkmark$		00H	Note1
F9C4H	MTRC compare register 20	MCMP2HW	MCMP20	R/W		$\checkmark$	$\checkmark$	00H	Note1
F9C5H	MTRC compare register 21	 	MCMP21	R/W	_	$\checkmark$		00H	Note1
F9C6H	MTRC compare register 30	MCMP3HW	MCMP30	R/W	_			00H	Note2
F9C7H	MTRC compare register 31	]	MCMP31	R/W		$\checkmark$	ĺ	00H	Note2
F9C8H	MTRC compare register 40	MCMP4HW	MCMP40	R/W	_	$\checkmark$	$\checkmark$	00H	Note2
F9C9H	MTRC compare register 41	<u> </u>	MCMP41	R/W	_	$\checkmark$		00H	Note2
F9CAH	MTRC compare control register 1	MCMPC1		R/W	$\checkmark$	$\checkmark$		00H	Note1
F9CCH	MTRC compare control register 2	MCMPC2		R/W	$\checkmark$	$\checkmark$	_	00H	Note1
F9CEH	MTRC compare control register 3	МСМРС3		R/W	$\checkmark$	$\checkmark$	_	00H	Note2
F9F8H	MTRC compare control register 4	MCMPC4		R/W	$\checkmark$	$\checkmark$		00H	Note2
F9FCH	MTRC ZPD detection voltage setting register 0	ZPDS0		R/W		$\checkmark$	-	00H	Note1
F9FDH	MTRC ZPD detection voltage setting register 1	ZPDS1		R/W	$\checkmark$	$\checkmark$	-	00H	Note2
F9FEH	MTRC ZPD flag detection clock setting register	CMPCTL		R/W	$\checkmark$	$\checkmark$	-	00H	-
F9FFH	MTRC ZPD operational control register	ZPDEN		R/W	$\checkmark$	$\checkmark$	_	00H	_

Table 3-8. Extended Function Register List (2/2)

Notes 1.  $\mu$ PD78F0836, 78F0837, 78F0842, 78F0843, 78F0844, 78F0845, 78F0848, and 78F0849 only.

**2.** *μ*PD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849 only.

## 3.3 Instruction Address Addressing

An instruction address is determined by program counter (PC) contents and is normally incremented (+1 for each byte) automatically according to the number of bytes of an instruction to be fetched each time another instruction is executed. When a branch instruction is executed, the branch destination information is set to the PC and branched by the following addressing (for details of instructions, refer to **78K/0 Series Instructions User's Manual (U12326E)**.

#### 3.3.1 Relative addressing

#### [Function]

The value obtained by adding 8-bit immediate data (displacement value: jdisp8) of an instruction code to the start address of the following instruction is transferred to the program counter (PC) and branched. The displacement value is treated as signed two's complement data (-128 to +127) and bit 7 becomes a sign bit. In other words, relative addressing consists of relative branching from the start address of the following instruction to the -128 to +127 range.

This function is carried out when the BR \$addr16 instruction or a conditional branch instruction is executed.

#### [Illustration]



When S = 0, all bits of  $\alpha$  are 0. When S = 1, all bits of  $\alpha$  are 1.



## 3.3.2 Immediate addressing

## [Function]

Immediate data in the instruction word is transferred to the program counter (PC) and branched. This function is carried out when the CALL !addr16 or BR !addr16 or CALLF !addr11 instruction is executed. CALL !addr16 and BR !addr16 instructions can be branched to the entire memory space. The CALLF !addr11 instruction is branched to the 0800H to 0FFFH area.

## [Illustration]

In the case of CALL laddr16 and BR laddr16 instructions



In the case of CALLF !addr11 instruction





## 3.3.3 Table indirect addressing

#### [Function]

Table contents (branch destination address) of the particular location to be addressed by bits 1 to 5 of the immediate data of an operation code are transferred to the program counter (PC) and branched.

This function is carried out when the CALLT [addr5] instruction is executed.

This instruction references the address that is indicated by addr5 and is stored in the memory table from 0040H to 007FH, and allows branching to the entire memory space.

## [Illustration]





## 3.3.4 Register addressing

## [Function]

Register pair (AX) contents to be specified with an instruction word are transferred to the program counter (PC) and branched.

This function is carried out when the BR AX instruction is executed.

## [Illustration]





## 3.4 Operand Address Addressing

The following methods are available to specify the register and memory (addressing) to undergo manipulation during instruction execution.

#### 3.4.1 Implied addressing

#### [Function]

The register that functions as an accumulator (A and AX) among the general-purpose registers is automatically (implicitly) addressed.

Of the 78K0/Dx2 instruction words, the following instructions employ implied addressing.

Instruction	Register to Be Specified by Implied Addressing
MULU	A register for multiplicand and AX register for product storage
DIVUW	AX register for dividend and quotient storage
ADJBA/ADJBS	A register for storage of numeric values that become decimal correction targets
ROR4/ROL4	A register for storage of digit data that undergoes digit rotation

#### [Operand format]

Because implied addressing can be automatically employed with an instruction, no particular operand format is necessary.

#### [Description example]

In the case of MULU X

With an 8-bit  $\times$  8-bit multiply instruction, the product of A register and X register is stored in AX. In this example, the A and AX registers are specified by implied addressing.



### 3.4.2 Register addressing

#### [Function]

The general-purpose register to be specified is accessed as an operand with the register bank select flags (RBS0 to RBS1) and the register specify codes (Rn and RPn) of an operation code.

Register addressing is carried out when an instruction with the following operand format is executed. When an 8-bit register is specified, one of the eight registers is specified with 3 bits in the operation code.

### [Operand format]

Identifier	Description
r	X, A, C, B, E, D, L, H
rp	AX, BC, DE, HL

'r' and 'rp' can be described by absolute names (R0 to R7 and RP0 to RP3) as well as function names (X, A, C, B, E, D, L, H, AX, BC, DE, and HL).

#### [Description example]

MOV A, C; when selecting C register as r



INCW DE; when selecting DE register pair as rp

Operation code



## 3.4.3 Direct addressing

## [Function]

The memory to be manipulated is directly addressed with immediate data in an instruction word becoming an operand address.

### [Operand format]



## [Description example]

MOV A, !0FE00H; when setting !addr16 to FE00H



## [Illustration]





## 3.4.4 Short direct addressing

#### [Function]

The memory to be manipulated in the fixed space is directly addressed with 8-bit data in an instruction word. This addressing is applied to the 256-byte space FE20H to FF1FH. Internal RAM and special function registers (SFRs) are mapped at FE20H to FEFFH and FF00H to FF1FH, respectively.

The SFR area (FF00H to FF1FH) where short direct addressing is applied is a part of the overall SFR area. Ports that are frequently accessed in a program and compare and capture registers of the timer/event counter are mapped in this area, allowing SFRs to be manipulated with a small number of bytes and clocks.

When 8-bit immediate data is at 20H to FFH, bit 8 of an effective address is set to 0. When it is at 00H to 1FH, bit 8 is set to 1. Refer to the **[Illustration]** shown below.

#### [Operand format]

Identifier	Description
saddr Immediate data that indicate label or FE20H to FF1FH	
saddrp	Immediate data that indicate label or FE20H to FF1FH (even address only)

#### [Description example]

MOV 0FE30H, A; when transferring value of A register to saddr (FE30H)





When 8-bit immediate data is 20H to FFH,  $\alpha$  = 0 When 8-bit immediate data is 00H to 1FH,  $\alpha$  = 1


## 3.4.5 Special function register (SFR) addressing

# [Function]

A memory-mapped special function register (SFR) is addressed with 8-bit immediate data in an instruction word. This addressing is applied to the 240-byte spaces FF00H to FFCFH and FFE0H to FFFFH. However, the SFRs mapped at FF00H to FF1FH can be accessed with short direct addressing.

# [Operand format]

Identifier	Description
sfr	Special function register name
sfrp	16-bit manipulatable special function register name (even address only)

#### [Description example]

MOV PM0, A; when selecting PM0 (FF20H) as sfr







### 3.4.6 Register indirect addressing

# [Function]

Register pair contents specified by a register pair specify code in an instruction word and by a register bank select flag (RBS0 and RBS1) serve as an operand address for addressing the memory. This addressing can be carried out for all the memory spaces.

# [Operand format]

Identifier	Description
-	[DE], [HL]

#### [Description example]

MOV A, [DE]; when selecting [DE] as register pair

Operation code

0 0 0 0 1 0 1 1





# 3.4.7 Based addressing

#### [Function]

8-bit immediate data is added as offset data to the contents of the base register, that is, the HL register pair in the register bank specified by the register bank select flag (RBS0 and RBS1), and the sum is used to address the memory. Addition is performed by expanding the offset data as a positive number to 16 bits. A carry from the 16th bit is ignored. This addressing can be carried out for all the memory spaces.

### [Operand format]

Identifier	Description
-	[HL + byte]

#### [Description example]

MOV A, [HL + 10H]; when setting byte to 10H







#### 3.4.8 Based indexed addressing

#### [Function]

The B or C register contents specified in an instruction word are added to the contents of the base register, that is, the HL register pair in the register bank specified by the register bank select flag (RBS0 and RBS1), and the sum is used to address the memory. Addition is performed by expanding the B or C register contents as a positive number to 16 bits. A carry from the 16th bit is ignored. This addressing can be carried out for all the memory spaces.

# [Operand format]

Identifier	Description
-	[HL + B], [HL + C]

#### [Description example]

In the case of MOV A, [HL + B]; (selecting B register)

Operation code

```
1 0 1 0 1 0 1 1
```





# 3.4.9 Stack addressing

# [Function]

The stack area is indirectly addressed with the stack pointer (SP) contents.

This addressing method is automatically employed when the PUSH, POP, subroutine call and return instructions are executed or the register is saved/reset upon generation of an interrupt request. With stack addressing, only the internal high-speed RAM area can be accessed.

### [Description example]

In the case of PUSH DE; (saving DE register)

Operation code

1 0 1 1 0 1 0 1





# CHAPTER 4 PORT FUNCTIONS

# 4.1 Port Functions

There are four types of pin I/O buffer power supplies: AVREF, EVDD, SMVDD, and VDD. The relationship between these power supplies and the pins is shown below.

Power Supply	Corresponding Pins
AVREF	P20 to P23, P24 to P27 <sup>Note</sup>
EVDD	Port pins other than P20 to P27, P80 to P87, P90 to P97, and P121 to P124
SMVdd	<ul> <li>P80 to P87</li> <li>P90 to P97<sup>Note</sup></li> </ul>
Vdd	P121 to P124     Non-port pins

Table 4-1. Pin I/O Buffer Power Supplies

Note 78K0/DF2 only.

78K0/Dx2 products are provided with the ports shown in Figure 4-1, which enable variety of control operations.

In addition to the function as digital I/O ports, these ports have several alternate functions. For details of the alternate functions, refer to **CHAPTER 2 PIN FUNCTIONS**.

The 78K0/DE2 has a total of 47 I/O ports, ports 0 to 3, 6 to 8, and 12. Also, the 78K0/DF2 has a total of 63 I/O ports, ports 0 to 3, 6 to 9, and 12. The port configuration is shown below.



Figure 4-1. Port Types (1/2)



(a) 78K0/DE2



Figure 4-1. Port Types (2/2)







# 4.2 Port Configuration

Ports include the following hardware.

Item		Configuration			
		78K0/DE2	78K0/DF2		
Control register	Port mode register	PM0 to PM3, PM6 to PM8, PM12	PM0 to PM3, PM6 to PM9, PM12		
	Port register	P0 to P3, P6 to P8, P12	P0 to P3, P6 to P9, P12		
	Pull-up resistor option register	PU0, PU1, PU3, PU6, PU7, PU12			
Port	Total	47 (CMOS I/O: 45, N-ch open drain I/O <sup>Note</sup> : 2)	63 (CMOS I/O: 61, N-ch open drain I/O <sup>Note</sup> : 2)		
Pull-up resistor	Total	31	41		

# Table 4-2. Port Configuration

Note 5 V tolerant / N-ch open-drain output selectable.



# 4.2.1 Port 0

Port 0 is an 8-bit I/O port with an output latch. Port 0 can be set to the input mode or output mode in 1-bit units using port mode register 0 (PM0). When the P00 to P07 pins are used as an input port, use of an on-chip pull-up resistor can be specified in 1-bit units by pull-up resistor option register 0 (PU0).

This port can also be used for timer I/O and segment signal outputs for the LCD controller/driver.

Reset signal generation sets port 0 to input mode.

Figure 4-2 shows a block diagram of port 0.





P0:	Port register 0
PU0:	Pull-up resistor option register 0
PM0:	Port mode register 0
LCDPF0:	LCD port function register 0
RD:	Read signal
WR××:	Write signal

Caution When using P00 to P07 as an alternate function in output mode, set the corresponding port latch to 0.

When using P00 to P07 as general-purpose ports, specify the port settings so that the alternatefunction outputs are fixed to 0.

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### 4.2.2 Port 1

Port 1 is an 8-bit I/O port with an output latch. Port 1 can be set to the input mode or output mode in 1-bit units using port mode register 1 (PM1). When the P10 to P17 pins are used as an input port, use of an on-chip pull-up resistor can be specified in 1-bit units by pull-up resistor option register 1 (PU1).

This port can also be used for serial interface data I/O, clock I/O, timer I/O, external interrupt request input, and segment signal outputs for the LCD controller/driver.

Reset signal generation sets port 1 to input mode.

Figures 4-3 to 4-7 show block diagrams of port 1.

- Cautions 1. To use P10/SCK10/INTP4/TxD61 and P12/SO10/INTP2 as general-purpose ports, set serial operation mode register 10 (CSIM10) and serial clock selection register 10 (CSIC10) to the default status (00H).
  - 2. To use P10/SCK10/INTP4/TxD61 and P13/SEG23/TIOP30/TxD60 as general-purpose port, clear bit 0 (TXDLV60, TXDLV61) of asynchronous serial interface control registers 60, 61 (ASICL60, ASICL61) to 0 (normal output of TxD60, TxD61).



#### Figure 4-3. Block Diagram of P10

Note 78K0/DF2 only.

- P1: Port register 1
- PU1: Pull-up resistor option register 1
- PM1: Port mode register 1
- RD: Read signal
- WR××: Write signal
- Caution When using P10 as an alternate function in output mode, set the port latch to 1. When using P10 as a general-purpose port, specify the port settings so that the alternatefunction outputs are fixed to 1.

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Figure 4-4. Block Diagram of P11



Note 78K0/DF2 only.

- P1: Port register 1
- PU1: Pull-up resistor option register 1
- PM1: Port mode register 1
- RD: Read signal
- WR××: Write signal





Figure 4-5. Block Diagram of P12 and P17

- P1: Port register 1
- PU1: Pull-up resistor option register 1
- PM1: Port mode register 1
- RD: Read signal
- WR××: Write signal

Caution When using P12 and P17 as an alternate function in output mode, set the corresponding port latch to 0.

When using P12 and P17 as general-purpose ports, specify the port settings so that the alternate-function outputs are fixed to 0.

**Remark** The function within arrowheads (<>) can be assigned by setting the input switch control register (ISC).





Fiaure	4-6.	Block	Diagram	of	P13

P1:	Port register 1
PU1:	Pull-up resistor option register 1
PM1:	Port mode register 1
LCDPFALL:	LCD port function register ALL
RD:	Read signal
WR××:	Write signal

Caution When using the alternate function TIOP30, set the port latch to 0.

When using the alternate function TxD60, set the port latch to 1.

When using P13 as a general-purpose port, specify the port settings so that the alternate-function outputs are fixed to 1.



Figure 4-7	<b>Block Diagram</b>	of	P14	to	P16
1 igule 4-7.	DIOCK Diagram	UI.	F 14	ιU	FIU

P1:	Port register 1
PU1:	Pull-up resistor option register 1
PM1:	Port mode register 1
LCDPFALL:	LCD port function register ALL
RD:	Read signal
WR××:	Write signal

Caution When using P14 to P16 as an alternate function in output mode, set the corresponding port latch to 0.

When using P14 to P16 as general-purpose ports, specify the port settings so that the alternatefunction outputs are fixed to 0.



# 4.2.3 Port 2

Port 2 is a 4-bit I/O port in 78K0/DE2 and an 8-bit I/O port in 78K0/DF2 with an output latch. Port 2 can be set to the input mode or output mode in 1-bit units using port mode register 2 (PM2).

This port can also be used for A/D converter analog input.

To use P20/ANI0 to P27/ANI7 (P20/ANI0 to P23/ANI3 in 78K0/DE2, P20/ANI0 to P27/ANI7 in 78K0/DF2) as digital input pins, set them in the digital I/O mode by using the A/D port configuration register (ADPC) and in the input mode by using PM2 (for details, see **11.3 (5) A/D port configuration register (ADPC)**). Use these pins starting from the lower bit.

ADPC	PM2	ADS	P20/ANI0 to P27/ANI7 Pin
Digital I/O selection	Input mode	_	Digital input
	Output mode	-	Digital output
Analog input selection	Input mode	Selects ANI.	Analog input (to be converted)
		Does not select ANI.	Analog input (not to be converted)
	Output mode	Selects ANI.	Setting prohibited
		Does not select ANI.	

Table 4-3. Setting Functions of P20/ANI0 to P27/ANI7 Pins

All P20/ANI0 to P27/ANI7 are set in the analog input mode when the reset signal is generated. **Figure 4-8** shows a block diagram of port 2.

Caution Make the AVREF pin the same potential as the VDD pin when port 2 is used as a digital port.





Figure 4-8. Block Diagram of P20 to P27

Note 78K0/DF2 only

- P2: Port register 2
- PM2: Port mode register 2
- RD: Read signal
- WR××: Write signal



# 4.2.4 Port 3

Port 3 is an 8-bit I/O port with an output latch. Port 3 can be set to the input mode or output mode in 1-bit units using port mode register 3 (PM3). When used as an input port, use of an on-chip pull-up resistor can be specified in 1-bit units by pull-up resistor option register 3 (PU3).

This port can also be used for segment signal outputs for the LCD controller/driver.

Reset signal generation sets port 3 to input mode.

Figures 4-9 and 4-10 show block diagrams of port 3.

### Caution Be sure to pull the P31/SEG5/OCD1A pin down before a reset release, to prevent malfunction.

**Remark** The P31/SEG5 and P32/SEG6 pins can be used for on-chip debug mode setting (OCD1A, OCD1B) when the on-chip debug function is used. For how to connect an in-circuit emulator supporting on-chip debugging (QB-MINI2), see **CHAPTER 27 ON-CHIP DEBUG FUNCTION**.



Figure 4-9. Block Diagram of P30 and P33 to 37

P3:	Port register 3
PU3:	Pull-up resistor option register 3
PM3:	Port mode register 3
LCDPF3:	LCD port function register 3
RD:	Read signal
WR××:	Write signal





Figure 4-10. Block Diagram of P31 and P32

P3:	Port register 3
PU3:	Pull-up resistor option register 3
PM3:	Port mode register 3
LCDPF3:	LCD port function register 3
RD:	Read signal
WR××:	Write signal



#### 4.2.5 Port 6

Port 6 is a 2-bit I/O port with an output latch. Port 6 can be set to the input mode or output mode in 1-bit units using port mode register 6 (PM6). P60 and P61 use of an on-chip pull-up resistor can be specified in 1-bit units using pull-up resistor option register 6 (PU6).

Output from the P60 and P61 pins can be specified as normal CMOS output or N-ch open-drain output (5 V-torelant) in 1-bit units, using port output mode register 6 (POM6).

This port can also be used for external interrupt request input and serial clock I/O and data I/O for IICO.

Reset signal generation sets port 6 to input mode.

Figure 4-11 shows a block diagram of port 6.



Figure 4-11. Block Diagram of P60 and P61

- P6: Port register 6
- PU6: Pull-up resistor option register 6
- PM6: Port mode register 6
- POM6: Port output control register 6
- RD: Read signal
- WR××: Write signal
- Caution When using P60 and P61 as an alternate function in output mode, set the corresponding port latch to 0.

When using P60 and P61 as general-purpose ports, specify the port settings so that the alternate-function outputs are fixed to 0.

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### 4.2.6 Port 7

Port 7 is a 4-bit I/O port in 78K0/DE2 and an 8-bit I/O port in 78K0/DF2 with an output latch. Port 7 can be set to the input mode or output mode in 1-bit units using port mode register 7 (PM7). When the P70 to P77 (P70 to P73 in 78K0/DE2, P70 to P77 in 78K0/DF2) pins are used as an input port, use of an on-chip pull-up resistor can be specified in 1-bit units by pull-up resistor option register 7 (PU7).

This port can also be used for output pins for the sound generator, clock output pins, buzzer output pins, CAN I/F I/O, serial interface data I/O and clock I/O, timer I/O, and segment output pins for the LCD controller/driver.

Reset signal generation sets port 7 to input mode.

Figures 4-12 to 4-18 show block diagrams of port 7.

- Cautions 1. To use P74/SCK11 and P76/SO11 as general-purpose ports, set serial operation mode register 10 (CSIM10) and serial clock selection resister 10 (CSIC10) to the default status (00H).
  - 2. To use P77/SSI11/SEG27 as general-purpose ports, set serial operation mode register 11 (CSIM11) to the default status (00H).



Figure 4-12. Block Diagram of P70

Note  $\mu$  PD78F0844, 78F0845, 78F0846, 78F0847, 78F0848, and 78F0849 only.

- P7: Port register 7
- PU7: Pull-up resistor option register 7
- PM7: Port mode register 7
- RD: Read signal
- WR××: Write signal

**Remark** The function within arrowheads (<>) can be assigned by setting the input switch control register (ISC).





Note  $\mu$  PD78F0844, 78F0845, 78F0846, 78F0847, 78F0848, and 78F0849 only.

- P7: Port register 7
- PU7: Pull-up resistor option register 7
- PM7: Port mode register 7
- RD: Read signal
- WR××: Write signal
- Caution When using P71 as an alternate function in output mode, set the port latch to 1. When using P71 as a general-purpose port, specify the port settings so that the alternatefunction outputs are fixed to 1.



**Remark** The function within arrowheads (<>) can be assigned by setting the input switch control register (ISC).



Figure 4-14. Block Diagram of P72 and P73

- P7: Port register 7
- PU7: Pull-up resistor option register 7
- PM7: Port mode register 7
- RD: Read signal
- WR××: Write signal
- Caution When using P72 and P73 as an alternate function in output mode, set the corresponding port latch to 0.

When using P72 and P73 as general-purpose ports, specify the port settings so that the alternate-function outputs are fixed to 0.



# Figure 4-15. Block Diagram of P74 (1/2)



### (a) *µ* PD78F038, 78F039, 78F040, 78F041, 78F036, and 78F047

- P7: Port register 7
- PU7: Pull-up resistor option register 7
- PM7: Port mode register 7
- RD: Read signal
- WR××: Write signal
- Caution When using P74 as an alternate function in output mode, set the port latch to 1.
  - When using P74 as a general-purpose port, specify the port settings so that the alternatefunction outputs are fixed to 1.



Figure 4-15. Block Diagram of P74 (2/2)



# (b) $\mu$ PD78F042, 78F043, 78F048, and 78F049

P7:	Port register 7
PU7:	Pull-up resistor option register 7
PM7:	Port mode register 7
LCDPFALL:	LCD port function register ALL
RD:	Read signal
WR××:	Write signal

Caution When using P74 as an alternate function in output mode, set the port latch to 1.

When using P74 as a general-purpose port, specify the port settings so that the alternatefunction outputs are fixed to 1.

# Figure 4-16. Block Diagram of P75 (1/2)



# (a) $\mu$ PD78F038, 78F039, 78F040, 78F041, 78F036, and 78F047

- P7: Port register 7
- PU7: Pull-up resistor option register 7
- PM7: Port mode register 7
- RD: Read signal
- WR××: Write signal



Figure 4-16. Block Diagram of P75 (2/2)



Port register 7
Pull-up resistor option register 7
Port mode register 7
LCD port function register ALL
Read signal
Write signal



### Figure 4-17. Block Diagram of P76 (1/2)



#### (a) *µ* PD78F038, 78F039, 78F040, 78F041, 78F036, and 78F047

- P7: Port register 7
- PU7: Pull-up resistor option register 7
- PM7: Port mode register 7
- RD: Read signal
- WR××: Write signal
- Caution When using P76 as an alternate function in output mode, set the port latch to 0. When using P76 as a general-purpose port, specify the port settings so that the alternatefunction outputs are fixed to 0.



Figure 4-17. Block Diagram of P76 (2/2)



(b)  $\mu$  PD78F042, 78F043, 78F048, and 78F049

P7:	Port register 7
PU7:	Pull-up resistor option register 7
PM7:	Port mode register 7
LCDPFALL:	LCD port function register ALL
RD:	Read signal
WR××:	Write signal

Caution When using P76 as an alternate function in output mode, set the port latch to 0.

When using P76 as a general-purpose port, specify the port settings so that the alternatefunction outputs are fixed to 0.

# Figure 4-18. Block Diagram of P77 (1/2)



### (a) $\mu$ PD78F038, 78F039, 78F040, 78F041, 78F036, and 78F047

- P7: Port register 7
- PU7: Pull-up resistor option register 7
- PM7: Port mode register 7
- RD: Read signal
- WR××: Write signal
- Caution When using P77 as an alternate function in output mode, set the port latch to 0. When using P77 as a general-purpose port, specify the port settings so that the alternatefunction outputs are fixed to 0.



**Remark** The function within arrowheads (<>) can be assigned by setting the input switch control register (ISC).

Figure 4-18. Block Diagram of P77 (2/2)





P7:	Port register 7
PU7:	Pull-up resistor option register 7
PM7:	Port mode register 7
LCDPFALL:	LCD port function register ALL
RD:	Read signal
WR××:	Write signal

Caution When using P77 as an alternate function in output mode, set the port latch to 0. When using P77 as a general-purpose port, specify the port settings so that the alternatefunction outputs are fixed to 0.

**Remark** The function within arrowheads (<>) can be assigned by setting the input switch control register (ISC).



# 78K0/Dx2

# 4.2.7 Port 8

Port 8 is an 8-bit I/O port with an output latch. Port 8 can be set to the input mode or output mode in 1-bit units using port mode register 8 (PM8).

This port can also be used for stepper motor controller/driver outputs/inputs in  $\mu$  PD78F0836, 78F0837, 78F0842, 78F0843, 78F0844, 78F0845, 78F0848, and 78F0849 or LCD segment outputs in  $\mu$  PD78F0838, 78F0839, 78F0840, 78F0841, 78F0846, and 78F0847.

Reset signal generation sets port 8 to input mode.

Figures 4-19 and 4-20 show block diagrams of port 8.

#### Figure 4-19. Block Diagram of P80 to P82 and P84 to P86 (1/2)

(a)  $\mu$  PD78F0836, 78F0837, 78F0842, 78F0843, 78F0844, 78F0845, 78F0848, and 78F0849



го.	For register o
PM8:	Port mode register 8
RD:	Read signal
WR××:	Write signal

Caution When using P80 to P82 and P84 to P86 as an alternate function in output mode, set the corresponding port latch to 0.

When using P80 to P82 and P84 to P86 as general-purpose ports, specify the port settings so that the alternate-function outputs are fixed to 0.



# Figure 4-19. Block Diagram of P80 to P82 and P84 to P86 (2/2)





P8:	Port register 8
PM8:	Port mode register 8
LCDPFALL:	LCD port function register ALL
RD:	Read signal
WR××:	Write signal



# Figure 4-20. Block Diagram of P83 and P87 (1/2)



### (a) $\mu$ PD78F0836, 78F0837, 78F0842, 78F0843, 78F0844, 78F0845, 78F0848, and 78F0849

P8:	Port register 8
PM8:	Port mode register 8
RD:	Read signal
WR××:	Write signal

Caution When using P83 and P87 as an alternate function in output mode, set the corresponding port latch to 0.

When using P83 and P87 as general-purpose ports, specify the port settings so that the alternate-function outputs are fixed to 0.



# Figure 4-20. Block Diagram of P83 and P87 (2/2)





P8:	Port register 8
PU8:	Pull-up resistor option register 8
PM8:	Port mode register 8
LCDPFALL:	LCD port function register ALL
RD:	Read signal
WR××:	Write signal



# 78K0/Dx2

# 4.2.8 Port 9 (78K0/DF2 only)

Port 9 is an 8-bit I/O port with an output latch. Port 9 can be set to the input mode or output mode in 1-bit units using port mode register 9 (PM9).

This port can also be used for LCD segment outputs in  $\mu$  PD78F0838 and 78F0839 or stepper motor controller/driver outputs/inputs in  $\mu$  PD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849.

Reset signal generation sets port 9 to input mode.

Figures 4-21 and 4-22 shows block diagrams of port 9.

#### Figure 4-21. Block Diagram of P90 to P92 and P94 to P96 (1/2)



#### (a) $\mu$ PD78F0838 and 78F0839

P9:	Port register 9
PM9:	Port mode register 9
LCDPFALL:	LCD port function register ALL
RD:	Read signal
WR××:	Write signal








P9:	Port register 9
PM9:	Port mode register 9
RD:	Read signal
WR××:	Write signal

Caution When using P90 to P92 and P94 to P96 as an alternate function in output mode, set the corresponding port latch to 0.

When using P90 to P92 and P94 to P96 as general-purpose ports, specify the port settings so that the alternate-function outputs are fixed to 0.



Figure 4-22. Block Diagram of P93 and P97 (1/2)





P9:	Port register 9
PM9:	Port mode register 9
LCDPFALL:	LCD port function register ALL
RD:	Read signal
WR××:	Write signal



#### Figure 4-22. Block Diagram of P93 and P97 (2/2)



#### (b) $\mu$ PD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849

P9:	Port register 9
PM9:	Port mode register 9
RD:	Read signal
WR××:	Write signal

Caution When using P93 and P97 as an alternate function in output mode, set the corresponding port latch to 0.

When using P93 and P97 as general-purpose ports, specify the port settings so that the alternate-function outputs are fixed to 0.



#### 4.2.9 Port 12

Port 12 is a 5-bit I/O port with an output latch. Port 12 can be set to the input mode or output mode in 1-bit units using port mode register 12 (PM12). When used as an input port only for P120, use of an on-chip pull-up resistor can be specified by pull-up resistor option register 12 (PU12).

This port can also be used for external interrupt input, potential input for external low-voltage detector, connecting resonator for main system clock, connecting resonator for subsystem clock, external clock input for main system clock, external clock input for subsystem clock.

Reset signal generation sets port 12 to input mode.

Figures 4-23 and 4-24 show block diagrams of port 12.

- Cautions 1. When using the P121 to P124 pins to connect a resonator for the main system clock (X1, X2) or subsystem clock (XT1, XT2), or to input an external clock for the main system clock (EXCLK) or subsystem clock (EXCLKS), the X1 oscillation mode, XT1 oscillation mode, or external clock input mode must be set by using the clock operation mode select register (OSCCTL) (for detail, see 5.3 (5) Clock operation mode select register (OSCCTL)). The reset value of OSCCTL is 00H (all of the P121 to P124 pins are I/O port pins). At this time, setting of the PM121 to PM124 and P121 to P124 pins is not necessary.
  - 2. Connect P121/X1 as follows when writing the flash memory with a flash programmer.
    P121/X1: When using this pin as a port, connect it to Vss via a resistor (10 kΩ:

recommended) (in the input mode) or leave it open (in the output mode). The above connection is not necessary when writing the flash memory by means of self programming.

**Remark** P121/X1 and P122/X2/EXCLK can be used as on-chip debug mode setting pins (OCD0A, OCD0B) when the on-chip debug function is used. For how to connect an in-circuit emulator supporting on-chip debugging (QB-MINI2), see **CHAPTER 27 ON-CHIP DEBUG FUNCTION**.



Figure 4-23. Block Diagram of P120



- P12: Port register 12
- PU12: Pull-up resistor option register 12
- PM12: Port mode register 12
- RD: Read signal
- WR××: Write signal





#### Figure 4-24. Block Diagram of P121 to P124

P12:Port register 12PU12:Pull-up resistor option register 12PM12:Port mode register 12OSCCTL:Clock operation mode select registerRD:Read signalWR××:Write signal



#### 4.3 Registers Controlling Port Function

Port functions are controlled by the following four types of registers.

- Port mode registers (PM0 to PM3, PM3 to PM8, PM9<sup>Note</sup>, PM12)
- Port registers (P0 to P3, P3 to P8, P9<sup>Note</sup>, P12)
- Pull-up resistor option registers (PU0, PU1, PU3, PU6, PU7, PU12)
- Port output mode control register 6 (POM6)
- LCD port function register 0 (LCDPF0)
- LCD port function register 3 (LCDPF3)
- LCD port function register ALL (LCDPFALL)
- Stepper motor port mode control register (SMPC)
- A/D port configuration register (ADPC)

Note 78K0/DF2 only



#### (1) Port mode registers (PM0 to PM3, PM6 to PM9, PM12)

These registers specify input or output mode for the port in 1-bit units. These registers can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation sets these registers to FFH.

When port pins are used as alternate-function pins, set the port mode register by referencing **4.4 Settings of** LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output Latch When Using Alternate Function.

Symbol	7	6	5	4	3	2	1	0	Address	After reset	R/W
PM0	PM07	PM06	PM05	PM04	PM03	PM02	PM01	PM00	FF20H	FFH	R/W
I											
	7	6	5	4	3	2	1	0	l		
PM1	PM17	PM16	PM15	PM14	PM13	PM12	PM11	PM10	FF21H	FFH	R/W
For 78K	7	e	F	4	2	0	4	0			
DMO	1	0	3	4	DM02	Z DM00	I DM01	DM20	EEOOL	EEU	
PIVIZ		I	I	I	PIVI23	PIVIZZ	PIVIZ I	PIVIZU	FF22N	FFN	H/ VV
For 78K	(0/DF2										
	7	6	5	4	3	2	1	0			
PM2	PM27	PM26	PM25	PM24	PM23	PM22	PM21	PM20	FF22H	FFH	R/W
1	7	6	5	4	3	2	1	0	I		
PM3	PM37	PM36	PM35	PM34	PM33	PM32	PM31	PM30	FF23H	FFH	R/W
i	7	6	5	4	3	2	1	0	I		
PM6	1	1	1	1	1	1	PM61	PM60	FF26H	FFH	R/W
For 78K	(0/DF2										
	7	6	5	4	3	2	1	0			
PM7	1	1	1	1	PM73	PM72	PM71	PM70	FF27H	FFH	R/W
									I		
For 78K	(0/DF2										
I	7	6	5	4	3	2	1	0	I		
PM7	PM77	PM76	PM75	PM74	PM73	PM72	PM71	PM70	FF27H	FFH	R/W
I	7	6	5	4	3	2	1	0	I		
PM8	PM87	PM86	PM85	PM84	PM83	PM82	PM81	PM80	FF28H	FFH	R/W

Figure 4-25. Format of Port Mode Register (1/2)





#### Figure 4-25. Format of Port Mode Register (2/2)

Note 78K0/DF2 only



#### (2) Port registers (P0 to P3, P6 to P9, P12)

These registers write the data that is output from the chip when data is output from a port.

If the data is read in the input mode, the pin level is read. If it is read in the output mode, the value of the output latch is read.

These registers can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears these registers to 00H.

Symbol	7	6	5	4	3	2	1	0	Address	After reset	R/W
P0	P07	P06	P05	P04	P03	P02	P01	P00	FF00H	00H (output latch)	R/W
-									-		
	7	6	5	4	3	2	1	0	•		
P1	P17	P16	P15	P14	P13	P12	P11	P10	FF01H	00H (output latch)	R/W
Ear 79K	0/DE2										
	7	6	5	4	3	2	1	0			
P2	0	0	0	0	P23	P22	P21	P20	FF02H	00H (output latch)	R/W
	-	-	-	-							
For 78K	(0/DF2										
_	7	6	5	4	3	2	1	0			
P2	P27	P26	P25	P24	P23	P22	P21	P20	FF02H	00H (output latch)	R/W
									_		
	7	6	5	4	3	2	1	0	•		
P3	P37	P36	P35	P34	P33	P32	P31	P30	FF03H	00H (output latch)	R/W
	7	6	5	4	3	2	1	0	•		
P6	0	0	0	0	0	0	P61	P60	FF06H	00H (output latch)	R/W
For 78K	0/DE2										
	7	6	5	4	3	2	1	0			
P7	0	0	0	0	P73	P72	P71	P70	FF07H	00H (output latch)	R/W
I				1				1	<u>.</u>		
For 78K	0/DF2										
-	7	6	5	4	3	2	1	0	_		
P7	P77	P76	P75	P74	P73	P72	P71	P70	FF07H	00H (output latch)	R/W
	7	6	5	4	3	2	1	0			
P8	P87	P86	P85	P84	P83	P82	P81	P80	FF08H	00H (output latch)	R/W

#### Figure 4-26. Format of Port Register (1/2)



Symbol	7	6	5	4	3	2	1	0	Address	After reset	R/W
P9 <sup>Note</sup>	P97	P96	P95	P94	P93	P92	P91	P90	FF09H	00H (output latch)	R/W
-									-		
_	7	6	5	4	3	2	1	0	_		
P12	0	0	0	P124	P123	P122	P121	P120	FF0CH	00H (output latch)	R/W

Figure 4-26. Format of Port Register (2/2)

**Remarks 1.** An undefined value (pin input level) is read for the value after reset when P0 is read in the input mode. When P2 is read in the output mode, 00H (output latch value) is output.

2. P121 to P124 always indicate 00H (output latch value) in the input mode.

Pmn	m = 0 to 3, 6 to 8, 9 <sup>Note</sup> , 12; n = 0 to 7								
	Output data control (in output mode)	Input data read (in input mode)							
0	Output 0	Input low level							
1	Output 1	Input high level							

Note 78K0/DF2 only



#### (3) Pull-up resistor option registers (PU0, PU1, PU3, PU6, PU7, PU12)

These registers specify whether the on-chip pull-up resistors of P00 to P07, P10 to P17, P30 to P37, P60, P61, P70 to P77, and P120 are to be used or not. On-chip pull-up resistors can be used in 1-bit units only for the bits set to input mode of the pins to which the use of an on-chip pull-up resistor has been specified in PU0, PU1, PU3, PU6, PU7, and PU12. On-chip pull-up resistors cannot be connected to bits set to output mode and bits used as alternate-function output pins, regardless of the settings of PU0, PU1, PU3, PU6, PU7, and PU12. These registers can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears these registers to 00H.

Symbol	7	6	5	4	3	2	1	0	Address	After reset	R/W
PU0	PU07	PU06	PU05	PU04	PU03	PU02	PU01	PU00	FF30H	00H	R/W
-											
	7	6	5	4	3	2	1	0	l		
PU1	PU17	PU16	PU15	PU14	PU13	PU12	PU11	PU10	FF31H	00H	R/W
	7	6	5	4	3	2	1	0	I		
PU3	PU37	PU36	PU35	PU34	PU33	PU32	PU31	PU30	FF33H	00H	R/W
	7	6	5	4	3	2	1	0	L		
PU6	0	0	0	0	0	0	PU61	PU60	FF36H	00H	R/W
For 78K	0/DE2										
	7	6	5	4	3	2	1	0	1		
PU7	0	0	0	0	PU73	PU72	PU71	PU70	FF37H	00H	R/W
For 78K	0/DF2										
	7	6	5	4	3	2	1	0	I		
PU7	PU77	PU76	PU75	PU74	PU73	PU72	PU71	PU70	FF37H	00H	R/W
	7	6	5	4	3	2	1	0	1		
PU12	0	0	0	0	0	0	0	PU120	FF3CH	00H	R/W

#### Figure 4-27. Format of Pull-up Resistor Option Register

PUmn	PUmn pin on-chip pull-up resistor selection $(m = 0, 1, 3, 6, 7, 12; n = 0 \text{ to } 7)$
0	On-chip pull-up resistor not connected
1	On-chip pull-up resistor connected



#### (4) Port output mode control register 6 (POM6)

This register sets the output mode of P60 and P61 in 1-bit units. During I<sup>2</sup>C communication, set P60/SCL0/INTP1 and P61/SDA0/INTP3 to N-ch open-drain output (5 V-torelant) mode.

This register can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears this register to 00H.

#### Figure 4-28. Format of Port Output Mode Control Register 6 (POM6)



POM6n	P6n pin output selection $(n = 0, 1)$
0	CMOS output
1	N-ch open-drain output (5 V-torelant)

#### (5) LCD port function register 0 (LCDPF0)

This register sets whether to use pins P00 to P07 as port pins or segment output pins. LCDPF0 is set using a 1-bit or 8-bit memory manipulation instruction. Reset signal generation sets LCDPF0 to 00H.

#### Figure 4-29. Format of LCD Port Function Register 0 (LCDPF0)

Symbol	7	6	5	4	3	2	1	0	Address	After reset	R/W
LCDPF0	PF07	PF06	PF05	PF04	PF03	PF02	PF01	PF00	FF1BH	00H	R/W

PF0n	P0n pin port/segment output specification (n = 0 to 7)
0	Used as port
1	Used as segment output



#### (6) LCD port function register 3 (LCDPF3)

This register sets whether to use pins P30 to P37 as port pins or segment output pins. LCDPF3 is set using a 1-bit or 8-bit memory manipulation instruction. Reset signal generation sets LCDPF3 to 00H.

#### Figure 4-30. Format of LCD Port Function Register 3 (LCDPF3)



PF3n	P3n pin port/segment output specification (n = 0 to 7)
0	Used as port
1	Used as segment output

#### (7) LCD port function register ALL (LCDPFALL)

This register sets whether to use pins P13 to P16, P74 to P77, P80 to P87, and P90 to P97 as port pins or segment output pins.

LCDPFALL is set using a 1-bit or 8-bit memory manipulation instruction. Reset signal generation sets LCDPFALL to 00H.

#### Figure 4-31. Format of LCD Port Function Register ALL (LCDPFALL)



PF1n	P1n pin port/segment output specification (n = 3 to 6)
0	Used as port
1	Used as segment output

PF7UPNIB	P7n pin port/segment output specification (n = 4 to 7)
0	Used as port
1	Used as segment output

PFnALL	Pnm pin port/segment output specification (n = 8, 9; m = 0 to 7)
0	Used as port
1	Used as segment output

Caution µPD78D0838, 78F0839: Set PF7UPPNIB to 0.

 $\mu$ PD78DF0840, 78F0841, 78F0846, 78F0847: Set PF7UPPNIB and PF9ALL to 0.  $\mu$ PD78DF0842, 78F0843, 78F0848, 78F0849: Set PF8ALL and PF9ALL to 0.

RENESAS

#### (8) Stepper motor port mode control register (SMPC)

This register sets the output mode of stepper motor controller/driver. This register can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears this register to 00H.

#### Figure 4-32. Format of Stepper Motor Port Mode Control Register (SMPC)

Symbol	7	6	5	4	3	2	1	0	Address	After reset	R/W
SMPC	MOD4	MOD3	MOD2	MOD1	EN4	EN3	EN2	EN1	FF3DH	00H	R/W

ENn	MODn	Port mode selection $(n = 0 \text{ to } 4)$
0	_	Port mode
		All SMnm (n = 1 to 4, m = 1 to 4) are set to port function.
1	0	PWM full bridge mode
		SMnm (n = 1 to 4, m = 1 to 4) are set to full bridge output control mode.
1	1	PWM half bridge mode
		Depending on the DIRnk (n = 1 to 4, k = 0, 1) bit of the compare control registers (MCMPCn; n = 1 to 4), SMnm (n = 1 to 4, m = 1 to 4) are set to PWM output control mode or port mode.

An example of settings when n = 1 is as follows:

EN1	MOD1	DIR11	DIR10	ŀ	PWM Outp	Output Mode		
				SM11	SM12	SM13	SM14	
				(sin+)	(sin–)	(cos+)	(cos–)	
0	_	-	-	port	port	port	port	Port mode
1	0	0	0	PWM	0	PWM	0	PWM full bridge mode
1	0	0	1	PWM	0	0	PWM	
1	0	1	0	0	PWM	0	PWM	
1	0	1	1	0	PWM	PWM	0	
1	1	0	0	PWM	port	PWM	port	PWM half bridge mode
1	1	0	1	PWM	port	port	PWM	
1	1	1	0	port	PWM	port	PWM	
1	1	1	1	port	PWM	PWM	port	

Caution Set port registers (Pn) and port mode registers (PMn) whose pins are not in the PWM mode to 00H in the PWM full bridge mode.



#### (9) A/D port configuration register (ADPC)

This register switches the P20/ANI0 to P27/ANI7 (P20/ANI0 to P23/ANI3 in 78K0/DE2, P20/ANI0 to P27/ANI7 in 78K0/DF2) pins to analog input of A/D converter or digital I/O of port.

ADPC can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears this register to 00H.

#### Figure 4-33. Format of A/D Port Configuration Register (ADPC)

Symbol	7	6	5	4	3	2	1	0	Address	After reset	R/W
ADPC	0	0	0	0	ADPC3	ADPC2	ADPC1	ADPC0	FF22H	00H	R/W

ADPC3	ADPC2	ADPC1	ADPC0		Analog input (A)/ digital input (D) switching								
				P27/ANI7	P26/ANI6	P25/ANI5	P24/ANI4	P23/ANI3	P22/ANI2	P21/ANI1	P20/ANI0		
0	0	0	0	А	А	А	А	А	А	А	А		
0	0	0	1	А	А	А	А	А	А	А	D		
0	0	1	0	А	А	А	А	А	А	D	D		
0	0	1	1	А	А	А	А	А	D	D	D		
0	1	0	0	А	А	А	А	D	D	D	D		
0	1	0	1	А	А	А	D	D	D	D	D		
0	1	1	0	А	А	D	D	D	D	D	D		
0	1	1	1	А	D	D	D	D	D	D	D		
1	0	0	0	D	D	D	D	D	D	D	D		
Other than above				Setting pr	Setting prohibited								

- Cautions 1. Set the channel used for A/D conversion to the input mode by using port mode register 2 (PM2).
  - 2. Do not set the pin set by ADPC as digital I/O by analog input channel specification register (ADS).
  - 3. If data is written to ADPC, a wait cycle is generated. Do not write data to ADPC when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.



### 4.4 Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output Latch When Using Alternate Function

To use the alternate function of a port pin, set the LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, port mode register, and output latch as shown in the following tables.

The descriptions of the column titles and the value in the tables are as follows:

×:	Don't care
-:	Don't apply
LCDPFALL:	LCD port function register ALL
LCDPF0:	LCD port function register 0
LCDPF3:	LCD port function register 3
SMPC:	Stepper motor port mode control register
ISC:	Input switch control register
PM××:	Port mode register
P××:	Port output latch

The functions within arrowheads (<>) can be assigned by setting the input switch control register (ISC).



## Table 4-4. Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output Latch When Using Alternate Function (1/7) (a) 78K0/DE2

Pin Name	Alternate Fund	ction	LCDPFALL	LCDPF0	LCDPF3	SMPC	ISC	PM××	P××
	Function Name	I/O	-						
P00	SEG12	Output	_	PF00 = 1	_	_	_	×	×
	TIOP40	Input	_	PF00 = 0	_	_	ISC0 = 0	1	×
		Output	-					0	0
P01	SEG13	Output	_	PF01 = 1	_	_	_	×	×
	TIOP41	Input	-	PF01 = 0	-	-	-	1	×
		Output						0	0
P02	SEG14	Output	-	PF02 = 1	-	-	-	×	×
	TIO50	Input	-	PF02 = 0	-	-	-	1	×
		Output						0	0
P03	SEG15	Output	-	PF03 = 1	-	-	-	×	×
	TIO51	Input	-	PF03 = 0	-	-	-	1	×
		Output	-					0	0
P04	SEG16	Output	_	PF04 = 1	_	-	_	×	×
	TIOP01	Input	-	PF04 = 0	-	-	-	1	×
		Output						0	0
P05	SEG17	Output	_	PF05 = 1	_		_	×	×
	TIOP11	Input	-	PF05 = 0	-	-	-	1	×
		Output						0	0
P06	SEG18	Output	-	PF06 = 1	-	-	-	×	×
	TIOP21	Input	-	PF06 = 0	-	-	ISC3 = 0	1	×
		Output						0	0
P07	SEG19	Output	-	PF07 = 1	-	-	-	×	×
	TIOP31	Input	-	PF07 = 0	-	-	-	1	×
		Output						0	0
P10	INTP4	Input	-	-	-	-	-	1	×
	SCK10	Input	-	-	-	-	-	1	×
		Output	-	-	-			0	1
P11	SI10	Input	-	-	-	-	-	1	×
P12	INTP2	Input	-	-	-	-	-	1	×
	SO10	Output	-	-	-	-	-	0	0
P13	SEG23	Output	PF13 = 1	-	-	-	-	×	×
	TIOP30	Input	PF13 = 0	-	-	-	ISC6 = 0	1	×
		Output						0	0
	TxD60	Output	PF13 = 0	-	-	-	ISC7 = 0	0	1

## Table 4-4. Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output Latch When Using Alternate Function (2/7) (a) 78K0/DE2

									(2/3)
Pin Name	Alternate Function		LCDPFALL	LCDPF0	LCDPF3	SMPC	ISC	PM××	P××
	Function Name	I/O							
P14	INTPR60	Input	PF14 = 0	-	-	-	ISC7 = 0	1	×
	RxD60	Input	PF14 = 0	_	-	-		1	×
	SEG22	Output	PF14 = 1	-	-	-	-	×	×
	TIOP20	Input	PF14 = 0	-	-	_	ISC1 = 0 & ISC5 = 0	1	×
		Output					ISC5 = 0	0	0
P15	SEG21	Output	PF15 = 1	-	-	_	_	×	×
	TIOP10	Input	PF15 = 0	_	-	-	-	1	×
		Output						0	0
P16	SEG20	Output	PF16 = 1	-	-	_	_	×	×
	TIOP00	Input	PF16 = 0	_	-	-	-	1	×
		Output						0	0
P17	INTP0	Input	-	_	-	-	-	1	×
	<tiop30></tiop30>	Input	-	-	-	-	ISC6 = 1	1	×
		Output						0	0
P20 to P23	ANI0 to ANI3	Input	-	-	_	-	-	1	×
P30	SEG4	Output	-	1	PF30 = 1	I	_	×	×
P31	SEG5	Output	-	-	PF31 = 1	-	-	×	×
	OCD1A	I/O	-	I	PF31 = 0	Ι	-	1	×
P32	SEG6	Output	-	_	PF32 = 1	-	-	×	×
	OCD1B	I/O	-	-	PF32 = 0	-	-	1	×
P33	SEG7	Output	-	_	PF33 = 1	-	-	×	×
P34	SEG8	Output	-	-	PF34 = 1	-	-	×	×
P35	SEG9	Output	-	-	PF35 = 1	-	-	×	×
P36	SEG10	Output	-	-	PF36 = 1	-	-	×	×
P37	SEG11	Output	-	-	PF37 = 1	-	-	×	×
P60	INTP1	Input	-	-	-	-	-	1	×
	SCL0	I/O	-	-	-	-	-	0	0
P61	INTP3	Input	-	-	-	-	-	1	×
	SDA0	I/O	-	I	-	Ι	-	0	0
P70	CRxD <sup>Note</sup>	Input	_	Ι	_	I	_	1	×
	<rxd60 intpr60=""></rxd60>	Input	_	_	_	_	ISC7 = 1	1	×
P71	CTxD <sup>Note</sup>	Output	-	_	-	_	-	0	1
	<txd60></txd60>	Output	-	_	_	_	ISC7 = 1	0	1

**Note**  $\mu$  PD78F0844 and 78F0845 only.



## Table 4-4. Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output Latch When Using Alternate Function (3/7) (a) 78K0/DE2

									(3/3)
Pin Name	Alternate Fund	tion	LCDPFALL	LCDPF0	LCDPF3	SMPC	ISC	PM××	P××
	Function Name	I/O							
P72	PCL	Output	-	_	-	_	_	0	0
	SGOA	Output	_	_	Ι	-	_	0	0
P73	BUZ	Output	-	-	Ι	-	_	0	0
	SGO	Output	-	_	-	_	_	0	0
	SGOF	Output	-	_	-	_	_	0	0
P80 to P82	SM11 to SM13	Output	_	_	-	EN1 = 1	_	0	0
P83	SM14	Output	-	_	-	EN1 = 1	_	0	0
-	ZPD14	Input	-	_	_	_	_	1	×
P84 to P86	SM21 to SM23	Output	-	_	_	EN2 = 1	_	0	0
P87	SM24	Output	-	_	_	EN2 = 1	_	0	0
	ZPD24	Input	-	_	_	_	_	1	×
P120	EXLVI	Input	-	_	_	_	_	1	×
P121	X1	Input	-	_	-	-	_	1	×
	OCD0A	I/O	-	_	-	_	_	1	×
P122	X2	Input	-	_	_	_	_	1	×
	EXCLK	Input	-	_	_	_	_	1	×
	OCD0B	I/O	-	_	_	-	_	1	×
P123	XT1	Input	-	_	_	-	_	1	×
P124	XT2	Input	-	_	-	-	_	1	×
	EXCLKS	Input	-	_	-	-	_	1	×



# Table 4-4. Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output LatchWhen Using Alternate Function (4/7)(b) 78K0/DF2

					I	I			(1/4)
Pin Name	Alternate Fund	ction	LCDPFALL	LCDPF0	LCDPF3	SMPC	ISC	PM××	P××
	Function Name	I/O							
P00	SEG12	Output	-	PF00 = 1	-	-	-	×	×
	TIOP40	Input	-	PF00 = 0	-	-	ISC0 = 0	1	×
		Output						0	0
P01	SEG13	Output	-	PF01 = 1	-	-	-	×	×
	TIOP41	Input	-	PF01 = 0	-	-	-	1	×
		Output						0	0
P02	SEG14	Output	-	PF02 = 1	-	-	-	×	×
	TIO50	Input	-	PF02 = 0	-	-	-	1	×
		Output						0	0
P03	SEG15	Output	_	PF03 = 1	_	_	_	×	×
	TIO51	Input	-	PF03 = 0	-	-	-	1	×
		Output						0	0
P04	SEG16	Output	-	PF04 = 1	_	_	_	×	×
	TIOP01	Input	-	PF04 = 0	-	-	-	1	×
		Output						0	0
P05	SEG17	Output	-	PF05 = 1	-	-	-	×	×
Т	TIOP11	Input	-	PF05 = 0	_	_	_	1	×
		Output						0	0
P06	SEG18	Output	-	PF06 = 1	-	-	-	×	×
	TIOP21	Input	-	PF06 = 0	-	-	ISC3 = 0	1	×
		Output						0	0
P07	SEG19	Output	-	PF07 = 1	-	-	-	×	×
	TIOP31	Input	-	PF07 = 0	-	-	-	1	×
		Output	-					0	0
P10	INTP4	Input	-	_	_	_	_	1	×
	SCK10	Input	-	_	-	-	-	1	×
		Output	-	_	-	-	-	0	1
	TxD61	Output	-	-	-	-	-	0	1
P11	INTPR61	Input	-	-	-	-	-	1	×
	SI10	Input	-	_	-	-	-	1	×
	RxD61	Input	-	-	-	-	-	1	×
P12	INTP2	Input	-	-	-	-	-	1	×
	SO10	Output	-	-	-	-	-	0	0
P13	SEG23	Output	PF13 = 1	-	-	-	-	×	×
	TIOP30	Input	PF13 = 0	_	_	_	ISC2 = 0 &	1	×
		Output					ISC6 = 0	0	0
	TxD60	Output	PF13 = 0	_	-	-	ISC7 = 0	0	1



### Table 4-4. Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output LatchWhen Using Alternate Function (5/7)(b) 78K0/DF2

									(2/4)
Pin Name	Alternate Func	tion	LCDPFALL	LCDPF0	LCDPF3	SMPC	ISC	PM××	P××
	Function Name	I/O							
P14	INTPR60	Input	PF14 = 0	_	-	_	ISC7 = 0	1	×
	RxD60	Input	PF14 = 0	-	-	-		1	×
	SEG22	Output	PF14 = 1	-	-	-	-	×	×
	TIOP20	Input	PF14 = 0	-	-	-	ISC1 = 0 & ISC5 = 0	1	×
		Output					ISC5 = 0	0	0
P15	SEG21	Output	PF15 = 1	1	_	-	-	×	×
	TIOP10	Input	PF15 = 0	-	-	-	-	1	×
		Output						0	0
P16	SEG20	Output	PF16 = 1	1	_	-	-	×	×
	TIOP00	Input	PF16 = 0	-	-	-	-	1	×
		Output						0	0
P17	INTP0	Input	_	1	_	-	-	1	×
	<tiop30></tiop30>	Input	-	-	-	-	ISC2 = 0 &	1	×
		Output					ISC6 = 1	0	0
P20 to P27	ANI0 to ANI7	Input	_	1	_	-	-	1	×
P30	SEG4	Output	_	-	PF30 = 1	-	-	×	×
P31	SEG5	Output	-	Ι	PF31 = 1	-	-	×	×
	OCD1A	I/O	_		PF31 = 0	1	_	1	×
P32	SEG6	Output	_	I	PF32 = 1	I	-	×	×
	OCD1B	I/O	_		PF32 = 0	1	_	1	×
P33 to P37	SEG7 to SEG11	Output	-	-	PF33 to PF37 = 1	-	-	×	×
P60	INTP1	Input	_	_	_	_	_	1	×
	SCL0	I/O	-	-	-	-	-	0	0
P61	INTP3	Input	-	-	-	-	-	1	×
	SDA0	I/O	-	-	-	-	-	0	0
P70	CRxD <sup>Note</sup>	Input	-	-	-	-	-	1	×
	<rxd60 intpr60=""></rxd60>	Input	_	-	-	-	ISC7 = 1	1	×
P71	CTxD <sup>Note</sup>	Output	_	_	-	_	-	0	1
	<txd60></txd60>	Output	-	-	-	-	ISC7 = 1	0	1
P72	PCL	Output	-	-	-	-	-	0	0
	SGOA	Output	_	_	_	_	_	0	0
P73	BUZ	Output	_	_	_	_	_	0	0
	SGO	Output	_	_	_	_	_	0	0
	SGOF	Output	-	_	_	_	_	0	0

**Note** *μ* PD78F0846, 78F0847, 78F0848, and 78F0849 only.



### Table 4-4. Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output LatchWhen Using Alternate Function (6/7)(b) 78K0/DF2

									(3/4)
Pin Name	Alternate Func	tion	LCDPFALL	LCDPF0	LCDPF3	SMPC	ISC	PM××	P××
	Function Name	I/O							
P74	SCK11	Input	PF7UPNIB = 0	_	_	_	-	1	×
		Output	PF7UPNIB = 0	-	-	-	-	0	1
	SEG24 <sup>Note1</sup>	Output	PF7UPNIB = 1	_	_	-	-	×	×
P75	SI11	Input	PF7UPNIB = 0	-	_	_	-	1	×
	SEG25 <sup>Note1</sup>	Output	PF7UPNIB = 1	-	_	-	-	×	×
P76	SO11	Output	PF7UPNIB = 0	-	_	-	-	0	0
	SEG26 <sup>Note1</sup>	Output	PF7UPNIB = 1	-	-	-	-	×	×
P77	SEG27 <sup>Note1</sup>	Output	PF7UPNIB = 1	-	_	-	-	×	×
	SSI11	Input	PF7UPNIB = 0	_	-	-	-	1	×
	<tiop20></tiop20>	Input	PF7UPNIB = 0	-	-	-	ISC1 = 0 &	1	×
		Output					1505 = 1	0	0
P80 to P82	SEG24 to SEG26 <sup>Note2</sup>	Output	PF8ALL = 1	_	_	_	_	×	×
	SM11 to SM13 <sup>Note3</sup>	Output	PF8ALL = 0	_	_	EN1 = 1	-	0	0
P83	SEG27 <sup>Note2</sup>	Output	PF8ALL = 1	-	_	-	-	×	×
	SM14 <sup>Note3</sup>	Output	PF8ALL = 0	-	-	EN1 = 1	-	0	0
	ZPD14 <sup>Note3</sup>	Input	PF8ALL = 0	-	-	-	-	1	×
P84 to P86	SEG28 to SEG30 <sup>Note2</sup>	Output	PF8ALL = 1	-	_	_	-	×	×
	SM21 to SM23 <sup>Note3</sup>	Output	PF8ALL = 0	_	_	EN2 = 1	_	0	0
P87	SEG31 <sup>Note2</sup>	Output	PF8ALL = 1	-	-	-	-	×	×
	SM24 <sup>Note3</sup>	Output	PF8ALL = 0	-	_	EN2 = 1	-	0	0
	ZPD24 <sup>Note3</sup>	Input	PF8ALL = 0	-	-	-	-	1	×
P90 to P92	SEG32 to SEG34 <sup>Note4</sup>	Output	PF9ALL = 1	-	_	_	-	×	×
	SM31 to SM33 <sup>Note5</sup>	Output	PF9ALL = 0	-	-	EN3 = 1	-	0	0
P93	SEG35 <sup>Note4</sup>	Output	PF9ALL = 1	_	_	_	-	×	×
	SM34 <sup>Note5</sup>	Output	PF9ALL = 0	_	_	EN3 = 1	-	0	0
	ZPD34 <sup>Note5</sup>	Input	PF9ALL = 0	_	_	_	-	1	×

**Notes 1.** *μ* PD78F0842, 78F0843, 78F0848, and 78F0849 only.

- **2.** For *μ* PD78F0838, 78F0839, 78F0840, 78F0841, 78F0846, and 78F0847.
- **3.** For *μ* PD78F0842, 78F0843, 78F0848, and 78F0849.
- **4.** For  $\mu$  PD78F0838 and 78F0839.
- **5.** For *μ* PD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849.



## Table 4-4. Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output LatchWhen Using Alternate Function (7/7)(b) 78K0/DF2

									(4/4)
Pin Name	Alternate Func	tion	LCDPFALL	LCDPF0	LCDPF3	SMPC	ISC	PM××	P××
	Function Name	I/O							
P94 to P96	SEG36 to SEG38 <sup>Note1</sup>	Output	PF9ALL = 1	-	-	_	-	×	×
	SM41 to SM43 <sup>Note2</sup>	Output	PF9ALL = 0	-	-	EN4 = 1	-	0	0
P97	SEG39 <sup>Note1</sup>	Output	PF9ALL = 1	-	-	_	-	×	×
	SM44 <sup>Note2</sup>	Output	PF9ALL = 0	_	_	EN4 = 1	_	0	0
	ZPD44 <sup>Note2</sup>	Input	PF9ALL = 0	-	-	_	-	1	×
P120	EXLVI	Input	-	-	-	_	-	1	×
P121	X1	Input	_	_	Ι	_	-	1	×
	OCD0A	I/O	-	_	1	-	1	1	×
P122	X2	Input	-	_	Ι	-	Ι	1	×
	EXCLK	Input	-	_	Ι	-	Ι	1	×
	OCD0B	I/O	-	_	Ι	-	Ι	1	×
P123	XT1	Input	-	_	Ι	-	Ι	1	×
P124	XT2	Input	_	_	_	_	_	1	×
	EXCLKS	Input	_	_	_	_	_	1	×

Notes 1. For  $\mu$  PD78F0838 and 78F0839.

**2.** For *μ* PD78F0840, 78F0841, 78F0842, 78F0843, 78F0846, 78F0847, 78F0848, and 78F0849.



**Remarks 1.** The function of the ANI0/P20 to ANI7/P27 pins can be selected by using the A/D port configuration register (ADPC), the analog input channel specification register (ADS), and PM2.

ADPC	PM2	ADS	P20/ANI0 to P27/ANI7 Pin	
Digital I/O selection	Input mode	_	Digital input	
	Output mode	-	Digital output	
Analog input selection	Input mode	Selects ANI.	Analog input (to be converted)	
		Does not select ANI.	Analog input (not to be converted)	
	Output mode	Selects ANI.	Setting prohibited	
		Does not select ANI.		

- 2. When using the P121 to P124 pins to connect a resonator for the main system clock (X1, X2) or subsystem clock (XT1, XT2), or to input an external clock for the main system clock (EXCLK) or subsystem clock (EXCLKS), the X1 oscillation mode, XT1 oscillation mode, or external clock input mode must be set by using the clock operation mode select register (OSCCTL) (for detail, see 5.3 (5) Clock operation mode select register (OSCCTL)). The reset value of OSCCTL is 00H (all of the P121 to P124 pins are I/O port pins). At this time, setting of the PM121 to PM124 and P121 to P124 pins is not necessary.
- P31/SEG5, P32/SEG6, P121/X1, and P122/X2/EXCLK can be used as on-chip debug mode setting pins (OCD1A, OCD1B, OCD0A, OCD0B) when the on-chip debug function is used. For how to connect an in-circuit emulator supporting on-chip debugging (QB-MINI2), see CHAPTER 27 ON-CHIP DEBUG FUNCTION.



#### 4.5 Port Function Operations

Port operations differ depending on whether the input or output mode is set, as shown below.

#### 4.5.1 Writing to I/O port

#### (1) Output mode

A value is written to the output latch by a transfer instruction, and the output latch contents are output from the pin. Once data is written to the output latch, it is retained until data is written to the output latch again. The data of the output latch is cleared by reset.

#### (2) Input mode

A value is written to the output latch by a transfer instruction, but since the output buffer is off, the pin status does not change.

Once data is written to the output latch, it is retained until data is written to the output latch again.

#### 4.5.2 Reading from I/O port

#### (1) Output mode

The output latch contents are read by a transfer instruction. The output latch contents do not change.

#### (2) Input mode

The pin status is read by a transfer instruction. The output latch contents do not change.

#### 4.5.3 Operations on I/O port

#### (1) Output mode

An operation is performed on the output latch contents, and the result is written to the output latch. The output latch contents are output from the pins.

Once data is written to the output latch, it is retained until data is written to the output latch again. The data of the output latch is cleared by reset.

#### (2) Input mode

The pin level is read and an operation is performed on its contents. The result of the operation is written to the output latch, but since the output buffer is off, the pin status does not change.



#### 4.6 Cautions on 1-bit Manipulation Instruction for Port Register n (Pn)

When a 1-bit manipulation instruction is executed on a port that provides both input and output functions, the output latch value of an input port that is not subject to manipulation may be written in addition to the targeted bit.

Therefore, it is recommended to rewrite the output latch when switching a port from input mode to output mode.

- <Example> When P10 is an output port, P11 to P17 are input ports (all pin statuses are high level), and the port latch value of port 1 is 00H, if the output of output port P10 is changed from low level to high level via a 1-bit manipulation instruction, the output latch value of port 1 is FFH.
- Explanation: The targets of writing to and reading from the Pn register of a port whose PMnm bit is 1 are the output latch and pin status, respectively.

A 1-bit manipulation instruction is executed in the following order in the 78K0/Dx2.

- <1> The Pn register is read in 8-bit units.
- <2> The targeted one bit is manipulated.
- <3> The Pn register is written in 8-bit units.

In step <1>, the output latch value (0) of P10, which is an output port, is read, while the pin statuses of P11 to P17, which are input ports, are read. If the pin statuses of P11 to P17 are high level at this time, the read value is FEH.

The value is changed to FFH by the manipulation in <2>.

FFH is written to the output latch by the manipulation in <3>.







#### CHAPTER 5 CLOCK GENERATOR

#### 5.1 Functions of Clock Generator

The clock generator generates the clock to be supplied to the CPU and peripheral hardware. The following system clocks and clock oscillators are selectable.

#### (1) Main system clock

#### <1> X1 oscillator

This circuit oscillates a clock of  $f_x = 4$  to 20 MHz. Oscillation can be stopped by executing the STOP instruction or using the main OSC control register (MOC).

#### <2> Internal high-speed oscillator

This circuit oscillates a clock of fosce = 8 MHz (TYP.). After a RESET release, the CPU always starts operating with this internal high-speed oscillation clock. Oscillation can be stopped by executing the STOP instruction or using the internal oscillator mode register (RCM).

An external main system clock (f<sub>EXT</sub> = 4 to 20 MHz) can also be supplied from the EXCLK pin. As the main system clock, a high-speed system clock (X1 clock or external main system clock) or internal high-speed oscillation clock can be selected by using the main clock mode register (MCM).

#### (2) Subsystem clock

#### Subsystem clock oscillator

This circuit oscillates at a frequency of  $f_{XT} = 32.768$  kHz by connecting a 32.768 kHz resonator across XT1 and XT2. Oscillation can be stopped by using the processor clock control register (PCC) and clock operation mode select register (OSCCTL).

An external subsystem clock (fexts = 32.768 kHz) can also be supplied from the EXCLKS pin.

#### (3) Internal low-speed oscillation clock (clock for watchdog timer)

#### Internal low-speed oscillator

This circuit oscillates a clock of fosc = 240 kHz (TYP.). After a reset release, the internal low-speed oscillation clock always starts operating.

Oscillation can be stopped by using the internal oscillation mode register (RCM) when "internal low-speed oscillator can be stopped by software" is set by option byte.

The internal low-speed oscillation clock cannot be used as the CPU clock. The following hardware operates with the internal low-speed oscillation clock.

#### Watchdog timer

• 8-bit timer TM50 (when fosc, fosc/2<sup>7</sup>, or fosc/2<sup>9</sup> is selected)

#### Remarks 1. fx: X1 clock oscillation frequency

- 2. fosca: Internal high-speed oscillation clock frequency
- 3. fext: External main system clock frequency
- 4. fxT: XT1 clock oscillation frequency
- 5. fEXTS: External subsystem clock frequency
- 6. fosc: Internal low-speed oscillation clock frequency



### 5.2 Configuration of Clock Generator

The clock generator includes the following hardware.

Item	Configuration				
Control registers	Processor clock control register (PCC)				
	Internal oscillator mode register (RCM)				
	Main clock mode register (MCM)				
	Main OSC control register (MOC)				
	Clock operation mode select register (OSCCTL)				
	Oscillation stabilization time counter status register (OSTC)				
	Oscillation stabilization time select register (OSTS)				
Oscillators	X1 oscillator				
	XT1 oscillator				
	Internal high-speed oscillator				
	Internal low-speed oscillator				





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Remark	fx:	X1 clock oscillation frequency
	fosca:	Internal high-speed oscillation clock frequency
	fext:	External main system clock frequency
	fin:	High-speed system clock oscillation frequency
	fmain:	Main system clock oscillation frequency
	fprs:	Peripheral hardware clock frequency
	fcpu:	CPU clock oscillation frequency
	fx⊤:	XT1 clock oscillation frequency
	fexts:	External subsystem clock frequency
	fsuв:	Subsystem clock frequency
	fosc:	Internal low-speed oscillation clock frequency

#### 5.3 Registers Controlling Clock Generator

The following seven registers are used to control the clock generator.

- Processor clock control register (PCC)
- Internal oscillator mode register (RCM)
- Main clock mode register (MCM)
- Main OSC control register (MOC)
- Clock operation mode select register (OSCCTL)
- Oscillation stabilization time counter status register (OSTC)
- Oscillation stabilization time select register (OSTS)



#### (1) Processor clock control register (PCC)

This register is used to select the CPU clock and the division ratio. PCC is set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation sets PCC to 01H.

#### Figure 5-2. Format of Processor Clock Control Register (PCC)



0

1

0

#### **Notes 1.** Bit 5 is read-only.

0

0

1

2. Be sure to switch CSS from 1 to 0 when bits 1 (MCS) and 0 (MCM0) of the main clock mode register (MCM) are 1.

Setting prohibited

Caution Be sure to clear bits 3 and 6 to 0.

Other than above

Remarks 1. fMAIN: Main system clock oscillation frequency

1

1

0

2. fsub: Subsystem clock frequency

The fastest instruction can be executed in 2 clocks of the CPU clock in the 78K0/Dx2. Therefore, the relationship between the CPU clock (fcPu) and the minimum instruction execution time is as shown in **Table 5-2**.



CPU Clock (fcpu)	Minimum Instruction Execution Time: 2/fcpu						
	High-Speed System Clock <sup>Note</sup>		Internal high-speed oscillation clock <sup>Note</sup>	Subsystem Clock			
	At 10 MHz Operation	At 20 MHz Operation	At 8 MHz (TYP.) Operation	At 32.768 kHz Operation			
fmain	0.2 <i>μ</i> s	0.1 <i>μ</i> s	0.25 μs (TYP.)	-			
fmain/2	0.4 <i>μ</i> s	0.2 <i>μ</i> s	0.5 μs (TYP.)	-			
fmain/2 <sup>2</sup>	0.8 <i>μ</i> s	0.4 <i>μ</i> s	1.0 μs (TYP.)	-			
fmain/2 <sup>3</sup>	1.6 <i>μ</i> s	0.8 <i>μ</i> s	2.0 μs (TYP.)	-			
fmain/2 <sup>4</sup>	3.2 <i>μ</i> s	1.6 <i>μ</i> s	4.0 μs (TYP.)	-			
fsub/2	_		_	122.1 <i>μ</i> s			

Table 5-2.	Relationship	between	CPU	Clock	and	Minimum	Instruction	Execution	Time
------------	--------------	---------	-----	-------	-----	---------	-------------	-----------	------

**Note** The main clock mode register (MCM) is used to set the CPU clock (high-speed system clock/internal high-speed oscillation clock) (see **Figure 5-4**).



#### (2) Internal oscillator mode register (RCM)

This register sets the operation mode of internal oscillator.

RCM can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to  $80H^{Note 1}$ .

#### Figure 5-3. Format of Internal Oscillator Mode Register (RCM)

Address: FF	A0H After	reset: 80H <sup>Note 1</sup>	R/W <sup>Note 2</sup>					
Symbol	<7>	6	5	4	3	2	<1>	<0>
RCM	RSTS	0	0	0	0	0	LSRSTOP	RSTOP

RSTS	Status of internal high-speed oscillator oscillation			
0	Waiting for stabilization of internal high-speed oscillator oscillation in high-accuracy mode (internal high-speed oscillator operation in low-accuracy mode)			
1	Internal high-speed oscillator operation in high-accuracy mode			

LSRSTOP	Internal low-speed oscillator oscillating/stopped			
0	Internal low-speed oscillator oscillating			
1	Internal low-speed oscillator stopped			

RSTOP	Internal high-speed oscillator oscillating/stopped			
0	Internal high-speed oscillator oscillating			
1	Internal high-speed oscillator stopped			

- **Notes 1.** The value of this register is 00H immediately after a reset release but automatically changes to 80H after internal high-speed oscillator oscillation has been stabilized.
  - 2. Bit 7 is read-only.
- Caution When setting RSTOP to 1, be sure to confirm that the CPU operates with a clock other than the internal high-speed oscillation clock. Specifically, set RSTOP to 1 under either of the following conditions.
  - When MCS = 1 (when CPU operates with the high-speed system clock)
  - When CLS = 1 (when CPU operates with the subsystem clock)



#### (3) Main clock mode register (MCM)

This register selects the main system clock supplied to CPU clock and clock supplied to peripheral hardware clock.

MCM can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears this register to 00H.

#### Figure 5-4. Format of Main Clock Mode Register (MCM) R/W<sup>Note</sup> Address: FFA1H After reset: 00H Symbol 6 <?> <0> 7 5 4 3 <1> MCM XSEL MCS MCM0 0 0 0 0 0

XSEL	MCM0	Selection of clock supplied to main system clock and peripheral hardware		
		Main system clock (fmain)	Peripheral hardware clock (fprs)	
0	0	Internal high-speed oscillation clock	Internal high-speed oscillation clock	
0	1	(fosca)	(fosca)	
1	0		High-speed system clock (fin)	
1	1	High-speed system clock (fin)		

MCS	Main system clock status			
0	Operates with internal high-speed oscillation clock			
1	Operates with high-speed system clock			

Note Bit 1 is read-only.

Cautions 1. XSEL can be changed only once after a reset release.

- 2. The peripheral hardware cannot operate when the peripheral hardware clock is stopped. To resume the operation of the peripheral hardware after the peripheral hardware clock has been stopped, initialize the peripheral hardware.
- 3. A clock other than fPRs is supplied to the following peripheral functions regardless of the setting of XSEL and MCM0.
  - Watchdog timer
  - When "fosc, fosc/2", fosc/2" is selected as the count clock for 8-bit timer TM50
  - Peripheral hardware selects the external clock as the clock source
- 4. It takes one clock to change the CPU clock.



#### (4) Main OSC control register (MOC)

This register selects the operation mode of the high-speed system clock.

This register is used to stop the X1 oscillator or to disable an external clock input from the EXCLK pin when the CPU operates with a clock other than the high-speed system clock.

MOC can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to 80H.

#### Figure 5-5. Format of Main OSC Control Register (MOC)

Address: FFA2H After reset: 80H R/W

Symbol	<7>	6	5	4	3	2	1	0
MOC	MSTOP	0	0	0	0	0	0	0

MSTOP	Control of high-speed system clock operation				
	X1 oscillation mode	External clock input mode			
0	X1 oscillator operating	External clock from EXCLK pin is enabled			
1	X1 oscillator stopped	External clock from EXCLK pin is disabled			

Cautions 1. When setting MSTOP to 1, be sure to confirm that the CPU operates with a clock other than the high-speed system clock. Specifically, set MSTOP to 1 under either of the following conditions.

- When MCS = 0 (when CPU operates with the internal high-speed oscillation clock)
- When CLS = 1 (when CPU operates with the subsystem clock)

In addition, stop peripheral hardware that is operating on the high-speed system clock before setting MSTOP to 1.

- 2. Do not clear MSTOP to 0 while bit 6 (OSCSEL) of the clock operation mode select register (OSCCTL) is 0.
- 3. The peripheral hardware cannot operate when the peripheral hardware clock is stopped. To resume the operation of the peripheral hardware after the peripheral hardware clock has been stopped, initialize the peripheral hardware.


# (5) Clock operation mode select register (OSCCTL)

This register selects the operation modes of the high-speed system and subsystem clocks. OSCCTL can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears this register to 00H.

# Figure 5-6. Format of Clock Operation Mode Select Register (OSCCTL)

Address: FFEFH After reset: 00H R/W

Symbol	<7>	<6>	<5>	<4>	3	2	1	<0>
OSCCTL	EXCLK	OSCSEL	EXCLKS	OSCSELS	0	0	0	AMPH

EXCLK	OSCSEL	High-speed system clock operation mode	P121/X1 pin	P122/X2/EXCLK pin
0	0	I/O port mode	I/O port	
0	1	X1 oscillation mode	Crystal/ceramic resonator connection	
1	0	I/O port mode	I/O port	
1	1	External clock input mode	I/O port	External clock input

EXCLKS	OSCSELS	Subsystem clock operation mode	P123/XT1 pin	P124/XT2/EXCLKS pin
0	0	I/O port mode	I/O port	
0	1	XT1 oscillation mode	Crystal resonator connection	
1	0	I/O port mode	I/O port	
1	1	External clock input mode	I/O port	External clock input

AMPH	Operating frequency control
0	$4 \text{ MHz} \leq f_{IN} \leq 10 \text{ MHz}$
1	$10 \text{ MHz} < f_{IN} \le 20 \text{ MHz}$

Cautions 1. Be sure to set AMPH to 1 if the high-speed system clock oscillation frequency exceeds 10 MHz.

- 2. Set AMPH before setting the main clock mode register (MCM).
- 3. Set AMPH before setting the peripheral functions after a reset release. The value of AMPH can be changed only once after a reset release. When the high-speed system clock (X1 oscillation) is selected as the CPU clock, supply of the CPU clock is stopped for 4.06 to 16.12  $\mu$ s after AMPH is set to 1. When the high-speed system clock (external clock input) is selected as the CPU clock, supply of the CPU clock is stopped for the duration of 160 external clocks after AMPH is set to 1.
- 4. If the STOP instruction is executed when AMPH = 1, supply of the CPU clock is stopped for 4.06 to 16.12  $\mu$ s after the STOP mode is released when the internal high-speed oscillation clock is selected as the CPU clock, or for the duration of 160 external clocks when the high-speed system clock (external clock input) is selected as the CPU clock. When the high-speed system clock (X1 oscillation) is selected as the CPU clock, the oscillation stabilization time is counted after the STOP mode is released.
- 5. AMPH can be changed only once after a reset release.

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- Cautions 6. To change the value of EXCLK and OSCSEL, be sure to confirm that bit 7 (MSTOP) of the main OSC control register (MOC) is 1 (the X1 oscillator stops or the external clock from the EXCLK pin is disabled).
  - 7. To change the value of EXCLKS and OSCSELS, confirm that bit 5 (CLS) of the processor clock control register (PCC) is 0 (the CPU is operating with the high-speed system clock).

Remark fin: High-speed system clock oscillation frequency



# (6) Oscillation stabilization time counter status register (OSTC)

This is the status register of the X1 clock oscillation stabilization time counter. If the internal high-speed oscillation clock or subsystem clock is used as the CPU clock, the X1 clock oscillation stabilization time can be checked.

OSTC can be read by a 1-bit or 8-bit memory manipulation instruction.

When reset is released (reset by  $\overrightarrow{\text{RESET}}$  input, POC, LVI, and WDT), the STOP instruction and MSTOP (bit 7 of MOC register) = 1 clear OSTC to 00H.

# Figure 5-7. Format of Oscillation Stabilization Time Counter Status Register (OSTC)

Address:	FFA3H	After reset:	00H	R
----------	-------	--------------	-----	---

Symbol OSTC

1	0	5	4	3	2		0
0	0	0	MOST11	MOST13	MOST14	MOST15	MOST16
MOST11	MOST13	MOST14	MOST15	MOST16	Oscillation	stabilization	time status
						[min.]	
						fx = 10 MHz	fx = 20 MHz
1	0	0	0	0	2 <sup>11</sup> /fx	204.8 μs	102.4 <i>μ</i> s
1	1	0	0	0	2 <sup>13</sup> /fx	819.2 <i>μ</i> s	409.6 <i>µ</i> s
1	1	1	0	0	2 <sup>14</sup> /fx	1.64 ms	819.2 <i>μ</i> s
1	1	1	1	0	2 <sup>15</sup> /fx	3.27 ms	1.64 ms
1	1	1	1	1	2 <sup>16</sup> /fx	6.55 ms	3.27 ms

Cautions 1. After the above time has elapsed, the bits are set to 1 in order from MOST11 and remain 1.

- 2. If the STOP mode is entered and then released while the internal high-speed oscillation clock or subsystem clock is being used as the CPU clock, set the oscillation stabilization time as follows.
  - Desired OSTC oscillation stabilization time ≤ Oscillation stabilization time set by OSTS

The oscillation stabilization time counter counts up to the oscillation stabilization time set by OSTS. Note, therefore, that only the status up to the oscillation stabilization time set by OSTS is set to OSTC after STOP mode is released.

3. The X1 clock oscillation stabilization wait time does not include the time until clock oscillation starts ("a" below).



Remark fx: X1 clock oscillation frequency



#### (7) Oscillation stabilization time select register (OSTS)

This register is used to select the X1 clock oscillation stabilization wait time when the STOP mode is released. The wait time set by OSTS is valid only after the STOP mode is released with the X1 clock selected as the CPU clock. After the STOP mode is released with the internal high-speed oscillation clock or subsystem clock selected as the CPU clock, the oscillation stabilization time must be confirmed by OSTC.

OSTS can be set by an 8-bit memory manipulation instruction.

Reset signal generation sets OSTS to 05H.

#### Figure 5-8. Format of Oscillation Stabilization Time Select Register (OSTS)

Address: FFA4H After reset: 05	5H R/W	
--------------------------------	--------	--

Symbol	7	6	5	4	3	2	1	0
OSTS	0	0	0	0	0	OSTS2	OSTS1	OSTS0

00700	00704	00700	O s sills	the state in the state of the state	-lester
05152	05151	05150	Oscilla	tion stabilization time s	election
				fx = 10 MHz	fx = 20 MHz
0	0	1	2 <sup>11</sup> /fx	204.8 μs	102.4 <i>μ</i> s
0	1	0	2 <sup>13</sup> /fx	819.2 <i>μ</i> s	409.6 μs
0	1	1	2 <sup>14</sup> /fx	1.64 ms	819.2 <i>μ</i> s
1	0	0	2 <sup>15</sup> /fx	3.27 ms	1.64 ms
1	0	1	2 <sup>16</sup> /fx	6.55 ms	3.27 ms
C	ther than abo	ve	Setting prohibited		

Cautions 1. To set the STOP mode when the X1 clock is used as the CPU clock, set OSTS before executing the STOP instruction.

- 2. Do not change the value of the OSTS register during the X1 clock oscillation stabilization time.
- 3. If the STOP mode is entered and then released while the internal high-speed oscillation clock or subsystem clock is being used as the CPU clock, set the oscillation stabilization time as follows.
  - Desired OSTC oscillation stabilization time ≤ Oscillation stabilization time set by OSTS

The oscillation stabilization time counter counts up to the oscillation stabilization time set by OSTS. Note, therefore, that only the status up to the oscillation stabilization time set by OSTS is set to OSTC after STOP mode is released.

4. The X1 clock oscillation stabilization wait time does not include the time until clock oscillation starts ("a" below).



Remark fx: X1 clock oscillation frequency



# 5.4 System Clock Oscillator

# 5.4.1 X1 oscillator

The X1 oscillator oscillates with a crystal resonator or ceramic resonator (4 to 20 MHz) connected to the X1 and X2 pins.

An external clock can also be input. In this case, input the clock signal to the EXCLK pin.

Figure 5-9 shows an example of the external circuit of the X1 oscillator.

# Figure 5-9. Example of External Circuit of X1 Oscillator

#### (a) Crystal or ceramic oscillation





(b) External clock

Cautions are listed on the next page.

# 5.4.2 XT1 oscillator

The XT1 oscillator oscillates with a crystal resonator (standard: 32.768 kHz) connected to the XT1 and XT2 pins. An external clock can also be input. In this case, input the clock signal to the EXCLKS pin. **Figure 5-10** shows an example of the external circuit of the XT1 oscillator.

# Figure 5-10. Example of External Circuit of XT1 Oscillator





(b) External clock



Cautions are listed on the next page.



Caution When using the X1 oscillator and XT1 oscillator, wire as follows in the area enclosed by the broken lines in the Figures 5-9 and 5-10 to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
- Do not cross the wiring with the other signal lines. Do not route the wiring near a signal line through which a high fluctuating current flows.
- Always make the ground point of the oscillator capacitor the same potential as Vss. Do not ground the capacitor to a ground pattern through which a high current flows.
- Do not fetch signals from the oscillator.

Note that the XT1 oscillator is designed as a low-amplitude circuit for reducing power consumption.

Figure 5-11 shows examples of incorrect resonator connection.



Figure 5-11. Examples of Incorrect Resonator Connection (1/2)

**Remark** When using the subsystem clock, replace X1 and X2 with XT1 and XT2, respectively. Also, insert resistors in series on the XT2 side.



ξ

**V**DD



Vss

A

X1

в

High current

ł

- (c) Wiring near high alternating current
- (d) Current flowing through ground line of oscillator (potential at points A, B, and C fluctuates)

Pmn

X2

С



(e) Signals are fetched



- **Remark** When using the subsystem clock, replace X1 and X2 with XT1 and XT2, respectively. Also, insert resistors in series on the XT2 side.
- Caution When X2 and XT1 are wired in parallel, the crosstalk noise of X2 may increase with XT1, resulting in malfunctioning.



#### 5.4.3 When subsystem clock is not used

If it is not necessary to use the subsystem clock for low power consumption operations, or if not using the subsystem clock as an I/O port, set the XT1 and XT2 pins to I/O mode (OSCSELS = 0) and connect them as follows.

Input (PM123/PM124 = 1): Independently connect to  $V_{DD}$  or  $V_{SS}$  via a resistor. Output (PM123/PM124 = 0): Leave open.

Remark OSCSELS: Bit 4 of clock operation mode select register (OSCCTL) PM123, PM124: Bits 3 and 4 of port mode register 12 (PM12)

#### 5.4.4 Internal high-speed oscillator

The internal high-speed oscillator is incorporated in the 78K0/Dx2. Oscillation can be controlled by the internal oscillator mode register (RCM).

After a RESET release, the internal high-speed oscillation clock starts oscillation (8 MHz (TYP.)).

#### 5.4.5 Internal low-speed oscillator

The internal low-speed oscillator is incorporated in the 78K0/Dx2.

The internal low-speed oscillation clock is only used as the watchdog timer and the clock of 8-bit timer H1. The internal low-speed oscillation clock cannot be used as the CPU clock.

"Can be stopped by software" or "Cannot be stopped" can be selected by the option byte. When "Can be stopped by software" is set, oscillation can be controlled by the internal oscillator mode register (RCM).

After a RESET release, the internal low-speed oscillation clock starts oscillation and the watchdog timer is operated (240 kHz (TYP.)).

#### 5.4.6 Prescaler

The prescaler generates various clocks by dividing the main system clock when the main system clock is selected as the clock to be supplied to the CPU.



# 5.5 Clock Generator Operation

The clock generator generates the following clocks and controls the operation modes of the CPU, such as standby mode.

- Main system clock fmain
  - High-speed system clock fin
    - X1 clock fx
    - External main system clock fEXT
  - Internal high-speed oscillation clock fosce
- Subsystem clock fsub
  - XT1 clock fxT
  - External subsystem clock fEXTS
- Internal low-speed oscillation clock fosc
- CPU clock fcpu
- Peripheral hardware clock fprs

The CPU starts operation when the on-chip internal high-speed oscillator starts outputting after a reset release in the 78K0/Dx2, thus enabling the following.

# (1) Enhancement of security function

When the X1 clock is set as the CPU clock by the default setting, the device cannot operate if the X1 clock is damaged or badly connected and therefore does not operate after reset is released. However, the start clock of the CPU is the on-chip internal high-speed oscillation clock, so the device can be started by the internal high-speed oscillation clock after a reset release. Consequently, the system can be safely shut down by performing a minimum operation, such as acknowledging a reset source by software or performing safety processing when there is a malfunction.



# (2) Improvement of performance

Because the CPU can be started without waiting for the X1 clock oscillation stabilization time, the total performance can be improved.

A timing diagram of the CPU default start using the internal high-speed oscillation clock is shown in **Figures 5-12** and **5-13**.





- **Notes 1.** The internal voltage stabilization time includes the oscillation accuracy stabilization time of the internal high-speed oscillation clock.
  - 2. When releasing a reset (above figure) or releasing STOP mode while the CPU is operating on the internal high-speed oscillation clock, confirm the oscillation stabilization time for the X1 clock using the oscillation stabilization time counter status register (OSTC). If the CPU operates on the high-speed system clock (X1 oscillation), set the oscillation stabilization time when releasing STOP mode using the oscillation stabilization time select register (OSTS).
  - <1> The internal reset signal by the power-on clear (POC) circuit is generated after a power supply injection.
  - <2> If power supply voltage exceeds 1.59 V (TYP.), reset will be released and the oscillation start of the high-speed oscillator will be carried out automatically.
  - <3> If power supply voltage is rose by inclination of 0.5 V/ms (MIN.), after the voltage stable waiting time of a power supply/regulator passed after reset release and reset processing will be performed, CPU carries out a start of operation with high-speed oscillation clock.
  - <4> One clock or XT1 clock should set up an oscillation start by software (see (1) in 5.6.1 Controlling high-speed system clock and (1) in 5.6.3 Example of controlling subsystem clock).
  - <5> When you change CPU to X1 clock or XT1 clock, set up a change by software after the oscillation stability waiting of a clock (see (3) in 5.6.1 Controlling high-speed system clock and (3) in 5.6.3 Example of controlling subsystem clock).

- Cautions 1. When the standup of voltage until it reaches 1.8 V from the time of a power supply injection is looser than 0.5 V/ms (MIN.), input a low level into RESET pin, or set up 2.7 V/1.59 V POC mode (LVISTART = 1) from an option byte until it reaches 1.8 V from the time of a power supply injection (refer to Figure 5-13). When a low level is inputted into RESET pin until it reaches 1.8 V, after the reset release by RESET pin operates to the same timing as <2> of Figure 5-12 or subsequent ones.
  - 2. When using the external clock input from EXCLK pin and EXCLKS pin, oscillation stable waiting time is unnecessary.
- Remark The clock which is not used as a CPU clock can be suspended by setup of software during microcomputer operation. Moreover, high-speed oscillation clock and a high-speed system clock can suspend a clock by execution of a STOP command (see (4) in 5.6.1 Controlling high-speed system clock, (3) in 5.6.2 Example of controlling internal high-speed oscillation clock, and (4) in 5.6.3 Example of controlling subsystem clock).

Figure 5-13 Operation of the Clock Generating Circuit When Power Supply Voltage Injection (When 2.7 V/1.59V POC mode setup (option byte: LVISTART = 1))



**Note** Check the oscillation stable time of X1 clock with an oscillation stable time counter status register (OSTC) when STOP mode release in case the time of reset release (above figure) and a CPU clock are high-speed oscillation clocks. Moreover, when a CPU clock is a high-speed system clock (X1 oscillation), set up the oscillation stable time at the time of STOP mode release by the oscillation stable time selection register (OSTS).



- <1> The internal reset signal by the power-on clear (POC) circuit is generated after a power supply injection.
- <2> If power supply voltage exceeds 1.59 V (TYP.), reset will be canceled and the oscillation start of the high-speed oscillator will be carried out automatically.
- <3> After reset release, after reset processing is performed, CPU carries out a start of operation with high-speed oscillation clock.
- <4> X1 clock or XT1 clock should set up an oscillation start by software (see (1) in 5.6.1 Controlling highspeed system clock and (1) in 5.6.3 Example of controlling subsystem clock).
- <5> When you change CPU to X1 clock or XT1 clock, set up a change by software after the oscillation stability waiting of a clock (see (3) in 5.6.1 Controlling high-speed system clock and (3) in 5.6.3 Example of controlling subsystem clock).
- Cautions 1. A voltage oscillation stabilization time of 1.93 to 5.39 ms is required after the supply voltage reaches 1.59 V (TYP.). If the supply voltage rises from 1.59 V (TYP.) to 2.7 V (TYP.) within 1.93 ms, the power supply oscillation stabilization time of 0 to 5.39 ms is automatically generated before reset processing.
  - 2. It is not necessary to wait for the oscillation stabilization time when an external clock input from the EXCLK and EXCLKS pins is used.
- Remark The clock which is not used as a CPU clock can be suspended by setup of software during microcomputer operation. Moreover, high-speed oscillation clock and a high-speed system clock can suspend a clock by execution of a STOP command (see (4) in 5.6.1 Controlling high-speed system clock, (3) in 5.6.2 Example of controlling internal high-speed oscillation clock, and (4) in 5.6.3 Example of controlling subsystem clock).



# 5.6 Controlling Clock

# 5.6.1 Controlling high-speed system clock

The following two types of high-speed system clocks are available.

- X1 clock: Crystal/ceramic resonator is connected across the X1 and X2 pins.
- External main system clock: External clock is input to the EXCLK pin.

When the high-speed system clock is not used, the X1/P121 and X2/EXCLK/P122 pins can be used as I/O port pins.

# Caution The X1/P121 and X2/EXCLK/P122 pins are in the I/O port mode after a reset release.

The following describes examples of setting procedures for the following cases.

- (1) When oscillating X1 clock
- (2) When using external main system clock
- (3) When using high-speed system clock as CPU clock and peripheral hardware clock
- (4) When stopping high-speed system clock



# (1) Example of setting procedure when oscillating the X1 clock

<1> Setting frequency (OSCCTL register)

Using AMPH, set the gain of the on-chip oscillator according to the frequency to be used.

AMPH <sup>Note</sup>	Operating Frequency Control
0	$4 \text{ MHz} \le f_{IN} \le 10 \text{ MHz}$
1	$10 \text{ MHz} < f_{IN} \le 20 \text{ MHz}$

**Note** Set AMPH before setting the peripheral functions after a reset release. The value of AMPH can be changed only once after a reset release. When AMPH is set to 1, the clock supply to the CPU is stopped for 4.06 to 16.12  $\mu$ s.

Remark fin: High-speed system clock oscillation frequency

<2> Setting P121/X1 and P122/X2/EXCLK pins and selecting X1 clock or external clock (OSCCTL register) When EXCLK is cleared to 0 and OSCSEL is set to 1, the mode is switched from port mode to X1 oscillation mode.

EXCLK	OSCSEL	Operation Mode of High- Speed System Clock Pin	P121/X1 Pin	P122/X2/EXCLK Pin
0	1	X1 oscillation mode	Crystal/ceramic resonat	or connection

- <3> Controlling oscillation of X1 clock (MOC register) If MSTOP is cleared to 0, the X1 oscillator starts oscillating.
- <4> Waiting for the stabilization of the oscillation of X1 clock Check the OSTC register and wait for the necessary time. During the wait time, other software processing can be executed with the internal high-speed oscillation clock.
- Cautions 1. Do not change the value of EXCLK and OSCSEL while the X1 clock is operating.
  - 2. Set the X1 clock after the supply voltage has reached the operable voltage of the clock to be used (see CHAPTER 29 ELECTRICAL SPECIFICATIONS ((A) GRADE PRODUCTS)).



# (2) Example of setting procedure when using the external main system clock

<1> Setting frequency (OSCCTL register)

Using AMPH, set the frequency to be used.

AMPH <sup>Note</sup>	Operating Frequency Control
0	$4 \text{ MHz} \le f_{IN} \le 10 \text{ MHz}$
1	10 MHz < $f_{IN} \le 20$ MHz

**Note** Set AMPH before setting the peripheral functions after a reset release. The value of AMPH can be changed only once after a reset release. The clock supply to the CPU is stopped for the duration of 160 external clocks after AMPH is set to 1.

Remark fin: High-speed system clock oscillation frequency

<2> Setting P121/X1 and P122/X2/EXCLK pins and selecting operation mode (OSCCTL register) When EXCLK and OSCSEL are set to 1, the mode is switched from port mode to external clock input

mode.

EXCLK	OSCSEL	Operation Mode of High- Speed System Clock Pin	P121/X1 Pin	P122/X2/EXCLK Pin
1	1	External clock input mode	I/O port	External clock input

- <3> Controlling external main system clock input (MOC register) When MSTOP is cleared to 0, the input of the external main system clock is enabled.
- Cautions 1. Do not change the value of EXCLK and OSCSEL while the external main system clock is operating.
  - 2. Set the external main system clock after the supply voltage has reached the operable voltage of the clock to be used (see CHAPTER 29 ELECTRICAL SPECIFICATIONS ((A) GRADE PRODUCTS)).



- (3) Example of setting procedure when using high-speed system clock as CPU clock and peripheral hardware clock
  - <1> Setting high-speed system clock oscillation<sup>Note</sup>

(See 5.6.1 (1) Example of setting procedure when oscillating the X1 clock and (2) Example of setting procedure when using the external main system clock.)

Note The setting of <1> is not necessary when high-speed system clock is already operating.

<2> Setting the high-speed system clock as the main system clock (MCM register)

When XSEL and MCM0 are set to 1, the high-speed system clock is supplied as the main system clock and peripheral hardware clock.

XSEL	MCM0	Selection of Main System Clock and C	Clock Supplied to Peripheral Hardware
		Main System Clock (fmain)	Peripheral Hardware Clock (fprs)
1	1	High-speed system clock (fin)	High-speed system clock (fin)

# Caution If the high-speed system clock is selected as the main system clock, a clock other than the high-speed system clock cannot be set as the peripheral hardware clock.

<3> Setting the main system clock as the CPU clock and selecting the division ratio (PCC register) When CSS is cleared to 0, the main system clock is supplied to the CPU. To select the CPU clock division ratio, use PCC0, PCC1, and PCC2.

CSS	PCC2	PCC1	PCC0	CPU Clock (fcPu) Selection
0	0	0	0	fmain
	0	0	1	fmain/2 (default)
	0	1	0	fmain/2 <sup>2</sup>
	0	1	1	fmain/2 <sup>3</sup>
	1	0	0	fmain/2 <sup>4</sup>
	Other than above			Setting prohibited



# (4) Example of setting procedure when stopping the high-speed system clock

The high-speed system clock can be stopped in the following two ways.

- Executing the STOP instruction and stopping the X1 oscillation (disabling clock input if the external clock is used)
- Setting MSTOP to 1 and stopping the X1 oscillation (disabling clock input if the external clock is used)

#### (a) To execute a STOP instruction

<1> Setting to stop peripheral hardware

Stop peripheral hardware that cannot be used in the STOP mode (for peripheral hardware that cannot be used in STOP mode, see **CHAPTER 20 STANDBY FUNCTION**).

- <2> Setting the X1 clock oscillation stabilization time after standby release When the CPU is operating on the X1 clock, set the value of the OSTS register before the STOP instruction is executed.
- <3> Executing the STOP instruction

When the STOP instruction is executed, the system is placed in the STOP mode and X1 oscillation is stopped (the input of the external clock is disabled).

# (b) To stop X1 oscillation (disabling external clock input) by setting MSTOP to 1

<1> Confirming the CPU clock status (PCC and MCM registers)

Confirm with CLS and MCS that the CPU is operating on a clock other than the high-speed system clock.

When CLS = 0 and MCS = 1, the high-speed system clock is supplied to the CPU, so change the CPU clock to the subsystem clock or internal high-speed oscillation clock.

CLS	MCS	CPU Clock Status		
0	0	Internal high-speed oscillation clock		
0	1	High-speed system clock		
1	×	Subsystem clock		

<2> Stopping the high-speed system clock (MOC register)

When MSTOP is set to 1, X1 oscillation is stopped (the input of the external clock is disabled).

# Caution Be sure to confirm that MCS = 0 or CLS = 1 when setting MSTOP to 1. In addition, stop peripheral hardware that is operating on the high-speed system clock.



# 5.6.2 Example of controlling internal high-speed oscillation clock

- The following describes examples of clock setting procedures for the following cases.
- (1) When restarting oscillation of the internal high-speed oscillation clock
- (2) When using internal high-speed oscillation clock as CPU clock, and internal high-speed oscillation clock or high-speed system clock as peripheral hardware clock
- (3) When stopping the internal high-speed oscillation clock
- (1) Example of setting procedure when restarting oscillation of the internal high-speed oscillation clock<sup>Note 1</sup>
  - <1> Setting restart of oscillation of the internal high-speed oscillation clock (RCM register) When RSTOP is cleared to 0, the internal high-speed oscillation clock starts operating.
  - <2> Waiting for the oscillation accuracy stabilization time of internal high-speed oscillation clock (RCM register)

Wait until RSTS is set to 1<sup>Note 2</sup>.

- **Notes 1.** After a reset release, the internal high-speed oscillator automatically starts oscillating and the internal high-speed oscillation clock is selected as the CPU clock.
  - 2. This wait time is not necessary if high accuracy is not necessary for the CPU clock and peripheral hardware clock.
- (2) Example of setting procedure when using internal high-speed oscillation clock as CPU clock, and internal high-speed oscillation clock or high-speed system clock as peripheral hardware clock
  - <1> Restarting oscillation of the internal high-speed oscillation clock<sup>Note</sup> (See 5.6.2 (1) Example of setting procedure when restarting internal high-speed oscillation clock).
    - Oscillating the high-speed system clock<sup>Note</sup> (This setting is required when using the high-speed system clock as the peripheral hardware clock. See 5.6.1 (1) Example of setting procedure when oscillating the X1 clock and (2) Example of setting procedure when using the external main system clock.)
      - **Note** The setting of <1> is not necessary when the internal high-speed oscillation clock or high-speed system clock is already operating.
  - <2> Selecting the clock supplied as the main system clock and peripheral hardware clock (MCM register) Set the main system clock and peripheral hardware clock using XSEL and MCM0.

XSEL	MCM0	Selection of Main System Clock and Clock Supplied to Peripheral Hardware			
		Main System Clock (fmain)	Peripheral Hardware Clock (fprs)		
0	0	Internal high-speed oscillation clock	Internal high-speed oscillation clock		
0	1	(fosca)	(fosca)		
1	0		High-speed system clock (fin)		



<3> Selecting the CPU clock division ratio (PCC register)

When CSS is cleared to 0, the main system clock is supplied to the CPU. To select the CPU clock division ratio, use PCC0, PCC1, and PCC2.

CSS	PCC2	PCC1	PCC0	CPU Clock (fcPu) Selection
0	0	0	0	fmain
	0	0	1	fmain/2 (default)
	0	1	0	fmain/2 <sup>2</sup>
	0	1	1	fmain/2 <sup>3</sup>
	1	0	0	fmain/2 <sup>4</sup>
	Other than above		ve	Setting prohibited

# (3) Example of setting procedure when stopping the internal high-speed oscillation clock

The internal high-speed oscillation clock can be stopped in the following two ways.

- Executing the STOP instruction to set the STOP mode
- Setting RSTOP to 1 and stopping the internal high-speed oscillation clock

# (a) To execute a STOP instruction

<1> Setting of peripheral hardware

Stop peripheral hardware that cannot be used in the STOP mode (for peripheral hardware that cannot be used in STOP mode, see **CHAPTER 20 STANDBY FUNCTION**).

- <2> Setting the X1 clock oscillation stabilization time after standby release When the CPU is operating on the X1 clock, set the value of the OSTS register before the STOP instruction is executed.
- <3> Executing the STOP instruction

When the STOP instruction is executed, the system is placed in the STOP mode and internal highspeed oscillation clock is stopped.

# (b) To stop internal high-speed oscillation clock by setting RSTOP to 1

- <1> Confirming the CPU clock status (PCC and MCM registers)
  - Confirm with CLS and MCS that the CPU is operating on a clock other than the internal high-speed oscillation clock.

When CLS = 0 and MCS = 0, the internal high-speed oscillation clock is supplied to the CPU, so change the CPU clock to the high-speed system clock or subsystem clock.

CLS	MCS	CPU Clock Status		
0	0	Internal high-speed oscillation clock		
0	1	High-speed system clock		
1	×	Subsystem clock		

<2> Stopping the internal high-speed oscillation clock (RCM register)

When RSTOP is set to 1, internal high-speed oscillation clock is stopped.

Caution Be sure to confirm that MCS = 1 or CLS = 1 when setting RSTOP to 1. In addition, stop peripheral hardware that is operating on the internal high-speed oscillation clock.

#### 5.6.3 Example of controlling subsystem clock

The following two types of subsystem clocks are available.

- XT1 clock: Crystal/ceramic resonator is connected across the XT1 and XT2 pins.
- External subsystem clock: External clock is input to the EXCLKS pin.

When the subsystem clock is not used, the XT1/P123 and XT2/EXCLKS/P124 pins can be used as I/O port pins.

# Caution The XT1/P123 and XT2/EXCLKS/P124 pins are in the I/O port mode after a reset release.

The following describes examples of setting procedures for the following cases.

- (1) When oscillating XT1 clock
- (2) When using external subsystem clock
- (3) When using subsystem clock as CPU clock
- (4) When stopping subsystem clock

# (1) Example of setting procedure when oscillating the XT1 clock

<1> Setting XT1 and XT2 pins and selecting operation mode (PCC and OSCCTL registers) When EXCLKS and OSCSELS are set as any of the following, the mode is switched from port mode to XT1 oscillation mode.

EXCLKS	OSCSELS	Operation Mode of	P123/XT1 Pin	P124/XT2/
		Subsystem Clock Pin		EXCLKS Pin
0	1	XT1 oscillation mode	Crystal/ceramic resonator of	connection

<2> Waiting for the stabilization of the subsystem clock oscillation Wait for the oscillation stabilization time of the subsystem clock by software, using a timer function.

#### Caution Do not change the value of EXCLKS and OSCSELS while the subsystem clock is operating.

#### (2) Example of setting procedure when using the external subsystem clock

<1> Setting XT1 and XT2 pins, selecting XT1 clock/external clock and controlling oscillation (PCC and OSCCTL registers)

When EXCLKS and OSCSELS are set to 1, the mode is switched from port mode to external clock input mode. In this case, input the external clock to the EXCLKS/XT2/P124 pins.

EXCLKS	OSCSELS	Operation Mode of	P123/XT1 Pin	P124/XT2/
		Subsystem Clock Pin		EXCLKS Pin
1	1	External clock input mode	I/O port	External clock input

#### Caution Do not change the value of EXCLKS and OSCSELS while the subsystem clock is operating.



# (3) Example of setting procedure when using the subsystem clock as the CPU clock

<1> Setting subsystem clock oscillation<sup>Note</sup>

# (See 5.6.3 (1) Example of setting procedure when oscillating the XT1 clock and (2) Example of setting procedure when using the external subsystem clock.)

Note The setting of <1> is not necessary when while the subsystem clock is operating.

<2> Switching the CPU clock (PCC register)

When CSS is set to 1, the subsystem clock is supplied to the CPU.

CSS	PCC2	PCC1	PCC0	CPU Clock (fcPu) Selection		
1	0	0	0	fsub/2		
	0	0	1			
	0	1	0			
	0	1	1			
	1	0	0			
	Ot	her than abo	ve	Setting prohibited		

# (4) Example of setting procedure when stopping the subsystem clock

<1> Confirming the CPU clock status (PCC and MCM registers)

Confirm with CLS and MCS that the CPU is operating on a clock other than the subsystem clock. When CLS = 1, the subsystem clock is supplied to the CPU, so change the CPU clock to the internal high-speed oscillation clock or high-speed system clock.

CLS	MCS	CPU Clock Status		
0	0	Internal high-speed oscillation clock		
0	1	High-speed system clock		
1	×	Subsystem clock		

<2> Stopping the subsystem clock (OSCCTL register)

When OSCSELS is cleared to 0, XT1 oscillation is stopped (the input of the external clock is disabled).

# Cautions 1. Be sure to confirm that CLS = 0 when clearing OSCSELS to 0. In addition, stop the watch timer if it is operating on the subsystem clock.

2. The subsystem clock oscillation cannot be stopped using the STOP instruction.



# 5.6.4 Controlling internal low-speed oscillation clock

The internal low-speed oscillation clock is a clock for the watchdog timer. It cannot be used as the CPU clock. With this clock, only the following peripheral hardware can operate.

- Watchdog timer
- 8-bit timer H1 (if fosc is selected as the count clock)

In addition, the following operation modes can be selected by the option byte.

- Internal low-speed oscillation clock oscillation cannot be stopped
- Internal low-speed oscillation clock oscillation can be stopped by software

The internal low-speed oscillator automatically starts oscillation after a reset release, and the watchdog timer is driven (240 kHz (TYP.)) if the watchdog timer operation has been enabled by the option byte.

- (1) To stop the internal low-speed oscillation clock (example of setting method)
  - <1> Setting LSRSTOP to 1 (RCM register)
    - If LSRSTOP is set to 1, the internal low-speed oscillator oscillation is stopped.
- (2) To oscillate the internal low-speed oscillation clock (example of setting method)
  - <1> Clearing LSRSTOP to 0 (RCM register)
    - If LSRSTOP is cleared to 0, the internal low-speed oscillation clock is oscillated.

# Caution If "Internal low-speed oscillation clock oscillation cannot be stopped" is selected by the option byte, oscillation of the internal low-speed oscillation clock cannot be controlled.

# 5.6.5 Clocks supplied to CPU and peripheral hardware

The following table shows the relation among the clocks supplied to the CPU and peripheral hardware, and setting of registers.

XSEL	CSS	MCM0	EXCLK	Supplied Clock	
				Clock Supplied to CPU	Clock Supplied to Peripheral Hardware
0	0	×	×	Internal high-speed oscillation clo	ock
0	1	×	×	Subsystem clock	Internal high-speed oscillation clock
1	0	0	0	Internal high-speed oscillation	X1 clock
1	0	0	1	1 clock	External main system clock
1	0	1	0	X1 clock	
1	0	1	1	External main system clock	
1	1	0	0	Subsystem clock	X1 clock
1	1	0	1		External main system clock
1	1	1	0		X1 clock
1	1	1	1		External main system clock

 Table 5-3. Clocks Supplied to CPU and Peripheral Hardware, and Register Setting

Remarks 1. XSEL: Bit 2 of the main clock mode register (MCM)

2. CSS: Bit 4 of the processor clock control register (PCC)

3. MCM0: Bit 0 of MCM

4. EXCLK: Bit 7 of the clock operation mode select register (OSCCTL)

# 5.6.6 CPU clock status transition diagram

Figure 5-14 shows the CPU clock status transition diagram of this product.



# Figure 5-14. CPU Clock Status Transition Diagram (When 1.59 V POC Mode is Set (Option Byte: LVISTART = 0))

**Remark** In the 2.7 V/1.59 V POC mode (option byte: LVISTART = 1), the CPU clock status changes to (A) in the above figure when the supply voltage exceeds 2.7 V (TYP.), and to (B) after reset processing (11 to 45  $\mu$ s).

Table 5-4 shows transition of the CPU clock and examples of setting the SFR registers.



# Table 5-4. CPU Clock Transition and SFR Register Setting Examples (1/5)

# (1) CPU operating with high-speed system clock (C) after reset release (A)

(The CPU operates with the internal high-speed oscillation clock immediately after a reset release (B).)

(Setting sequence of SFR registers)							
Setting Flag of SFR Register Status Transition	AMPH	EXCLK	OSCSEL	MSTOP	OSTC Register	XSEL	MCM0
$(A) \rightarrow (B) \rightarrow (C)$ (X1 clock: less than 10 MHz)	0	0	1	0	Must be checked	1	1
$(A) \rightarrow (B) \rightarrow (C)$ (external main clock: less than 10 MHz)	0	1	1	0	Must not be checked	1	1
(A) $\rightarrow$ (B) $\rightarrow$ (C) (X1 clock: 10 MHz or more)	1	0	1	0	Must be checked	1	1
$(A) \rightarrow (B) \rightarrow (C)$ (external main clock: 10 MHz or more)	1	1	1	0	Must not be checked	1	1

# (2) CPU operating with internal high-speed oscillation clock (B) after reset release (A)

Status Transition	SFR Register Setting
$(A) \rightarrow (B)$	SFR registers do not have to be set (default status after reset release).

#### (3) CPU operating with subsystem clock (D) after reset release (A)

(The CPU operates with the internal high-speed oscillation clock immediately after a reset release (B).)

(Setting sequence of SFR registers)				
Setting Flag of SFR Register Status Transition	EXCLKS	OSCSELS	Waiting for Oscillation Stabilization	CSS
$(A) \rightarrow (B) \rightarrow (D) (XT1 \text{ clock})$	0	1	Necessary	1
$(A) \rightarrow (B) \rightarrow (D)$ (external subsystem clock)	1	1	Unnecessary	1

#### Remarks 1. (A) to (I) in Table 5-4 correspond to (A) to (I) in Figure 5-14.

2. EXCLK, OSCSEL, EXCLKS, OSCSELS, AMPH:

Bits 7 to 4 and 0 of the clock operation mode select register (OSCCTL)

MSTOP: Bit 7 of the main OSC control register (MOC)

XSEL, MCM0: Bits 2 and 0 of the main clock mode register (MCM)

CSS: Bit 4 of the processor clock control register (PCC)



# Table 5-4. CPU Clock Transition and SFR Register Setting Examples (2/5)

# (4) CPU clock changing from internal high-speed oscillation clock (B) to high-speed system clock (C)

(Setting sequence of SFR registers)							
Setting Flag of SFR Register Status Transition	AMPH	EXCLK	OSCSEL	MSTOP	OSTC Register	XSEL	MCM0
(B) $\rightarrow$ (C) (X1 clock: less than 10 MHz)	0	0	1	0	Must be checked	1	1
(B) $\rightarrow$ (C) (external main clock: less than 10 MHz)	0	1	1	0	Must not be checked	1	1
(B) $\rightarrow$ (C) (X1 clock: 10 MHz or more)	1	0	1	0	Must be checked	1	1
(B) $\rightarrow$ (C) (external main clock: 10 MHz or more)	1	1	1	0	Must not be checked	1	1
						$\uparrow$	
	Unnecessary if these registers are already set			Unneces CPU is o	sary if the operating	Unnecess register is	ary if this s already

(Setting sequence of SFR registers)

# (5) CPU clock changing from internal high-speed oscillation clock (B) to subsystem clock (D)

(Setting sequence of SFR registers)				
Setting Flag of SFR Register Status Transition	EXCLKS	OSCSELS	Waiting for Oscillation Stabilization	CSS
(B) $\rightarrow$ (D) (XT1 clock)	0	1	Necessary	1
(B) $\rightarrow$ (D) (external subsystem clock)	1	1	Unnecessary	1

Unnecessary if the CPU is operating with the subsystem clock

with the high-speed

system clock

set

**Remarks 1.** (A) to (I) in **Table 5-4** correspond to (A) to (I) in **Figure 5-14**.

2. EXCLK, OSCSEL, EXCLKS, OSCSELS, AMPH:

Bits 7 to 4 and 0 of the clock operation mode select register (OSCCTL)

MSTOP: Bit 7 of the main OSC control register (MOC)

XSEL, MCM0: Bits 2 and 0 of the main clock mode register (MCM)

CSS: Bit 4 of the processor clock control register (PCC)



# Table 5-4. CPU Clock Transition and SFR Register Setting Examples (3/5)

# (6) CPU clock changing from high-speed system clock (C) to internal high-speed oscillation clock (B)

(Setting sequence of SFR registers)			
Setting Flag of SFR Register	RSTOP	RSTS	MCM0
Status Transition			
$(C) \to (B)$	0	Confirm this flag is 1.	0

Unnecessary if the CPU is operating

with the internal high-speed oscillation clock

# (7) CPU clock changing from high-speed system clock (C) to subsystem clock (D)

(Setting sequence of SFR registers)				<b>▶</b>
Setting Flag of SFR Register Status Transition	EXCLKS	OSCSELS	Waiting for Oscillation Stabilization	CSS
$(C) \rightarrow (D) (XT1 clock)$	0	1	Necessary	1
(C) $\rightarrow$ (D) (external subsystem clock)	1	1	Unnecessary	1

Unnecessary if the CPU is operating with the subsystem clock

# Remarks 1. (A) to (I) in Table 5-4 correspond to (A) to (I) in Figure 5-14.

2. EXCLKS, OSCSELS:

	Bits 5and 4 of the clock operation mode select register (OSCCTL)
MCM0:	Bit 0 of the main clock mode register (MCM)
CSS:	Bit 4 of the processor clock control register (PCC)
RSTS, RSTOP:	Bits 7 and 0 of the internal oscillator mode register (RCM)



# Table 5-4. CPU Clock Transition and SFR Register Setting Examples (4/5)

# (8) CPU clock changing from subsystem clock (D) to high-speed system clock (C)

(Setting sequence of SFR registers)								
Setting Flag of SFR Register Status Transition	AMPH	EXCLK	OSCSEL	MSTOP	OSTC Register	XSEL	MCM0	CSS
(D) $\rightarrow$ (C) (X1 clock: less than 10 MHz)	0	0	1	0	Must be checked	1	1	0
(D) $\rightarrow$ (C) (external main clock: less than 10 MHz)	0	1	1	0	Must not be checked	1	1	0
(D) $\rightarrow$ (C) (X1 clock: 10 MHz or more)	1	0	1	0	Must be checked	1	1	0
(D) $\rightarrow$ (C) (external main clock: 10 MHz or more)	1	1	1	0	Must not be checked	1	1	0
						$\uparrow$		

Unnecessary if these registers Unnecessary if the are already set

CPU is operating with the high-speed Unnecessary if this register is already set

#### system clock

#### (9) CPU clock changing from subsystem clock (D) to internal high-speed oscillation clock (B)

(Setting sequence of SFR registers)				<b>▶</b>
Setting Flag of SFR Register	RSTOP	RSTS	MCM0	CSS
Status Transition				
$(D) \to (B)$	0	Confirm this flag is 1.	0	0
$\frown$				

Unnecessary if the CPU is operating with Unnecessary if the internal high-speed oscillation clock XSEL is 0

Remarks 1. (A) to (I) in Table 5-4 correspond to (A) to (I) in Figure 5-14.

2. EXCLK, OSCSEL, AMPH:

	Bits 7, 6, and 0 of the clock operation mode select register (OSCCTL)
MSTOP:	Bit 7 of the main OSC control register (MOC)
XSEL, MCM0:	Bits 2 and 0 of the main clock mode register (MCM)
CSS:	Bit 4 of the processor clock control register (PCC)
RSTS, RSTOP:	Bits 7 and 0 of the internal oscillator mode register (RCM)



# Table 5-4. CPU Clock Transition and SFR Register Setting Examples (5/5)

(10) • HALT mode (E) set while CPU is operating with internal high-speed oscillation clock (B)

- HALT mode (F) set while CPU is operating with high-speed system clock (C)
  - HALT mode (G) set while CPU is operating with subsystem clock (D)

Status Transition	Setting
$(B) \to (E)$	Executing HALT instruction
$(C) \rightarrow (F)$	
$(D) \to (G)$	

# (11) • STOP mode (H) set while CPU is operating with internal high-speed oscillation clock (B)

• STOP mode (I) set while CPU is operating with high-speed system clock (C)

(Setting sequence)						
Status Transition	Setting					
$(B) \to (H)$	Stopping peripheral functions that	Executing STOP instruction				
$(C) \to (I)$	cannot operate in STOP mode					

Remark (A) to (I) in Table 5-4 correspond to (A) to (I) in Figure 5-14.



# 5.6.7 Condition before changing CPU clock and processing after changing CPU clock

Condition before changing the CPU clock and processing after changing the CPU clock are shown below.

CPU Clock		Condition Before Change	Processing After Change					
Before Change	After Change							
Internal high- speed oscillation clock	X1 clock	Stabilization of X1 oscillation • MSTOP = 0, OSCSEL = 1, EXCLK = 0 • After elapse of oscillation stabilization time	<ul> <li>Internal high-speed oscillator can be stopped (RSTOP = 1).</li> <li>Clock supply to CPU is stopped for 4.06 to 16.12 μs after AMPH has been set to 1.</li> </ul>					
	External main system clock	Enabling input of external clock from EXCLK pin • MSTOP = 0, OSCSEL = 1, EXCLK = 1	<ul> <li>Internal high-speed oscillator can be stopped (RSTOP = 1).</li> <li>Clock supply to CPU is stopped for the duration of 160 external clocks from the EXCLK pin after AMPH has been set to 1.</li> </ul>					
X1 clock	Internal high-	Oscillation of internal high-speed oscillator	X1 oscillation can be stopped (MSTOP = 1).					
External main system clock	speed oscillation clock	• RSTOP = 0	External main system clock input can be disabled (MSTOP = 1).					
Internal high- speed oscillation clock	XT1 clock	Stabilization of XT1 oscillation • EXCLKS = 0, OSCSELS = 1 • After elapse of oscillation stabilization time	Operating current can be reduced by stopping internal high-speed oscillator (RSTOP = 1).					
X1 clock			X1 oscillation can be stopped (MSTOP = 1).					
External main system clock			External main system clock input can be disabled (MSTOP = 1).					
Internal high- speed oscillation clock	External subsystem clock	Enabling input of external clock from EXCLKS pin • EXCLKS = 1, OSCSELS = 1	Operating current can be reduced by stopping internal high-speed oscillator (RSTOP = 1).					
X1 clock			X1 oscillation can be stopped (MSTOP = 1).					
External main system clock			External main system clock input can be disabled (MSTOP = 1).					
XT1 clock, external subsystem clock	Internal high- speed oscillation clock	Oscillation of internal high-speed oscillator and selection of internal high-speed oscillation clock as main system clock • RSTOP = 0, MCS = 0	XT1 oscillation can be stopped or external subsystem clock input can be disabled (OSCSELS = 0).					
	X1 clock	Stabilization of X1 oscillation and selection of high-speed system clock as main system clock • MSTOP = 0, OSCSEL = 1, EXCLK = 0 • After elapse of oscillation stabilization time • MCS = 1	<ul> <li>XT1 oscillation can be stopped or external subsystem clock input can be disabled (OSCSELS = 0).</li> <li>Clock supply to CPU is stopped for 4.06 to 16.12 μs after AMPH has been set to 1.</li> </ul>					
	External main system clock	Enabling input of external clock from EXCLK pin and selection of high-speed system clock as main system clock • MSTOP = 0, OSCSEL = 1, EXCLK = 1 • MCS = 1	<ul> <li>XT1 oscillation can be stopped or external subsystem clock input can be disabled (OSCSELS = 0).</li> <li>Clock supply to CPU is stopped for the duration of 160 external clocks from the EXCLK pin after AMPH has been set to 1.</li> </ul>					

# Table 5-5. Changing CPU Clock



# 5.6.8 Time required for switchover of CPU clock and main system clock

By setting bits 0 to 2 (PCC0 to PCC2) and bit 4 (CSS) of the processor clock control register (PCC), the CPU clock can be switched (between the main system clock and the subsystem clock) and the division ratio of the main system clock can be changed.

The actual switchover operation is not performed immediately after rewriting to PCC; operation continues on the pre-switchover clock for several clocks (see **Table 5-6**).

Whether the CPU is operating on the main system clock or the subsystem clock can be ascertained using bit 5 (CLS) of the PCC register.

Set ;	t Value Before Switchover							Set Value After Switchover [clock(s)]																			
CSS	PCC2	PCC1	PCC0	CSS	PCC2	PCC1	PCC0	CSS	PCC2	PCC1	PCC0	CSS	PCC2	PCC1	PCC0	CSS	PCC2	PCC1	PCC0	CSS	PCC2	PCC1	PCC0	CSS	PCC2	PCC1	PCC0
		L'	<u>                                     </u>	0	0	0	0	0	0	0	1	0	0	1	0	0	0	1	1	0	1	0	0	1	×	×	×
0	0	0	0					16				16				16			16				2fмаin/fsub				
	0	0	1		8							8			8			8				í <u> </u>	fmain	/fsub			
	0	1	0		4			4			/				4			I	4				fmain/2fsub				
	0	1	1		2			2			2						2				fmain/4fsub						
	1	0	0		1			1			1				1						fmain/8fsub						
1	×	×	×			2		2			2				;	2	—	2									

Table 5-6. Time Required for Switchover of CPU Clock and Main System Clock Cycle Division Factor

Caution Selection of the main system clock cycle division factor (PCC0 to PCC2) and switchover from the main system clock to the subsystem clock (changing CSS from 0 to 1) should not be set simultaneously.

Simultaneous setting is possible, however, for selection of the main system clock cycle division factor (PCC0 to PCC2) and switchover from the subsystem clock to the main system clock (changing CSS from 1 to 0).

- Remarks 1. The number of clocks listed in Table 5-6 is the number of CPU clocks before switchover.
  - 2. When switching the CPU clock from the main system clock to the subsystem clock, calculate the number of clocks by rounding up to the next clock and discarding the decimal portion, as shown below.
    - **Example** When switching CPU clock from fmain/2 to fsub /2 (@ oscillation with fmain = 10 MHz, fsub = 32.768 kHz)

fmain/fsub = 10000/32.768  $\cong$  305.1  $\rightarrow$  306 clocks



By setting bit 0 (MCM0) of the main clock mode register (MCM), the main system clock can be switched (between the internal high-speed oscillation clock and the high-speed system clock).

The actual switchover operation is not performed immediately after rewriting to MCM0; operation continues on the pre-switchover clock for several clocks (see **Table 5-7**).

Whether the CPU is operating on the internal high-speed oscillation clock or the high-speed system clock can be ascertained using bit 1 (MCS) of MCM.

Set Value Before Switchover	Set Value After Switchover [clocks]						
MCM0	MC	Ю					
	0	1					
0		1 + 2fosca/fin					
1	1 + 2fin/fosca						

Table 5-7. Maximum Time Required for Main System Clock Switchover

- Caution When switching the internal high-speed oscillation clock to the high-speed system clock, bit 2 (XSEL) of MCM must be set to 1 in advance. The value of XSEL can be changed only once after a reset release.
- Remarks 1. The number of clocks listed in Table 5-7 is the number of main system clocks before switchover.
  - 2. Calculate the number of clocks in Table 5-7 by removing the decimal portion.

**Example** When switching the main system clock from the internal high-speed oscillation clock to the high-speed system clock (@ oscillation with  $fosc_8 = 8 \text{ MHz}$ ,  $f_{IN} = 10 \text{ MHz}$ ) 1 + 2fosc\_8/f\_{IN} = 1 + 2 × 8/10 = 1 + 2 × 0.8 = 1 + 1.6 = 2.6  $\rightarrow$  2 clocks

#### 5.6.9 Conditions before clock oscillation is stopped

The following lists the register flag settings for stopping the clock oscillation (disabling external clock input) and conditions before the clock oscillation is stopped.

Clock	Conditions Before Clock Oscillation is Stopped (External Clock Input Disabled)	Flag Settings of SFR Register
Internal high-speed oscillation clock	MCS = 1 or CLS = 1 (The CPU is operating on a clock other than the internal high-speed oscillation clock)	RSTOP = 1
X1 clock External main system clock	MCS = 0 or CLS = 1 (The CPU is operating on a clock other than the high-speed system clock)	MSTOP = 1
XT1 clock External subsystem clock	CLS = 0 (The CPU is operating on a clock other than the subsystem clock)	OSCSELS = 0

Table 5-8. Conditions before the Clock Oscillation is Stopped and Flag Settings



# CHAPTER 6 16-BIT TIMER/EVENT COUNTER P (TMP)

Timer P (TMP) is a 16-bit timer/event counter. The 78K0/Dx2 has five timer/event counter channels, TMP0 to TMP4.

# 6.1 Overview

An outline of TMPn (n = 0 to 4) is shown below.

- Clock selection: 8 ways
- Capture/trigger input pins: 2
- External event count input pins: 1
- External trigger input pins: 1
- Timer/counters: 1
- Capture/compare registers: 2
- Capture/compare match interrupt request signals: 2
- Timer output pins: 2

# 6.2 Functions

TMPn (n = 0 to 4) has the following functions.

- Interval timer
- External event counter
- External trigger pulse output
- One-shot pulse output
- PWM output: Maximum 9
- Free-running timer
- Pulse width measurement
- Timer conjunction function
- Timer synchronous operation function



# 6.3 Configuration

TMPn includes the following hardware.

Item	Configuration
Timer register	16-bit counter
Registers	TMPn capture/compare registers 0, 1 (TPnCCR0, TPnCCR1) TMPn counter read buffer register (TPnCNT) CCR0, CCR1 buffer registers
Timer inputs/outputs	2 (TIOPn0, TIOPn1 pins) <sup>№0® 1</sup>
Control registers <sup>Note</sup> 2	TMPn control registers 0, 1 (TPnCTL0, TPnCTL1) TMPn I/O control registers 0 to 2 (TPnIOC0 to TPnIOC2) TMPn option register 0 (TPnOPT0) Input switch control register (ISC) TMPn input noise filter control register 0 to 2 (TIPNF0 to TIPNF2)

Table 6-1.	Configuration	of TMPn	
------------	---------------	---------	--

**Notes 1.** The TIOPn0 pin is used as an external event count input pin and a capture trigger input pin.

The TIOPn1 pin is used as an external event trigger input pin and a capture trigger input pin.

2. When using the functions of the TIOPn0 and TIOPn1 pins, see 4.4 Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output Latch When Using Alternate Function.

**Remark** n = 0 to 4



Figure 6-1. Block Diagram of TMPn



# (1) 16-bit counter

This 16-bit counter can count internal clocks or external events.

The count value of this counter can be read by using the TPnCNT register.

When the TPnCTL0.TPnCE bit = 0, the value of the 16-bit counter is FFFFH. If the TPnCNT register is read at this time, 0000H is read.

Reset sets the TPnCE bit to 0. Therefore, the 16-bit counter is set to FFFFH.

# (2) CCR0 buffer register

This is a 16-bit compare register that compares the count value of the 16-bit counter. When the TPnCCR0 register is used as a compare register, the value written to the TPnCCR0 register is transferred to the CCR0 buffer register. When the count value of the 16-bit counter matches the value of the CCR0 buffer register, a compare match interrupt request signal (INTTPnCC0) is generated. The CCR0 buffer register cannot be read or written directly.

RENESAS

The CCR0 buffer register is cleared to 0000H after reset, as the TPnCCR0 register is cleared to 0000H.

#### (3) CCR1 buffer register

This is a 16-bit compare register that compares the count value of the 16-bit counter.

When the TPnCCR1 register is used as a compare register, the value written to the TPnCCR1 register is transferred to the CCR1 buffer register. When the count value of the 16-bit counter matches the value of the CCR1 buffer register, a compare match interrupt request signal (INTTPnCC1) is generated. The CCR1 buffer register cannot be read or written directly.

The CCR1 buffer register is cleared to 0000H after reset, as the TPnCCR1 register is cleared to 0000H.

# (4) Edge detector

This circuit detects the valid edges input to the TIOPn0 and TIOPn1 pins. No edge, rising edge, falling edge, or both the rising and falling edges can be selected as the valid edge by using the TPnIOC1 and TPnIOC2 registers.

#### (5) Output controller

This circuit controls the output of the TIOPn0 and TIOPn1 pins. The output controller is controlled by the TPnIOC0 register.

#### (6) Selector

This selector selects the count clock for the 16-bit counter. Eight types of internal clocks or an external event can be selected as the count clock.

#### (7) Digital noise filter

This circuit rejects the noise of digital input. The filters are controlled with the input noise filter control registers (TIPNF0 to TIPNF2).

#### (8) TMP2 and TMP3 conjunction

TMP3 output of TIOP30 is connected to TMP2 input of TIOP21. This function is controlled with the bit3 of the input switch control register (ISC).



# 6.4 Registers

The registers that control TMPn are as follows.

- TMPn control register 0 (TPnCTL0)
- TMPn control register 1 (TPnCTL1)
- TMPn I/O control register 0 (TPnIOC0)
- TMPn I/O control register 1 (TPnIOC1)
- TMPn I/O control register 2 (TPnIOC2)
- TMPn option register 0 (TPnOPT0)
- TMPn capture/compare register 0 (TPnCCR0)
- TMPn capture/compare register 1 (TPnCCR1)
- TMPn counter read buffer register (TPnCNT)
- Input switch control register (ISC)
- TMP0, TMP1 input noise filter control register 0 (TIPNF0)
- TMP2, TMP3 input noise filter control register 1 (TIPNF1)
- TMP4 input noise filter control register 2 (TIPNF2)
- Remarks 1. When using the functions of the TIOPn0 and TIOPn1 pins, see 4.4 Settings of LCDPFALL, LCDPF0, LCDPF3, SMPC, ISC, Port Mode Register, and Output Latch When Using Alternate Function.

**2.** n = 0 to 4


# (1) TMPn control register 0 (TPnCTL0)

The TPnCTL0 register is an 8-bit register that controls the operation of TMPn.

This register can be read or written in 8-bit or 1-bit units.

Reset sets this register to 00H.

The same value can always be written to the TPnCTL0 register by software.

	<7>	6	5	4	3	2	1	0
TPnCTL0	TPnCE	0	0	0	0	TPnCKS2	TPnCKS1	TPnCKS
(n = 0 to 4)								
	TPnCE			TMP	n operation o	control		
	0	TMPn oper	ration disable	ed (TMPn rese	et asynchron	ously <sup>Note</sup> ).		
	1	TMPn oper	ration enable	d. TMPn ope	ration starte	d.		
	TPnCKS2	TPnCKS1	TPnCKS0		Interna	l count clock s	election	
				n = 0,	1, 4	n = 2		n = 3
				(TMP0, TM	P1, TMP4)	(TMP2)		(TMP3)
	0	0	0	fprs				
	0	0	1	fprs/2				
	0	1	0	fprs/2 <sup>2</sup>				
	0	1	1	fprs/2 <sup>3</sup>		fprs/2 <sup>8</sup>	fprs/2	2 <sup>3</sup>
	1	0	0	fprs/2 <sup>4</sup>		fprs/2 <sup>9</sup>	fprs/	2 <sup>₄</sup>
	1	0	1	fprs/2⁵				
	1	1	0	fprs/2 <sup>6</sup>				
	1	1	1	fprs/2			fosc	
Cautions <sup>-</sup>	Note TPr 1. Set t When t bits ca	hOPT0.TPn he TPnC he value of n be set sin	OVF bit, 16 KS2 to f the TPnC nultaneous	-bit counter, TPnCKS0 E bit is cha sly.	timer outp bits v nged from	ut (TIOPn0, <sup>•</sup> vhen the n 0 to 1, the	TIOPn1 pin TPnCE TPnCKS2	s) bit = to TPnC
		e to clear bi	its 3 to 6 to	- "O"				



# (2) TMPn control register 1 (TPnCTL1)

The TPnCTL1 register is an 8-bit register that controls the operation of TMPn. This register can be read or written in 8-bit or 1-bit units. Reset sets this register to 00H.

	After res	set: 00H	R/W	Address: T T T	POCTL1 F9 P2CTL1 F9 P4CTL1 FF	981H, TI 9A1H, TI 511H	P1CTL1 F991 P3CTL1 F9B <sup>-</sup>	IH 1H							
	7	<6>	<5>	4	3	2	1	0							
TPnCTL1	TPnSYE	TPnEST	TPnEEE	0	0	TPnMD2	TPnMD1	TPnMI							
(n = 0 to 4)															
	TPnSYE	nSYE Timer synchronous operation mode enable control													
	0 Independent operation mode (asynchronous operation mode)														
	1	Timer sync	hronous oper	ation mode (	specification	of slave opera	ation)								
		In this mod	e, timer P (TN	MP1 to TMP4	) can operat	e in synchroniz	zation with a r	naster							
		For the time	er synchronou	us operation r	node, refer t	to 6.6 Timer S	as a slave um Synchronous	operation							
		For the timer synchronous operation mode, refer to 6.6 Timer Synchronous O Function.													
	TPnEST	Software trigger control													
	0														
	1	Generates a	Generates a valid signal for external trigger input.												
		<ul> <li>In external</li> </ul>	trigger pulse	output mode	:										
		A PWM	waveform is o	output with w	riting 1 to the	e TPnEST bit a	as the trigger.								
		• In one-sho	In one-shot pulse output mode:												
		A one-s	not pulse is o	utout with wri	tina 1 to the										
		A one-s	not pulse is o	utput with wri	ting 1 to the										
	TPnEEE	A one-s	not pulse is o	utput with wri	ting 1 to the										
	TPnEEE	A one-s Count clock Selects wh	not pulse is o selection ether counting	utput with wri	ting 1 to the	ternal count clo	ock or the vali	d edge o							
	TPnEEE	A one-s Count clock Selects wh the externa	not pulse is o selection ether counting l event count	utput with wri g is performe input.	ting 1 to the	ternal count clo	ock or the vali	d edge o							
	TPnEEE	A one-s Count clock Selects wh the externa Disable ope	not pulse is on selection ether counting l event count eration with e	utput with wri g is performer input. xternal event	ting 1 to the d with the inf count input.	ternal count clo	ock or the vali	d edge o							
	TPnEEE 0	A one-s Count clock Selects wh the externa Disable op (Perform co bits.)	not pulse is on c selection ether counting I event count eration with e pounting with th	utput with wri g is performe input. xternal event he count cloc	d with the int count input. k selected by	ternal count clo	ock or the vali	d edge o							
	TPnEEE 0 1	A one-s Count clock Selects wh the externa Disable ope (Perform co bits.) Enable ope	selection ether counting l event count eration with e punting with th gration with exp	g is performer input. xternal event he count cloc	d with the inf count input. k selected by count input.	ternal count clo	Dock or the vali	d edge o							



TPnMD2	TPnMD1	TPnMD0	Timer mode selection
0	0	0	Interval timer mode
0	0	1	External event count mode
0	1	0	External trigger pulse output mode
0	1	1	One-shot pulse output mode
1	0	0	PWM output mode
1	0	1	Free-running timer mode
1	1	0	Pulse width measurement mode
1	1	1	Setting prohibited

Cautions 1. The TPnEST bit is valid only in the external trigger pulse output mode or one-shot pulse output mode. In any other mode, writing 1 to this bit is ignored.

- 2. External event count input is selected in the external event count mode regardless of the value of the TPnEEE bit.
- 3. Set the TPnEEE and TPnMD2 to TPnMD0 bits when the TPnCTL0.TPnCE bit = 0. (The same value can be written when the TPnCE bit = 1.) The operation is not guaranteed when rewriting is performed with the TPnCE bit = 1. If rewriting was mistakenly performed, clear the TPnCE bit to 0 and then set the bits again.
- 4. Be sure to clear bits 3, 4, and 7 to "0".

(2/2)



# (3) TMPn I/O control register 0 (TPnIOC0)

The TPnIOC0 register is an 8-bit register that controls the timer output (TIOPn0, TIOPn1 pins). This register can be read or written in 8-bit or 1-bit units. Reset sets this register to 00H.

	After res	set: 00H	R/W	Address:	TP0IOC0 F98 TP2IOC0 F9/ TP4IOC0 FF	82H, T A2H, T I2H	P1IOC0 F99 P3IOC0 F98	92H 32H						
	After reset:       OH       R/W       Address:       TPOIOCO       F982H, TP2IOCO       TP1IOCO       F992H TP3IOCO         7       6       5       4       3       <2>       1       <0>         10C0       0       0       0       0       TPnOL1       TPnOL1       TPnOE1       TPnOL0       TPnOE1         0       10Pn1 pin output starts at high level       1       TIOPn1 pin output starts at low level       1       TIOPn1 pin output starts at low level         1       TIOPn1 pin output starts at low level is output from the TIOPn1 pin       1       Timer output disabled          0       Timer output disabled              1       TiPnOL1       Timer output disabled             1       Timer output disabled              1       Timer output enabled (a square wave is output from the TIOPn1 pin pin).             1       TiPnOL0       TIOPn0 pin output setting             0       TIOPn0 pin output starts at high level													
TPnIOC0	0	0	0	0	TPnOL1	TPnOE1	TPnOL0	TPnOE						
(n = 0 to 4)														
	TPnOL1			TIOPn1 p	oin output level	setting <sup>Note</sup>								
	0	TIOPn1 pir	n output start	s at high leve	əl									
	1	TIOPn1 pir	n output start	s at low leve	l									
	TPnOE1 TIOPn1 pin output setting													
	0	Timer outp	Timer output disabled											
		When TP	When TPnOL1 bit = 1: High level is output from the TIOPn1 pin											
	1	Timer outp	ut enabled (a	a square way	e is output fro	m the TIOPn	1 pin).							
	TPnOL0	TIOPn0 pin output level setting <sup>Note</sup>												
	0	TIOPn0 pin output starts at high level												
	1	TIOPn0 pin output starts at low level												
	TPnOE0			TIOP	n0 pin output	setting								
	0	Timer outp	ut disabled											
		When TP     When TP	nOL0 bit = 0: nOL0 bit = 1:	: Low level is High level is	output from the	e TIOPn0 pi	n in							
	1	Timer outp	ut enabled (a	a square way	e is output from	n the TIOPn	0 pin).							
	Note The show	output leve wn below (m • When TPr 16-b	el of the tin n = 0, 1). nOLm bit = 0 	ner output	pin (TIOPnn • When TF 16	n) specified PnOLm bit = - - bit counter TPnCE bit	by the TP	PnOLm bil						



(2/2)

- Cautions 1. Rewrite the TPnOL1, TPnOE1, TPnOL0, and TPnOE0 bits when the TPnCTL0.TPnCE bit = 0. (The same value can be written when the TPnCE bit = 1.) If rewriting was mistakenly performed, clear the TPnCE bit to 0 and then set the bits again.
  - 2. Even if the TPnOLm bit is manipulated when the TPnCE and TPnOEm bits are 0, the TIOPnm pin output level varies (m = 0, 1).

# (4) TMPn I/O control register 1 (TPnIOC1)

The TPnIOC1 register is an 8-bit register that controls the valid edge of the capture trigger input signals (TIOPn0, TIOPn1 pins).

This register can be read or written in 8-bit or 1-bit units.

Reset sets this register to 00H.

	After res	et: 00H	R/W	Address: 1 ר ר	P0IOC1 F98 P2IOC1 F94 P4IOC1 FF	33H, Т АЗН, Т 13H	P1IOC1 F99 P3IOC1 F9B	3H 3H						
	7	6	5	4	3	2	1	0						
TPnIOC1	0	0	0	0	TPnIS3	TPnIS2	TPnIS1	TPnIS0						
(n = 0 to 4)														
	TPnIS3	TPnIS2	Ca	pture trigger	input signal (1	TIOPn1 pin) v	alid edge set	ting						
	0	0 0 No edge detection (capture operation invalid)												
	0	0 1 Detection of rising edge												
	1	1     0     Detection of falling edge												
	1	1	Detection of	of both edges										
	TPnIS1	TPnIS0	Ca	pture trigger	input signal (1	TIOPn0 pin) v	alid edge set	ting						
	0	0	No edge de	etection (cap	ture operation	invalid)								
	0	1	Detection of	of rising edge										
	1	0	Detection of	of falling edge	9									
	1	1	Detection of	of both edges	i									
Cautions 1	I. Rewrite value ca clear the 2. The TPr pulse w	the TPnIS n be writte TPnCE bin NIS3 to TP idth meas	3 to TPnIS n when the t to 0 and tl nIS0 bits a urement m	0 bits whe TPnCE bit hen set the ire valid o ode. In a	en the TPn = 1.) If rev bits again. nly in the f Il other mo	CTL0.TPnC vriting was free-runnin odes, a ca	E bit = 0. mistakenly g timer mo pture oper	(The same of perform () () () () () () () () () () () () ()						



# (5) TMPn I/O control register 2 (TPnIOC2)

The TPnIOC2 register is an 8-bit register that controls the valid edge of the external event count input signal (TIOPn0 pin) and external trigger input signal (TIOPn1 pin).

This register can be read or written in 8-bit or 1-bit units.

Reset sets this register to 00H.

	After res	set: 00H	R/W	R/W Address: TP0IOC2 F984H, TP1IOC2 TP2IOC2 F9A4H, TP3IOC2 TP4IOC2 FF14H								
	7	6	5	4	3	2	1	0				
TPnIOC2	0	0	0	0	TPnEES1	TPnEES0	TPnETS1	TPnETS0				
(n = 0 to 4)												
	TPnEES1	TPnEES0	Exterr	nal event cou	nt input signa	l (TIOPn0 pir	ı) valid edge :	setting				
	0	0	No edge de	etection (exte	rnal event co	unt invalid)						
	0	1	Detection c	of rising edge								
	1	0	Detection of	of falling edge	)							
	1	1	Detection of	of both edges								
	TPnETS1	TPnETS0	Ext	ernal trigger	input signal (1	TOPn1 pin) v	alid edge set	ting				
	0	0	No edge de	etection (exte	rnal trigger in	valid)						
	0	1	Detection c	of rising edge								
	1	0	Detection of	of falling edge	9							
	1	1	Detection c	of both edges	i							
Cautions <sup>-</sup>	I. Rewrite TPnCTL rewriting again.	the TPn 0.TPnCE bi g was mist	EES1, TP it = 0. (The akenly perf	nEES0, 1 same valu formed, cle	PnETS1, a le can be w ear the TPn	and TPnE ritten whei CE bit to (	TS0 bits n the TPnC ) and then	when t E bit = 1.) set the bi				
2	2. The TPn	EES1 and	TPnEES0 b	its are val	d only whe	n the TPnC	TL1.TPnE	EE bit = 1				
	when th	e external	event coun	it mode (T	PnCTL1.TP	nMD2 to TI	PnCTL1.TP	nMD0 bits				
	001) has	been set.										
:	<ul> <li>bits are valid only when the external trigger pulse output mode (TPnCTL1.TPnMD2 to TPnCTL1.TPnMD0 bits = 010) or the one-shot pulse output mode (TPnCTL1.TPnMD2 to TPnCTL1.TPnMD0 = 011) is set.</li> </ul>											



# (6) TMPn option register 0 (TPnOPT0)

The TPnOPT0 register is an 8-bit register used to set the capture/compare operation and detect an overflow. This register can be read or written in 8-bit or 1-bit units.

Reset sets this register to 00H.

	7	6	5	4	3	2	1	<0>						
TPnOPT0	0	0	TPnCCS1	TPnCCS0	0	0	0	TPnOVF						
(n = 0 to 4)		-												
	TPnCCS1		TP	nCCR1 registe	er capture/co	mpare select	ion							
	0	Compare r	egister select	ed										
	1	1 Capture register selected												
	This bit s	etting is valid	only in the fr	ee-running tim	er mode.									
	TPnCCS0		TP	nCCR0 registe	er capture/co	mpare select	ion							
	0	Compare r	egister select	ed										
	1	Capture re	gister selecte	d										
	<ul> <li>This bit s</li> </ul>	etting is valid	only in the fr	ee-running tim	er mode.									
	TPnOVF			TMPn ov	erflow detec	tion flag								
	Set (1)	Overflow o	ccurred			-								
	Reset (0)	TPnOVF b	it 0 written or	TPnCTL0.TPr	nCE bit = 0									
	<ul> <li>This bit is running tir</li> <li>An interrup</li> <li>The INIT</li> </ul>	set when the ner mode or ot request sig	16-bit counte the pulse widt nal (INTTPn0	r count value o th measureme DV) is generate	overflows fro nt mode. ed at the sar	om FFFFH to me time that t	0000H in th he TPnOVF	e free-						
	the pulse	width measu	rement mode.	nerated in mod	ues other tha	an the free-ru	nning umer	mode and						
	This bit is     TPnOVF b	not cleared e bit = 1.	ven when the	TPnOVF bit c	or the TPnO	PT0 register a	are read wh	en the						
	This bit ca on the ope	n be both rea eration of TM	ad and written Pn.	, but cannot be	e set to 1 by	software. W	riting 1 has	no influence						
	Note TME	2 and TMP	3 only											



#### (7) TMPn capture/compare register 0 (TPnCCR0)

The TPnCCR0 register can be used as a capture register or a compare register depending on the mode. This register can be used as a capture register or a compare register only in the free-running timer mode, depending on the setting of the TPnOPT0.TPnCCS0 bit. In the pulse width measurement mode, the TPnCCR0 register can be used only as a capture register. In any other mode, this register can be used only as a compare register.

The TPnCCR0 register can be read or written during operation.

This register can be read or written in 16-bit units.

Reset sets this register to 0000H.

#### Caution Accessing the TPnCCR0 register is prohibited in the following statuses.

- When the CPU operates with the subclock and the main clock oscillation is stopped
  - When the CPU operates with the internal oscillation clock

	After reset: 0000H					R/W Address: TP0CCR0 F986H, TP1CCR0 F996H TP2CCR0 F9A6H, TP3CCR0 F9B6H TP4CCR0 FF6CH							6H 6H			
1 TPnCCR0 (n = 0 to 4)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0



# (a) Function as compare register

The TPnCCR0 register can be rewritten even when the TPnCTL0.TPnCE bit = 1.

The set value of the TPnCCR0 register is transferred to the CCR0 buffer register. When the value of the 16-bit counter matches the value of the CCR0 buffer register, a compare match interrupt request signal (INTTPnCC0) is generated. If TIOPn0 pin output is enabled at this time, the output of the TIOPn0 pin is inverted.

When the TPnCCR0 register is used as a cycle register in the interval timer mode, external event count mode, external trigger pulse output mode, one-shot pulse output mode, or PWM output mode, the value of the 16-bit counter is cleared (0000H) if its count value matches the value of the CCR0 buffer register.

# (b) Function as capture register

When the TPnCCR0 register is used as a capture register in the free-running timer mode, the count value of the 16-bit counter is stored in the TPnCCR0 register if the valid edge of the capture trigger input pin (TIOPn0 pin) is detected. In the pulse-width measurement mode, the count value of the 16-bit counter is stored in the TPnCCR0 register and the 16-bit counter is cleared (0000H) if the valid edge of the capture trigger input pin (TIOPn0) is detected.

Even if the capture operation and reading the TPnCCR0 register conflict, the correct value of the TPnCCR0 register can be read.

The following table shows the functions of the capture/compare register in each mode, and how to write data to the compare register.

Operation Mode	Capture/Compare Register	How to Write Compare Register
Interval timer	Compare register	Anytime write
External event counter	Compare register	Anytime write
External trigger pulse output	Compare register	Batch write
One-shot pulse output	Compare register	Anytime write
PWM output	Compare register	Batch write
Free-running timer	Capture/compare register	Anytime write
Pulse width measurement	Capture register	_

#### Table 6-2. Function of Capture/Compare Register in Each Mode and How to Write Compare Register



#### (8) TMPn capture/compare register 1 (TPnCCR1)

The TPnCCR1 register can be used as a capture register or a compare register depending on the mode. This register can be used as a capture register or a compare register only in the free-running timer mode, depending on the setting of the TPnOPT0.TPnCCS1 bit. In the pulse width measurement mode, the TPnCCR1 register can be used only as a capture register. In any other mode, this register can be used only as a compare register.

The TPnCCR1 register can be read or written during operation.

This register can be read or written in 16-bit units.

Reset sets this register to 0000H.

## Caution Accessing the TPnCCR1 register is prohibited in the following statuses.

- When the CPU operates with the subclock and the main clock oscillation is stopped
  - When the CPU operates with the internal oscillation clock

	Aft	er rese	ət: 000	00H	R/W Address: TP0CCR1 F988H, TP2CCR1 F9A8H, TP4CCR1 FFBAH						TP1CCR1 F998H TP3CCR1 F9B8H					
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
n = 0  to  4																



# (a) Function as compare register

The TPnCCR1 register can be rewritten even when the TPnCTL0.TPnCE bit = 1.

The set value of the TPnCCR1 register is transferred to the CCR1 buffer register. When the value of the 16-bit counter matches the value of the CCR1 buffer register, a compare match interrupt request signal (INTTPnCC1) is generated. If TIOPn1 pin output is enabled at this time, the output of the TIOPn1 pin is inverted.

# (b) Function as capture register

When the TPnCCR1 register is used as a capture register in the free-running timer mode, the count value of the 16-bit counter is stored in the TPnCCR1 register if the valid edge of the capture trigger input pin (TIOPn1 pin) is detected. In the pulse-width measurement mode, the count value of the 16-bit counter is stored in the TPnCCR1 register and the 16-bit counter is cleared (0000H) if the valid edge of the capture trigger input pin (TIOPn1) is detected.

Even if the capture operation and reading the TPnCCR1 register conflict, the correct value of the TPnCCR1 register can be read.

The following table shows the functions of the capture/compare register in each mode, and how to write data to the compare register.

Operation Mode	Capture/Compare Register	How to Write Compare Register
Interval timer	Compare register	Anytime write
External event counter	Compare register	Anytime write
External trigger pulse output	Compare register	Batch write
One-shot pulse output	Compare register	Anytime write
PWM output	Compare register	Batch write
Free-running timer	Capture/compare register	Anytime write
Pulse width measurement	Capture register	_

#### Table 6-3. Function of Capture/Compare Register in Each Mode and How to Write Compare Register



# (9) TMPn counter read buffer register (TPnCNT)

The TPnCNT register is a read buffer register that can read the count value of the 16-bit counter. If this register is read when the TPnCTL0.TPnCE bit = 1, the count value of the 16-bit timer can be read. This register is read-only, in 16-bit units.

The value of the TPnCNT register is cleared to 0000H when the TPnCE bit = 0. If the TPnCNT register is read at this time, the value of the 16-bit counter (FFFFH) is not read, but 0000H is read.

The value of the TPnCNT register is cleared to 0000H after reset, as the TPnCE bit is cleared to 0.

#### Caution Accessing the TPnCNT register is prohibited in the following statuses.

- When the CPU operates with the subclock and the main clock oscillation is stopped
- When the CPU operates with the internal oscillation clock

	Afte	er rese	:t: 000	0H	I	R Address: TP0CNT TP2CNT TP4CNT				F98 F94 FF8	F98AH, TP1CNT F9AAH, TP3CNT FFBCH			F99, F9B	F99AH F9BAH		
TPnCNT (n = 0 to 4)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	]



# (10) Input switch control register (ISC)

This register selects the pins for timer I/O and UART6 I/O.

This register can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to 00H.

• 78K0	/ <b>DE2</b> 7	_							
ISC	7	-							
ISC		6	5	4	3		2	1	0
	ISC7	ISC6	0	0	ISC	03	0	ISC1	ISC0
	Note	u PD78F084	4 and 78F0	845 only.					
	ISC7			UART	60 pin se	election	control		
			TxD6	0			RxE	060/INTPR60	
	0	TxD60 (P1	3)			RxD6	60/INTPR60	(P14)	
	1	<txd60> (</txd60>	P71)			<rx[< td=""><td>060/INTPR6</td><td>i0&gt; (P70)</td><td></td></rx[<>	060/INTPR6	i0> (P70)	
_									
	ISC6			TIOP	30 pin se	election	control		
	0	TIOP30 (P	TIOP30 (P13)						
	1	<tiop30></tiop30>	(P17)						
r									
	ISC3		٦	MP2 input s	ource (T	IP21) s	election con	trol	
-	0		06)		conjuncti	on lunc		]	
-	1	TMP3 outr	ut signal (TC	)P30)					
L				1 00)					
ſ	ISC1			MP2 input s	ource (T	IP20) s	election cor	trol	
				[For LIN rec	eption o	peratio	n of UART6	0]	
	0	TIOP20 (P	14)						
	1	RxD60 <sup>Note</sup>							
_	Note	Selected with	ISC7.						
ſ	ISC0		ſ	MP4 input s For tim	ource (T	IP40) s functio	election con	trol	
-	0	TIOP40 (P	00)	[, 0, tim	e stamp				
	~		,						



	7	6	5	4	3	2	1	(		
sc	ISC7	ISC6	ISC5	0	ISC3	ISC2	ISC1	ISC		
	Note	u PD78F084	6, 78F0847,	78F0848,	and 78F08	49 only.				
Γ	ISC7			UART	60 pin select	tion control				
L			TxD60			RxD	060/INTPR60			
L	0	TxD60 (P1	3)		R	xD60/INTPR60	(P14)			
L	1	<txd60> (</txd60>	P71)		<	RxD60/INTPR6	i0> (P70)			
Г	ISC6			TIOP	30 pin selecti	ion control				
	0	TIOP30 (P	13)							
	1	<tiop30></tiop30>	(P17)							
Г	ISC5			TIOP	20 pin selecti	ion control				
	0	TIOP20 (P	14)							
	1	<tiop20></tiop20>	(P77)							
		-								
	ISC3		Т	/IP2 input s [For timer (	ource (TIP21	) selection con unction of TMP	trol			
-	0	TIOP21 (P								
	1	TMP3 output signal (TOP30)								
Γ	ISC2		T	MP3 input s For LIN rec	ource (TIP30 ception opera	) selection con tion of UART6	trol 1]			
	0	TIOP30 <sup>Note</sup>			-					
F	1	RxD61 (P1	1)							
!	Note S	Selected with	ISC6.							
Γ	ISC1		T	MP2 input s	ource (TIP20	) selection cor	trol			
┝	0		14)	For LIN rec	ception opera	tion of UART6	0]			
┣	1		14)							
L	Note '									
_			1507.							
ſ	ISC0		T	MP4 input s	ource (TIP40	) selection con	trol			
				[⊢or tim	e stamp tunc					
┝	0		00)	_				<b>`</b>		



# • In case that TIOP20 pin is used for TMP2 input signal (78K0/DE2)



ISC7	ISC1	RxD60/INTPR60 input	TIP20 (TMP2 input)	Remark
0	0	RxD60/INTPR60 (P14)	RxD60/INTPR60/TIOP20 (P14)	LIN mode (TIOP20 can be used)
0	1	RxD60/INTPR60 (P14)	RxD60/INTPR60 (P14)	LIN mode
1	0	<rxd60 intpr60=""> (P70)</rxd60>	TIOP20 (P14)	
1	1	<rxd60 intpr60=""> (P70)</rxd60>	<rxd60 intpr60=""> (P70)</rxd60>	LIN mode



## • In case that TIOP20 pin is used for TMP2 input signal (78K0/DF2)



ISC7	ISC5	ISC1	RxD60/INTPR60 input	TIP20 (TMP2 input)	Remark
0	0	0	RxD60/INTPR60 (P14)	RxD60/INTPR60/TIOP20 (P14)	LIN mode (TIOP20 can be used)
0	0	1	RxD60/INTPR60 (P14)	RxD60/INTPR60 (P14)	LIN mode
0	1	0	RxD60/INTPR60 (P14)	<tiop20> (P77)</tiop20>	
0	1	1	RxD60/INTPR60 (P14)	RxD60/INTPR60 (P14)	LIN mode
1	0	0	<rxd60 intpr60=""> (P70)</rxd60>	TIOP20 (P14)	
1	0	1	<rxd60 intpr60=""> (P70)</rxd60>	<rxd60 intpr60=""> (P70)</rxd60>	LIN mode
1	1	0	<rxd60 intpr60=""> (P70)</rxd60>	<tiop20> (P77)</tiop20>	
1	1	1	<rxd60 intpr60=""> (P70)</rxd60>	<rxd60 intpr60=""> (P70)</rxd60>	LIN mode



• In case that TIOP20 pin is used for TMP2 output signal



Note Check the port function setting by referring to CHAPTER 4 PORT FUNCTIONS.

ISC5	TOP20 (TMP2 output)
0	TIOP20 (P14)
1	<tiop20> (P77)</tiop20>

• In case that TIOP30 pin is used for TMP3 input signal (78K0/DE2)



ISC6	TIP30 (TMP3 input)
0	TIOP30 (P13)
1	<tiop30> (P17)</tiop30>



#### • In case that TIOP30 pin is used for TMP3 input signal (78K0/DF2)



ISC6	ISC2	RxD61/INTPR61 input	TIP30 (TMP3 input)	INTP0	Remark
0	0	RxD61/INTPR61 (P11)	TIOP30 (P13)	INTP0 (P17)	
0	1	RxD61/INTPR61 (P11)	RxD61/INTPR61 (P11)	INTP0 (P17)	LIN mode
1	0	RxD61/INTPR61 (P11)	<tiop30> (P17)</tiop30>	INTP0 (P17)	
1	1	RxD61/INTPR61 (P11)	RxD61/INTPR61 (P11)	INTP0 (P17)	LIN mode



• In case that TIOP30 pin is used for TMP3 output signal



ISC6	TOP30 (TMP3 output)
0	TIOP30 (P13)
1	<tiop30> (P17)</tiop30>



#### • How to use the timer conjunction function



#### Note Check the port function setting by referring to CHAPTER 4 PORT FUNCTIONS.

	ISC3	TMP2 input source (TIP21)
ĺ	0	TIOP21 (P06)
	1	TMP3 output signal (TOP30)

• How to use the CAN time stamp function



ISC0	TMP4 input source (TIP40)
0	TIOP40 (P00)
1	TSOUT



## 78K0/Dx2

# (11) TMPn input noise filter control registers 0 to 2 (TIPNF0 to TIPNF2)

The digital noise rejection settings are performed using the TIPNFn registers.

When digital noise rejection is selected, the sampling clock for digital sampling can be selected from among fPRs, fPRs/2, fPRs/2<sup>3</sup>, fPRs/2<sup>3</sup> (or fPRs/2<sup>8</sup>), fPRs/2<sup>4</sup> (or fPRs/2<sup>9</sup>), fPRs/2<sup>5</sup>, fPRs/2<sup>6</sup>, and fPRs/2<sup>7</sup> (or fosc). Sampling is performed two times.

These registers can be read or written in 1-bit or 8-bit units.

Reset sets these registers to 00H.

# Cautions 1. To use the noise filter, proceed as follows:

- <1> Enable the noise filter by setting TIPNFn.
- <2> Wait for 3 sampling clocks.
- <3> Enable the timer operation by setting TPnCTL0.
- 2. To stop the operation TMPn and noise filter, proceed as follows:
  - <1> Disable the timer operation by setting TPnCTL0.
  - <2> Disable the noise filter by setting TIPNFn.
- 3. After the sampling clock has been changed, it takes 3 sampling clocks to initialize the digital noise rejection. If one of the external event counter mode, external trigger plus output mode, and capture trigger function is used, the operation of TMPn should be enabled after over 3 sampling clocks.

	After res	et: 00H	R/W	Address: F	F54H			
	7	6	5	4	3	2	1	0
TIPNF0	TIP1NFEN	TIP1NF2	TIP1NF1	TIP1NF0	TIPONFEN	TIP0NF2	TIP0NF1	TIP0NF0
	After rese	et: 00H	R/W	Address: F	F59H			
	7	6	5	4	3	2	1	0
TIPNF1	<b>TIP3NFEN</b>	TIP3NF2	TIP3NF1	TIP3NF0	TIP2NFEN	TIP2NF2	TIP2NF1	TIP2NF0
	After rese	et: 00H	R/W	Address: F	F69H			
	7	6	5	4	3	2	1	0
TIPNF2	0	0	0	0	TIP4NFEN	TIP4NF2	TIP4NF1	TIP4NF0
		1						
	TIPnNFEN			Digital noise	e filter operatio	on (n = 0 to 4)	)	
	0	TMPn nois	se filter disab	led				
		<b>T</b> 14D ·	eu					



TPnNF2 TPnNF1		TPnNF0	Sampling check for TIPn0 and TIPn1				
			n = 0, 1, 4 (TMP0, TMP1, TMP4)	n = 2 (TMP2)	n = 3 (TMP3)		
0	0	0	fprs				
0	0	1	fprs/2				
0	1	0	fprs/2 <sup>2</sup>				
0	1	1	fprs/2 <sup>3</sup>	fprs/2 <sup>8</sup>	fprs/2 <sup>3</sup>		
1	0	0	f₽RS/2 <sup>4</sup>	fprs/2 <sup>9</sup>	fprs/2 <sup>4</sup>		
1	0	1	fprs/2⁵				
1	1	0	fprs/2 <sup>6</sup>				
1	1	1	fprs/2 <sup>7</sup>		fosc		



# 6.5 Timer Conjunction Function

TMP3 output of TIOP30 is connected to TMP2 input of TIOP21. This function is controlled with the bit3 of the input switch control register (ISC).





# Caution In the external event counter mode, the pulse must not be input before the TMP operation enabled.

**Remark** For low frequency input pulse, selecting the capture function is recommended. For high frequency input pulse, setting the TPnEEE bit to 1 is recommended.



#### 6.6 Timer Synchronous Operation Function

Timer P has a timer synchronized operation function. TMP0 as a master timer and TMP1 to TMP4 as slave timers can be synchronized.

- Cautions 1. The timer synchronous operation mode is enabled or disabled by the TPnSYE bit of the TPnCTL1 register. For TMP0, TMP1 to TMP4 can be specified as slaves.
  - 2. Set the timer synchronous operation mode using the following procedure:
    - <1> Set the TPnSYE bit of the TPnCTL1 register of the slave timer to enable the timer synchronous operation. Set the TPnMD2 to TPnMD0 bits of the TPnCTL1 register of the slave timer to the free-running mode.
    - <2> Set the timer mode by using the TPnMD2 to TPnMD0 bits of the TPnCTL1 register. At this time, do not set the TPnSYE bit of the TPnCTL1 register of the master timer.
    - <3> Set the compare register value of the master and slave timers.
    - <4> Set the TPnCE bit of the TPnCTL0 register of the slave timer to enable operation on the internal operating clock.
    - <5> Set the TPnCE bit of the TPnCTL0 register of the master timer to enable operation on the internal operating clock.

The free-running mode and PWM mode can be used for TMP0 as a master timer in the timer synchronous operation mode as follows:

Synchronous	Timer	Pin	Free-running Mode		PWM Mode	
Channel			Tuning OFF	Tuning ON	Tuning OFF	Tuning ON
Ch0 TMP0 (master TMP1 (slave) TMP2 (slave) TMP3 (slave) TMP4 (slave)	TMP0	TIOP00	PPG	←	Toggle	$\leftarrow$
	(master)	TIOP01			PWM	$\leftarrow$
	TMP1 (slave)	TIOP10			Toggle	PWM
		TIOP11			PWM	$\leftarrow$
	TMP2 (slave)	TIOP20			Toggle	PWM
		TIOP21			PWM	$\leftarrow$
	TMP3 (slave)	TIOP30			Toggle	PWM
		TIOP31			PWM	←
	TMP4 (slave)	TIOP40			Toggle	PWM
		TIOP41			PWM	←

 Table 6-4.
 Timer Output Functions

Remark The timing of transmitting data from the compare register of the master

timer to the compare register of the slave timer is as follows. PPG: CPU write timing

Toggle, PWM: Timing at which timer counter and compare register

match TIOPn0 (n = 0 to 4)





#### Figure 6-3. Timer Synchronous Operation Image (TMP0 to TMP4)









# 6.7 Operation

TMPn can perform the following operations.

Operation	TPnCTL1.TPnEST Bit (Software Trigger Bit)	TIOPn1 Pin (External Trigger Input)	Capture/Compare Register Setting	Compare Register Write
Interval timer mode	Invalid	Invalid	Compare only	Anytime write
External event count mode <sup>Note 1</sup>	Invalid	Invalid	Compare only	Anytime write
External trigger pulse output mode <sup>Note 2</sup>	Valid	Valid	Compare only	Batch write
One-shot pulse output mode <sup>Note 2</sup>	Valid	Valid	Compare only	Anytime write
PWM output mode	Invalid	Invalid	Compare only	Batch write
Free-running timer mode	Invalid	Invalid	Switching enabled	Anytime write
Pulse width measurement mode <sup>Note 2</sup>	Invalid	Invalid	Capture only	Not applicable

**Notes 1.** To use the external event count mode, specify that the valid edge of the TIOPn0 pin capture trigger input is not detected (by clearing the TPnIOC1.TPnIS1 and TPnIOC1.TPnIS0 bits to "00").

2. When using the external trigger pulse output mode, one-shot pulse output mode, and pulse width measurement mode, select the internal clock as the count clock (by clearing the TPnCTL1.TPnEEE bit to 0).

**Remark** n = 0 to 4



# 6.7.1 Interval timer mode (TPnMD2 to TPnMD0 bits = 000)

In the interval timer mode, an interrupt request signal (INTTPnCC0) is generated at the specified interval if the TPnCTL0.TPnCE bit is set to 1. A square wave whose half cycle is equal to the interval can be output from the TIOPn0 pin.

Usually, the TPnCCR1 register is not used in the interval timer mode.





Figure 6-6. Basic Timing of Operation in Interval Timer Mode





When the TPnCE bit is set to 1, the value of the 16-bit counter is cleared from FFFFH to 0000H in synchronization with the count clock, and the counter starts counting. At this time, the output of the TIOPn0 pin is inverted. Additionally, the set value of the TPnCCR0 register is transferred to the CCR0 buffer register.

When the count value of the 16-bit counter matches the value of the CCR0 buffer register, the 16-bit counter is cleared to 0000H, the output of the TIOPn0 pin is inverted, and a compare match interrupt request signal (INTTPnCC0) is generated.

The interval can be calculated by the following expression.

Interval = (Set value of TPnCCR0 register + 1)  $\times$  Count clock cycle

Remark n = 0 to 4





RENESAS



#### Figure 6-7. Register Setting for Interval Timer Mode Operation (2/2)



# (1) Interval timer mode operation flow



Figure 6-8. Software Processing Flow in Interval Timer Mode



# 78K0/Dx2

## (2) Interval timer mode operation timing

#### (a) Operation if TPnCCR0 register is set to 0000H

If the TPnCCR0 register is set to 0000H, the INTTPnCC0 signal is generated at each count clock subsequent to the first count clock, and the output of the TIOPn0 pin is inverted. The value of the 16-bit counter is always 0000H.

Count clock 16-bit counter	FFFH 0000H 000	он Хоооон Хоооон		
TPnCE bit				
TPnCCR0 register	000	OH		
TIOPn0 pin output				
INTTPnCC0 signal				
		Interval time Count clock cycle		
<b>Remark</b> n = 0 to 4				



# (b) Operation if TPnCCR0 register is set to FFFFH

If the TPnCCR0 register is set to FFFFH, the 16-bit counter counts up to FFFFH. The counter is cleared to 0000H in synchronization with the next count-up timing. The INTTPnCC0 signal is generated and the output of the TIOPn0 pin is inverted. At this time, an overflow interrupt request signal (INTTPnOV) is not generated, nor is the overflow flag (TPnOPT0.TPnOVF bit) set to 1.





## (c) Notes on rewriting TPnCCR0 register

To change the value of the TPnCCR0 register to a smaller value, stop counting once and then change the set value.

If the value of the TPnCCR0 register is rewritten to a smaller value during counting, the 16-bit counter may overflow.



If the value of the TPnCCR0 register is changed from  $D_1$  to  $D_2$  while the count value is greater than  $D_2$  but less than  $D_1$ , the count value is transferred to the CCR0 buffer register as soon as the TPnCCR0 register has been rewritten. Consequently, the value of the 16-bit counter that is compared is  $D_2$ .

Because the count value has already exceeded D<sub>2</sub>, however, the 16-bit counter counts up to FFFFH, overflows, and then counts up again from 0000H. When the count value matches D<sub>2</sub>, the INTTPnCC0 signal is generated and the output of the TIOPn0 pin is inverted.

Therefore, the INTTPnCC0 signal may not be generated at the interval time " $(D_1 + 1) \times$  Count clock cycle" or " $(D_2 + 1) \times$  Count clock cycle" originally expected, but may be generated at an interval of " $(10000H + D_2 + 1) \times$  Count clock period".



# (d) Operation of TPnCCR1 register



Figure 6-9. Configuration of TPnCCR1 Register



If the set value of the TPnCCR1 register is less than the set value of the TPnCCR0 register, the INTTPnCC1 signal is generated once per cycle. At the same time, the output of the TIOPn1 pin is inverted. The TIOPn1 pin outputs a square wave with the same cycle as that output by the TIOPn0 pin.






If the set value of the TPnCCR1 register is greater than the set value of the TPnCCR0 register, the count value of the 16-bit counter does not match the value of the TPnCCR1 register. Consequently, the INTTPnCC1 signal is not generated, nor is the output of the TIOPn1 pin changed.







## 6.7.2 External event count mode (TPnMD2 to TPnMD0 bits = 001)

In the external event count mode, the valid edge of the external event count input is counted when the TPnCTL0.TPnCE bit is set to 1, and an interrupt request signal (INTTPnCC0) is generated each time the specified number of edges have been counted. The TIOPn0 pin cannot be used.

Usually, the TPnCCR1 register is not used in the external event count mode.







Figure 6-13. Basic Timing in External Event Count Mode

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When the TPnCE bit is set to 1, the value of the 16-bit counter is cleared from FFFFH to 0000H. The counter counts each time the valid edge of external event count input is detected. Additionally, the set value of the TPnCCR0 register is transferred to the CCR0 buffer register.

When the count value of the 16-bit counter matches the value of the CCR0 buffer register, the 16-bit counter is cleared to 0000H, and a compare match interrupt request signal (INTTPnCC0) is generated.

The INTTPnCC0 signal is generated each time the valid edge of the external event count input has been detected (set value of TPnCCR0 register + 1) times.



Figure 6-14. Register Setting for Operation in External Event Count Mode (1/2)



Γ

# Figure 6-14. Register Setting for Operation in External Event Count Mode (2/2)

(e) TMPn counter read buffer register (TPnCNT)							
The count value of the 16-bit counter can be read by reading the TPnCNT register.							
(f) TMPn capture/compare register 0 (TPnCCR0)							
If D <sub>0</sub> is set to the TPnCCR0 register, the counter is cleared and a compare match interrupt request							
signal (INTTPnCC0) is generated when the number of external event counts reaches ( $D_0 + 1$ ).							
(g) TMPn capture/compare register 1 (TPnCCR1)							
Usually, the TPnCCR1 register is not used in the external event count mode. However, the set value of							
the TPnCCR1 register is transferred to the CCR1 buffer register. When the count value of the 16-bit							
counter matches the value of the CCR1 buffer register, a compare match interrupt request signal							
(INTTPnCC1) is generated.							
Therefore, mask the interrupt signal by using the interrupt mask flag (TPnCCMK1).							
Caution When an external clock is used as the count clock, the external clock can be input only from the TIOPn0 pin. At this time, set the TPnIOC1.TPnIS1 and TPnIOC1.TPnIS0 bits to 00 (capture trigger input (TIOPn0 pin): no edge detection).							
<b>Remarks 1.</b> TMPn I/O control register 1 (TPnIOC1) and TMPn option register 0 (TPnOPT0) are not used in the external event count mode.							
<b>2.</b> n = 0 to 4							



## (1) External event count mode operation flow



### Figure 6-15. Flow of Software Processing in External Event Count Mode



## (2) Operation timing in external event count mode

Cautions 1. In the external event count mode, do not set the TPnCCR0 register to 0000H.

2. In the external event count mode, use of the timer output is disabled. If performing timer output using external event count input, set the interval timer mode, and select the operation enabled by the external event count input for the count clock (TPnCTL1.TPnMD2 to TPnCTL1.TPnMD0 bits = 000, TPnCTL1.TPnEEE bit = 1).

#### (a) Operation if TPnCCR0 register is set to FFFFH

If the TPnCCR0 register is set to FFFFH, the 16-bit counter counts to FFFFH each time the valid edge of the external event count signal has been detected. The 16-bit counter is cleared to 0000H in synchronization with the next count-up timing, and the INTTPnCC0 signal is generated. At this time, the TPnOPT0.TPnOVF bit is not set.





### (b) Notes on rewriting the TPnCCR0 register

To change the value of the TPnCCR0 register to a smaller value, stop counting once and then change the set value.

If the value of the TPnCCR0 register is rewritten to a smaller value during counting, the 16-bit counter may overflow.



If the value of the TPnCCR0 register is changed from  $D_1$  to  $D_2$  while the count value is greater than  $D_2$  but less than  $D_1$ , the count value is transferred to the CCR0 buffer register as soon as the TPnCCR0 register has been rewritten. Consequently, the value that is compared with the 16-bit counter is  $D_2$ .

Because the count value has already exceeded  $D_2$ , however, the 16-bit counter counts up to FFFFH, overflows, and then counts up again from 0000H. When the count value matches  $D_2$ , the INTTPnCC0 signal is generated.

Therefore, the INTTPnCC0 signal may not be generated at the valid edge count of " $(D_1 + 1)$  times" or " $(D_2 + 1)$  times" originally expected, but may be generated at the valid edge count of " $(10000H + D_2 + 1)$  times".



# (c) Operation of TPnCCR1 register



Figure 6-16. Configuration of TPnCCR1 Register

If the set value of the TPnCCR1 register is smaller than the set value of the TPnCCR0 register, the INTTPnCC1 signal is generated once per cycle.







If the set value of the TPnCCR1 register is greater than the set value of the TPnCCR0 register, the INTTPnCC1 signal is not generated because the count value of the 16-bit counter and the value of the TPnCCR1 register do not match.







## 6.7.3 External trigger pulse output mode (TPnMD2 to TPnMD0 bits = 010)

In the external trigger pulse output mode, 16-bit timer/event counter P waits for a trigger when the TPnCTL0.TPnCE bit is set to 1. When the valid edge of an external trigger input signal is detected, 16-bit timer/event counter P starts counting, and outputs a PWM waveform from the TIOPn1 pin.

Pulses can also be output by generating a software trigger instead of using the external trigger. When using a software trigger, a square wave that has one cycle of the PWM waveform as half its cycle can also be output from the TIOPn0 pin.









Figure 6-20. Basic Timing in External Trigger Pulse Output Mode

16-bit timer/event counter P waits for a trigger when the TPnCE bit is set to 1. When the trigger is generated, the 16-bit counter is cleared from FFFFH to 0000H, starts counting at the same time, and outputs a PWM waveform from the TIOPn1 pin. If the trigger is generated again while the counter is operating, the counter is cleared to 0000H and restarted. (The output of the TIOPn0 pin is inverted. The TIOPn1 pin outputs a high-level regardless of the status (high/low) when a trigger occurs.)

The active level width, cycle, and duty factor of the PWM waveform can be calculated as follows.

Active level width = (Set value of TPnCCR1 register) × Count clock cycle Cycle = (Set value of TPnCCR0 register + 1) × Count clock cycle Duty factor = (Set value of TPnCCR1 register)/(Set value of TPnCCR0 register + 1)

The compare match request signal INTTPnCC0 is generated when the 16-bit counter counts next time after its count value matches the value of the CCR0 buffer register, and the 16-bit counter is cleared to 0000H. The compare match interrupt request signal INTTPnCC1 is generated when the count value of the 16-bit counter matches the value of the CCR1 buffer register.

The value set to the TPnCCRm register is transferred to the CCRm buffer register when the count value of the 16bit counter matches the value of the CCRm buffer register and the 16-bit counter is cleared to 0000H.

The valid edge of an external trigger input signal, or setting the software trigger (TPnCTL1.TPnEST bit) to 1 is used as the trigger.

**Remark** n = 0 to 4, m = 0, 1

RENESAS



Figure 6-21. Register Setting for Operation in External Trigger Pulse Output Mode (1/2)



## Figure 6-21. Register Setting for Operation in External Trigger Pulse Output Mode (2/2)





#### 78K0/Dx2

## (1) Operation flow in external trigger pulse output mode



# Figure 6-22. Software Processing Flow in External Trigger Pulse Output Mode (1/2)





Figure 6-22. Software Processing Flow in External Trigger Pulse Output Mode (2/2)



### 78K0/Dx2

## (2) External trigger pulse output mode operation timing

#### (a) Note on changing pulse width during operation

To change the PWM waveform while the counter is operating, write the TPnCCR1 register last. Rewrite the TPnCCRm register after writing the TPnCCR1 register after the INTTPnCC0 signal is detected.





In order to transfer data from the TPnCCRm register to the CCRm buffer register, the TPnCCR1 register must be written.

To change both the cycle and active level width of the PWM waveform at this time, first set the cycle to the TPnCCR0 register and then set the active level width to the TPnCCR1 register.

To change only the cycle of the PWM waveform, first set the cycle to the TPnCCR0 register, and then write the same value to the TPnCCR1 register.

To change only the active level width (duty factor) of the PWM waveform, only the TPnCCR1 register has to be set.

After data is written to the TPnCCR1 register, the value written to the TPnCCRm register is transferred to the CCRm buffer register in synchronization with clearing of the 16-bit counter, and is used as the value compared with the 16-bit counter.

To write the TPnCCR0 or TPnCCR1 register again after writing the TPnCCR1 register once, do so after the INTTPnCC0 signal is generated. Otherwise, the value of the CCRm buffer register may become undefined because the timing of transferring data from the TPnCCRm register to the CCRm buffer register conflicts with writing the TPnCCRm register.

**Remark** n = 0 to 4m = 0, 1



#### (b) 0%/100% output of PWM waveform

To output a 0% waveform, set the TPnCCR1 register to 0000H. If the set value of the TPnCCR0 register is FFFFH, the INTTPnCC1 signal is generated periodically.

Count clock			
16-bit counter	FFF 0000	$\sum_{i=1}^{n} \sum_{i=1}^{n} \sum_{j=1}^{n} \sum_{i=1}^{n} \sum_{i$	$\frac{1}{2}$ $D_0 - 1$ $D_0$ 0000
TPnCE bit			,
TPnCCR0 register	Do	5)	Do
TPnCCR1 register	0000H	оооон	0000Н
INTTPnCC0 signal	(	رب بر	,
INTTPnCC1 signal		,,	,
TIOPn1 pin output	(	۱ <del>۱</del>	\ <u></u>
Remark n	n = 0 to 4		

To output a 100% waveform, set a value of (set value of TPnCCR0 register + 1) to the TPnCCR1 register. If the set value of the TPnCCR0 register is FFFFH, 100% output cannot be produced.

Count clock					
16-bit counter	FFFF 0000	$\sum_{i=1}^{n} \sum_{i=1}^{n} D_0 - 1 \sum_{i=1}^{n} D_0$	0000 0001	$D_{0} = D_{0} = 1$	0000
TPnCE bit		۶ <u>۶</u>		, ,	
TPnCCR0 register	D	\$} \$}	Do	Do	
TPnCCR1 register	Do + 1	\$ <del>}</del>	D <sub>0</sub> + 1	D0 + 1	
INTTPnCC0 signal		\$}		<u>،</u>	
INTTPnCC1 signal		<u> </u>		, <u>,</u>	
TIOPn1 pin output		\$ <del>}</del>		)	
<b>Remark</b> $n = 0$ to 4					



## (c) Conflict between trigger detection and match with TPnCCR1 register

If the trigger is detected immediately after the INTTPnCC1 signal is generated, the 16-bit counter is immediately cleared to 0000H, the output signal of the TIOPn1 pin is asserted, and the counter continues counting. Consequently, the inactive period of the PWM waveform is shortened.



If the trigger is detected immediately before the INTTPnCC1 signal is generated, the INTTPnCC1 signal is not generated, and the 16-bit counter is cleared to 0000H and continues counting. The output signal of the TIOPn1 pin remains active. Consequently, the active period of the PWM waveform is extended.





## (d) Conflict between trigger detection and match with TPnCCR0 register

If the trigger is detected immediately after the INTTPnCC0 signal is generated, the 16-bit counter is cleared to 0000H and continues counting up. Therefore, the active period of the TIOPn1 pin is extended by time from generation of the INTTPnCC0 signal to trigger detection.



If the trigger is detected immediately before the INTTPnCC0 signal is generated, the INTTPnCC0 signal is not generated. The 16-bit counter is cleared to 0000H, the TIOPn1 pin is asserted, and the counter continues counting. Consequently, the inactive period of the PWM waveform is shortened.





## (e) Generation timing of compare match interrupt request signal (INTTPnCC1)

The timing of generation of the INTTPnCC1 signal in the external trigger pulse output mode differs from the timing of other INTTPnCC1 signals; the INTTPnCC1 signal is generated when the count value of the 16-bit counter matches the value of the TPnCCR1 register.



Usually, the INTTPnCC1 signal is generated in synchronization with the next count up, after the count value of the 16-bit counter matches the value of the TPnCCR1 register.

In the external trigger pulse output mode, however, it is generated one clock earlier. This is because the timing is changed to match the timing of changing the output signal of the TIOPn1 pin.



# 6.7.4 One-shot pulse output mode (TPnMD2 to TPnMD0 bits = 011)

In the one-shot pulse output mode, 16-bit timer/event counter P waits for a trigger when the TPnCTL0.TPnCE bit is set to 1. When the valid edge of an external trigger input is detected, 16-bit timer/event counter P starts counting, and outputs a one-shot pulse from the TIOPn1 pin.

Instead of the external trigger, a software trigger can also be generated to output the pulse. When the software trigger is used, the TIOPn0 pin outputs the active level while the 16-bit counter is counting, and the inactive level when the counter is stopped (waiting for a trigger).









Figure 6-24. Basic Timing in One-shot Pulse Output Mode

When the TPnCE bit is set to 1, 16-bit timer/event counter P waits for a trigger. When the trigger is generated, the 16-bit counter is cleared from FFFFH to 0000H, starts counting, and outputs a one-shot pulse from the TIOPn1 pin. After the one-shot pulse is output, the 16-bit counter is set to FFFFH, stops counting, and waits for a trigger. If a trigger is generated again while the one-shot pulse is being output, it is ignored.

The output delay period and active level width of the one-shot pulse can be calculated as follows.

Output delay period = (Set value of TPnCCR1 register) × Count clock cycle Active level width = (Set value of TPnCCR0 register – Set value of TPnCCR1 register + 1) × Count clock cycle

The compare match interrupt request signal INTTPnCC0 is generated when the 16-bit counter counts after its count value matches the value of the CCR0 buffer register. The compare match interrupt request signal INTTPnCC1 is generated when the count value of the 16-bit counter matches the value of the CCR1 buffer register.

The valid edge of an external trigger input or setting the software trigger (TPnCTL1.TPnEST bit) to 1 is used as the trigger.

**Remark** n = 0 to 4m = 0, 1





Figure 6-25. Register Setting for Operation in One-shot Pulse Output Mode (1/2)



# Figure 6-25. Register Setting for Operation in One-shot Pulse Output Mode (2/2)

(d) TM	Pn I/O co	ntrol regi	ster 2 (TI	PnIOC2)					
					TPnEES1	TPnEES0	TPnETS1	TPnETS0	
TPnIOC2	0	0	0	0	0	0	0/1	0/1	
									Select valid edge of external
(e) TM	Pn count	er read b	uffer regi	ster (TPn	CNT)				
٦	The value	of the 16-	bit counte	r can be r	read by re	eading the	TPnCNT	register.	
<ul> <li>(f) TMPn capture/compare registers 0 and 1 (TPnCCR0 and TPnCCR1)         If D<sub>0</sub> is set to the TPnCCR0 register and D<sub>1</sub> to the TPnCCR1 register, the active level width and output delay period of the one-shot pulse are as follows.         Active level width = (D<sub>0</sub> - D<sub>1</sub> + 1) × Count clock cycle         Output delay period = (D<sub>1</sub>) × Count clock cycle     </li> </ul>									
Caution One-shot pulses are not output even in the one-shot pulse output mode, if the value set in									
the TPnCCR1 register is greater than that set in the TPnCCR0 register.									
Remarks 1. TMPn I/O control register 1 (TPnIOC1) and TMPn option register 0 (TPnOPT0) are not used in the one-shot pulse output mode.									
	2. n = 0	to 4							



## 78K0/Dx2

## (1) Operation flow in one-shot pulse output mode



#### Figure 6-26. Software Processing Flow in One-shot Pulse Output Mode



## (2) Operation timing in one-shot pulse output mode

#### (a) Note on rewriting TPnCCRm register

To change the set value of the TPnCCRm register to a smaller value, stop counting once, and then change the set value.

If the value of the TPnCCRm register is rewritten to a smaller value during counting, the 16-bit counter may overflow.



When the TPnCCR0 register is rewritten from  $D_{00}$  to  $D_{01}$  and the TPnCCR1 register from  $D_{10}$  to  $D_{11}$  where  $D_{00} > D_{01}$  and  $D_{10} > D_{11}$ , if the TPnCCR1 register is rewritten when the count value of the 16-bit counter is greater than  $D_{11}$  and less than  $D_{10}$  and if the TPnCCR0 register is rewritten when the count value is greater than  $D_{01}$  and less than  $D_{00}$ , each set value is reflected as soon as the register has been rewritten and compared with the count value. The counter counts up to FFFFH and then counts up again from 0000H. When the count value matches  $D_{11}$ , the counter generates the INTTPnCC1 signal and asserts the TIOPn1 pin. When the count value matches  $D_{01}$ , the counter generates the INTTPnCC0 signal, deasserts the TIOPn1 pin, and stops counting.

Therefore, the counter may output a pulse with a delay period or active period different from that of the one-shot pulse that is originally expected.

**Remark** n = 0 to 4m = 0, 1

## (b) Generation timing of compare match interrupt request signal (INTTPnCC1)

The generation timing of the INTTPnCC1 signal in the one-shot pulse output mode is different from other INTTPnCC1 signals; the INTTPnCC1 signal is generated when the count value of the 16-bit counter matches the value of the TPnCCR1 register.

Count clock	
16-bit counter	D1 - 2 D1 - 1 D1 D1 D1 + 1 D1 + 2
TPnCCR1 register	D1
TIOPn1 pin output	
INTTPnCC1 signal	

Usually, the INTTPnCC1 signal is generated when the 16-bit counter counts up next time after its count value matches the value of the TPnCCR1 register.

In the one-shot pulse output mode, however, it is generated one clock earlier. This is because the timing is changed to match the change timing of the TIOPn1 pin.

**Remark** n = 0 to 4



# 6.7.5 PWM output mode (TPnMD2 to TPnMD0 bits = 100)

In the PWM output mode, a PWM waveform is output from the TIOPn1 pin when the TPnCTL0.TPnCE bit is set to 1.

In addition, a pulse with one cycle of the PWM waveform as half its cycle is output from the TIOPn0 pin.









Figure 6-28. Basic Timing in PWM Output Mode

When the TPnCE bit is set to 1, the 16-bit counter is cleared from FFFFH to 0000H, starts counting, and outputs a PWM waveform from the TIOPn1 pin.

The active level width, cycle, and duty factor of the PWM waveform can be calculated as follows.

Active level width = (Set value of TPnCCR1 register ) × Count clock cycle Cycle = (Set value of TPnCCR0 register + 1) × Count clock cycle Duty factor = (Set value of TPnCCR1 register)/(Set value of TPnCCR0 register + 1)

The PWM waveform can be changed by rewriting the TPnCCRm register while the counter is operating. The newly written value is reflected when the count value of the 16-bit counter matches the value of the CCR0 buffer register and the 16-bit counter is cleared to 0000H.

The compare match interrupt request signal INTTPnCC0 is generated when the 16-bit counter counts next time after its count value matches the value of the CCR0 buffer register, and the 16-bit counter is cleared to 0000H. The compare match interrupt request signal INTTPnCC1 is generated when the count value of the 16-bit counter matches the value of the CCR1 buffer register.

The value set to the TPnCCRm register is transferred to the CCRm buffer register when the count value of the 16bit counter matches the value of the CCRm buffer register and the 16-bit counter is cleared to 0000H.

**Remark** n = 0 to 4, m = 0, 1









Figure 6-29. Register Setting for Operation in PWM Output Mode (2/2)

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## 78K0/Dx2

# (1) Operation flow in PWM output mode

FFFFH	
16-bit counter	
0000H	
TPnCE bit	
TPnCCR0 register	D <sub>00</sub> D <sub>01</sub> D <sub>00</sub>
CCR0 buffer register	D <sub>00</sub> D <sub>01</sub> D <sub>00</sub>
INTTPnCC0 signal	
TIOPn0 pin output	
TPnCCR1 register	D10 D10 D11 D10
CCR1 buffer register	D10 D10 D11 D10
INTTPnCC1 signal	
TIOPn1 pin output	
	<pre></pre>
<b>Remark</b> n = 0 m = 0	to 4 ), 1

Figure 6-30. Software Processing Flow in PWM Output Mode (1/2)





#### Figure 6-30. Software Processing Flow in PWM Output Mode (2/2)



## (2) PWM output mode operation timing

## (a) Changing pulse width during operation

To change the PWM waveform while the counter is operating, write the TPnCCR1 register last. Rewrite the TPnCCRm register after writing the TPnCCR1 register after the INTTPnCC1 signal is detected.



To transfer data from the TPnCCRm register to the CCRm buffer register, the TPnCCR1 register must be written.

To change both the cycle and active level of the PWM waveform at this time, first set the cycle to the TPnCCR0 register and then set the active level to the TPnCCR1 register.

To change only the cycle of the PWM waveform, first set the cycle to the TPnCCR0 register, and then write the same value to the TPnCCR1 register.

To change only the active level width (duty factor) of the PWM waveform, only the TPnCCR1 register has to be set.

After data is written to the TPnCCR1 register, the value written to the TPnCCRm register is transferred to the CCRm buffer register in synchronization with clearing of the 16-bit counter, and is used as the value compared with the 16-bit counter.

To write the TPnCCR0 or TPnCCR1 register again after writing the TPnCCR1 register once, do so after the INTTPnCC0 signal is generated. Otherwise, the value of the CCRm buffer register may become undefined because the timing of transferring data from the TPnCCRm register to the CCRm buffer register conflicts with writing the TPnCCRm register.

**Remark** n = 0 to 4, m = 0, 1



#### (b) 0%/100% output of PWM waveform

To output a 0% waveform, set the TPnCCR1 register to 0000H. If the set value of the TPnCCR0 register is FFFFH, the INTTPnCC1 signal is generated periodically.

Count clock				
16-bit counter	FFF 0000	$\sum_{n=1}^{\infty} \sqrt{D_{00} - 1} \sqrt{D_{00}}$	0000 0001	$\sum_{i=1}^{n} \sum_{i=1}^{n} \sum_{j=1}^{n} \sum_{i=1}^{n} \sum_{i$
TPnCE bit		· ·		(
TPnCCR0 register	D <sub>00</sub>	» <del>)</del> »)	Doo	Doo
TPnCCR1 register	0000H	; <u>;</u>	0000H	0000H
INTTPnCC0 signal		···		,
INTTPnCC1 signal		55		,
TIOPn1 pin output		· · · · · · · · · · · · · · · · · · ·		<u>,</u>
<b>Remark</b> n	= 0 to 4			

To output a 100% waveform, set a value of (set value of TPnCCR0 register + 1) to the TPnCCR1 register. If the set value of the TPnCCR0 register is FFFFH, 100% output cannot be produced.

Count clock		"		,	
16-bit counter	FFF 0000	$\int D_{00} - 1 D_{00}$	0000 0001	$D_{00} - 1$	0000
TPnCE bit					
TPnCCR0 register	Doo	۶ <u>۶</u>	Doo 5	, Doo ;	
TPnCCR1 register	D00 + 1	{}	Doo + 1	) Doo + 1	
INTTPnCC0 signal		ς,		ç	
INTTPnCC1 signal		<u> </u>		<u>,</u>	
TIOPn1 pin output		· ۱	\	}	
Remark n	a = 0 to 4				


### (c) Generation timing of compare match interrupt request signal (INTTPnCC1)

The timing of generation of the INTTPnCC1 signal in the PWM output mode differs from the timing of other INTTPnCC1 signals; the INTTPnCC1 signal is generated when the count value of the 16-bit counter matches the value of the TPnCCR1 register.



Usually, the INTTPnCC1 signal is generated in synchronization with the next counting up after the count value of the 16-bit counter matches the value of the TPnCCR1 register.

In the PWM output mode, however, it is generated one clock earlier. This is because the timing is changed to match the change timing of the output signal of the TIOPn1 pin.



# 6.7.6 Free-running timer mode (TPnMD2 to TPnMD0 bits = 101)

In the free-running timer mode, 16-bit timer/event counter P starts counting when the TPnCTL0.TPnCE bit is set to 1. At this time, the TPnCCRm register can be used as a compare register or a capture register, depending on the setting of the TPnOPT0.TPnCCS0 and TPnOPT0.TPnCCS1 bits.



#### Figure 6-31. Configuration in Free-running Timer Mode



When the TPnCE bit is set to 1, 16-bit timer/event counter P starts counting, and the output signals of the TIOPn0 and TIOPn1 pins are inverted. When the count value of the 16-bit counter later matches the set value of the TPnCCRm register, a compare match interrupt request signal (INTTPnCCm) is generated, and the output signal of the TIOPnm pin is inverted.

The 16-bit counter continues counting in synchronization with the count clock. When it counts up to FFFFH, it generates an overflow interrupt request signal (INTTPnOV) at the next clock, is cleared to 0000H, and continues counting. At this time, the overflow flag (TPnOPT0.TPnOVF bit) is also set to 1. Clear the overflow flag to 0 by executing the CLR instruction by software.

The TPnCCRm register can be rewritten while the counter is operating. If it is rewritten, the new value is reflected at that time, and compared with the count value.



#### Figure 6-32. Basic Timing in Free-running Timer Mode (Compare Function)



When the TPnCE bit is set to 1, the 16-bit counter starts counting. When the valid edge input to the TIOPnm pin is detected, the count value of the 16-bit counter is stored in the TPnCCRm register, and a capture interrupt request signal (INTTPnCCm) is generated.

The 16-bit counter continues counting in synchronization with the count clock. When it counts up to FFFFH, it generates an overflow interrupt request signal (INTTPnOV) at the next clock, is cleared to 0000H, and continues counting. At this time, the overflow flag (TPnOPT0.TPnOVF bit) is also set to 1. Clear the overflow flag to 0 by executing the CLR instruction by software.



Figure 6-33. Basic Timing in Free-running Timer Mode (Capture Function)



Figure 6-34. Register Setting in Free-running Timer Mode (1/2)









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### (1) Operation flow in free-running timer mode

# (a) When using capture/compare register as compare register

Figure 6-35. Software Processing Flow in Free-running Timer Mode (Compare Function) (1/2)











# 78K0/Dx2

# (b) When using capture/compare register as capture register



# Figure 6-36. Software Processing Flow in Free-running Timer Mode (Capture Function) (1/2)









### 78K0/Dx2

# (2) Operation timing in free-running timer mode

### (a) Interval operation with compare register

When 16-bit timer/event counter P is used as an interval timer with the TPnCCRm register used as a compare register, software processing is necessary for setting a comparison value to generate the next interrupt request signal each time the INTTPnCCm signal has been detected.



When performing an interval operation in the free-running timer mode, two intervals can be set with one channel.

To perform the interval operation, the value of the corresponding TPnCCRm register must be re-set in the interrupt servicing that is executed when the INTTPnCCm signal is detected.

The set value for re-setting the TPnCCRm register can be calculated by the following expression, where " $D_m$ " is the interval period.

Compare register default value:  $\mathsf{D}_\mathsf{m}-1$ 

Value set to compare register second and subsequent time: Previous set value +  $\mathsf{D}_\mathsf{m}$ 

(If the calculation result is greater than FFFFH, subtract 10000H from the result and set this value to the register.)

 $\begin{array}{ll} \textbf{Remark} & n=0 \text{ to } 4 \\ & m=0, \ 1 \end{array}$ 



### (b) Pulse width measurement with capture register

When pulse width measurement is performed with the TPnCCRm register used as a capture register, software processing is necessary for reading the capture register each time the INTTPnCCm signal has been detected and for calculating an interval.



When executing pulse width measurement in the free-running timer mode, two pulse widths can be measured with one channel.

To measure a pulse width, the pulse width can be calculated by reading the value of the TPnCCRm register in synchronization with the INTTPnCCm signal, and calculating the difference between the read value and the previously read value.

**Remark** n = 0 to 4 m = 0, 1



### (c) Processing of overflow when two capture registers are used

Care must be exercised in processing the overflow flag when two capture registers are used. First, an example of incorrect processing is shown below.



When two capture registers are used, and if the overflow flag is cleared to 0 by one capture register, the other capture register may not obtain the correct pulse width.

Use software when using two capture registers. An example of how to use software is shown below.



(1/2)





(2/2)





### (d) Processing of overflow if capture trigger interval is long

If the pulse width is greater than one cycle of the 16-bit counter, care must be exercised because an overflow may occur more than once from the first capture trigger to the next. First, an example of incorrect processing is shown below.





If an overflow occurs twice or more when the capture trigger interval is long, the correct pulse width may not be obtained.

If the capture trigger interval is long, slow the count clock to lengthen one cycle of the 16-bit counter, or use software. An example of how to use software is shown next.





# (e) Clearing overflow flag

The overflow flag can be cleared to 0 by clearing the TPnOVF bit to 0 with the CLR instruction and by writing 8-bit data (bit 0 is 0) to the TPnOPT0 register. To accurately detect an overflow, read the TPnOVF bit when it is 1, and then clear the overflow flag by using a bit manipulation instruction.

(i) Operation to write 0 (without conflict with setting)	(iii) Operation to clear to 0 (without conflict with setting)
Overflow set signal	Overflow set signal
0 write signal	0 write signal
Overflow flag (TPnOVF bit)	Register Read Write
	Overflow flag (TPnOVF bit)
(ii) Operation to write 0 (conflict with setting)	(iv) Operation to clear to 0 (conflict with setting)
Overflow set signal	Overflow set signal
0 write signal	0 write signal
Overflow flag (TPnOVF bit)	Register Read Write
	Overflow flag (TPnOVF bit)
<b>Remark</b> n = 0 to 4	

To clear the overflow flag to 0, read the overflow flag to check if it is set to 1, and clear it with the CLR instruction. If 0 is written to the overflow flag without checking if the flag is 1, the set information of overflow may be erased by writing 0 ((ii) in the above chart). Therefore, software may judge that no overflow has occurred even when an overflow actually has occurred.

If execution of the CLR instruction conflicts with occurrence of an overflow when the overflow flag is cleared to 0 with the CLR instruction, the overflow flag remains set even after execution of the clear instruction.



### 78K0/Dx2

### 6.7.7 Pulse width measurement mode (TPnMD2 to TPnMD0 bits = 110)

In the pulse width measurement mode, 16-bit timer/event counter P starts counting when the TPnCTL0.TPnCE bit is set to 1. Each time the valid edge input to the TIOPnm pin has been detected, the count value of the 16-bit counter is stored in the TPnCCRm register, and the 16-bit counter is cleared to 0000H.

The interval of the valid edge can be measured by reading the TPnCCRm register after a capture interrupt request signal (INTTPnCCm) occurs.

Select either the TIOPn0 or TIOPn1 pin as the capture trigger input pin. Specify "No edge detected" by using the TPnIOC1 register for the unused pins.

When an external clock is used as the count clock, measure the pulse width of the TIOPn1 pin because the external clock is fixed to the TIOPn0 pin. At this time, clear the TPnIOC1.TPnIS1 and TPnIOC1.TPnIS0 bits to 00 (capture trigger input (TIOPn0 pin): No edge detected).



Figure 6-37. Configuration in Pulse Width Measurement Mode





Figure 6-38. Basic Timing in Pulse Width Measurement Mode

When the TPnCE bit is set to 1, the 16-bit counter starts counting. When the valid edge input to the TIOPnm pin is later detected, the count value of the 16-bit counter is stored in the TPnCCRm register, the 16-bit counter is cleared to 0000H, and a capture interrupt request signal (INTTPnCCm) is generated.

The pulse width is calculated as follows.

Pulse width = Captured value × Count clock cycle

If the valid edge is not input to the TIOPnm pin even when the 16-bit counter counted up to FFFFH, an overflow interrupt request signal (INTTPnOV) is generated at the next count clock, and the counter is cleared to 0000H and continues counting. At this time, the overflow flag (TPnOPT0.TPnOVF bit) is also set to 1. Clear the overflow flag to 0 by executing the CLR instruction via software.

If the overflow flag is set to 1, the pulse width can be calculated as follows.

Pulse width = (10000H × TPnOVF bit set (1) count + Captured value) × Count clock cycle

**Remark** n = 0 to 4 m = 0, 1









# Figure 6-39. Register Setting in Pulse Width Measurement Mode (2/2)

(e)	<b>TMPn counter read buffer register (TPnCNT)</b> The value of the 16-bit counter can be read by reading the TPnCNT register.
(f)	TMPn capture/compare registers 0 and 1 (TPnCCR0 and TPnCCR1) These registers store the count value of the 16-bit counter when the valid edge input to the TIOPnm pin is detected.
Rema	<ul> <li>arks 1. TMPn I/O control register 0 (TPnIOC0) and TMPn I/O control register 2 (TPnIOC2) are not used in the pulse width measurement mode.</li> <li>2. n = 0 to 4 m = 0, 1</li> </ul>



### (1) Operation flow in pulse width measurement mode



### Figure 6-40. Software Processing Flow in Pulse Width Measurement Mode



#### (2) Operation timing in pulse width measurement mode

### (a) Clearing overflow flag

The overflow flag can be cleared to 0 by clearing the TPnOVF bit to 0 with the CLR instruction and by writing 8-bit data (bit 0 is 0) to the TPnOPT0 register. To accurately detect an overflow, read the TPnOVF bit when it is 1, and then clear the overflow flag by using a bit manipulation instruction.

(i) Operation to write 0 (without conflict with setting)	(iii) Operation to clear to 0 (without conflict with setting)
Overflow set signal 0 write signal Overflow flag (TPnOVF bit)	Overflow set signal 0 write signal Register access signal Read Write Overflow flag (TPnOVF bit)
(ii) Operation to write 0 (conflict with setting)	(iv) Operation to clear to 0 (conflict with setting)
<b>Remark</b> n = 0 to 4	x - 7

To clear the overflow flag to 0, read the overflow flag to check if it is set to 1, and clear it with the CLR instruction. If 0 is written to the overflow flag without checking if the flag is 1, the set information of overflow may be erased by writing 0 ((ii) in the above chart). Therefore, software may judge that no overflow has occurred even when an overflow actually has occurred.

If execution of the CLR instruction conflicts with occurrence of an overflow when the overflow flag is cleared to 0 with the CLR instruction, the overflow flag remains set even after execution of the clear instruction.



# 6.7.8 Timer output operations

The following table shows the operations and output levels of the TIOPn0 and TIOPn1 pins.

Operation Mode	TIOPn1 Pin	TIOPn0 Pin
Interval timer mode	Square wave output	
External event count mode	Square wave output	-
External trigger pulse output mode	External trigger pulse output	Square wave output
One-shot pulse output mode	One-shot pulse output	
PWM output mode	PWM output	
Free-running timer mode	Square wave output (only when com	pare function is used)
Pulse width measurement mode	-	=

**Remark** n = 0 to 4

#### Table 6-6. Truth Table of TIOPn0 and TIOPn1 Pins Under Control of Timer Output Control Bits

TPnIOC0.TPnOLm Bit	TPnIOC0.TPnOEm Bit	TPnCTL0.TPnCE Bit	Level of TIOPnm Pin
0	0	×	Low-level output
	1	0	Low-level output
		1	Low level immediately before counting, high level after counting is started
1	0	×	High-level output
	1	0	High-level output
		1	High level immediately before counting, low level after counting is started

**Remark** n = 0 to 4 m = 0, 1



# 6.8 Cautions

### (1) Capture operation

When the capture operation is used and a slow clock is selected as the count clock, FFFFH, not 0000H, may be captured in the TPnCCR0 and TPnCCR1 registers if the capture trigger is input immediately after the TPnCE bit is set to 1.



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# CHAPTER 7 8-BIT TIMER/EVENT COUNTERS 50 AND 51

# 7.1 Functions of 8-Bit Timer/Event Counters 50 and 51

8-bit timer/event counters 50 and 51 have the following functions.

- Interval timer
- External event counter
- Square-wave output
- PWM output

Figures 7-1 and 7-2 show the block diagrams of 8-bit timer/event counters 50 and 51.





- Notes 1. Timer output F/F
  - 2. PWM output F/F





Figure 7-2. Block Diagram of 8-Bit Timer/Event Counter 51

- Notes 1. Timer output F/F
  - 2. PWM output F/F



### 7.2 Configuration of 8-Bit Timer/Event Counters 50 and 51

8-bit timer/event counters 50 and 51 include the following hardware.

Item	Configuration
Timer register	8-bit timer counter 5n (TM5n)
Register	8-bit timer compare register 5n (CR5n)
Timer input	TIO5n
Timer output	TIO5n
Control registers	Timer clock selection register 5n (TCL5n) 8-bit timer mode control register 5n (TMC5n) Port mode register 0 (PM0) Port register 0 (P0)

#### Table 7-1. Configuration of 8-Bit Timer/Event Counters 50 and 51

#### (1) 8-bit timer counter 5n (TM5n)

TM5n is an 8-bit register that counts the count pulses and is read-only. The counter is incremented in synchronization with the rising edge of the count clock.

#### Figure 7-3. Format of 8-Bit Timer Counter 5n (TM5n)

R

Address: FF16H (TM50), FF1FH (TM51) After reset: 00H

Symbol	7	6	5	4	3	2	1	0
TM5n								
(n = 0, 1)								

In the following situations, the count value is cleared to 00H.

- <1> Reset signal generation
- <2> When TCE5n is cleared
- <3> When TM5n and CR5n match in the mode in which clear & start occurs upon a match of the TM5n and CR5n.

**Remark** n = 0, 1



### (2) 8-bit timer compare register 5n (CR5n)

CR5n can be read and written by an 8-bit memory manipulation instruction.

Except in PWM mode, the value set in CR5n is constantly compared with the 8-bit timer counter 5n (TM5n) count value, and an interrupt request (INTTM5n) is generated if they match.

In PWM mode, when the TIO5n pin becomes active due to a TM5n overflow and the values of TM5n and CR5n match, the TIO5n pin becomes inactive.

The value of CR5n can be set within 00H to FFH.

Reset signal generation clears CR5n to 00H.

#### Figure 7-4. Format of 8-Bit Timer Compare Register 5n (CR5n)

Address:	FF17H (CR	50), FF41H	I (CR51)	After res	set: 00H	R/W		
Symbol	7	6	5	4	3	2	1	0
CR5n								
(n = 0, 1)								

- Cautions 1. In the mode in which clear & start occurs on a match of TM5n and CR5n (TMC5n6 = 0), do not write other values to CR5n during operation.
  - 2. In PWM mode, make the CR5n rewrite period 3 count clocks of the count clock (clock selected by TCL5n) or more.

**Remark** n = 0, 1



# 7.3 Registers Controlling 8-Bit Timer/Event Counters 50 and 51

The following four registers are used to control 8-bit timer/event counters 50 and 51.

- Timer clock selection register 5n (TCL5n)
- 8-bit timer mode control register 5n (TMC5n)
- Port mode register 0 (P0)
- Port register 0 (P0)

### (1) Timer clock selection register 5n (TCL5n)

This register sets the count clock of 8-bit timer/event counter 5n and the valid edge of the TIO5n pin input. TCL5n can be set by an 8-bit memory manipulation instruction. Reset signal generation clears TCL5n to 00H.

#### **Remark** n = 0, 1

### Figure 7-5. Format of Timer Clock Selection Register 50 (TCL50)

Address: FF6AH After reset: 00H R/W

7 Symbol 6 5 4 3 2 1 0 TCL50 0 0 0 0 0 TCL502 TCL501 TCL500

TCL502	TCL501	TCL500	Count clock selection Note 1				
				f <sub>PRS</sub> = 2 MHz	f <sub>PRS</sub> = 5 MHz	f <sub>PRS</sub> = 10 MHz	f <sub>PRS</sub> = 20 MHz
0	0	0	TIO50 pin falling edge <sup>Note 2</sup>				
0	0	1	TIO50 pin rising edge <sup>Note 3</sup>				
0	1	0	fprs	2 MHz	5 MHz	10 MHz	20 MHz
0	1	1	fprs/2	1 MHz	2.5 MHz	5 MHz	10 MHz
1	0	0	fprs/2 <sup>2</sup>	500 kHz	1.25 MHz	2.5 MHz	5 MHz
1	0	1	fosc/27	fosc/2 <sup>7</sup> Typ. 1.88 kHz			
1	1	0	fosc/2 <sup>°</sup> Typ. 0.47 kHz				
1	1	1	fosc	Typ. 240 kH	Z		

**Notes 1.** If the peripheral hardware clock (fPRS) operates on the high-speed system clock (fIN) (XSEL = 1), the fPRS operating frequency varies depending on the supply voltage.

- VDD = 4.0 to 5.5 V: fprs  $\leq 20~MHz$
- Vdd = 2.7 to 4.0 V: fprs  $\leq 10~MHz$
- 2. In the on-board mode, the FLMD0 pin falling edge is selected.
- 3. In the on-board mode, the FLMD0 pin rising edge is selected.

### Cautions 1. When rewriting TCL50 to other data, stop the timer operation beforehand. 2. Be sure to set bits 3 to 7 to 0.

Remark fPRs: Peripheral hardware clock frequency



Address: FF	8CH After	reset: 00H	R/W					
Symbol	7	6	5	4	3	2	1	0
TCL51	0	0	0	0	0	TCL512	TCL511	TCL510
	TCL512	TCL511	TCL510		Coun	nt clock select	ion <sup>Note</sup>	
					fprs = 2	fprs = 5	fprs = 10	fprs = 20
					MHz	MHz	MHz	MHz
	0	0	0	TIO51 pin falling edge				
	0	0	1	TIO51 pin ris	sing edge			
	0	1	0	fprs	2 MHz	5 MHz	10 MHz	20 MHz
	0	1	1	fprs/2	1 MHz	2.5 MHz	5 MHz	10 MHz
	1	0	0	fprs/2 <sup>4</sup>	125 kHz	312.5 kHz	625 kHz	1.25 MHz
	1	0	1	fprs/26	31.25 kHz	78.13 kHz	156.25 kHz	312.5 kHz
	1	1	0	fprs/2 <sup>8</sup>	7.81 kHz	19.53 kHz	39.06 kHz	78.13 kHz
	1	1	1	fprs/2 <sup>12</sup>	0.49 kHz	1.22 kHz	2.44 kHz	4.88 kHz

### Figure 7-6. Format of Timer Clock Selection Register 51 (TCL51)

- **Note** If the peripheral hardware clock (fPRs) operates on the high-speed system clock (fIN) (XSEL = 1), the fPRs operating frequency varies depending on the supply voltage.
  - VDD = 4.0 to 5.5 V: fPRs  $\leq 20 \ MHz$
  - VDD = 2.7 to 4.0 V: fPRs  $\leq$  10 MHz

# Cautions 1. When rewriting TCL51 to other data, stop the timer operation beforehand. 2. Be sure to set bits 3 to 7 to 0.

Remark fPRS: Peripheral hardware clock frequency



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### (2) 8-bit timer mode control register 5n (TMC5n)

TMC5n is a register that performs the following five types of settings.

- <1> 8-bit timer counter 5n (TM5n) count operation control
- <2> 8-bit timer counter 5n (TM5n) operating mode selection
- <3> Timer output F/F (flip flop) status setting
- <4> Active level selection in timer F/F control or PWM (free-running) mode.
- <5> Timer output control

TMC5n can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears this register to 00H.

**Remark** n = 0, 1

#### Figure 7-7. Format of 8-Bit Timer Mode Control Register 50 (TMC50)

Address: FF6BH After reset: 00H R/WNote

Symbol	<7>	6	5	4	<3>	<2>	1	<0>
TMC50	TCE50	TMC506	0	0	LVS50	LVR50	TMC501	TOE50

TCE50	TM50 count operation control
0	After clearing to 0, count operation disabled (counter stopped)
1	Count operation start

TMC506	TM50 operating mode selection
0	Mode in which clear & start occurs on a match between TM50 and CR50
1	PWM (free-running) mode

LVS50	LVR50	Timer output F/F status setting
0	0	No change
0	1	Timer output F/F clear (0) (default value of TIO50 output: low level)
1	0	Timer output F/F set (1) (default value of TIO50 output: high level)
1	1	Setting prohibited

TMC501	In other modes (TMC506 = 0)	In PWM mode (TMC506 = 1)		
	Timer F/F control	Active level selection		
0	Inversion operation disabled	Active-high		
1	Inversion operation enabled	Active-low		

TOE50	Timer output control
0	Output disabled (TM50 output is low level)
1	Output enabled

Note Bits 2 and 3 are write-only.

(Refer to Cautions and Remarks on the next page.)



Address: FF	-43H After	reset: 00H	R/W <sup>Note</sup>					
Symbol	<7>	6	5	4	<3>	<2>	1	<0>
TMC51	TCE51	TMC516	0	0	LVS51	LVR51	TMC511	TOE51

# Figure 7-8. Format of 8-Bit Timer Mode Control Register 51 (TMC51)

TCE51	TM51 count operation control
0	After clearing to 0, count operation disabled (counter stopped)
1	Count operation start

TMC516	TM51 operating mode selection
0	Mode in which clear & start occurs on a match between TM51 and CR51
1	PWM (free-running) mode

LVS51	LVR51	Timer output F/F status setting
0	0	No change
0	1	Timer output F/F clear (0) (default value of TIO51 output: low)
1	0	Timer output F/F set (1) (default value of TIO51 output: high)
1	1	Setting prohibited

TMC511	In other modes (TMC516 = 0)	In PWM mode (TMC516 = 1)		
	Timer F/F control	Active level selection		
0	Inversion operation disabled	Active-high		
1	Inversion operation enabled	Active-low		

TOE51	Timer output control
0	Output disabled (TM51 output is low level)
1	Output enabled

**Note** Bits 2 and 3 are write-only.

Cautions 1. The settings of LVS5n and LVR5n are valid in other than PWM mode.

- 2. Perform <1> to <4> below in the following order, not at the same time.
  - <1> Set TMC5n1, TMC5n6: Operation mode setting
  - <2> Set TOE5n to enable output: Timer output enable
  - <3> Set LVS5n, LVR5n (see Caution 1): Timer F/F setting
  - <4> Set TCE5n
  - 3. Stop operation before rewriting TMC5n6.

**Remarks 1.** In PWM mode, PWM output is made inactive by clearing TCE5n to 0.

- $\textbf{2.} \quad \text{If LVS5n and LVR5n are read, the value is 0.} \\$
- **3.** The values of the TMC5n6, LVS5n, LVR5n, TMC5n1, and TOE5n bits are reflected at the TIO5n pin regardless of the value of TCE5n.
- **4.** n = 0, 1

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# (3) Port mode register 0 (PM0)

This register sets port 0 input/output in 1-bit units.

When using the P02/TIO50/SEG14 and P03/TIO51/SEG15 pins for timer output, clear PM02 and PM03 and the output latches of P02 and P03 to 0.

When using the P02/TIO50/SEG14 and P03/TIO51/SEG15 pins for timer input, set PM02 and PM03 to 1. The output latches of P02 and P03 at this time may be 0 or 1.

PM0 can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to FFH.

### Figure 7-9. Format of Port Mode Register 0 (PM0)

Address: I	FF20H A	fter reset: FF	H R/W					
Symbol	7	6	5	4	3	2	1	0
PM0	PM07	PM06	PM05	PM04	PM03	PM02	PM01	PM00

PM0n	P0n pin I/O mode selection (n = 0 to 7)
0	Output mode (output buffer on)
1	Input mode (output buffer off)



# 7.4 Operations of 8-Bit Timer/Event Counters 50 and 51

### 7.4.1 Operation as interval timer

8-bit timer/event counter 5n operates as an interval timer that generates interrupt requests repeatedly at intervals of the count value preset to 8-bit timer compare register 5n (CR5n).

When the count value of 8-bit timer counter 5n (TM5n) matches the value set to CR5n, counting continues with the TM5n value cleared to 0 and an interrupt request signal (INTTM5n) is generated.

The count clock of TM5n can be selected with bits 0 to 2 (TCL5n0 to TCL5n2) of timer clock selection register 5n (TCL5n).

### Setting

<1> Set the registers.

- TCL5n: Select the count clock.
- CR5n: Compare value
- TMC5n: Stop the count operation, select the mode in which clear & start occurs on a match of TM5n and CR5n.

 $(TMC5n = 0000 \times \times \times 0B \times = Don't care)$ 

- <2> After TCE5n = 1 is set, the count operation starts.
- <3> If the values of TM5n and CR5n match, INTTM5n is generated (TM5n is cleared to 00H).
- <4> INTTM5n is generated repeatedly at the same interval. Set TCE5n to 0 to stop the count operation.

### Caution Do not write other values to CR5n during operation.

#### Figure 7-10. Interval Timer Operation Timing (1/2)





**Remark** Interval time =  $(N + 1) \times t$ N = 00H to FFH n = 0, 1


### t Count clock TM5n 00H 00Н 00Н CR5n 00H ¦ 00H TCE5n INTTM5n















#### 7.4.2 Operation as external event counter

The external event counter counts the number of external clock pulses to be input to the TIO5n pin by 8-bit timer counter 5n (TM5n).

TM5n is incremented each time the valid edge specified by timer clock selection register 5n (TCL5n) is input. Either the rising or falling edge can be selected.

When the TM5n count value matches the value of 8-bit timer compare register 5n (CR5n), TM5n is cleared to 0 and an interrupt request signal (INTTM5n) is generated.

Whenever the TM5n value matches the value of CR5n, INTTM5n is generated.

#### Setting

<1> Set each register.

- Set the port mode register (PM02 or PM03)<sup>Note</sup> to 1.
- TCL5n: Select TIO5n pin input edge. TIO5n pin falling edge  $\rightarrow$  TCL5n = 00H TIO5n pin rising edge  $\rightarrow$  TCL5n = 01H
- CR5n: Compare value
- TMC5n: Stop the count operation, select the mode in which clear & start occurs on match of TM5n and CR5n, disable the timer F/F inversion operation, disable timer output.

(TMC5n =  $0000 \times \times 00B \times = Don't care$ )

- <2> When TCE5n = 1 is set, the number of pulses input from the TIO5n pin is counted.
- <3> When the values of TM5n and CR5n match, INTTM5n is generated (TM5n is cleared to 00H).
- <4> After these settings, INTTM5n is generated each time the values of TM5n and CR5n match.

Note 8-bit timer/event counter 50: PM02 8-bit timer/event counter 51: PM03

#### Figure 7-11. External Event Counter Operation Timing (with Rising Edge Specified)

TIO5n	 Count start	
TM5n count value	X 00 X 01 X 02 X 03 X 04 X 05 X	XN-1X N X 00 X 01 X 02 X 03 X
CR5n		- <u>N</u>
INTTM5n		
Remark N	I = 00H to FFH	

n = 0, 1



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#### 7.4.3 Square-wave output operation

A square wave with any selected frequency is output at intervals determined by the value preset to 8-bit timer compare register 5n (CR5n).

The TIO5n pin output status is inverted at intervals determined by the count value preset to CR5n by setting bit 0 (TOE5n) of 8-bit timer mode control register 5n (TMC5n) to 1. This enables a square wave with any selected frequency to be output (duty = 50%).

#### Setting

<1> Set each register.

- Clear the port output latch (P02 or P03)<sup>Note</sup> and port mode register (PM02 or PM03)<sup>Note</sup> to 0.
- TCL5n: Select the count clock.
- CR5n: Compare value
- TMC5n: Stop the count operation, select the mode in which clear & start occurs on a match of TM5n and CR5n.

LVS5n	LVR5n	Timer Output F/F Status Setting
1	0	High-level output
0	1	Low-level output

Timer output F/F inversion enabled Timer output enabled (TMC5n = 00001011B or 00000111B)

- <2> After TCE5n = 1 is set, the count operation starts.
- <3> The timer output F/F is inverted by a match of TM5n and CR5n. After INTTM5n is generated, TM5n is cleared to 00H.
- <4> After these settings, the timer output F/F is inverted at the same interval and a square wave is output from TIO5n.

The frequency is as follows. Frequency = 1/2t (N + 1)(N: 00H to FFH)

Note 8-bit timer/event counter 50: P02, PM02 8-bit timer/event counter 51: P03, PM03

Caution Do not write other values to CR5n during operation.





Figure 7-12. Square-Wave Output Operation Timing

Note The initial value of TIO5n output can be set by bits 2 and 3 (LVR5n, LVS5n) of 8-bit timer mode control register 5n (TMC5n).

#### 7.4.4 PWM output operation

8-bit timer/event counter 5n operates as a PWM output when bit 6 (TMC5n6) of 8-bit timer mode control register 5n (TMC5n) is set to 1.

The duty pulse determined by the value set to 8-bit timer compare register 5n (CR5n) is output from TIO5n.

Set the active level width of the PWM pulse to CR5n; the active level can be selected with bit 1 (TMC5n1) of TMC5n.

The count clock can be selected with bits 0 to 2 (TCL5n0 to TCL5n2) of timer clock selection register 5n (TCL5n). PWM output can be enabled/disabled with bit 0 (TOE5n) of TMC5n.

#### Caution In PWM mode, make the CR5n rewrite period 3 count clocks of the count clock (clock selected by TCL5n) or more.



#### (1) PWM output basic operation

#### Setting

- <1> Set each register.
  - Clear the port output latch (P02 or P03)<sup>Note</sup> and port mode register (PM02 or PM03)<sup>Note</sup> to 0.
  - TCL5n: Select the count clock.
  - CR5n: Compare value
  - TMC5n: Stop the count operation, select PWM mode.

The timer output F/F is not changed.

	TMC5n1	Active Level Selection
ſ	0	Active-high
	1	Active-low

Timer output enabled

(TMC5n = 01000001B or 01000011B)

- <2> The count operation starts when TCE5n = 1. Clear TCE5n to 0 to stop the count operation.
  - Note 8-bit timer/event counter 50: P02, PM02 8-bit timer/event counter 51: P03, PM03

#### PWM output operation

- <1> PWM output (output from TIO5n) outputs an inactive level until an overflow occurs.
- <2> When an overflow occurs, the active level is output. The active level is output until CR5n matches the count value of 8-bit timer counter 5n (TM5n).
- <3> After the CR5n matches the count value, the inactive level is output until an overflow occurs again.
- <4> Operations <2> and <3> are repeated until the count operation stops.
- <5> When the count operation is stopped with TCE5n = 0, PWM output becomes inactive.

For details of timing, see Figures 7-13 and 7-14.

The cycle, active-level width, and duty are as follows.

- Cycle =  $2^{8}t$
- Active-level width = Nt
- Duty =  $N/2^8$
- (N = 00H to FFH)







(a) Basic operation (active level = H)

**2.** n = 0, 1

Remarks 1. <1> to <3> and <5> in Figure 7-13 (a) correspond to <1> to <3> and <5> in PWM output operation in 7. 4. 4 (1) PWM output basic operation.

#### (2) Operation with CR5n changed



(a) CR5n value is changed from N to M before clock rising edge of FFH



 <sup>(</sup>b) CR5n value is changed from N to M after clock rising edge of FFH
 → Value is transferred to CR5n at second overflow.



Caution When reading from CR5n between <1> and <2> in Figure 7-14, the value read differs from the actual value (read value: M, actual value of CR5n: N).



#### 7.5 Cautions for 8-Bit Timer/Event Counters 50 and 51

#### (1) Timer start error

An error of up to one clock may occur in the time required for a match signal to be generated after timer start. This is because 8-bit timer counters 50 and 51 (TM50, TM51) are started asynchronously to the count clock.

#### Figure 7-15. 8-Bit Timer Counter 5n Start Timing





#### CHAPTER 8 WATCH TIMER

#### 8.1 Functions of Watch Timer

The watch timer has the following functions.

- Watch timer
- Interval timer

The watch timer and the interval timer can be used simultaneously. Figure 8-1 shows the watch timer block diagram.



Figure 8-1. Block Diagram of Watch Timer

Remark fPRs: Peripheral hardware clock frequency

- fsub: Subsystem clock frequency
- fw: Watch timer clock frequency (fprs/2<sup>7</sup> or fsub)
- fwx: fw or fw/2 $^{9}$



#### (1) Watch timer

When the high-speed system clock or subsystem clock is used, interrupt requests (INTWT) are generated at preset intervals.

Interrupt Time	When Operated at fsub = 32.768 kHz	InterviewWhen Operated atWhen Operated atSUB = 32.768 kHzfPRs = 2 MHzfPRs = 5 MHz		When Operated at fprs = 10 MHz	When Operated at fPRS = 20 MHz
2 <sup>4</sup> /fw	488 μs	1.02 ms	410 <i>μ</i> s	205 <i>μ</i> s	102 <i>μ</i> s
2⁵/fw	977 μs	2.05 ms	819 <i>μ</i> s	410 <i>μ</i> s	205 μs
2 <sup>13</sup> /fw	0.25 s	0.52 s	0.210 s	0.105 s	52.5 ms
2 <sup>14</sup> /fw	0.5 s	1.05 s	0.419 s	0.210 s	0.105 s

#### Table 8-1. Watch Timer Interrupt Time

Remark fPRs: Peripheral hardware clock frequency

fsub: Subsystem clock frequency

fw: Watch timer clock frequency (fprs/2<sup>7</sup> or fsub)

#### (2) Interval timer

Interrupt requests (INTWTI) are generated at preset time intervals.

Interrupt Time	When Operated at fsub = 32.768 kHzWhen Operated at fPRS = 2 MHzWhe fP		When Operated at fPRs = 5 MHz	When Operated at fPRS = 10 MHz	When Operated at fPRS = 20 MHz
2⁴/fw	488 μs	1.02 ms	410 <i>μ</i> s	205 <i>μ</i> s	102 <i>µ</i> s
2⁵/fw	977 <i>μ</i> s	2.05 ms	820 μs	410 <i>μ</i> s	205 <i>μ</i> s
2 <sup>6</sup> /fw	1.95 ms	4.10 ms	1.64 ms	820 <i>μ</i> s	410 <i>μ</i> s
2 <sup>7</sup> /fw	3.91 ms	8.20 ms	3.28 ms	1.64 ms	820 <i>μ</i> s
2 <sup>8</sup> /fw	7.81 ms	16.4 ms	6.55 ms	3.28 ms	1.64 ms
2º/fw	15.6 ms	32.8 ms	13.1 ms	6.55 ms	3.28 ms
2 <sup>10</sup> /fw	31.3 ms	65.5 ms	26.2 ms	13.1 ms	6.55 ms
2 <sup>11</sup> /fw	62.5 ms	131.1 ms	52.4 ms	26.2 ms	13.1 ms

#### Table 8-2. Interval Timer Interval Time

**Remark** fprs: Peripheral hardware clock frequency

fsub: Subsystem clock frequency

fw: Watch timer clock frequency (fprs/2<sup>7</sup> or fsub)

#### 8.2 Configuration of Watch Timer

The watch timer includes the following hardware.

Table 8-3.	Watch T	imer Configuration
------------	---------	--------------------

Item	Configuration
Counter	5 bits × 1
Prescaler	11 bits × 1
Control register	Watch timer operation mode register (WTM)



#### 8.3 Register Controlling Watch Timer

The watch timer is controlled by the watch timer operation mode register (WTM).

#### • Watch timer operation mode register (WTM)

This register sets the watch timer count clock, enables/disables operation, prescaler interval time, and 5-bit counter operation control.

WTM is set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears WTM to 00H.



Address: FF	8FH After	eset: 00H	R/W					
Symbol	7	6	5	4	3	2	<1>	<0>
WTM	WTM7	WTM6	WTM5	WTM4	WTM3	WTM2	WTM1	WTM0

WTM7		Watch timer count clock selection (fw) Note					
		fsuв = 32.768 kHz	fprs = 2 MHz	fprs = 5 MHz	fprs = 10 MHz	fprs = 20 MHz	
0	fprs/27	-	15.625 kHz	39.625 kHz	78.125 kHz	156.25 kHz	
1	fsuв	32.768 kHz		-	_		

WTM6	WTM5	WTM4	Prescaler interval time selection
0	0	0	2 <sup>4</sup> /fw
0	0	1	2 <sup>5</sup> /fw
0	1	0	2 <sup>s</sup> /fw
0	1	1	2 <sup>7</sup> /fw
1	0	0	2 <sup>s</sup> /fw
1	0	1	2°/fw
1	1	0	2 <sup>10</sup> /fw
1	1	1	2 <sup>11</sup> /fw

WTM3	WTM2	Interrupt time selection
0	0	2 <sup>14</sup> /fw
0	1	2 <sup>13</sup> /fw
1	0	2⁵/fw
1	1	2 <sup>4</sup> /fw

WTM1	5-bit counter operation control
0	Clear after operation stop
1	Start

WTM0	Watch timer operation enable			
0	Operation stop (clear both prescaler and 5-bit counter)			
1	Operation enable			

**Note** If the peripheral hardware clock (fPRs) operates on the high-speed system clock (fIN) (XSEL = 1), the fPRs operating frequency varies depending on the supply voltage.

- VDD = 4.0 to 5.5 V: fPRs  $\leq 20~MHz$
- VDD = 2.7 to 4.0 V: fPRs  $\leq$  10 MHz
- Caution Do not change the count clock and interval time (by setting bits 4 to 7 (WTM4 to WTM7) of WTM) during watch timer operation.
- **Remarks 1.** fw: Watch timer clock frequency (fPRs/2<sup>7</sup> or fsUB)
  - 2. fprs: Peripheral hardware clock frequency
  - 3. fsub: Subsystem clock frequency

#### 8.4 Watch Timer Operations

#### 8.4.1 Watch timer operation

The watch timer generates an interrupt request (INTWT) at a specific time interval by using the peripheral hardware clock or subsystem clock.

When bit 0 (WTM0) and bit 1 (WTM1) of the watch timer operation mode register (WTM) are set to 1, the count operation starts. When these bits are cleared to 0, the 5-bit counter is cleared and the count operation stops.

When the interval timer is simultaneously operated, zero-second start can be achieved only for the watch timer by clearing WTM1 to 0. In this case, however, the 11-bit prescaler is not cleared. Therefore, an error up to  $2^9 \times 1/\text{fw}$  seconds occurs in the first overflow (INTWT) after zero-second start.

The interrupt request is generated at the following time intervals.

WTM3	WTM2	Interrupt Time	When Operated at	When Operated at	When Operated at	When Operated at	When Operated
		Selection	fsuв = 32.768 kHz	fprs = 2 MHz	fprs = 5 MHz	fprs = 10 MHz	at fprs = 20 MHz
			(WTM7 = 1)	(WTM7 = 0)	(WTM7 = 0)	(WTM7 = 0)	(WTM7 = 0)
0	0	2 <sup>14</sup> /fw	0.5 s	1.05 s	0.419 s	0.210 s	0.105 s
0	1	2 <sup>13</sup> /fw	0.25 s	0.52 s	0.210 s	0.105 s	52.5 ms
1	0	2⁵/fw	977 <i>μ</i> s	2.05 ms	819 <i>µ</i> s	410 <i>µ</i> s	205 <i>µ</i> s
1	1	2⁴/fw	488 μs	1.02 ms	410 <i>μ</i> s	205 <i>µ</i> s	102 <i>µ</i> s

Table 8-4. Watch Timer Interrupt Time

**Remarks 1.** fw: Watch timer clock frequency ( $f_{PRS}/2^7$  or  $f_{SUB}$ )

- 2. fprs: Peripheral hardware clock frequency
- 3. fsub: Subsystem clock frequency



#### 8.4.2 Interval timer operation

The watch timer operates as interval timer which generates interrupt requests (INTWTI) repeatedly at an interval of the preset count value.

The interval time can be selected with bits 4 to 6 (WTM4 to WTM6) of the watch timer operation mode register (WTM).

When bit 0 (WTM0) of the WTM is set to 1, the count operation starts. When this bit is set to 0, the count operation stops.

WTM6	WTM5	WTM4	Interval Time	When Operated at fsub = 32.768 kHz (WTM7 = 1)	When Operated at fPRS = 2 MHz (WTM7 = 0)	When Operated at fPRs = 5 MHz (WTM7 = 0)	When Operated at fPRS = 10 MHz (WTM7 = 0)	When Operated at fPRS = 20 MHz (WTM7 = 0)
0	0	0	2 <sup>4</sup> /fw	488 <i>µ</i> s	1.02 ms	410 <i>μ</i> s	205 <i>μ</i> s	102 <i>μ</i> s
0	0	1	2 <sup>5</sup> /fw	977 <i>µ</i> s	2.05 ms	820 <i>µ</i> s	410 <i>μ</i> s	205 <i>μ</i> s
0	1	0	2 <sup>6</sup> /fw	1.95 ms	4.10 ms	1.64 ms	820 <i>µ</i> s	410 <i>μ</i> s
0	1	1	2 <sup>7</sup> /fw	3.91 ms	8.20 ms	3.28 ms	1.64 ms	820 <i>µ</i> s
1	0	0	2 <sup>8</sup> /fw	7.81 ms	16.4 ms	6.55 ms	3.28 ms	1.64 ms
1	0	1	2 <sup>9</sup> /fw	15.6 ms	32.8 ms	13.1 ms	6.55 ms	3.28 ms
1	1	0	2 <sup>10</sup> /fw	31.3 ms	65.5 ms	26.2 ms	13.1 ms	6.55 ms
1	1	1	2 <sup>11</sup> /fw	62.5 ms	131.1 ms	52.4 ms	26.2 ms	13.1 ms

Table 8-5. Interval Timer Interval Time

**Remarks 1.** fw: Watch timer clock frequency (fprs/2<sup>7</sup> or fsub)

2. fPRS: Peripheral hardware clock frequency

3. fsub: Subsystem clock frequency





**Remark** fw: Watch timer clock frequency

Figures in parentheses are for operation with fw = 32.768 kHz (WTM7 = 1, WTM3, WTM2 = 0, 0)



#### 8.5 Cautions for Watch Timer

When operation of the watch timer and 5-bit counter is enabled by the watch timer mode control register (WTM) (by setting bits 0 (WTM0) and 1 (WTM1) of WTM to 1), the interval until the first interrupt request (INTWT) is generated after the register is set does not exactly match the specification made with bits 2 and 3 (WTM2, WTM3) of WTM. Subsequently, however, the INTWT signal is generated at the specified intervals.

#### Figure 8-4. Example of Generation of Watch Timer Interrupt Request (INTWT) (When Interrupt Period = 0.5 s)

It takes 0.515625 seconds for the first INTWT to be generated ( $2^9 \times 1/32768 = 0.015625$  s longer). INTWT is then generated every 0.5 seconds.





### CHAPTER 9 WATCHDOG TIMER

#### 9.1 Functions of Watchdog Timer

The watchdog timer operates on the internal low-speed oscillation clock.

The watchdog timer is used to detect an inadvertent program loop. If a program loop is detected, an internal reset signal is generated.

Program loop is detected in the following cases.

- If the watchdog timer counter overflows
- If a 1-bit manipulation instruction is executed on the watchdog timer enable register (WDTE)
- If data other than "ACH" is written to WDTE
- If data is written to WDTE during a window close period
- If the instruction is fetched from an area not set by the IMS and IXS registers (detection of an invalid check while the CPU hangs up)
- If the CPU accesses an area that is not set by the IMS and IXS registers (excluding FB00H to FFCFH and FFE0H to FFFFH) by executing a read/write instruction (detection of an abnormal access during a CPU program loop)

When a reset occurs due to the watchdog timer, bit 4 (WDTRF) of the reset control flag register (RESF) is set to 1. For details of RESF, see **CHAPTER 21 RESET FUNCTION**.



#### 9.2 Configuration of Watchdog Timer

The watchdog timer includes the following hardware.

#### Table 9-1. Configuration of Watchdog Timer

Item	Configuration
Control register	Watchdog timer enable register (WDTE)

How the counter operation is controlled, overflow time, and window open period are set by the option byte.

Tahla Q_2	Sotting of	Ontion F	Rutae and	Watchdog	Timor
	Setting of	Option L	Jytes and	watchuog	THIE

Setting of Watchdog Timer	Option Byte (0080H)	
Window open period	Bits 6 and 5 (WINDOW1, WINDOW0)	
Controlling counter operation of watchdog timer	Bit 4 (WDTON)	
Overflow time of watchdog timer	Bits 3 to 1 (WDCS2 to WDCS0)	

Remark For the option byte, see CHAPTER 25 OPTION BYTE.



#### Figure 9-1. Block Diagram of Watchdog Timer



#### 9.3 Register Controlling Watchdog Timer

The watchdog timer is controlled by the watchdog timer enable register (WDTE).

#### (1) Watchdog timer enable register (WDTE)

Writing ACH to WDTE clears the watchdog timer counter and starts counting again. This register can be set by an 8-bit memory manipulation instruction. Reset signal generation sets this register to 9AH or 1AH<sup>Note</sup>.

#### Figure 9-2. Format of Watchdog Timer Enable Register (WDTE)

Address:	FF9BH	After reset: 9AH	H/1AH <sup>Note</sup> I	R/W				
Symbol	7	6	5	4	3	2	1	0
WDTE								

**Note** The WDTE reset value differs depending on the WDTON setting value of the option byte (0080H). To operate watchdog timer, set WDTON to 1.

WDTON Setting Value	WDTE Reset Value
0 (watchdog timer count operation disabled)	1AH
1 (watchdog timer count operation enabled)	9AH

- Cautions 1. If a value other than ACH is written to WDTE, an internal reset signal is generated. If the source clock to the watchdog timer is stopped, however, an internal reset signal is generated when the source clock to the watchdog timer resumes operation.
  - 2. If a 1-bit memory manipulation instruction is executed for WDTE, an internal reset signal is generated. If the source clock to the watchdog timer is stopped, however, an internal reset signal is generated when the source clock to the watchdog timer resumes operation.
  - 3. The value read from WDTE is 9AH/1AH (this differs from the written value (ACH)).



#### 9.4 Operation of Watchdog Timer

#### 9.4.1 Controlling operation of watchdog timer

- 1. When the watchdog timer is used, its operation is specified by the option byte (0080H).
  - Enable counting operation of the watchdog timer by setting bit 4 (WDTON) of the option byte (0080H) to 1 (the counter starts operating after a reset release) (for details, see **CHAPTER 25 OPTION BYTE**).

WDTON	Operation Control of Watchdog Timer Counter/Illegal Access Detection
0	Counter operation disabled (counting stopped after reset), Illegal access detection operation disabled.
1	Counter operation enabled (counting started after reset), Illegal access detection operation enabled.

- Set an overflow time by using bits 3 to 1 (WDCS2 to WDCS0) of the option byte (0080H) (for details, see 9.4.2 Setting overflow time of watchdog timer and CHAPTER 25 OPTION BYTE).
- Set a window open period by using bits 6 and 5 (WINDOW1 and WINDOW0) of the option byte (0080H) (for details, see 9.4.3 Setting window open period of watchdog timer and CHAPTER 25 OPTION BYTE).
- 2. After a reset release, the watchdog timer starts counting.
- 3. By writing "ACH" to WDTE after the watchdog timer starts counting and before the overflow time set by the option byte, the watchdog timer is cleared and starts counting again.
- 4. After that, write WDTE the second time or later after a reset release during the window open period. If WDTE is written during a period other than the window open period, an internal reset signal is generated.
- 5. If the overflow time expires without "ACH" written to WDTE, an internal reset signal is generated. An internal reset signal is generated in the following cases.
  - If a 1-bit manipulation instruction is executed on the watchdog timer enable register (WDTE)
  - If data other than "ACH" is written to WDTE
  - If the instruction is fetched from an area not set by the IMS and IXS registers (detection of an invalid check during a CPU program loop)
  - If the CPU accesses an area not set by the IMS and IXS registers (excluding FB00H to FFCFH and FFE0H to FFFFH) by executing a read/write instruction (detection of an abnormal access during a CPU program loop)
  - Cautions 1. The first writing to WDTE after a reset release clears the watchdog timer, if it is made before the overflow time regardless of the timing of the writing, and the watchdog timer starts counting again.
    - 2. If the watchdog timer is cleared by writing "ACH" to WDTE, the actual overflow time may be different from the overflow time set by the option byte by up to 2/fosc seconds.
    - 3. The watchdog timer can be cleared immediately before the count value overflows (FFFFH).



## Cautions 4. The operation of the watchdog timer in the HALT and STOP modes differs as follows depending on the set value of bit 0 (LSROSC) of the option byte.

	LSROSC = 0 (Internal Low-Speed Oscillator Can Be Stopped by Software)	LSROSC = 1 (Internal Low-Speed Oscillator Cannot Be Stopped)	
In HALT mode	Watchdog timer operation stops.	Watchdog timer operation continues.	
In STOP mode			

If LSROSC = 0, the watchdog timer resumes counting after the HALT or STOP mode is released. At this time, the counter is not cleared to 0 but starts counting from the value at which it was stopped.

If oscillation of the internal low-speed oscillator is stopped by setting LSRSTOP (bit 1 of the internal oscillation mode register (RCM) = 1) when LSROSC = 0, the watchdog timer stops operating. At this time, the counter is not cleared to 0.

5. The watchdog timer continues its operation during self-programming and EEPROM<sup>™</sup> emulation of the flash memory. During processing, the interrupt acknowledge time is delayed. Set the overflow time and window size taking this delay into consideration.



#### 9.4.2 Setting overflow time of watchdog timer

Set the overflow time of the watchdog timer by using bits 3 to 1 (WDCS2 to WDCS0) of the option byte (0080H). If an overflow occurs, an internal reset signal is generated. The present count is cleared and the watchdog timer starts counting again by writing "ACH" to WDTE during the window open period before the overflow time.

The following overflow time is set.

WDCS2	WDCS1	WDCS0	Overflow Time of Watchdog Timer
0	0	0	2 <sup>10</sup> /fosc (4.27 ms)
0	0	1	2 <sup>11</sup> /fosc (8.53 ms)
0	1	0	2 <sup>12</sup> /fosc (17.07 ms)
0	1	1	2 <sup>13</sup> /fosc (34.13 ms)
1	0	0	2 <sup>14</sup> /fosc (68.27 ms)
1	0	1	2 <sup>15</sup> /fosc (136.53 ms)
1	1	0	2 <sup>16</sup> /fosc (273.07 ms)
1	1	1	2 <sup>17</sup> /fosc (546.13 ms)

Table 9-3.	Setting of	Overflow	Time of	Watchdog	Timer
	00g 0.	••••		materialog	

Cautions 1. The combination of WDCS2 = WDCS1 = WDCS0 = 0 and WINDOW1 = WINDOW0 = 0 is prohibited.

2. The watchdog timer continues its operation during self-programming and EEPROM emulation of the flash memory. During processing, the interrupt acknowledge time is delayed. Set the overflow time and window size taking this delay into consideration.

Remarks 1. fosc: Internal low-speed oscillation clock frequency

**2.** (): fosc = 264 kHz (MAX.)



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#### 9.4.3 Setting window open period of watchdog timer

Set the window open period of the watchdog timer by using bits 6 and 5 (WINDOW1, WINDOW0) of the option byte (0080H). The outline of the window is as follows.

- If "ACH" is written to WDTE during the window open period, the watchdog timer is cleared and starts counting again.
- Even if "ACH" is written to WDTE during the window close period, an abnormality is detected and an internal reset signal is generated.

**Example**: If the window open period is 25%



## Caution The first writing to WDTE after a reset release clears the watchdog timer, if it is made before the overflow time regardless of the timing of the writing, and the watchdog timer starts counting again.

The window open period to be set is as follows.

WINDOW1	WINDOW0	Window Open Period of Watchdog Timer
0	0	25%
0	1	50%
1	0	75%
1	1	100%

Table 9-4. Setting Window Open Period of Watchdog Timer

Cautions 1. The combination of WDCS2 = WDCS1 = WDCS0 = 0 and WINDOW1 = WINDOW0 = 0 is prohibited.

2. The watchdog timer continues its operation during self-programming and EEPROM emulation of the flash memory. During processing, the interrupt acknowledge time is delayed. Set the overflow time and window size taking this delay into consideration.



**Remark** If the overflow time is set to 2<sup>10</sup>/fosc, the window close time and open time are as follows.

	Setting of Window Open Period									
	25%	50%	75%	100%						
Window close time	0 to 3.2 ms	0 to 2.13 ms	0 to 1.07 ms	None						
Window open time	3.2 to 4.27 ms	2.13 to 4.27 ms	1.07 to 4.27 ms	0 to 4.27 ms						

(when 2.7 V  $\leq$  V<sub>DD</sub>  $\leq$  5.5 V)

<When window open period is 25%>

• Overflow time:

 $2^{10}$ /fosc (MAX.) =  $2^{10}$ /264 kHz (MAX.) = 4.27 ms

• Window close time:

0 to  $2^{10}$ /fosc (MIN.) × (1 – 0.25) = 0 to  $2^{10}$ /216 kHz (MIN.) × 0.75 = 0 to 3.2 ms

• Window open time:

 $2^{10}$ /fosc (MIN.) × (1 – 0.25) to  $2^{10}$ /fosc (MAX.) =  $2^{10}$ /216 kHz (MIN.) × 0.75 to  $2^{10}$ /264 kHz (MAX.) = 3.2 to 4.27 ms



### CHAPTER 10 CLOCK OUTPUT/BUZZER OUTPUT CONTROLLER

#### 10.1 Functions of Clock Output/Buzzer Output Controller

The clock output controller is intended for carrier output during remote controlled transmission and clock output for supply to peripheral LSIs. The clock selected with the clock output selection register (CKS) is output.

In addition, the buzzer output is intended for square-wave output of buzzer frequency selected with CKS.

Figure 10-1 shows the block diagram of clock output/buzzer output controller.







#### 10.2 Configuration of Clock Output/Buzzer Output Controller

The clock output/buzzer output controller includes the following hardware.

#### Table 10-1. Clock Output/Buzzer Output Controller Configuration

Item	Configuration
Control registers	Clock output selection register (CKS)
	Port mode register 7 (PM7)
	Port register 7 (P7)

#### 10.3 Register Controlling Clock Output/Buzzer Output Controller

The following two registers are used to control the clock output/buzzer output controller.

- Clock output selection register (CKS)
- Port mode register 7 (PM7)

#### (1) Clock output selection register (CKS)

This register sets output enable/disable for clock output (PCL) and for the buzzer frequency output (BUZ), and sets the output clock.

CKS is set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears CKS to 00H.



Address: FF	-40H After	reset: 00H	R/W										
Symbol	<7>	6	5	<4>	3	2	1	0					
CKS	BZOE	BCS1	BCS0	CLOE	CCS3	CCS2	CCS1	CCS0					
	BZOE		BUZ output enable/disable specification										
	0	Clock divisio	lock division circuit operation stopped. BUZ fixed to low level.										
	1	Clock divisio	lock division circuit operation enabled. BUZ output enabled.										
	BCS1	BCS0			BUZ outpu	it clock selection	n						
					<b>f</b> prs	= 10 MHz	fprs =	20 MHz					
	0	0	fprs/2 <sup>10</sup>		9.77 kHz		19.54 kHz						
	0	1	fprs/2 <sup>11</sup>		4.88 kHz		9.77 kHz						
	1	0	fprs/2 <sup>12</sup>		2.44 kHz		4.88 kHz						
	1	1	fprs/2 <sup>13</sup>		1.22 kHz		2.44 kHz						
	CLOE			PCL output e	nable/disa	ble specificatio	n						
	0	Clock divisio	on circuit opera	ation stopped	. PCL fixed	to low level.							
	1	Clock divisio	Clock division circuit operation enabled. PCL output enabled.										
	CCS3	CCS2	CCS1	CCS0	_	PCL output cl	ock selection <sup>►</sup>	ote 1					
			ľ			fsuв =	fprs =	fprs =					

#### Figure 10-2. Format of Clock Output Selection Register (CKS)

CCS3	CCS2	CCS1	CCS0	PCL output clock selection Note 1						
					fsuв = 32.768 kHz	f <sub>PRS</sub> = 10 MHz	f <sub>PRS</sub> = 20 MHz			
0	0	0	0	fprs	_	10 MHz	Setting prohibited <sup>Note 2</sup>			
0	0	0	1	f <sub>PRS</sub> /2		5 MHz	10 MHz			
0	0	1	0	fprs/2 <sup>2</sup>		2.5 MHz	5 MHz			
0	0	1	1	fprs/2 <sup>3</sup>		1.25 MHz	2.5 MHz			
0	1	0	0	fprs/2 <sup>4</sup>		625 kHz	1.25 MHz			
0	1	0	1	fprs/2⁵		312.5 kHz	625 kHz			
0	1	1	0	fprs/2 <sup>6</sup>		156.25 kHz	312.5 kHz			
0	1	1	1	fprs/27		78.125 kHz	156.25 kHz			
1	0	0	0	fsuв	32.768 kHz	_				
	Other the	an above		Setting prohibited						

- **Notes 1.** If the peripheral hardware clock (fPRS) operates on the high-speed system clock (fIN) (XSEL = 1), the fPRS operating frequency varies depending on the supply voltage.
  - VDD = 4.0 to 5.5 V: fprs  $\leq$  20 MHz
  - VDD = 2.7 to 4.0 V: fprs  $\leq$  10 MHz
  - 2. The PCL output clock prohibits settings if they exceed 10 MHz.

#### Cautions 1. Set BCS1 and BCS0 when the buzzer output operation is stopped (BZOE = 0).

2. Set CCS3 to CCS0 while the clock output operation is stopped (CLOE = 0).

Remarks 1. fPRs: Peripheral hardware clock frequency

2. fsub: Subsystem clock frequency

#### (2) Port mode register 7 (PM7)

This register sets port 7 input/output in 1-bit units.

When using the P72/SGOA/PCL pin for clock output and the P73/SGO/SGOF/BUZ pin for buzzer output, set PM72, PM73 and the output latch of P72, P73 to 0.

PM7 is set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets PM7 to FFH.

#### Figure 10-3. Format of Port Mode Register 7 (PM7)

Address: FF27H After reset: FFH R/W Symbol 6 5 4 3 2 0 7 1 PM7 PM76 PM74 PM73 PM72 PM71 1 PM75 **PM70** 

PM7n	P7n pin I/O mode selection (n = 0 to 6)
0	Output mode (output buffer on)
1	Input mode (output buffer off)



#### 10.4 Clock Output/Buzzer Output Controller Operations

#### 10.4.1 Clock output operation

The clock pulse is output as the following procedure.

- <1> Select the clock pulse output frequency with bits 0 to 3 (CCS0 to CCS3) of the clock output selection register (CKS) (clock pulse output in disabled status).
- <2> Set bit 4 (CLOE) of CKS to 1 to enable clock output.
  - **Remark** The clock output controller is designed not to output pulses with a small width during output enable/disable switching of the clock output. As shown in **Figure 10-4**, be sure to start output from the low period of the clock (marked with \* in the figure). When stopping output, do so after the high-level period of the clock.





#### 10.4.2 Operation as buzzer output

The buzzer frequency is output as the following procedure.

- <1> Select the buzzer output frequency with bits 5 and 6 (BCS0, BCS1) of the clock output selection register (CKS) (buzzer output in disabled status).
- <2> Set bit 7 (BZOE) of CKS to 1 to enable buzzer output.



### CHAPTER 11 A/D CONVERTER

#### 11.1 Function of A/D Converter

The A/D converter converts an analog input signal into a digital value, and consists of up to eight channels (ANI0 to ANI7) with a resolution of 10 bits.

The A/D converter has the following function.

#### • 10-bit resolution A/D conversion

10-bit resolution A/D conversion is carried out repeatedly for one channel selected from analog inputs ANI0 to ANI7. Each time an A/D conversion operation ends, an interrupt request (INTAD) is generated.



Figure 11-1. Block Diagram of A/D Converter



#### 11.2 Configuration of A/D Converter

The A/D converter includes the following hardware.

#### (1) ANI0 to ANI7 pins

These are the analog input pins of the 16-channel A/D converter. They input analog signals to be converted into digital signals. Pins other than the one selected as the analog input pin can be used as I/O port pins.

#### (2) Sample & hold circuit

The sample & hold circuit samples the input voltage of the analog input pin selected by the selector when A/D conversion is started, and holds the sampled voltage value during A/D conversion.

#### (3) Series resistor string

The series resistor string is connected between AV<sub>REF</sub> and AV<sub>SS</sub>, and generates a voltage to be compared with the sampled voltage value.





#### (4) Voltage comparator

The voltage comparator compares the sampled voltage value and the output voltage of the series resistor string.

#### (5) Successive approximation register (SAR)

This register converts the result of comparison by the voltage comparator, starting from the most significant bit (MSB).

When the voltage value is converted into a digital value down to the least significant bit (LSB) (end of A/D conversion), the contents of the SAR register are transferred to the A/D conversion result register (ADCR).

#### (6) 10-bit A/D conversion result register (ADCR)

The A/D conversion result is loaded from the successive approximation register to this register each time A/D conversion is completed, and the ADCR register holds the A/D conversion result in its higher 10 bits (the lower 6 bits are fixed to 0).



#### (7) 8-bit A/D conversion result register (ADCRH)

The A/D conversion result is loaded from the successive approximation register to this register each time A/D conversion is completed, and the ADCRH register stores the higher 8 bits of the A/D conversion result.

# Caution When data is read from ADCR and ADCRH, a wait cycle is generated. Do not read data from ADCR and ADCRH when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.

#### (8) Controller

This circuit controls the conversion time of an input analog signal that is to be converted into a digital signal, as well as starting and stopping of the conversion operation. When A/D conversion has been completed, this controller generates INTAD.

#### (9) AVREF pin

This pin inputs an analog power/reference voltage to the A/D converter. Make this pin the same potential as the  $V_{DD}$  pin when port 2 is used as a digital port.

The signal input to ANI0 to ANI7 is converted into a digital signal, based on the voltage applied across AVREF and AVss.

#### (10) AVss pin

This is the ground potential pin of the A/D converter. Always use this pin at the same potential as that of the Vss pin even when the A/D converter is not used.

#### (11) A/D converter mode register (ADM)

This register is used to set the conversion time of the analog input signal to be converted, and to start or stop the conversion operation.

#### (12) A/D port configuration register (ADPC)

This register switches the P20/ANI0 to P27/ANI7 pins to analog input of A/D converter or digital I/O of port.

#### (13) Analog input channel specification register (ADS)

This register is used to specify the port that inputs the analog voltage to be converted into a digital signal.

#### (14) Port mode register 2 (PM2)

This register switches the P20/ANI0 to P27/ANI7 pins to input or output.



#### 11.3 Registers Used in A/D Converter

The A/D converter uses the following seven registers.

- A/D converter mode register (ADM)
- A/D port configuration register (ADPC)
- Analog input channel specification register (ADS)
- Port mode register 2 (PM2)
- 10-bit A/D conversion result register (ADCR)
- 8-bit A/D conversion result register (ADCRH)

#### (1) A/D converter mode register (ADM)

This register sets the conversion time for analog input to be A/D converted, and starts/stops conversion. ADM can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears this register to 00H.

#### Figure 11-3. Format of A/D Converter Mode Register (ADM)



ADCS	A/D conversion operation control
0	Stops conversion operation
1	Enables conversion operation

ADCE	Comparator operation control <sup>Note 2</sup>							
0	Stops comparator operation							
1	Enables comparator operation							

- Notes 1. For details of FR2 to FR0, and A/D conversion, see Table 11-2 A/D Conversion Time Selection.
  - 2. The operation of the comparator is controlled by ADCS and ADCE, and it takes 1  $\mu$ s from operation start to operation stabilization. Therefore, when ADCS is set to 1 after 1  $\mu$ s or more has elapsed from the time ADCE is set to 1, the conversion result at that time has priority over the first conversion result. Otherwise, ignore data of the first conversion.



ADCS	ADCE	A/D Conversion Operation
0	0	Stop status (DC power consumption path does not exist)
0	1	Conversion waiting mode (comparator operation, only comparator consumes power)
1	0	Conversion mode (comparator operation stopped <sup>Note</sup> )
1	1	Conversion mode (comparator operation)

#### Table 11-1. Settings of ADCS and ADCE

Note Ignore data of the first conversion because it is not guaranteed range.

Figure 11-4. Timing Chart When Comparator Is Used



- **Note** To stabilize the internal circuit, the time from the rising of the ADCE bit to the rising of the ADCS bit must be 1  $\mu$ s or longer.
- Cautions 1. A/D conversion must be stopped before rewriting bits FR0 to FR2 to values other than the identical data.
  - 2. If data is written to ADM, a wait cycle is generated. Do not write data to ADM when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.



A/D Conver	rter Mode Reg	ister (ADM)		Conversior	Conversion Clock (fad)		
FR2	FR1	FR0		fprs = 2 MHz	fprs = 10 MHz	fprs = 20 MHz	
0	0	0	264/fprs	Setting prohibited	26.4 <i>µ</i> s	13.2 <i>μ</i> s	fprs/12
0	0	1	176/fprs		17.6 <i>µ</i> s	8.8 µs <sup>Note</sup>	fprs/8
0	1	0	132/fprs		13.2 <i>μ</i> s	6.6 µs <sup>Note</sup>	fprs/6
0	1	1	88/fprs		8.8 µs <sup>Note</sup>	Setting prohibited	fprs/4
1	0	0	66/fprs	33.0 <i>μ</i> s	6.6 µs <sup>Note</sup>		fprs/3
1	0	1	44/f <sub>PRS</sub>	22.0 μs	Setting prohibited		fprs/2
Other than above Setting p			Setting prof	hibited			

Table 11-2. A/D Conversion Time Selection

Note This can be set only when 4.0 V  $\leq AV_{\text{REF}} \leq 5.5$  V.

Cautions 1. Set the conversion times with the following conditions.

 $\bullet$  4.0 V  $\leq$  AVref  $\leq$  5.5 V: fad = 0.6 to 3.6 MHz

 $\bullet$  2.7 V  $\leq$  AVref < 4.0 V: fad = 0.6 to 1.8 MHz

- 2. When rewriting FR2 to FR0 to other than the same data, stop A/D conversion once (ADCS = 0) beforehand.
- 3. The above conversion time does not include clock frequency errors. Select conversion time, taking clock frequency errors into consideration.

**Remark** fprs: Peripheral hardware clock frequency





Figure 11-5. A/D Converter Sampling and A/D Conversion Timing

Note For details of wait period, see CHAPTER 33 CAUTIONS FOR WAIT.

#### (2) 10-bit A/D conversion result register (ADCR)

This register is a 16-bit register that stores the A/D conversion result. The lower 6 bits are fixed to 0. Each time A/D conversion ends, the conversion result is loaded from the successive approximation register, and is stored in ADCR in order starting from bit 7 of FF19H. FF19H indicates the higher 8 bits of the conversion result, and FF18H indicates the lower 2 bits of the conversion result.

ADCR can be read by a 16-bit memory manipulation instruction.

Reset signal generation clears this register to 0000H.

#### Figure 11-6. Format of 10-Bit A/D Conversion Result Register (ADCR)

Address: FF18H, FF19H After reset: 0000H R

Symbol	FF19H						FF18H									
ADCR											0	0	0	0	0	0

- Cautions 1. When writing to the A/D converter mode register (ADM), analog input channel specification register (ADS), and A/D port configuration register (ADPC), the contents of ADCR may become undefined. Read the conversion result following conversion completion before writing to ADM, ADS, and ADPC. Using timing other than the above may cause an incorrect conversion result to be read.
  - 2. If data is read from ADCR, a wait cycle is generated. Do not read data from ADCR when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.

#### (3) 8-bit A/D conversion result register (ADCRH)

This register is an 8-bit register that stores the A/D conversion result. The higher 8 bits of 10-bit resolution are stored.

ADCRH can be read by an 8-bit memory manipulation instruction.

Reset signal generation clears this register to 00H.

#### Figure 11-7. Format of 8-Bit A/D Conversion Result Register (ADCRH)

Address: FF19H		After reset:	00H R					
Symbol	7	6	5	4	3	2	1	0
ADCRH								

- Cautions 1. When writing to the A/D converter mode register (ADM), analog input channel specification register (ADS), and A/D port configuration register (ADPC), the contents of ADCRH may become undefined. Read the conversion result following conversion completion before writing to ADM, ADS, and ADPC. Using timing other than the above may cause an incorrect conversion result to be read.
  - 2. If data is read from ADCRH, a wait cycle is generated. Do not read data from ADCRH when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.


## (4) Analog input channel specification register (ADS)

This register specifies the input port of the analog voltage to be A/D converted. ADS can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears this register to 00H.

## Figure 11-8. Format of Analog Input Channel Specification Register (ADS)

Address: FF	2BH After	reset: 00H	R/W					
Symbol	7	6	5	4	3	2	1	0
ADS	0	0	0	0	0	ADS2	ADS1	ADS0

ADS2	ADS1	ADS0	Analog input channel specification
0	0	0	ANIO
0	0	1	ANI1
0	1	0	ANI2
0	1	1	ANI3
1	0	0	ANI4
1	0	1	ANI5
1	1	0	ANI6
1	1	1	ANI7

Cautions 1. Be sure to clear bits 3 to 7 to 0.

- 2. Because ADS and ADPC do not control input and output, set the channel used for A/D conversion in the input mode by using port mode register 2 (PM2). If the channel is set in the output mode, selection of ADPC is disabled.
- 3. Do not set a pin to be used as a digital input pin with ADPC with ADS.
- 4. If data is written to ADS, a wait cycle is generated. Do not write data to ADS when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.



# (5) A/D port configuration register (ADPC)

This register switches the P20/ANI0 to P27/ANI7 pins to analog input of A/D converter or digital I/O of port. ADPC can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears this register to 00H.

Address: FF	2DH After	reset: 00H	R/W					
Symbol	7	6	5	4	3	2	1	0
ADPC	0	0	0	0	ADPC3	ADPC2	ADPC1	ADPC0

Figure 11-9. Format of A/D Port Configuration Register (ADPC)

ADPC3	ADPC2	ADPC1	ADPC0		Analog input (A)/ digital I/O (D) switching						
				P27/ANI7	P26/ANI6	P25/ANI5	P24/ANI4	P23/ANI3	P22/ANI2	P21/ANI1	P20/ANI0
0	0	0	0	А	А	А	А	А	А	А	А
0	0	0	1	А	А	А	А	А	А	А	D
0	0	1	0	А	А	А	А	А	А	D	D
0	0	1	1	А	А	А	А	А	D	D	D
0	1	0	0	А	А	А	А	D	D	D	D
0	1	0	1	А	А	А	D	D	D	D	D
0	1	1	0	А	А	D	D	D	D	D	D
0	1	1	1	А	D	D	D	D	D	D	D
1	0	0	0	D	D	D	D	D	D	D	D
0	Other than above		ve	Setting p	rohibited						

# Cautions 1. Set the channel to be used for A/D conversion in the input mode by using port mode register 2 (PM2).

2. If data is written to ADPC, a wait cycle is generated. Do not write data to ADPC when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.



# (6) Port mode register 2 (PM2)

When using the P20/ANI0 to P27/ANI7 pins for analog input port, set PM20 to PM27 to 1. The output latches of P20 to P27 at this time may be 0 or 1.

If PM20 to PM27 are set to 0, they cannot be used as analog input port pins.

PM2 can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to FFH.

#### Figure 11-10. Format of Port mode register 2 (PM2)

Address: FF22H After reset: FFH R/W

Symbol 7 6 5 4 3 2 0 1 PM2 PM26 PM24 PM23 PM22 PM21 PM20 PM27 PM25

PM2n	P2n pin I/O mode selection (n = 0 to 7)
0	Output mode (Output buffer on)
1	Input mode (Output buffer off)

P20/ANI0 to P27/ANI7 pins are as shown below depending on the settings of ADPC, ADS, PM2.

Table 11-3. Setting Functions of P20/ANI0 to P27/ANI7 Pins
--

ADPC	PM2	ADS	P20/ANI0 to P27/ANI7 Pins
Analog input selection	Analog input selection Input mode		Analog input (to be converted)
		Does not select ANI.	Analog input (not to be converted)
	Output mode	Selects ANI.	Setting prohibited
		Does not select ANI.	
Digital I/O selection	Input mode	-	Digital input
	Output mode	_	Digital output



# 11.4 A/D Converter Operations

#### 11.4.1 Basic operations of A/D converter

- <1> Set bit 0 (ADCE) of the A/D converter mode register (ADM) to 1 to start the operation of the comparator.
- <2> Set channels for A/D conversion to analog input by using the A/D port configuration register (ADPC) and set to input mode by using port mode register 2 (PM2).
- <3> Set A/D conversion time by using bits 5 to 3 (FR2 to FR0) of ADM.
- <4> Select one channel for A/D conversion using the analog input channel specification register (ADS).
- <5> Start the conversion operation by setting bit 7 (ADCS) of ADM to 1. (<6> to <12> are operations performed by hardware.)
- <6> The voltage input to the selected analog input channel is sampled by the sample & hold circuit.
- <7> When sampling has been done for a certain time, the sample & hold circuit is placed in the hold state and the sampled voltage is held until the A/D conversion operation has ended.
- <8> Bit 9 of the successive approximation register (SAR) is set. The series resistor string voltage tap is set to (1/2) AVREF by the tap selector.
- <9> The voltage difference between the series resistor string voltage tap and sampled voltage is compared by the voltage comparator. If the analog input is greater than (1/2) AVREF, the MSB of SAR remains set to 1. If the analog input is smaller than (1/2) AVREF, the MSB is reset to 0.
- <10> Next, bit 8 of SAR is automatically set to 1, and the operation proceeds to the next comparison. The series resistor string voltage tap is selected according to the preset value of bit 9, as described below.
  - Bit 9 = 1: (3/4) AVREF
  - Bit 9 = 0: (1/4) AVREF

The voltage tap and sampled voltage are compared and bit 8 of SAR is manipulated as follows.

- Analog input voltage  $\geq$  Voltage tap: Bit 8 = 1
- Analog input voltage < Voltage tap: Bit 8 = 0
- <11> Comparison is continued in this way up to bit 0 of SAR.
- <12> Upon completion of the comparison of 10 bits, an effective digital result value remains in SAR, and the result value is transferred to the A/D conversion result register (ADCR, ADCRH) and then latched.

At the same time, the A/D conversion end interrupt request (INTAD) can also be generated.

<13> Repeat steps <6> to <12>, until ADCS is cleared to 0.

To stop the A/D converter, clear ADCS to 0.

To restart A/D conversion from the status of ADCE = 1, start from <5>. To start A/D conversion again when ADCE = 0, set ADCE to 1, wait for 1  $\mu$ s or longer, and start <5>. To change a channel of A/D conversion, start from <4>.

#### Caution Make sure the period of <1> to <5> is 1 $\mu$ s or more.

- Remark Two types of A/D conversion result registers are available.
  - ADCR (16 bits): Store 10-bit A/D conversion value
  - ADCRH (8 bits): Store 8-bit A/D conversion value





# Figure 11-11. Basic Operation of A/D Converter

A/D conversion operations are performed continuously until bit 7 (ADCS) of the A/D converter mode register (ADM) is reset (0) by software.

If a write operation is performed to the analog input channel specification register (ADS) during an A/D conversion operation, the conversion operation is initialized, and if the ADCS bit is set (1), conversion starts again from the beginning.

Reset signal generation clears the A/D conversion result register (ADCR, ADCRH) to 0000H or 00H.



## 11.4.2 Input voltage and conversion results

The relationship between the analog input voltage input to the analog input pins (ANI0 to ANI7) and the theoretical A/D conversion result (stored in the 10-bit A/D conversion result register (ADCR)) is shown by the following expression.

$$SAR = INT \left(\frac{V_{AIN}}{AV_{REF}} \times 1024 + 0.5\right)$$
$$ADCR = SAR \times 64$$

or

$$(ADCR - 0.5) \times \frac{AV_{REF}}{1024} \le V_{AIN} < (ADCR + 0.5) \times \frac{AV_{REF}}{1024}$$

- where, INT(): Function which returns integer part of value in parentheses VAIN: Analog input voltage AVREF: AVREF pin voltage
  - ADCR: A/D conversion result register (ADCR) value
  - SAR: Successive approximation register

Figure 11-12 shows the relationship between the analog input voltage and the A/D conversion result.





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## 11.4.3 A/D converter operation mode

The operation mode of the A/D converter is the select mode. One channel of analog input is selected from ANI0 to ANI7 by the analog input channel specification register (ADS) and A/D conversion is executed.

# (1) A/D conversion operation

By setting bit 7 (ADCS) of the A/D converter mode register (ADM) to 1, the A/D conversion operation of the voltage, which is applied to the analog input pin specified by the analog input channel specification register (ADS), is started.

When A/D conversion has been completed, the result of the A/D conversion is stored in the A/D conversion result register (ADCR), and an interrupt request signal (INTAD) is generated. When one A/D conversion has been completed, the next A/D conversion operation is immediately started.

If ADS is rewritten during A/D conversion, the A/D conversion operation under execution is stopped and restarted from the beginning.

If 0 is written to ADCS during A/D conversion, A/D conversion is immediately stopped. At this time, the conversion result immediately before is retained.



Figure 11-13. A/D Conversion Operation

**Remarks 1.** n = 0 to 7 **2.** m = 0 to 7



The setting methods are described below.

- <1> Set bit 0 (ADCE) of the A/D converter mode register (ADM) to 1.
- <2> Set the channel to be used in the analog input mode by using bits 4 to 0 (ADPC4 to ADPC0) of the A/D port configuration register (ADPC) and bits 7 to 0 (PM27 to PM20) of port mode register 2 (PM2).
- <3> Select conversion time by using bits 5 to 3 (FR2 to FR0) of ADM.
- <4> Select a channel to be used by using bits 3 to 0 (ADS3 to ADS0) of the analog input channel specification register (ADS).
- <5> Set bit 7 (ADCS) of ADM to 1 to start A/D conversion.
- <6> When one A/D conversion has been completed, an interrupt request signal (INTAD) is generated.
- <7> Transfer the A/D conversion data to the A/D conversion result register (ADCR, ADCRH).

<Change the channel>

- <8> Change the channel using bits 3 to 0 (ADS3 to ADS0) of ADS to start A/D conversion.
- <9> When one A/D conversion has been completed, an interrupt request signal (INTAD) is generated.

<10> Transfer the A/D conversion data to the A/D conversion result register (ADCR, ADCRH).

<Complete A/D conversion>

<11> Clear ADCS to 0.

<12> Clear ADCE to 0.

Cautions 1. Make sure the period of <1> to <5> is 1  $\mu$ s or more.

- 2. <1> may be done between <2> and <4>.
- 3. <1> can be omitted. However, ignore data of the first conversion after <5> in this case.
- 4. The period from <6> to <9> differs from the conversion time set using bits 5 to 3 (FR2 to FR0) of ADM. The period from <8> to <9> is the conversion time set using FR2 to FR0.



# 11.5 How to Read A/D Converter Characteristics Table

Here, special terms unique to the A/D converter are explained.

#### (1) Resolution

This is the minimum analog input voltage that can be identified. That is, the percentage of the analog input voltage per bit of digital output is called 1LSB (Least Significant Bit). The percentage of 1LSB with respect to the full scale is expressed by %FSR (Full Scale Range).

1LSB is as follows when the resolution is 10 bits.

 $1LSB = 1/2^{10} = 1/1024$ = 0.098%FSR

Accuracy has no relation to resolution, but is determined by overall error.

#### (2) Overall error

This shows the maximum error value between the actual measured value and the theoretical value. Zero-scale error, full-scale error, integral linearity error, and differential linearity errors that are combinations of these express the overall error.

Note that the quantization error is not included in the overall error in the characteristics table.

#### (3) Quantization error

When analog values are converted to digital values, a  $\pm 1/2$ LSB error naturally occurs. In an A/D converter, an analog input voltage in a range of  $\pm 1/2$ LSB is converted to the same digital code, so a quantization error cannot be avoided.

Note that the quantization error is not included in the overall error, zero-scale error, full-scale error, integral linearity error, and differential linearity error in the characteristics table.





#### Figure 11-15. Quantization Error



#### (4) Zero-scale error

This shows the difference between the actual measurement value of the analog input voltage and the theoretical value (1/2LSB) when the digital output changes from 0.....000 to 0.....001.

If the actual measurement value is greater than the theoretical value, it shows the difference between the actual measurement value of the analog input voltage and the theoretical value (3/2LSB) when the digital output changes from 0.....011 to 0.....010.

## (5) Full-scale error

This shows the difference between the actual measurement value of the analog input voltage and the theoretical value (Full-scale -3/2LSB) when the digital output changes from 1.....110 to 1.....111.

## (6) Integral linearity error

This shows the degree to which the conversion characteristics deviate from the ideal linear relationship. It expresses the maximum value of the difference between the actual measurement value and the ideal straight line when the zero-scale error and full-scale error are 0.

## (7) Differential linearity error

While the ideal width of code output is 1LSB, this indicates the difference between the actual measurement value and the ideal value.



Figure 11-18. Integral Linearity Error







Figure 11-19. Differential Linearity Error



## (8) Conversion time

This expresses the time from the start of sampling to when the digital output is obtained. The sampling time is included in the conversion time in the characteristics table.

#### (9) Sampling time

This is the time the analog switch is turned on for the analog voltage to be sampled by the sample & hold circuit.





# 11.6 Cautions for A/D Converter

## (1) Operating current in STOP mode

The A/D converter stops operating in the STOP mode. At this time, the operating current can be reduced by clearing bit 7 (ADCS) and bit 0 (ADCE) of the A/D converter mode register (ADM) to 0.

To restart from the standby status, clear bit 6 (ADIF) of interrupt request flag register 1L (IF1L) to 0 and start operation.

## (2) Input range of ANI0 to ANI7

Observe the rated range of the ANI0 to ANI7 input voltage. If a voltage of AV<sub>REF</sub> or higher and AVss or lower (even in the range of absolute maximum ratings) is input to an analog input channel, the converted value of that channel becomes undefined. In addition, the converted values of the other channels may also be affected.

## (3) Conflicting operations

- <1> Conflict between A/D conversion result register (ADCR, ADCRH) write and ADCR or ADCRH read by instruction upon the end of conversion ADCR or ADCRH read has priority. After the read operation, the new conversion result is written to ADCR
- or ADCRH.
  <2> Conflict between ADCR or ADCRH write and A/D converter mode register (ADM) write, analog input channel specification register (ADS), or A/D port configuration register (ADPC) write upon the end of conversion

ADM, ADS, or ADPC write has priority. ADCR or ADCRH write is not performed, nor is the conversion end interrupt signal (INTAD) generated.

#### (4) Noise countermeasures

To maintain the 10-bit resolution, attention must be paid to noise input to the AVREF pin and pins ANI0 to ANI7.

- <1> Connect a capacitor with a low equivalent resistance and a good frequency response to the power supply.
- <2> The higher the output impedance of the analog input source, the greater the influence. To reduce the noise, connecting external C as shown in **Figure 11-20** is recommended.
- <3> Do not switch these pins with other pins during conversion.
- <4> The accuracy is improved if the HALT mode is set immediately after the start of conversion.



#### Figure 11-20. Analog Input Pin Connection



#### (5) P20/ANI0 to P27/ANI7

<1> The analog input pins (ANI0 to ANI7) are also used as I/O port pins (P20 to P27). When A/D conversion is performed with any of ANI0 to ANI7 selected, do not access P20 to P27 while conversion is in progress; otherwise the conversion resolution may be degraded. It is recommended to

select pins used as P20 to P27 starting with the P20/ANI0 that is the furthest from AVREF.

<2> If a digital pulse is applied to the pins adjacent to the pins currently used for A/D conversion, the expected value of the A/D conversion may not be obtained due to coupling noise. Therefore, do not apply a pulse to the pins adjacent to the pin undergoing A/D conversion.

#### (6) Input impedance of ANI0 to ANI7 pins

This A/D converter charges a sampling capacitor for sampling during sampling time.

Therefore, only a leakage current flows when sampling is not in progress, and a current that charges the capacitor flows during sampling. Consequently, the input impedance fluctuates depending on whether sampling is in progress, and on the other states.

To make sure that sampling is effective, however, it is recommended to keep the output impedance of the analog input source to within 10 k $\Omega$ , and to connect a capacitor of about 100 pF to the ANI0 to ANI7 pins (see **Figure 11-20. Analog Input Pin Connection**).

#### (7) AVREF pin input impedance

A series resistor string of several tens of  $k\Omega$  is connected between the AV<sub>REF</sub> and AV<sub>SS</sub> pins. Therefore, if the output impedance of the reference voltage source is high, this will result in a series connection to the series resistor string between the AV<sub>REF</sub> and AV<sub>SS</sub> pins, resulting in a large reference voltage error.



# (8) Interrupt request flag (ADIF)

The interrupt request flag (ADIF) is not cleared even if the analog input channel specification register (ADS) is changed.

Therefore, if an analog input pin is changed during A/D conversion, the A/D conversion result and ADIF for the pre-change analog input may be set just before the ADS rewrite. Caution is therefore required since, at this time, when ADIF is read immediately after the ADS rewrite, ADIF is set despite the fact A/D conversion for the post-change analog input has not ended.

When A/D conversion is stopped and then resumed, clear ADIF before the A/D conversion operation is resumed.



Figure 11-21. Timing of A/D Conversion End Interrupt Request Generation

**Remarks 1.** n = 0 to 7

**2.** m = 0 to 7

#### (9) Conversion results just after A/D conversion start

The first A/D conversion value immediately after A/D conversion starts may not fall within the rating range if the ADCS bit is set to 1 within 1  $\mu$ s after the ADCE bit was set to 1, or if the ADCS bit is set to 1 with the ADCE bit = 0. Take measures such as polling the A/D conversion end interrupt request (INTAD) and removing the first conversion result.

# (10) A/D conversion result register (ADCR, ADCRH) read operation

When a write operation is performed to the A/D converter mode register (ADM), analog input channel specification register (ADS), and A/D port configuration register (ADPC), the contents of ADCR and ADCRH may become undefined. Read the conversion result following conversion completion before writing to ADM, ADS, and ADPC. Using a timing other than the above may cause an incorrect conversion result to be read.



# (11) Internal equivalent circuit

The equivalent circuit of the analog input block is shown below.

## Figure 11-22. Internal Equivalent Circuit of ANIn Pin



Table 11-4. Resistance and Capacitance Values of Equivalent Circuit (Reference Values)

AVREF	R1	C1	C2
$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$	8.1 kΩ	8 pF	5 pF
$2.7 \text{ V} \le AV_{\text{REF}} < 4.0 \text{ V}$	31 kΩ	8 pF	5 pF

**Remarks 1.** The resistance and capacitance values shown in **Table 11-4** are not guaranteed values. **2.** n = 0 to 7



# CHAPTER 12 SERIAL INTERFACES UART60 AND UART61

The 78K0/Dx2 incorporate serial interfaces UART60 and UART61.

## 12.1 Functions of Serial Interfaces UART60 and UART61

#### Caution Serial interface UART61 is for 78K0/DF2 only.

Serial interfaces UART60 and UART61 have the following two modes.

#### (1) Operation stop mode

This mode is used when serial communication is not executed and can enable a reduction in the power consumption.

For details, see **12.4.1** Operation stop mode.

#### (2) Asynchronous serial interface (UART) mode

This mode supports the LIN (Local Interconnect Network)-bus. The functions of this mode are outlined below. For details, see **12.4.2** Asynchronous serial interface (UART) mode and **12.4.3** Dedicated baud rate generator.

- Maximum transfer rate: 625 kbps
- Two-pin configuration TxD6n: Transmit data output pin

RxD6n: Receive data input pin

- Data length of communication data can be selected from 7 or 8 bits.
- Dedicated internal 8-bit baud rate generator allowing any baud rate to be set
- Transmission and reception can be performed independently (full-duplex operation).
- Twelve operating clock inputs selectable
- MSB- or LSB-first communication selectable
- Inverted transmission operation
- Sync break field transmission from 13 to 20 bits
- More than 11 bits can be identified for sync break field reception (SBF reception flag provided).

Cautions 1. The TXD6n output inversion function inverts only the transmission side and not the reception side. To use this function, the reception side must be ready for reception of inverted data.

- 2. If clock supply to serial interfaces UART60 and UART61 are not stopped (e.g., in the HALT mode), normal operation continues. If clock supply to serial interfaces UART60 and UART61 are stopped (e.g., in the STOP mode), each register stops operating, and holds the value immediately before clock supply was stopped. The TXD6n pins also holds the value immediately before clock supply was stopped and outputs it. However, the operation is not guaranteed after clock supply is resumed. Therefore, reset the circuit by setting POWER6n = 0, RXE6n = 0, and TXE6n = 0.
- 3. Set POWER6n = 1 and then set TXE6n = 1 (transmission) or RXE6n = 1 (reception) to start communication.
- 4. TXE6n and RXE6n are synchronized by the base clock (fxcLK6) set by CKSR6n. To enable transmission or reception again, set TXE6n or RXE6n to 1 at least two clocks of the base clock after TXE6n or RXEn6 has been cleared to 0. If TXE6n or RXE6n is set within two clocks of the base clock, the transmission circuit or reception circuit may not be initialized.

Cautions 5. Set transmit data to TXB6n at least one base clock (fxcLK6) after setting TXE6n = 1.

- 6. If data is continuously transmitted, the communication timing from the stop bit to the next start bit is extended two operating clocks of the macro. However, this does not affect the result of communication because the reception side initializes the timing when it has detected a start bit. Do not use the continuous transmission function if the interface is used in LIN communication operation.
- **Remarks 1.** LIN stands for Local Interconnect Network and is a low-speed (1 to 20 kbps) serial communication protocol intended to aid the cost reduction of an automotive network.

LIN communication is single-master communication, and up to 15 slaves can be connected to one master.

The LIN slaves are used to control the switches, actuators, and sensors, and these are connected to the LIN master via the LIN network.

Normally, the LIN master is connected to a network such as CAN (Controller Area Network).

In addition, the LIN bus uses a single-wire method and is connected to the nodes via a transceiver that complies with ISO9141.

n the LIN protocol, the master transmits a frame with baud rate information and the slave receives it and corrects the baud rate error. Therefore, communication is possible when the baud rate error in the slave is  $\pm 15\%$  or less.

**2.** n = 0, 1

Figures 12-1 and 12-2 outline the transmission and reception operations of LIN.



#### Figure 12-1. LIN Transmission Operation

Notes 1. The wakeup signal frame is substituted by 80H transmission in the 8-bit mode.

- The sync break field is output by hardware. The output width is the bit length set by bits 4 to 2 (SBL62n to SBL60n) of asynchronous serial interface control register 6n (ASICL6n). If more precise output width adjustment is necessary, use baud rate generator control register 6n (BRGC6n) (see 12.4.2 (2) (h) SBF transmission).
- 3. INTST6n is output on completion of each transmission. It is also output when SBF is transmitted.

 $\label{eq:result} \begin{array}{ll} \textbf{Remark} & \text{The interval between each field is controlled by software.} \end{array}$ 

n = 0, 1





#### Figure 12-2. LIN Reception Operation

Reception processing is as follows.

- <1> The wakeup signal is detected at the edge of the pin, and enables UART6n and sets the SBF reception mode.
- <2> Reception continues until the STOP bit is detected. When an SBF with low-level data of 11 bits or more has been detected, it is assumed that SBF reception has been completed correctly, and an interrupt signal is output. If an SBF with low-level data of less than 11 bits has been detected, it is assumed that an SBF reception error has occurred. The interrupt signal is not output and the SBF reception mode is restored.
- <3> If SBF reception has been completed correctly, an interrupt signal is output. Start 16-bit timer/event counter 00 by the SBF reception end interrupt servicing and measure the bit interval (pulse width) of the sync field (see 6.5.7 Pulse width measurement mode (TPnMD2 to TPnMD0 bits = 110)). Detection of errors OVE6n, PE6n, and FE6n is suppressed, and error detection processing of UART communication and data transfer of the shift register and RXB6n is not performed. The shift register holds the reset value FFH.
- <4> Calculate the baud rate error from the bit length of the sync field, disable UART6n after SF reception, and then re-set baud rate generator control register 6n (BRGC6n).
- <5> Distinguish the checksum field by software. Also perform processing by software to initialize UART6n after reception of the checksum field and to set the SBF reception mode again.

**Remark** n = 0, 1



Figures 12-3 and 12-4 show the port configuration for LIN reception operation.

The wakeup signal transmitted from the LIN master is received by detecting the edge of the external interrupt (INTPR60 and INTPR61). The length of the sync field transmitted from the LIN master can be measured using the external event capture operation of 16-bit timer/event counter P2, P3, and the baud rate error can be calculated.

The input source of the reception port input (RxD60 and RxD61) can be input to 16-bit timer/event counter P2, P3 by port input switch control (ISC), without connecting RxD60/INTPR60, RxD61/INTPR61, TIOP20 and TIOP30 externally.





- Notes 1. Check the port function setting by referring to CHAPTER 4 PORT FUNCTIONS.
  - **2.** *μ* PD78F0844 and 78F0845 only.
- Remark ISC1, ISC7: Bits 1 and 7 of the input switch control register (ISC) (see Figure 12-19. Format of Input Switch Control Register (ISC).)

ISC7	ISC1	RxD60/INTPR60 input	TIP20 (TMP2 input)	Remark
0	0	RxD60/INTPR60 (P14)	RxD60/INTPR60/TIOP20 (P14)	LIN mode (TIOP20 can be used)
0	1	RxD60/INTPR60 (P14)	RxD60/INTPR60 (P14)	LIN mode
1	0	<rxd60 intpr60=""> (P70)</rxd60>	TIOP20 (P14)	
1	1	<rxd60 intpr60=""> (P70)</rxd60>	<rxd60 intpr60=""> (P70)</rxd60>	LIN mode





# Figure 12-3. Port Configuration for LIN Reception Operation (UART60) (2/2) (b) 78K0/DF2

- Notes 1. Check the port function setting by referring to CHAPTER 4 PORT FUNCTIONS.
  - **2.** *μ* PD78F0846, 78F0847, 78F0848, and 78F0849 only.
- Remark ISC1, ISC5, ISC7: Bits 1, 5, and 7 of the input switch control register (ISC) (see Figure 12-19. Format of Input Switch Control Register (ISC).)

ISC7	ISC5	ISC1	RxD60/INTPR60 input	TIP20 (TMP2 input)	Remark
0	0	0	RxD60/INTPR60 (P14)	RxD60/INTPR60/TIOP20 (P14)	LIN mode (TIOP20 can be used)
0	0	1	RxD60/INTPR60 (P14)	RxD60/INTPR60 (P14)	LIN mode
0	1	0	RxD60/INTPR60 (P14)	<tiop20> (P77)</tiop20>	
0	1	1	RxD60/INTPR60 (P14)	RxD60/INTPR60 (P14)	LIN mode
1	0	0	<rxd60 intpr60=""> (P70)</rxd60>	TIOP20 (P14)	
1	0	1	<rxd60 intpr60=""> (P70)</rxd60>	<rxd60 intpr60=""> (P70)</rxd60>	LIN mode
1	1	0	<rxd60 intpr60=""> (P70)</rxd60>	<tiop20> (P77)</tiop20>	
1	1	1	<rxd60 intpr60=""> (P70)</rxd60>	<rxd60 intpr60=""> (P70)</rxd60>	LIN mode

The peripheral functions used in the LIN communication operation are shown below.

<Peripheral functions used>

- External interrupt (INTPR60); wakeup signal detection
  Use: Detects the wakeup signal edges and detects start of communication.
- 16-bit timer/event counter P2 (TMP2); baud rate error detection
  - Use: Detects the baud rate error (measures the TMP2 input edge interval in the capture mode) by detecting the sync field (SF) length and divides it by the number of bits.
- Serial interface UART60.

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Figure 12-4. Port Configuration for LIN Reception Operation (UART61)

Note Check the port function setting by referring to CHAPTER 4 PORT FUNCTIONS.

Remark ISC2, ISC6: Bits 2 and 6 of the input switch control register (ISC) (see Figure 12-19. Format of Input Switch Control Register (ISC).)

ISC6	ISC2	RxD61/INTPR61 input	TIP30 (TMP3 input)	INTP0	Remark
0	0	RxD61/INTPR61 (P11)	TIOP30 (P13)	INTP0 (P17)	
0	1	RxD61/INTPR61 (P11)	RxD61/INTPR61 (P11)	INTP0 (P17)	LIN mode
1	0	RxD61/INTPR61 (P11)	<tiop30> (P17)</tiop30>	INTP0 (P17)	
1	1	RxD61/INTPR61 (P11)	RxD61/INTPR61 (P11)	INTP0 (P17)	LIN mode

The peripheral functions used in the LIN communication operation are shown below. <Peripheral functions used>

- External interrupt (INTPR61); wakeup signal detection
  Use: Detects the wakeup signal edges and detects start of communication.
- 16-bit timer/event counter P3 (TMP3); baud rate error detection
  - Use: Detects the baud rate error (measures the TMP3 input edge interval in the capture mode) by detecting the sync field (SF) length and divides it by the number of bits.
- Serial interface UART61.

# 12.2 Configurations of Serial Interface UART60 and UART61

Serial interfaces UART60 and UART61 include the following hardware.

# Table 12-1. Configurations of Serial Interface UART60 and UART61

Item	Configuration
Registers	Receive buffer register 6n (RXB6n) Receive shift register 6n (RXS6n) Transmit buffer register 6n (TXB6n) Transmit shift register 6n (TXS6n)
Control registers	Asynchronous serial interface operation mode register 6n (ASIM6n) Asynchronous serial interface reception error status register 6n (ASIS6n) Asynchronous serial interface transmission status register 6n (ASIF6n) Clock selection register 6n (CKSR6n) Baud rate generator control register 6n (BRGC6n) Asynchronous serial interface control register 6n (ASICL6n) Input switch control register (ISC) Port mode registers 1 and 7 (PM1, PM7) Port registers 1 and 7 (P1, P7)

**Remark** n = 0, 1





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78K0/Dx2

R01UH0009EJ0300 Rev. 3.00 Oct 29, 2010 Note Selectable with input switch control register (ISC).



Figure 12-6. Block Diagram of Serial Interface UART61

# (1) Receive buffer register 6n (RXB6n)

This 8-bit register stores parallel data converted by receive shift register 6n (RXS6n).

Each time 1 byte of data has been received, new receive data is transferred to this register from RXS6n. If the data length is set to 7 bits, data is transferred as follows.

- In LSB-first reception, the receive data is transferred to bits 0 to 6 of RXB6n and the MSB of RXB6n is always 0.
- In MSB-first reception, the receive data is transferred to bits 1 to 7 of RXB6n and the LSB of RXB6n is always 0.

If an overrun error (OVE6n) occurs, the receive data is not transferred to RXB6n. RXB6n can be read by an 8-bit memory manipulation instruction. No data can be written to this register. Reset signal generation sets this register to FFH.

# (2) Receive shift register 6n (RXS6n)

This register converts the serial data input to the RxD6n pins into parallel data. RXS6n cannot be directly manipulated by a program.

# (3) Transmit buffer register 6n (TXB6n)

This buffer register is used to set transmit data. Transmission is started when data is written to TXB6n. This register can be read or written by an 8-bit memory manipulation instruction. Reset signal generation sets this register to FFH.

- Cautions 1. Do not write data to TXB6n when bit 1 (TXBF6n) of asynchronous serial interface transmission status register 6n (ASIF6n) is 1.
  - 2. Do not refresh (write the same value to) TXB6n by software during a communication operation (when bits 7 and 6 (POWER6n, TXE6n) of asynchronous serial interface operation mode register 6n (ASIM6n) are 1 or when bits 7 and 5 (POWER6n, RXE6n) of ASIM6n are 1).
  - 3. Set transmit data to TXB6n at least one base clock (fxcLK6) after setting TXE6n = 1.

# (4) Transmit shift register 6n (TXS6n)

This register transmits the data transferred from TXB6n from the TxD6n pins as serial data. Data is transferred from TXB6n immediately after TXB6n is written for the first transmission, or immediately before INTST6n occurs after one frame was transmitted for continuous transmission. Data is transferred from TXB6n and transmitted from the TxD6n pins at the falling edge of the base clock.

TXS6n cannot be directly manipulated by a program.

**Remark** n = 0, 1



# 12.3 Registers Controlling Serial Interfaces UART60 and UART61

Serial interfaces UART60 and UART61 are controlled by the following nine registers.

- Asynchronous serial interface operation mode register 6n (ASIM6n)
- Asynchronous serial interface reception error status register 6n (ASIS6n)
- Asynchronous serial interface transmission status register 6n (ASIF6n)
- Clock selection register 6n (CKSR6n)
- Baud rate generator control register 6n (BRGC6n)
- Asynchronous serial interface control register 6n (ASICL6n)
- Input switch control register (ISC)
- Port mode registers 1 and 7 (PM1, PM7)
- Port registers 1 and 7 (P1, P7)

**Remark** n = 0, 1 (the registers given with n = 1 are for 78K0/DF2 only).



## (1) Asynchronous serial interface operation mode register 6n (ASIM6n)

This 8-bit register controls the serial communication operations of serial interface UART60 and UART61. This register can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation sets this register to 01H.

- Remarks 1. ASIM6n can be refreshed (the same value is written) by software during a communication operation (when bits 7 and 6 (POWER6n, TXE6n) of ASIM6n = 1 or bits 7 and 5 (POWER6n, RXE6n) of ASIM6n = 1).
  - **2.** n = 0, 1

## Figure 12-7. Format of Asynchronous Serial Interface Operation Mode Register 60 (ASIM60) (1/2)

Address: FF50H After reset: 01H R/W

Sy AS

mbol	<7>	<6>	<5>	4	3	2	1	0
SIM60	POWER60	TXE60	RXE60	PS610	PS600	CL60	SL60	1

POWER60	Enables/disables operation of internal operation clock
0 <sup>Note 1</sup>	Disables operation of the internal operation clock (fixes the clock to low level) and asynchronously resets the internal circuit <sup>Note 2</sup> .
1	Enables operation of the internal operation clock

TXE60	Enables/disables transmission
0	Disables transmission (synchronously resets the transmission circuit).
1	Enables transmission

RXE60	Enables/disables reception
0	Disables reception (synchronously resets the reception circuit).
1	Enables reception

Notes 1. The output of the TxD60 pins goes high level and the input from the RxD60 pins is fixed to the high level when POWER60 = 0 during transmission.

2. Asynchronous serial interface reception error status register 60 (ASIS60), asynchronous serial interface transmission status register 60 (ASIF60), bit 7 (SBRF60) and bit 6 (SBRT60) of asynchronous serial interface control register 60 (ASICL60), and receive buffer register 60 (RXB60) are reset.



PS610	PS600	Transmission operation	Reception operation
0	0	Does not output parity bit.	Reception without parity
0	1	Outputs 0 parity.	Reception as 0 parity <sup>Note</sup>
1	0	Outputs odd parity.	Judges as odd parity.
1	1	Outputs even parity.	Judges as even parity.

#### Figure 12-7. Format of Asynchronous Serial Interface Operation Mode Register 60 (ASIM60) (2/2)

CL60	Specifies character length of transmit/receive data	
0	Character length of data = 7 bits	
1	Character length of data = 8 bits	

SL60	Specifies number of stop bits of transmit data
0	Number of stop bits = 1
1	Number of stop bits = 2

**Note** If "reception as 0 parity" is selected, the parity is not judged. Therefore, bit 2 (PE60) of asynchronous serial interface reception error status register 60 (ASIS60) is not set and the error interrupt does not occur.

## Cautions 1. Be sure to set bit 0 to 1.

- 2. To start the transmission, set POWER60 to 1 and then set TXE60 to 1. To stop the transmission, clear TXE60 to 0, and then clear POWER60 to 0.
- 3. To start the reception, set POWER60 to 1 and then set RXE60 to 1. To stop the reception, clear RXE60 to 0, and then clear POWER60 to 0.
- 4. Set POWER60 to 1 and then set RXE60 to 1 while a high level is input to the RxD60 pins. If POWER60 is set to 1 and RXE60 is set to 1 while a low level is input, reception is started.
- 5. TXE60 and RXE60 are synchronized by the base clock (fxcLK6) set by CKSR60. To enable transmission or reception again, set TXE60 or RXE60 to 1 at least two clocks of the base clock after TXE60 or RXE60 has been cleared to 0. If TXE60 or RXE60 is set within two clocks of the base clock, the transmission circuit or reception circuit may not be initialized.
- 6. Set transmit data to TXB60 at least one base clock (fxcLK6) after setting TXE60 = 1.
- 7. Clear the TXE60 and RXE60 bits to 0 before rewriting the PS610, PS600, and CL60 bits.
- 8. Fix the PS610 and PS600 bits to 0 when used in LIN communication operation.
- 9. Clear TXE60 to 0 before rewriting the SL60 bit. Reception is always performed with "the number of stop bits = 1", and therefore, is not affected by the set value of the SL60 bit.



## 78K0/Dx2

# Figure 12-8. Format of Asynchronous Serial Interface Operation Mode Register 61 (ASIM61) (1/2)

Address:	FF2EH	After reset:	01H	R/W	
----------	-------	--------------	-----	-----	--

Symbol	<7>	<6>	<5>	4	3	2	1	0
ASIM61	POWER61	TXE61	RXE61	PS611	PS601	CL61	SL61	1

POWER61	Enables/disables operation of internal operation clock
0 <sup>Note 1</sup>	Disables operation of the internal operation clock (fixes the clock to low level) and asynchronously resets the internal circuit <sup>Note 2</sup> .
1	Enables operation of the internal operation clock

TXE61	Enables/disables transmission
0	Disables transmission (synchronously resets the transmission circuit).
1	Enables transmission

RXE61	Enables/disables reception
0	Disables reception (synchronously resets the reception circuit).
1	Enables reception

**Notes 1.** The output of the TXD61 pins goes high level and the input from the RXD61 pins is fixed to the high level when POWER61 = 0 during transmission.

2. Asynchronous serial interface reception error status register 61 (ASIS61), asynchronous serial interface transmission status register 61 (ASIF61), bit 7 (SBRF61) and bit 6 (SBRT61) of asynchronous serial interface control register 61 (ASICL61), and receive buffer register 61 (RXB61) are reset.



PS611	PS601	Transmission operation	Reception operation
0	0	Does not output parity bit.	Reception without parity
0	1	Outputs 0 parity.	Reception as 0 parity <sup>Note</sup>
1	0	Outputs odd parity.	Judges as odd parity.
1	1	Outputs even parity.	Judges as even parity.

#### Figure 12-8. Format of Asynchronous Serial Interface Operation Mode Register 61 (ASIM61) (2/2)

CL61	Specifies character length of transmit/receive data		
0	Character length of data = 7 bits		
1	Character length of data = 8 bits		

SL61	Specifies number of stop bits of transmit data
0	Number of stop bits = 1
1	Number of stop bits = 2

**Note** If "reception as 0 parity" is selected, the parity is not judged. Therefore, bit 2 (PE61) of asynchronous serial interface reception error status register 61 (ASIS61) is not set and the error interrupt does not occur.

## Cautions 1. Be sure to set bit 0 to 1.

- 2. To start the transmission, set POWER61 to 1 and then set TXE61 to 1. To stop the transmission, clear TXE61 to 0, and then clear POWER61 to 0.
- 3. To start the reception, set POWER61 to 1 and then set RXE61 to 1. To stop the reception, clear RXE61 to 0, and then clear POWER61 to 0.
- 4. Set POWER61 to 1 and then set RXE61 to 1 while a high level is input to the RxD61 pins. If POWER61 is set to 1 and RXE61 is set to 1 while a low level is input, reception is started.
- 5. TXE61 and RXE61 are synchronized by the base clock (fxcLK6) set by CKSR61. To enable transmission or reception again, set TXE61 or RXE61 to 1 at least two clocks of the base clock after TXE61 or RXE61 has been cleared to 0. If TXE61 or RXE61 is set within two clocks of the base clock, the transmission circuit or reception circuit may not be initialized.
- 6. Set transmit data to TXB61 at least one base clock (fxcLK6) after setting TXE61 = 1.
- 7. Clear the TXE61 and RXE61 bits to 0 before rewriting the PS611, PS601, and CL61 bits.
- 8. Fix the PS611 and PS601 bits to 0 when used in LIN communication operation.
- 9. Clear TXE61 to 0 before rewriting the SL61 bit. Reception is always performed with "the number of stop bits = 1", and therefore, is not affected by the set value of the SL61 bit.



## (2) Asynchronous serial interface reception error status register 6n (ASIS6n)

This register indicates an error status on completion of reception by serial interfaces UART60 and UART61. It includes three error flag bits (PE6n, FE6n, OVE6n).

This register is read-only by an 8-bit memory manipulation instruction.

Reset signal generation, or clearing bit 7 (POWER6n) or bit 5 (RXE6n) of ASIM6n to 0 clears this register to 00H. 00H is read when this register is read. If a reception error occurs, read ASIS6n and then read receive buffer register 6n (RXB6n) to clear the error flag.

**Remark** n = 0, 1

## Figure 12-9. Format of Asynchronous Serial Interface Reception Error Status Register 60 (ASIS60)

Address: FF53H After reset: 00H R

Symbo

nbol	7	6	5	4	3	2	1	0
S60	0	0	0	0	0	PE60	FE60	OVE60

PE60	Status flag indicating parity error
0	If POWER60 = 0 and RXE60 = 0, or if ASIS60 register is read
1	If the parity of transmit data does not match the parity bit on completion of reception

FE60	Status flag indicating framing error
0	If POWER60 = 0 and RXE60 = 0, or if ASIS60 register is read
1	If the stop bit is not detected on completion of reception

OVE60	Status flag indicating overrun error
0	If POWER60 = 0 and RXE60 = 0, or if ASIS60 register is read
1	If receive data is set to the RXB60 register and the next reception operation is completed before the data is read.

Cautions 1. The operation of the PE60 bit differs depending on the set values of the PS610 and PS600 bits of asynchronous serial interface operation mode register 60 (ASIM60).

- 2. The first bit of the receive data is checked as the stop bit, regardless of the number of stop bits.
- 3. If an overrun error occurs, the next receive data is not written to receive buffer register 60 (RXB60) but discarded.
- 4. If data is read from ASIS60, a wait cycle is generated. Do not read data from ASIS60 when the CPU is operating on the subsystem clock and the high-speed system clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.



#### 78K0/Dx2

# Figure 12-10. Format of Asynchronous Serial Interface Reception Error Status Register 61 (ASIS61)

Address: FF2FH After reset: 00H R								
Symbol	7	6	5	4	3	2	1	0
ASIS61	0	0	0	0	0	PE61	FE61	OVE61

PE61	Status flag indicating parity error
0	If POWER61 = 0 and RXE61 = 0, or if ASIS61 register is read
1	If the parity of transmit data does not match the parity bit on completion of reception

FE61	Status flag indicating framing error
0	If POWER61 = 0 and RXE61 = 0, or if ASIS61 register is read
1	If the stop bit is not detected on completion of reception

OVE61	Status flag indicating overrun error
0	If POWER61 = 0 and RXE61 = 0, or if ASIS61 register is read
1	If receive data is set to the RXB61 register and the next reception operation is completed before the data is read.

Cautions 1. The operation of the PE61 bit differs depending on the set values of the PS611 and PS601 bits of asynchronous serial interface operation mode register 61 (ASIM61).

- 2. The first bit of the receive data is checked as the stop bit, regardless of the number of stop bits.
- 3. If an overrun error occurs, the next receive data is not written to receive buffer register 61 (RXB61) but discarded.
- 4. If data is read from ASIS61, a wait cycle is generated. Do not read data from ASIS61 when the CPU is operating on the subsystem clock and the high-speed system clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.



## (3) Asynchronous serial interface transmission status register 6n (ASIF6n)

This register indicates the status of transmission by serial interfaces UART60 and UART61. It includes two status flag bits (TXBF6n and TXSF6n).

Transmission can be continued without disruption even during an interrupt period, by writing the next data to the TXB6n register after data has been transferred from the TXB6n register to the TXS6n register.

This register is read-only by an 8-bit memory manipulation instruction.

Reset signal generation, or clearing bit 7 (POWER6n) or bit 6 (TXE6n) of ASIM6n to 0 clears this register to 00H.

**Remark** n = 0, 1

## Figure 12-11. Format of Asynchronous Serial Interface Transmission Status Register 60 (ASIF60)

Address: FF55H After reset: 00H R

AS

Symbol	7	6	5	4	3	2	1	0
ASIF60	0	0	0	0	0	0	TXBF60	TXSF60

TXBF60	Transmit buffer data flag
0	If POWER60 = 0 or TXE60 = 0, or if data is transferred to transmit shift register 60 (TXS60)
1	If data is written to transmit buffer register 60 (TXB60) (if data exists in TXB60)

TXSF60	Transmit shift register data flag
0	If POWER60 = 0 or TXE60 = 0, or if the next data is not transferred from transmit buffer register 60 (TXB60) after completion of transfer
1	If data is transferred from transmit buffer register 60 (TXB60) (if data transmission is in progress)

- Cautions 1. To transmit data continuously, write the first transmit data (first byte) to the TXB60 register. Be sure to check that the TXBF60 flag is "0". If so, write the next transmit data (second byte) to the TXB60 register. If data is written to the TXB60 register while the TXBF60 flag is "1", the transmit data cannot be guaranteed.
  - 2. To initialize the transmission unit upon completion of continuous transmission, be sure to check that the TXSF60 flag is "0" after generation of the transmission completion interrupt, and then execute initialization. If initialization is executed while the TXSF60 flag is "1", the transmit data cannot be guaranteed.



#### Figure 12-12. Format of Asynchronous Serial Interface Transmission Status Register 61 (ASIF61)

Address: FF:	38H After rese	et: 00H R								
Symbol	7	6	5	4	3	2	1	0		
ASIF61	0	0	0	0	0	0	TXBF61	TXSF61		
	TXBF61		Transmit buffer data flag							
	0	If POWER61	If POWER61 = 0 or TXE61 = 0, or if data is transferred to transmit shift register 61 (TXS61)							
1 If data is written to transmit buffer register 61 (TXB61) (if data exists in TXB6							ГХВ61)			

TXSF61	Transmit shift register data flag
0	If POWER61 = 0 or TXE61 = 0, or if the next data is not transferred from transmit buffer register 61 (TXB61) after completion of transfer
1	If data is transferred from transmit buffer register 61 (TXB61) (if data transmission is in progress)

- Cautions 1. To transmit data continuously, write the first transmit data (first byte) to the TXB61 register. Be sure to check that the TXBF61 flag is "0". If so, write the next transmit data (second byte) to the TXB61 register. If data is written to the TXB61 register while the TXBF61 flag is "1", the transmit data cannot be guaranteed.
  - 2. To initialize the transmission unit upon completion of continuous transmission, be sure to check that the TXSF61 flag is "0" after generation of the transmission completion interrupt, and then execute initialization. If initialization is executed while the TXSF61 flag is "1", the transmit data cannot be guaranteed.



# (4) Clock selection register 6n (CKSR6n)

This register selects the base clocks of serial interface UART60 and UART61. CKSR6n can be set by an 8-bit memory manipulation instruction. Reset signal generation sets this register to 00H.

**Remarks 1.** CKSR6n can be refreshed (the same value is written) by software during a communication operation (when bits 7 and 6 (POWER6n, TXE6n) of ASIM6n = 1 or bits 7 and 5 (POWER6n, RXE6n) of ASIM6n = 1).

**2.** n = 0, 1



Address: FF5	56H After rese	t: 00H R/W								
Symbol	7	6	5	4	3 2		2	1	0	
CKSR60	0	0	0	0	TPS6	30 TPS	5620 T	PS610	TPS600	
	TPS630	TPS620	TPS610	TPS600		Base clo	ock (fxclk6) se	election <sup>Note 1</sup>		
						fprs =		fprs =	fprs =	
						2 MHz	5 MHz	10 MHz	20 MHz	
	0	0	0	0	<b>f</b> PRS	2 MHz	5 MHz	10 MHz	20 MHz	
	0	0	0	1	fprs/2	1 MHz	2.5 MHz	5 MHz	10 MHz	
	0	0	1	0	fprs/2 <sup>2</sup>	500 kHz	1.25 MHz	2.5 MHz	5 MHz	
	0	0	1	1	fprs/2 <sup>3</sup>	250 kHz	625 kHz	1.25 MHz	2.5 MHz	
	0	1	0	0	f <sub>PRS</sub> /2⁴	125 kHz	312.5 kHz	625 kHz	1.25 MHz	
	0	1	0	1	f <sub>PRS</sub> /2⁵	62.5 kHz	156.25 kHz	312.5 kHz	625 kHz	
	0	1	1	0	fprs/26	31.25 kHz	78.13 kHz	156.25 kHz	312.5 kHz	
	0	1	1	1	fprs/27	15.625 kHz	39.06 kHz	78.13 kHz	156.25 kHz	
	1	0	0	0	fprs/2 <sup>8</sup>	7.813 kHz	19.53 kHz	39.06 kHz	78.13 kHz	
	1	0	0	1	fprs/29	3.906 kHz	9.77 kHz	19.53 kHz	39.06 kHz	
	1	0	1	0	fprs/2 <sup>10</sup>	1.953 kHz	4.88 kHz	9.77 kHz	19.53 kHz	
	1	0	1	1	TM50 output <sup>Note 2</sup>					
	Other than above				Setting prohibited					

# Figure 12-13. Format of Clock Selection Register 60 (CKSR60)

Notes 1. If the peripheral hardware clock (fPRs) operates on the high-speed system clock (fIN) (XSEL = 1), the fPRs operating frequency varies depending on the supply voltage.
 •VDD = 4.0 to 5.5 V: fPRs ≤ 20 MHz

•VDD = 2.7 to 4.0 V: fPRs  $\leq$  10 MHz

- 2. Note the following points when selecting the TM50 output as the base clock.
  - Mode in which the count clock is cleared and started upon a match of TM50 and CR50 (TMC506 = 0)

Start the operation of 8-bit timer/event counter 50 first and then enable the timer F/F inversion operation (TMC501 = 1).

 PWM mode (TMC506 = 1) Start the operation of 8-bit timer/event counter 50 first and then set the count clock to make the duty = 50%.

It is not necessary to enable the TO50 pin as a timer output pin in any mode.

# Caution Make sure POWER60 = 0 when rewriting TPS630 to TPS600.

- Remarks 1. fprs: Peripheral hardware clock frequency
  - 2. TMC506: Bit 6 of 8-bit timer mode control register 50 (TMC50) TMC501: Bit 1 of TMC50



Address: FF3	39H After rese	t: 00H R/W								
Symbol	7	6	5	4	3		2	1	0	
CKSR61	0	0	0	0	TPS6	31 TPS	5621 T	PS611	TPS601	
	TPS631	TPS621	TPS611	TPS601		Base clo	ock (fxclk6) se	election <sup>Note 1</sup>		
						fprs =	fprs =	fprs =	fprs =	
						2 MHz	5 MHz	10 MHz	20 MHz	
	0	0	0	0	<b>f</b> PRS	2 MHz	5 MHz	10 MHz	20 MHz	
	0	0	0	1	fprs/2	1 MHz	2.5 MHz	5 MHz	10 MHz	
	0	0	1	0	fprs/2 <sup>2</sup>	500 kHz	1.25 MHz	2.5 MHz	5 MHz	
	0	0	1	1	fprs/2 <sup>3</sup>	250 kHz	625 kHz	1.25 MHz	2.5 MHz	
	0	1	0	0	fprs/2 <sup>4</sup>	125 kHz	312.5 kHz	625 kHz	1.25 MHz	
	0	1	0	1	fprs/2⁵	62.5 kHz	156.25 kHz	312.5 kHz	625 kHz	
	0	1	1	0	fprs/2 <sup>6</sup>	31.25 kHz	78.13 kHz	156.25 kHz	312.5 kHz	
	0	1	1	1	fprs/27	15.625 kHz	39.06 kHz	78.13 kHz	156.25 kHz	
	1	0	0	0	fprs/2 <sup>8</sup>	7.813 kHz	19.53 kHz	39.06 kHz	78.13 kHz	
	1	0	0	1	fprs/2 <sup>9</sup>	3.906 kHz	9.77 kHz	19.53 kHz	39.06 kHz	
	1	0	1	0	fprs/2 <sup>10</sup>	1.953 kHz	4.88 kHz	9.77 kHz	19.53 kHz	
	1	0	1	1	TM50 output <sup>Note 2</sup>					
	Other than above				Setting prohibited					

# Figure 12-14. Format of Clock Selection Register 61 (CKSR61)

 $\label{eq:Notes1} \textbf{Notes1.} \quad \text{If the peripheral hardware clock (f_{PRS}) operates on the high-speed system clock (f_{IN}) (XSEL$ 

- = 1), the fPRS operating frequency varies depending on the supply voltage.
  - + Vdd = 4.0 to 5.5 V: fprs  $\leq 20~MHz$
  - Vdd = 2.7 to 4.0 V: fprs  $\leq$  10 MHz
- 2. Note the following points when selecting the TM50 output as the base clock.
  - Mode in which the count clock is cleared and started upon a match of TM50 and CR50 (TMC506 = 0)

Start the operation of 8-bit timer/event counter 50 first and then enable the timer F/F inversion operation (TMC501 = 1).

PWM mode (TMC506 = 1)
 Start the operation of 8-bit timer/event counter 50 first and then set the count clock to make the duty = 50%.

It is not necessary to enable the TO50 pin as a timer output pin in any mode.

# Caution Make sure POWER61 = 0 when rewriting TPS631 to TPS601.

- Remarks 1. fprs: Peripheral hardware clock frequency
  - 2. TMC506: Bit 6 of 8-bit timer mode control register 50 (TMC50) TMC501: Bit 1 of TMC50


## (5) Baud rate generator control register 6n (BRGC6n)

This register sets the division value of the 8-bit counters of serial interface UART60 and UART61. BRGC6n can be set by an 8-bit memory manipulation instruction. Reset signal generation sets this register to FFH.

**Remarks 1.** BRGC6n can be refreshed (the same value is written) by software during a communication operation (when bits 7 and 6 (POWER6n, TXE6n) of ASIM6n = 1 or bits 7 and 5 (POWER6n, RXE6n) of ASIM6n = 1).

**2.** n = 0, 1

## Figure 12-15. Format of Baud Rate Generator Control Register 60 (BRGC60)

Address: FF57H After reset: FFH R/W

Symbol	7	6	5	4	3	2	1	0
BRGC60	MDL670	MDL660	MDL650	MDL640	MDL630	MDL620	MDL610	MDL600

MDL670	MDL660	MDL650	MDL640	MDL630	MDL620	MDL610	MDL600	k	Output clock selection of 8-bit counter
0	0	0	0	0	0	×	×	×	Setting prohibited
0	0	0	0	0	1	0	0	4	fxclk6/4
0	0	0	0	0	1	0	1	5	fxclk6/5
0	0	0	0	0	1	1	0	6	fxclk6/6
•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•
1	1	1	1	1	1	0	0	252	fxclk6/252
1	1	1	1	1	1	0	1	253	fxclk6/253
1	1	1	1	1	1	1	0	254	fxclк6/254
1	1	1	1	1	1	1	1	255	fxclk6/255

Cautions 1. Make sure that bit 6 (TXE60) and bit 5 (RXE60) of the ASIM6n register = 0 when rewriting the MDL670 to MDL600 bits.

2. The baud rate is the output clock of the 8-bit counter divided by 2.

Remarks 1. fxclk6: Frequency of base clock selected by the TPS630 to TPS600 bits of CKSR60 register

2. k: Value set by MDL670 to MDL600 bits (k = 4, 5, 6, ..., 255)

**3.** ×: Don't care



0

# Figure 12-16. Format of Baud Rate Generator Control Register 61 (BRGC61)

Address: FF3EH After reset: FFH R/W

Symbol 6 5 7 4 3 2 1 BRGC61 MDL671 MDL661 MDL651 MDL641 MDL631 MDL621 MDL611 **MDL601** 

MDL671	MDL661	MDL651	MDL641	MDL631	MDL621	MDL611	MDL601	k	Output clock selection of 8-bit counter
0	0	0	0	0	0	×	×	×	Setting prohibited
0	0	0	0	0	1	0	0	4	fxclк6/4
0	0	0	0	0	1	0	1	5	fxclк6/5
0	0	0	0	0	1	1	0	6	fхс∟к₀/6
•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•
	•	•	•	•	•	•	•	•	•
1	1	1	1	1	1	0	0	252	fxclк6/252
1	1	1	1	1	1	0	1	253	fxclk6/253
1	1	1	1	1	1	1	0	254	fxclк6/254
1	1	1	1	1	1	1	1	255	fxclk6/255

# Cautions 1. Make sure that bit 6 (TXE61) and bit 5 (RXE61) of the ASIM61 register = 0 when rewriting the MDL671 to MDL601 bits.

- 2. The baud rate is the output clock of the 8-bit counter divided by 2.
- Remarks 1. fxcLK6: Frequency of base clock selected by the TPS631 to TPS601 bits of CKSR61 register
  - 2. k: Value set by MDL671 to MDL601 bits (k = 4, 5, 6, ..., 255)
  - 3. ×: Don't care



## (6) Asynchronous serial interface control register 6n (ASICL6n)

This register controls the serial communication operations of serial interface UART60 and UART61. ASICL6n can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation sets this register to 16H.

Caution ASICL6n can be refreshed (the same value is written) by software during a communication operation (when bits 7 and 6 (POWER6n, TXE6n) of ASIM6n = 1 or bits 7 and 5 (POWER6n, RXE6n) of ASIM6n = 1). However, do not set both SBRT6n and SBTT6n to 1 by a refresh operation during SBF reception (SBRT6n = 1) or SBF transmission (until INTST6n occurs since SBTT6n has been set (1)), because it may re-trigger SBF reception or SBF transmission.

**Remark** n = 0, 1

## Figure 12-17. Format of Asynchronous Serial Interface Control Register 60 (ASICL60) (1/2)

Address: FF58H After reset: 16H R/W<sup>Note</sup>

Symbol	<7>	<6>	5	4	3	2	1	0
ASICL60	SBRF60	SBRT60	SBTT60	SBL620	SBL610	SBL600	DIR60	TXDLV60

SBRF60	SBF reception status flag
0	If POWER60 = 0 and RXE60 = 0 or if SBF reception has been completed correctly
1	SBF reception in progress

SBRT60	SBF reception trigger
0	_
1	SBF reception trigger

SBTT60	SBF transmission trigger
0	_
1	SBF transmission trigger

**Note** Bit 7 is read-only.



SBL620	SBL610	SBL600	SBF transmission output width control
1	0	1	SBF is output with 13-bit length.
1	1	0	SBF is output with 14-bit length.
1	1	1	SBF is output with 15-bit length.
0	0	0	SBF is output with 16-bit length.
0	0	1	SBF is output with 17-bit length.
0	1	0	SBF is output with 18-bit length.
0	1	1	SBF is output with 19-bit length.
1	0	0	SBF is output with 20-bit length.

## Figure 12-17. Format of Asynchronous Serial Interface Control Register 60 (ASICL60) (2/2)

DIR60	First-bit specification
0	MSB
1	LSB

TXDLV60	Enables/disables inverting TxD6n output
0	Normal output of TxD60
1	Inverted output of TxD60

Cautions 1. In the case of an SBF reception error, the mode returns to the SBF reception mode. The status of the SBRF60 flag is held (1).

- Before setting the SBRT60 bit, make sure that bit 7 (POWER60) and bit 5 (RXE60) of ASIM60 =
   After setting the SBRT60 bit to 1, do not clear it to 0 before SBF reception is completed (before an interrupt request signal is generated).
- 3. The read value of the SBRT60 bit is always 0. SBRT60 is automatically cleared to 0 after SBF reception has been correctly completed.
- Before setting the SBTT60 bit to 1, make sure that bit 7 (POWER60) and bit 6 (TXE60) of ASIM60 = 1. After setting the SBTT60 bit to 1, do not clear it to 0 before SBF transmission is completed (before an interrupt request signal is generated).
- 5. The read value of the SBTT60 bit is always 0. SBTT60 is automatically cleared to 0 at the end of SBF transmission.
- 6. Do not set the SBRT60 bit to 1 during reception, and do not set the SBTT60 bit to 1 during transmission.
- 7. Before rewriting the DIR60 and TXDLV60 bits, clear the TXE60 and RXE60 bits to 0.
- 8. When the TXDLV60 bit is set to 1 (inverted TxD60 output), the TxD60/P13/SEG23/TIOP30<sup>Note</sup> pin cannot be used as a general-purpose port, regardless of the settings of POWER60 and TXE60. When using the TxD60/P13/SEG23/TIOP30<sup>Note</sup> pin as a general-purpose port, clear the TXDLV60 bit to 0 (normal TxD60 output).
  - Note The TxD60/P13/SEG23/TIOP30 pin is selectable with input switch control (ISC) register. See Figure 12-19. Format of Input Switch Control Register (ISC) for details.



# Figure 12-18. Format of Asynchronous Serial Interface Control Register 61 (ASICL61) (1/2)

Address: FF3FH After reset: 16H R/W<sup>Note</sup>

Symbol	<7>	<6>	5	4	3	2	1	0
ASICL61	SBRF61	SBRT61	SBTT61	SBL621	SBL611	SBL601	DIR61	TXDLV61

SBRF61	SBF reception status flag
0	If POWER61 = 0 and RXE61 = 0 or if SBF reception has been completed correctly
1	SBF reception in progress

SBRT61	SBF reception trigger
0	_
1	SBF reception trigger

SBTT61	SBF transmission trigger
0	_
1	SBF transmission trigger

Note Bit 7 is read-only.



SBL621	SBL611	SBL601	SBF transmission output width control
1	0	1	SBF is output with 13-bit length.
1	1	0	SBF is output with 14-bit length.
1	1	1	SBF is output with 15-bit length.
0	0	0	SBF is output with 16-bit length.
0	0	1	SBF is output with 17-bit length.
0	1	0	SBF is output with 18-bit length.
0	1	1	SBF is output with 19-bit length.
1	0	0	SBF is output with 20-bit length.

## Figure 12-18. Format of Asynchronous Serial Interface Control Register 61 (ASICL61) (2/2)

DIR61	First-bit specification
0	MSB
1	LSB

TXDLV61	Enables/disables inverting TxD6n output
0	Normal output of TxD6n
1	Inverted output of TxD6n

Cautions 1. In the case of an SBF reception error, the mode returns to the SBF reception mode. The status of the SBRF61 flag is held (1).

- Before setting the SBRT61 bit, make sure that bit 7 (POWER61) and bit 5 (RXE61) of ASIM61 =
   After setting the SBRT61 bit to 1, do not clear it to 0 before SBF reception is completed (before an interrupt request signal is generated).
- 3. The read value of the SBRT61 bit is always 0. SBRT61 is automatically cleared to 0 after SBF reception has been correctly completed.
- Before setting the SBTT61 bit to 1, make sure that bit 7 (POWER61) and bit 6 (TXE61) of ASIM61 = 1. After setting the SBTT61 bit to 1, do not clear it to 0 before SBF transmission is completed (before an interrupt request signal is generated).
- 5. The read value of the SBTT61 bit is always 0. SBTT61 is automatically cleared to 0 at the end of SBF transmission.
- 6. Do not set the SBRT61 bit to 1 during reception, and do not set the SBTT61 bit to 1 during transmission.
- 7. Before rewriting the DIR61 and TXDLV61 bits, clear the TXE61 and RXE61 bits to 0.
- 8. When the TXDLV61 bit is set to 1 (inverted TxD61 output), the TxD61/SCK10/P10/INTP4 pin cannot be used as a general-purpose port, regardless of the settings of POWER61 and TXE61. When using the TxD61/SCK10/P10/INTP4 pin as a general-purpose port, clear the TXDLV61 bit to 0 (normal TxD61 output).



# (7) Input switch control register (ISC)

The input switch control register (ISC) is used to receive a status signal transmitted from the master during LIN (Local Interconnect Network) reception. The input source is switched by setting ISC.

This register can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears this register to 00H.

# Figure 12-19. Format of Input Switch Control Register (ISC) (1/2)

After reset: 00H R/W Ad

Address: FFFFFF4FH

# • 78K0/DE2

Symbol	7	6	5	4	3	2	1	0
ISC	ISC7	ISC6	0	0	ISC3	0	ISC1	ISC0 <sup>Note</sup>

**Note**  $\mu$  PD78F0844 and 78F0845 only.

ISC7	UART60 pin selection control				
	TxD60	RxD60/INTPR60			
0	TxD60 (P13)	RxD60/INTPR60 (P14)			
1	<txd60> (P71)</txd60>	<rxd60 intpr60=""> (P70)</rxd60>			

ISC6	TIOP30 pin selection control
0	TIOP30 (P13)
1	<tiop30> (P17)</tiop30>

ISC3	TMP2 input source (TIP21) selection control [For timer conjunction function of TMP]
0	TIOP21 (P06)
1	TMP3 output signal (TOP30)

ISC1	TMP2 input source (TIP20) selection control [For LIN reception operation of UART60]
0	TIOP20 (P14)
1	RxD60 <sup>Note</sup>

Note Selected with ISC7.

ISC0	TMP4 input source (TIP40) selection control [For time stamp function of CAN]
0	TIOP40 (P00)
1	TSOUT



## Figure 12-19. Format of Input Switch Control Register (ISC) (2/2)

• 78K0/DF2										
Symbol	7	6	5	4	3	2	1	0		
ISC	ISC7	ISC6	ISC5	0	ISC3	ISC2	ISC1	ISC0 <sup>Note</sup>		
	Note ,	u PD78F084	6, 78F0847	, 78F0848, a	and 78F084	9 only.				

ISC7	UART60 pin selection control					
	TxD60	RxD60/INTPR60				
0	TxD60 (P13)	RxD60/INTPR60 (P14)				
1	<txd60> (P71)</txd60>	<rxd60 intpr60=""> (P70)</rxd60>				

ISC6	TIOP30 pin selection control
0	TIOP30 (P13)
1	<tiop30> (P17)</tiop30>

ISC5	TIOP20 pin selection control
0	TIOP20 (P14)
1	<tiop20> (P77)</tiop20>

TMP2 input source (TIP21) selection control [For timer conjunction function of TMP]
TIOP21 (P06)
TMP3 output signal (TOP30)

ISC2	TMP3 input source (TIP30) selection control			
0	TIOP30 <sup>Note</sup>			
1	RxD61 (P11)			

**Note** Selected with ISC6.

ISC1	TMP2 input source (TIP20) selection control [For LIN reception operation of UART60]
0	TIOP20 (P14)
1	RxD60 <sup>Note</sup>
1	RxD60 <sup>Note</sup>

**Note** Selected with ISC7.

ISC0	TMP4 input source (TIP40) selection control [For time stamp function of CAN]
0	TIOP40 (P00)
1	TSOUT



# (8) Port mode registers 1 and 7 (PM1, PM7)

PM1 sets port 1 input/output in 1-bit units. PM7 sets port 7 input/output in 1-bit units. When using the P13/TxD60/SEG23/TIOP30 and P10/SCK10/TxD61/INTP4 pins for serial interface data output, clear PM13 and PM10 to 0 and set the output latch of P13 and P10 to 1.

When using the P14/RxD60/INTPR60/SEG22/TIOP20 and P11/SI10/RxD61/INTPR61 pins for serial interface data input, set PM14 and PM11 to 1. The output latch of P14 and P11 at this time may be 0 or 1.

When the ISC7 bit of input switch control (ISC) register is set to 1, the P70/RxD60/INTPR60/CRxD<sup>Note</sup> pin is used for serial interface data input and the P71/TxD60/CTxD<sup>Note</sup> pin is used for serial interface output instead of the P13/TxD60/SEG23/TIOP30 and P14/RxD60/INTPR60/SEG22/TIOP20 pins. In this case, clear PM71 to 0 and set the output latch of P71 to 1 to use the P71/TxD60/CTxD<sup>Note</sup> pin. Also, set PM70 to 1 to use the P70/RxD60/INTPR60/CRxD<sup>Note</sup> pin. The output latch of P70 at this time may be 0 or 1.

PM1 and PM7 can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets these registers to FFH.

Note  $\mu$  PD78F0844, 78F0845, 78F0846, 78F0847, 78F0848 and 78F0849 only.

## Figure 12-20. Format of Port Mode Registers 1 and 7 (PM1, PM7)

Address: FF	21H After res	set: FFH R	/W					
Symbol	7	6	5	4	3	2	1	0
PM1	PM17	PM16	PM15	PM14	PM13	PM12	PM11	PM10
Address: FF	27H After res	set: FFH R	Ŵ					
Symbol	7	6	5	4	3	2	1	0
PM7	PM77 <sup>Note</sup>	PM76 <sup>Note</sup>	PM75 <sup>Note</sup>	PM74 <sup>Note</sup>	PM73	PM72	PM71	PM70
	PMnm		Pn	m nin I/O mod	e selection (n -	- 1 7 m – 0 to	7)	

PMnm	Pnm pin I/O mode selection (n = 1, 7; m = 0 to 7)		
0	Output mode (output buffer on)		
1	Input mode (output buffer off)		

**Note** These bits are set to 1 in 78K0/DE2.



## 12.4 Operations of Serial Interface UART60 and UART61

Serial interfaces UART60 and UART61 have the following two modes.

- Operation stop mode
- Asynchronous serial interface (UART) mode

#### 12.4.1 Operation stop mode

In this mode, serial communication cannot be executed; therefore, the power consumption can be reduced. In addition, the pins can be used as ordinary port pins in this mode. To set the operation stop mode, clear bits 7, 6, and 5 (POWER6n, TXE6n, and RXE6n) of ASIM6n to 0.

## (1) Register used

The operation stop mode is set by asynchronous serial interface operation mode register 6n (ASIM6n). ASIM6n can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation sets this register to 01H.

Address: FF50H After reset: 01H R/W

Symbol	<7>	<6>	<5>	4	3	2	1	0
ASIM6n	POWER6n	TXE6n	RXE6n	PS61n	PS60n	CL6n	SL6n	ISRM6n

POWER6n	Enables/disables operation of internal operation clock
0 <sup>Note 1</sup>	Disables operation of the internal operation clock (fixes the clock to low level) and asynchronously resets the internal circuit <sup>Note 2</sup> .

TXE6n	Enables/disables transmission
0	Disables transmission operation (synchronously resets the transmission circuit).

RXE6n	Enables/disables reception
0	Disables reception (synchronously resets the reception circuit).

- **Notes 1.** The output of the TxD6n pins goes high and the input from the RxD6n pins is fixed to high level when POWER6n = 0.
  - Asynchronous serial interface reception error status register 6n (ASIS6n), asynchronous serial interface transmission status register 6n (ASIF6n), bit 7 (SBRF6n) and bit 6 (SBRT6n) of asynchronous serial interface control register 6n (ASICL6n), and receive buffer register 6n (RXB6n) are reset.
- Caution Clear POWER6n to 0 after clearing TXE6n and RXE6n to 0 to stop the operation. To start the communication, set POWER6n to 1, and then set TXE6n and RXE6n to 1.
- Remarks 1. To use the RxD60/INTPR60/P14/SEG22/TIOP20, RxD61/INTPR61/P11/SI10, TxD60/P13/SEG23/TIOP30, and TxD61/P10/SCK10/INTP4 pins as general-purpose port pins, see CHAPTER 4 PORT FUNCTIONS (the RxD60/INTPR60/P14/SEG22/TIOP20 and TxD60/P13/SEG23/TIOP30 pins are selectable with input switch control (ISC) register).
  - **2.** n = 0, 1

## 12.4.2 Asynchronous serial interface (UART) mode

In this mode, data of 1 byte is transmitted/received following a start bit, and a full-duplex operation can be performed.

A dedicated UART baud rate generator is incorporated, so that communication can be executed at a wide range of baud rates.

## (1) Registers used

- Asynchronous serial interface operation mode register 6n (ASIM6n)
- Asynchronous serial interface reception error status register 6n (ASIS6n)
- Asynchronous serial interface transmission status register 6n (ASIF6n)
- Clock selection register 6n (CKSR6n)
- Baud rate generator control register 6n (BRGC6n)
- Asynchronous serial interface control register 6n (ASICL6n)
- Input switch control register (ISC)
- Port mode register 1 (PM1)
- Port register 1 (P1)

The basic procedure of setting an operation in the UART mode is as follows.

- <1> Set the CKSR6n register (see Figures 12-13 and 12-14).
- <2> Set the BRGC6n register (see Figures 12-15 and 12-16).
- <3> Set bits 0 to 4 (ISRM6n, SL6n, CL6n, PS60n, PS61n) of the ASIM6n register (see Figures 12-7 and 12-8).
- <4> Set bits 0 and 1 (TXDLV6n, DIR6n) of the ASICL6n register (see Figures 12-17 and 12-18).
- <5> Set bit 7 (POWER6n) of the ASIM6n register to 1.
- <6> Set bit 6 (TXE6n) of the ASIM6n register to 1.  $\rightarrow$  Transmission is enabled. Set bit 5 (RXE6n) of the ASIM6n register to 1.  $\rightarrow$  Reception is enabled.
- <7> Write data to transmit buffer register 6n (TXB6n).  $\rightarrow$  Data transmission is started.

# Caution Take relationship with the other party of communication when setting the port mode register and port register.



The relationship between the register settings and pins is shown below.

# (a) UART60

POWER6n	TXE6n	RXE6n	PM13 <sup>Note 1</sup>	P13 <sup>Note 1</sup>	PM14 <sup>Note 1</sup>	P14 <sup>Note 1</sup>		Pin Fu	inction
							UART60 Operation	UART60 TxD60/TIOP30/ Operation SEG23/P13 <sup>Note 1</sup>	
0	0	0	Note 2 ×	Note 2 ×	Note 2 ×	Note 2 ×	Stop	P13	P14
1	0	1	× Note 2	× Note 2	1	×	Reception	P13	RxD60
	1	0	0	1	× X	Note 2 ×	Transmission	TxD60	P14
	1	1	0	1	1	×	Transmission/ reception	TxD60	RxD60

# (b) UART61

POWER6n	TXE6n	RXE6n	PM10	P10	PM11	P11		Pin Function			
							Operation		RxD61/INTPR61/ P11/SI10		
0	0	0	× Note 2	× ×	× <sup>Note 2</sup>	× <sup>Note 2</sup>	Stop	P10	P11		
1	0	1	Note 2 ×	× ×	1	×	Reception	P10	RxD61		
	1	0	0	1	× X	× ×	Transmission	TxD61	P11		
	1	1	0	1	1	×	Transmission/ reception	TxD61	RxD61		

- Notes 1. The P13/TxD60/TIOP30/SEG23 and P14/RxD60/INTPR60/TIOP20/SEG22 pins are selectable with input switch control (ISC) register. See Figure 12-19. Format of Input Switch Control Register (ISC) for details.
  - 2. Can be set as port function.

Remarks 1. ×: don't care

POWER6n:Bit 7 of asynchronous serial interface operation mode register 6n (ASIM6n)TXE6n:Bit 6 of ASIM6nRXE6n:Bit 5 of ASIM6nPM1×:Port mode registerP1x:Port output latch2. n = 0, 1



## (2) Communication operation

(a) Format and waveform example of normal transmit/receive data

Figures 12-21 and 12-22 show the format and waveform example of the normal transmit/receive data.

#### Figure 12-21. Format of Normal UART Transmit/Receive Data

#### 1. LSB-first transmission/reception



#### 2. MSB-first transmission/reception



One data frame consists of the following bits.

- Start bit ... 1 bit
- Character bits ... 7 or 8 bits
- Parity bit ... Even parity, odd parity, 0 parity, or no parity
- Stop bit ... 1 or 2 bits

The character bit length, parity, and stop bit length in one data frame are specified by asynchronous serial interface operation mode register 6n (ASIM6n).

Whether data is communicated with the LSB or MSB first is specified by bit 1 (DIR6n) of asynchronous serial interface control register 6n (ASICL6n).

Whether the TxD6n pins outputs normal or inverted data is specified by bit 0 (TXDLV6n) of ASICL6n.



## Figure 12-22. Example of Normal UART Transmit/Receive Data Waveform

# 1. Data length: 8 bits, LSB first, Parity: Even parity, Stop bit: 1 bit, Communication data: 55H

- 1 data frame											
Start	D0	D1	D2	D3	D4	D5	D6	D7	Parity	Stop	

## 2. Data length: 8 bits, MSB first, Parity: Even parity, Stop bit: 1 bit, Communication data: 55H



3. Data length: 8 bits, MSB first, Parity: Even parity, Stop bit: 1 bit, Communication data: 55H, TxD6n pin inverted output



## 4. Data length: 7 bits, LSB first, Parity: Odd parity, Stop bit: 2 bits, Communication data: 36H



## 5. Data length: 8 bits, LSB first, Parity: None, Stop bit: 1 bit, Communication data: 87H

◄ 1 data frame												
 Start	D0	D1	D2	D3	D4	D5	D6	D7	Stop	/ 1 1 1 1		



## (b) Parity types and operation

The parity bit is used to detect a bit error in communication data. Usually, the same type of parity bit is used on both the transmission and reception sides. With even parity and odd parity, a 1-bit (odd number) error can be detected. With zero parity and no parity, an error cannot be detected.

# Caution Fix the PS61n and PS60n bits to 0 when the device is used in LIN communication operation.

## (i) Even parity

Transmission

Transmit data, including the parity bit, is controlled so that the number of bits that are "1" is even. The value of the parity bit is as follows.

If transmit data has an odd number of bits that are "1": 1 If transmit data has an even number of bits that are "1": 0

• Reception

The number of bits that are "1" in the receive data, including the parity bit, is counted. If it is odd, a parity error occurs.

## (ii) Odd parity

• Transmission

Unlike even parity, transmit data, including the parity bit, is controlled so that the number of bits that are "1" is odd.

If transmit data has an odd number of bits that are "1": 0 If transmit data has an even number of bits that are "1": 1

• Reception

The number of bits that are "1" in the receive data, including the parity bit, is counted. If it is even, a parity error occurs.

## (iii) 0 parity

The parity bit is cleared to 0 when data is transmitted, regardless of the transmit data.

The parity bit is not detected when the data is received. Therefore, a parity error does not occur regardless of whether the parity bit is "0" or "1".

## (iv) No parity

No parity bit is appended to the transmit data.

Reception is performed assuming that there is no parity bit when data is received. Because there is no parity bit, a parity error does not occur.



# (c) Normal transmission

When bit 7 (POWER6n) of asynchronous serial interface operation mode register 6n (ASIM6n) is set to 1 and bit 6 (TXE6n) of ASIM6n is then set to 1, transmission is enabled. Transmission can be started by writing transmit data to transmit buffer register 6n (TXB6n). The start bit, parity bit, and stop bit are automatically appended to the data.

When transmission is started, the data in TXB6n is transferred to transmit shift register 6n (TXS6n). After that, the transmit data is sequentially output from TXS6n to the TxD6n pins. When transmission is completed, the parity and stop bits set by ASIM6n are appended and a transmission completion interrupt request (INTST6n) is generated.

Transmission is stopped until the data to be transmitted next is written to TXB6n.

**Figure 12-23** shows the timing of the transmission completion interrupt request (INTST6n). This interrupt occurs as soon as the last stop bit has been output.

## Figure 12-23. Normal Transmission Completion Interrupt Request Timing

## 1. Stop bit length: 1





## (d) Continuous transmission

The next transmit data can be written to transmit buffer register 6n (TXB6n) as soon as transmit shift register 6 (TXS6n) has started its shift operation. Consequently, even while the INTST6n interrupt is being serviced after transmission of one data frame, data can be continuously transmitted and an efficient communication rate can be realized. In addition, the TXB6n register can be efficiently written twice (2 bytes) without having to wait for the transmission time of one data frame, by reading bit 0 (TXSF6n) of asynchronous serial interface transmission status register 6n (ASIF6n) when the transmission completion interrupt has occurred. To transmit data continuously, be sure to reference the ASIF6n register to check the transmission status and whether the TXB6n register can be written, and then write the data.

- Cautions 1. The TXBF6n and TXSF6n flags of the ASIF6n register change from "10" to "11", and to "01" during continuous transmission. To check the status, therefore, do not use a combination of the TXBF6n and TXSF6n flags for judgment. Read only the TXBF6n flag when executing continuous transmission.
  - 2. When the device is used in LIN communication operation, the continuous transmission function cannot be used. Make sure that asynchronous serial interface transmission status register 6n (ASIF6n) is 00H before writing transmit data to transmit buffer register 6n (TXB6n).

TXBF6n	Writing to TXB6 Register
0	Writing enabled
1	Writing disabled

Caution To transmit data continuously, write the first transmit data (first byte) to the TXB6n register. Be sure to check that the TXBF6n flag is "0". If so, write the next transmit data (second byte) to the TXB6n register. If data is written to the TXB6n register while the TXBF6n flag is "1", the transmit data cannot be guaranteed.

The communication status can be checked using the TXSF6n flag.

TXSF6n	Transmission Status									
0	Transmission is completed.									
1	Transmission is in progress.									

- Cautions 1. To initialize the transmission unit upon completion of continuous transmission, be sure to check that the TXSF6n flag is "0" after generation of the transmission completion interrupt, and then execute initialization. If initialization is executed while the TXSF6n flag is "1", the transmit data cannot be guaranteed.
  - 2. During continuous transmission, an overrun error may occur, which means that the next transmission was completed before execution of INTST6n interrupt servicing after transmission of one data frame. An overrun error can be detected by developing a program that can count the number of transmit data and by referencing the TXSF6n flag.



Figure 12-24 shows an example of the continuous transmission processing flow.





 Remark
 TXB6n:
 Transmit buffer register 6n

 ASIF6n:
 Asynchronous serial interface transmission status register 6n

 TXBF6n:
 Bit 1 of ASIF6n (transmit buffer data flag)

 TXSF6n:
 Bit 0 of ASIF6n (transmit shift register data flag)

 n = 0, 1
 T

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Figure 12-25 shows the timing of starting continuous transmission, and Figure 12-26 shows the timing of ending continuous transmission.



Figure 12-25. Timing of Starting Continuous Transmission

**Note** When ASIF6n is read, there is a period in which TXBF6n and TXSF6n = 1, 1. Therefore, judge whether writing is enabled using only the TXBF6n bit.

 Remark
 TxD6n:
 TxD6n pins (output)

 INTST6n:
 Interrupt request signal

 TXB6n:
 Transmit buffer register 6n

 TXS6n:
 Transmit shift register 6n

 ASIF6n:
 Asynchronous serial interface transmission status register 6n

 TXBF6n:
 Bit 1 of ASIF6n

 TXSF6n:
 Bit 0 of ASIF6n

 n = 0, 1
 T





# Figure 12-26. Timing of Ending Continuous Transmission

Remark	TxD6n:	TxD6n pins (output)
	INTST6n:	Interrupt request signal
	TXB6n:	Transmit buffer register 6n
	TXS6n:	Transmit shift register 6n
	ASIF6n:	Asynchronous serial interface transmission status register 6n
	TXBF6n:	Bit 1 of ASIF6n
	TXSF6n:	Bit 0 of ASIF6n
	POWER6n:	Bit 7 of asynchronous serial interface operation mode register (ASIM6n)
	TXE6n:	Bit 6 of asynchronous serial interface operation mode register (ASIM6n)
	n = 0, 1	



## (e) Normal reception

Reception is enabled and the RxD6n pins input is sampled when bit 7 (POWER6n) of asynchronous serial interface operation mode register 6n (ASIM6n) is set to 1 and then bit 5 (RXE6n) of ASIM6n is set to 1.

The 8-bit counter of the baud rate generator starts counting when the falling edge of the RxD6n pins input is detected. When the set value of baud rate generator control register 6n (BRGC6n) has been counted, the RxD6n pins input is sampled again ( $\bigtriangledown$ in **Figure 12-27**). If the RxD6n pins are low level at this time, it is recognized as a start bit.

When the start bit is detected, reception is started, and serial data is sequentially stored in the receive shift register 6n (RXS6n) at the set baud rate. When the stop bit has been received, the reception completion interrupt (INTSR6n) is generated and the data of RXS6n is written to receive buffer register 6n (RXB6n). If an overrun error (OVE6n) occurs, however, the receive data is not written to RXB6n.

Even if a parity error (PE6n) occurs while reception is in progress, reception continues to the reception position of the stop bit, and a reception error interrupt (INTSR6n) is generated on completion of reception.





- Cautions 1. If a reception error occurs, read ASIS6n and then RXB6n to clear the error flag. Otherwise, an overrun error will occur when the next data is received, and the reception error status will persist.
  - 2. Reception is always performed with the "number of stop bits = 1". The second stop bit is ignored.
  - 3. Be sure to read asynchronous serial interface reception error status register 6n (ASIS6n) before reading RXB6n.



## (f) Reception error

Three types of errors may occur during reception: a parity error, framing error, or overrun error. If the error flag of asynchronous serial interface reception error status register 6n (ASIS6n) is set as a result of data reception, a reception error interrupt request (INTSR6n) is generated.

Which error has occurred during reception can be identified by reading the contents of ASIS6n in the reception error interrupt (INTSR6n) servicing (see Figure 12-9. Format of Asynchronous Serial Interface Reception Error Status Register 60 (ASIS60) and Figure 12-10. Format of Asynchronous Serial Interface Reception Error Status Register 61 (ASIS61)).

The contents of ASIS6n are cleared to 0 when ASIS6n is read.

Reception Error	Cause
Parity error	The parity specified for transmission does not match the parity of the receive data.
Framing error	Stop bit is not detected.
Overrun error	Reception of the next data is completed before data is read from receive buffer register 6n (RXB6n).

Table 12	-3 Caus	se of Rec	ention	Frror
	. <b>0. 0</b> uu		cpuon	

**Remark** n = 0, 1

#### (g) Noise filter of receive data

The RXD6n (n = 0, 1) signal's is sampled with the base clock output by the prescaler block.

If two sampled values are the same, the output of the match detector changes, and the data is sampled as input data.

Because the circuit is configured as shown in the following figure, the internal processing of the reception operation is delayed by two clocks from the external signal status.

#### Figure 12-28. Noise Filter Circuit



**Note** *μ* PD78F0844, 78F0845, 78F0846, 78F0847, 78F0848, and 78F0849 only.



## (h) SBF transmission

When the device is used in LIN communication operation, the SBF (Synch Break Field) transmission control function is used for transmission. For the transmission operation of LIN, see **Figure 12-1 LIN Transmission Operation**.

When bit 7 (POWER6n) of asynchronous serial interface operation mode register 6n (ASIM6n) is set to 1 and bit 6 (TXE6n) of ASIM6n is then set to 1, transmission is enabled.

SBF transmission can be started by setting bit 5 (SBTT6n) of asynchronous serial interface control register 6n (ASICL6n) to 1.

Thereafter, a low level of bits 13 to 20 (set by bits 4 to 2 (SBL62n to SBL60n) of ASICL6n) is output. Following the end of SBF transmission, the transmission completion interrupt request (INTST6n) is generated and SBTT6n is automatically cleared. Thereafter, the normal transmission mode is restored.

Transmission is suspended until the data to be transmitted next is written to transmit buffer register 6n (TXB6n), or until SBTT6n is set to 1.

**Remark** n = 0, 1

							jure	12-23	. 501	man	511115	31011				
TxD6n		1	:	2	3	4	5	6	7	8	9	10	11	12	13	Stop
INTST6n																Л
SBTT6n																1
Rema	rk T II S	×D6 NTS BTT = 0,	n: T6n <sup>-</sup> 6n: , 1	:	TxI Tra Bit	D6n p ansm 5 of	oins ( issior async	output comp chrono	t) pletior ous se	n interr rial int	upt re erfac	eques e con	t trol re	egiste	r 6n (A	SICL6n)

## Figure 12-29. SBF Transmission



#### (i) SBF reception

When the device is used in LIN communication operation, the SBF (Synch Break Field) reception control function is used for reception. For the reception operation of LIN, see **Figure 12-2** LIN Reception **Operation**.

Reception is enabled when bit 7 (POWER6n) of asynchronous serial interface operation mode register 6n (ASIM6n) is set to 1 and then bit 5 (RXE6n) of ASIM6n is set to 1. SBF reception is enabled when bit 6 (SBRT6n) of asynchronous serial interface control register 6n (ASICL6n) is set to 1. In the SBF reception enabled status, the RxD6n pins are sampled and the start bit is detected in the same manner as the normal reception enable status.

When the start bit has been detected, reception is started, and serial data is sequentially stored in the receive shift register 6n (RXS6n) at the set baud rate. When the stop bit is received and if the width of SBF is 11 bits or more, a reception completion interrupt request (INTSR6n) is generated as normal processing. At this time, the SBRF6n and SBRT6n bits are automatically cleared, and SBF reception ends. Detection of errors, such as OVE6n, PE6n, and FE6n (bits 0 to 2 of asynchronous serial interface reception error status register 6n (ASIS6n)) is suppressed, and error detection processing of UART communication is not performed. In addition, data transfer between receive shift register 6n (RXS6n) and receive buffer register 6n (RXB6n) is not performed, and the reset value of FFH is retained. If the width of SBF is 10 bits or less, an interrupt does not occur as error processing after the stop bit has been received, and the SBF reception mode is restored. In this case, the SBRF6n and SBRT6n bits are not cleared.

## Figure 12-30. SBF Reception

#### 1. Normal SBF reception (stop bit is detected with a width of more than 10.5 bits)



#### 2. SBF reception error (stop bit is detected with a width of 10.5 bits or less)



 Remark
 RxD6n:
 RxD6n pins (input)

 SBRT6n:
 Bit 6 of asynchronous serial interface control register 6n (ASICL6n)

 SBRF6n:
 Bit 7 of ASICL6n

 INTSR6n:
 Reception completion interrupt request

 n = 0, 1

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## 78K0/Dx2

# 12.4.3 Dedicated baud rate generator

The dedicated baud rate generator consists of a source clock selector and an 8-bit programmable counter, and generates a serial clock for transmission/reception of UART60 and UART61.

Separate 8-bit counters are provided for transmission and reception.

# (1) Configuration of baud rate generator

# Base clock

The clock selected by bits 3 to 0 (TPS63n to TPS60n) of clock selection register 6n (CKSR6n) is supplied to each module when bit 7 (POWER6n) of asynchronous serial interface operation mode register 6n (ASIM6n) is 1. This clock is called the base clock and its frequency is called  $f_{XCLK6}$ . The base clock is fixed to low level when POWER6n = 0.

Transmission counter

This counter stops operation, cleared to 0, when bit 7 (POWER6n) or bit 6 (TXE6n) of asynchronous serial interface operation mode register 6n (ASIM6n) is 0.

It starts counting when POWER6n = 1 and TXE6n = 1.

The counter is cleared to 0 when the first data transmitted is written to transmit buffer register 6n (TXB6n).

If data are continuously transmitted, the counter is cleared to 0 again when one frame of data has been completely transmitted. If there is no data to be transmitted next, the counter is not cleared to 0 and continues counting until POWER6n or TXE6n is cleared to 0.

# Reception counter

This counter stops operation, cleared to 0, when bit 7 (POWER6n) or bit 5 (RXE6n) of asynchronous serial interface operation mode register 6n (ASIM6n) is 0.

It starts counting when the start bit has been detected.

The counter stops operation after one frame has been received, until the next start bit is detected.

 $\textbf{Remark} \quad n=0,\ 1$ 





Figure 12-31. Configuration of Baud Rate Generator

Remark POWER6n: Bit 7 of asynchronous serial interface operation mode register 6n (ASIM6n)

TXE6n:	Bit 6 of ASIM6n
RXE6n:	Bit 5 of ASIM6n
CKSR6n:	Clock selection register 6n
BRGC6n:	Baud rate generator control register 6n
n = 0, 1	



# (2) Generation of serial clock

A serial clock can be generated by using clock selection register 6n (CKSR6n) and baud rate generator control register 6n (BRGC6n).

Select the clock to be input to the 8-bit counter by using bits 3 to 0 (TPS63n to TPS60n) of CKSR6n.

Bits 7 to 0 (MDL67n to MDL60n) of BRGC6n can be used to select the division value of the 8-bit counter.

# (a) Baud rate

The baud rate can be calculated by the following expression.

• Baud rate =  $\frac{f_{XCLK6}}{2 \times k}$  [bps]

fxclk6: Frequency of base clock selected by TPS63n to TPS60n bits of CKSR6n register

k: Value set by MDL67n to MDL60n bits of BRGC6n register (k = 4, 5, 6, ..., 255)

# (b) Error of baud rate

The baud rate error can be calculated by the following expression.

• Error (%) = 
$$\left(\frac{\text{Actual baud rate (baud rate with error)}}{\text{Desired baud rate (correct baud rate)}} - 1\right) \times 100 [\%]$$

- Cautions 1. Keep the baud rate error during transmission to within the permissible error range at the reception destination.
  - 2. Make sure that the baud rate error during reception satisfies the range shown in (4) Permissible baud rate range during reception.

Example: Frequency of base clock = 10 MHz = 10,000,000 Hz Set value of MDL67n to MDL60n bits of BRGC6 register = 00100001B (k = 33) Target baud rate = 153600 bps

Error = (151515/153600 - 1) × 100 = -1.357 [%]



# 78K0/Dx2

# (3) Example of setting baud rate

Baud	fprs = 5.0 MHz			fprs = 10.0 MHz			fprs = 20.0 MHz					
Rate [bps]	TPS63n, TPS60n	k	Calculated Value	ERR [%]	TPS63n, TPS60n	k	Calculated Value	ERR [%]	TPS63n, TPS60n	k	Calculated Value	ERR [%]
300	7H	65	301	0.16	8H	65	301	0.16	9H	65	301	0.16
600	6H	65	601	0.16	7H	65	601	0.16	8H	65	601	0.16
1200	5H	65	1202	0.16	6H	65	1202	0.16	7H	65	1202	0.16
2400	4H	65	2404	0.16	5H	65	2404	0.16	6H	65	2404	0.16
4800	ЗH	65	4808	0.16	4H	65	4808	0.16	5H	65	4808	0.16
9600	2H	65	9615	0.16	ЗH	65	9615	0.16	4H	65	9615	0.16
19200	1H	65	19231	0.16	2H	65	19231	0.16	ЗH	65	19231	0.16
24000	ЗH	13	24038	0.16	4H	13	24038	0.16	5H	13	24038	0.16
31250	4H	5	31250	0	5H	5	31250	0	6H	5	31250	0
38400	ОH	65	38462	0.16	1H	65	38462	0.16	2H	65	38462	0.16
48000	2H	13	48077	0.16	ЗH	13	48077	0.16	4H	13	48077	0.16
76800	ОH	33	75758	-1.36	ОН	65	76923	0.16	1H	65	76923	0.16
115200	1H	11	113636	-1.36	ОН	43	116279	0.94	он	87	114943	-0.22
153600	1H	8	156250	1.73	он	33	151515	-1.36	1H	33	151515	-1.36
312500	оH	8	312500	0	1H	8	312500	0	2H	8	312500	0
625000	0H	4	625000	0	1H	4	625000	0	2H	4	625000	0

Table 12-4.	Set Data of	Baud Rate	Generator
-------------	-------------	-----------	-----------

Remark TPS63n to TPS60n: Bits 3 to 0 of clock selection register 6n (CKSR6n) (setting of base

Value set by MDL67n to MDL60n bits of baud rate generator control register 6n (BRGC6n) (k = 4, 5, 6, ..., 255)

fprs:

k:

Peripheral hardware clock frequency Baud rate error

clock (fxclk6))

ERR: n = 0, 1



## (4) Permissible baud rate range during reception

The permissible error from the baud rate at the transmission destination during reception is shown below.

Caution Make sure that the baud rate error during reception is within the permissible error range, by using the calculation expression shown below.



Figure 12-32. Permissible Baud Rate Range During Reception

As shown in **Figure 12-32**, the latch timing of the receive data is determined by the counter set by baud rate generator control register 6n (BRGC6n) after the start bit has been detected. If the last data (stop bit) meets this latch timing, the data can be correctly received.

Assuming that 11-bit data is received, the theoretical values can be calculated as follows.

 $FL = (Brate)^{-1}$ 

Brate: Baud rate of UART60 and UART61

k: Set value of BRGC6n

FL: 1-bit data length

Margin of latch timing: 2 clocks



Minimum permissible data frame length: FLmin =  $11 \times FL - \frac{k-2}{2k} \times FL = \frac{21k+2}{2k} FL$ 

Therefore, the maximum receivable baud rate at the transmission destination is as follows.

BRmax = 
$$(FLmin/11)^{-1} = \frac{22k}{21k+2}$$
 Brate

Similarly, the maximum permissible data frame length can be calculated as follows.

$$\frac{10}{11} \times FLmax = 11 \times FL - \frac{k+2}{2 \times k} \times FL = \frac{21k-2}{2 \times k} FL$$
$$FLmax = \frac{21k-2}{20k} FL \times 11$$

Therefore, the minimum receivable baud rate at the transmission destination is as follows.

BRmin = 
$$(FLmax/11)^{-1} = \frac{20k}{21k - 2}$$
 Brate

The permissible baud rate error between UART60 and UART61 and the transmission destination can be calculated from the above minimum and maximum baud rate expressions, as follows.

Division Ratio (k)	Maximum Permissible Baud Rate Error	Minimum Permissible Baud Rate Error
4	+2.33%	-2.44%
8	+3.53%	-3.61%
20	+4.26%	-4.31%
50	+4.56%	-4.58%
100	+4.66%	-4.67%
255	+4.72%	-4.73%

Table 12-5. Maximum/Minimum Permissible Baud Rate Error

- **Remarks 1.** The permissible error of reception depends on the number of bits in one frame, input clock frequency, and division ratio (k). The higher the input clock frequency and the higher the division ratio (k), the higher the permissible error.
  - **2.** k: Set value of BRGC6n (n = 0, 1)



## 78K0/Dx2

# (5) Data frame length during continuous transmission

When data is continuously transmitted, the data frame length from a stop bit to the next start bit is extended by two clocks of base clock from the normal value. However, the result of communication is not affected because the timing is initialized on the reception side when the start bit is detected.

## Figure 12-33. Data Frame Length During Continuous Transmission



Where the 1-bit data length is FL, the stop bit length is FLstp, and base clock frequency is fxclk6, the following expression is satisfied.

FLstp = FL + 2/fxclk6

Therefore, the data frame length during continuous transmission is:

Data frame length =  $11 \times FL + 2/f_{XCLK6}$ 



# CHAPTER 13 SERIAL INTERFACES CSI10 AND CSI11

The 78K0/Dx2 incorporate serial interfaces CSI10 and CSI11.

# 13.1 Functions of Serial Interfaces CSI10 and CSI11

## Caution Serial interface CSI11 is for 78K0/DF2 only.

Serial interfaces CSI10 and CSI11 have the following two modes.

- Operation stop mode
- 3-wire serial I/O mode

## (1) Operation stop mode

This mode is used when serial communication is not performed and can enable a reduction in the power consumption.

For details, see 13.4.1 Operation stop mode.

## (2) 3-wire serial I/O mode (MSB/LSB-first selectable)

This mode is used to communicate 8-bit data using three lines: a serial clock line (SCK1n) and two serial data lines (SI1n and SO1n).

The processing time of data communication can be shortened in the 3-wire serial I/O mode because transmission and reception can be simultaneously executed.

In addition, whether 8-bit data is communicated with the MSB or LSB first can be specified, so this interface can be connected to any device.

The 3-wire serial I/O mode is used for connecting peripheral ICs and display controllers with a clocked serial interface.

For details, see 13.4.2 3-wire serial I/O mode.



# 13.2 Configuration of Serial Interfaces CSI10 and CSI11

Serial interfaces CSI10 and CSI11 include the following hardware.

Item	Configuration		
	78K0/DE2 78K0/DF2		
Controller	Transmit controller Clock start/stop controller & clock phase controller		
Registers	Transmit buffer register 1n (SOTB1n) Serial I/O shift register 1n (SIO1n)		
Control registers	Serial operation mode register 1n (CSIM1n) Serial clock selection register 1n (CSIC1n) Port mode register 1 (PM1) Port register 1 (P1)		
	_	Port mode register 7 (PM7) Port register 7 (P7)	

Table 13-1. Configuration of Serial Interfaces CSI10 and CSI
--

**Remark** n = 0, 1 (the registers given with n = 1 are for 78K0/DF2 only).





Figure 13-1. Block Diagram of Serial Interface CSI10

Note 78K0/DF2 only.

Remark (a): SO10 output





Note  $\ \mu$  PD78F0842, 78F0843, 78F0848, and 78F0849 only.

Remark (a): SO11 output



# (1) Transmit buffer register 1n (SOTB1n)

This register sets the transmit data.

Transmission/reception is started by writing data to SOTB1n when bit 7 (CSIE1n) and bit 6 (TRMD1n) of serial operation mode register 1n (CSIM1n) is 1.

The data written to SOTB1n is converted from parallel data into serial data by serial I/O shift register 1n, and output to the serial output pin (SO1n).

SOTB1n can be written or read by an 8-bit memory manipulation instruction.

Reset signal generation clears this register to 00H.

# Cautions 1. Do not access SOTB1n when CSOT1n = 1 (during serial communication).

2. In the slave mode, transmission/reception is started when data is written to SOTB11 with a low level input to the SSI11 pin. For details of the transmission/reception operation, see 13.4.2 (2) Communication operation.

# (2) Serial I/O shift register 1n (SIO1n)

This is an 8-bit register that converts data from parallel data into serial data and vice versa.

This register can be read by an 8-bit memory manipulation instruction.

Reception is started by reading data from SIO1n if bit 6 (TRMD1n) of serial operation mode register 1n (CSIM1n) is 0.

During reception, the data is read from the serial input pin (SI1n) to SIO1n.

Reset signal generation clears this register to 00H.

## Cautions 1. Do not access SIO1n when CSOT1n = 1 (during serial communication).

2. In the slave mode, reception is started when data is read from SIO11 with a low level input to the SSI11 pin. For details of the reception operation, see 13.4.2 (2) Communication operation.



# 13.3 Registers Controlling Serial Interfaces CSI10 and CSI11

Serial interfaces CSI10 and CSI11 are controlled by the following four registers.

- Serial operation mode register 1n (CSIM1n)
- Serial clock selection register 1n (CSIC1n)
- Port mode registers 1, 7 (PM1, PM7)
- Port registers 1, 7 (P1, P7)

Remark CSIM11, CSIC11, PM7, and P7 are for 78K0/DF2 only.


#### (1) Serial operation mode register 1n (CSIM1n)

CSIM1n is used to select the operation mode and enable or disable operation. CSIM1n can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears this register to 00H.

 $\textbf{Remark} \quad n=0,\ 1$ 

#### Figure 13-3. Format of Serial Operation Mode Register 10 (CSIM10)

Address: FF80H After reset: 00H R/W<sup>Note 1</sup>

Symbol	<7>	6	5	4	3	2	1	0
CSIM10	CSIE10	TRMD10	0	DIR10	0	0	0	CSOT10

CSIE10	Operation control in 3-wire serial I/O mode
0	Disables operation <sup>Note 2</sup> and asynchronously resets the internal circuit <sup>Note 3</sup> .
1	Enables operation

TRMD10 <sup>Note 4</sup>	Transmit/receive mode control		
0 <sup>Note 5</sup>	Receive mode (transmission disabled).		
1	Transmit/receive mode		

DIR10 <sup>Note 6</sup>	First bit specification
0	MSB
1	LSB

CSOT10	Communication status flag
0	Communication is stopped.
1	Communication is in progress.

Notes 1. Bit 0 is a read-only bit.

- 2. To use P10/SCK10/INTP4/TxD61, and P12/SO10/INTP2 as general-purpose ports, set CSIM10 in the default status (00H). (The TxD61 function is for 78K0/DF2 only.)
- **3.** Bit 0 (CSOT10) of CSIM10 and serial I/O shift register 10 (SIO10) are reset.
- 4. Do not rewrite TRMD10 when CSOT10 = 1 (during serial communication).
- 5. The SO10 output (see (a) in Figure 13-1. Block Diagram of Serial Interface CSI10) is fixed to the low level when TRMD10 is 0. Reception is started when data is read from SIO10.
- 6. Do not rewrite DIR10 when CSOT10 = 1 (during serial communication).
- Caution Be sure to clear bit 5 to 0.



# Figure 13-4. Format of Serial Operation Mode Register 11 (CSIM11)

Address: FF88H After reset: 00H R/W<sup>Note 1</sup>

Symbo

ol	<7>	6	5	4	3	2	1	0
11	CSIE11	TRMD11	SSE11	DIR11	0	0	0	CSOT11

CSIE11	Operation control in 3-wire serial I/O mode
0	Disables operation Note <sup>2</sup> and asynchronously resets the internal circuit Note <sup>3</sup> .
1	Enables operation

TRMD11 <sup>Note 4</sup>	Transmit/receive mode control
0 <sup>Note 5</sup>	Receive mode (transmission disabled).
1	Transmit/receive mode

SSE11 <sup>Notes 6, 7</sup>	SSI11 pin use selection
0	SSI11 pin is not used
1	SSI11 pin is used

DIR11 <sup>Note 8</sup>	First bit specification
0	MSB
1	LSB

CSOT11	Communication status flag
0	Communication is stopped.
1	Communication is in progress.

#### **Notes 1.** Bit 0 is a read-only bit.

- 2. To use P74/SCK11/SEG24, P76/SO11/SEG26, and P77/SSI11/TIOP20/SEG27 as general-purpose ports, set CSIM11 in the default status (00H). (The SEG24, SEG26, and SEG27 functions are for  $\mu$  PD78F0842, 78F0843, 78F0848, and 78F0849 only.)
- **3.** Bit 0 (CSOT11) of CSIM11 and serial I/O shift register 11 (SIO11) are reset.
- 4. Do not rewrite TRMD11 when CSOT11 = 1 (during serial communication).
- 5. The SO11 output (see (a) in Figure 13-2. Block Diagram of Serial Interface CSI11) is fixed to the low level when TRMD11 is 0. Reception is started when data is read from SIO11.
- 6. Do not rewrite SSE11 when CSOT11 = 1 (during serial communication).
- 7. Before setting this bit to 1, fix the SSI11 pin input level to 0 or 1.
- 8. Do not rewrite DIR11 when CSOT11 = 1 (during serial communication).



# (2) Serial clock selection register 1n (CSIC1n)

This register specifies the timing of the data transmission/reception and sets the serial clock. CSIC1n can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears this register to 00H.

**Remark** n = 0, 1

# Figure 13-5. Format of Serial Clock Selection Register 10 (CSIC10) (1/2)

Address: FF81H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
CSIC10	0	0	0	CKP10	DAP10	CKS102	CKS101	CKS100

CKP10	DAP10	Specification of data transmission/reception timing	Туре
0	0	SCK10            SO10            SO10            SI10 input timing	1
0	1	SCK10         SCK10 <th< td=""><td>2</td></th<>	2
1	0	SCK10            SO10            SO10            SI10 input timing	3
1	1	SCK10            SO10         XD7XD6XD5XD4XD3XD2XD1XD0           SI10 input timing	4



CKS102	CKS101	CKS100		CSI10 serial clock selection Notes 1, 2					
				f <sub>PRS</sub> = 2 MHz	f <sub>PRS</sub> = 5 MHz	f <sub>PRS</sub> = 10 MHz	f <sub>PRS</sub> = 20 MHz		
0	0	0	fprs/2	1 MHz	2.5 MHz	5 MHz	10 MHz	Master mode	
0	0	1	fprs/2 <sup>2</sup>	500 kHz	1.25 MHz	2.5 MHz	5 MHz		
0	1	0	fprs/2 <sup>3</sup>	250 kHz	625 kHz	1.25 MHz	2.5 MHz		
0	1	1	fprs/2 <sup>4</sup>	125 kHz	312.5 kHz	625 kHz	1.25 MHz		
1	0	0	f <sub>PRS</sub> /2⁵	62.5 kHz	156.25 kHz	312.5 kHz	625 kHz		
1	0	1	fprs/2 <sup>6</sup>	31.25 kHz	78.13 kHz	156.25 kHz	312.5 kHz		
1	1	0	fprs/27	15.63 kHz	39.06 kHz	78.13 kHz	156.25 kHz		
1	1	1	Externa	al clock input	to SCK10			Slave mode	

Figure 13-5. Format of Serial Clock Selection Register 10 (CSIC10) (2/2)

Notes 1. If the peripheral hardware clock (fPRs) operates on the high-speed system clock (fIN) (XSEL =

1), the fPRs operating frequency varies depending on the supply voltage.

- Vdd = 4.0 to 5.5 V: fprs  $\leq 20~MHz$
- Vdd = 2.7 to 4.0 V: fprs  $\leq$  10 MHz
- **2.** Set the serial clock to satisfy the following conditions.

Supply Voltage	(A) Grade Products	(A2) Grade Products		
V <sub>DD</sub> = 4.0 to 5.5 V	Serial clock $\leq$ 5 MHz	Serial clock $\leq$ 5 MHz		
V <sub>DD</sub> = 2.7 to 4.0 V	Serial clock $\leq$ 2.5 MHz	Serial clock $\leq$ 2.5 MHz		

Cautions 1. Do not write to CSIC10 while CSIE10 = 1 (operation enabled).

- 2. To use P10/SCK10/INTP4/TxD61 and P12/SO10/INTP2 as general-purpose ports, set CSIC10 in the default status (00H). (The TxD61 function is for 78K0/DF2 only.)
- 3. The phase type of the data clock is type 1 after reset.
- **Remark** fPRS: Peripheral hardware clock frequency



#### Address: FF89H After reset: 00H R/W Symbol 7 6 5 4 3 2 1 0 CSIC11 0 0 CKP11 DAP11 CKS112 CKS111 CKS110 0 CKP11 DAP11 Specification of data transmission/reception timing Туре 0 0 1 SCK11 SO11 D7 D6 D5 D4 D3 D2 D1 D0SI11 input timing 0 1 2 SCK11 SO11 <u>\D7\D6\D5\D4\D3\D2\D1\D0</u> SI11 input timing 1 0 3 SCK11 П SI11 input timing 1 1 4 SCK11 SO11 XD7 XD6 X D5 X D4 X D3 X D2 X D1 X D0 SI11 input timing

# Figure 13-6. Format of Serial Clock Selection Register 11 (CSIC11) (1/2)

78K0/Dx2



CKS112	CKS111	CKS110		2	Mode			
				f <sub>PRS</sub> = 2 MHz	f <sub>PRS</sub> = 5 MHz	f <sub>PRS</sub> = 10 MHz	f <sub>PRS</sub> = 20 MHz	
0	0	0	fprs/2	1 MHz	2.5 MHz	5 MHz	10 MHz	Master mode
0	0	1	fprs/2 <sup>2</sup>	500 kHz	1.25 MHz	2.5 MHz	5 MHz	
0	1	0	fprs/2 <sup>3</sup>	250 kHz	625 kHz	1.25 MHz	2.5 MHz	
0	1	1	fprs/24	125 kHz	312.5 kHz	625 kHz	1.25 MHz	
1	0	0	fprs/2⁵	62.5 kHz	156.25 kHz	312.5 kHz	625 kHz	
1	0	1	fprs/2 <sup>6</sup>	31.25 kHz	78.13 kHz	156.25 kHz	312.5 kHz	
1	1	0	fprs/27	15.63 kHz	39.06 kHz	78.13 kHz	156.25 kHz	
1	1	1	Externa	al clock input	to SCK11			Slave mode

Figure 13-6. Format of Serial Clock Selection Register 11 (CSIC11) (1/2)

Notes 1. If the peripheral hardware clock (fprs) operates on the high-speed system clock (fin) (XSEL =

- 1), the fPRs operating frequency varies depending on the supply voltage.
  - VDD = 4.0 to 5.5 V: fPRs  $\leq 20 \mbox{ MHz}$
  - Vdd = 2.7 to 4.0 V: fprs  $\leq 10~MHz$
- 2. Set the serial clock to satisfy the following conditions.

Supply Voltage	(A) Grade Products	(A2) Grade Products		
$V_{DD} = 4.0$ to 5.5 V	Serial clock $\leq$ 5 MHz	Serial clock $\leq$ 5 MHz		
V <sub>DD</sub> = 2.7 to 4.0 V	Serial clock $\leq$ 2.5 MHz	Serial clock $\leq$ 2.5 MHz		

Cautions 1. Do not write to CSIC11 while CSIE11 = 1 (operation enabled).

- 2. To use P74/SCK11/SEG24 and P76/SO11/SEG26 as general-purpose ports, set CSIC11 in the default status (00H). (The SEG24 and SEG26 functions are for  $\mu$  PD78F0842, 78F0843, 78F0848, and 78F0849 only.)
- 3. The phase type of the data clock is type 1 after reset.

**Remark** fprs: Peripheral hardware clock frequency



# (3) Port mode registers 1, 7 (PM1, PM7)

These registers set port 1 and 7 input/output in 1-bit units.

When using P10/SCK10/INTP4/TxD61<sup>Note 1</sup> and P74/SCK11/SEG24<sup>Note 2</sup> as the clock output pins of the serial interface, clear PM10 and PM76, and the output latches of P10 and P74 to 1.

When using P12/SO10/INTP2 and P76/SO11/SEG26<sup>Note 2</sup> as the data output pins of the serial interface, clear PM12, PM76, P12 and P76 to 0.

When using P10/SCK10/INTP4/TxD61<sup>Note 1</sup> and P74/SCK11/SEG24<sup>Note 2</sup> as the clock input pins of the serial interface, P11/SI10/RxD61<sup>Note 1</sup>/INTPR61<sup>Note 1</sup> and P75/SI11/SEG25<sup>Note 2</sup> as the data input pins, and P77/SSI11/TIOP20/SEG27<sup>Note 2</sup> as the chip select input pin, set PM10, PM74, PM11, PM75, and PM77 to 1. At this time, the output latches of P10, P74, P11, P75, and P77 may be 0 or 1.

PM1 and PM7 can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation sets these registers to FFH.

Notes 1. 78K0/DF2 only.

**2.** *μ* PD78F0842, 78F0843, 78F0848, and 78F0849 only.

#### Figure 13-7. Format of Port Mode Register 1 (PM1)

Address: FF21H After reset: FFH R/W

Symbol	7	6	5	4	3	2	1	0				
PM1	PM17	PM16	PM15	PM14	PM13	PM12	PM11	PM10				
	PM1n		P1n pin I/O mode selection (n = 0 to 7)									
	0	Output mode (Output buffer on)										
	1	Input mode (Output buffer off)										

#### Figure 13-8. Format of Port Mode Register 7 (PM7)

#### Address: FF27H After reset: FFH R/W

1

Symb

Symbol	7	6	5	4	3	2	1	0				
PM7	PM77 <sup>Note</sup>	PM76 <sup>Note</sup>	PM75 <sup>Note</sup>	PM74 <sup>Note</sup>	PM73	PM72	PM71	PM70				
	PM7n		P7n pin I/O mode selection (n = 0 to 7)									
	0	Output mode (Output buffer on)										

Note These bits are set to 1 in 78K0/DE2.

Input mode (Output buffer off)



# 13.4 Operation of Serial Interfaces CSI10 and CSI11

Serial interfaces CSI10 and CSI11 can be used in the following two modes.

- Operation stop mode
- 3-wire serial I/O mode

Remark Serial interface CSI11 is for 78K0/DF2 only.



# 13.4.1 Operation stop mode

Serial communication is not executed in this mode. Therefore, the power consumption can be reduced. In addition, the P10/SCK10/INTP4/TxD61, P11/SI10/RxD61/INTPR61, P12/SO10/INTP2, P74/SCK11/SEG24, P75/SI11/SEG25, and P76/SO11/SEG26 pins can be used as ordinary I/O port pins in this mode.

#### (1) Register used

The operation stop mode is set by serial operation mode register 1n (CSIM1n). To set the operation stop mode, clear bit 7 (CSIE1n) of CSIM1n to 0.

#### (a) Serial operation mode register 1n (CSIM1n)

CSIM1n can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears CSIM1n to 00H.

**Remark** n = 0, 1

• Serial operation mode register 10 (CSIM10)

Address: FF80H After reset: 00H R/W



Notes 1. To use P74/SCK11/SEG24, P77/SSI11/TIOP20/SEG27, and P76/SO11/SEG26 as general-purpose ports, set CSIM11 in the default status (00H).

2. Bit 0 (CSOT11) of CSIM11 and serial I/O shift register 11 (SIO11) are reset.

Remarks 1. The TxD61, RxD61, and INTPR61 functions are for 78K0/DF2 only.

2. The SEG24 to SEG27 functions are for  $\mu$  PD78F0842, 78F0843, 78F0848, and 78F0849 only.

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# 13.4.2 3-wire serial I/O mode

The 3-wire serial I/O mode is used for connecting peripheral ICs and display controllers with a clocked serial interface.

In this mode, communication is executed by using three lines: the serial clock (SCK1n), serial output (SO1n), and serial input (SI1n) lines.

#### (1) Registers used

- Serial operation mode register 1n (CSIM1n)
- Serial clock selection register 1n (CSIC1n)
- Port mode register 1 (PM1) or port mode register 7 (PM7)
- Port register 1 (P1) or port register 7 (P7)

The basic procedure of setting an operation in the 3-wire serial I/O mode is as follows.

- <1> Set the CSIC1n register (see Figures 13-5 and 13-6).
- <2> Set bits 0 and 4 to 6 (CSOT1n, DIR1n, SSE11 (serial interface CSI11 only), and TRMD1n) of the CSIM1n register (see Figures 13-3 and 13-4).
- <3> Set bit 7 (CSIE1n) of the CSIM1n register to 1.  $\rightarrow$  Transmission/reception is enabled.
- <4> Write data to transmit buffer register 1n (SOTB1n). → Data transmission/reception is started. Read data from serial I/O shift register 1n (SIO1n). → Data reception is started.
- Caution Take relationship with the other party of communication when setting the port mode register and port register.



The relationship between the register settings and pins is shown below.

# Table 13-2. Relationship between Register Settings and Pins (1/2)

#### (a) Serial interface CSI10

CSIE10	TRMD10	PM11	P11	PM12	P12	PM10	P10			Pin Function	
								CSI10 Operation	SI10/RxD61/ INTPR61/ P11	SO10/ INTP2/ P12	SCK10/ INTP4/ TxD61/P10
0	×	X Note 1	Stop	RxD61/ INTPR61/ P11	INTP2/P12	TxD61/ INTP4/ P10 <sup>Note 2</sup>					
1	0	1	×	X Note 1	X Note 1	1	×	Slave reception	SI10	INTP2/P12	SCK10 (input) <sup>Note 3</sup>
1	1	× Note 1	× Note 1	0	0	1	×	Slave transmission <sup>Note 3</sup>	RxD61/ INTPR61/ P11	SO10	SCK10 (input) <sup>Note 3</sup>
1	1	1	×	0	0	1	×	Slave transmission/ reception <sup>Note 3</sup>	SI10	SO10	SCK10 (input) <sup>Note 3</sup>
1	0	1	×	X Note 1	X Note 1	0	1	Master reception	SI10	INTP2/P12	SCK10 (output)
1	1	X Note 1	X Note 1	0	0	0	1	Master transmission	RxD61/ INTPR61/ P11	SO10	SCK10 (output)
1	1	1	×	0	0	0	1	Master transmission/ reception	SI10	SO10	SCK10 (output)

Notes 1. Can be set as port function.

- 2. To use P10/SCK10/INTP4/TxD61 as port pins, clear CKP10 to 0.
- 3. To use the slave mode, set CKS102, CKS101, and CKS100 to 1, 1, 1.

#### Remarks 1. ×:

x:	don't care
CSIE10:	Bit 7 of serial operation mode register 10 (CSIM10)
TRMD10:	Bit 6 of CSIM10
CKP10:	Bit 4 of serial clock selection register 10 (CSIC10)
CKS102, CKS101, CKS100:	Bits 2 to 0 of CSIC10
PM1×:	Port mode register
P1x:	Port output latch

2. The RxD61, INTPR61, and TxD61 functions are for 78K0/DF2 only.



# Table 13-2. Relationship between Register Settings and Pins (2/2)

# (b) Serial interface CSI11

CSIE11	TRMD11	SSE11	PM75	P75	PM76	P76	PM74	P74	PM77	P77			Pin Fu	unction	
											CSI11 Operation	SI11/ SEG25/ P75	SO11/ SEG26/ P76	SCK11/ SEG24/ P74	SSI11/ TIOP20/ SEG27/ P77
0	×	×	X Note 1	Stop	SEG25 /P75	SEG26 /P76	SEG24/ P74 Note 2	TIOP20 /SEG27 /P77							
1	0	0	1	×	X Note 1	X Note 1	1	×	X Note 1	X Note 1	Slave reception Note 3	SI11	SEG26 /P76	SCK11 (input) Note 3	TIOP20 /SEG27 /P77
		1							1	×					SSI11
1	1	0	X Note 1	X Note 1	0	0	1	×	X Note 1	X Note 1	Slave transmission Note 3	SEG25 /P75	SO11	SCK11 (input) Note 3	TIOP20 /SEG27 /P77
		1							1	×					SSI11
1	1	0	1	×	0	0	1	×	X Note 1	X Note 1	Slave transmission /reception	SI11	SO11	SCK11 (input) Note 3	TIOP20 /SEG27 /P77
		1							1	×	Note 3				SSI11
1	0	0	1	×	X Note 1	X Note 1	0	1	X Note 1	X Note 1	Master reception	SI11	SEG26 /P76	SCK11 (output)	TIOP20 /SEG27 /P77
1	1	0	X Note 1	X Note 1	0	0	0	1	X Note 1	X Note 1	Master transmission	SEG25 /P75	SO11	SCK11 (output)	TIOP20 /SEG27 /P77
1	1	0	1	×	0	0	0	1	X Note 1	X Note 1	Master transmission /reception	SI11	SO11	SCK11 (output)	TIOP20 /SEG27 /P77

# Notes 1. Can be set as port function.

2. To use P74/SCK11/SEG24 as port pins, clear CKP11 to 0.

3. To use the slave mode, set CKS112, CKS111, and CKS110 to 1, 1, 1.

Remarks 1.	x:	don't care			
	CSIE11:	Bit 7 of serial operation mode register 11 (CSIM11)			
	TRMD11:	Bit 6 of CSIM11			
	CKP11:	Bit 4 of serial clock selection register 11 (CSIC11)			
	CKS112, CKS111, CKS110:	Bits 2 to 0 of CSIC11			
	PM7×:	Port mode register 7×			
	P7x:	Port 7× output latch			
	PM7x: P7x:	Port mode register 7× Port 7× output latch			

2. The SEG24 to SEG27 functions are for  $\mu$  PD78F0842, 78F0843, 78F0848, and 78F0849 only.

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# (2) Communication operation

In the 3-wire serial I/O mode, data is transmitted or received in 8-bit units. Each bit of the data is transmitted or received in synchronization with the serial clock.

Data can be transmitted or received if bit 6 (TRMD1n) of serial operation mode register 1n (CSIM1n) is 1. Transmission/reception is started when a value is written to transmit buffer register 1n (SOTB1n). In addition, data can be received when bit 6 (TRMD1n) of serial operation mode register 1n (CSIM1n) is 0.

Reception is started when data is read from serial I/O shift register 1n (SIO1n).

However, communication is performed as follows if bit 5 (SSE11) of CSIM11 is 1 when serial interface CSI11 is in the slave mode.

- <1> Low level input to the  $\overline{SSI11}$  pin
  - → Transmission/reception is started when SOTB11 is written, or reception is started when SIO11 is read.
- <2> High level input to the  $\overline{SSI11}$  pin
  - → Transmission/reception or reception is held, therefore, even if SOTB11 is written or SIO11 is read, transmission/reception or reception will not be started.
- <3> Data is written to SOTB11 or data is read from SIO11 while a high level is input to the SSI11 pin, then a low level is input to the SSI11 pin
  - $\rightarrow$  Transmission/reception or reception is started.
- <4> A high level is input to the SSI11 pin during transmission/reception or reception
  - $\rightarrow$  Transmission/reception or reception is suspended.

After communication has been started, bit 0 (CSOT1n) of CSIM1n is set to 1. When communication of 8-bit data has been completed, a communication completion interrupt request flag (CSIIF1n) is set, and CSOT1n is cleared to 0. Then the next communication is enabled.

- Cautions 1. Do not access the control register and data register when CSOT1n = 1 (during serial communication).
  - 2. When using serial interface CSI11, wait for the duration of at least one clock before the clock operation is started to change the level of the SSI11 pin in the slave mode; otherwise, malfunctioning may occur.





#### Figure 13-9. Timing in 3-wire Serial I/O Mode (1/2)





Note The SSE11 flag and SSI11 pin are available only for serial interface CSI11, and are used in the slave mode.



# Figure 13-9. Timing in 3-wire Serial I/O Mode (2/2)



Note The SSE11 flag and SSI11 pin are available only for serial interface CSI11, and are used in the slave mode.



<sup>55</sup>H is written to SOTB1n.

#### Figure 13-10. Timing of Clock/data Phase

#### (a) Type 1; CKP1n = 0, DAP1n = 0, DIR1n = 0





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# (3) Timing of output to SO1n pin (first bit)

When communication is started, the value of transmit buffer register 1n (SOTB1n) is output from the SO1n pin. The output operation of the first bit at this time is described below.

Figure 13-11. Output Operation of First Bit (1/2)



(a) Type 1: CKP1n = 0, DAP1n = 0





The first bit is directly latched by the SOTB1n register to the output latch at the falling (or rising) edge of  $\overline{SCK1n}$ , and output from the SO1n pin via an output selector. Then, the value of the SOTB1n register is transferred to the SIO1n register at the next rising (or falling) edge of  $\overline{SCK1n}$ , and shifted one bit. At the same time, the first bit of the receive data is stored in the SIO1n register via the SI1n pin.

The second and subsequent bits are latched by the SIO1n register to the output latch at the next falling (or rising) edge of SCK1n, and the data is output from the SO1n pin.





# Figure 13-11. Output Operation of First Bit (2/2)

(c) Type 2: CKP1n = 0, DAP1n = 1

The first bit is directly latched by the SOTB1n register at the falling edge of the write signal of the SOTB1n register or the read signal of the SIO1n register, and output from the SO1n pin via an output selector. Then, the value of the SOTB1n register is transferred to the SIO1n register at the next falling (or rising) edge of SCK1n, and shifted one bit. At the same time, the first bit of the receive data is stored in the SIO1n register via the SI1n pin. The second and subsequent bits are latched by the SIO1n register to the output latch at the next rising (or falling) edge of SCK1n, and the data is output from the SO1n pin.



# (4) Output value of SO1n pin (last bit)

After communication has been completed, the SO1n pin holds the output value of the last bit.



Figure 13-12. Output Value of SO1n Pin (Last Bit) (1/2)





Figure 13-12. Output Value of SO1n Pin (Last Bit) (2/2)



# (5) SO1n output (see (a) in Figures 13-1 and 13-2)

The status of the SO1n output is as follows if bit 7 (CSIE1n) of serial operation mode register 1n (CSIM1n) is cleared to 0.

TRMD1n	DAP1n	DIR1n	SO1n Output <sup>Note 1</sup>
$\text{TRMD1n} = 0^{\text{Note 2}}$	-	-	Outputs low level <sup>Note 2</sup>
TRMD1n = 1	DAP1n = 0	_	Value of SO1n latch (low-level output)
	DAP1n = 1	DIR1n = 0	Value of bit 7 of SOTB1n
		DIR1n = 1	Value of bit 0 of SOTB1n

# Table 13-3. SO1n Output Status

- **Notes 1.** The actual output of the SO10/INTP2/P12 or SO11/P76 pin is determined according to PM12 and P12 or PM76 and P76, as well as the SO1n output.
  - 2. Status after reset

# Caution If a value is written to TRMD1n, DAP1n, and DIR1n, the output value of SO1n changes.



# CHAPTER 14 SERIAL INTERFACE IICO

Caution Do not use serial interface IIC0 and the multiplier/divider simultaneously, because various flags corresponding to interrupt request sources are shared among serial interface IIC0 and the multiplier/divider.

# 14.1 Functions of Serial Interface IIC0

Serial interface IIC0 are mounted onto all 78K0/Dx2 microcontroller products. Serial interface IIC0 has the following two modes.

# (1) Operation stop mode

This mode is used when serial transfers are not performed. It can therefore be used to reduce power consumption.

#### (2) I<sup>2</sup>C bus mode (multimaster supported)

This mode is used for 8-bit data transfers with several devices via two lines: a serial clock (SCL0) line and a serial data bus (SDA0) line.

This mode complies with the  $l^2C$  bus format and the master device can generated "start condition", "address", "transfer direction specification", "data", and "stop condition" data to the slave device, via the serial data bus. The slave device automatically detects these received status and data by hardware. This function can simplify the part of application program that controls the  $l^2C$  bus.

Since the SCL0 and SDA0 pins are used for open drain outputs, IIC0 requires pull-up resistors for the serial clock line and the serial data bus line.

Figure 14-1 shows a block diagram of serial interface IIC0.





Figure 14-1. Block Diagram of Serial Interface IIC0



Figure 14-2 shows a serial bus configuration example.



Figure 14-2. Serial Bus Configuration Example Using I<sup>2</sup>C Bus



# 14.2 Configuration of Serial Interface IIC0

Serial interface IIC0 includes the following hardware.

Item	Configuration
Registers	IIC shift register 0 (IIC0) Slave address register 0 (SVA0)
Control registers	IIC control register 0 (IICC0) IIC status register 0 (IICS0) IIC flag register 0 (IICF0) IIC clock selection register 0 (IICCL0) IIC function expansion register 0 (IICX0) Port mode register 6 (PM6) Port register 6 (P6)

#### Table 14-1. Configuration of Serial Interface IIC0

# (1) IIC shift register 0 (IIC0)

IIC0 is used to convert 8-bit serial data to 8-bit parallel data and vice versa in synchronization with the serial clock. IIC0 can be used for both transmission and reception.

The actual transmit and receive operations can be controlled by writing and reading operations to IICO.

Cancel the wait state and start data transfer by writing data to IIC0 during the wait period.

IIC0 is set by an 8-bit memory manipulation instruction.

Reset signal generation clears IIC0 to 00H.

#### Figure 14-3. Format of IIC Shift Register 0 (IIC0)

Address:	FFB0H	After reset:	00H R/V	V				
Symbol	7	6	5	4	3	2	1	0
IIC0								

# Cautions 1. Do not write data to IIC0 during data transfer.

2. Write or read IIC0 only during the wait period. Accessing IIC0 in a communication state other than during the wait period is prohibited. When the device serves as the master, however, IIC0 can be written only once after the communication trigger bit (STT0) is set to 1.



#### (2) Slave address register 0 (SVA0)

This register stores local addresses when in slave mode.

SVA0 is set by an 8-bit memory manipulation instruction.

However, rewriting to this register is prohibited while STD0 = 1 (while the start condition is detected). Reset signal generation clears SVA0 to 00H.

#### Figure 14-4. Format of Slave Address Register 0 (SVA0)

Address: FFB2H After reset: 00H R/W



#### Note Bit 0 is fixed to 0.

#### (3) SO latch

The SO latch is used to retain the SDA0 pin's output level.

#### (4) Wake-up controller

This circuit generates an interrupt request (INTIIC0) when the address received by this register matches the address value set to slave address register 0 (SVA0) or when an extension code is received.

#### (5) Prescaler

This selects the sampling clock to be used.

#### (6) Serial clock counter

This counter counts the serial clocks that are output or input during transmit/receive operations and is used to verify that 8-bit data was transmitted or received.

#### (7) Interrupt request signal generator

This circuit controls the generation of interrupt request signals (INTIIC0).

An I<sup>2</sup>C interrupt request is generated by the following two triggers.

- Falling edge of eighth or ninth clock of the serial clock (set by WTIM0 bit)
- · Interrupt request generated when a stop condition is detected (set by SPIE0 bit)

Remark WTIM0 bit: Bit 3 of IIC control register 0 (IICC0) SPIE0 bit: Bit 4 of IIC control register 0 (IICC0)

#### (8) Serial clock controller

In master mode, this circuit generates the clock output via the SCL0 pin from a sampling clock.

#### (9) Serial clock wait controller

This circuit controls the wait timing.

#### (10) ACK generator, stop condition detector, start condition detector, and ACK detector

These circuits generate and detect each status.

#### (11) Data hold time correction circuit

This circuit generates the hold time for data corresponding to the falling edge of the serial clock.



# (12) Start condition generator

This circuit generates a start condition when the STT0 bit is set to 1.

However, in the communication reservation disabled status (IICRSV bit = 1), when the bus is not released (IICBSY bit = 1), start condition requests are ignored and the STCF bit is set to 1.

# (13) Stop condition generator

This circuit generates a stop condition when the SPT0 bit is set to 1.

#### (14) Bus status detector

This circuit detects whether or not the bus is released by detecting start conditions and stop conditions. However, as the bus status cannot be detected immediately following operation, the initial status is set by the STCEN bit.

Remark	STT0 bit:	Bit 1 of IIC control register 0 (IICC0)
	SPT0 bit:	Bit 0 of IIC control register 0 (IICC0)
	IICRSV bit:	Bit 0 of IIC flag register 0 (IICF0)
	IICBSY bit:	Bit 6 of IIC flag register 0 (IICF0)
	STCF bit:	Bit 7 of IIC flag register 0 (IICF0)
	STCEN bit:	Bit 1 of IIC flag register 0 (IICF0)



# 14.3 Registers to Control Serial Interface IIC0

Serial interface IIC0 is controlled by the following seven registers.

- IIC control register 0 (IICC0)
- IIC flag register 0 (IICF0)
- IIC status register 0 (IICS0)
- IIC clock selection register 0 (IICCL0)
- IIC function expansion register 0 (IICX0)
- Port mode register 6 (PM6)
- Port register 6 (P6)

# (1) IIC control register 0 (IICC0)

This register is used to enable/stop I<sup>2</sup>C operations, set wait timing, and set other I<sup>2</sup>C operations.

IICC0 is set by a 1-bit or 8-bit memory manipulation instruction. However, set the SPIE0, WTIM0, and ACKE0 bits while IICE0 bit = 0 or during the wait period. These bits can be set at the same time when the IICE0 bit is set from "0" to "1".

Reset signal generation clears IICC0 to 00H.



Address: FFB1H After reset: 00H R/W									
Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>	_
IICC0	IICE0	LREL0	WREL0	SPIE0	WTIM0	ACKE0	STT0	SPT0	
IICE0		l <sup>2</sup> C operation enable							
0	Stop ope	Stop operation. Reset IIC status register 0 (IICS0) <sup>Note 1</sup> . Stop internal operation.							
1	Enable o	Enable operation.							
Be sure to set this bit (1) while the SCL0 and SDA0 lines are at high level.									
Condition for clearing (IICE0 = 0) Condition for s				n for setting (	(IICE0 = 1)				

# Figure 14-5. Format of IIC Control Register 0 (IICC0) (1/4)

Cleared	by	instruction
<ul> <li>Reset</li> </ul>		

LREL0 <sup>Note 2</sup>	Exit from communications				
0	Normal operation	Normal operation			
1	This exits from the current communications and sets standby mode. This setting is automatically cleared to 0 after being executed. Its uses include cases in which a locally irrelevant extension code has been received. The SCL0 and SDA0 lines are set to high impedance. The following flags of IIC control register 0 (IICC0) and IIC status register 0 (IICS0) are cleared to 0. • STT0 • SPT0 • MSTS0 • EXC0 • COI0 • TRC0 • ACKD0 • STD0				
The standby mode following exit from communications remains in effect until the following communications entry conditions are met. • After a stop condition is detected, restart is in master mode. • An address match or extension code reception occurs after the start condition.					
Condition for	Condition for clearing (LREL0 = 0) Condition for setting (LREL0 = 1)				
<ul> <li>Automatica</li> </ul>	ally cleared after execution	Set by instruction			

Set by instruction

Reset

WREL0 <sup>Note 2</sup>	Wait cancellation				
0	Do not cancel wait				
1	Cancel wait. This setting is automatically cleared after wait is canceled.				
When WREL SDA0 line go	When WREL0 is set (wait canceled) during the wait period at the ninth clock pulse in the transmission status (TRC0 = 1), the SDA0 line goes into the high impedance state (TRC0 = 0).				
Condition for	Condition for clearing (WREL0 = 0) Condition for setting (WREL0 = 1)				
<ul><li>Automatically cleared after execution</li><li>Reset</li></ul>		Set by instruction			

- **Notes 1.** The IICS0 register, the STCF0 and IICBSY bits of the IICF0 register, and the CLD0 and DAD0 bits of the IICCL0 register are reset.
  - **2.** This flag's signal is invalid when IICE0 = 0.
- Caution The start condition is detected immediately after  $I^2C$  is enabled to operate (IICE0 = 1) while the SCL0 line is at high level and the SDA0 line is at low level. Immediately after enabling  $I^2C$  to operate (IICE0 = 1), set LREL0 (1) by using a 1-bit memory manipulation instruction.

RENESAS

# Figure 14-5. Format of IIC Control Register 0 (IICC0) (2/4)

SPIE0 <sup>Note 1</sup>	Enable/disable generation of interrupt request when stop condition is detected				
0	Disable				
1	Enable				
Condition for clearing (SPIE0 = 0)		Condition for setting (SPIE0 = 1)			
Cleared by instruction     Reset		Set by instruction			

WTIM0 <sup>Note 1</sup>	Control of wait and interrupt request generation				
0	Interrupt request is generated at the eighth clock's falling edge. Master mode: After output of eight clocks, clock output is set to low level and wait is set. Slave mode: After input of eight clocks, the clock is set to low level and wait is set for master device.				
1	Interrupt request is generated at the ninth clock's falling edge. Master mode: After output of nine clocks, clock output is set to low level and wait is set. Slave mode: After input of nine clocks, the clock is set to low level and wait is set for master device.				
An interrupt The setting of edge of the r falling edge extension co	An interrupt is generated at the falling edge of the ninth clock during address transfer independently of the setting of this bit. The setting of this bit is valid when the address transfer is completed. When in master mode, a wait is inserted at the falling edge of the ninth clock during address transfers. For a slave device that has received a local address, a wait is inserted at the falling edge of the ninth clock after an acknowledge ( $\overline{ACK}$ ) is issued. However, when the slave device has received an extension code, a wait is inserted at the falling edge of the eighth clock.				
Condition for	Condition for clearing (WTIM0 = 0) Condition for setting (WTIM0 = 1)				
<ul><li>Cleared by</li><li>Reset</li></ul>	instruction	Set by instruction			

ACKE0 <sup>Notes 1, 2</sup>	Acknowledgment control			
0	Disable acknowledgment.			
1	Enable acknowledgment. During the ninth clock period, the SDA0 line is set to low level.			
Condition for clearing (ACKE0 = 0)		Condition for setting (ACKE0 = 1)		
Cleared by instruction     Reset		Set by instruction		

**Notes 1.** This flag's signal is invalid when IICE0 = 0.

The set value is invalid during address transfer and if the code is not an extension code.
 When the device serves as a slave and the addresses match, an acknowledge is generated regardless of the set value.



Figure 14-5.	Format of IIC	<b>Control Register</b>	0	(IICC0) (3/4)
			-	· · · · / · · /

Start condition trigger				
Do not generate a start condition.				
<ul> <li>When bus is released (in STOP mode):</li> <li>Generate a start condition (for starting as master). When the SCL0 line is high level, the SDA0 line is changed from high level to low level and then the start condition is generated. Next, after the rated amount of time has elapsed, SCL0 is changed to low level (wait state).</li> <li>When a third party is communicating: <ul> <li>When communication reservation function is enabled (IICRSV = 0)</li> <li>Functions as the start condition reservation flag. When set to 1, automatically generates a start condition after the bus is released.</li> <li>When communication reservation function is disabled (IICRSV = 1)</li> <li>STCF is set to 1 and information that is set (1) to STT0 is cleared. No start condition is generated.</li> </ul> </li> </ul>				
<ul> <li>Generates a restart condition after releasing the wait.</li> <li>Cautions concerning set timing <ul> <li>For master reception:</li> <li>Cannot be set to 1 during transfer. Can be set to 1 only in the waiting period when ACKE0 has been cleared to 0 and slave has been notified of final reception.</li> </ul> </li> <li>For master transmission: A start condition cannot be generated normally during the acknowledge period. Set to 1 during the wait period that follows output of the ninth clock.</li> <li>Cannot be set to 1 at the same time as SPT0.</li> </ul>				
or clearing (STT0 = 0)	Condition for setting (STT0 = 1)			
by setting SST0 to 1 while communication on is prohibited. by loss in arbitration after start condition is generated by master device by LREL0 = 1 (exit from communications) E0 = 0 (operation stop)	Set by instruction			
	Start Do not generate a start condition. When bus is released (in STOP mode): Generate a start condition (for starting as master) from high level to low level and then the start con elapsed, SCL0 is changed to low level (wait state When a third party is communicating: • When communication reservation function is e Functions as the start condition reservation function is d after the bus is released. • When communication reservation function is d STCF is set to 1 and information that is set (1) In the wait state (when master device): Generates a restart condition after releasing the o oncerning set timing er reception: Cannot be set to 1 during transfer. been cleared to 0 and slave has be er transmission: A start condition cannot be generate the wait period that follows output o re set to 1 at the same time as SPT0. TT0 to 1 and then setting it again before it is cleared for clearing (STT0 = 0) by setting SST0 to 1 while communication on is prohibited. by lAREL0 = 1 (exit from communications) CE0 = 0 (operation stop)			

**Note** This flag's signal is invalid when IICE0 = 0.

Remarks 1. Bit 1 (STT0) becomes 0 when it is read after data setting.

- 2. IICRSV: Bit 0 of IIC flag register (IICF0)
  - STCF: Bit 7 of IIC flag register (IICF0)



Figure 14-5.	Format of IIC Control	ol Register 0 (IICC0) (4/4)
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SPT0	Stop condition trigger			
0	Stop condition is not generated.			
1	Stop condition is generated (termination of master device's transfer). After the SDA0 line goes to low level, either set the SCL0 line to high level or wait until it goes to high level. Next, after the rated amount of time has elapsed, the SDA0 line changes from low level to high level and a stop condition is generated.			
Cautions co	oncerning set timing			
<ul> <li>For master</li> </ul>	er reception: Cannot be set to 1 during transfer.			
	Can be set to 1 only in the waiting period when ACKE0 notified of final reception.	has been cleared to 0 and slave has been		
<ul> <li>For master</li> </ul>	er transmission: A stop condition cannot be generated normally during the wait period that follows output of the ninth clo	ne acknowledge period. Therefore, set it ock.		
Cannot be	e set to 1 at the same time as STT0.			
<ul> <li>SPT0 car</li> </ul>	n be set to 1 only when in master mode <sup>™ee</sup> .			
<ul> <li>When W1</li> </ul>	TIM0 has been cleared to 0, if SPT0 is set to 1 during the wait period that	follows output of eight clocks, note that a		
stop cond	lition will be generated during the high-level period of the ninth clock. W	ΓIM0 should be changed from 0 to 1 during		
the wait period following the output of eight clocks, and SPT0 should be set to 1 during the wait period that follows the output				
of the nin	of the ninth clock.			
Setting SPT0 to 1 and then setting it again before it is cleared to 0 is prohibited.				
Condition for	Condition for clearing (SPT0 = 0) Condition for setting (SPT0 = 1)			
Cleared b	Cleared by loss in arbitration     Set by instruction			
Automatically cleared after stop condition is detected				
Cleared b	<ul> <li>Cleared by LREL0 = 1 (exit from communications)</li> </ul>			
<ul> <li>When IIC</li> </ul>	• When IICE0 = 0 (operation stop)			
<ul> <li>Reset</li> </ul>				

- **Note** Set SPT0 to 1 only in master mode. However, SPT0 must be set to 1 and a stop condition generated before the first stop condition is detected following the switch to the operation enabled status. For details, see **14.5.15 Cautions**.
- Caution When bit 3 (TRC0) of IIC status register 0 (IICS0) is set to 1, WREL0 is set to 1 during the ninth clock and wait is canceled, after which TRC0 is cleared and the SDA0 line is set to high impedance.

**Remark** Bit 0 (SPT0) becomes 0 when it is read after data setting.



# (2) IIC status register 0 (IICS0)

This register indicates the status of  $I^2C$ .

IICS0 is read by a 1-bit or 8-bit memory manipulation instruction only when STT0 = 1 and during the wait period.

Reset signal generation clears IICS0 to 00H.

# Caution If data is read from IICS0, a wait cycle is generated. Do not read data from IICS0 when the peripheral hardware clock (fPRs) is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.

#### Figure 14-6. Format of IIC Status Register 0 (IICS0) (1/3)

Address: FF	B5H	After reset:	00H R					
Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
IICS0	MSTS0	ALD0	EXC0	COI0	TRC0	ACKD0	STD0	SPD0

MSTS0	Master device status	
0	Slave device status or communication standby status	
1	Master device communication status	
Condition for clearing (MSTS0 = 0)		Condition for setting (MSTS0 = 1)
<ul> <li>When a stop condition is detected</li> <li>When ALD0 = 1 (arbitration loss)</li> <li>Cleared by LREL0 = 1 (exit from communications)</li> <li>When IICE0 changes from 1 to 0 (operation stop)</li> <li>Reset</li> </ul>		When a start condition is generated

ALD0	Detection of arbitration loss	
0	This status means either that there was no arbitration or that the arbitration result was a "win".	
1	This status indicates the arbitration result was a "loss". MSTS0 is cleared.	
Condition for clearing (ALD0 = 0)		Condition for setting (ALD0 = 1)
<ul> <li>Automatically cleared after IICS0 is read<sup>Note</sup></li> <li>When IICE0 changes from 1 to 0 (operation stop)</li> <li>Reset</li> </ul>		• When the arbitration result is a "loss".

EXC0	Detection of extension code reception	
0	Extension code was not received.	
1	Extension code was received.	
Condition for clearing (EXC0 = 0)		Condition for setting (EXC0 = 1)
<ul> <li>When a start condition is detected</li> <li>When a stop condition is detected</li> <li>Cleared by LREL0 = 1 (exit from communications)</li> <li>When IICE0 changes from 1 to 0 (operation stop)</li> <li>Reset</li> </ul>		• When the higher four bits of the received address data is either "0000" or "1111" (set at the rising edge of the eighth clock).

**Note** This register is also cleared when a 1-bit memory manipulation instruction is executed for bits other than IICS0. Therefore, when using the ALD0 bit, read the data of this bit before the data of the other bits.

Remark LREL0: Bit 6 of IIC control register 0 (IICC0) IICE0: Bit 7 of IIC control register 0 (IICC0)



# Figure 14-6. Format of IIC Status Register 0 (IICS0) (2/3)

COI0	Detection of matching addresses		
0	Addresses do not match.		
1	Addresses match.		
Condition for clearing (COI0 = 0)		Condition for setting (COI0 = 1)	
<ul> <li>When a start condition is detected</li> <li>When a stop condition is detected</li> <li>Cleared by LREL0 = 1 (exit from communications)</li> <li>When IICE0 changes from 1 to 0 (operation stop)</li> <li>Reset</li> </ul>		• When the received address matches the local address (slave address register 0 (SVA0)) (set at the rising edge of the eighth clock).	

TRC0	Detection of transmit/receive status		
0	Receive status (other than transmit status). The SDA0 line is set for high impedance.		
1	Transmit status. The value in the SO0 latch is enabled for output to the SDA0 line (valid starting at the falling edge of the first byte's ninth clock).		
Condition for	or clearing (TRC0 = 0)	Condition for setting (TRC0 = 1)	
<both mast<="" td=""><td>er and slave&gt;</td><td><master></master></td></both>	er and slave>	<master></master>	
Condition for clearing (TRC0 = 0) <both and="" master="" slave=""> • When a stop condition is detected • Cleared by LREL0 = 1 (exit from communications) • When IICE0 changes from 1 to 0 (operation stop) • Cleared by WREL0 = 1<sup>Note</sup> (wait cancel) • When ALD0 changes from 0 to 1 (arbitration loss) • Reset <master> • When "1" is output to the first byte's LSB (transfer direction specification bit) <slave> • When a start condition is detected • When "0" is input to the first byte's LSB (transfer direction specification bit)</slave></master></both>		<ul> <li>When a start condition is generated</li> <li>When "0" is output to the first byte's LSB (transfer direction specification bit)</li> <li><slave></slave></li> <li>When "1" is input to the first byte's LSB (transfer direction specification bit)</li> </ul>	
<pre><when communication="" for="" not="" used=""></when></pre>			

- **Note** If the wait state is canceled by setting bit 5 (WREL0) of IIC control register 0 (IICC0) to 1 at the ninth clock when bit 3 (TRC0) of IIC status register 0 (IICS0) is 1, TRC0 is cleared, and the SDA0 line goes into a high-impedance state.
- Remark
   LREL0:
   Bit 6 of IIC control register 0 (IICC0)

   IICE0:
   Bit 7 of IIC control register 0 (IICC0)



# Figure 14-6. Format of IIC Status Register 0 (IICS0) (3/3)

ACKD0	Detection of acknowledge (ACK)	
0	Acknowledge was not detected.	
1	Acknowledge was detected.	
Condition for clearing (ACKD0 = 0)		Condition for setting (ACKD0 = 1)
<ul> <li>When a stop condition is detected</li> <li>At the rising edge of the next byte's first clock</li> <li>Cleared by LREL0 = 1 (exit from communications)</li> <li>When IICE0 changes from 1 to 0 (operation stop)</li> <li>Reset</li> </ul>		After the SDA0 line is set to low level at the rising edge of SCL0's ninth clock

STD0	Detection of start condition	
0	Start condition was not detected.	
1	Start condition was detected. This indicates that the address transfer period is in effect.	
Condition for clearing (STD0 = 0)		Condition for setting (STD0 = 1)
<ul> <li>When a stop condition is detected</li> <li>At the rising edge of the next byte's first clock following address transfer</li> <li>Cleared by LREL0 = 1 (exit from communications)</li> <li>When IICE0 changes from 1 to 0 (operation stop)</li> <li>Reset</li> </ul>		• When a start condition is detected

SPD0	Detection of stop condition	
0	Stop condition was not detected.	
1	Stop condition was detected. The master device's communication is terminated and the bus is released.	
Condition for clearing (SPD0 = 0)		Condition for setting (SPD0 = 1)
<ul> <li>At the rising edge of the address transfer byte's first clock following setting of this bit and detection of a start condition</li> <li>When IICE0 changes from 1 to 0 (operation stop)</li> <li>Reset</li> </ul>		When a stop condition is detected

 Remark
 LREL0:
 Bit 6 of IIC control register 0 (IICC0)

 IICE0:
 Bit 7 of IIC control register 0 (IICC0)



# (3) IIC flag register 0 (IICF0)

This register sets the operation mode of  $l^2C$  and indicates the status of the  $l^2C$  bus.

IICF0 is set by a 1-bit or 8-bit memory manipulation instruction. However, the STCF and IICBSY bits are readonly.

The IICRSV bit can be used to enable/disable the communication reservation function (see **14.5.14 Communication reservation**).

STCEN can be used to set the initial value of the IICBSY bit (see 14.5.15 Cautions).

IICRSV and STCEN can be written only when the operation of  $I^2C$  is disabled (bit 7 (IICE0) of IIC control register 0 (IICC0) = 0). When operation is enabled, the IICF0 register can be read.

Reset signal generation clears IICF0 to 00H.


Generating start condition unsuccessful and STT0

cleared to 0 when communication reservation is

disabled (IICRSV = 1).

Address	: FFB7H	After rea	set: 00H	R/W <sup>Note</sup>					
Symbol	<7>	<6>	5	4	3	2	<1>	<0>	
IICF0	STCF	IICBSY	0	0	0	0	STCEN	IICRSV	
	STCF	STT0 clear flag							
	0	Generate start condition							
	1	Start condition generation unsuccessful: clear STT0 flag							
	Condition	for clearing (STCF = 0) Condition for setting (STCF = 1)							

## Figure 14-7. Format of IIC Flag Register 0 (IICF0)

IICBSY	l <sup>2</sup> C bus status flag					
0	Bus release status (communication initial status when STCEN = 1)					
1	Bus communication status (communication	initial status when STCEN = 0)				
Conditior	n for clearing (IICBSY = 0)	Condition for setting (IICBSY = 1)				
<ul><li>Detect</li><li>When</li><li>Reset</li></ul>	ion of stop condition IICE0 = 0 (operation stop)	<ul> <li>Detection of start condition</li> <li>Setting of IICE0 when STCEN = 0</li> </ul>				

STCEN	Initial start enable trigger				
0	After operation is enabled (IICE0 = 1), enable generation of a start condition upon detection of a stop condition.				
1	After operation is enabled (IICE0 = 1), enable generation of a start condition without detecting a stop condition.				
Condition	for clearing (STCEN = 0)	Condition for setting (STCEN = 1)			
<ul><li>Detection</li><li>Reset</li></ul>	on of start condition	Set by instruction			

IICRSV	Communication reservation function disable bit				
0	Enable communication reservation				
1	Disable communication reservation				
Condition	for clearing (IICRSV = 0)	Condition for setting (IICRSV = 1)			
<ul><li>Cleared by instruction</li><li>Reset</li></ul>		Set by instruction			

**Note** Bits 6 and 7 are read-only.

Cleared by STT0 = 1

Reset

When IICE0 = 0 (operation stop)

Cautions 1. Write to STCEN only when the operation is stopped (IICE0 = 0).

- 2. As the bus release status (IICBSY = 0) is recognized regardless of the actual bus status when STCEN = 1, when generating the first start condition (STT0 = 1), it is necessary to verify that no third party communications are in progress in order to prevent such communications from being destroyed.
- 3. Write to IICRSV only when the operation is stopped (IICE0 = 0).

Remark STT0: Bit 1 of IIC control register 0 (IICC0) IICE0: Bit 7 of IIC control register 0 (IICC0)

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# (4) IIC clock selection register 0 (IICCL0)

This register is used to set the transfer clock for the I<sup>2</sup>C bus.

IICCL0 is set by a 1-bit or 8-bit memory manipulation instruction. However, the CLD0 and DAD0 bits are readonly. The SMC0, CL01, and CL00 bits are set in combination with bit 0 (CLX0) of IIC function expansion register 0 (IICX0) (see (6)  $l^2C$  transfer clock setting method).

Set IICCL0 while bit 7 (IICE0) of IIC control register 0 (IICC0) is 0.

Reset signal generation clears IICCL0 to 00H.

# Figure 14-8. Format of IIC Clock Selection Register 0 (IICCL0)

Address: FF	ВЗН	After reset: 0	0H R/W	Note				
Symbol	7	6	<5>	<4>	<3>	<2>	1	0
IICCL0	0	0	CLD0	DAD0	SMC0	DFC0	CL01	CL00

CLD0	Detection of SCL0 pin level (valid only when IICE0 = 1)			
0	The SCL0 pin was detected at low level.			
1	The SCL0 pin was detected at high level.			
Condition for clearing (CLD0 = 0)		Condition for setting (CLD0 = 1)		
<ul><li>When the</li><li>When IIC</li><li>Reset</li></ul>	e SCL0 pin is at low level E0 = 0 (operation stop)	When the SCL0 pin is at high level		

DAD0	Detection of SDA0 pin level (valid only when IICE0 = 1)				
0	The SDA0 pin was detected at low level.				
1	The SDA0 pin was detected at high level.				
Condition f	or clearing (DAD0 = 0)	Condition for setting (DAD0 = 1)			
<ul><li>When the</li><li>When IIC</li><li>Reset</li></ul>	<ul> <li>SDA0 pin is at low level</li> <li>E0 = 0 (operation stop)</li> </ul>	When the SDA0 pin is at high level			

SMC0	Operation mode switching
0	Operates in standard mode.
1	Operates in high-speed mode.

DFC0	Digital filter operation control				
0	Digital filter off.				
1	Digital filter on.				
Digital filter In high-spe	Digital filter can be used only in high-speed mode. In high-speed mode, the transfer clock does not vary regardless of DFC0 bit set (1)/clear (0).				
The shall all of the standard for an effective for the black second se					

The digital filter is used for noise elimination in high-speed mode.

**Note** Bits 4 and 5 are read-only.

Remark IICE0: Bit 7 of IIC control register 0 (IICC0)



# (5) IIC function expansion register 0 (IICX0)

This register sets the function expansion of  $I^2C$ .

IICX0 is set by a 1-bit or 8-bit memory manipulation instruction. The CLX0 bit is set in combination with bits 3, 1, and 0 (SMC0, CL01, and CL00) of IIC clock selection register 0 (IICCL0) (see (6)  $I^2C$  transfer clock setting method).

Set IICX0 while bit 7 (IICE0) of IIC control register 0 (IICC0) is 0. Reset signal generation clears IICX0 to 00H.

# Figure 14-9. Format of IIC Function Expansion Register 0 (IICX0)

Address: FF	B4H	After reset: 0	0H R/W	1				
Symbol	7	6	5	4	3	2	1	<0>
IICX0	0	0	0	0	0	0	0	CLX0



# (6) I<sup>2</sup>C transfer clock setting method

The I<sup>2</sup>C transfer clock frequency (fscL) is calculated using the following expression.

 $f_{SCL} = 1/(m \times T + t_R + t_F)$ 

m = 12, 18, 24, 44, 66, 86 (see Table 14-2. Selection Clock Setting)

- T: 1/fw
- tR: SCL0 rise time
- tF: SCL0 fall time

For example, the  $l^2C$  transfer clock frequency (fscL) when fw = fPRS/2 = 4.19 MHz, m = 86, tR = 200 ns, and tF = 50 ns is calculated using following expression.

 $\text{fscl} = 1/(88 \times 238.7 \text{ ns} + 200 \text{ ns} + 50 \text{ ns}) \cong 48.1 \text{ kHz}$ 





The selection clock is set using a combination of bits 3, 1, and 0 (SMC0, CL01, and CL00) of IIC clock selection register 0 (IICCL0) and bit 0 (CLX0) of IIC function expansion register 0 (IICX0).

IICX0		IICCL0		Selection Clock	Transfer Clock	Settable Selection Clock	Operation Mode
Bit 0	Bit 3	Bit 1	Bit 0	(fw) <sup>Note</sup>	(fw/m)	(fw) Range	
CLX0	SMC0	CL01	CL00				
0	0	0	0	fprs/2	fw/44	2.00 to 4.19 MHz	Normal mode
0	0	0	1	fprs/2	fw/86	4.19 to 8.38 MHz	(SMC0 bit = 0)
0	0	1	0	fprs/4	fw/86		
0	0	1	1	Setting prohibited			
0	1	0	×	fprs/2	fw/24	4.00 to 8.38 MHz	High-speed mode
0	1	1	0	fprs/4	fw/24		(SMC0 bit = 1)
0	1	1	1	Setting prohibited			
1	0	×	×				
1	1	0	×	fprs/2	fw/12	4.00 to 4.19 MHz	High-speed mode
1	1	1	0	fprs/4	fw/12		(SMC0 bit = 1)
1	1	1	1	Setting prohibited			

Table 14-2. Selection Clock Setting	Table 14-2.	Selection	<b>Clock Setting</b>
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**Note** If the peripheral hardware clock (fPRS) operates on the internal high-speed oscillation clock (fIN) (XSEL = 0), set CLX0, SMC0, CL01 and CL00 as follows.

IICX0		IICCL0		Selection Clock	Transfer Clock	Settable Selection	Operation Mode
Bit 0	Bit 3	Bit 1	Bit 0	(fw)	(fw/m)	Clock (fw) Range	
CLX0	SMC0	CL01	CL00				
0	0	0	0	fprs/2	fw/44	3.8 MHz to 4.2 MHz	Normal mode (SMC0 bit = 0)
0	1	0	×	fprs/2	fw/24		High-speed mode (SMC0 bit = 1)

Caution Determine the transfer clock frequency of I<sup>2</sup>C by using CLX0, SMC0, CL01, and CL00 before enabling the operation (by setting bit 7 (IICE0) of IIC control register 0 (IICC0) to 1). To change the transfer clock frequency, clear IICE0 once to 0.

Remarks 1. ×: don't care

2. fPRS: Peripheral hardware clock frequency



# (7) Port mode register 6 (PM6)

This register sets the input/output of port 6 in 1-bit units.

When using the P60/SCL0 pin as clock I/O and the P61/SDA0 pin as serial data I/O, clear PM60 and PM61, and the output latches of P60 and P61 to 0.

Set IICE0 (bit 7 of IIC control register 0 (IICC0)) to 1 before setting the output mode because the P60/SCL0 and P61/SDA0 pins output a low level (fixed) when IICE0 is 0.

PM6 is set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets PM6 to FFH.

#### Figure 14-10. Format of Port Mode Register 6 (PM6)

Address:	FF26H	After reset: F	FH R/W					
Symbol	7	6	5	4	3	2	1	0
PM6	PM67	PM66	PM65	PM64	PM63	PM62	PM61	PM60

PM6n	P6n pin I/O mode selection (n = 0 to 7)			
0	Output mode (output buffer on)			
1	Input mode (output buffer off)			

## (8) Port register 6 (P6)

This register writes the data that is output from the chip when data is output from a port.

\_ . . .

If the data is read in the input mode, the pin level is read. If it is read in the output mode, the value of the output latch is read.

This register can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears this register to 00H.

### Figure 14-11. Format of Port Register 6 (P6)



P6n	n = 0 to 7					
	Output data control (In output mode)	Input data read (In input mode)				
0	Output 0	Input low level				
1	Output 1	Input high level				



# (9) Port output mode control register 6 (POM6)

This register sets the output mode of P60 and P61 in 1-bit units. During I<sup>2</sup>C communication, set P60/SCL0/INTP1 and P61/SDA0/INTP3 to N-ch open-drain output (5 V-torelant) mode. This register can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears this register to 00H.

# Figure 14-12. Format of Port Output Mode Control Register 6 (POM6)

Address:	FF0EH	After reset: C	0H R/W					
Symbol	7	6	5	4	3	2	1	0
POM6	0	0	0	0	0	0	POM61	POM60

POM6n	P6n pin output selection $(n = 0, 1)$			
0	CMOS output			
1	N-ch open-drain output (5 V-torelant)			



# 14.4 I<sup>2</sup>C Bus Mode Functions

# 14.4.1 Pin configuration

The serial clock pin (SCL0) and serial data bus pin (SDA0) are configured as follows.

- (1) SCL0.....This pin is used for serial clock input and output.
- This pin is an N-ch open-drain output for both master and slave devices. Input is Schmitt input. (2) SDA0 ......This pin is used for serial data input and output.

This pin is an N-ch open-drain output for both master and slave devices. Input is Schmitt input.

Since outputs from the serial clock line and the serial data bus line are N-ch open-drain outputs, an external pull-up resistor is required.



Figure 14-13. Pin Configuration Diagram



ACK

Stop

# 14.5 I<sup>2</sup>C Bus Definitions and Control Methods

The following section describes the l<sup>2</sup>C bus's serial data communication format and the signals used by the l<sup>2</sup>C bus. **Figure 14-14** shows the transfer timing for the "start condition", "address", "data", and "stop condition" output via the l<sup>2</sup>C bus's serial data bus.



Figure 14-14. I<sup>2</sup>C Bus Serial Data Transfer Timing

Start Address R/W ACK Data ACK Data

condition condition

The master device generates the start condition, slave address, and stop condition.

The acknowledge (ACK) can be generated by either the master or slave device (normally, it is output by the device that receives 8-bit data).

The serial clock (SCL0) is continuously output by the master device. However, in the slave device, the SCL0's low level period can be extended and a wait can be inserted.

## 14.5.1 Start conditions

A start condition is met when the SCL0 pin is at high level and the SDA0 pin changes from high level to low level. The start conditions for the SCL0 pin and SDA0 pin are signals that the master device generates to the slave device when starting a serial transfer. When the device is used as a slave, start conditions can be detected.

### Figure 14-15. Start Conditions



A start condition is output when bit 1 (STT0) of IIC control register 0 (IICC0) is set (to 1) after a stop condition has been detected (SPD0: Bit 0 = 1 in IIC status register 0 (IICS0)). When a start condition is detected, bit 1 (STD0) of IICS0 is set (to 1).



#### 14.5.2 Addresses

The address is defined by the 7 bits of data that follow the start condition.

An address is a 7-bit data segment that is output in order to select one of the slave devices that are connected to the master device via the bus lines. Therefore, each slave device connected via the bus lines must have a unique address.

The slave devices include hardware that detects the start condition and checks whether or not the 7-bit address data matches the data values stored in slave address register 0 (SVA0). If the address data matches the SVA0 values, the slave device is selected and communicates with the master device until the master device generates a start condition or stop condition.





**Note** INTIIC0 is not issued if data other than a local address or extension code is received during slave device operation.

The slave address and the eighth bit, which specifies the transfer direction as described in **14.5.3 Transfer direction specification** below, are together written to IIC shift register 0 (IIC0) and are then output. Received addresses are written to IIC0.

The slave address is assigned to the higher 7 bits of IIC0.

### 14.5.3 Transfer direction specification

In addition to the 7-bit address data, the master device sends 1 bit that specifies the transfer direction.

When this transfer direction specification bit has a value of "0", it indicates that the master device is transmitting data to a slave device. When the transfer direction specification bit has a value of "1", it indicates that the master device is receiving data from a slave device.



**Note** INTIIC0 is not issued if data other than a local address or extension code is received during slave device operation.

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## 14.5.4 Acknowledge (ACK)

ACK is used to check the status of serial data at the transmission and reception sides.

The reception side returns  $\overline{ACK}$  each time it has received 8-bit data.

The transmission side usually receives  $\overline{ACK}$  after transmitting 8-bit data. When  $\overline{ACK}$  is returned from the reception side, it is assumed that reception has been correctly performed and processing is continued. Whether  $\overline{ACK}$  has been detected can be checked by using bit 2 (ACKD0) of IIC status register 0 (IICS0).

When the master receives the last data item, it does not return  $\overline{ACK}$  and instead generates a stop condition. If a slave does not return  $\overline{ACK}$  after receiving data, the master outputs a stop condition or restart condition and stops transmission. If  $\overline{ACK}$  is not returned, the possible causes are as follows.

- <1> Reception was not performed normally.
- <2> The final data item was received.
- <3> The reception side specified by the address does not exist.

To generate ACK, the reception side makes the SDA0 line low at the ninth clock (indicating normal reception).

Automatic generation of  $\overline{ACK}$  is enabled by setting bit 2 (ACKE0) of IIC control register 0 (IICC0) to 1. Bit 3 (TRC0) of the IICS0 register is set by the data of the eighth bit that follows 7-bit address information. Usually, set ACKE0 to 1 for reception (TRC0 = 0).

If a slave can receive no more data during reception (TRC0 = 0) or does not require the next data item, then the slave must inform the master, by clearing ACKE0 to 0, that it will not receive any more data.

When the master does not require the next data item during reception (TRC0 = 0), it must clear ACKE0 to 0 so that  $\overline{ACK}$  is not generated. In this way, the master informs a slave at the transmission side that it does not require any more data (transmission will be stopped).



When the local address is received,  $\overline{ACK}$  is automatically generated, regardless of the value of ACKE0. When an address other than that of the local address is received,  $\overline{ACK}$  is not generated (NACK).

When an extension code is received, ACK is generated if ACKE0 is set to 1 in advance.

How ACK is generated when data is received differs as follows depending on the setting of the wait timing.

- When 8-clock wait state is selected (bit 3 (WTIM0) of IICC0 register = 0): By setting ACKE0 to 1 before releasing the wait state, ACK is generated at the falling edge of the eighth clock of the SCL0 pin.
- When 9-clock wait state is selected (bit 3 (WTIM0) of IICC0 register = 1):  $\overrightarrow{ACK}$  is generated by setting ACKE0 to 1 in advance.



# 14.5.5 Stop condition

When the SCL0 pin is at high level, changing the SDA0 pin from low level to high level generates a stop condition.

A stop condition is a signal that the master device generates to the slave device when serial transfer has been completed. When the device is used as a slave, stop conditions can be detected.

## Figure 14-19. Stop Condition



A stop condition is generated when bit 0 (SPT0) of IIC control register 0 (IICC0) is set to 1. When the stop condition is detected, bit 0 (SPD0) of IIC status register 0 (IICS0) is set to 1 and INTIIC0 is generated when bit 4 (SPIE0) of IICC0 is set to 1.



# 14.5.6 Wait

The wait is used to notify the communication partner that a device (master or slave) is preparing to transmit or receive data (i.e., is in a wait state).

Setting the SCL0 pin to low level notifies the communication partner of the wait state. When wait state has been canceled for both the master and slave devices, the next data transfer can begin.

## Figure 14-20. Wait (1/2)

# (1) When master device has a nine-clock wait and slave device has an eight-clock wait (master transmits, slave receives, and ACKE0 = 1)





# Figure 14-20. Wait (2/2)



# (2) When master and slave devices both have a nine-clock wait (master transmits, slave receives, and ACKE0 = 1)

Remark ACKE0: Bit 2 of IIC control register 0 (IICC0)

WREL0: Bit 5 of IIC control register 0 (IICC0)

A wait may be automatically generated depending on the setting of bit 3 (WTIM0) of IIC control register 0 (IICC0). Normally, the receiving side cancels the wait state when bit 5 (WREL0) of IICC0 is set to 1 or when FFH is written

to IIC shift register 0 (IIC0), and the transmitting side cancels the wait state when data is written to IIC0.

The master device can also cancel the wait state via either of the following methods.

- By setting bit 1 (STT0) of IICC0 to 1
- By setting bit 0 (SPT0) of IICC0 to 1



## 14.5.7 Canceling wait

The I<sup>2</sup>C usually cancels a wait state by the following processing.

- Writing data to IIC shift register 0 (IIC0)
- Setting bit 5 (WREL0) of IIC control register 0 (IICC0) (canceling wait)
- Setting bit 1 (STT0) of IIC0 register (generating start condition)<sup>№</sup>
- Setting bit 0 (SPT0) of IIC0 register (generating stop condition)<sup>Note</sup>

## Note Master only

When the above wait canceling processing is executed, the I<sup>2</sup>C cancels the wait state and communication is resumed.

To cancel a wait state and transmit data (including addresses), write the data to IICO.

To receive data after canceling a wait state, or to complete data transmission, set bit 5 (WREL0) of the IIC0 control register 0 (IICC0) to 1.

To generate a restart condition after canceling a wait state, set bit 1 (STT0) of IICC0 to 1.

To generate a stop condition after canceling a wait state, set bit 0 (SPT0) of IICC0 to 1.

Execute the canceling processing only once for one wait state.

If, for example, data is written to IIC0 after canceling a wait state by setting WREL0 to 1, an incorrect value may be output to SDA0 because the timing for changing the SDA0 line conflicts with the timing for writing IIC0.

In addition to the above, communication is stopped if IICE0 is cleared to 0 when communication has been aborted, so that the wait state can be canceled.

If the I<sup>2</sup>C bus has deadlocked due to noise, processing is saved from communication by setting bit 6 (LREL0) of IICC0, so that the wait state can be canceled.

### 14.5.8 Interrupt request (INTIIC0) generation timing and wait control

The setting of bit 3 (WTIM0) of IIC control register 0 (IICC0) determines the timing by which INTIIC0 is generated and the corresponding wait control, as shown in **Table 14-3**.

WTIM0	During Slave Device Operation			During	Master Device Ope	eration
	Address	Data Reception	Data Transmission	Address	Data Reception	Data Transmission
0	9 <sup>Notes 1, 2</sup>	8 <sup>Note 2</sup>	8 <sup>Note 2</sup>	9	8	8
1	9 <sup>Notes 1, 2</sup>	9 <sup>Note 2</sup>	9 <sup>Note 2</sup>	9	9	9

#### Table 14-3. INTIIC0 Generation Timing and Wait Control

- Notes 1. The slave device's INTIIC0 signal and wait period occurs at the falling edge of the ninth clock only when there is a match with the address set to slave address register 0 (SVA0). At this point, ACK is generated regardless of the value set to IICC0's bit 2 (ACKE0). For a slave device that has received an extension code, INTIIC0 occurs at the falling edge of the eighth clock. However, if the address does not match after restart, INTIIC0 is generated at the falling edge of the 9th clock, but wait does not occur.
  - 2. If the received address does not match the contents of slave address register 0 (SVA0) and extension code is not received, neither INTIIC0 nor a wait occurs.
- **Remark** The numbers in the table indicate the number of the serial clock's clock signals. Interrupt requests and wait control are both synchronized with the falling edge of these clock signals.

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## (1) During address transmission/reception

- Slave device operation: Interrupt and wait timing are determined depending on the conditions described in Notes 1 and 2 above, regardless of the WTIM0 bit.
- Master device operation: Interrupt and wait timing occur at the falling edge of the ninth clock regardless of the WTIM0 bit.

#### (2) During data reception

• Master/slave device operation: Interrupt and wait timing are determined according to the WTIM0 bit.

#### (3) During data transmission

• Master/slave device operation: Interrupt and wait timing are determined according to the WTIM0 bit.

### (4) Wait cancellation method

The four wait cancellation methods are as follows.

- Writing data to IIC shift register 0 (IIC0)
- Setting bit 5 (WREL0) of IIC control register 0 (IICC0) (canceling wait)
- Setting bit 1 (STT0) of IIC0 register (generating start condition)<sup>Note</sup>
- Setting bit 0 (SPT0) of IIC0 register (generating stop condition)<sup>Note</sup>

#### Note Master only.

When an 8-clock wait has been selected (WTIM0 = 0), the presence/absence of  $\overline{ACK}$  generation must be determined prior to wait cancellation.

### (5) Stop condition detection

INTIIC0 is generated when a stop condition is detected (only when SPIE0 = 1).

### 14.5.9 Address match detection method

In I<sup>2</sup>C bus mode, the master device can select a particular slave device by transmitting the corresponding slave address.

Address match can be detected automatically by hardware. An interrupt request (INTIIC0) occurs when a local address has been set to slave address register 0 (SVA0) and when the address set to SVA0 matches the slave address sent by the master device, or when an extension code has been received.

### 14.5.10 Error detection

In I<sup>2</sup>C bus mode, the status of the serial data bus (SDA0) during data transmission is captured by IIC shift register 0 (IIC0) of the transmitting device, so the IIC0 data prior to transmission can be compared with the transmitted IIC0 data to enable detection of transmission errors. A transmission error is judged as having occurred when the compared data values do not match.



# 14.5.11 Extension code

- (1) When the higher 4 bits of the receive address are either "0000" or "1111", the extension code reception flag (EXC0) is set to 1 for extension code reception and an interrupt request (INTIIC0) is issued at the falling edge of the eighth clock. The local address stored in slave address register 0 (SVA0) is not affected.
- (2) If "11110××0" is set to SVA0 by a 10-bit address transfer and "11110××0" is transferred from the master device, the results are as follows. Note that INTIIC0 occurs at the falling edge of the eighth clock.
  - Higher four bits of data match: EXC0 = 1
  - Seven bits of data match: COI0 = 1
  - Remark EXC0: Bit 5 of IIC status register 0 (IICS0) COI0: Bit 4 of IIC status register 0 (IICS0)
- (3) Since the processing after the interrupt request occurs differs according to the data that follows the extension code, such processing is performed by software.

If the extension code is received while a slave device is operating, then the slave device is participating in communication even if its address does not match.

For example, after the extension code is received, if you do not wish to operate the target device as a slave device, set bit 6 (LREL0) of the IIC control register 0 (IICC0) to 1 to set the standby mode for the next communication operation.

Slave Address	R/W Bit	Description
0000 000	0	General call address
1111 0 x x	0	10-bit slave address specification (for address authentication)
1111 0 x x	1	10-bit slave address specification (for read command issuance after address match)

#### Table 14-4. Bit Definitions of Main Extension Code

**Remark** For extension codes other than the above, refer to THE I<sup>2</sup>C-BUS SPECIFICATION published by NXP.



## 14.5.12 Arbitration

When several master devices simultaneously generate a start condition (when STT0 is set to 1 before STD0 is set to 1), communication among the master devices is performed as the number of clocks are adjusted until the data differs. This kind of operation is called arbitration.

When one of the master devices loses in arbitration, an arbitration loss flag (ALD0) in IIC status register 0 (IICS0) is set (1) via the timing by which the arbitration loss occurred, and the SCL0 and SDA0 lines are both set to high impedance, which releases the bus.

The arbitration loss is detected based on the timing of the next interrupt request (the eighth or ninth clock, when a stop condition is detected, etc.) and the ALD0 = 1 setting that has been made by software.

For details of interrupt request timing, see 14.5.17 Timing of I<sup>2</sup>C interrupt request (INTIIC0) occurrence.

Remark STD0: Bit 1 of IIC status register 0 (IICS0) STT0: Bit 1 of IIC control register 0 (IICC0)



Figure 14-21. Arbitration Timing Example



Status During Arbitration	Interrupt Request Generation Timing
During address transmission	At falling edge of eighth or ninth clock following byte transfer <sup>Note 1</sup>
Read/write data after address transmission	
During extension code transmission	
Read/write data after extension code transmission	
During data transmission	
During $\overline{ACK}$ transfer period after data transmission	
When restart condition is detected during data transfer	
When stop condition is detected during data transfer	When stop condition is generated (when SPIE0 = 1) <sup>Note 2</sup>
When data is at low level while attempting to generate a restart condition	At falling edge of eighth or ninth clock following byte transfer <sup>Note 1</sup>
When stop condition is detected while attempting to generate a restart condition	When stop condition is generated (when SPIE0 = $1$ ) <sup>Note 2</sup>
When data is at low level while attempting to generate a stop condition	At falling edge of eighth or ninth clock following byte transfer <sup>Note 1</sup>
When SCL0 is at low level while attempting to generate a restart condition	

Table 14-5. Status during Arbitration and Interrupt Request Generation Timing

- **Notes 1.** When WTIM0 (bit 3 of IIC control register 0 (IICC0)) = 1, an interrupt request occurs at the falling edge of the ninth clock. When WTIM0 = 0 and the extension code's slave address is received, an interrupt request occurs at the falling edge of the eighth clock.
  - 2. When there is a chance that arbitration will occur, set SPIE0 = 1 for master device operation.

**Remark** SPIE0: Bit 4 of IIC control register 0 (IICC0)

#### 14.5.13 Wakeup function

The I<sup>2</sup>C bus slave function is a function that generates an interrupt request signal (INTIIC0) when a local address and extension code have been received.

This function makes processing more efficient by preventing unnecessary INTIIC0 signal from occurring when addresses do not match.

When a start condition is detected, wakeup standby mode is set. This wakeup standby mode is in effect while addresses are transmitted due to the possibility that an arbitration loss may change the master device (which has generated a start condition) to a slave device.

However, when a stop condition is detected, bit 4 (SPIE0) of IIC control register 0 (IICC0) is set regardless of the wakeup function, and this determines whether interrupt requests are enabled or disabled.



## 14.5.14 Communication reservation

(1) When communication reservation function is enabled (bit 0 (IICRSV) of IIC flag register 0 (IICF0) = 0)

To start master device communications when not currently using a bus, a communication reservation can be made to enable transmission of a start condition when the bus is released. There are two modes under which the bus is not used.

- When arbitration results in neither master nor slave operation
- When an extension code is received and slave operation is disabled (ACK is not returned and the bus was released when bit 6 (LREL0) of IIC control register 0 (IICC0) was set to 1).

If bit 1 (STT0) of IICC0 is set to 1 while the bus is not used (after a stop condition is detected), a start condition is automatically generated and wait state is set.

If an address is written to IIC shift register 0 (IIC0) after bit 4 (SPIE0) of IICC0 was set to 1, and it was detected by generation of an interrupt request signal (INTIIC0) that the bus was released (detection of the stop condition), then the device automatically starts communication as the master. Data written to IIC0 before the stop condition is detected is invalid.

When STT0 has been set to 1, the operation mode (as start condition or as communication reservation) is determined according to the bus status.

- If the bus has been released......a start condition is generated
- If the bus has not been released (standby mode) ......communication reservation

Check whether the communication reservation operates or not by using MSTS0 (bit 7 of IIC status register 0 (IICS0)) after STT0 is set to 1 and the wait time elapses.

The wait periods, which should be set via software, are listed in **Table 14-6**.

CLX0	SMC0	CL01	CL00	Wait Period
0	0	0	0	46 clocks
0	0	0	1	86 clocks
0	0	1	0	172 clocks
0	0	1	1	34 clocks
0	1	0	0	30 clocks
0	1	0	1	
0	1	1	0	60 clocks
0	1	1	1	12 clocks
1	1	0	0	18 clocks
1	1	0	1	
1	1	1	0	36 clocks

#### Table 14-6. Wait Periods

Figure 14-22 shows the communication reservation timing.





## Figure 14-22. Communication Reservation Timing



Remark IIC0:	IIC shift register 0
--------------	----------------------

STT0: Bit 1 of IIC control register 0 (IICC0)

STD0: Bit 1 of IIC status register 0 (IICS0)

SPD0: Bit 0 of IIC status register 0 (IICS0)

Communication reservations are accepted via the following timing. After bit 1 (STD0) of IIC status register 0 (IICS0) is set to 1, a communication reservation can be made by setting bit 1 (STT0) of IIC control register 0 (IICC0) to 1 before a stop condition is detected.





Figure 14-24 shows the communication reservation protocol.





Figure 14-24. Communication Reservation Protocol

- **Note** The communication reservation operation executes a write to IIC shift register 0 (IIC0) when a stop condition interrupt request occurs.
- Remark
   STT0:
   Bit 1 of IIC control register 0 (IICC0)

   MSTS0:
   Bit 7 of IIC status register 0 (IICS0)

   IIC0:
   IIC shift register 0
- (2) When communication reservation function is disabled (bit 0 (IICRSV) of IIC flag register 0 (IICF0) = 1) When bit 1 (STT0) of IIC control register 0 (IICC0) is set to 1 when the bus is not used in a communication during bus communication, this request is rejected and a start condition is not generated. The following two statuses are included in the status where bus is not used.
  - When arbitration results in neither master nor slave operation
  - When an extension code is received and slave operation is disabled (ACK is not returned and the bus was released when bit 6 (LREL0) of IICC0 was set to 1)

To confirm whether the start condition was generated or request was rejected, check STCF (bit 7 of IICF0). The time shown in **Table 14-7** is required until STCF is set to 1 after setting STT0 = 1. Therefore, secure the time by software.

CL01	CL00	Wait Period
0	0	6 clocks
0	1	6 clocks
1	0	12 clocks
1	1	3 clocks

Table 14-7. Wait Periods

### 14.5.15 Cautions

(1) When STCEN (bit 1 of IIC flag register 0 (IICF0)) = 0

Immediately after  $l^2C$  operation is enabled (IICE0 = 1), the bus communication status (IICBSY (bit 6 of IICF0) = 1) is recognized regardless of the actual bus status. When changing from a mode in which no stop condition has been detected to a master device communication mode, first generate a stop condition to release the bus, then perform master device communication.

When using multiple masters, it is not possible to perform master device communication when the bus has not been released (when a stop condition has not been detected).

Use the following sequence for generating a stop condition.

- <1> Set IIC clock selection register 0 (IICCL0).
- <2> Set bit 7 (IICE0) of IIC control register 0 (IICC0) to 1.
- <3> Set bit 0 (SPT0) of IICC0 to 1.
- (2) When STCEN = 1

Immediately after  $I^2C$  operation is enabled (IICE0 = 1), the bus released status (IICBSY = 0) is recognized regardless of the actual bus status. To generate the first start condition (STT0 (bit 1 of IIC control register 0 (IICC0)) = 1), it is necessary to confirm that the bus has been released, so as to not disturb other communications.

(3) If other I<sup>2</sup>C communications are already in progress

If  $I^2C$  operation is enabled and the device participates in communication already in progress when the SDA0 pin is low and the SCL0 pin is high, the macro of  $I^2C$  recognizes that the SDA0 pin has gone low (detects a start condition). If the value on the bus at this time can be recognized as an extension code,  $\overline{ACK}$  is returned, but this interferes with other  $I^2C$  communications. To avoid this, start  $I^2C$  in the following sequence.

- <1> Clear bit 4 (SPIE0) of IICC0 to 0 to disable generation of an interrupt request signal (INTIIC0) when the stop condition is detected.
- <2> Set bit 7 (IICE0) of IICC0 to 1 to enable the operation of  $I^2C$ .
- <3> Wait for detection of the start condition.
- <4> Set bit 6 (LREL0) of IICC0 to 1 before ACK is returned (4 to 80 clocks after setting IICE0 to 1), to forcibly disable detection.
- (4) Determine the transfer clock frequency by using SMC0, CL01, CL00 (bits 3, 1, and 0 of IICL0), and CLX0 (bit 0 of IICX0) before enabling the operation (IICE0 = 1). To change the transfer clock frequency, clear IICE0 to 0 once.



- (5) Setting STT0 and SPT0 (bits 1 and 0 of IICC0) again after they are set and before they are cleared to 0 is prohibited.
- (6) When transmission is reserved, set SPIE0 (bit 4 of IICL0) to 1 so that an interrupt request is generated when the stop condition is detected. Transfer is started when communication data is written to IIC0 after the interrupt request is generated. Unless the interrupt is generated when the stop condition is detected, the device stops in the wait state because the interrupt request is not generated when communication is started. However, it is not necessary to set SPIE0 to 1 when MSTS0 (bit 7 of IICS0) is detected by software.

## 14.5.16 Communication operations

The following shows three operation procedures with the flowchart.

## (1) Master operation in single master system

The flowchart when using the 78K0/Dx2 microcontrollers as the master in a single master system is shown below.

This flowchart is broadly divided into the initial settings and communication processing. Execute the initial settings at startup. If communication with the slave is required, prepare the communication and then execute communication processing.

### (2) Master operation in multimaster system

In the I<sup>2</sup>C bus multimaster system, whether the bus is released or used cannot be judged by the I<sup>2</sup>C bus specifications when the bus takes part in a communication. Here, when data and clock are at a high level for a certain period (1 frame), the 78K0/Dx2 microcontrollers takes part in a communication with bus released state. This flowchart is broadly divided into the initial settings, communication waiting, and communication processing. The processing when the 78K0/Dx2 microcontrollers looses in arbitration and is specified as the slave is omitted here, and only the processing as the master is shown. Execute the initial settings at startup to take part in a communication. Then, wait for the communication request as the master or wait for the specification as the slave. The actual communication is performed in the communication processing, and it supports the transmission/reception with the slave and the arbitration with other masters.

### (3) Slave operation

An example of when the 78K0/Dx2 microcontrollers is used as the I<sup>2</sup>C bus slave is shown below. When used as the slave, operation is started by an interrupt. Execute the initial settings at startup, then wait for the INTIIC0 interrupt occurrence (communication waiting). When an INTIIC0 interrupt occurs, the communication status is judged and its result is passed as a flag over to the main processing. By checking the flags, necessary communication processing is performed.



#### (1) Master operation in single-master system

Figure 14-25. Master Operation in Single-Master System



- **Note** Release (SCL0 and SDA0 pins = high level) the I<sup>2</sup>C bus in conformance with the specifications of the product that is communicating. If EEPROM is outputting a low level to the SDA0 pin, for example, set the SCL0 pin in the output port mode, and output a clock pulse from the output port until the SDA0 pin is constantly at high level.
- **Remark** Conform to the specifications of the product that is communicating, with respect to the transmission and reception formats.

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## (2) Master operation in multi-master system





**Note** Confirm that the bus is released (CLD0 bit = 1, DAD0 bit = 1) for a specific period (for example, for a period of one frame). If the SDA0 pin is constantly at low level, decide whether to release the I<sup>2</sup>C bus (SCL0 and SDA0 pins = high level) in conformance with the specifications of the product that is communicating.





# Figure 14-26. Master Operation in Multi-Master System (2/3)





Figure 14-26. Master Operation in Multi-Master System (3/3)

- **Remarks 1.** Conform to the specifications of the product that is communicating, with respect to the transmission and reception formats.
  - 2. To use the device as a master in a multi-master system, read the MSTS0 bit each time interrupt INTIIC0 has occurred to check the arbitration result.
  - **3.** To use the device as a slave in a multi-master system, check the status by using the IICS0 and IICF0 registers each time interrupt INTIIC0 has occurred, and determine the processing to be performed next.

# (3) Slave operation

The processing procedure of the slave operation is as follows.

Basically, the slave operation is event-driven. Therefore, processing by the INTIIC0 interrupt (processing that must substantially change the operation status such as detection of a stop condition during communication) is necessary.

In the following explanation, it is assumed that the extension code is not supported for data communication. It is also assumed that the INTIIC0 interrupt servicing only performs status transition processing, and that actual data communication is performed by the main processing.



Therefore, data communication processing is performed by preparing the following three flags and passing them to the main processing instead of INTIIC0.

# <1> Communication mode flag

This flag indicates the following two communication statuses.

- Clear mode: Status in which data communication is not performed
- Communication mode: Status in which data communication is performed (from valid address detection to stop condition detection, no detection of ACK from master, address mismatch)

# <2> Ready flag

This flag indicates that data communication is enabled. Its function is the same as the INTIICO interrupt for ordinary data communication. This flag is set by interrupt servicing and cleared by the main processing. Clear this flag by interrupt servicing when communication is started. However, the ready flag is not set by interrupt servicing when the first data is transmitted. Therefore, the first data is transmitted without the flag being cleared (an address match is interpreted as a request for the next data).

# <3> Communication direction flag

This flag indicates the direction of communication. Its value is the same as TRC0.



The main processing of the slave operation is explained next.

Start serial interface IIC0 and wait until communication is enabled. When communication is enabled, execute communication by using the communication mode flag and ready flag (processing of the stop condition and start condition is performed by an interrupt. Here, check the status by using the flags).

The transmission operation is repeated until the master no longer returns ACK. If ACK is not returned from the master, communication is completed.

For reception, the necessary amount of data is received. When communication is completed,  $\overline{ACK}$  is not returned as the next data. After that, the master generates a stop condition or restart condition. Exit from the communication status occurs in this way.



Figure 14-27. Slave Operation Flowchart (1)

**Remark** Conform to the specifications of the product that is in communication, regarding the transmission and reception formats.

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An example of the processing procedure of the slave with the INTIIC0 interrupt is explained below (processing is performed assuming that no extension code is used). The INTIIC0 interrupt checks the status, and the following operations are performed.

- <1> Communication is stopped if the stop condition is issued.
- <2> If the start condition is issued, the address is checked and communication is completed if the address does not match. If the address matches, the communication mode is set, wait is cancelled, and processing returns from the interrupt (the ready flag is cleared).
- <3> For data transmit/receive, only the ready flag is set. Processing returns from the interrupt with the l<sup>2</sup>C bus remaining in the wait state.

Remark <1> to <3> above correspond to <1> to <3> in Figure 14-28 Slave Operation Flowchart (2).



Figure 14-28. Slave Operation Flowchart (2)



# 14.5.17 Timing of I<sup>2</sup>C interrupt request (INTIIC0) occurrence

The timing of transmitting or receiving data and generation of interrupt request signal INTIIC0, and the value of the IICS0 register when the INTIIC0 signal is generated are shown below.

 Remark
 ST:
 Start condition

 AD6 to AD0:
 Address

 R/W:
 Transfer direction specification

 ACK:
 Acknowledge

 D7 to D0:
 Data

 SP:
 Stop condition



## (1) Master device operation

# (a) Start ~ Address ~ Data ~ Data ~ Stop (transmission/reception)

(i) When WTIM0 = 0



(ii) When WTIM0 = 1



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# (b) Start ~ Address ~ Data ~ Start ~ Address ~ Data ~ Stop (restart)

(i) When WTIM0 = 0



(ii) When WTIM0 = 1



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## (c) Start ~ Code ~ Data ~ Data ~ Stop (extension code transmission)

# (i) When WTIM0 = 0



(ii) When WTIM0 = 1





# (2) Slave device operation (slave address data reception)

# (a) Start ~ Address ~ Data ~ Data ~ Stop

## (i) When WTIM0 = 0



## (ii) When WTIM0 = 1




# (b) Start ~ Address ~ Data ~ Start ~ Address ~ Data ~ Stop

# (i) When WTIM0 = 0 (after restart, matches with SVA0)



#### (ii) When WTIM0 = 1 (after restart, matches with SVA0)





## (c) Start ~ Address ~ Data ~ Start ~ Code ~ Data ~ Stop

#### (i) When WTIM0 = 0 (after restart, does not match address (= extension code))



## (ii) When WTIM0 = 1 (after restart, does not match address (= extension code))





### (d) Start ~ Address ~ Data ~ Start ~ Address ~ Data ~ Stop

#### (i) When WTIM0 = 0 (after restart, does not match address (= not extension code))



(ii) When WTIM0 = 1 (after restart, does not match address (= not extension code))





## (3) Slave device operation (when receiving extension code)

The device is always participating in communication when it receives an extension code.

#### (a) Start ~ Code ~ Data ~ Data ~ Stop

#### (i) When WTIM0 = 0







# (b) Start ~ Code ~ Data ~ Start ~ Address ~ Data ~ Stop

# (i) When WTIM0 = 0 (after restart, matches SVA0)



# (ii) When WTIM0 = 1 (after restart, matches SVA0)





## (c) Start ~ Code ~ Data ~ Start ~ Code ~ Data ~ Stop

## (i) When WTIM0 = 0 (after restart, extension code reception)



# (ii) When WTIM0 = 1 (after restart, extension code reception)





# (d) Start ~ Code ~ Data ~ Start ~ Address ~ Data ~ Stop

## (i) When WTIM0 = 0 (after restart, does not match address (= not extension code))



#### (ii) When WTIM0 = 1 (after restart, does not match address (= not extension code))





## (4) Operation without communication

(a) Start ~ Code ~ Data ~ Data ~ Stop



# (5) Arbitration loss operation (operation as slave after arbitration loss)

When the device is used as a master in a multi-master system, read the MSTS0 bit each time interrupt request signal INTIIC0 has occurred to check the arbitration result.

### (a) When arbitration loss occurs during transmission of slave address data





## (ii) When WTIM0 = 1



## (b) When arbitration loss occurs during transmission of extension code





## (ii) When WTIM0 = 1



### (6) Operation when arbitration loss occurs (no communication after arbitration loss)

When the device is used as a master in a multi-master system, read the MSTS0 bit each time interrupt request signal INTIIC0 has occurred to check the arbitration result.

#### (a) When arbitration loss occurs during transmission of slave address data (when WTIM0 = 1)





#### (b) When arbitration loss occurs during transmission of extension code



# (c) When arbitration loss occurs during transmission of data





## (ii) When WTIM0 = 1



# (d) When loss occurs due to restart condition during data transfer

(i) Not extension code (Example: unmatches with SVA0)





# (ii) Extension code



### (e) When loss occurs due to stop condition during data transfer





# (f) When arbitration loss occurs due to low-level data when attempting to generate a restart condition



# (i) When WTIM0 = 0





## (g) When arbitration loss occurs due to a stop condition when attempting to generate a restart condition

# (i) When WTIM0 = 0







## (h) When arbitration loss occurs due to low-level data when attempting to generate a stop condition



# (i) When WTIM0 = 0





# 14.6 Timing Charts

When using the l<sup>2</sup>C bus mode, the master device outputs an address via the serial bus to select one of several slave devices as its communication partner.

After outputting the slave address, the master device transmits the TRC0 bit (bit 3 of IIC status register 0 (IICS0)), which specifies the data transfer direction, and then starts serial communication with the slave device.

Figures 14-29 and 14-30 show timing charts of the data communication.

IIC shift register 0 (IIC0)'s shift operation is synchronized with the falling edge of the serial clock (SCL0). The transmit data is transferred to the SO0 latch and is output (MSB first) via the SDA0 pin.

Data input via the SDA0 pin is captured into IIC0 at the rising edge of SCL0.



# Figure 14-29. Example of Master to Slave Communication (When 9-Clock Wait Is Selected for Both Master and Slave) (1/3)

# (1) Start condition ~ address



Notes 1. Write data to IIC0, not setting WREL0, in order to cancel a wait state during master transmission.2. To cancel slave wait, write "FFH" to IIC0 or set WREL0.



# Figure 14-29. Example of Master to Slave Communication (When 9-Clock Wait Is Selected for Both Master and Slave) (2/3)





## (3) Stop condition



Notes 1. Write data to IIC0, not setting WREL0, in order to cancel a wait state during master transmission.2. To cancel slave wait, write "FFH" to IIC0 or set WREL0.

# Figure 14-30. Example of Slave to Master Communication (When 8-Clock Wait Is Selected for Master, 9-Clock Wait Is Selected for Slave) (1/3)

# (1) Start condition ~ address



Notes 1. To cancel master wait, write "FFH" to IIC0 or set WREL0.

2. Write data to IIC0, not setting WREL0, in order to cancel a wait state during slave transmission.



#### (2) Data



Notes 1. To cancel master wait, write "FFH" to IIC0 or set WREL0.

2. Write data to IIC0, not setting WREL0, in order to cancel a wait state during slave transmission.

Figure 14-30. Example of Slave to Master Communication (When 8-Clock and 9-Clock Wait Is Selected for Master, 9-Clock Wait Is Selected for Slave) (3/3)

#### (3) Stop condition



- 2. Write data to IIC0, not setting WREL0, in order to cancel a wait state during slave transmission.
- 3. If a wait state during slave transmission is canceled by setting WREL0, TRC0 will be cleared.

# CHAPTER 15 CAN CONTROLLER

# **15.1 Outline Description**

This product features an on-chip 1-channel CAN (Controller Area Network) controller that complies with CAN protocol as standardized in ISO 11898.

#### 15.1.1 Features

- Compliant with ISO 11898 and tested according to ISO/DIS 16845 (CAN conformance test)
- Standard frame and extended frame transmission/reception enabled
- Transfer rate: 1 Mbps max. (CAN clock input  $\ge$  8 MHz)
- 16 message buffers/1 channel
- Receive/transmit history list function
- Automatic block transmission function
- Multi-buffer receive block function
- Mask setting of four patterns is possible for each channel



# 15.1.2 Overview of functions

Table 15-1 presents an overview of the CAN controller functions.

Function	Details		
Protocol	CAN protocol ISO 11898 (standard and extended frame transmission/reception)		
Baud rate	Maximum 1 Mbps (CAN clock input ≥ 8 MHz)		
Data storage	Storing messages in the CAN RAM		
Number of messages	- 16 message buffers/1 channel		
	- Each message buffer can be set to be either a transmit message buffer or a receive message buffer.		
Message reception	- Unique ID can be set to each message buffer.		
	- Mask setting of four patterns is possible for each channel.		
	- A receive completion interrupt is generated each time a message is received and stored in a message buffer.		
	- Two or more receive message buffers can be used as a FIFO receive buffer (multi-buffer receive block function).		
	- Receive history list function		
Message transmission	- Unique ID can be set to each message buffer.		
	- Transmit completion interrupt for each message buffer		
	- Message buffer number 0 to 7 specified as the transmit message buffer can be used for automatic block transfer. Message transmission interval is programmable (automatic block transmission function (hereafter referred to as "ABT")).		
	- Transmission history list function		
Remote frame processing	Remote frame processing by transmit message buffer		
Time stamp function	- The time stamp function can be set for a message reception when a 16-bit timer is used in combination.		
	Time stamp capture trigger can be selected (SOF or EOF in a CAN message frame can be detected.).		
Diagnostic function	- Readable error counters		
	- "Valid protocol operation flag" for verification of bus connections		
	- Receive-only mode		
	- Single-shot mode		
	- CAN protocol error type decoding		
	- Self-test mode		
Forced release from bus-off state	- Forced release from bus-off (by ignoring timing constraint) possible by software.		
	- No automatic release from bus-off (software must re-enable).		
Power save mode	- CAN sleep mode (can be woken up by CAN bus)		
	- CAN stop mode (cannot be woken up by CAN bus)		

Caution To use the CAN controller, set P70 to 1.



### 15.1.3 Configuration

The CAN controller is composed of the following four blocks.

(1) NPB interface

This functional block provides an NPB (NEC peripheral I/O bus) interface and means of transmitting and receiving signals between the CAN module and the host CPU.

(2) MCM (Message Control Module)

This functional block controls access to the CAN protocol layer and to the CAN RAM within the CAN module.

(3) CAN protocol layer

This functional block is involved in the operation of the CAN protocol and its related settings.

(4) CAN RAM

This is the CAN memory functional block, which is used to store message IDs, message data, etc.







# 15.2 CAN Protocol

CAN (Controller Area Network) is a high-speed multiplex communication protocol for real-time communication in automotive applications (class C). CAN is prescribed by ISO 11898. For details, refer to the ISO 11898 specifications. The CAN specification is generally divided into two layers: a physical layer and a data link layer. In turn, the data

link layer includes logical link and medium access control. The composition of these layers is illustrated below.

Figure 15-2. Composition of Layers

Higher	Data link	Logical link control (LLC)	<ul><li>Acceptance filtering</li><li>Overload report</li><li>Recovery management</li></ul>
	layer <sup>Note</sup>	Medium access control (MAC)	<ul> <li>Data capsuled/not capsuled</li> <li>Frame coding (stuffing/not stuffing)</li> <li>Medium access management</li> <li>Error detection</li> <li>Error report</li> <li>Acknowledgement</li> </ul>
Lower	Physical layer		Prescription of signal level and bit description

Note CAN controller specification

#### 15.2.1 Frame format

- (1) Standard format frame
  - The standard format frame uses 11-bit identifiers, which means that it can handle up to 2048 messages.
- (2) Extended format frame
  - The extended format frame uses 29-bit (11 bits + 18 bits) identifiers which increase the number of messages that can be handled to 2048 x 218 messages.
  - Extended format frame is set when "recessive level" (CMOS level equals "1") is set for both the SRR and IDE bits in the arbitration field.



### 15.2.2 Frame types

The following four types of frames are used in the CAN protocol.

#### Table 15-2. Frame Types

Frame Type	Description	
Data frame	Frame used to transmit data	
Remote frame	Frame used to request a data frame	
Error frame	Frame used to report error detection	
Overload frame	Frame used to delay the next data frame or remote frame	

#### (1) Bus value

The bus values are divided into dominant and recessive.

- Dominant level is indicated by logical 0.
- Recessive level is indicated by logical 1.
- When a dominant level and a recessive level are transmitted simultaneously, the bus value becomes dominant level.

# 15.2.3 Data frame and remote frame

(1) Data frame

A data frame is composed of seven fields.

# Figure 15-3. Data Frame







# (2) Remote frame

A remote frame is composed of six fields.

### Figure 15-4. Remote Frame



- Remarks 1. The data field is not transferred even if the control field's data length code is not "0000B".
  - **2.** D: Dominant = 0
    - R: Recessive = 1

## (3) Description of fields

#### <1> Start of frame (SOF)

The start of frame field is located at the start of a data frame or remote frame.

#### Figure 15-5. Start of Frame (SOF)



Remark D: Dominant = 0 R: Recessive = 1

- If dominant level is detected in the bus idle state, a hard-synchronization is performed (the current TQ is assigned to be the SYNC segment).
- If dominant level is sampled at the sample point following such a hard-synchronization, the bit is assigned to be a SOF. If recessive level is detected, the protocol layer returns to the bus idle state and regards the preceding dominant pulse as a disturbance only. No error frame is generated in such case.

#### <2> Arbitration field

The arbitration field is used to set the priority, data frame/remote frame, and frame format.

#### Figure 15-6. Arbitration Field (in Standard Format Mode)



2. An identifier is transmitted MSB first.

Remark D: Dominant = 0 R: Recessive = 1





Cautions 1. ID28 to ID18 are identifiers. 2. An identifier is transmitted MSB first.

Remark D: Dominant = 0 R: Recessive = 1

Fable 15-3.       RTR Frame Setting
-------------------------------------

Frame Type	RTR Bit
Data frame	0 (D)
Remote frame	1 (R)

#### Table 15-4. Frame Format Setting (IDE Bit) and Number of Identifier (ID) Bits

Frame Format	SRR Bit	IDE Bit	Number. of Bits
Standard format mode	None	0 (D)	11 bits
Extended format mode	1 (R)	1 (R)	29 bits



# <3> Control field

The control field sets "N" as the number of data bytes in the data field (N = 0 to 8).

### Figure 15-8. Control Field



Remark D: Dominant = 0 R: Recessive = 1

In a standard format frame, the control field's IDE bit is the same as the r1 bit.

Data Length Code			Data Byte Count	
DLC3	DLC2	DLC1	DLC0	
0	0	0	0	0 bytes
0	0	0	1	1 byte
0	0	1	0	2 bytes
0	0	1	1	3 bytes
0	1	0	0	4 bytes
0	1	0	1	5 bytes
0	1	1	0	6 bytes
0	1	1	1	7 bytes
1	0	0	0	8 bytes
Other than above			8 bytes regardless of the value of DLC3 to DLC0	

Table 15-5. Data Length Setting

Caution In the remote frame, there is no data field even if the data length code is not 0000B.



#### <4> Data field

The data field contains the amount of data (byte units) set by the control field. Up to 8 units of data can be set.





#### <5> CRC field

The CRC field is a 16-bit field that is used to check for errors in transmit data.

#### Figure 15-10. CRC Field



Remark D: Dominant = 0 R: Recessive = 1

- The polynomial P(X) used to generate the 15-bit CRC sequence is expressed as follows.  $P(X) = X^{15} + X^{14} + X^{10} + X^8 + X^7 + X^4 + X^3 + 1$
- Transmitting node: Transmits the CRC sequence calculated from the data (before bit stuffing) in the start of frame, arbitration field, control field, and data field.
- Receiving node: Compares the CRC sequence calculated using data bits that exclude the stuffing bits in the receive data with the CRC sequence in the CRC field. If the two CRC sequences do not match, the node issues an error frame.



# <6> ACK field

The ACK field is used to acknowledge normal reception.

## Figure 15-11. ACK Field



If no CRC error is detected, the receiving node sets the ACK slot to the dominant level. The transmitting node outputs two recessive-level bits.

#### <7> End of frame (EOF)

The end of frame field indicates the end of data frame/remote frame.

## Figure 15-12. End of Frame (EOF)





## <8> Interframe space

The interframe space is inserted after a data frame, remote frame, error frame, or overload frame to separate one frame from the next.

- The bus state differs depending on the error status.

#### (a) Error active node

The interframe space consists of a 3-bit intermission field and a bus idle field.

Figure 15-13. Interframe Space (Error Active Node)



**Remarks 1.** Bus idle: State in which the bus is not used by any node.

2. D: Dominant = 0

R: Recessive = 1

#### (b) Error passive node

The interframe space consists of an intermission field, a suspend transmission field, and a bus idle field.

Figure 15-14. Interframe Space (Error Passive Node)



Usually, the intermission field is 3 bits. If the transmitting node detects a dominant level at the third bit of the intermission field, however, it executes transmission.



## - Operation in error status

Table 15-6.	Operation	in Error	Status
-------------	-----------	----------	--------

Error Status	Operation	
Error active	A node in this status can transmit immediately after a 3-bit intermission.	
Error passive	A node in this status can transmit 8 bits after the intermission.	



# 15.2.4 Error frame

An error frame is output by a node that has detected an error.

## Figure 15-15. Error Frame



Remark D: Dominant = 0 R: Recessive = 1

No.	Name	Bit Count	Definition
<1>	Error flag1	6	Error active node: Outputs 6 dominant-level bits consecutively.
			Error passive node: Outputs 6 recessive-level bits consecutively.
			If another node outputs a dominant level while one node is outputting a passive error flag, the passive error flag is not cleared until the same level is detected 6 bits in a row.
<2>	Error flag2	0 to 6	Nodes receiving error flag 1 detect bit stuff errors and issues this error flag.
<3>	Error delimiter	8	Outputs 8 recessive-level bits consecutively.
			If a dominant level is detected at the 8th bit, an overload frame is transmitted from the next bit.
<4>	Error bit	-	The bit at which the error was detected.
			The error flag is output from the bit next to the error bit.
			In the case of a CRC error, this bit is output following the ACK delimiter.
<5>	Interframe space/overload frame	-	An interframe space or overload frame starts from here.5

Table 15-7.	Definition	Frror	Frame	Fields
	Deminion		riume	1 10103


# 15.2.5 Overload frame

An overload frame is transmitted under the following conditions.

- When the receiving node has not completed the reception operation<sup>Note</sup>
- If a dominant level is detected at the first two bits during intermission
- If a dominant level is detected at the last bit (7th bit) of the end of frame or at the last bit (8th bit) of the error delimiter/overload delimiter

Note The CAN is internally fast enough to process all received frames not generating overload frames.



Figure 15-16. Overload Frame

**Remark** D: Dominant = 0 R: Recessive = 1

No	Name	Bit Count	Definition
<1>	Overload flag	6	Outputs 6 dominant-level bits consecutively.
<2>	Overload flag from other node	0 to 6	The node that received an overload flag in the interframe space outputs an overload flag.
<3>	Overload delimiter	8	Outputs 8 recessive-level bits consecutively. If a dominant level is detected at the 8th bit, an overload frame is transmitted from the next bit.
<4>	Frame	-	Output following an end of frame, error delimiter, or overload delimiter.
<5>	Interframe space/overload frame	_	An interframe space or overload frame starts from here.

Table 15-8	Definition	of Overload	Frame	Fields
	Deminuon	or Overioau	гіаше	LIGIUS

Frame



# 15.3 Functions

# 15.3.1 Determining bus priority

- (1) When a node starts transmission:
  - During bus idle, the node that output data first transmits the data.
- (2) When more than one node starts transmission:
  - The node that outputs the dominant level for the longest consecutively from the first bit of the arbitration field acquires the bus priority (if a dominant level and a recessive level are simultaneously transmitted, the dominant level is taken as the bus value).
  - The transmitting node compares its output arbitration field and the data level on the bus.

# Table 15-9. Determining Bus Priority

Level match	Continuous transmission
Level mismatch	Stops transmission at the bit where mismatch is detected and starts reception at the following bit

(3) Priority of data frame and remote frame

- When a data frame and a remote frame are on the bus, the data frame has priority because its RTR bit, the last bit in the arbitration field, carries a dominant level.

# Caution If the extended-format data frame and the standard-format remote frame conflict on the bus (if ID28 to ID18 of both of them are the same), the standard-format remote frames takes priority.

# 15.3.2 Bit stuffing

Bit stuffing is used to establish synchronization by appending 1-bit inverted data if the same level continues for 5 bits, in order to prevent a burst error.

# Table 15-10. Bit Stuffing

Transmission	During the transmission of a data frame or remote frame, when the same level continues for 5 bits in the data between the start of frame and the ACK field, 1 inverted-level bit of data is inserted before the following bit.
Reception	During the reception of a data frame or remote frame, when the same level continues for 5 bits in the data between the start of frame and the ACK field, reception is continued after deleting the next bit.

# 15.3.3 Multi masters

As the bus priority (a node acquiring transmit functions) is determined by the identifier, any node can be the bus master.

# 15.3.4 Multi cast

Although there is one transmitting node, two or more nodes can receive the same data at the same time because the same identifier can be set to two or more nodes.

# 15.3.5 CAN sleep mode/CAN stop mode function

The CAN sleep mode/CAN stop mode function puts the CAN controller in waiting mode to achieve low power consumption.

The controller is woken up from the CAN sleep mode by bus operation but it is not woken up from the CAN stop mode by bus operation (the CAN stop mode is controlled by CPU access).



# 15.3.6 Error control function

# (1) Error types

Туре	Description of Er	ror	Detection State		
	Detection Method	Detection Condition	Transmission/ Reception	Field/Frame	
Bit error	Comparison of output level and level on the bus	Mismatch of levels	Transmitting/ receiving node	Bit that outputting data on the bus at the start of frame to end of frame, error frame and overload frame.	
Stuff error	Check the receive data at the stuff bit	6 consecutive bits of the same output level	Receiving node	Start of frame to CRC sequence	
CRC error	Comparison of the CRC sequence generated from the receive data and the received CRC sequence	Mismatch of CRC	Receiving node	CRC field	
Form error	Field/frame check of the fixed format	Detection of fixed format violation	Receiving node	CRC delimiter ACK field End of frame Error frame Overload frame	
ACK error	Check of the ACK slot by the transmitting node	Detection of recessive level in ACK slot	Transmitting node	ACK slot	

### Table 15-11. Error Types

### (2) Output timing of error frame

#### Table 15-12. Output Timing of Error Frame

Туре	Output Timing		
Bit error, stuff error, form error, ACK error	Error frame output is started at the timing of the bit following the detected error.		
CRC error	Error frame output is started at the timing of the bit following the ACK delimiter.		

#### (3) Processing in case of error

The transmission node re-transmits the data frame or remote frame after the error frame (However, it does not re-transmit the frame in the single-shot mode).



# (4) Error state

# (a) Types of error states

The following three types of error states are defined by the CAN specification.

- Error active
- Error passive
- Bus-off

These types of error states are classified by the values of the TEC7 to TEC0 bits (transmission error counter bits) and the REC6 to REC0 bits (reception error counter bits) of the CAN error counter register (C0ERC) as shown in **Table 15-13**.

The present error state is indicated by the CAN module information register (C0INFO).

When each error counter value becomes equal to or greater than the error warning level (96), the TECS0 or RECS0 bit of the COINFO register is set to 1. In this case, the bus state must be tested because it is considered that the bus has a serious fault. An error counter value of 128 or more indicates an error passive state and the TECS1 or RECS1 bit of the COINFO register is set to 1.

- If the value of the transmission error counter is greater than or equal to 256 (actually, the transmission error counter does not indicate a value greater than or equal to 256), the bus-off state is reached and the BOFF bit of the C0INFO register is set to 1.
- If only one node is active on the bus at startup (i.e., a particular case such as when the bus is connected only to the local station), ACK is not returned even if data is transmitted. Consequently, re-transmission of the error frame and data is repeated. In the error passive state, however, the transmission error counter is not incremented and the bus-off state is not reached.



Туре	Operation	Value of Error Counter	Indication of C0INFO Register	Operation specific to Given Error State	
Error active	Transmission	0-95	TECS1, TECS0 = 00	- Outputs an active error flag (6 consecutive	
	Reception	0-95	RECS1, RECS0 = 00	dominant-level bits) on detection of the	
	Transmission	96-127	TECS1, TECS0 = 01	enor.	
	Reception	96-127	RECS1, RECS0 = 01		
Error passive	Transmission	128-255	TECS1, TECS0 = 11	- Outputs a passive error flag (6 consecutive	
	Reception	128 or more	RECS1, RECS0 = 11	recessive-level bits) on detection of the error.	
				<ul> <li>Transmits 8 recessive-level bits, in between transmissions, following an intermission (suspend transmission).</li> </ul>	
Bus-off	Transmission	256 or more (not indicated) <sup>Note</sup>	BOFF = 1, TECS1, TECS0 = 11	<ul> <li>Communication is not possible. Messages are not stored when receiving frames, however, the following operations of &lt;1&gt;, &lt;2&gt;, and &lt;3&gt; are done.</li> <li>&lt;1&gt; TSOUT toggles.</li> <li>&lt;2&gt; REC is incremented/decremented.</li> <li>&lt;3&gt; VALID bit is set.</li> <li>If the CAN module is entered to the initialization mode and then transition request to any operation mode is made, and when 11 consecutive recessive-level bits are detected 128 times, the error counter is reset to 0 and the error active state can be restored.</li> </ul>	

Table 15-13.	Types of Error States
--------------	-----------------------

**Note** The value of the transmission error counter (TEC) is invalid when the BOFF bit is set to 1. If an error that increments the value of the transmission error counter by +8 while the counter value is in a range of 248 to 255, the counter is not incremented and the bus-off state is assumed.



#### (b) Error counter

The error counter counts up when an error has occurred, and counts down upon successful transmission and reception. The error counter is updated immediately after error detection.

State	Transmission Error Counter (TEC7 to TEC0)	Reception Error Counter (REC6 to REC0)
Receiving node detects an error (except bit error in the active error flag or overload flag).	No change	+1 (when REPS bit = 0)
Receiving node detects dominant level following error flag of error frame.	No change	+8 (when REPS bit = 0)
Transmitting node transmits an error flag.	+8	No change
[As exceptions, the error counter does not change in the following cases.]		
<1> ACK error is detected in error passive state and dominant level is not detected while the passive error flag is being output.		
<2> A stuff error is detected in an arbitration field that transmitted a recessive level as a stuff bit, but a dominant level is detected.		
Bit error detection while active error flag or overload flag is being output (error-active transmitting node)	+8	No change
Bit error detection while active error flag or overload flag is being output (error-active receiving node)	No change	+8 (when REPS bit = 0)
When the node detects 14 consecutive dominant-level bits from the beginning of the active error flag or overload flag, and then subsequently detects 8 consecutive dominant-level bits. When the node detects 8 consecutive dominant levels after a passive error flag	+8 (during transmission)	+8 (during reception, when REPS bit = 0)
When the transmitting node has completed transmission without error $(\pm 0 \text{ if error counter} = 0)$	-1	No change
When the receiving node has completed reception without error	No change	<ul> <li>-1 (1 ≤ REC6 to REC0 ≤ 127, when REPS bit = 0)</li> <li>±0 (REC6 to REC0 = 0, when REPS bit = 0)</li> <li>Value of 119 to 255 is set (when REPS bit = 1)</li> </ul>

#### Table 15-14. Error Counter

# (c) Occurrence of bit error in intermission

An overload frame is generated.

Caution If an error occurs, the error flag output (active or passive) is controlled according to the contents of the transmission error counter and reception error counter before the error occurred. The value of the error counter is incremented after the error flag has been output.



# (5) Recovery from bus-off state

When the CAN module is in the bus-off state, the CAN module permanently sets its output signals (CTxD) to recessive level.

The CAN module recovers from the bus-off state in the following bus-off recovery sequence.

- <1> A request to enter the CAN initialization mode
- <2> A request to enter a CAN operation mode
  - (a) Recovery operation through normal recovery sequence
  - (b) Forced recovery operation that skips recovery sequence

#### (a) Recovery operation from bus-off state through normal recovery sequence

The CAN module first issues a request to enter the initialization mode (refer to timing <1> in **Figure 15-17**). This request will be immediately acknowledged, and the OPMODE bits of the COCTRL register are cleared to 000B. Processing such as analyzing the fault that has caused the bus-off state, re-defining the CAN module and message buffer using application software, or stopping the operation of the CAN module can be performed by clearing the GOM bit to 0.

Next, the user requests to change the mode from the initialization mode to an operation mode (refer to timing <2> in **Figure 15-17**). This starts an operation to recover the CAN module from the bus-off state. The conditions under which the module can recover from the bus-off state are defined by the CAN protocol ISO 11898, and it is necessary to detect 11 consecutive recessive-level bits 128 times. At this time, the request to change the mode to an operation mode is held pending until the recovery conditions are satisfied. When the recovery conditions are satisfied (refer to timing <3> in **Figure 15-17**), the CAN module can enter the operation mode it has requested. Until the CAN module enters this operation mode, it stays in the initialization mode. Completion to be requested operation mode can be confirmed by reading the OPMODE bits of the COCTRL register.

During the bus-off period and bus-off recovery sequence, the BOFF bit of the C0INFO register stays set (to 1). In the bus-off recovery sequence, the reception error counter (REC[6:0]) counts the number of times 11 consecutive recessive-level bits have been detected on the bus. Therefore, the recovery state can be checked by reading REC[6:0].

- Cautions 1. If the Bus-off Recovery Sequence is interrupted by entering Initialization Mode and re-entering any Operation Mode, the Bus-off Recovery Sequence will restart from the beginning, and the waiting phase will be again 128 times 11 recessive-level bits, counted from this point.
  - 2. In the bus-off recovery sequence, REC [6:0] counts up (+1) each time 11 consecutive recessive-level bits have been detected. Even during the bus-off period, the CAN module can enter the CAN sleep mode or CAN stop mode. To start the bus-off recovery sequence, it is necessary to transit to the initialization mode once.

However, when the CAN module is in either CAN sleep mode or CAN stop mode, transition request to the initialization mode is not accepted, thus you have to release the CAN sleep mode first. In this case, as soon as the CAN sleep mode is released, the bus-off recovery sequence starts and no transition to initialization mode is necessary. If the CAN module detects a dominant edge on the CAN bus while in sleep mode even during bus-off, the sleep mode will be left and the bus-off recovery sequence will start (in the state that the CAN clock is supplied, it is necessary to clear the PSMODE by software after dominant edge detection).







#### (b) Forced recovery operation that skips bus-off recovery sequence

The CAN module can be forcibly released from the bus-off state, regardless of the bus state, by skipping the bus-off recovery sequence. Here is the procedure.

First, the CAN module requests to enter the initialization mode. For the operation and points to be noted at this time, refer to (a) Recovery operation from bus-off state through normal recovery sequence.

Next, the module requests to enter an operation mode. At the same time, the CCERC bit of the C0CTRL register must be set to 1.

As a result, the bus-off recovery sequence defined by the CAN protocol ISO 11898 is skipped, and the module immediately enters the operation mode. In this case, the module is connected to the CAN bus after it has monitored 11 consecutive recessive-level bits. For details, refer to the processing in **Figure 15-56. Bus-Off Recovery (Expect Normal Operation Mode with ABT)**.

# Caution This function is not defined by the CAN protocol ISO 11898. When using this function, thoroughly evaluate its effect on the network system.

(6) Initializing CAN module error counter register (C0ERC) in initialization mode

If it is necessary to initialize the CAN module error counter register (C0ERC) and CAN module information register (C0INFO) for debugging or evaluating a program, they can be initialized to the default value by setting the CCERC bit of the C0CTRL register in the initialization mode. When initialization has been completed, the CCERC bit is automatically cleared to 0.

# Cautions 1. This function is enabled only in the initialization mode. Even if the CCERC bit is set to 1 in a CAN operation mode, the C0ERC and C0INFO registers are not initialized.

2. The CCERC bit can be set at the same time as the request to enter a CAN operation mode.

### 15.3.7 Baud rate control function

#### (1) Prescaler

The CAN controller has a prescaler that divides the clock (fcan) supplied to CAN. This prescaler generates a CAN protocol layer basic clock (fr $\alpha$ ) derived from the CAN module system clock (fcanmod), and divided by 1 to 256 (refer to **15.7 (12) CAN Bit Rate Prescaler Register (C0BRP)**).

#### (2) Data bit time (8-25 time quanta)

One data bit time is defined as shown in Figure 15-18.

The CAN controller sets time segment 1, time segment 2, and reSynchronization Jump Width (SJW) as the parameter of data bit time, as shown in **Figure 15-18**. Time segment 1 is equivalent to the total of the propagation (prop) segment and phase segment 1 that are defined by the CAN protocol specification. Time segment 2 is equivalent to phase segment 2.



#### Figure 15-18. Segment Setting

Sample point (SPT)

Segment Name	Settable Range	Notes on Setting to Confirm to CAN Specification		
Time Segment 1 (TSEG1)	2TQ-16TQ	_		
Time Segment 2 (TSEG2)	1TQ-8TQ	IPT of the CAN controller is 0TQ. To conform to the CAN protocol specification, therefore, a length equal to phase segment 1 must be set here. This means that the length of time segment 1 minus 1TQ is the settable upper limit of time segment 2.		
Resynchronization jump width(SJW)	1TQ-4TQ	The length of time segment 1 minus 1TQ or 4 TQ, whichever is smaller.		

**Remark** IPT: Information Processing Time

TQ : Time Quanta



# Reference: The CAN standard ISO 11898 specification defines the segments constituting the data bit time as shown in Figure 15-19.

# Figure 15-19. Reference: Configuration of Data Bit Time Defined by CAN Specification



Sample point (SPT)

Segment Name	Segment Length	Description
Sync Segment (Synchronization Segment)	1	This segment starts at the edge where the level changes from recessive to dominant when hard-synchronization is established.
Prop Segment Programmable to 1 to 8 or more		This segment absorbs the delay of the output buffer, CAN bus, and input buffer.
		The length of this segment is set so that ACK is returned before the start of phase segment 1.
		Time of prop segment $\ge$ (Delay of output buffer) + 2 x (Delay of CAN bus) + (Delay of input buffer)
Phase Segment 1	Programmable to 1 to 8	This segment compensates for an error of data bit time.
Phase Segment 2	Phase Segment 1 or IPT, whichever greater	The longer this segment, the wider the permissible range but the slower the communication speed.
SJW	Programmable from 1TQ to length of segment 1 or 4TQ, whichever is smaller	This width sets the upper limit of expansion or contraction of the phase segment during resynchronization.

**Remark** IPT: Information Processing Time

TQ : Time Quanta



#### (3) Synchronizing data bit

- The receiving node establishes synchronization by a level change on the bus because it does not have a sync signal.
- The transmitting node transmits data in synchronization with the bit timing of the transmitting node.

#### (a) Hard-synchronization

This synchronization is established when the receiving node detects the start of frame in the interframe space.

- When a falling edge is detected on the bus, that TQ means the sync segment and the next segment is the prop segment. In this case, synchronization is established regardless of SJW.

#### Figure 15-20. Hard-synchronization at Recognition of Dominant Level during Bus Idle





# (b) Resynchronization

Synchronization is established again if a level change is detected on the bus during reception (only if a recessive level was sampled previously).

- The phase error of the edge is given by the relative position of the detected edge and sync segment.

<Sign of phase error>

0: If the edge is within the sync segment

Positive: If the edge is before the sample point (phase error)

Negative: If the edge is after the sample point (phase error)

If phase error is positive: Phase segment 1 is longer by specified SJW.

If phase error is negative: Phase segment 2 is shorter by specified SJW.

- The sample point of the data of the receiving node moves relatively due to the "discrepancy" in baud rate between the transmitting node and receiving node.



Figure 15-21. Resynchronization



# 15.4 Connection with Target System

The microcontroller incorporated a CAN has to be connected to the CAN bus using an external transceiver.

Figure 15-22. Connection to CAN Bus





# 15.5 Internal Registers of CAN Controller

# 15.5.1 CAN controller configuration

Table 15-15.	List of	CAN	Controller	Registers
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Item Register Name				
CAN global registers	CAN global control register (C0GMCTRL)			
	CAN global clock selection register (C0GMCS)			
	CAN global automatic block transmission control register (COGMABT)			
	CAN global automatic block transmission delay setting register (C0GMABTD)			
CAN module registers	CAN module mask 1 register (C0MASK1L, C0MASK1H)			
	CAN module mask 2 register (C0MASK2L, C0MASK2H)			
	CAN module mask3 register (C0MASK3L, C0MASK3H)			
	CAN module mask 4 registers (C0MASK4L, C0MASK4H)			
	CAN module control register (C0CTRL)			
	CAN module last error code register (C0LEC)			
	CAN module information register (C0INFO)			
	CAN module error counter register (C0ERC)			
	CAN module interrupt enable register (C0IE)			
	CAN module interrupt status register (C0INTS)			
	CAN module bit rate prescaler register (C0BRP)			
	CAN module bit rate register (C0BTR)			
	CAN module last in-pointer register (C0LIPT)			
	CAN module receive history list register (C0RGPT)			
	CAN module last out-pointer register (C0LOPT)			
	CAN module transmit history list register (C0TGPT)			
	CAN module time stamp register (C0TS)			
Message buffer registers	CAN message data byte 01 register m (C0MDATA01m)			
	CAN message data byte 0 register m (C0MDATA0m)			
	CAN message data byte 1 register m (C0MDATA1m)			
	CAN message data byte 23 register m (C0MDATA23m)			
	CAN message data byte 2 register m (C0MDATA2m)			
	CAN message data byte 3 Register m (C0MDATA3m)			
	CAN message data byte 45 Register m (C0MDATA45m)			
	CAN message data byte 4 Register m (C0MDATA4m)			
	CAN message data byte 5 Register m (C0MDATA5m)			
	CAN message data byte 67 Register m (C0MDATA67m)			
	CAN message data byte 6 register m (C0MDATA6m)			
	CAN message data byte 7 register m (C0MDATA7m)			
	CAN message data length register m (C0MDLCm)			
	CAN message configuration register m (C0MCONFm)			
	CAN message ID register m (C0MIDLm, C0MIDHm)			
	CAN message control register m (C0MCTRLm)			

Remarks 1. CAN global registers are identified by C0GM<register function>. CAN module registers are identified by C0<register function>. Message buffer registers are identified by C0M<register function>.

**2.** m = 0 to 15

# 15.5.2 Register access type

Address	Register Name	Symbol	R/W	Bit Ma	Bit Manipulation Units		Default Value
				1	8	16	
FA00H	CAN0 message data byte 01 register 00	C0MDATA0100	R/W			$\checkmark$	Undefined
FA00H	CAN0 message data byte 0 register 00	C0MDATA000			$\checkmark$		Undefined
FA01H	CAN0 message data byte 1 register 00	C0MDATA100			$\checkmark$		Undefined
FA02H	CAN0 message data byte 23 register 00	C0MDATA2300				$\checkmark$	Undefined
FA02H	CAN0 message data byte 2 register 00	C0MDATA200			$\checkmark$		Undefined
FA03H	CAN0 message data byte 3 register 00	C0MDATA300			$\checkmark$		Undefined
FA04H	CAN0 message data byte 45 register 00	C0MDATA4500				$\checkmark$	Undefined
FA04H	CAN0 message data byte 4 register 00	C0MDATA400			$\checkmark$		Undefined
FA05H	CAN0 message data byte 5 register 00	C0MDATA500			$\checkmark$		Undefined
FA06H	CAN0 message data byte 67 register 00	C0MDATA6700				$\checkmark$	Undefined
FA06H	CAN0 message data byte 6 register 00	C0MDATA600			$\checkmark$		Undefined
FA07H	CAN0 message data byte 7 register 00	C0MDATA700			$\checkmark$		Undefined
FA08H	CAN0 message data length code register 00	C0MDLC00			$\checkmark$		0000xxxxB
FA09H	CAN0 message configuration register 00	C0MCONF00			$\checkmark$		Undefined
FA0AH	CAN0 message ID register 00	C0MIDL00				$\checkmark$	Undefined
FA0CH		C0MIDH00				$\checkmark$	Undefined
FA0EH	CAN0 message control register 00	COMCTRL00				V	00x00000 000xx000B
FA10H	CAN0 message data byte 01 register 01	C0MDATA0101				$\checkmark$	Undefined
FA10H	CAN0 message data byte 0 register 01	C0MDATA001			$\checkmark$		Undefined
FA11H	CAN0 message data byte 1 register 01	C0MDATA101			$\checkmark$		Undefined
FA12H	CAN0 message data byte 23 register 01	C0MDATA2301				$\checkmark$	Undefined
FA12H	CAN0 message data byte 2 register 01	C0MDATA201			$\checkmark$		Undefined
FA13H	CAN0 message data byte 3 register 01	C0MDATA301			$\checkmark$		Undefined
FA14H	CAN0 message data byte 45 register 01	C0MDATA4501				$\checkmark$	Undefined
FA14H	CAN0 message data byte 4 register 01	C0MDATA401			$\checkmark$		Undefined
FA15H	CAN0 message data byte 5 register 01	C0MDATA501			$\checkmark$		Undefined
FA16H	CAN0 message data byte 67 register 01	C0MDATA6701				$\checkmark$	Undefined
FA16H	CAN0 message data byte 6 register 01	C0MDATA601			$\checkmark$		Undefined
FA17H	CAN0 message data byte 7 register 01	C0MDATA701			$\checkmark$		Undefined
FA18H	CAN0 message data length code register 01	C0MDLC01			$\checkmark$		0000xxxxB
FA19H	CAN0 message configuration register 01	C0MCONF01			$\checkmark$		Undefined
FA1AH	CAN0 message ID register 01	C0MIDL01				$\checkmark$	Undefined
FA1CH		C0MIDH01				$\checkmark$	Undefined
FA1EH	CAN0 message control register 01	C0MCTRL01				V	00x00000 000xx000B

# Table 15-16. Register Access Types (1/9)



Table 15-16.	<b>Register Access</b>	Types (2/9)
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Address	Register Name	Symbol	R/W	Bit Manipulation Units		Default Value	
				1	8	16	
FA20H	CAN0 message data byte 01 register 02	C0MDATA0102	R/W			$\checkmark$	Undefined
FA20H	CAN0 message data byte 0 register 02	C0MDATA002			$\checkmark$		Undefined
FA21H	CAN0 message data byte 1 register 02	C0MDATA102			$\checkmark$		Undefined
FA22H	CAN0 message data byte 23 register 02	C0MDATA2302				$\checkmark$	Undefined
FA22H	CAN0 message data byte 2 register 02	C0MDATA202			$\checkmark$		Undefined
FA23H	CAN0 message data byte 3 register 02	C0MDATA302			$\checkmark$		Undefined
FA24H	CAN0 message data byte 45 register 02	C0MDATA4502				$\checkmark$	Undefined
FA24H	CAN0 message data byte 4 register 02	C0MDATA402			$\checkmark$		Undefined
FA25H	CAN0 message data byte 5 register 02	C0MDATA502			$\checkmark$		Undefined
FA26H	CAN0 message data byte 67 register 02	C0MDATA6702				$\checkmark$	Undefined
FA26H	CAN0 message data byte 6 register 02	C0MDATA602			$\checkmark$		Undefined
FA27H	CAN0 message data byte 7 register 02	C0MDATA702			$\checkmark$		Undefined
FA28H	CAN0 message data length code register 02	C0MDLC02			$\checkmark$		0000xxxxB
FA29H	CAN0 message configuration register 02	C0MCONF02			$\checkmark$		Undefined
FA2AH	CAN0 message ID register 02	C0MIDL02				$\checkmark$	Undefined
FA2CH		C0MIDH02				$\checkmark$	Undefined
FA2EH	CAN0 message control register 02	COMCTRL02				$\checkmark$	00x00000 000xx000B
FA30H	CAN0 message data byte 01 register 03	C0MDATA0103				$\checkmark$	Undefined
FA30H	CAN0 message data byte 0 register 03	C0MDATA003			$\checkmark$		Undefined
FA31H	CAN0 message data byte 1 register 03	C0MDATA103			$\checkmark$		Undefined
FA32H	CAN0 message data byte 23 register 03	C0MDATA2303				$\checkmark$	Undefined
FA32H	CAN0 message data byte 2 register 03	C0MDATA203			$\checkmark$		Undefined
FA33H	CAN0 message data byte 3 register 03	C0MDATA303			$\checkmark$		Undefined
FA34H	CAN0 message data byte 45 register 03	C0MDATA4503				$\checkmark$	Undefined
FA34H	CAN0 message data byte 4 register 03	C0MDATA403			$\checkmark$		Undefined
FA35H	CAN0 message data byte 5 register 03	C0MDATA503			$\checkmark$		Undefined
FA36H	CAN0 message data byte 67 register 03	C0MDATA6703				$\checkmark$	Undefined
FA36H	CAN0 message data byte 6 register 03	C0MDATA603			$\checkmark$		Undefined
FA37H	CAN0 message data byte 7 register 03	C0MDATA703			$\checkmark$		Undefined
FA38H	CAN0 message data length code register 03	C0MDLC03			$\checkmark$		0000xxxxB
FA39H	CAN0 message configuration register 03	C0MCONF03			$\checkmark$		Undefined
<b>FA3AH</b>	CAN0 message ID register 03	C0MIDL03				$\checkmark$	Undefined
FA3CH		C0MIDH03				$\checkmark$	Undefined
<b>FA3EH</b>	CAN0 message control register 03	COMCTRL03					00x00000 000xx000B



Table 15-16.	<b>Register Access</b>	Types (3/9)
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Address	Register Name	Symbol	R/W	Bit Manipulation Units		Default Value	
				1	8	16	
FA40H	CAN0 message data byte 01 register 04	C0MDATA0104	R/W			$\checkmark$	Undefined
FA40H	CAN0 message data byte 0 register 04	C0MDATA004			$\checkmark$		Undefined
FA41H	CAN0 message data byte 1 register 04	C0MDATA104			$\checkmark$		Undefined
FA42H	CAN0 message data byte 23 register 04	C0MDATA2304				$\checkmark$	Undefined
FA42H	CAN0 message data byte 2 register 04	C0MDATA204			$\checkmark$		Undefined
FA43H	CAN0 message data byte 3 register 04	C0MDATA304			$\checkmark$		Undefined
FA44H	CAN0 message data byte 45 register 04	C0MDATA4504				$\checkmark$	Undefined
FA44H	CAN0 message data byte 4 register 04	C0MDATA404			$\checkmark$		Undefined
FA45H	CAN0 message data byte 5 register 04	C0MDATA504			$\checkmark$		Undefined
FA46H	CAN0 message data byte 67 register 04	C0MDATA6704				$\checkmark$	Undefined
FA46H	CAN0 message data byte 6 register 04	C0MDATA604			$\checkmark$		Undefined
FA47H	CAN0 message data byte 7 register 04	C0MDATA704			$\checkmark$		Undefined
FA48H	CAN0 message data length code register 04	C0MDLC04			$\checkmark$		0000xxxxB
FA49H	CAN0 message configuration register 04	C0MCONF04			$\checkmark$		Undefined
FA4AH	CAN0 message ID register 04	C0MIDL04				$\checkmark$	Undefined
FA4CH		C0MIDH04				$\checkmark$	Undefined
FA4EH	CAN0 message control register 04	COMCTRL04				$\checkmark$	00x00000 000xx000B
FA50H	CAN0 message data byte 01 register 05	C0MDATA0105				$\checkmark$	Undefined
FA50H	CAN0 message data byte 0 register 05	C0MDATA005			$\checkmark$		Undefined
FA51H	CAN0 message data byte 1 register 05	C0MDATA105			$\checkmark$		Undefined
FA52H	CAN0 message data byte 23 register 05	C0MDATA2305				$\checkmark$	Undefined
FA52H	CAN0 message data byte 2 register 05	C0MDATA205			$\checkmark$		Undefined
FA53H	CAN0 message data byte 3 register 05	C0MDATA305			$\checkmark$		Undefined
FA54H	CAN0 message data byte 45 register 05	C0MDATA4505				$\checkmark$	Undefined
FA54H	CAN0 message data byte 4 register 05	C0MDATA405			$\checkmark$		Undefined
FA55H	CAN0 message data byte 5 register 05	C0MDATA505			$\checkmark$		Undefined
FA56H	CAN0 message data byte 67 register 05	C0MDATA6705				$\checkmark$	Undefined
FA56H	CAN0 message data byte 6 register 05	C0MDATA605			$\checkmark$		Undefined
FA57H	CAN0 message data byte 7 register 05	C0MDATA705			$\checkmark$		Undefined
FA58H	CAN0 message data length code register 05	C0MDLC05			$\checkmark$		0000xxxxB
FA59H	CAN0 message configuration register 05	C0MCONF05			$\checkmark$		Undefined
FA5AH	CAN0 message ID register 05	C0MIDL05				$\checkmark$	Undefined
FA5CH		C0MIDH05				$\checkmark$	Undefined
FA5EH	CAN0 message configuration register 05	COMCTRL05				$\checkmark$	00x00000 000xx000B



Table 15-16.	<b>Register Access</b>	Types (4/9)
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Address	Register Name	Symbol	R/W	Bit Manipulation Units		Default Value	
				1	8	16	
FA60H	CAN0 message data byte 01 register 06	C0MDATA0106	R/W			$\checkmark$	Undefined
FA60H	CAN0 message data byte 0 register 06	COMDATA006			$\checkmark$		Undefined
FA61H	CAN0 message data byte 1 register 06	C0MDATA106			$\checkmark$		Undefined
FA62H	CAN0 message data byte 23 register 06	C0MDATA2306				$\checkmark$	Undefined
FA62H	CAN0 message data byte 2 register 06	C0MDATA206			$\checkmark$		Undefined
FA63H	CAN0 message data byte 3 register 06	C0MDATA306			$\checkmark$		Undefined
FA64H	CAN0 message data byte 45 register 06	C0MDATA4506				$\checkmark$	Undefined
FA64H	CAN0 message data byte 4 register 06	C0MDATA406			$\checkmark$		Undefined
FA65H	CAN0 message data byte 5 register 06	C0MDATA506			$\checkmark$		Undefined
FA66H	CAN0 message data byte 67 register 06	C0MDATA6706				$\checkmark$	Undefined
FA66H	CAN0 message data byte 6 register 06	C0MDATA606			$\checkmark$		Undefined
FA67H	CAN0 message data byte 7 register 06	C0MDATA706			$\checkmark$		Undefined
FA68H	CAN0 message data length code register 06	C0MDLC06			$\checkmark$		0000xxxxB
FA69H	CAN0 message configuration register 06	C0MCONF06			$\checkmark$		Undefined
FA6AH	CAN0 message ID register 06	C0MIDL06				$\checkmark$	Undefined
FA6CH		C0MIDH06				$\checkmark$	Undefined
FA6EH	CAN0 message control register 06	COMCTRL06				$\checkmark$	00x00000 000xx000B
FA70H	CAN0 message data byte 01 register 07	C0MDATA0107				$\checkmark$	Undefined
FA70H	CAN0 message data byte 0 register 07	C0MDATA007			$\checkmark$		Undefined
FA71H	CAN0 message data byte 1 register 07	C0MDATA107			$\checkmark$		Undefined
FA72H	CAN0 message data byte 23 register 07	C0MDATA2307				$\checkmark$	Undefined
FA72H	CAN0 message data byte 2 register 07	C0MDATA207			$\checkmark$		Undefined
FA73H	CAN0 message data byte 3 register 07	C0MDATA307			$\checkmark$		Undefined
FA74H	CAN0 message data byte 45 register 07	C0MDATA4507				$\checkmark$	Undefined
FA74H	CAN0 message data byte 4 register 07	C0MDATA407			$\checkmark$		Undefined
FA75H	CAN0 message data byte 5 register 07	C0MDATA507			$\checkmark$		Undefined
FA76H	CAN0 message data byte 67 register 07	C0MDATA6707				$\checkmark$	Undefined
FA76H	CAN0 message data byte 6 register 07	C0MDATA607			$\checkmark$		Undefined
FA77H	CAN0 message data byte 7 register 07	C0MDATA707			$\checkmark$		Undefined
FA78H	CAN0 message data length code register 07	C0MDLC07			$\checkmark$		0000xxxxB
FA79H	CAN0 message configuration register 07	C0MCONF07			$\checkmark$		Undefined
FA7AH	CAN0 message ID register 07	C0MIDL07				$\checkmark$	Undefined
FA7CH		C0MIDH07				$\checkmark$	Undefined
FA7EH	CAN0 message control register 07	COMCTRL07				$\checkmark$	00x00000 000xx000B



Table 15-16.	<b>Register Access</b>	Types (5/9)
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Address	Register Name	Symbol	R/W	Bit Manipulation Units		Default Value	
				1	8	16	
FA80H	CAN0 message data byte 01 register 08	C0MDATA0108	R/W			$\checkmark$	Undefined
FA80H	CAN0 message data byte 0 register 08	C0MDATA008			$\checkmark$		Undefined
FA81H	CAN0 message data byte 1 register 08	C0MDATA108			$\checkmark$		Undefined
FA82H	CAN0 message data byte 23 register 08	C0MDATA2308				$\checkmark$	Undefined
FA82H	CAN0 message data byte 2 register 08	C0MDATA208			$\checkmark$		Undefined
FA83H	CAN0 message data byte 3 register 08	C0MDATA308			$\checkmark$		Undefined
FA84H	CAN0 message data byte 45 register 08	C0MDATA4508				$\checkmark$	Undefined
FA84H	CAN0 message data byte 4 register 08	C0MDATA408			$\checkmark$		Undefined
FA85H	CAN0 message data byte 5 register 08	C0MDATA508			$\checkmark$		Undefined
FA86H	CAN0 message data byte 67 register 08	C0MDATA6708				$\checkmark$	Undefined
FA86H	CAN0 message data byte 6 register 08	C0MDATA608			$\checkmark$		Undefined
FA87H	CAN0 message data byte 7 register 08	C0MDATA708			$\checkmark$		Undefined
FA88H	CAN0 message data length code register 08	C0MDLC08			$\checkmark$		0000xxxxB
FA89H	CAN0 message configuration register 08	C0MCONF08			$\checkmark$		Undefined
FA8AH	CAN0 message ID register 08	C0MIDL08				$\checkmark$	Undefined
FA8CH		C0MIDH08				$\checkmark$	Undefined
FA8EH	CAN0 message control register 08	C0MCTRL08				$\checkmark$	00x00000 000xx000B
FA90H	CAN0 message data byte 01 register 09	C0MDATA0109				$\checkmark$	Undefined
FA90H	CAN0 message data byte 0 register 09	C0MDATA009					Undefined
FA91H	CAN0 message data byte 1 register 09	C0MDATA109					Undefined
FA92H	CAN0 message data byte 23 register 09	C0MDATA2309				$\checkmark$	Undefined
FA92H	CAN0 message data byte 2 register 09	C0MDATA209			$\checkmark$		Undefined
FA93H	CAN0 message data byte 3 register 09	C0MDATA309					Undefined
FA94H	CAN0 message data byte 45 register 09	C0MDATA4509				$\checkmark$	Undefined
FA94H	CAN0 message data byte 4 register 09	C0MDATA409			$\checkmark$		Undefined
FA95H	CAN0 message data byte 5 register 09	C0MDATA509			$\checkmark$		Undefined
FA96H	CAN0 message data byte 67 register 09	C0MDATA6709				$\checkmark$	Undefined
FA96H	CAN0 message data byte 6 register 09	C0MDATA609			$\checkmark$		Undefined
FA97H	CAN0 message data byte 7 register 09	C0MDATA709					Undefined
FA98H	CAN0 message data length code register 09	C0MDLC09					0000xxxxB
FA99H	CAN0 message configuration register 09	C0MCONF09			$\checkmark$		Undefined
FA9AH	CAN0 message ID register 09	C0MIDL09				$\checkmark$	Undefined
FA9CH		C0MIDH09				$\checkmark$	Undefined
FA9EH	CAN0 message control register 09	COMCTRL09				$\checkmark$	00x00000 000xx000B



Table 15-16.	<b>Register Access</b>	Types (6/9)
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Address	Register Name	Symbol	R/W	Bit Manipulation Units		Default Value	
				1	8	16	
FAA0H	CAN0 message data byte 01 register 10	C0MDATA0110	R/W			$\checkmark$	Undefined
FAA0H	CAN0 message data byte 0 register 10	C0MDATA010			$\checkmark$		Undefined
FAA1H	CAN0 message data byte 1 register 10	C0MDATA110			$\checkmark$		Undefined
FAA2H	CAN0 message data byte 23 register 10	C0MDATA2310				$\checkmark$	Undefined
FAA2H	CAN0 message data byte 2 register 10	C0MDATA210			$\checkmark$		Undefined
<b>FAA3H</b>	CAN0 message data byte 3 register 10	C0MDATA310			$\checkmark$		Undefined
FAA4H	CAN0 message data byte 45 register 10	C0MDATA4510				$\checkmark$	Undefined
FAA4H	CAN0 message data byte 4 register 10	C0MDATA410			$\checkmark$		Undefined
FAA5H	CAN0 message data byte 5 register 10	C0MDATA510			$\checkmark$		Undefined
FAA6H	CAN0 message data byte 67 register 10	C0MDATA6710				$\checkmark$	Undefined
FAA6H	CAN0 message data byte 6 register 10	C0MDATA610			$\checkmark$		Undefined
FAA7H	CAN0 message data byte 7 register 10	C0MDATA710			$\checkmark$		Undefined
FAA8H	CAN0 message data length code register 10	C0MDLC10			$\checkmark$		0000xxxxB
FAA9H	CAN0 message configuration register 10	C0MCONF10			$\checkmark$		Undefined
FAAAH	CAN0 message ID register 10	C0MIDL10				$\checkmark$	Undefined
FAACH		C0MIDH10				$\checkmark$	Undefined
FAAEH	CAN0 message control register 10	COMCTRL10				$\checkmark$	00x00000 000xx000B
FAB0H	CAN0 message data byte 01 register 11	C0MDATA0111				$\checkmark$	Undefined
FAB0H	CAN0 message data byte 0 register 11	C0MDATA011			$\checkmark$		Undefined
FAB1H	CAN0 message data byte 1 register 11	C0MDATA111			$\checkmark$		Undefined
FAB2H	CAN0 message data byte 23 register 11	C0MDATA2311				$\checkmark$	Undefined
FAB2H	CAN0 message data byte 2 register 11	C0MDATA211			$\checkmark$		Undefined
FAB3H	CAN0 message data byte 3 register 11	C0MDATA311			$\checkmark$		Undefined
FAB4H	CAN0 message data byte 45 register 11	C0MDATA4511				$\checkmark$	Undefined
FAB4H	CAN0 message data byte 4 register 11	C0MDATA411			$\checkmark$		Undefined
FAB5H	CAN0 message data byte 51 register 11	C0MDATA511			$\checkmark$		Undefined
FAB6H	CAN0 message data byte 67 register 11	C0MDATA6711				$\checkmark$	Undefined
FAB6H	CAN0 message data byte 6 register 11	C0MDATA611			$\checkmark$		Undefined
FAB7H	CAN0 message data byte 71 register 11	C0MDATA711			$\checkmark$		Undefined
FAB8H	CAN0 message data length code register 11	C0MDLC11			$\checkmark$		0000xxxxB
FAB9H	CAN0 message configuration register 11	C0MCONF11			$\checkmark$		Undefined
FABAH	CAN0 message ID register 11	C0MIDL11				$\checkmark$	Undefined
FABCH		C0MIDH11				$\checkmark$	Undefined
FABEH	CAN0 message control register 11	COMCTRL11				$\checkmark$	00x00000 000xx000B



Table 15-16.	Register Access	Types (7/9)
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Address	Register Name	Symbol	R/W	Bit Mar	nipulatior	Units	Default Value
				1	8	16	
FAC0H	CAN0 message data byte 01 register 12	C0MDATA0112	R/W			$\checkmark$	Undefined
FAC0H	CAN0 message data byte 0 register 12	C0MDATA012			$\checkmark$		Undefined
FAC1H	CAN0 message data byte 1 register 12	C0MDATA112			$\checkmark$		Undefined
FAC2H	CAN0 message data byte 23 register 12	C0MDATA2312				$\checkmark$	Undefined
FAC2H	CAN0 message data byte 2 register 12	C0MDATA212			$\checkmark$		Undefined
FAC3H	CAN0 message data byte 3 register 12	C0MDATA312			$\checkmark$		Undefined
FAC4H	CAN0 message data byte 45 register 12	C0MDATA4512				$\checkmark$	Undefined
FAC4H	CAN0 message data byte 4 register 12	C0MDATA412			$\checkmark$		Undefined
FAC5H	CAN0 message data byte 5 register 12	C0MDATA512			$\checkmark$		Undefined
FAC6H	CAN0 message data byte 67 register 12	C0MDATA6712				$\checkmark$	Undefined
FAC6H	CAN0 message data byte 6 register 12	C0MDATA612			$\checkmark$		Undefined
FAC7H	CAN0 message data byte 7 register 12	C0MDATA712			$\checkmark$		Undefined
FAC8H	CAN0 message data length code register 12	C0MDLC12			$\checkmark$		0000xxxxB
FAC9H	CAN0 message configuration register 12	C0MCONF12			$\checkmark$		Undefined
FACAH	CAN0 message ID register 12	C0MIDL12				$\checkmark$	Undefined
FACCH		C0MIDH12				$\checkmark$	Undefined
FACEH	CAN0 message control register 12	COMCTRL12				$\checkmark$	00x00000 000xx000B
FAD0H	CAN0 message data byte 01 register 13	C0MDATA0113				$\checkmark$	Undefined
FAD0H	CAN0 message data byte 0 register 13	C0MDATA013			$\checkmark$		Undefined
FAD1H	CAN0 message data byte 1 register 13	C0MDATA113			$\checkmark$		Undefined
FAD2H	CAN0 message data byte 23 register 13	C0MDATA2313				$\checkmark$	Undefined
FAD2H	CAN0 message data byte 2 register 13	C0MDATA213			$\checkmark$		Undefined
FAD3H	CAN0 message data byte 3 register 13	C0MDATA313					Undefined
FAD4H	CAN0 message data byte 45 register 13	C0MDATA4513				$\checkmark$	Undefined
FAD4H	CAN0 message data byte 4 register 13	C0MDATA413			$\checkmark$		Undefined
FAD5H	CAN0 message data byte 5 register 13	C0MDATA513			$\checkmark$		Undefined
FAD6H	CAN0 message data byte 67 register 13	C0MDATA6713				$\checkmark$	Undefined
FAD6H	CAN0 message data byte 6 register 13	C0MDATA613			$\checkmark$		Undefined
FAD7H	CAN0 message data byte 7 register 13	C0MDATA713			$\checkmark$		Undefined
FAD8H	CAN0 message data length code register 13	C0MDLC13			$\checkmark$		0000xxxxB
FAD9H	CAN0 message configuration register 13	C0MCONF13			$\checkmark$		Undefined
FADAH	CAN0 message ID register 13	C0MIDL13					Undefined
FADCH		C0MIDH13				$\checkmark$	Undefined
FADEH	CAN0 message control register 13	COMCTRL13				$\checkmark$	00x00000 000xx000B



Table 15-16. Register Access Types (8/
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Address	Register Name	Symbol	R/W	Bit Manipulation Units			Default Value
				1	8	16	
FAE0H	CAN0 message data byte 01 register 14	C0MDATA0114	R/W			$\checkmark$	Undefined
FAE0H	CAN0 message data byte 0 register 14	C0MDATA014			$\checkmark$		Undefined
FAE1H	CAN0 message data byte 1 register 14	C0MDATA114			$\checkmark$		Undefined
FAE2H	CAN0 message data byte 23 register 14	C0MDATA2314				$\checkmark$	Undefined
FAE2H	CAN0 message data byte 2 register 14	C0MDATA214			$\checkmark$		Undefined
FAE3H	CAN0 message data byte 3 register 14	C0MDATA314			$\checkmark$		Undefined
FAE4H	CAN0 message data byte 45 register 14	C0MDATA4514				$\checkmark$	Undefined
FAE4H	CAN0 message data byte 4 register 14	C0MDATA414			$\checkmark$		Undefined
FAE5H	CAN0 message data byte 5 register 14	C0MDATA514			$\checkmark$		Undefined
FAE6H	CAN0 message data byte 67 register 14	C0MDATA6714				$\checkmark$	Undefined
FAE6H	CAN0 message data byte 6 register 14	C0MDATA614			$\checkmark$		Undefined
FAE7H	CAN0 message data byte 7 register 14	C0MDATA714			$\checkmark$		Undefined
FAE8H	CAN0 message data length code register 14	C0MDLC14			$\checkmark$		0000xxxxB
FAE9H	CAN0 message configuration register 14	C0MCONF14			$\checkmark$		Undefined
FAEAH	CAN0 message ID register 14	C0MIDL14				$\checkmark$	Undefined
FAECH		C0MIDH14				$\checkmark$	Undefined
FAEEH	CAN0 message control register 14	C0MCTRL14				$\checkmark$	00x00000 000xx000B
FAF0H	CAN0 message data byte 01 register 15	C0MDATA0115				$\checkmark$	Undefined
FAF0H	CAN0 message data byte 0 register 15	C0MDATA015			$\checkmark$		Undefined
FAF1H	CAN0 message data byte 1 register 15	C0MDATA115			$\checkmark$		Undefined
FAF2H	CAN0 message data byte 23 register 15	C0MDATA2315				$\checkmark$	Undefined
FAF2H	CAN0 message data byte 2 register 15	C0MDATA215			$\checkmark$		Undefined
FAF3H	CAN0 message data byte 3 register 15	C0MDATA315			$\checkmark$		Undefined
FAF4H	CAN0 message data byte 45 register 15	C0MDATA4515				$\checkmark$	Undefined
FAF4H	CAN0 message data byte 4 register 15	C0MDATA415			$\checkmark$		Undefined
FAF5H	CAN0 message data byte 5 register 15	C0MDATA515			$\checkmark$		Undefined
FAF6H	CAN0 message data byte 67 register 15	C0MDATA6715				$\checkmark$	Undefined
FAF6H	CAN0 message data byte 6 register 15	C0MDATA615			$\checkmark$		Undefined
FAF7H	CAN0 message data byte 7 register 15	C0MDATA715			$\checkmark$		Undefined
FAF8H	CAN0 message data length code register 15	C0MDLC15			$\checkmark$		0000xxxxB
FAF9H	CAN0 message configuration register 15	C0MCONF15			$\checkmark$		Undefined
FAFAH	CAN0 message ID register 15	C0MIDL15				$\checkmark$	Undefined
FAFCH		C0MIDH15				$\checkmark$	Undefined
FAFEH	CAN0 message control register 15	C0MCTRL15				$\checkmark$	00x00000 000xx000B



Address	Register Name	Symbol	R/W	Bit Ma	nipulatior	n Units	Default Value
				1	8	16	
FF60H	CAN0 module receive history list register	CORGPT	R/W	-	_	$\checkmark$	xx02H
FF62H	CAN0 module transmit history list register	COTGPT	R/W	-	_	$\checkmark$	xx02H
FF64H	CAN0 global control register	COGMCTRL	R/W	-	_	$\checkmark$	0000H
FF66H	CAN0 global automatic block transmission control register	COGMABT	R/W		_	V	0000H
FF68H	CAN0 module last out-pointer register	COLOPT	R	_			Undefined
FF6EH	CAN0 global clock select register	COGMCS	R/W	-			0FH
FF6FH	CAN0 global automatic block transmission delay setting register	COGMABTD	R/W	_	$\checkmark$	-	00H
FF70H	CAN0 module mask 1 register	C0MASK1L	R/W	-	_	$\checkmark$	Undefined
FF72H		C0MASK1H					
FF74H	CAN0 module mask 2 register	C0MASK2L	R/W		_		Undefined
FF76H		C0MASK2H					
FF78H	CAN0 module mask 3 register	C0MASK3L	R/W		!		Undefined
FF7AH		C0MASK3H					
FF7CH	CAN0 module mask 4 register	C0MASK4L	R/W	-	_ ·		Undefined
FF7EH		C0MASK4H					
FF8AH	CAN0 module time stamp register	COTS	R/W	-		$\checkmark$	0000H
FF90H	CAN0 module control register	COCTRL	R/W	-		$\checkmark$	0000H
FF92H	CAN0 module last error information register	COLEC	R/W	-	$\checkmark$		00H
FF93H	CAN0 module information register	COINFO	R	-	$\checkmark$		00H
FF94H	CAN0 module error counter register	COERC	R			$\checkmark$	0000H
FF96H	CAN0 module interrupt enable register	COIE	R/W	_		$\checkmark$	0000H
FF98H	CAN0 module interrupt status register	COINTS	R/W			$\checkmark$	0000H
FF9CH	CAN0 module bit rate register	COBTR	R/W	_		$\checkmark$	370FH
FF9EH	CAN0 module bit rate prescaler register	COBRP	R/W		$\checkmark$		FFH
FF9FH	CAN0 module last in-pointer register	COLIPT	R	<u> </u>		<u> </u>	Undefined

Table 15-16. Register Access Types (9/9)



# 15.5.3 Register bit configuration

Address	Symbol	Bit 7/15	Bit 6/14	Bit 5/13	Bit 4/12	Bit 3/11	Bit 2/10	Bit 1/9	Bit 0/8
FF64H	C0GMCTRL(W)	0	0	0	0	0	0	0	Clear GOM
FF65H		0	0	0	0	0	0	Set EFSD	Set GOM
FF64H	C0GMCTRL(R)	0	0	0	0	0	0	EFSD	GOM
FF65H		MBON	0	0	0	0	0	0	0
FF66H	C0GMABT(W)	0	0	0	0	0	0	0	Clear ABTTRG
FF67H		0	0	0	0	0	0	Set ABTCLR	Set ABTTRG
FF66H	C0GMABT(R)	0	0	0	0	0	0	ABTCLR	ABTTRG
FF67H		0	0	0	0	0	0	0	0
FF6EH	COGMCS	0	0	0	0	CCP3	CCP2	CCP1	CCP0
FF6FH	COGMABTD	0	0	0	0	ABTD3	ABTD2	ABTD1	ABTD0

Table 15-17. Bit Configuration of CAN Global Registers

Caution The actual register address is calculated as follows:

Register Address = Global Register Area Offset (CH dependent) + Offset Address as listed in the table above

Remark (R) When read

(W) When write



Address	Symbol	Bit 7/15	Bit 6/14	Bit 5/13	Bit 4/12	Bit 3/11	Bit 2/10	Bit 1/9	Bit 0/8	
FF60H	C0RGPT(W)	0	0	0	0	0	0	0	Clear ROVF	
FF61H	1	0	0	0	0	0	0	0	0	
FF60H	C0RGPT(R)	0	0	0	0	0	0	RHPM	ROVF	
FF61H	l				RGP <sup>-</sup>	T [7:0]				
FF62H	COLOPT				LOP	Г [7:0]				
FF64H	C0TGPT(W)	0	0	0	0	0	0	0	Clear TOVF	
FF65H	1	0	0	0	0	0	0	0	0	
FF64H	C0TGPT(R)	0	0	0	0	0	0	THPM	TOVF	
FF65H	1				TGP	T [7:0]				
FF70H	C0MASK1L				CM1I	D [7:0]				
FF71H	l				CM1IE	J [15:8]				
FF72H	C0MASK1H				CM1ID	[23:16]				
FF73H		0	0	0		(	CM1ID [28:24	4]		
FF74H	C0MASK2L		CM2ID [7:0]							
FF75H	<u> </u>				CM2IE	) [15:8]				
FF76H	C0MASK2H				CM2ID	[23:16]				
FF77H	l	0	0	0		(	CM2ID [28:24	4]		
FF78H	C0MASK3L				CM3I	D [7:0]				
FF79H					CM3IE	J [15:8]				
FF7AH	C0MASK3H				CM3ID	[23:16]				
FF7BH		0	0	0		(	CM3ID [28:24	4]		
FF7CH	C0MASK4L				CM4I	D [7:0]				
FF7DH	l				CM4IE	J [15:8]				
FF7EH	C0MASK4H				CM4ID	[23:16]				
FF7FH	<u> </u>	0	0	0		(	CM4ID [28:24	4]		
FF8AH	COTS(W)	0	0	0	0	0	Clear TSLOCK	Clear TSSEL	Clear TSEN	
FF8BH		0	0	0	0	0	Set TSLOCK	Set TSSEL	Set TSEN	
FF8AH	C0TS(R)	0	0	0	0	0	TSLOCK	TSSEL	TSEN	
FF8BH		0	0	0	0	0	0	0	0	

Table 15-18. Bit Configuration of CAN Module Registers (1/2)

Caution The actual register address is calculated as follows:

Register Address = Global Register Area Offset (CH dependent) + Offset Address as listed in the table above

- Remark (R) When read
  - (W) When write



Address	Symbol	Bit 7/15	Bit 6/14	Bit 5/13	Bit 4/12	Bit 3/11	Bit 2/10	Bit 1/9	Bit 0/8		
FF90H	C0CTRL(W)	Clear CCERC	Clear AL	Clear VALID	Clear PSMODE1	Clear PSMODE0	Clear OPMODE2	Clear OPMODE1	Clear OPMODE0		
FF91H		Set CCERC	Set AL	0	Set PSMODE1	Set PSMODE0	Set OPMODE2	Set OPMODE1	Set OPMODE0		
FF90H	C0CTRL(R)	CCERC	AL	VALID	PSMODE1	PSMODE0	OPMODE2	OPMODE1	OPMODE0		
FF91H		0	0	0	0	0	0	RSTAT	TSTAT		
FF92H	C0LEC(W)	0	0	0	0	0	0	0	0		
FF92H	C0LEC(R)	0	0	0	0	0	LEC2	LEC1	LEC0		
FF93H	COINFO	0	0	0	BOFF	TECS1	TECS0	RECS1	RECS0		
FF94H	COERC				TEC	[7:0]					
FF95H			REC [7:0]								
FF96H	C0IE(W)	0	0	Clear CIE5	Clear CIE4	Clear CIE3	Clear CIE2	Clear CIE1	Clear CIE0		
FF97H		0	0	Set CIE5	Set CIE4	Set CIE3	Set CIE2	Set CIE1	Set CIE0		
FF96H	C0IE(R)	0	0	CIE5	CIE4	CIE3	CIE2	CIE1	CIE0		
FF97H		0	0	0	0	0	0	0	0		
FF98H	C0INTS(W)	0	0	Clear CINTS5	Clear CINTS4	Clear CINTS3	Clear CINTS2	Clear CINTS1	Clear CINTS0		
FF99H		0	0	0	0	0	0	0	0		
FF98H	C0INTS(R)	0	0	CINTS5	CINTS4	CINTS3	CINTS2	CINTS1	CINTS0		
FF99H		0	0	0	0	0	0	0	0		
FF9CH	COBTR	0	0	0	0		TSEG	1 [3:0]			
FF9DH		0 0 SJW [1:0] 0 TSEG2 [2:0]									
FF9EH	COBRP	TQPRS [7:0]									
FF9FH	COLIPT				LIPT	[7:0]					

 Table 15-18. Bit Configuration of CAN Module Registers (2/2)

Caution The actual register address is calculated as follows:

Register Address = Global Register Area Offset (CH dependent) + Offset Address as listed in the table above

Remark (R) When read

(W) When write



Address	Symbol	Bit 7/15	Bit 6/14	Bit 5/13	Bit 4/12	Bit 3/11	Bit 2/10	Bit 1/9	Bit 0/8			
FAx0H	C0MDATA01m	Message d	Message data (byte 0)									
FAx1H		Message d	lata (byte 1)									
FAx0H	C0MDATA0m	Message d	lata (byte 0)									
FAx1H	C0MDATA1m	Message d	lata (byte 1)									
FAx2H	C0MDATA23m	Message d	lata (byte 2)									
FAx3H		Message d	lata (byte 3)									
FAx2H	C0MDATA2m	Message d	Message data (byte 2)									
FAx3H	C0MDATA3m	Message d	Nessage data (byte 3)									
FAx4H	C0MDATA45m	Message d	Aessage data (byte 4)									
FAx5H		Message d	lessage data (byte 5)									
FAx4H	C0MDATA4m	Message d	Message data (byte 4)									
FAx5H	C0MDATA5m	Message data (byte 5)										
FAx6H	C0MDATA67m	Message data (byte 6)										
FAx7H		Message d	Message data (byte 7)									
FAx6H	C0MDATA6m	Message d	lata (byte 6)									
FAx7H	C0MDATA7m	Message d	lata (byte 7)									
FAx8H	C0MDLCm	0	0	0	0	MDLC3	MDLC2	MDLC1	MDLC0			
FAx9H	COMCONFm	OWS	RTR	MT2	MT1	MTO	0	0	MA0			
FAxAH	C0MIDLm	ID7	ID6	ID5	ID4	ID3	ID2	ID1	ID0			
FAxBH		ID15	ID14	ID13	ID12	ID11	ID10	ID9	ID8			
FAxCH	C0MIDHm	ID23	ID22	ID21	ID20	ID19	ID18	ID17	ID16			
FAxDH		IDE	0	0	ID28	ID27	ID26	ID25	ID24			
FAxEH	C0MCTRLm (W)	0	0	0	Clear MOW	Clear IE	Clear DN	Clear TRQ	Clear RDY			
FAxFH		0	0	0	0	Set IE	0	Set TRQ	Set RDY			
FAxEH	C0MCTRLm (R)	0	0	0	MOW	IE	DN	TRQ	RDY			
FAxFH	]	0	0	MUC	0	0	0	0	0			

Caution The actual register address is calculated as follows:

Register Address = Global Register Area Offset (CH dependent) + Offset Address as listed in the table above

Remarks 1. (R) When read (W) When write

**2.** m = 0 to 15



# 15.6 Bit Set/Clear Function

The CAN control registers include registers whose bits can be set or cleared via the CPU and via the CAN interface. An operation error occurs if the following registers are written directly. Do not write any values directly via bit manipulation, read/modify/write, or direct writing of target values.

- CAN global control register (C0GMCTRL)
- CAN global automatic block transmission control register (C0GMABT)
- CAN module control register (C0CTRL)
- CAN module interrupt enable register (C0IE)
- CAN module interrupt status register (C0INTS)
- CAN module receive history list register (C0RGPT)
- CAN module transmit history list register (C0TGPT)
- CAN module time stamp register (C0TS)
- CAN message control register (C0MCTRLm)

Remark m = 0 to 15

All the 16 bits in the above registers can be read via the usual method. Use the procedure described in **Figure 15-23** below to set or clear the lower 8 bits in these registers.

Setting or clearing of lower 8 bits in the above registers is performed in combination with the higher 8 bits (refer to the 16-bit data after a write operation in **Figure 15-24**). **Figure 15-23** shows how the values of set bits or clear bits relate to set/clear/no change operations in the corresponding register.

#### Figure 15-23. Example of Bit Setting/Clearing Operations



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15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
set 7	set 6	set 5	set 4	set 3	set 2	set 1	set 0	clear 7	clear 6	clear 5	clear 4	clear 3	clear 2	clear 1	clear 0	
	:	set n				clear	n		Status of bit n after bit set/clear operation							
		0			0					No change						
		0				1			0							
		1			0							1				
	1 1								No change							

# Figure 15-24. 16-Bit Data during Write Operation

**Remark** n = 0 to 7



# **15.7 Control Registers**

**Remark** m = 0 to 15

#### (1) CAN global control register (C0GMCTRL)

The COGMCTRL register is used to control the operation of the CAN module.

After reset: 0000H R/W Address: FF4CH, FF4DH

(a) Read

	15	14	13	12	11	10	9	8
COGMCTRL	MBON	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	EFSD	GOM

(b) Write

	15	14	13	12	11	10	9	8
COGMCTRL	0	0	0	0	0	0	Set EFSD	Set GOM
	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	0	Clear GOM

(a) Read

MBON	Bit Enabling Access to Message Buffer Register, Transmit/Receive History List Registers
0	Write access and read access to the message buffer register and the transmit/receive history list registers is disabled.
1	Write access and read access to the message buffer register and the transmit/receive history list registers is enabled.

Cautions 1. While the MBON bit is cleared (to 0), software access to the message buffers (C0MDATA0m, C0MDATA1m, C0MDATA01m, C0MDATA2m, C0MDATA3m, C0MDATA23m, C0MDATA4m, C0MDATA5m, C0MDATA45m, C0MDATA6m, C0MDATA7m, C0MDATA67m, C0MDLCm, C0MCONFm, C0MIDLm, C0MIDHm, and C0MCTRLm), or registers related to transmit history or receive history (C0LOPT, C0TGPT, C0LIPT, and C0RGPT) is disabled.

2. This bit is read-only. Even if 1 is written to MBON while it is 0, the value of MBON does not change, and access to the message buffer registers, or registers related to transmit history or receive history remains disabled.

Remark MBON bit is cleared (to 0) when the CAN module enters CAN sleep mode/CAN stop mode or GOM bit is cleared (to 0).
MBON bit is set (to 1) when the CAN sleep mode/the CAN stop mode is released or GOM bit is set (to 1).

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EFSD	Bit Enabling Forced Shut Down						
0	Forced shut down by GOM = 0 disabled.						
1	Forced shut down by GOM = 0 enabled.						

Caution To request forced shutdown, the GOM bit must be cleared to 0 in a subsequent, immediately following write access after the EFSD bit has been set to 1. If access to another register (including reading the COGMCTRL register) is executed without clearing the GOM bit immediately after the EFSD bit has been set to 1, the EFSD bit is forcibly cleared to 0, and the forced shutdown request is invalid.

GOM	Global Operation Mode Bit					
0	CAN module is disabled from operating.					
1	CAN module is enabled to operate.					

Caution The GOM bit can be cleared only in the initialization mode or immediately after EFSD bit is set (to 1).

(b) Write

Set EFSD	EFSD Bit Setting
0	No change in ESFD bit .
1	EFSD bit set to 1.

Set GOM	Clear GOM	GOM Bit Setting					
0	1	GOM bit cleared to 0.					
1	0	GOM bit set to 1.					
Other than above		No change in GOM bit.					

Caution Set GOM bit and ESFD bit always separately.



# (2) CAN global clock selection register (C0GMCS)

The COGMCS register is used to select the CAN module system clock.

After reset	: 0FH			R/W		Address:	FF6EH					
		7		6		5	4	3	2	1	0	
COGMCS	- <b>[</b>			0		0	0	CCP2	- -	CCP1	CCPO	
COGINIC	5	0		0		0	0	CCF3	0072	COFT	CCFU	
CCP3	CCF	P2	С	CP1	(	CCP1		CAN M	odule Syst	em Clock	(fcanmod)	
0	0			0		0	fcan/1					
0	0			0		1	fcan/2					
0	0			1		0	fcan/3					
0	0			1		1	fcan/4					
0	1			0		0	fcan/5					
0	1			0		1	fcan/6					
0	1			1		0	fcan/7					
0	1			1		1	fcan/8					
1	0			0		0	fcan/9					
1	0			0		1	fcan/10					
1	0			1		0	fcan/11					
1	0			1		1	fcan/12					
1	1			0		0	fcan/13					
1	1			0		1	fcan/14					
1	1			1		0	fcan/15					
1	1			1		1	fcan/16 (	Default val	ue)			

Remark fcan = Clock supplied to CAN



# (3) CAN global automatic block transmission control register (C0GMABT)

The COGMABT register is used to control the automatic block transmission (ABT) operation.

After reset: 0000H R/W Address: FFAEH, FFAFH

(a)	Read
-----	------

	15	14	13	12	11	10	9	8
COGMABT	0	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	ABTCLR	ABTTRG

(b) Write

	15	14	13	12	11	10	9	8
COGMABT	0	0	0	0	0	0	Set ABTCLR	Set ABTTRG
	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	0	Clear ABTTRG

Caution Before changing the normal operation mode with ABT to the initialization mode, be sure to set the C0GMABT register to the default value (0000H) and confirm the C0GMABT register is surely initialized to the default value (0000H).

(a) Read

ABTCLR	Automatic Block Transmission Engine Clear Status Bit								
0	Clearing the automatic transmission engine is completed.								
1	The automatic transmission engine is being cleared.								
Remark	<b>s 1.</b> Set the ABTCLR bit to 1 while the ABTTRG bit is cleared (0).								
	The operation is not guaranteed if the ABTCLR bit is set to 1 while the ABTTRG								
	bit is set to 1.								

2. When the automatic block transmission engine is cleared by setting the ABTCLR bit to 1, the ABTCLR bit is automatically cleared to 0 as soon as the requested clearing processing is complete.

ABTTRG	Automatic Block Transmission Status Bit						
0	Automatic block transmission is stopped.						
1	Automatic block transmission is under execution.						

Caution Do not set the ABTTRG bit (ABTTRG = 1) in the initialization mode. If the ABTTRG bit is set in the initialization mode, the operation is not guaranteed after the CAN module has entered the normal operation mode with ABT. Do not set the ABTTRG bit (1) while the C0CTRL.TSTAT bit is set (1). Confirm TSTAT = 0 directly in advance before setting ABTTRG bit.

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(b) Write

Set ABTCLR	Automatic Block Transmission Engine Clear Request Bit
0	The automatic block transmission engine is in idle state or under operation.
1	Request to clear the automatic block transmission engine. After the automatic block transmission engine has been cleared, automatic block transmission is started from message buffer 0 by setting the ABTTRG bit to 1.

Set ABTTRG	Clear ABTTRG	Automatic Block Transmission Start Bit
0	1	Request to stop automatic block transmission.
1	0	Request to start automatic block transmission.
Other than above		No change in ABTTRG bit.

Caution While receiving a message from another node or transmitting the messages other than the ABT messages (message buffer 8 to 15), there is a possibility not to begin immediately the transmission even if the ABTTRG bit is set to 1. Transmission is not aborted even if the ABTTRG bit is cleared to 0, until the transmission of the ABT message, which is currently being transmitted is completed (successfully or not). After that, the transmission is aborted.



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# (4) CAN global automatic block transmission delay setting register (C0GMABTD)

The COGMABTD register is used to set the interval at which the data of the message buffer assigned to ABT is to be transmitted in the normal operation mode with ABT.

After reset	: 00H		R/W	Addres	s: FF6FH						
		7	6	5	4	3	2	1	0		
COGMABTD		0	0	0	0	ABTD3	ABTD2	ABTD1	ABTD0		
ABTD3	ABTD	2 A	BTD1	ABTD0	Data frame interval during automatic block transmission (unit: Data bit time (DBT))				nission		
0	0		0	0	0 DBT (c	lefault valu	ie)				
0	0		0	1	2⁵DBT	2 <sup>5</sup> DBT					
0	0		1	0	2 <sup>6</sup> DBT						
0	0		1	1	2 <sup>7</sup> DBT						
0	1		0	0	2°DBT						
0	1		0	1	2°DBT						
0	1		1	0	2 <sup>10</sup> DBT						
0	1		1	1	2 <sup>11</sup> DBT						
1	0		0	0	2 <sup>12</sup> DBT						
Other than above				Setting prohibited							

Cautions 1. Do not change the contents of the C0GMABTD register while the ABTTRG bit is set to 1.

2. The timing at which the ABT message is actually transmitted onto the CAN bus differs depending on the status of transmission from the other station or how a request to transmit a message other than an ABT message (message buffers 8 to 15) is made.



# (5) CAN module mask control register (C0MASKaL, C0MASKaH) (a = 1, 2, 3, or 4)

The COMASKaL and COMASKaH registers are used to extend the number of receivable messages into the same message buffer by masking part of the ID comparison of a message and invalidating the ID of the masked part.

- CAN Module Mask 1 Register (C0MASK1L, C0MASK1H)

After reset: Undefined R/W Address: C0MASK1L FF70H, FF71H C0MASK1H FF72H, FF73H

	15	14	13	12	11	10	9	8
C0MASK1L	CMID15	CMID14	CMID13	CMID12	CMID11	CMID10	CMID9	CMID8
	7	6	5	4	3	2	1	0
	CMID7	CMID6	CMID5	CMID4	CMID3	CMID2	CMID1	CMID0
C0MASK1H	15	14	13	12	11	10	9	8
	0	0	0	CMID28	CMID27	CMID26	CMID25	CMID24
	7	6	5	4	3	2	1	0
	CMID23	CMID22	CMID21	CMID20	CMID19	CMID18	CMID17	CMID16

- CAN Module Mask 2 Register (C0MASK2L, C0MASK2H)

After reset: Undefined R/W

	C0MASK2H FF76H, FF77H								
	15	14	13	12	11	10	9	8	
C0MASK2L	CMID15	CMID14	CMID13	CMID12	CMID11	CMID10	CMID9	CMID8	
	7	6	5	4	3	2	1	0	
	CMID7	CMID6	CMID5	CMID4	CMID3	CMID2	CMID1	CMID0	
C0MASK2H	15	14	13	12	11	10	9	8	
	0	0	0	CMID28	CMID27	CMID26	CMID25	CMID24	
	7	6	5	4	3	2	1	0	
	CMID23	CMID22	CMID21	CMID20	CMID19	CMID18	CMID17	CMID16	

Address: C0MASK2L FF74H, FF75H


	15	14	13	12	11	10	9	8
C0MASK3L	CMID15	CMID14	CMID13	CMID12	CMID11	CMID10	CMID9	CMID8
	7	6	5	4	3	2	1	0
	CMID7	CMID6	CMID5	CMID4	CMID3	CMID2	CMID1	CMID0
	15	14	13	12	11	10	9	8
C0MASK3H	0	0	0	CMID28	CMID27	CMID26	CMID25	CMID24
	7	6	5	4	3	2	1	0
	CMID23	CMID22	CMID21	CMID20	CMID19	CMID18	CMID17	CMID16

Address: COMASK3L FF78H, FF79H

COMASK3H FF7AH, FF7BH

- CAN Module Mask 3 Register (C0MASK3L, C0MASK3H)

After reset: Undefined R/W

- CAN Module Mask 4 Register (C0MASK4L, C0MASK4H)

After reset: Undefined R/W Address: C0MASK4L FF7CH, FF7DH C0MASK4H FF7EH, FF7FH

	15	14	13	12	11	10	9	8
C0MASK4L	CMID15	CMID14	CMID13	CMID12	CMID11	CMID10	CMID9	CMID8
	7	6	5	4	3	2	1	0
	CMID7	CMID6	CMID5	CMID4	CMID3	CMID2	CMID1	CMID0
	15	14	13	12	11	10	9	8
C0MASK4H	0	0	0	CMID28	CMID27	CMID26	CMID25	CMID24
	7	6	5	4	3	2	1	0
	CMID23	CMID22	CMID21	CMID20	CMID19	CMID18	CMID17	CMID16

CMID28-CMID0	Sets Mask Pattern of ID Bit.
0	The ID bits of the message buffer set by the CMID28 to CMID0 bits are compared with the ID bits of the received message frame.
1	The ID bits of the message buffer set by the CMID28 to CMID0 bits are not compared with the ID bits of the received message frame (they are masked).

**Remark** Masking is always defined by an ID length of 29 bits. If a mask is assigned to a message with a standard ID, CMID17 to CMID0 are ignored. Therefore, only CMID28 to CMID18 of the received ID are masked. The same mask can be used for both the standard and extended IDs.

# (6) CAN module control register (C0CTRL)

The COCTRL register is used to control the operation mode of the CAN module.

After reset: 0000H R/W Address: FF90H, FF91H

(a)	Read
-----	------

	15	14	13	12	11	10	9	8
C0CTRL	0	0	0	0	0	0	RSTAT	TSTAT
	7	6	5	4	3	2	1	0
	CCERC	AL	VALID	PSMODE1	PSMODE0	OPMODE2	OPMODE1	OPMODE0

(b) Write

	15	14	13	12	11	10	9	8
COCTRL	Set CCERC	Set AL	0	Set PSMODE1	Set PSMODE0	Set OPMODE2	Set OPMODE1	Set OPMODE0
	7	6	5	4	3	2	1	0
	Clear CCERC	Clear AL	Clear VALID	Clear PSMODE1	Clear PSMODE0	Clear OPMODE2	Clear OPMODE1	Clear OPMODE0

(a) Read

RSTAT	Reception Status Bit
0	Reception is stopped.
1	Reception is in progress.

Remark - The RSTAT bit is set to 1 under the following conditions (timing).

- The SOF bit of a receive frame is detected

- On occurrence of arbitration loss during a transmit frame
- The RSTAT bit is cleared to 0 under the following conditions (timing)
- When a recessive level is detected at the second bit of the interframe space
- On transition to the initialization mode at the first bit of the interframe space



TSTAT	Transmission Status Bit
0	Transmission is stopped.
1	Transmission is in progress.

**Remark** - The TSTAT bit is set to 1 under the following conditions (timing).

- The SOF bit of a transmit frame is detected

- The TSTAT bit is cleared to 0 under the following conditions (timing).

- During transition to bus-off state

- On occurrence of arbitration loss in transmit frame

- On detection of recessive level at the second bit of the interframe space

- On transition to the initialization mode at the first bit of the interframe space

CCERC	Error Counter Clear Bit
0	The C0ERC and C0INFO registers are not cleared in the initialization mode.
1	The C0ERC and C0INFO registers are cleared in the initialization mode.

**Remarks 1.** The CCERC bit is used to clear the C0ERC and C0INFO registers for re-initialization or forced recovery from the bus-off state. This bit can be set to 1 only in the initialization mode.

- 2. When the C0ERC and C0INFO registers have been cleared, the CCERC bit is also cleared to 0 automatically.
- **3.** The CCERC bit can be set to 1 at the same time as a request to change the initialization mode to an operation mode is made.
- 4. The receive data may be corrupted in case of setting the CCERC bit to (1) immediately after entering the INIT mode from self-test mode.

AL	Bit to Set Operation in Case of Arbitration Loss
0	Re-transmission is not executed in case of an arbitration loss in the single-shot mode.
1	Re-transmission is executed in case of an arbitration loss in the single-shot mode.

Remark The AL bit is valid only in the single-shot mode.

VALID	Valid Receive Message Frame Detection Bit
0	A valid message frame has not been received since the VALID bit was last cleared to 0.
1	A valid message frame has been received since the VALID bit was last cleared to 0.

**Remarks 1**. Detection of a valid receive message frame is not dependent upon storage in the receive message buffer (data frame) or transmit message buffer (remote frame).

2. Clear the VALID bit (0) before changing the initialization mode to an operation mode.

- **3.** If only two CAN nodes are connected to the CAN bus with one transmitting a message frame in the normal operation mode and the other in the receive-only mode, the VALID bit is not set to 1 before the transmitting node enters the error passive state, because in receive-only mode no acknowledge is generated.
- 4. In order to clear the VALID bit, set the Clear VALID bit to 1 first and confirm that the VALID bit is cleared. If it is not cleared, perform clearing processing again.



PSMODE1	PSMODE0	Power Save Mode
0	0	No power save mode is selected.
0	1	CAN sleep mode
1	0	Setting prohibited
1	1	CAN stop mode

Cautions1. Transition to and from the CAN stop mode must be made via CAN sleep mode. A request for direct transition to and from the CAN stop mode is ignored.

- 2. The MBON flag of C0GMCTRL must be checked after releasing a power save mode, prior to access the message buffers again.
- 3. CAN Sleep mode requests are kept pending, until cancelled by software or entered on appropriate bus condition (bus idle). Software can check the actual status by reading PSMODE.

OPMODE2	OPMODE1	OPMODE0	Operation Mode
0	0	0	No operation mode is selected (CAN module is in the initialization mode).
0	0	1	Normal operation mode
0	1	0	Normal operation mode with automatic block transmission function (normal operation mode with ABT)
0	1	1	Receive-only mode
1	0	0	Single-shot mode
1	0	1	Self-test mode
Other than above		ove	Setting prohibited

Caution Transit to initialization mode or power saving modes may take some time. Be sure to verify the success of mode change by reading the values, before proceeding.

Remark The OPMODE[2:0] bits are read-only in the CAN sleep mode or CAN stop mode.

(b) Write

Set CCERC	Clear CCERC	Setting of CCERC Bit
1	1	CCERC bit is set to 1.
Other than above	0	CCERC bit is not changed.

Set AL	Clear AL	Setting of AL Bit
0	1	AL bit is cleared to 0.
1	0	AL bit is set to 1.
Other than above		AL bit is not changed.



Clear VALID	Setting of VALID Bit
0	VALID bit is not changed.
1	VALID bit is cleared to 0.

Set PSMODE0	Clear PSMODE0	Setting of PSMODE0 Bit
0	1	PSMODE0 bit is cleared to 0.
1	0	PSMODE bit is set to 1.
Other the	an above	PSMODE0 bit is not changed.

Set PSMODE1	Clear PSMODE1	Setting of PSMODE1 Bit
0	1	PSMODE1 bit is cleared to 0.
1	0	PSMODE1 bit is set to 1.
Other than above		PSMODE1 bit is not changed.

Set OPMODE0	Clear OPMODE0	Setting of OPMODE0 Bit
0	1	OPMODE0 bit is cleared to 0.
1	0	OPMODE0 bit is set to 1.
Other than above		OPMODE0 bit is not changed.

Set OPMODE1	Clear OPMODE1	Setting of OPMODE1 Bit
0	1	OPMODE1 bit is cleared to 0.
1	0	OPMODE1 bit is set to 1.
Other than above		OPMODE1 bit is not changed.

Set OPMODE2	Clear OPMODE2	Setting of OPMODE2 Bit
0	1	OPMODE2 bit is cleared to 0.
1	0	OPMODE2 bit is set to 1.
Other than above		OPMODE2 bit is not changed.



# (7) CAN module last error code register (C0LEC)

The COLEC register provides the error information of the CAN protocol.

After reset: 00H		R/W	Address:	FF92H				
	7	6	5	4	3	2	1	0
COLEC	0	0	0	0	0	LEC2	LEC1	LEC0

- **Remarks 1.** The contents of the COLEC register are not cleared when the CAN module changes from an operation mode to the initialization mode.
  - **2.** If an attempt is made to write a value other than 00H to the C0LEC register by software, the access is ignored.

LEC2	LEC1	LEC0	Last CAN Protocol Error Information
0	0	0	No error
0	0	1	Stuff error
0	1	0	Form error
0	1	1	ACK error
1	0	0	Bit error (The CAN module tried to transmit a recessive-level bit as part of a transmit message (except the arbitration field), but the value on the CAN bus is a dominant-level bit.)
1	0	1	Bit error (The CAN module tried to transmit a dominant-level bit as part of a transmit message, ACK bit, error frame, or overload frame, but the value on the CAN bus is a recessive-level bit.)
1	1	0	CRC error
1	1	1	Undefined



# (8) CAN module information register (C0INFO)

The C0INFO register indicates the status of the CAN module.



BOFF	Bus-off State Bit
0	Not bus-off state (transmit error counter $\leq$ 255) (The value of the transmit counter is less than 256.)
1	Bus-off state (transmit error counter > 255) (The value of the transmit counter is 256 or more.)

TECS1	TECS0	Transmission Error Counter Status Bit
0	0	The value of the transmission error counter is less than that of the warning level (<96).
0	1	The value of the transmission error counter is in the range of the warning level (96 to 127).
1	0	Undefined
1	1	The value of the transmission error counter is in the range of the error passive or bus-off state ( $\geq$ 128).

RECS1	RECS0	Reception Error Counter Status Bit
0	0	The value of the reception error counter is less than that of the warning level (<96).
0	1	The value of the reception error counter is in the range of the warning level (96 to 127).
1	0	Undefined
1	1	The value of the reception error counter is in the error passive range ( $\geq$ 128).



# (9) CAN module error counter register (C0ERC)

R

After reset: 0000H

The C0ERC register indicates the count value of the transmission/reception error counter.

Address: FF94H, FF95H

	15	14	13	12	11	10	9	8
C0ERC	REPS	REC6	REC5	REC4	REC3	REC2	REC1	REC0
	7	6	5	4	3	2	1	0
	TEC7	TEC6	TEC5	TEC4	TEC3	TEC2	TEC1	TEC0

REPS	Reception error passive status bit
0	Reception error counter is not error passive (<128)
1	Reception error counter is error passive range (≥128)

REC6-REC0	Reception Error Counter Bit
0-127	Number of reception errors. These bits reflect the status of the reception error counter. The number of errors is defined by the CAN protocol.

**Remark** REC6 to REC0 of the reception error counter are invalid in the reception error passive state (RECS [1:0] = 11B).

TEC7-TEC0	Transmission Error Counter Bit			
0-255	Number of transmission errors. These bits reflect the status of the transmission error counter. The number of errors is defined by the CAN protocol.			

**Remark** TEC7 to TEC0 of the transmission error counter are invalid in the bus-off state (BOFF = 1).



# (10) CAN module interrupt enable register (C0IE)

The COIE register is used to enable or disable the interrupts of the CAN module.

After reset: 0000H R/W Address: FF96H, FF97H

# (a) Read

	15	14	13	12	11	10	9	8
COIE	0	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	CIE5	CIE4	CIE3	CIE2	CIE1	CIE0

## (b) Write

	15	14	13	12	11	10	9	8
COIE	0	0	Set CIE5	Set CIE4	Set CIE3	Set CIE2	Set CIE1	Set CIE0
	7	6	5	4	3	2	1	0
	0	0	Clear CIE5	Clear CIE4	Clear CIE3	Clear CIE2	Clear CIE1	Clear CIE0

# (a) Read

CIE5-CIE0	CAN Module Interrupt Enable Bit
0	Output of the interrupt corresponding to interrupt status register CINTS5 to CINTS0 bits is disabled.
1	Output of the interrupt corresponding to interrupt status register CINTS5 to CINTS0 bits is enabled.

# (b) Write

Set CIE5	Clear CIE5	Setting of CIE5 Bit
0	1	CIE5 bit is cleared to 0.
1	0	CIE5 bit is set to 1.
Other than above		CIE5 bit is not changed.

Set CIE4	Clear CIE4	Setting of CIE4 Bit
0	1	CIE4 bit is cleared to 0.
1	0	CIE4 bit is set to 1.
Other than above		CIE4 bit is not changed.



Set CIE3	Clear CIE3	Setting of CIE Bit
0	1	CIE3 bit is cleared to 0.
1	0	CIE3 bit is set to 1.
Other than above		CIE3 bit is not changed.

Set CIE2	Clear CIE2	Setting of CIE2 Bit
0	1	CIE2 bit is cleared to 0.
1	0	CIE2 bit is set to 1.
Other than above		CIE2 bit is not changed.

Set CIE1	Clear CIE1	Setting of CIE1 Bit
0	1	CIE1 bit is cleared to 0.
1	0	CIE1 bit is set to 1.
Other than above		CIE1 bit is not changed.

Set CIE0	Clear CIE0	Setting of CIE0 Bit
0	1	CIE0 bit is cleared to 0.
1	0	CIE0 bit is set to 1.
Other than above		CIE0 bit is not changed.



# (11) CAN module interrupt status register (C0INTS)

The COINTS register indicates the interrupt status of the CAN module.

After reset:	0000H	R/W	Address:	FF98H, FF99H

(a)	Read
-----	------

	15	14	13	12	11	10	9	8
COINTS	0	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	CINTS5	CINTS4	CINTS3	CINTS2	CINTS1	CINTS0
	0	0	CINTS5	CINTS4	CINTS3	CINTS2	CINTS1	CINT

#### (b) Write

	15	14	13	12	11	10	9	8
COINTS	0	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	Clear CINTS5	Clear CINTS4	Clear CINTS3	Clear CINTS2	Clear CINTS1	Clear CINTS0

#### (a) Read

CINTS5-CINTS0	CAN Interrupt Status Bit
0	No related interrupt source event is pending.
1	A related interrupt source event is pending.

Interrupt Status Bit	Related Interrupt Source Event
CINTS5	Wakeup interrupt from CAN sleep mode <sup>Note</sup>
CINTS4	Arbitration loss interrupt
CINTS3	CAN protocol error interrupt
CINTS2	CAN error status interrupt
CINTS1	Interrupt on completion of reception of valid message frame to message buffer m
CINTS0	Interrupt on normal completion of transmission of message frame from message buffer m

**Note** The CINTS5 bit is set only when the CAN module is woken up from the CAN sleep mode by a CAN bus operation. The CINTS5 bit is not set when the CAN sleep mode has been released by software.

## (b) Write

Clear CINTS5-CINTS0	Setting of CINTS5 to CINTS0 Bits
0	CINTS5 to CINTS0 bits are not changed.
1	CINTS5 to CINTS0 bits are cleared to 0.

Caution Please clear the status bit of this register with software when the confirmation of each status is necessary in the interrupt processing, because these bits are not cleared automatically.

# (12) CAN module bit rate prescaler register (C0BRP)

The C0BRP register is used to select the CAN protocol layer basic clock (frq). The communication baud rate is set to the C0BTR register.







## Caution The C0BRP register can be write-accessed only in the initialization mode.

# Remark fCAN: Clock supplied to CAN (fPRS)

fCANMOD: CAN module system clock

fTQ: CAN protocol layer basic system clock



# (13) CAN module bit rate register (C0BTR)

R/W

After reset: 370FH

The COBTR register is used to control the data bit time of the communication baud rate.

	15	14	13	12	11	10	9	8
COBTR	0	0	SJW1	SJW0	0	TSEG22	TSEG21	TSEG20
	7	6	5	4	3	2	1	0
	0	0	0	0	TSEG13	TSEG12	TSEG11	TSEG10

Address: FF9CH, FF9DH

## Figure 15-26. Data Bit Time





SJW1	SJW0	Length of Synchronization jump width
0	0	1TQ
0	1	2TQ
1	0	ЗТQ
1	1	4TQ (default value)

TSEG22	TSEG21	TSEG20	Length of time segment 2
0	0	0	1TQ
0	0	1	2TQ
0	1	0	ЗТQ
0	1	1	4TQ
1	0	0	5TQ
1	0	1	6TQ
1	1	0	7TQ
1	1	1	8TQ (default value)

TSEG13	TSEG12	TSEG11	TSEG10	Length of time segment 1
0	0	0	0	Setting prohibited
0	0	0	1	2TQ <sup>Note</sup>
0	0	1	0	3TQ <sup>Note</sup>
0	0	1	1	4TQ
0	1	0	0	5TQ
0	1	0	1	6TQ
0	1	1	0	7TQ
0	1	1	1	8TQ
1	0	0	0	9TQ
1	0	0	1	10TQ
1	0	1	0	11TQ
1	0	1	1	12TQ
1	1	0	0	13TQ
1	1	0	1	14TQ
1	1	1	0	15TQ
1	1	1	1	16TQ (default value)

**Note** This setting must not be made when the C0BRP register = 00H.

**Remark** TQ = 1/frq (frq: CAN protocol layer basic system clock)



# (14) CAN module last in-pointer register (C0LIPT)

The COLIPT register indicates the number of the message buffer in which a data frame or a remote frame was last stored.



LIPT7-LIPT0	Last In-Pointer Register (C0LIPT)
0 to 15	When the COLIPT register is read, the contents of the element indexed by the last in- pointer (LIPT) of the receive history list are read. These contents indicate the number of the message buffer in which a data frame or a remote frame was last stored.

**Remark** The read value of the COLIPT register is undefined if a data frame or a remote frame has never been stored in the message buffer. If the RHPM bit of the CORGPT register is set to 1 after the CAN module has changed from the initialization mode to an operation mode, therefore, the read value of the COLIPT register is undefined.



Clear

ROVF

# (15) CAN module receive history list register (C0RGPT)

0

0

0

The CORGPT register is used to read the receive history list.

R/W

(a) Read

After reset: xx02H

	15	14	13	12	11	10	9	8
C0RGPT	RGPT7	RGPT6	RGPT5	RGPT4	RGPT3	RGPT2	RGPT1	RGPT0
	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	RHPM	ROVF
(b) Write								
	15	14	13	12	11	10	9	8
C0RGPT	0	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0

0

0

0

0

Address: FF44H, FF45H

#### (a) Read

RGPT7-RGPT0	Receive History List Get Pointer
0 to 15	When the CORGPT register is read, the contents of the element indexed by the receive history list get pointer (RGPT) of the receive history list are read. These contents indicate the number of the message buffer in which a data frame or a remote frame has been stored.

RHPM <sup>№te</sup>	Receive History List Pointer Match
0	The receive history list has at least one message buffer number that has not been read.
1	The receive history list has no message buffer numbers that has not been read.

Note The read value of RGPT0 to RGPT7 is invalid when RHPM = 1.

ROVF	Receive History List Overflow Bit
0	All the message buffer numbers that have not been read are preserved. All the numbers of the message buffer in which a new data frame or remote frame has been received and stored are recorded to the receive history list (the receive history list has a vacant element).
1	At least 23 entries have been stored since the host processor has serviced the RHL last time (i.e. read C0RGPT). The first 22 entries are sequentially stored while the last entry can have been overwritten whenever newly received message is stored because all buffer numbers are stored at position LIPT-1 when ROVF bit is set. Thus the sequence of receptions can not be recovered completely now.

**Note** If ROVF is set, RHPM is no longer cleared on message storage, but RHPM is still set, if all entries of CORGPT are read by software.



(b) Write

Clear ROVF	Setting of ROVF Bit
0	ROVF bit is not changed.
1	ROVF bit is cleared to 0.

# (16) CAN module last out-pointer register (C0LOPT)

The C0LOPT register indicates the number of the message buffer to which a data frame or a remote frame was transmitted last.

After reset: Und	efined	R	Address:	FF42H					
	7	6	5	4	3	2	1	0	
COLOPT	LOPT7	LOPT6	LOPT5	LOPT4	LOPT3	LOPT2	LOPT1	LOPT0	
LOPT7-LOPT0		Last Out-Pointer of Transmit History List (LOPT)							
0 to 15	Wher pointe of the	When the C0LOPT register is read, the contents of the element indexed by the last out- pointer (LOPT) of the receive history list are read. These contents indicate the number of the message buffer to which a data frame or a remote frame was transmitted last.							

**Remark** The value read from the COLOPT register is undefined if a data frame or remote frame has never been transmitted from a message buffer. If the THPM bit is set to 1 after the CAN module has changed from the initialization mode to an operation mode, therefore, the read value of the COLOPT register is undefined.



# (17) CAN module transmit history list register (C0TGPT)

The C0TGPT register is used to read the transmit history list.

R/W

(a) Read

After reset: xx02H

	15	14	13	12	11	10	9	8
COTGPT	TGPT7	TGPT6	TGPT5	TGPT4	TGPT3	TGPT2	TGPT1	TGPT0
	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	THPM	TOVF
(b) Write								
	15	14	13	12	11	10	9	8
COTGPT	0	0	0	0	0	0	0	0

Address: FF4AH, FF4BH

TGPT	0	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	0	Clear TOVF

## (a) Read

TGPT7-TGPT0	Transmit History List Read Pointer
0 to 15	When the C0TGPT register is read, the contents of the element indexed by the read pointer (TGPT) of the transmit history list are read. These contents indicate the number of the message buffer to which a data frame or a remote frame was transmitted last.

THPM Note	Transmit History Pointer Match
0	The transmit history list has at least one message buffer number that has not been read.
1	The transmit history list has no message buffer number that has not been read.

**Note** The read value of TGPT0 to TGPT7 is invalid when THPM = 1.

TOVF	Transmit History List Overflow Bit
0	All the message buffer numbers that have not been read are preserved. All the numbers of the message buffers to which a new data frame or remote frame has been transmitted are recorded to the transmit history list (the transmit history list has a vacant element).
1	At least 7 entries have been stored since the host processor has serviced the THL last time (i.e. read C0TGPT). The first 6 entries are sequentially stored while the last entry can have been overwritten whenever a message is newly transmitted because all buffer numbers are stored at position LOPT-1 when TOVF bit is set. Thus the sequence of transmissions can not be recovered completely now.

**Note** If TOVF is set, THPM is no longer cleared on message transmission, but THPM is still set, if all entries of C0TGPT are read by software.

**Remark** Transmission from message buffer 0 to 7 is not recorded to the transmit history list in the normal operation mode with ABT.

RENESAS

# (b) Write

Clear TOVF	Setting of TOVF Bit				
0	TOVF bit is not changed.				
1	TOVF bit is cleared to 0.				

## (18) CAN module time stamp register (C0TS)

The C0TS register is used to control the time stamp function.

After reset: 0000H R/W Address: FF8AH, FF8BH

(a) Read

	15	14	13	12	11	10	9	8
COTS	0	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	0	0	0	TSLOCK	TSSEL	TSEN

# (b) Write

	15	14	13	12	11	10	9	8
COTS	0	0	0	0	0	Set TSLOCK	Set TSSEL	Set TSEN
	7	6	5	4	3	2	1	0

**Remark** The lock function of the time stamp function must not be used when the CAN module is in the normal operation mode with ABT.

## (a) Read

TSLOCK	Time Stamp Lock Function Enable Bit
0	Time stamp lock function stopped. The TSOUT signal is toggled each time the selected time stamp capture event occurs.
1	Time stamp lock function enabled. The TSOUT signal is toggled each time the selected time stamp capture event occurs. However, the TSOUT output signal is locked when a data frame has been correctly received to message buffer 0 <sup>Note</sup> .

Note The TSEN bit is automatically cleared to 0.

TSSEL	Time Stamp Capture Event Selection Bit			
0	The time stamp capture event is SOF.			
1	The time stamp capture event is the last bit of EOF.			



TSEN	TSOUT Signal Operation Setting Bit				
0	Disable TSOUT signal toggle operation.				
1	Enable TSOUT signal toggle operation.				

Remark The signal TSOUT is output from the CAN macro to a timer resource, depending on implementation. Refer to Figure 12-19 Format of Input Switch Control Register (ISC).

(b) Write

Set TSLOCK	Clear TSLOCK	Setting of TSLOCK Bit
0	1	TSLOCK bit is cleared to 0.
1	0	TSLOCK bit is set to 1.
Other than above		TSLOCK bit is not changed.

Set TSSEL	Clear TSSEL	Setting of TSSEL Bit
0	1	TSSEL bit is cleared to 0.
1	0	TSSEL bit is set to 1.
Other than above		TSSEL bit is not changed.

Set TSEN	Clear TSEN	Setting of TSEN Bit
0	1	TSEN bit is cleared to 0.
1	0	TSEN bit is set to 1.
Other than above		TSEN bit is not changed.



# (19) CAN message data byte register (C0MDATAxm)(x = 0 to 7), (C0MDATAzm) (z = 01, 23, 45, 67)

The COMDATAxm, COMDATAzm registers are used to store the data of a transmit/receive message. The COMDATAxm registers can access in 8-bit units. The COMDATAzm registers can access the COMDATAxm registers in 16-bit units.

After reset: Undefined R/W Address: See Table 15-16 Register Access Types.

- COMDATAxm Register

MDATA01	MDATA00
1	0
MDATA11	MDATA10
1	0
MDATA21	MDATA20
1	0
MDATA31	MDATA30
1	0
MDATA41	MDATA40
1	0
MDATA51	MDATA50
1	0
MDATA61	MDATA60
1	0
MDATA71	MDATA70
	2 MDATA01 1 2 MDATA11 1 2 MDATA21 1 2 MDATA21 1 2 MDATA31 1 2 MDATA51 1 2 MDATA61 1 2 MDATA61 1



# - COMDATAzm Register

	15	14	13	12	11	10	9	8
C0MDATA01m	MDATA011 5	MDATA011 4	MDATA011 3	MDATA011 2	MDATA011 1	MDATA011 0	MDATA019	MDATA018
	7	6	5	4	3	2	1	0
	MDATA017	MDATA016	MDATA015	MDATA014	MDATA013	MDATA012	MDATA011	MDATA010
	15	14	13	12	11	10	9	8
C0MDATA23m	MDATA231 5	MDATA231 4	MDATA231 3	MDATA231 2	MDATA231 1	MDATA231 0	MDATA239	MDATA238
	7	6	5	4	3	2	1	0
	MDATA237	MDATA236	MDATA235	MDATA234	MDATA233	MDATA232	MDATA231	MDATA230
	15	14	13	12	11	10	9	8
C0MDATA45m	MDATA451 5	MDATA451 4	MDATA451 3	MDATA451 2	MDATA451 1	MDATA451 0	MDATA459	MDATA458
	7	6	5	4	3	2	1	0
	MDATA457	MDATA456	MDATA455	MDATA454	MDATA453	MDATA452	MDATA451	MDATA450
	15	14	13	12	11	10	9	8
C0MDATA67m	MDATA671 5	MDATA671 4	MDATA671 3	MDATA671 2	MDATA671 1	MDATA671 0	MDATA679	MDATA678
	7	6	5	4	3	2	1	0
	MDATA677	MDATA676	MDATA675	MDATA674	MDATA673	MDATA672	MDATA671	MDATA670



# (20) CAN message data length register m (C0MDLCm)

R/W

After reset: 0000xxxxB

The COMDLCm register is used to set the number of bytes of the data field of a message buffer.

Address: See Table 15-16 Register Access Types. C0MDLCm MDLC3 MDLC2 MDLC1 MDLC0 MDLC3 MDLC2 MDLC1 MDLC0 Data Length Of Transmit/Receive Message 0 bytes 1 byte 2 bytes 3 bytes 4 bytes 5 bytes 6 bytes 7 bytes 8 bytes Setting prohibited (If these bits are set during transmission, 8-byte data is transmitted regardless of the set DLC value when a data frame is transmitted. However, the DLC actually transmitted to the CAN bus is the DLC value set to this register.)Note 

Note The data and DLC value actually transmitted to CAN bus are as follows.

Type of Transmit Frame	Length of Transmit Data	DLC Transmitted
Data frame	Number of bytes specified by DLC (However, 8 bytes if $DLC \ge 8$ )	MDLC[3:0]
Remote frame	0 bytes	

Cautions 1. Be sure to set bits 7 to 4 0000B.

2. Receive data is stored in as many COMDATAxm as the number of bytes (however, the upper limit is 8) corresponding to DLC of the received frame. COMDATAxm in which no data is stored is undefined.



# (21) CAN message configuration register (C0MCONFm)

The COMCONFm register is used to specify the type of the message buffer and to set a mask.



OWS	Overwrite Control Bit
0	The message buffer that has already received a data frame <sup>Note</sup> is not overwritten by a newly received data frame. The newly received data frame is discarded.
1	The message buffer that has already received a data frame <sup>Note</sup> is overwritten by a newly received data frame.

**Note** The "message buffer that has already received a data frame" is a receive message buffer whose DN bit has been set to 1.

**Remark** A remote frame is received and stored, regardless of the setting of OWS bit and DN bit. A remote frame that satisfies the other conditions (ID matches, RTR = 0, TRQ = 0) is always received and stored in the corresponding message buffer (interrupt generated, DN flag set, MDLC [3:0] bits updated, and recorded to the receive history list).

RTR	Remote Frame Request Bit <sup>Note</sup>
0	Transmit a data frame.
1	Transmit a remote frame.

**Note** The RTR bit specifies the type of message frame that is transmitted from a message buffer defined as a transmit message buffer. Even if a valid remote frame has been received, RTR of the transmit message buffer that has received the frame remains cleared to 0. Even if a remote frame whose ID matches has been received from the CAN bus with the RTR bit of the transmit message buffer set to 1 to transmit a remote frame, that remote frame is not received or stored (interrupt generated, DN flag set, MDLC [3:0] bits updated, and recorded to the receive history list).

MT2	MT1	MT0	Message Buffer Type Setting Bit
0	0	0	Transmit message buffer
0	0	1	Receive message buffer (no mask setting)
0	1	0	Receive message buffer (mask 1 set)
0	1	1	Receive message buffer (mask 2 set)
1	0	0	Receive message buffer (mask 3 set)
1	0	1	Receive message buffer (mask 4 set)
Other than above		ove	Setting prohibited



MA0	Message Buffer Assignment Bit
0	Message buffer not used.
1	Message buffer used.

Caution Be sure to write 0 to bits 2 and 1.

## (22) CAN message id register m (C0MIDLm, C0MIDHm)

The COMIDLm and COMIDHm registers are used to set an identifier (ID).

After reset: Undefined R/W Address	See Table 15-16 Register Access Types.
------------------------------------	--

	15	14	13	12	11	10	9	8
C0MIDLm	ID15	ID14	ID13	ID12	ID11	ID10	ID9	ID8
	7	6	5	4	3	2	1	0
	ID7	ID6	ID5	ID4	ID3	ID2	ID1	ID0
-								
	15	14	13	12	11	10	9	8
C0MIDHm	IDE	0	0	ID28	ID27	ID26	ID25	ID24
	7	6	5	4	3	2	1	0
	ID23	ID22	ID21	ID20	ID19	ID18	ID17	ID16
C0MIDHm	1D7 15 1DE 7 1D23	ID6 14 0 6 ID22	ID5 13 0 5 ID21	ID4 12 ID28 4 ID20	ID3 11 ID27 3 ID19	10 102 1026 2 1D18	ID1 9 ID25 1 ID17	ID 8 ID2 0 ID1

IDE	Format Mode Specification Bit
0	Standard format mode (ID28 to ID18: 11 bits) <sup>Note</sup>
1	Extended format mode (ID28 to ID0: 29 bits)

Note The ID17 to ID0 bits are not used.

ID28 to ID0	Message ID
ID28 to ID18	Standard ID value of 11 bits (when IDE = 0)
ID28 to ID0	Extended ID value of 29 bits (when IDE = 1)

Cautions 1. Be sure to write 0 to bits 14 and 13 of the COMIDHm register.

2. Be sure to align the ID value according to the given bit positions into this registers. Note that for standard ID, the ID value must be shifted to fit into ID28 to ID11 bit positions.



# (23) CAN message control register m (C0MCTRLm)

The COMCTRLm register is used to control the operation of the message buffer.

After reset:	00x00000	R/W	Address:	See Table 15-16	<b>Register Access</b>	Types.
	0000000B					

# (a) Read

	15	14	13	12	11	10	9	8
COMCTRLm	0	0	MUC	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	0	MOW	IE	DN	TRQ	RDY

## (b) Write

	15	14	13	12	11	10	9	8
C0MCTRLm	0	0	0	0	Set IE	0	Set TRQ	Set RDY
	7	6	5	4	3	2	1	0
	0	0	0	Clear MOW	Clear IE	Clear DN	Clear TRQ	Clear RDY

# (a) Read

MUC <sup>Note</sup>	Message Buffer Data Updating Bit
0	The CAN module is not updating the message buffer (reception and storage).
1	The CAN module is updating the message buffer (reception and storage).

**Note** The MUC bit is undefined until the first reception and storage is performed.

MOW	Message Buffer Overwrite Status Bit
0	The message buffer is not overwritten by a newly received data frame.
1	The message buffer is overwritten by a newly received data frame.

**Remark** MOW bit is not set to 1 even if a remote frame is received and stored in the transmit message buffer with DN = 1.

Ē	Message Buffer Interrupt Request Enable Bit
0	Receive message buffer: Valid message reception completion interrupt disabled. Transmit message buffer: Normal message transmission completion interrupt disabled.
1	Receive message buffer: Valid message reception completion interrupt enabled. Transmit message buffer: Normal message transmission completion interrupt enabled.



DN	Message Buffer Data Updating Bit
0	A data frame or remote frame is not stored in the message buffer.
1	A data frame or remote frame is stored in the message buffer.

TRQ	Message Buffer Transmission Request Bit
0	No message frame transmitting request that is pending or being transmitted is in the message buffer.
1	The message buffer is holding transmission of a message frame pending or is transmitting a message frame.

# Caution Do not set the TRQ bit and the RDY bit (1) at the same time. Set the RDY bit (1) before setting the TRQ bit.

RDY	Message Buffer Ready Bit
0	The message buffer can be written by software. The CAN module cannot write to the message buffer.
1	Writing the message buffer by software is ignored (except a write access to the RDY, TRQ, DN, and MOW bits). The CAN module can write to the message buffer.

## Cautions1. Do not clear the RDY bit (0) during message transmission.

Follow the transmission abort process about clearing the RDY bit (0) for redefinition of the message buffer.

- 2. Clear again when RDY bit is not cleared even if this bit is cleared.
- 3. Be sure that RDY is cleared before writing to the message buffer registers. Perform this confirmation by reading back the RDY bit. However, setting the TRQ bit, clearing the DN bit, setting the RDY bit or clearing the MOW bit of the C0MCTRLm register need not be confirmed.

## (b) Write

Clear MOW	Setting of MOW Bit		
0	MOW bit is not changed.		
1	MOW bit is cleared to 0.		

Set IE	Clear IE	Setting of IE Bit
0	1	IE bit is cleared to 0.
1	0	IE bit is set to 1.
Other than above		IE bit is not changed.

## Caution Set IE bit and RDY bit always separately.

Clear DN	Setting of DN Bit
0	DN bit is not changed.
1	DN bit is cleared to 0.

Caution Do not set the DN bit to 1 by software. Be sure to write 0 to bit 10.

Set TRQ	Clear TRQ	Setting of TRQ Bit
0	1	TRQ bit is cleared to 0.
1	0	TRQ bit is set to 1.
Other than above		TRQ bit is not changed.

Caution While receiving a message from another node or transmitting the messages, there is a possibility of not to begin immediately the transmission even if the TRQ bit is set to 1.

The transmission is not aborted even if the TRQ bit is cleared to 0. The transmission is continued if a message is currently being transmitted and until the transmission is completed (successfully or not).

Set RDY	Clear RDY	Setting of RDY Bit
0	1	RDY bit is cleared to 0.
1	0	RDY bit is set to 1.
Other than above		RDY bit is not changed.

Caution Set IE bit and RDY bit always separately.



# 15.8 CAN Controller Initialization

## 15.8.1 Initialization of CAN module

Before the CAN module operation is enabled, the CAN module system clock needs to be determined by setting the CCP[3:0] bits of the C0GMCS register by software. Do not change the setting of the CAN module system clock after CAN module operation is enabled.

The CAN module is enabled by setting the GOM bit of the C0GMCTRL register.

For the procedure of initializing the CAN module, refer to **15.16** Operation Of CAN Controller.

## 15.8.2 Initialization of message buffer

After the CAN module is enabled, the message buffers contain undefined values. A minimum initialization for all the message buffers, even for those not used in the application, is necessary before switching the CAN module from the initialization mode to one of the operation modes.

- Clear the RDY, TRQ, and DN bits of the COMCTRLm register to 0.
- Clear the MA0 bit of the C0MCONFm register to 0.

**Remark** m = 0 to 15

## 15.8.3 Redefinition of message buffer

Redefining a message buffer means changing the ID and control information of the message buffer while a message is being received or transmitted, without affecting other transmission/reception operations.

## (1) To redefine message buffer in initialization mode

Place the CAN module in the initialization mode once and then change the ID and control information of the message buffer in the initialization mode. After changing the ID and control information, set the CAN module in an operation mode.

## (2) To redefine message buffer during reception

Perform redefinition as shown in Figure 15-40. Message Buffer Redefinition.

## (3) To redefine message buffer during transmission

To rewrite the contents of a transmit message buffer to which a transmission request has been set, perform transmission abort processing (refer to 15.10.4 (1) Transmission abort process except for in normal operation mode with automatic block transmission (ABT) and 15.10.4 (2) Transmission abort process except for ABT transmission in normal operation mode with automatic block transmission (ABT). Confirm that transmission has been aborted or completed, and then redefine the message buffer. After redefining the transmit message buffer, set a transmission request using the procedure described below. When setting a transmission request to a message buffer that has been redefined without aborting the transmission in progress, however, the 1-bit wait time is not necessary.





#### Figure 15-27. Setting Transmission Request (TRQ) to Transmit Message Buffer After Redefining

- Cautions1. When a message is received, reception filtering is performed in accordance with the ID and mask set to each receive message buffer. If the procedure in Figure 15-40. Message Buffer Redefinition is not observed, the contents of the message buffer after it has been redefined may contradict the result of reception (result of reception filtering). If this happens, check that the ID and IDE received first and stored in the message buffer following redefinition are those stored after the message buffer has been redefined. If no ID and IDE are stored after redefinition, redefine the message buffer again.
  - 2. When a message is transmitted, the transmission priority is checked in accordance with the ID, IDE, and RTR bits set to each transmit message buffer to which a transmission request was set. The transmit message buffer having the highest priority is selected for transmission. If the procedure in Figure 15-41. Message Buffer Redefinition during Transmission is not observed, a message with an ID not having the highest priority may be transmitted after redefinition.

## 15.8.4 Transition from initialization mode to operation mode

The CAN module can be switched to the following operation modes.

- Normal operation mode
- Normal operation mode with ABT
- Receive-only mode
- Single-shot mode
- Self-test mode





Figure 15-28. Transition to Operation Modes

The transition from the initialization mode to an operation mode is controlled by the bit string OPMODE [2:0] in the COCTRL register.

Changing from one operation mode into another requires shifting to the initialization mode in between. Do not change one operation mode to another directly; otherwise the operation will not be guaranteed.

Requests for transition from the operation mode to the initialization mode are held pending when the CAN bus is not in the interframe space (i.e., frame reception or transmission is in progress), and the CAN module enters the initialization mode at the first bit in the interframe space (the value of OPMODE [2:0] are changed to 00H). After issuing a request to change the mode to the initialization mode, read the OPMODE [2:0] bits until their value becomes 000B to confirm that the module has entered the initialization mode (refer to **Figure 15-37. Initialization**).

#### 15.8.5 Resetting error counter C0ERC of CAN module

If it is necessary to reset the CAN module error counter register C0ERC and the CAN module information register C0INFO when re-initialization or forced recovery from the bus-off state is made, set the CCERC bit of the C0CTRL register to 1 in the initialization mode. When this bit is set to 1, the CAN module error counter register C0ERC and the CAN module information register C0INFO are cleared to their default values.



# 15.9 Message Reception

## 15.9.1 Message reception

In all the operation modes, the complete message buffer area is analyzed to find a suitable buffer to store a newly received message. All message buffers satisfying the following conditions are included in that evaluation (RX-search process).

- Used as a message buffer

(MA0 bit of COMCONFm register set to 1B.)

- Set as a receive message buffer

(MT [2:0] bits of COMCONFm register set to 001B, 010B, 011B, 100B, or 101B.)

Ready for reception

(RDY bit of COMCTRLm register set to 1.)

When two or more message buffers of the CAN module receive a message, the message is stored according to the priority explained below. The message is always stored in the message buffer with the highest priority, not in a message buffer with a low priority. For example, when an unmasked receive message buffer and a receive message buffer linked to mask 1 have the same ID, the received message is not stored in the message buffer linked to mask 1, even if that message buffer has not received a message and a message has already been received in the unmasked receive message buffer. In other words, when a condition has been set to store a message in two or more message buffers with different priorities, the message buffer with the highest priority always stores the message; the message is not stored in message buffers with a lower priority. This also applies when the message buffer with the highest priority is unable to receive and store a message (i.e., when DN = 1 indicating that a message has already been received and stored in the candidate message buffer with the highest priority, but neither is it stored in a message buffer with a lower priority.

Priority	Storing Condition If Same ID is Set				
1 (high)	Unmasked message buffer	DN = 0			
		DN = 1 and OWS = 1			
2	Message buffer linked to mask 1	DN = 0			
		DN = 1 and OWS = 1			
3	Message buffer linked to mask 2	DN = 0			
		DN = 1 and $OWS = 1$			
4	Message buffer linked to mask 3	DN = 0			
		DN = 1 and $OWS = 1$			
5(low)	Message buffer linked to mask 4	DN = 0			
		DN = 1 and OWS = 1			

Remark m = 0 to 15



# 15.9.2 Receive Data Read

To keep data consistency when reading CAN message buffers, perform the data reading according to **Figures 15-51** to **15-53**.

During message reception, the CAN module sets DN of the COMCTRLm register two times: at the beginning of the storage process of data to the message buffer, and again at the end of this storage process. During this storage process, the MUC bit of the COMCTRLm register of the message buffer is set (Refer to **Figure 15-29**).

The receive history list is also updated just before the storage process. In addition, during storage process (MUC = 1), the RDY bit of the COMCTRL register of the message buffer is locked to avoid the coincidental data WR by CPU. Note the storage process may be disturbed (delayed) when the CPU accesses the message buffer.



Figure 15-29. DN and MUC Bit Setting Period (for Standard ID Format)

Remark m = 0 to 15



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#### 15.9.3 Receive history list function

The receive history list (RHL) function records in the receive history list the number of the receive message buffer in which each data frame or remote frame was received and stored. The RHL consists of storage elements equivalent to up to 23 messages, the last in-message pointer (LIPT) with the corresponding C0LIPT register and the receive history list get pointer (RGPT) with the corresponding C0RGPT register.

The RHL is undefined immediately after the transition of the CAN module from the initialization mode to one of the operation modes.

The C0LIPT register holds the contents of the RHL element indicated by the value of the LIPT pointer minus 1. By reading the C0LIPT register, therefore, the number of the message buffer that received and stored a data frame or remote frame first can be checked. The LIPT pointer is utilized as a write pointer that indicates to what part of the RHL a message buffer number is recorded. Any time a data frame or remote frame is received and stored, the corresponding message buffer number is recorded to the RHL element indicated by the LIPT pointer. Each time recording to the RHL has been completed, the LIPT pointer is automatically incremented. In this way, the number of the message buffer that has received and stored a frame will be recorded chronologically.

The RGPT pointer is utilized as a read pointer that reads a recorded message buffer number from the RHL. This pointer indicates the first RHL element that the CPU has not read yet. By reading the CORGPT register by software, the number of a message buffer that has received and stored a data frame or remote frame can be read. Each time a message buffer number is read from the CORGPT register, the RGPT pointer is automatically incremented.

If the value of the RGPT pointer matches the value of the LIPT pointer, the RHPM bit (receive history list pointer match) of the CORGPT register is set to 1. This indicates that no message buffer number that has not been read remains in the RHL. If a new message buffer number is recorded, the LIPT pointer is incremented and because its value no longer matches the value of the RGPT pointer, the RHPM bit is cleared. In other words, the numbers of the unread message buffers exist in the RHL.

If the LIPT pointer is incremented and matches the value of the RGPT pointer minus 1, the ROVF bit (receive history list overflow) of the CORGPT register is set to 1. This indicates that the RHL is full of numbers of message buffers that have not been read. When further message reception and storing occur, the last recorded message buffer number is overwritten by the number of the message buffer that received and stored the new message. In this case, after the ROVF bit has been set (1), the recorded message buffer numbers in the RHL do not completely reflect the chronological order. However messages itself are not lost and can be located by CPU search in message buffer memory with the help of the DN bit.

Caution If the history list is in the overflow condition (ROVF is set), reading the history list contents is still possible, until the history list is empty (indicated by RHPM flag set). Nevertheless, the history list remains in the overflow condition, until ROVF is cleared by software. If ROVF is not cleared, the RHPM flag will also not be updated (cleared) upon a message storage of newly received frame. This may lead to the situation, that RHPM indicates an empty history list, although a reception has taken place, while the history list is in the overflow state (ROVF and RHPM are set).



As long as the RHL contains 23 or less entries the sequence of occurrence is maintained. If more receptions occur without reading the RHL by the host processor, complete sequence of receptions can not be recovered.



## Figure 15-30. Receive History List

ROVF = 1 denotes that LIPT equals RGPT-1 while message buffer number stored to element indicated by LIPT-1.



## 15.9.4 Mask function

For any message buffer, which is used for reception, the assignment to one of four global reception masks (or no mask) can be selected.

By using the mask function, the message ID comparison can be reduced by masked bits, herewith allowing the reception of several different IDs into one buffer.

While the mask function is in effect, an identifier bit that is defined to be "1" by a mask in the received message is not compared with the corresponding identifier bit in the message buffer.

However, this comparison is performed for any bit whose value is defined as "0" by the mask.

For example, let us assume that all messages that have a standard-format ID, in which bits ID27 to ID25 are "0" and bits ID24 and ID22 are "1", are to be stored in message buffer 14. The procedure for this example is shown below.

<1> Identifier to be stored in message buffer

ID28	ID27	ID26	ID25	ID24	ID23	ID22	ID21	ID20	ID19	ID18
x	0	0	0	1	х	1	x	х	х	х

x = don't care

<2> Identifier to be configured in message buffer 14 (example)

(using CANn message ID registers L14 and H14 (C0MIDL14 and C0MIDH14))

ID28	ID27	ID26	ID25	ID24	ID23	ID22	ID21	ID20	ID19	ID18
х	0	0	0	1	х	1	х	х	х	х
ID17	ID16	ID15	ID14	ID13	ID12	ID11	ID10	ID9	ID8	ID7
х	x	x	х	x	х	x	x	x	x	x
ID6	ID5	ID4	ID3	ID2	ID1	ID0	_			
x	x	x	х	х	х	х				

ID with ID27 to ID25 cleared to "0" and ID24 and ID22 set to "1" is registered (initialized) to message buffer 14.

**Remark** Message buffer 14 is set as a standard format identifier that is linked to mask 1 (MT [2:0] of C0MCONF14 register are set to 010B).


<3> Mask setting for CAN module 1 (mask 1) (Example)

(Using CAN1 address mask 1 registers L and H (C1MASK1L and C1MASK1H))

CMID28	CMID27	CMID26	CMID25	CMID24	CMID23	CMID22	CMID21	CMID20	CMID19	CMID18
1	0	0	0	0	1	0	1	1	1	1
CMID17	CMID16	CMID15	CMID14	CMID13	CMID12	CMID11	CMID10	CMID9	CMID8	CMID7
1	1	1	1	1	1	1	1	1	1	1
CMID6	CMID5	CMID4	CMID3	CMID2	CMID1	CMID0	_			
1	1	1	1	1	1	1				

1: Not compared (masked)

0: Compared

The CMID27 to CMID24 and CMID22 bits are cleared to "0", and CMID28, CMID23, and CMID21 to CMID0 bits are set to "1".



#### 15.9.5 Multi buffer receive block function

The multi buffer receive block (MBRB) function is used to store a block of data in two or more message buffers sequentially with no CPU interaction, by setting the same ID to two or more message buffers with the same message buffer type.

Suppose, for example, the same message buffer type is set to 5 message buffers, message buffers 10 to 14, and the same ID is set to each message buffer. If the first message whose ID matches the ID of the message buffers is received, it is stored in message buffer 10. At this point, the DN bit of message buffer 10 is set, prohibiting overwriting the message buffer when subsequent messages are received.

If the next message with a matching ID is received, it is received and stored in message buffer 11. Each time a message with a matching ID is received, it is sequentially (in the ascending order) stored in message buffers 12, 13, and 14. Even when a data block consisting of multiple messages is received, the messages can be stored and received without overwriting the previously received matching-ID data.

Whether a data block has been received and stored can be checked by setting the IE bit of the COMCTRLm register of each message buffer. For example, if a data block consists of k messages, k message buffers are initialized for reception of the data block. The IE bit in message buffers 0 to (k-2) is cleared to 0 (interrupts disabled), and the IE bit in message buffer k-1 is set to 1 (interrupts enabled). In this case, a reception completion interrupt occurs when a message has been received and stored in message buffer k-1, indicating that MBRB has become full. Alternatively, by clearing the IE bit of message buffers 0 to (k-3) and setting the IE bit of message buffer k-2, a warning that MBRB is about to overflow can be issued.

The basic conditions of storing receive data in each message buffer for the MBRB are the same as the conditions of storing data in a single message buffer.

- Cautions 1. MBRB can be configured for each of the same message buffer types. Therefore, even if a message buffer of another MBRB whose ID matches but whose message buffer type is different has a vacancy, the received message is not stored in that message buffer, but instead discarded.
  - 2. MBRB does not have a ring buffer structure. Therefore, after a message is stored in the message buffer having the highest number in the MBRB configuration, a newly received message will not be stored in the message buffer having the lowest message buffer number.
  - 3. MBRB operates based on the reception and storage conditions; there are no settings dedicated to MBRB, such as function enable bits. By setting the same message buffer type and ID to two or more message buffers, MBRB is automatically configured.
  - 4. With MBRB, "matching ID" means "matching ID after mask". Even if the ID set to each message buffer is not the same, if the ID that is masked by the mask register matches, it is considered a matching ID and the buffer that has this ID is treated as the storage destination of a message.
  - 5. The priority between MBRBs is mentioned in 15.9.1 Message reception.



## 15.9.6 Remote frame reception

In all the operation modes, when a remote frame is received, the message buffer that is to store the remote frame is searched from all the message buffers satisfying the following conditions.

- Used as a message buffer
- (MA0 bit of C0MCONFm register set to 1B.)
- Set as a transmit message buffer

(MT[2:0] bits in C0MCONFm register set to 000B)

- Ready for reception
- (RDY bit of COMCTRLm register set to 1.)
- Set to transmit message
- (RTR bit of COMCONFm register is cleared to 0.)
- Transmission request is not set.
- (TRQ bit of COMCTRLm register is cleared to 0.)

Upon acceptance of a remote frame, the following actions are executed if the ID of the received remote frame matches the ID of a message buffer that satisfies the above conditions.

- The MDLC [3:0] bit string in the COMDLCm register stores the received DLC value.
- COMDATA0m to COMDATA7m in the data area are not updated (data before reception is saved).
- The DN bit of the COMCTRLm register is set to 1.
- The CINTS1 bit of the COINTS register is set to 1 (if the IE bit in the COMCTRLm register of the message buffer that receives and stores the frame is set to 1).
- The reception completion interrupt (INTCOREC) is output (if the IE bit in the COMCTRLm register of the message buffer that receives and stores the frame is set to 1 and if the CIE1 bit of the COIE register is set to 1).
- The message buffer number is recorded to the receive history list.
  - Caution When a message buffer is searched for receiving and storing a remote frame, overwrite control by the OWS bit of the COMCONFm register of the message buffer and the DN bit of the COMCTRLm register are not affected. The setting of OWS is ignored, and DN is set in any case. If more than one transmit message buffer has the same ID and the ID of the received remote frame matches that ID, the remote frame is stored in the transmit message buffer with the lowest message buffer number.



## 15.10 Message Transmission

## 15.10.1 Message transmission

In all the operation modes, if the TRQ bit is set to 1 in a message buffer that satisfies the following conditions, the message buffer that is to transmit a message is searched.

- Used as a message buffer

(MA0 bit of C0MCONFm register set to 1B.)

- Set as a transmit message buffer

(MT [2:0] bits of COMCONFm register set to 000B.)

- Ready for transmission

(RDY bit of COMCTRLm register set to 1.)

The CAN system is a multi-master communication system. In a system like this, the priority of message transmission is determined based on message identifiers (IDs). To facilitate transmission processing by software when there are several messages awaiting transmission, the CAN module uses hardware to check the ID of the message with the highest priority and automatically identifies that message. This eliminates the need for software based priority control.

Transmission priority is controlled by the identifier (ID).

## Figure 15-31. Message Processing Example



After the transmit message search, the transmit message with the highest priority of the transmit message buffers that have a pending transmission request (message buffers with the TRQ bit set to 1 in advance) is transmitted.

If a new transmission request is set, the transmit message buffer with the new transmission request is compared with the transmit message buffer with a pending transmission request. If the new transmission request has a higher priority, it is transmitted, unless transmission of a message with a low priority has already started. If transmission of a message with a low priority has already started, however, the new transmission request is transmitted later. To solve this priority inversion effect, the software can perform a transmission abort request for the lower priority message. The highest priority is determined according to the following rules.



Priority	Conditions	Description
1(high)	Value of first 11 bits of ID [ID28 to ID18]:	The message frame with the lowest value represented by the first 11 bits of the ID is transmitted first. If the value of an 11-bit standard ID is equal to or smaller than the first 11 bits of a 29-bit extended ID, the 11-bit standard ID has a higher priority than message frame with the 29-bit extended ID.
2	Frame type	A data frame with an 11-bit standard ID (RTR bit is cleared to 0) has a higher priority than a remote frame with a standard ID and a message frame with an extended ID.
3	ID type	A message frame with a standard ID (IDE bit is cleared to 0) has a higher priority than a message frame with an extended ID.
4	Value of lower 18 bits of ID [ID17 to ID0]:	If more than one transmission-pending extended ID message frame have equal values in the first 11 bits of the ID and the same frame type (equal RTR bit values), the message frame with the lowest value in the lower 18 bits of its extended ID is transmitted first.
5(low)	Message buffer number	If two or more message buffers request transmission of message frames with the same ID, the message from the message buffer with the lowest message buffer number is transmitted first.

**Remarks 1.** If automatic block transmission request bit ABTTRG is set to 1 in the normal operation mode with ABT, the TRQ bit is set to 1 only for one message buffer in the ABT message buffer group.

If the ABT mode was triggered by ABTTRG bit, one TRQ bit is set to 1 in the ABT area (buffer 0 through 7). Beyond this TRQ bit, the application can request transmissions (set TRQ to 1) for other TX-message buffers that do not belong to the ABT area. In that case an interval arbitration process (TX-search) evaluates all TX-message buffers with TRQ bit set to 1 and chooses the message buffer that contains the highest prioritized identifier for the next transmission. If there are 2 or more identifiers that have the highest priority (i.e. identical identifiers), the message located at the lowest message buffer number is transmitted at first.

Upon successful transmission of a message frame, the following operations are performed.

- The TRQ flag of the corresponding transmit message buffer is automatically cleared to 0.
- The transmission completion status bit CINTS0 of the COINTS register is set to 1 (if the interrupt enable bit (IE) of the corresponding transmit message buffer is set to 1).
- An interrupt request signal INTCOTRX output (if the CIE0 bit of the COIE register is set to 1 and if the interrupt enable bit (IE) of the corresponding transmit message buffer is set to 1).
- 2.When changing the contents of a transmit buffer, the RDY flag of this buffer must be cleared before updating the buffer contents. As during internal transfer actions, the RDY flag may be locked temporarily, the status of RDY must be checked by software, after changing it.

**3.** m = 0 to 15



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#### 15.10.2 Transmit history list function

The transmit history list (THL) function records in the transmit history list the number of the transmit message buffer from which data or remote frames have been were sent. The THL consists of storage elements equivalent to up to seven messages, the last out-message pointer (LOPT) with the corresponding C0LOPT register, and the transmit history list get pointer (TGPT) with the corresponding C0TGPT register.

The THL is undefined immediately after the transition of the CAN module from the initialization mode to one of the operation modes.

The COLOPT register holds the contents of the THL element indicated by the value of the LOPT pointer minus 1. By reading the COLOPT register, therefore, the number of the message buffer that transmitted a data frame or remote frame first can be checked. The LOPT pointer is utilized as a write pointer that indicates to what part of the THL a message buffer number is recorded. Any time a data frame or remote frame is transmitted, the corresponding message buffer number is recorded to the THL element indicated by the LOPT pointer. Each time recording to the THL has been completed, the LOPT pointer is automatically incremented. In this way, the number of the message buffer that has received and stored a frame will be recorded chronologically.

The TGPT pointer is utilized as a read pointer that reads a recorded message buffer number from the THL. This pointer indicates the first THL element that the CPU has not yet read. By reading the C0TGPT register by software, the number of a message buffer that has completed transmission can be read. Each time a message buffer number is read from the C0TGPT register, the TGPT pointer is automatically incremented.

If the value of the TGPT pointer matches the value of the LOPT pointer, the THPM bit (transmit history list pointer match) of the C0TGPT register is set to 1. This indicates that no message buffer numbers that have not been read remain in the THL. If a new message buffer number is recorded, the LOPT pointer is incremented and because its value no longer matches the value of the TGPT pointer, the THPM bit is cleared. In other words, the numbers of the unread message buffers exist in the THL.

If the LOPT pointer is incremented and matches the value of the TGPT pointer minus 1, the TOVF bit (transmit history list overflow) of the COTGPT register is set to 1. This indicates that the THL is full of message buffer numbers that have not been read. If a new message is received and stored, the message buffer number recorded last is overwritten by the number of the message buffer that transmitted its message afterwards. After the TOVF bit has been set (1), therefore, the recorded message buffer numbers in the THL do not completely reflect the chronological order. However the other transmitted messages can be found by a CPU search applied to all transmit message buffers unless the CPU has not overwritten a transmit object in one of these buffers beforehand. In total up to six transmission completions can occur without overflowing the THL.

Caution If the history list is in the overflow condition (TOVF is set), reading the history list contents is still possible, until the history list is empty (indicated by THPM flag set). Nevertheless, the history list remains in the overflow condition, until TOVF is cleared by software. If TOVF is not cleared, the THPM flag will also not be updated (cleared) upon successful transmission of a new message. This may lead to the situation, that THPM indicates an empty history list, although a successful transmission has taken place, while the history list is in the overflow state (TOVF and THPM are set).



Figure 15-32. Transmit History List



TOVF = 1 denotes that LOPT equals TGPT-1 while message buffer number stored to element indicated by LOPT-1.



#### 15.10.3 Automatic block transmission (ABT)

The automatic block transmission (ABT) function is used to transmit two or more data frames successively with no CPU interaction. The maximum number of transmit message buffers assigned to the ABT function is eight (message buffer numbers 0 to 7).

By setting OPMODE [2:0] bits of the C0CTRL register to 010B, "normal operation mode with automatic block transmission function" (hereafter referred to as ABT mode) can be selected.

To issue an ABT transmission request, define the message buffers by software first. Set the MA0 bit (1) in all the message buffers used for ABT, and define all the buffers as transmit message buffers by setting MT [2:0] bits to 000B. Be sure to set the ID for each message buffer for ABT even when the same ID is being used for all the message buffers. To use two or more IDs, set the ID of each message buffer by using the COMIDLm and COMIDHm registers. Set the COMDLCm and COMDATA0m to COMDATA7m registers before issuing a transmission request for the ABT function.

After initialization of message buffers for ABT is finished, the RDY bit needs to be set (1). In the ABT mode, the TRQ bit does not have to be manipulated by software.

After the data for the ABT message buffers has been prepared, set the ABTTRG bit to 1. Automatic block transmission is then started. When ABT is started, the TRQ bit in the first message buffer (message buffer 0) is automatically set to 1. After transmission of the data of message buffer 0 has finished, TRQ bit of the next message buffer, message buffer 1, is set automatically. In this way, transmission is executed successively.

A delay time can be inserted by program in the interval in which the transmission request (TRQ) is automatically set while successive transmission is being executed. The delay time to be inserted is defined by the C0GMABTD register. The unit of the delay time is DBT (data bit time). DBT depends on the setting of the C0BRP and C0BTR registers.

Among transmit objects within the ABT-area, the priority of the transmission ID is not evaluated. The data of message buffers 0 to 7 are sequentially transmitted. When transmission of the data frame from message buffer 7 has been completed, the ABTTRG bit is automatically cleared to 0 and the ABT operation is finished.

If the RDY bit of an ABT message buffer is cleared during ABT, no data frame is transmitted from that buffer, ABT is stopped, and the ABTTRG bit is cleared. After that, transmission can be resumed from the message buffer where ABT stopped, by setting the RDY and ABTTRG bits to 1 by software. To not resume transmission from the message buffer where ABT stopped, the internal ABT engine can be reset by setting the ABTCLR bit to 1 while ABT mode is stopped and ABTTRG bit is cleared to 0. In this case, transmission is started from message buffer 0 if the ABTCLR bit is cleared to 0 and then the ABTTRG bit is set to 1.

An interrupt can be used to check if data frames have been transmitted from all the message buffers for ABT. To do so, the IE bit of the COMCTRLm register of each message buffer except the last message buffer needs to be cleared (0).

If a transmit message buffer other than those used by the ABT function (message buffer 8 to 15) is assigned to a transmit message buffer, the message to be transmitted next is determined by the priority of the transmission ID of the ABT message buffer whose transmission is currently held pending and the transmission ID of the message buffers other than those used by the ABT function.

Transmission of a data frame from an ABT message buffer is not recorded in the transmit history list (THL).



- Cautions 1. Set the ABTCLR bit to 1 while the ABTTRG bit is cleared to 0 in order to resume ABT operation at buffer No.0. If the ABTCLR bit is set to 1 while the ABTTRG bit is set to 1, the subsequent operation is not guaranteed.
  - 2. If the automatic block transmission engine is cleared by setting the ABTCLR bit to 1, the ABTCLR bit is automatically cleared immediately after the processing of the clearing request is completed.
  - 3. Do not set the ABTTRG bit in the initialization mode. If the ABTTRG bit is set in the initialization mode, the proper operation is not guaranteed after the mode is changed from the initialization mode to the ABT mode.
  - 4. Do not set TRQ bit of the ABT message buffers to 1 by software in the normal operation mode with ABT. Otherwise, the operation is not guaranteed.
  - 5. The COGMABTD register is used to set the delay time that is inserted in the period from completion of the preceding ABT message to setting of the TRQ bit for the next ABT message when the transmission requests are set in the order of message numbers for each message for ABT that is successively transmitted in the ABT mode. The timing at which the messages are actually transmitted onto the CAN bus varies depending on the status of transmission from other stations and the status of the setting of the transmission request for messages other than the ABT messages (message buffer 8 to 15).
  - 6. If a transmission request is made for a message other than an ABT message and if no delay time is inserted in the interval in which transmission requests for ABT are automatically set (C0GMABTD = 00H), messages other than ABT messages may be transmitted not depending on the priority of the ABT message.
  - 7. Do not clear the RDY bit to 0 when ABTTRG = 1.
  - 8. If a message is received from another node while normal operation mode with ABT is active, the TX-message from the ABT-area may be transmitted with delay of one frame although C0GMABTD register was set up with 00H.

**Remark** m = 0 to 15

#### 15.10.4 Transmission abort process

# (1) Transmission abort process except for in normal operation mode with automatic block transmission (ABT)

The user can clear the TRQ bit of the COMCTRLm register to 0 to abort a transmission request. The TRQ bit will be cleared immediately if the abort was successful. Whether the transmission was successfully aborted or not can be checked using the TSTAT bit of the COCTRL register and the COTGPT register, which indicate the transmission status on the CAN bus (for details, refer to the processing in **Figure 15-47**. **Transmission Abort Processing (Except Normal Operation Mode with ABT)**).

# (2) Transmission abort process except for ABT transmission in normal operation mode with automatic block transmission (ABT)

The user can clear the ABTTRG bit of the COGMABT register to 0 to abort a transmission request. After checking the ABTTRG bit of the COGMABT register = 0, clear the TRQ bit of the COMCTRLm register to 0. The TRQ bit will be cleared immediately if the abort was successful. Whether the transmission was successfully aborted or not can be checked using the TSTAT bit of the COCTRL register and the COTGPT register, which indicate the transmission status on the CAN bus (for details, refer to the processing in **Figure 15-48. Transmission Abort Processing Except for ABT Transmission (Normal Operation Mode with ABT)**).



# (3) Transmission abort process for ABT transmission in normal operation mode with automatic block transmission (ABT)

To abort ABT that is already started, clear the ABTTRG bit of the COGMABT register to 0. In this case, the ABTTRG bit remains 1 if an ABT message is currently being transmitted and until the transmission is completed (successfully or not), and is cleared to 0 as soon as transmission is finished. This aborts ABT.

If the last transmission (before ABT) was successful, the normal operation mode with ABT is left with the internal ABT pointer pointing to the next message buffer to be transmitted.

In the case of an erroneous transmission, the position of the internal ABT pointer depends on the status of the TRQ bit in the last transmitted message buffer. If the TRQ bit is set to 1 when clearing the ABTTRG bit is requested, the internal ABT pointer points to the last transmitted message buffer (for details, refer to the process in **Figure 15-49. ABT Transmission Abort Processing (Normal Operation Mode with ABT)**). If the TRQ bit is cleared to 0 when clearing the ABTTRG bit is requested, the internal ABT pointer is incremented (+1) and points to the next message buffer in the ABT area (for details, refer to the process in **Figure 15-50. ABT Transmission Request Abort Processing (Normal Operation Mode with ABT)**).

# Caution Be sure to abort ABT by clearing ABTTRG to 0. The operation is not guaranteed if aborting transmission is requested by clearing RDY bit.

When the normal operation mode with ABT is resumed after ABT has been aborted and ABTTRG bit is set to 1, the next ABT message buffer to be transmitted can be determined from the following table.

Status of TRQ of ABT Message Buffer	Abort After Successful Transmission	Abort after erroneous transmission
Set (1)	Next message buffer in the ABT area <sup>Note</sup>	Same message buffer in the ABT area
Cleared (0)	Next message buffer in the ABT area <sup>Note</sup>	Next message buffer in the ABT area <sup>Note</sup>

**Note** The above resumption operation can be performed only if a message buffer ready for ABT exists in the ABT area. For example, an abort request that is issued while ABT of message buffer 7 is in progress is regarded as completion of ABT, rather than abort, if transmission of message buffer 7 has been successfully completed, even if ABTTRG is cleared to 0. If the RDY bit in the next message buffer in the ABT area is cleared to 0, the internal ABT pointer is retained, but the resumption operation is not performed even if ABTTRG is set to 1, and ABT ends immediately.

**Remark** m = 0 to 15

#### 15.10.5 Remote frame transmission

Remote frames can be transmitted only from transmit message buffers. Set whether a data frame or remote frame is transmitted via the RTR bit of the COMCONFm register. Setting (1) the RTR bit sets remote frame transmission.



## 15.11 Power Save Modes

#### 15.11.1 CAN sleep mode

The CAN sleep mode can be used to set the CAN controller to standby mode in order to reduce power consumption. The CAN module can enter the CAN sleep mode from all operation modes. Release of the CAN sleep mode returns the CAN module to exactly the same operation mode from which the CAN sleep mode was entered.

In the CAN sleep mode, the CAN module does not transmit messages, even when transmission requests are issued or pending.

## (1) Entering CAN sleep mode

The CPU issues a CAN sleep mode transition request by writing 01B to the PSMODE [1:0] bits of the COCTRL register.

This transition request is only acknowledged only under the following conditions.

- The CAN module is already in one of the following operation modes
  - Normal operation mode
  - Normal operation mode with ABT
  - Receive-only mode
  - Single-shot mode
  - Self-test mode
  - CAN stop mode in all the above operation modes
- The CAN bus state is bus idle (the 4th bit in the interframe space is recessive) Note
- No transmission request is pending
  - **Note** If the CAN bus is fixed to dominant, the request for transition to the CAN sleep mode is held pending. Also the transition from CAN stop mode to CAN sleep mode is independent of the CAN bus state.
  - **Remark** If a sleep mode request is pending, and at the same time a message is received in a message box, the sleep mode request is not cancelled, but is executed right after message storage has been finished. This may result in AFCAN being in sleep mode, while the CPU would execute the RX interrupt routine. Therefore, the interrupt routine must check the access to the message buffers as well as reception history list registers by using the MBON flag, if sleep mode is used.

If any one of the conditions mentioned above is not met, the CAN module will operate as follows.

- If the CAN sleep mode is requested from the initialization mode, the CAN sleep mode transition request is ignored and the CAN module remains in the initialization mode.
- If the CAN bus state is not bus idle (i.e., the CAN bus state is either transmitting or receiving) when the CAN sleep mode is requested in one of the operation modes, immediate transition to the CAN sleep mode is not possible. In this case, the CAN sleep mode transition request is held pending until the CAN bus state becomes bus idle (the 4th bit in the interframe space is recessive). In the time from the CAN sleep mode request to successful transition, the PSMODE [1:0] bits remain 00B. When the module has entered the CAN sleep mode, PSMODE [1:0] bits are set to 01B.
- If a request for transition to the initialization mode and a request for transition to the CAN sleep are made at the same time while the CAN module is in one of the operation modes, the request for the initialization mode is enabled. The CAN module enters the initialization mode at a predetermined timing. At this time, the CAN sleep mode request is not held pending and is ignored.
- Even when initialization mode and sleep mode are not requested simultaneously (i.e the first request has not been granted while the second request is made), the request for initialization has priority over the sleep

mode request. The sleep mode request is cancelled when the initialization mode is requested. When a pending request for initialization mode is present, a subsequent request for Sleep mode request is cancelled right at the point in time where it was submitted.

## (2) Status in CAN sleep mode

The CAN module is in one of the following states after it enters the CAN sleep mode.

- The internal operating clock is stopped and the power consumption is minimized.
- The function to detect the falling edge of the CAN reception pin (CRxD) remains in effect to wake up the CAN module from the CAN bus.
- To wake up the CAN module from the CPU, data can be written to PSMODE [1:0] of the CAN module control register (C0CTRL), but nothing can be written to other CAN module registers or bits.
- The CAN module registers can be read, except for C0LIPT, C0RGPT, C0LOPT, and C0TGPT.
- The CAN message buffer registers cannot be written or read.
- MBON bit of the CAN global control register (C0GMCTRL) is cleared.
- A request for transition to the initialization mode is not acknowledged and is ignored.

## (3) Releasing CAN sleep mode

The CAN sleep mode is released by the following events.

- When the CPU writes 00B to the PSMODE [1:0] bits of the C0CTRL register
- A falling edge at the CAN reception pin (CRxD) (i.e. the CAN bus level shifts from recessive to dominant)
- Cautions 1. Even if the falling edge belongs to the SOF of a receive message, this message will not be received and stored. If the CPU has turned off the clock to the CAN while the CAN was in sleep mode, even subsequently the CAN sleep mode will not be released and PSMODE [1:0] will continue to be 01B unless the clock to the CAN is supplied again. In addition to this, the receive message will not be received after that.
  - 2. If the falling edge on the CAN reception pin (CRxD) is detected in the state that the CAN clock is supplied, it is necessary to clear the PSMODE0 bit by software (for details, refer to the processing in Figure 15-54. Setting CAN Sleep Mode/Stop Mode).

After releasing the sleep mode, the CAN module returns to the operation mode from which the CAN sleep mode was requested and the PSMODE [1:0] bits of the COCTRL register are reset to 00B. If the CAN sleep mode is released by a change in the CAN bus state, the CINTS5 bit of the COINTS register is set to 1, regardless of the CIE bit of the COIE register. After the CAN module is released from the CAN sleep mode, it participates in the CAN bus again by automatically detecting 11 consecutive recessive-level bits on the CAN bus. The user application has to wait until MBON = 1, before accessing message buffers again.

When a request for transition to the initialization mode is made while the CAN module is in the CAN sleep mode, that request is ignored; the CPU has to be released from sleep mode by software first before entering the initialization mode.

Caution Be aware that the release of CAN sleep mode by CAN bus event, and thus the wake up interrupt may happen at any time, even right after requesting sleep mode, if a CAN bus event occurs.



## 15.11.2 CAN stop mode

The CAN stop mode can be used to set the CAN controller to standby mode to reduce power consumption. The CAN module can enter the CAN stop mode only from the CAN sleep mode. Release of the CAN stop mode puts the CAN module in the CAN sleep mode.

The CAN stop mode can only be released (entering CAN sleep mode) by writing 01B to the PSMODE [1:0] bits of the C0CTRL register and not by a change in the CAN bus state. No message is transmitted even when transmission requests are issued or pending.

## (1) Entering CAN stop mode

A CAN stop mode transition request is issued by writing 11B to the PSMODE [1:0] bits of the COCTRL register.

A CAN stop mode request is only acknowledged when the CAN module is in the CAN sleep mode. In all other modes, the request is ignored.

Caution To set the CAN module to the CAN stop mode, the module must be in the CAN sleep mode. To confirm that the module is in the sleep mode, check that PSMODE [1:0] = 01B, and then request the CAN stop mode. If a bus change occurs at the CAN reception pin (CRxD) while this process is being performed, the CAN sleep mode is automatically released. In this case, the CAN stop mode transition request cannot be acknowledged (However, in the state that the CAN clock is supplied, it is necessary to clear the PSMODE0 bit by software after a bus change occurs at the CAN reception pin (CRxD)).

## (2) Status in CAN stop mode

The CAN module is in one of the following states after it enters the CAN stop mode.

- The internal operating clock is stopped and the power consumption is minimized.
- To wake up the CAN module from the CPU, data can be written to PSMODE [1:0] of the CAN module control register (C0CTRL), but nothing can be written to other CAN module registers or bits.
- The CAN module registers can be read, except for COLIPT, CORGPT, COLOPT, and COTGPT.
- The CAN message buffer registers cannot be written or read.
- MBON bit of the CAN global control register (C0GMCTRL) is cleared.
- An initialization mode transition request is not acknowledged and is ignored.

#### (3) Releasing CAN stop mode

The CAN stop mode can only be released by writing 01B to the PSMODE [1:0] bits of the C0CTRL register. After releasing the CAN stop mode, the CAN module enters the CAN sleep mode.

When the initialization mode is requested while the CAN module is in the CAN stop mode, that request is ignored; the CPU has to release the stop mode and subsequently CAN sleep mode before entering the initialization mode. It is impossible to enter the other operation mode directly from the CAN stop mode not entering the CAN sleep mode, that request is ignored.



#### 15.11.3 Example of using power saving modes

In some application systems, it may be necessary to place the CPU in a power saving mode to reduce the power consumption. By using the power saving mode specific to the CAN module and the power saving mode specific to the CPU in combination, the CPU can be woken up from the power saving status by the CAN bus.

Here is an example of using the power saving modes.

First, put the CAN module in the CAN sleep mode (PSMODE = 01B). Next, put the CPU in the power saving mode. If an edge transition from recessive to dominant is detected at the CAN reception pin (CRxD) in this status, the CINTS5 bit in the CAN module is set to 1. If the CIE5 bit of the COCTRL register is set to 1, a wakeup interrupt (INTCOWUP) is generated. The CAN module is automatically released from the CAN sleep mode (PSMODE = 00B) and returns to the normal operation mode (However, in the state that the CAN clock is supplied, it is necessary to clear the PSMODE0 bit by software after a bus change is detected at the CAN reception pin (CRxD)). The CPU, in response to INTCOWUP, can release its own power saving mode and return to the normal operation mode.

To further reduce the power consumption of the CPU, the internal clocks, including that of the CAN module, may be stopped. In this case, the operating clock supplied to the CAN module is stopped after the CAN module is put in the CAN sleep mode. Then the CPU enters a power saving mode in which the clock supplied to the CPU is stopped. If an edge transition from recessive to dominant is detected at the CAN reception pin (CRxD) in this status, the CAN module can set the CINTS5 bit to 1 and generate the wakeup interrupt (INTCOWUP) even if it is not supplied with the clock. The other functions, however, do not operate because clock supply to the CAN module is stopped, and the module remains in the CAN sleep mode. The CPU, in response to INTCOWUP, releases its power saving mode, resumes supply of the internal clocks, including the clock to the CAN module, after the oscillation stabilization time has elapsed, and starts instruction execution. The CAN module is immediately released from the CAN sleep mode when clock supply is resumed, and returns to the normal operation mode (PSMODE = 00B).



## 15.12 Interrupt Function

The CAN module provides 6 different interrupt sources.

The occurrence of these interrupt sources is stored in interrupt status registers. Four separate interrupt request signals are generated from the six interrupt sources. When an interrupt request signal that corresponds to two or more interrupt sources is generated, the interrupt sources can be identified by using an interrupt status register. After an interrupt source has occurred, the corresponding interrupt status bit must be cleared to 0 by software.

No.	o. Interrupt Status Bit		Interrupt Enable Bit		Interrupt	Interrupt Source Description
	Name	Register	Name	Register	Request Signal	
1	CINTS0 Note 1	COINTS	CIE0 <sup>Note 1</sup>	COIE	INTCOTRX	Message frame successfully transmitted from message buffer m
2	CINTS1 Note 1	COINTS	CIE1 Note 1	COIE	INTCOREC	Valid message frame reception in message buffer m
3	CINTS2	COINTS	CIE2	COIE	INTC0ERR	CAN module error state interrupt Note 2
4	CINTS3	COINTS	CIE3	COIE		CAN module protocol error interrupt Note 3
5	CINTS4	COINTS	CIE4	COIE		CAN module arbitration loss interrupt
6	CINTS5	COINTS	CIE5	COIE	INTCOWUP	CAN module wakeup interrupt from CAN sleep mode Note 4

 Table 15-20. List of CAN Module Interrupt Sources

**Notes 1.** The IE bit (message buffer interrupt enable bit) in the COMCTRL register of the corresponding message buffer has to be set to 1 for that message buffer to participate in the interrupt generation process.

2. This interrupt is generated when the transmission/reception error counter is at the warning level, or in the error passive or bus-off state.

3. This interrupt is generated when a stuff error, form error, ACK error, bit error, or CRC error occurs.

**4.** This interrupt is generated when the CAN module is woken up from the CAN sleep mode because a falling edge is detected at the CAN reception pin (CAN bus transition from recessive to dominant).



## 15.13 Diagnosis Functions and Special Operational Modes

The CAN module provides a receive-only mode, single-shot mode, and self-test mode to support CAN bus diagnosis functions or the operation of specific CAN communication methods.

#### 15.13.1 Receive-only mode

The receive-only mode is used to monitor receive messages without causing any interference on the CAN bus and can be used for CAN bus analysis nodes.

For example, this mode can be used for automatic baud-rate detection. The baud rate in the CAN module is changed until "valid reception" is detected, so that the baud rates in the module match ("valid reception" means a message frame has been received in the CAN protocol layer without occurrence of an error and with an appropriate ACK between nodes connected to the CAN bus). A valid reception does not require message frames to be stored in a receive message buffer (data frames) or transmit message buffer (remote frames). The event of valid reception is indicated by setting the VALID bit of the COCTRL register (1).

#### Figure 15-33. CAN Module Terminal Connection in Receive-Only Mode



In the receive-only mode, no message frames can be transmitted from the CAN module to the CAN bus. Transmit requests issued for message buffers defined as transmit message buffers are held pending.

In the receive-only mode, the CAN transmission pin (CTxD) in the CAN module is fixed to the recessive level. Therefore, no active error flag can be transmitted from the CAN module to the CAN bus even when a CAN bus error is detected while receiving a message frame. Since no transmission can be issued from the CAN module, the transmission error counter TEC is never updated. Therefore, a CAN module in the receive-only mode does not enter the bus-off state.

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Furthermore, ACK is not returned to the CAN bus in this mode upon the valid reception of a message frame. Internally, the local node recognizes that it has transmitted ACK. An overload frame cannot be transmitted to the CAN bus.

Caution If only two CAN nodes are connected to the CAN bus and one of them is operating in the receive-only mode, there is no ACK on the CAN bus. Due to the missing ACK, the transmitting node will transmit an active error flag, and repeat transmitting a message frame. The transmitting node becomes error passive after transmitting the message frame 16 times (assuming that the error counter was 0 in the beginning and no other errors have occurred). After the message frame for the 17th time is transmitted, the transmitting node generates a passive error flag. The receiving node in the receive-only mode detects the first valid message frame at this point, and the VALID bit is set to 1 for the first time.

#### 15.13.2 Single-shot mode

In the single-shot mode, automatic re-transmission as defined in the CAN protocol is switched off (According to the CAN protocol, a message frame transmission that has been aborted by either arbitration loss or error occurrence has to be repeated without control by software.). All other behavior of single shot mode is identical to normal operation mode. Features of single shot mode can not be used in combination with normal mode with ABT.

The single-shot mode disables the re-transmission of an aborted message frame transmission according to the setting of the AL bit of the COCTRL register. When the AL bit is cleared to 0, re-transmission upon arbitration loss and upon error occurrence is disabled. If the AL bit is set to 1, re-transmission upon error occurrence is disabled, but re-transmission upon arbitration loss is enabled. As a consequence, the TRQ bit in a message buffer defined as a transmit message buffer is cleared to 0 by the following events.

- Successful transmission of the message frame
- Arbitration loss while sending the message frame
- Error occurrence while sending the message frame

The events arbitration loss and error occurrence can be distinguished by checking the CINTS4 and CINTS3 bits of the COINTS register respectively, and the type of the error can be identified by reading the LEC[2:0] bits of the COLEC register.

Upon successful transmission of the message frame, the transmit completion interrupt bit CINTS0 of the C0INTS register is set to 1. If the CIE0 bit of the C0IE register is set to 1 at this time, an interrupt request signal is output.

The single-shot mode can be used when emulating time-triggered communication methods (e.g. TTCAN level 1).

## Caution The AL bit is only valid in Single-shot mode. It does not influence the operation of retransmission upon arbitration loss in the other operation modes.



## 15.13.3 Self-test mode

In the self-test mode, message frame transmission and message frame reception can be tested without connecting the CAN node to the CAN bus or without affecting the CAN bus.

In the self-test mode, the CAN module is completely disconnected from the CAN bus, but transmission and reception are internally looped back. The CAN transmission pin (CTxD) is fixed to the recessive level.

If the falling edge on the CAN reception pin (CRxD) is detected after the CAN module has entered the CAN sleep mode from the self-test mode, however, the module is released from the CAN sleep mode in the same manner as the other operation modes (However, to release the CAN sleep mode in the state that the CAN clock is supplied, it is necessary to clear the PSMODE0 bit by software after the falling edge on the CAN reception pin (CRxD) is detected). To keep the module in the CAN sleep mode, use the CAN reception pin (CRxD) as a port pin.







# 15.13.4 Receive/transmit operation in each operation mode

 Table 15-21 shows outline of the receive/transmit operation in each operation mode.

Operation Mode	Transmission of data/ remote frame	Transmission of ACK	Transmission of error/ overload frame	Transmission retry	Automatic Block Transmission (ABT)	Set of VALID bit	Store Data to message buffer
Initialization Mode	No	No	No	No	No	No	No
Normal Operation Mode	Yes	Yes	Yes	Yes	No	Yes	Yes
Normal Operation Mode with ABT	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Receive- only mode	No	No	No	No	No	Yes	Yes
Single-shot Mode	Yes	Yes	Yes	No <sup>Note 1</sup>	No	Yes	Yes
Self-test Mode	Yes <sup>Note 2</sup>	Yes <sup>Note 2</sup>	Yes <sup>Note 2</sup>	Yes <sup>Note 2</sup>	No	Yes <sup>Note 2</sup>	Yes <sup>Note 2</sup>

Table 15-21.	Outline of the Receive/Transmit in Each Operation Mod	de
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Notes 1. When the arbitration lost occurs, control of re-transmission is possible by the AL bit of COCTRL register.

2. Each signals are not generated to outside, but generated into the CAN module.



## 15.14 Time Stamp Function

CAN is an asynchronous, serial protocol. All nodes connected to the CAN bus have a local, autonomous clock. As a consequence, the clocks of the nodes have no relation (i.e., the clocks are asynchronous and may have different frequencies).

In some applications, however, a common time base over the network (= global time base) is needed. In order to build up a global time base, a time stamp function is used. The essential mechanism of a time stamp function is the capture of timer values triggered by signals on the CAN bus.

#### 15.14.1 Time stamp function

The CAN controller supports the capturing of timer values triggered by a specific frame. An on-chip 16-bit capture timer unit in a microcontroller system is used in addition to the CAN controller. The 16-bit capture timer unit captures the timer value according to a trigger signal (TSOUT) for capturing that is output when a data frame is received from the CAN controller. The CPU can retrieve the time of occurrence of the capture event, i.e., the time stamp of the message received from the CAN bus, by reading the captured value. TSOUT signal can be selected from the following two event sources and is specified by the TSSEL bit of the COTS register.

- SOF event (start of frame) (TSSEL = 0)

- EOF event (last bit of end of frame) (TSSEL = 1)

The TSOUT signal is enabled by setting the TSEN bit of the C0TS register to 1.



#### Figure 15-35. Timing Diagram of Capture Signal TSOUT

TSOUT signal toggles its level upon occurrence of the selected event during data frame reception (in the above timing diagram, the SOF is used as the trigger event source). To capture a timer value by using TSOUT signal, the capture timer unit must detect the capture signal at both the rising edge and falling edge.

This time stamp function is controlled by the TSLOCK bit of the COTS register. When TSLOCK is cleared to 0, TSOUT bit toggles upon occurrence of the selected event. If TSLOCK bit is set to 1, TSOUT toggles upon occurrence of the selected event, but the toggle is stopped as the TSEN bit is automatically cleared to 0 as soon as the message storing to the message buffer 0 starts. This suppresses the subsequent toggle occurrence by TSOUT, so that the time stamp value toggled last (= captured last) can be saved as the time stamp value of the time at which the data frame was received in message buffer 0.



Caution The time stamp function using TSLOCK bit is to stop toggle of TSOUT bit by receiving a data frame in message buffer 0. Therefore, message buffer 0 must be set as a receive message buffer. Since a receive message buffer cannot receive a remote frame, toggle of TSOUT bit cannot be stopped by reception of a remote frame. Toggle of TSOUT bit does not stop when a data frame is received in a message buffer other than message buffer 0.

For these reasons, a data frame cannot be received in message buffer 0 when the CAN module is in the normal operation mode with ABT, because message buffer 0 must be set as a transmit message buffer. In this operation mode, therefore, the function to stop toggle of TSOUT bit by TSLOCK bit cannot be used.

The input source of the timer value according to a trigger signal (TSOUT) can be input to the 16-bit timer/event counter 00 by port input switch control (ISC0), without connecting TIOP40, externally.



Figure 15-36. Port Input Switch Control

Remark ISC0: Bit 0 of the input switch control register (ISC) (see Figure 12-19 Format of Input Switch Control Register (ISC))



# 15.15 Baud Rate Settings

## 15.15.1 Baud rate settings

Make sure that the settings are within the range of limit values for ensuring correct operation of the CAN controller, as follows.

- (a) 5TQ ≤ SPT (sampling point) ≤ 17TQ SPT = TSEG1 + 1TQ
  (b) 8TQ ≤ DBT (data bit time) ≤ 25TQ DBT = TSEG1 + TSEG2 + 1TQ = TSEG2 + SPT
  (c) 1TQ ≤ SJW (synchronization jump width) ≤ 4TQ SJW ≤ DBT - SPT
  (d) 4TQ ≤ TSEG1 ≤ 16TQ [3 (Setting value of TSEG1 [3:0] ≤ 15]
  (e) 1TQ ≤ TSEG2 ≤ 8TQ [0 (Setting value of TSEG2 [2:0] ≤ 7]
- Remark
   TQ = 1/fra (fra: CAN protocol layer basic system clock)

   TSEG1 [3:0]:
   Bits 3 to 0 of CAN0 bit rate register (C0BTR)

   TSEG2 [2:0]:
   Bits 10 to 8 of CAN0 bit rate register (C0BTR)

 Table 15-22 shows the combinations of bit rates that satisfy the above conditions.



	٧	/alid Bit Rate Se		C0BTR Reg Va	ister Setting lue	Sampling Point (Unit %)	
DBT Length	SYNC SEGMENT	PROP SEGMENT	PHASE SEGMENT1	PHASE SEGMENT2	TSEG1[3:0]	TSEG2[2:0]	
25	1	8	8	8	1111	111	68.0
24	1	7	8	8	1110	111	66.7
24	1	9	7	7	1111	110	70.8
23	1	6	8	8	1101	111	65.2
23	1	8	7	7	1110	110	69.6
23	1	10	6	6	1111	101	73.9
22	1	5	8	8	1100	111	63.6
22	1	7	7	7	1101	110	68.2
22	1	9	6	6	1110	101	72.7
22	1	11	5	5	1111	100	77.3
21	1	4	8	8	1011	111	61.9
21	1	6	7	7	1100	110	66.7
21	1	8	6	6	1101	101	71.4
21	1	10	5	5	1110	100	76.2
21	1	12	4	4	1111	011	81.0
20	1	3	8	8	1010	111	60.0
20	1	5	7	7	1011	110	65.0
20	1	7	6	6	1100	101	70.0
20	1	9	5	5	1101	100	75.0
20	1	11	4	4	1110	011	80.0
20	1	13	3	3	1111	010	85.0
19	1	2	8	8	1001	111	57.9
19	1	4	7	7	1010	110	63.2
19	1	6	6	6	1011	101	68.4
19	1	8	5	5	1100	100	73.7
19	1	10	4	4	1101	011	78.9
19	1	12	3	3	1110	010	84.2
19	1	14	2	2	1111	001	89.5
18	1	1	8	8	1000	111	55.6
18	1	3	7	7	1001	110	61.1
18	1	5	6	6	1010	101	66.7
18	1	7	5	5	1011	100	72.2
18	1	9	4	4	1100	011	77.8
18	1	11	3	3	1101	010	83.3
18	1	13	2	2	1110	001	88.9
18	1	15	1	1	1111	000	94.4

# Table 15-22. Settable Bit Rate Combinations (1/3)



	V	alid Bit Rate Se		C0BTR Reg Va	ister Setting lue	Sampling Point (Unit %)	
DBT Length	SYNC SEGMENT	PROP SEGMENT	PHASE SEGMENT1	PHASE SEGMENT2	TSEG1[3:0]	TSEG2[2:0]	
17	1	2	7	7	1000	110	58.8
17	1	4	6	6	1001	101	64.7
17	1	6	5	5	1010	100	70.6
17	1	8	4	4	1011	011	76.5
17	1	10	3	3	1100	010	82.4
17	1	12	2	2	1101	001	88.2
17	1	14	1	1	1110	000	94.1
16	1	1	7	7	0111	110	56.3
16	1	3	6	6	1000	101	62.5
16	1	5	5	5	1001	100	68.8
16	1	7	4	4	1010	011	75.0
16	1	9	3	3	1011	010	81.3
16	1	11	2	2	1100	001	87.5
16	1	13	1	1	1101	000	93.8
15	1	2	6	6	0111	101	60.0
15	1	4	5	5	1000	100	66.7
15	1	6	4	4	1001	011	73.3
15	1	8	3	3	1010	010	80.0
15	1	10	2	2	1011	001	86.7
15	1	12	1	1	1100	000	93.3
14	1	1	6	6	0110	101	57.1
14	1	3	5	5	0111	100	64.3
14	1	5	4	4	1000	011	71.4
14	1	7	3	3	1001	010	78.6
14	1	9	2	2	1010	001	85.7
14	1	11	1	1	1011	000	92.9
13	1	2	5	5	0110	100	61.5
13	1	4	4	4	0111	011	69.2
13	1	6	3	3	1000	010	76.9
13	1	8	2	2	1001	001	84.6
13	1	10	1	1	1010	000	92.3
12	1	1	5	5	0101	100	58.3
12	1	3	4	4	0110	011	66.7
12	1	5	3	3	0111	010	75.0
12	1	7	2	2	1000	001	83.3
12	1	9	1	1	1001	000	91.7

# Table 15-22. Settable Bit Rate Combinations (2/3)



	V	/alid Bit Rate Se		C0BTR Reg Va	ister Setting lue	Sampling Point (Unit %)	
DBT Length	SYNC SEGMENT	PROP SEGMENT	PHASE SEGMENT1	PHASE SEGMENT2	TSEG1[3:0]	TSEG2[2:0]	
11	1	2	4	4	0101	011	63.6
11	1	4	3	3	0110	010	72.7
11	1	6	2	2	0111	001	81.8
11	1	8	1	1	1000	000	90.9
10	1	1	4	4	0100	011	60.0
10	1	3	3	3	0101	010	70.0
10	1	5	2	2	0110	001	80.0
10	1	7	1	1	0111	000	90.0
9	1	2	3	3	0100	010	66.7
9	1	4	2	2	0101	001	77.8
9	1	6	1	1	0110	000	88.9
8	1	1	3	3	0011	010	62.5
8	1	3	2	2	0100	001	75.0
8	1	5	1	1	0101	000	87.5
7 <sup>Note</sup>	1	2	2	2	0011	001	71.4
7 <sup>Note</sup>	1	4	1	1	0100	000	85.7
6 <sup>Note</sup>	1	1	2	2	0010	001	66.7
6 <sup>Note</sup>	1	3	1	1	0011	000	83.3
5 <sup>Note</sup>	1	2	1	1	0010	000	80.0
4 <sup>Note</sup>	1	1	1	1	0001	000	75.0

Table 15-22. Settable Bit Rate Combinations (3/3)

Note Setting with a DBT value of 7 or less is valid only when the value of the COBRP register is other than 00H.

Caution The values in Table 15-22 do not guarantee the operation of the network system. Thoroughly check the effect on the network system, taking into consideration oscillation errors and delays of the CAN bus and CAN transceiver.



# 15.15.2 Representative examples of baud rate settings

Tables 16-23 and 16-24 show representative examples of baud rate setting.

Set Baud Rate Value	Division Ratio of	C0BRP Register	Valid Bit Rate Setting (Unit: kbps)					C0BTR Setting	Sampling point	
(Unit: kbps)	COBRP	Set Value	Length of DBT	SYNC SEGMENT	PROP SEGMENT	PHASE SEGMENT 1	PHASE SEGMENT 2	TSEG1 [3:0]	TSEG2 [2:0]	(Unit: %)
1000	1	00000000	8	1	1	3	3	0011	010	62.5
1000	1	00000000	8	1	3	2	2	0100	001	75.0
1000	1	00000000	8	1	5	1	1	0101	000	87.5
500	1	00000000	16	1	1	7	7	0111	110	56.3
500	1	00000000	16	1	3	6	6	1000	101	62.5
500	1	00000000	16	1	5	5	5	1001	100	68.8
500	1	00000000	16	1	7	4	4	1010	011	75.0
500	1	00000000	16	1	9	3	3	1011	010	81.3
500	1	00000000	16	1	11	2	2	1100	001	87.5
500	1	00000000	16	1	13	1	1	1101	000	93.8
500	2	00000001	8	1	1	3	3	0011	010	62.5
500	2	00000001	8	1	3	2	2	0100	001	75.0
500	2	00000001	8	1	5	1	1	0101	000	87.5
250	2	00000001	16	1	1	7	7	0111	110	56.3
250	2	00000001	16	1	3	6	6	1000	101	62.5
250	2	00000001	16	1	5	5	5	1001	100	68.8
250	2	00000001	16	1	7	4	4	1010	011	75.0
250	2	00000001	16	1	9	3	3	1011	010	81.3
250	2	00000001	16	1	11	2	2	1100	001	87.5
250	2	00000001	16	1	13	1	1	1101	000	93.8
250	4	00000011	8	1	3	2	2	0100	001	75.0
250	4	00000011	8	1	5	1	1	0101	000	87.5
125	4	00000011	16	1	1	7	7	0111	110	56.3
125	4	00000011	16	1	3	6	6	1000	101	62.5
125	4	00000011	16	1	5	5	5	1001	100	68.8
125	4	00000011	16	1	7	4	4	1010	011	75.0
125	4	00000011	16	1	9	3	3	1011	010	81.3
125	4	00000011	16	1	11	2	2	1100	001	87.5
125	4	00000011	16	1	13	1	1	1101	000	93.8
125	8	00000111	8	1	3	2	2	0100	001	75.0
125	8	00000111	8	1	5	1	1	0101	000	87.5

Table 15-23.	Representative	Examples of	<b>Baud Rate</b>	Settings	(fcanmod = 8	8 MHz) (1/2)
					<b>1</b>	- /\`/

Caution The values in Table 15-23 do not guarantee the operation of the network system. Thoroughly check the effect on the network system, taking into consideration oscillation errors and delays of the CAN bus and CAN transceiver.

Set Baud Rate Value	Division Ratio of	C0BRP Register	Valid Bit Rate Setting (Unit: kbps)					C0BTR Register Setting Value		Sampling point
(Unit: kbps)	C0BRP	Set Value	Length of DBT	SYNC SEGMENT	PROP SEGMENT	PHASE SEGMENT 1	PHASE SEGMENT 2	TSEG1 [3:0]	TSEG2 [2:0]	(Unit: %)
100	4	00000011	20	1	7	6	6	1100	101	70.0
100	4	00000011	20	1	9	5	5	1101	100	75.0
100	5	00000100	16	1	7	4	4	1010	011	75.0
100	5	00000100	16	1	9	3	3	1011	010	81.3
100	8	00000111	10	1	3	3	3	0101	010	70.0
100	8	00000111	10	1	5	2	2	0110	001	80.0
100	10	00001001	8	1	3	2	2	0100	001	75.0
100	10	00001001	8	1	5	1	1	0101	000	87.5
83.3	4	00000011	24	1	7	8	8	1110	111	66.7
83.3	4	00000011	24	1	9	7	7	1111	110	70.8
83.3	6	00000101	16	1	5	5	5	1001	100	68.8
83.3	6	00000101	16	1	7	4	4	1010	011	75.0
83.3	6	00000101	16	1	9	3	3	1011	010	81.3
83.3	6	00000101	16	1	11	2	2	1100	001	87.5
83.3	8	00000111	12	1	5	3	3	0111	010	75.0
83.3	8	00000111	12	1	7	2	2	1000	001	83.3
83.3	12	00001011	8	1	3	2	2	0100	001	75.0
83.3	12	00001011	8	1	5	1	1	0101	000	87.5
33.3	10	00001001	24	1	7	8	8	1110	111	66.7
33.3	10	00001001	24	1	9	7	7	1111	110	70.8
33.3	12	00001011	20	1	7	6	6	1100	101	70.0
33.3	12	00001011	20	1	9	5	5	1101	100	75.0
33.3	15	00001110	16	1	7	4	4	1010	011	75.0
33.3	15	00001110	16	1	9	3	3	1011	010	81.3
33.3	16	00001111	15	1	6	4	4	1001	011	73.3
33.3	16	00001111	15	1	8	3	3	1010	010	80.0
33.3	20	00010011	12	1	5	3	3	0111	010	75.0
33.3	20	00010011	12	1	7	2	2	1000	001	83.3
33.3	24	00010111	10	1	3	3	3	0101	010	70.0
33.3	24	00010111	10	1	5	2	2	0110	001	80.0
33.3	30	00011101	8	1	3	2	2	0100	001	75.0
33.3	30	00011101	8	1	5	1	1	0101	000	87.5

## Table 15-23. Representative Examples of Baud Rate Settings (fCANMOD = 8 MHz) (2/2)

Caution The values in Table 15-23 do not guarantee the operation of the network system. Thoroughly check the effect on the network system, taking into consideration oscillation errors and delays of the CAN bus and CAN transceiver.

Set Baud Rate Value	Division Ratio of C0BRP	C0BRP Register Set Value	Valid Bit Rate Setting (Unit: kbps)					C0BTR Register Setting Value		Sampling point
(Unit: kbps)			Length of DBT	SYNC SEGMENT	PROP SEGMENT	PHASE SEGMENT 1	PHASE SEGMENT 2	TSEG1 [3:0]	TSEG2 [2:0]	(Unit: %)
1000	1	00000000	16	1	1	7	7	0111	110	56.3
1000	1	00000000	16	1	3	6	6	1000	101	62.5
1000	1	00000000	16	1	5	5	5	1001	100	68.8
1000	1	00000000	16	1	7	4	4	1010	011	75.0
1000	1	00000000	16	1	9	3	3	1011	010	81.3
1000	1	00000000	16	1	11	2	2	1100	001	87.5
1000	1	00000000	16	1	13	1	1	1101	000	93.8
1000	2	00000001	8	1	3	2	2	0100	001	75.0
1000	2	00000001	8	1	5	1	1	0101	000	87.5
500	2	00000001	16	1	1	7	7	0111	110	56.3
500	2	00000001	16	1	3	6	6	1000	101	62.5
500	2	00000001	16	1	5	5	5	1001	100	68.8
500	2	00000001	16	1	7	4	4	1010	011	75.0
500	2	00000001	16	1	9	3	3	1011	010	81.3
500	2	00000001	16	1	11	2	2	1100	001	87.5
500	2	00000001	16	1	13	1	1	1101	000	93.8
500	4	00000011	8	1	3	2	2	0100	001	75.0
500	4	00000011	8	1	5	1	1	0101	000	87.5
250	4	00000011	16	1	3	6	6	1000	101	62.5
250	4	00000011	16	1	5	5	5	1001	100	68.8
250	4	00000011	16	1	7	4	4	1010	011	75.0
250	4	00000011	16	1	9	3	3	1011	010	81.3
250	4	00000011	16	1	11	2	2	1100	001	87.5
250	8	00000111	8	1	3	2	2	0100	001	75.0
250	8	00000111	8	1	5	1	1	0101	000	87.5
125	8	00000111	16	1	3	6	6	1000	101	62.5
125	8	00000111	16	1	7	4	4	1010	011	75.0
125	8	00000111	16	1	9	3	3	1011	010	81.3
125	8	00000111	16	1	11	2	2	1100	001	87.5
125	16	00001111	8	1	3	2	2	0100	001	75.0
125	16	00001111	8	1	5	1	1	0101	000	87.5

# Table 15-24. Representative Examples of Baud Rate Settings (fcanmod = 16 MHz) (1/2)

Caution The values in Table 15-24 do not guarantee the operation of the network system. Thoroughly check the effect on the network system, taking into consideration oscillation errors and delays of the CAN bus and CAN transceiver.

Set Baud Rate Value	Division Ratio of	C0BRP Register	Valid Bit Rate Setting (Unit: kbps)					C0BTR Register Setting Value		Sampling point
(Unit: kbps)	C0BRP	Set Value	Length of DBT	SYNC SEGMENT	PROP SEGMENT	PHASE SEGMENT 1	PHASE SEGMENT 2	TSEG1 [3:0]	TSEG2 [2:0]	(Unit: %)
100	8	00000111	20	1	9	5	5	1101	100	75.0
100	8	00000111	20	1	11	4	4	1110	011	80.0
100	10	00001001	16	1	7	4	4	1010	011	75.0
100	10	00001001	16	1	9	3	3	1011	010	81.3
100	16	00001111	10	1	3	3	3	0101	010	70.0
100	16	00001111	10	1	5	2	2	0110	001	80.0
100	20	00010011	8	1	3	2	2	0100	001	75.0
83.3	8	00000111	24	1	7	8	8	1110	111	66.7
83.3	8	00000111	24	1	9	7	7	1111	110	70.8
83.3	12	00001011	16	1	7	4	4	1010	011	75.0
83.3	12	00001011	16	1	9	3	3	1011	010	81.3
83.3	12	00001011	16	1	11	2	2	1100	001	87.5
83.3	16	00001111	12	1	5	3	3	0111	010	75.0
83.3	16	00001111	12	1	7	2	2	1000	001	83.3
83.3	24	00010111	8	1	3	2	2	0100	001	75.0
83.3	24	00010111	8	1	5	1	1	0101	000	87.5
33.3	30	00011101	24	1	7	8	8	1110	111	66.7
33.3	30	00011101	24	1	9	7	7	1111	110	70.8
33.3	24	00010111	20	1	9	5	5	1101	100	75.0
33.3	24	00010111	20	1	11	4	4	1110	011	80.0
33.3	30	00011101	16	1	7	4	4	1010	011	75.0
33.3	30	00011101	16	1	9	3	3	1011	010	81.3
33.3	32	00011111	15	1	8	3	3	1010	010	80.0
33.3	32	00011111	15	1	10	2	2	1011	001	86.7
33.3	37	00100100	13	1	6	3	3	1000	010	76.9
33.3	37	00100100	13	1	8	2	2	1001	001	84.6
33.3	40	00100111	12	1	5	3	3	0111	010	75.0
33.3	40	00100111	12	1	7	2	2	1000	001	83.3
33.3	48	00101111	10	1	3	3	3	0101	010	70.0
33.3	48	00101111	10	1	5	2	2	0110	001	80.0
33.3	60	00111011	8	1	3	2	2	0100	001	75.0
33.3	60	00111011	8	1	5	1	1	0101	000	87.5

# Table 15-24. Representative Examples of Baud Rate Settings (fcanmod = 16 MHz) (2/2)

Caution The values in Table 15-24 do not guarantee the operation of the network system. Thoroughly check the effect on the network system, taking into consideration oscillation errors and delays of the CAN bus and CAN transceiver.

## 15.16 Operation of CAN Controller

**Remark** m = 0 to 15

## Figure 15-37. Initialization



**Remark** OPMODE: Normal operation mode, normal operation mode with ABT, receive-only mode, singleshot mode, self-test mode



Figure 15-38. Re-initialization



- Caution After setting the CAN module to the initialization mode, avoid setting the module to another operation mode immediately after. If it is necessary to immediately set the module to another operation mode, be sure to access registers other than the C0CTRL and C0GMCTRL registers (e.g. set a message buffer).
- **Remark** OPMODE: Normal operation mode, normal operation mode with ABT, receive-only mode, singleshot mode, self-test mode







- Cautions 1. Before a message buffer is initialized, the RDY bit must be cleared.
  - 2. Make the following settings for message buffers not used by the application.
    Clear the RDY, TRQ, and DN bits of the COMCTRLm register to 0.
    - Clear the MA0 bit of the C0MCONFm register to 0.

**Figure 15-40** shows the processing for a receive message buffer (MT [2:0] bits of COMCONFm register = 001B to 101B).



#### Figure 15-40. Message Buffer Redefinition

- **Notes 1.** Confirm that a message is being received because RDY bit must be set after a message is completely received.
  - **2.** Avoid message buffer redefinition during store operation of message reception by waiting additional 4 CAN data bits.

**Figure 15-41** shows the processing for a transmit message buffer during transmission (MT [2:0] bits of C0MCONFm register = 000B).







Figure 15-42 shows the processing for a transmit message buffer (MT [2:0] bits of COMCONFm register = 000B).





Cautions 1. The TRQ bit should be set after the RDY bit is set.

2. The RDY bit and TRQ bit should not be set at the same time.



Figure 15-43 shows the processing for a transmit message buffer (MT [2:0] bits of COMCONFm register = 000B).



#### Figure 15-43. ABT Message Transmit Processing

- Caution The ABTTRG bit should be set to 1 after the TSTAT bit is cleared to 0. Checking the TSTAT bit and setting the ABTTRG bit to 1 must be processed continuously.
- Remark This processing (normal operation mode with ABS) can only be applied to message buffers 0 to 7. For message buffers other than the ABT message buffers, refer to Figure 15-42. Message Transmit Processing.

RENESAS


Figure 15-44. Transmission via Interrupt (Using C0LOPT register)

Cautions 1. The TRQ bit should be set after the RDY bit is set.

- 2. The RDY bit and TRQ bit should not be set at the same time.
- Remark Also check the MBON flag at the beginning and at the end of the interrupt routine, in order to check the access to the message buffers as well as TX history list registers, in case a pending sleep mode had been executed. If MBON is detected to be cleared at any check, the actions and results of the processing have to be discarded and processed again, after MBON is set again. It is recommended to cancel any sleep mode requests, before processing TX interrupts.



Figure 15-45. Transmit via Interrupt (Using C0TGPT register)

- Cautions 1. The TRQ bit should be set after the RDY bit is set.
  - 2. The RDY bit and TRQ bit should not be set at the same time.
- Remarks 1. Also check the MBON flag at the beginning and at the end of the interrupt routine, in order to check the access to the message buffers as well as TX history list registers, in case a pending sleep mode had been executed. If MBON is detected to be cleared at any check, the actions and results of the processing have to be discarded and processed again, after MBON is set again. It is recommended to cancel any sleep mode requests, before processing TX interrupts.
  - 2. If TOVF was set once, the transmit history list is inconsistent. Consider to scan all configured transmit buffers for completed transmissions.



#### Figure 15-46. Transmission via Software Polling

- Cautions 1. The TRQ bit should be set after the RDY bit is set.
  - 2. The RDY bit and TRQ bit should not be set at the same time.
- **Remarks1.** Also check the MBON flag at the beginning and at the end of the polling routine, in order to check the access to the message buffers as well as TX history list registers, in case a pending sleep mode had been executed. If MBON is detected to be cleared at any check, the actions and results of the processing have to be discarded and processed again, after MBON is set again.
  - **2.** If TOVF was set once, the transmit history list is inconsistent. Consider to scan all configured transmit buffers for completed transmissions.



#### Figure 15-47. Transmission Abort Processing (Except Normal Operation Mode with ABT)

**Note** There is a possibility of starting the transmission without being aborted even if TRQ bit is cleared, because the transmission request to protocol layer might already been accepted between 11 bits, total of interframe space (3 bits) and suspend transmission (8 bits).

Cautions 1. Execute transmission request abort processing by clearing the TRQ bit, not the RDY bit.

- 2. Before making a sleep mode transition request, confirm that there is no transmission request left using this processing.
- 3. The TSTAT bit can be periodically checked by a user application or can be checked after the transmit completion interrupt.
- 4. Do not execute the new transmission request including in the other message buffers while transmission abort processing is in progress.
- 5. There is a possibility that contradiction is caused in the judgment whether the transmission abort request was successful when the transmission from the same message buffer is consecutive or only one message buffer is used. In that case, judge it by using the history information etc. that the C0TGPT register indicates.



# Figure 15-48. Transmission Abort Processing Except for ABT Transmission (Normal Operation Mode with ABT)

**Note** There is a possibility of starting the transmission without being aborted even if TRQ bit is cleared, because the transmission request to protocol layer might already been accepted between 11 bits, total of interframe space (3 bits) and suspend transmission (8 bits).

Cautions 1. Execute transmission request abort processing by clearing the TRQ bit, not the RDY bit.

- 2. Before making a sleep mode transition request, confirm that there is no transmission request left using this processing.
- 3. The TSTAT bit can be periodically checked by a user application or can be checked after the transmit completion interrupt.
- 4. Do not execute the new transmission request including in the other message buffers while transmission abort processing is in progress.

Cautions 5 There is a possibility that contradiction is caused in the judgment whether the transmission abort request was successful when the transmission from the same message buffer is consecutive or only one message buffer is used. In that case, judge it by using the history information etc. that the CnTGPT register indicates.



Figure 15-49 shows the processing not to skip resumption of transmitting a message that was stopped when transmission of an ABT message buffer was aborted.





- Cautions 1. Do not set any transmission requests while ABT transmission abort processing is in progress.
  - 2. Make a CAN sleep mode/CAN stop mode transition request after ABTTRG bit is cleared (after ABT mode is aborted) following the procedure shown in Figure 15-49 or 15-50. When clearing a transmission request in an area other than the ABT area, follow the procedure shown in Figure 15-47. Transmission Abort Processing (Except Normal Operation Mode with ABT).



Figure 15-50 shows the processing to skip resumption of transmitting a message that was stopped when transmission of an ABT message buffer was aborted.





- Cautions 1. Do not set any transmission requests while ABT transmission abort processing is in progress.
  - 2. Make a CAN sleep mode/CAN stop mode request after ABTTRG is cleared (after ABT mode is stopped) following the procedure shown in Figure 15-49 or 15-50. When clearing a transmission request in an area other than the ABT area, follow the procedure shown in Figure 15-47. Transmission Abort Processing (Except Normal Operation Mode with ABT).







Note Check the MUC and DN bits using one read access.

Remark Also check the MBON flag at the beginning and at the end of the interrupt routine, in order to check the access to the message buffers as well as reception history list registers, in case a pending sleep mode had been executed. If MBON is detected to be cleared at any check, the actions and results of the processing have to be discarded and processed again, after MBON is set again. It is recommended to cancel any sleep mode requests, before processing RX interrupts.







Note Check the MUC and DN bits using one read access.

**Remarks 1.** Also check the MBON flag at the beginning and at the end of the interrupt routine, in order to check the access to the message buffers as well as reception history list registers, in case a pending sleep mode had been executed. If MBON is detected to be cleared at any check, the actions and results of the processing have to be discarded and processed again, after MBON is set again.

It is recommended to cancel any sleep mode requests, before processing RX interrupts.

2. If ROVF was set once, the receive history list is inconsistent. Consider to scan all configured receive buffers for receptions.





Note Check the MUC and DN bits using one read access.

**Remarks 1.** Also check the MBON flag at the beginning and at the end of the polling routine, in order to check the access to the message buffers as well as reception history list registers, in case a pending sleep mode had been executed. If MBON is detected to be cleared at any check, the actions and results of the processing have to be discarded and processed again, after MBON is set again.

It is recommended to cancel any sleep mode requests, before processing RX interrupts.

**2.** If ROVF was set once, the receive history list is inconsistent. Consider to scan all configured receive buffers for receptions.



Figure 15-54. Setting CAN Sleep Mode/Stop Mode

Caution To abort transmission before making a request for the CAN sleep mode, perform processing according to Figures 15-47 to 15-50.







**Remark** "In case CAN clock is active": By means of the CPU standby mode, the CAN module clock has been switched off, and the CAN module is in sleep mode.







- **Note** Clear all TRQ bits when re-initialization of message buffer is executed by clearing RDY bit before bus-off recovery sequence is started.
- Caution When the transmission from the initialization mode to any operation modes is requested to execute bus-off recovery sequence again in the bus-off recovery sequence, reception error counter is cleared.

Therefore it is necessary to detect 11 consecutive recessive-level bits 128 times on the bus again.

**Remark** OPMODE: Normal operation mode, normal operation mode with ABT, receive-only mode, single-shot mode, self-test mode



Figure 15-57. Bus-Off Recovery (Normal Operation Mode with ABT)

- **Note** Clear all TRQ bits when re-initialization of message buffer is executed by clearing RDY bit before bus-off recovery sequence is started.
- Caution When the transmission from the initialization mode to any operation modes is requested to execute bus-off recovery sequence again in the bus-off recovery sequence, reception error counter is cleared.

Therefore it is necessary to detect 11 consecutive recessive-level bits 128 times on the bus again.

**Remark** OPMODE: Normal operation mode, normal operation mode with ABT, receive-only mode, single-shot mode, self-test mode



#### Figure 15-58. Normal Shutdown Process









Caution Do not read- or write-access any registers by software between setting the EFSD bit and clearing the GOM bit.



Figure 15-60. Error Handling







Figure 15-61. Setting CPU Standby (from CAN Sleep Mode)

Caution Before the CPU is set in the CPU standby mode, please check the CAN sleep mode or not. However, after check of the CAN sleep mode, until the CPU is set in the CPU standby mode, the CAN sleep mode may be cancelled by wakeup from CAN bus.





Figure 15-62. Setting CPU Standby (from CAN Stop Mode)

Note During wakeup interrupts

Caution The CAN stop mode can only be released by writing 01B to the PSMODE[1:0] bit of the C0CTRL register and not by a change in the CAN bus state.



## CHAPTER 16 STEPPER MOTOR CONTROLLER/DRIVER

The Stepper Motor Controller/Driver module is comprised of four drivers (k = 1 to 4) for external 360° type meters or for bipolar and unipolar stepper motors.

#### 16.1 Overview

The Stepper Motor Controller/Driver module generates pulse width modulated (PWM) output signals. Each driver generates up to four output signals.

#### Features

- 8-bit precision pulse width can be specified
- Pseudo 9-bit precision pulse width can be specified by using the 1-bit addition function
- PWM output is possible at frequencies up to 20 kHz
- Automatic PWM phase shift for reducing fluctuation on power supply and for reducing the susceptibility to electromagnetic interference
- Zero Point Detection (ZPD) function

#### 16.1.1 Driver overview

A stepper motor is driven by PWM signals. The PWM signals are generated by comparing the contents of compare registers with the actual value of a free running up counter. The Stepper Motor Controller/Driver module contains one counter and assigned compare registers and control registers.

**Figure 16-1** shows the main components of the Stepper Motor Controller/Driver. The Stepper Motor Controller/Driver includes a free running up counter (CNT0). The counter is controlled by a timer mode control register (MCNTC0). Each of the four drivers consists of two compare registers, MCMPk0 and MCMPk1, respectively. Their contents define the pulse widths for the sine and the cosine side of the meters. The MCMPk0/MCMPk1 registers comprise a master-slave register combination. This allows to re-write the master register while the slave register is currently used for comparison with the counter CNT0.

The compare control register MCMPCk defines whether or not enhanced pulse width precision by one-bit addition is enabled, and it routes the output signals to the corresponding output pins (SMk1 to SMk4).

#### 16.1.2 ZPD introduction

Zero Point Detection (ZPD) enables calibration of meter needle without additional pins.

When the needle reaches the zero-point of the meter, the induction voltage generated to this point by back electromotive force drops. ZPD function has the circuit to detect the induced voltage which its reference voltage could be configured in advance. Each of the four drivers has one ZPD circuit.

For reliable results of the ZPD circuit, digital noise removal is applied.

For details on the internal reference voltage, refer to CHAPTER 29 ELECTRICAL SPECIFICATIONS ((A) GRADE PRODUCTS) (TARGET) and CHAPTER 30 ELECTRICAL SPECIFICATIONS ((A2) GRADE PRODUCTS) (TARGET).



# 16.1.3 ZPD input pins

When Zero Point Detection is enabled and the MCMPCk.TWIN bit is set, every driver can be used for calibration. Dedicated pins of each driver are then used as input pins to allow for Zero Point Detection of the connected meter.

• At Stepper Motor Controller/Driver, the SMk4 pin (k = 1 to 4) can be used as ZPD input.

Note that these pins have to be configured as input pins.

The result of a voltage comparison is reflected in the MCMPCk.ZPD bit. Properties of the ZPD can be set in the ZPD flag detection clock setting register CMPCTL. **Figure 16-1** shows the ZPD circuit of the Stepper Motor Controller/Driver.





Figure 16-1. Stepper Motor Controller/Driver Block Diagram

The external signals are listed in the following table.

Table 16-1. Stepper Motor Controller/Driver External Connections

Signal name	I/O	Active level	Reset level	Pins	Function
SM[1:4]1	0	-	L	SM11 to SM41	Driver signal, sine side (+)
SM[1:4]2	0	-	L	SM12 to SM42	Driver signal, sine side (-)
SM[1:4]3	0	-	L	SM13 to SM43	Driver signal, cosine side (+)
SM[1:4]4	0	-	L	SM14 to SM44	Driver signal, cosine side (-)



# 16.2 Stepper Motor Controller/Driver Registers

The Stepper Motor Controller/Driver is controlled and operated by means of the following registers:

Register name	Shortcut
Timer mode control registers	MCNTC0
Compare registers	MCMPk0 (k = 1 to 4)
	MCMPk1 (k = 1 to 4)
	MCMPkHW (k = 1 to 4)
Compare control registers	MCMPCk (k = 1 to 4)
Stepper motor port mode control register	SMPC
ZPD detection voltage setting registers	ZPDS0, ZPDS1
ZPD flag detection clock setting register	CMPCTL
ZPD operational control register	ZPDEN

Table 16-2. Stepper Motor Controller/Driver Registers Overview



# (1) Timer mode control register (MCNTC0)

The 8-bit MCNTC0 register controls the operation of the free running up counters CNT0.

These registers can be read/written in 8-bit or 1-bit units.

This register is cleared by any reset.

#### Figure 16-2. Format of Timer Mode Control Register (MCNTC0) (1/2)

Address: F9	C0H After	reset: 00H	R/W					
Symbol	7	6	5	4	3	2	1	0
MCNTC0	CAE	0	FULL	PCE	PCS	SMCL2	SMCL1	SMCL0

CAE	Stepper Motor Controller/Driver control							
0	Stepper Motor Controller/Driver operation is disabled.							
1	Stepper Motor Controller/Driver operation is enabled.							

FULL	Count range of the timer counter								
0	Count range from 01H to FFH								
1	Count range from 00H to FFH								
The initial sta 16.3.1 (3) Du	The initial start value is 00H in both cases. For the impact of this bit on duty factor and PWM cycle time, see also <b>16.3.1 (3) Duty factor</b> .								

PCE	Timer operation control						
0	Timer counter is stopped.						
1	Timer counter is enabled.						

PCS	Timer count clock							
0	Count clock specified by SMCL2 to SMCL0							
1	Rising edge of TM51 output as external clock							



SMCL2	SMCL1	SMCL0	Selected timer count clock
0	0	0	fers
0	0	1	fprs/2
0	1	0	fprs/2 <sup>2</sup>
0	1	1	fprs/2 <sup>3</sup>
1	0	0	fprs/2 <sup>4</sup>
1	0	1	fprs/2 <sup>5</sup>
1	1	0	fprs/2 <sup>6</sup>
1	1	1	fPRS/27
Sets the time	r count clock fo	r the timer cou	nter

## Figure 16-2. Format of Timer Mode Control Register (MCNTC0) (2/2)

# Caution Bit 6 must be 0.

#### Power save mode preparation

Before entering any power save mode the Stepper-C/D must be shut down in advance in order to minimize power consumption.

Apply following sequence to shut down the Stepper-C/D:

- 1. Stop the counter CNT0 by setting MCNTC0.PCE = 0.
- 2. Disable the Stepper-C/D operation by setting MCNTC0.CAE = 0.
- **Remark** Note that the MCNTC0.PCE and MCNTC0.CAE bits must not be cleared to 0 by a single write instruction. Perform two write instructions as shown above.



#### 78K0/Dx2

#### (2) Compare registers for sine side (MCMPk0) (k = 1 to 4)

The 8-bit MCMPk0 registers hold the values that define the PWM pulse width for the sine side of the connected meters.

The contents of the registers are continuously compared to the timer counter value:

Registers MCMP10 to MCMP40 are compared to CNT0.

When the register contents match the timer counter contents, a match signal is generated. Thus a PWM pulse with a pulse width corresponding to the MCMPk0 register contents is output to the sine side of the connected meter.

These registers can be read/written in 8-bit units.

This register is cleared by any reset.

Address: F9C2H, F9C4H, F9C6H, F9C8H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
MCMPk0				sine [	DATA			

**Remarks 1.** New data must only be written to registers MCMPk0 if the corresponding bit MCMPCk.TEN = 0.

- **2.** Don't write to the compare register MCMPk0, until the corresponding bit MCMPCk.TEN has been reset to 0 automatically.
- 3. To enable master-to-slave register copy upon next CNTm overflow set MCMPCk.TEN = 1.

#### (3) Compare registers for cosine side (MCMPk1) (k = 1 to 4)

The 8-bit MCMPk1 registers hold the values that define the PWM pulse width for the cosine side of the connected meters.

The contents of the registers are continuously compared to the timer counter value:

Registers MCMP11 to MCMP41 are compared to CNT0.

When the register contents match the timer counter contents, a match signal is generated. Thus a PWM pulse with a pulse width corresponding to the MCMPk1 register contents is output to the cosine side of the connected meter.

These registers can be read/written in 8-bit units.

This register is cleared by any reset.

Address: F	9C3H, F9C5H, I	F9C7H, F9C9H	After res	set: 00H	R/W			
Symbol	7	6	5	4	3	2	1	0
MCMPk1				cosi	ne DATA			

- **Remarks 1.** New data must only be written to registers MCMPk1 if the corresponding bit MCMPCk.TEN = 0.
  - 2. Don't write to the compare register MCMPk1, until the corresponding bit MCMPCk.TEN has been reset to 0 automatically.
  - 3. To enable master-to-slave register copy upon next CNTm overflow set MCMPCk.TEN = 1.



# (4) Combined compare registers (MCMPkHW) (k = 1 to 4)

The 16-bit MCMPkHW registers combine the sine and cosine registers MCMPk0 and MCMPk1. Via these registers it is possible to read or write the contents of MCMPk0 and MCMPk1 in a single instruction. These registers can be read/written in 16-bit units.

This register is cleared by any reset.

Address: F9C2	H, F90	C4H, F9	9C6H, I	F9C8H	Afte	er reset	: 0000	H R	/W							
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MCMPkHW				cosine	DATA							sine [	DATA			

**Remarks 1.** New data must only be written to registers MCMPkHW if the corresponding bit MCMPCk.TEN = 0.

- 2. Don't write to the compare register MCMPkHW, until the corresponding bit MCMPCk.TEN has been reset to 0 automatically.
- 3. To enable master-to-slave register copy upon next CNTm overflow set MCMPCk.TEN = 1.



# 78K0/Dx2

## (5) Compare control registers (MCMPCk) (k = 1 to 4)

The 8-bit MCMPCk registers control the operation of the corresponding compare registers and the output direction of the PWM pin.

These registers can be read/written in 8-bit or 1-bit units.

This register is cleared by any reset.

#### Figure 16-3. Format of Compare Control Registers (MCMPCk) (1/2)

Address: F9CAH, F9CCH, F9CEH, F9F8H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
MCMPCk	AOUT	TWIN	ZPD <sup>Note</sup>	TEN	ADB1	ADB0	DIR1	DIR0

#### Note This bit may be written, but writing is ignored.

AOUT	Output pins for sine and cosine signals
0	The PWM signals for sine and cosine side are output to those pins that are selected by bits DIR0 and DIR1. At all other pins, the output signal is 0 (SMVss level).
1	The PWM signal for the sine side is output to pins SMk1 and SMk2. The PWM signal for the cosine side is output to pins SMk3 and SMk4.

TWIN	0-point detection timing window
0	Disable writing to ZPD bit from the comparator (No 0-point detection)
1	Enable writing to ZPD bit from the comparator (0-point detection)

ZPD	Induced voltage detection bit for 0-point detection (Read only)						
0	No induced voltage detection (0-point detection)						
1	Induced voltage detection (No 0-point detection)						

TEN	Transfer enable control bit							
0	MCMPk0/MCMPk1 master-to-slave register copy is disabled. New data can be written to compare registers MCMPk0 or MCMPk1.							
1	MCMPk0/MCMPk1 master-to-slave register copy is enabled. The copy process will take place when CNT0 overflows. Don't write to compare registers MCMPk0 or MCMPk1 while MCMPCk.TEN = 1.							
Remark Th	his bit functions as a control bit and status flag. It is automatically reset to zero upon the next timer punter overflow.							

ADB1	1-bit addition circuit control (cosine side)						
0	No 1-bit addition to PWM signal						
1	1-bit addition to PWM signal						

ADB0	1-bit addition circuit control (sine side)					
0	No 1-bit addition to PWM signal					
1	1-bit addition to PWM signal					



DIR1	DIR0	DIR0 Selected output pins							
0	0 0 Quadrant 1: SMk1 (sin +), SMk3 (cos +)								
0 1 Quadrant 2: SMk1 (sin +), SMk4 (cos –)									
1 0 Quadrant 3: SMk2 (sin –), SMk4 (cos –)									
1	1 1 Quadrant 4: SMk2 (sin –), SMk3 (cos +)								
Selects the or	utput pins for th	ne PWM signals.							
Bits DIR1 and DIR0 address the quadrant to be activated by sine and cosine. The PWM signal is routed to the specific pin with respect to the sin/cos of each quadrant.									
At the other output pins, the output level is SMVss.									
<b>Remark</b> These bits are only considered if bit AOUT is set to 0.									

Figure 16-3	3. Format of Compare Control Registers (MCN	/IPCk) (2/2)
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# (6) Stepper motor port mode control register (SMPC)

The 8-bit SMPC register controls output mode of SMnm pins (n = 1 to 4, m 1 to 4). These registers can be read/written in 8-bit or 1-bit units. This register is cleared by any reset.

#### Figure 16-4. Format of Stepper Motor Port Mode Control Register (SMPC)

Address: FF	-3DH After reset: 00H		R/W						
Symbol	7	6	5	4	3	2	1	0	
SMPC	MOD4	MOD3	MOD2	MOD1	EN4	EN3	EN2	EN1	

ENn	MODn	Port mode selection $(n = 0 \text{ to } 4)$						
0	-	ort mode						
		All SMnm (n = 1 to 4, m = 1 to 4) are set to port function.						
1	0	PWM full bridge mode						
		SMnm (n = 1 to 4, m = 1 to 4) are set to full bridge output control mode.						
1	1	PWM half bridge mode						
		Depending on the DIRnk (n = 1 to 4, k = 0, 1) bit of the compare control registers (MCMPCn; n = 1 to 4), SMnm (n = 1 to 4, m = 1 to 4) are set to PWM output control mode or port mode.						

An example of settings when n = 1 is as follows:

EN1	MOD1	DIR11	DIR10	Ĩ	PWM Outp	Output Mode		
				SM11	SM12	SM13	SM14	
				(sin+)	(sin–)	(cos+)	(cos–)	
0	_	_	-	port	port	port	port	Port mode
1	0	0	0	PWM	0	PWM	0	PWM full bridge mode
1	0	0	1	PWM	0	0	PWM	
1	0	1	0	0	PWM	0	PWM	
1	0	1	1	0	PWM	PWM	0	
1	1	0	0	PWM	port	PWM	port	PWM half bridge mode
1	1	0	1	PWM	port	port	PWM	
1	1	1	0	port	PWM	port	PWM	
1	1	1	1	port	PWM	PWM	port	

Caution Set port registers (Pn) and port mode registers (PMn) whose pins are not in the PWM mode to 00H in the PWM full bridge mode.



# 78K0/Dx2

# (7) ZPD detection voltage setting registers (ZPDS0, ZPDS1)

The 8-bit ZPDS0, ZPDS1 registers set ZPD detection voltage and control ZPD analog input. These registers can be read/written in 8-bit or 1-bit units. This register is cleared by any reset.

#### Figure 16-5. Format of ZPD detection voltage setting registers (ZPDS0, ZPDS1)

Address: F9FCH After reset: 00H			R/W							
Symbol	7	6	5	4	3	2	1	0		
ZPDS0	ZPD2PC	ZPD2S2	ZPD2S1	ZPD2S0	ZPD1PC	ZPD1S2	ZPD1S1	ZPD1S0		
Address: F9	FDH After	reset: 00H	R/W							

Symbol	7	6	5	4	3	2	1	0
ZPDS1 <sup>Note</sup>	ZPD4PC	ZPD4S2	ZPD4S1	ZPD4S0	ZPD3PC	ZPD3S2	ZPD3S1	ZPD3S0

Note 78K0/DF2 only.

ZPDnS2	ZPDnS1	ZPDnS0	0-point detection voltage setting for ZPDn ( $n = 1$ to 4)
0	0	0	SMV <sub>DD×</sub> 3/100 = 0.15 V
0	0	1	SMV <sub>DD</sub> ×5/100 = 0.25 V
0	1	0	SMV <sub>DD×</sub> 7/100 = 0.35 V
0	0 1 1		SMV <sub>DD</sub> ×9/100 = 0.45 V
1	0	0	SMV <sub>DD</sub> ×11/100 = 0.55 V
Other than above		e	Setting prohibited

ZPDnPC	Analog input/digital port selection					
0	Digital port/SM pin					
1	ZPD analog input					



# (8) ZPD flag detection clock setting register (CMPCTL)

The 8-bit CMPCTL register controls the clock for noise elimination. This register can be read/written in 8-bit or 1-bit units.

This register is cleared by any reset.

#### Figure 16-6. Format of ZPD Flag Detection Clock Setting Register (CMPCTL)

Address: F9FEH After reset: 00H		R/W						
Symbol	7	6	5	4	3	2	1	0
CMPCTL	0	0	0	0	DBCL3	DBCL2	DBCL1	DBCL0

DBCL3	DBCL2	DBCL1	DBCL0	Selected clock
0	0	0	0	fprs
0	0	0	1	fprs/2
0	0	1	0	fprs/2 <sup>2</sup>
0	0	1	1	fprs/2 <sup>3</sup>
0	1	0	0	fprs/2 <sup>4</sup>
0	1	0	1	fprs/2⁵
0	1	1	0	fprs/2 <sup>6</sup>
0	1	1	1	fprs/2 <sup>7</sup>
1	0	0	0	fprs/2 <sup>8</sup>
1	0	0	1	fprs/2°
Other than at	ove			Setting prohibited

## (9) ZPD operational control register (ZPDEN)

The 8-bit ZPDEN register controls ZPD operation. These registers can be read/written in 8-bit or 1-bit units. This register is cleared by any reset.

## Figure 16-7. Format of ZPD Operational Control Register (ZPDEN)

Address	: F9	FFH A	fter reset: 00H	R/W						
Symbol		7	6	5	4	3	2	1	0	
ZPDEN		0	0	0	0	ZPD4EN	ZPD3EN	ZPD2EN	ZPD1EN	
	-									
	Z	ZPDnEN ZPDn comparator operation (n = 1 to 4)								
	0 Disables oper			ation.						
		1	Enables opera	ation.						



# 16.3 Operation

In the following, the operation of the Stepper Motor Controller/Driver module as a driver for external meters is described.

#### 16.3.1 Stepper motor controller/driver operation

This section describes the generation of PWM signals of the driver k for driving external meters. Further, the explanation about the duty factor, operation of 1-bit addition circuit, detecting zero points and digital noise filter is shown.

**Remark** k = 1 to 4

# (1) Driving meters

External meters can be driven both in full bridge configuration and in half bridge configuration:

• Driving meters in full bridge configuration

Deflection of the needle of a meter in full bridge configuration is determined by the sine and cosine value of its desired angle. Since the PWM signals do not inherit a sign, separate signals for positive and negative sine and cosine values are generated.

The four signals at pins SMk1 to SMk4 of the driver k are:

- sine side, positive (sin +)
- sine side, negative (sin -)
- cosine side, positive (cos +)
- cosine side, negative (cos -)

Two output control circuits select which signal (sign) for sine side and cosine side is output (bits MCMPCk.DIR[1:0]). At the remaining two output pins, the signal is set to low level.

To drive meter k in full bridge mode, set bit MCMPCk.AOUT to 0.

Driving meters in half bridge configuration
 In this mode, the same signal is sent to both sine pins (SMk1 and SMk2) and both cosine pins (SMk3 and SMk4), respectively. The setting of output control bits MCMPCk.DIR[1:0] is neglected.

To drive meter k in half bridge mode, set bit MCMPCk.AOUT to 1.

## (2) Generation of PWM signals

Bit data corresponding to the length of the PWM pulses has to be written to the compare registers MCMPk0 (sine side) and MCMPk1 (cosine side).

A timer counter is counting up. The rising edge of the PWM pulse is initiated at the overflow of the counter. The falling edge of the PWM pulse is initiated when the counter value equals the contents of the compare register. The absolute pulse length in seconds is defined by the timer count clock ( $f_{MCO}$ ). Various cycle times can be set via the timer mode control register MCNTCO.

## Instruction

When writing data to compare registers, proceed as follows:

- 1. Confirm that MCMPCk.TEN = 0.
- 2. Write 8-bit PWM data to MCMPk0 and MCMPk1.
- 3. Set MCMPCk.ADB0 and MCMPCk.ADB1 as desired.
- Set MCMPCk.TEN = 1 to start the counting operation. The data in MCMPk0/MCMPk1 will automatically be copied to the compare slave register when the counter overflows. The new pulse width is valid immediately. Bit MCMPCk.TEN is automatically cleared to 0 by hardware.

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# (3) Duty factor

The minimum pulse width that can be generated is zero (output signal is low) and the maximum pulse width is 255 clock cycles (maximum value of 8-bit compare registers).

The count range of the timer counter defines the duty factor. It can be set by bit MCNTC0.FULL:

- count range 01H to FFH (MCNTC0.FULL = 0) Formula for the duty cycle: PWM duty = MCMPki / 255 with k = 1 to 4 and i = 0, 1 One count cycle is comprised of 255 clock cycles. A PWM signal with maximum pulse length is a steady high level signal. The duty factor is 100%.
- count range 00H to FFH (MCNTC0.FULL = 1)
  Formula for the duty cycle:

 $PWM \ duty = MCMPki \ / \ 256 \qquad \qquad with \ k = 1 \ to \ 4 \ and \ i = 0, \ 1$ 

One count cycle is comprised of 256 clock cycles. A PWM signal with maximum pulse length is comprised of 255 clock cycles at high level and one clock cycle at low level. The duty factor is  $255/256 \times 100\% = 99.6\%$ .

# (4) Operation of 1-bit addition circuit

The precision of the angle of a needle is implicitly defined by the number of bits of the compare registers MCMPk0 and MCMPk1 (8 bit).

If the 1-bit addition circuit is enabled, every second pulse of the PWM signal is extended by one bit (one clock cycle). In average, a pulse width precision of 1/2 bit (1/2 clock) can be achieved.

The following figures show the timing of PWM output signals with 1-bit addition disabled and enabled.

- **Remarks 1.** The PWM pulse is not generated until the first overflow occurs after the counting operation has been started.
  - **2.** The PWM signal is two cycle counts delayed compared to the overflow signal and the match signal. This is not depicted in the figures.

## (5) Detecting zero points

For the detection of zero points, proceed as follows:

- 1. Set ZPDn pin to analog input by setting ZPDnEN = 0, and select reference level using ZPDnS2 to ZPDnS0.
- 2. Enable ZPD comparator operation by setting ZPDnEN = 1, and wait for comparator stabilization time.
- 3. Enable ZPDn flag operation by setting TWIN = 1.
- 4. Apply input signal to ZPDn pin, and start detection operation.

## (6) Digital noise filter

The noise removal circuit suppresses short pulses/spikes of the comparator output to gain stable comparison results.

The minimum voltage comparator output pulse width to be validated is configurable by selecting the sampling clock for the digital noise removal, refer to CMPCTL.DBCL[3:0]. Spikes shorter than 2 sampling cycles are suppressed. Pulses longer than 3 sampling cycles are recognized as valid pulses. For pulses between 2 and 3 sampling cycles, the behavior is not defined.





Figure 16-8. Output Timing without 1-bit Addition





## Sequence

- 1. Start of counting (MCNTC0.PCE is set to 1)
- 2. Generation of overflow signal (start of PWM pulse)
- 3. Generation of match signal (timer counter CNT0 matches compare register, end of PWM pulse)


# 16.4 Timing

This section starts with the timing of the timer counter and general output timing behaviour. This section describes the timing at which the timer counter increments and when the count value is generally output. An example showing automatic phase shifting is also provided.

#### 16.4.1 Timer counter

The free running up counter is clocked by the timer count clock selected in register MCNTC0. The counting operation is enabled or disabled by the MCNTC0.PCE bit.

## Figure 16-10. Restart Timing after Count Stop (Count Start—Count Stop—Count Start)



#### Sequence

- Count Start:
  - Enable counting operation (MCNTC0.PCE = 1)
  - Timer counter starts with value 00H. Depending on bit MCNTC0.FULL, all following counter cycles start with 00H or 01H, respectively.
- Count Stop:
  - Disable counting operation (MCNTC0.PCE = 0)
  - Counting is stopped and timer counter is set to 00H.



# 16.4.2 Automatic PWM phase shift

If the sine and cosine waveforms of meters 1 to 4 switch simultaneously as indicated by the dotted lines in **Figure 16-11**, the power supply might fluctuate, increasing susceptibility to electromagnetic interference. To prevent this, the signals output to drivers 1 to 4 are shifted one cycle of the timer count clock specified by the MCNTC0 register so that they are output at the timing indicated by the solid lines in **Figure 16-11**.







# CHAPTER 17 LCD CONTROLLER/DRIVER

# 17.1 Functions of LCD Controller/Driver

The functions of the LCD controller/driver in the 78K0/Dx2 are as follows.

- (1) The LCD driver voltage generator uses internal resistance division method.
- (2) Automatic output of segment and common signals based on automatic display data memory read
- (3) Three different display modes:
  - Static
  - 1/3 duty (1/3 bias)
  - 1/4 duty (1/3 bias)
- (4) Six different frame frequencies, selectable in each display mode

(5)	μPD78F0838, 78F0839:	Segment signal outputs: 40 (SEG0 to SEG39),
		Common signal outputs: 4 (COM0 to COM3)
	μPD78F0840, 78F0841, 78F0846, 78F0847:	Segment signal outputs: 32 (SEG0 to SEG31),
		Common signal outputs: 4 (COM0 to COM3)
	μPD78F0842, 78F0843, 78F0848, 78F0849:	Segment signal outputs: 28 (SEG0 to SEG27),
		Common signal outputs: 4 (COM0 to COM3)
	μPD78F0836, 78F0837, 78F0844, 78F0845:	Segment signal outputs: 24 (SEG0 to SEG23),
		Common signal outputs: 4 (COM0 to COM3)



 Table 17-1 lists the maximum number of pixels that can be displayed in each display mode.

#### Table 17-1. Maximum Number of Pixels

#### (a) *µ*PD78F0838, 78F0839

LCD Driver Voltage Generator	Bias Mode	Number of Time Slices	Common Signals Used	Number of Segments	Maximum Number of Pixels
Internal resistance division	-	Static	COM0 (COM1 to COM3)	40	40 (40 segment signals, 1 common signal) <sup>Note 1</sup>
	1/3	3	COM0 to COM2		120 (40 segment signals, 3 common signals) <sup>Note 2</sup>
		4	COM0 to COM3		160 (40 segment signals, 4 common signals) <sup>Note 3</sup>

Notes 1. 5-digit LCD panel, each digit having an 8-segment  $\ensuremath{\mathcal{B}}$  configuration.

- **2.** 15-digit LCD panel, each digit having a 3-segment  $\mathcal{B}$  configuration.
- **3.** 20-digit LCD panel, each digit having a 2-segment  $\mathcal{E}$  configuration.

## (b) *µ*PD78F0840, 78F0841, 78F0846, 78F0847

LCD Driver Voltage Generator	Bias Mode	Number of Time Slices	Common Signals Used	Number of Segments	Maximum Number of Pixels
Internal resistance division	-	Static	COM0 (COM1 to COM3)	32	32 (32 segment signals, 1 common signal) <sup>№te 1</sup>
	1/3	3	COM0 to COM2		96 (32 segment signals, 3 common signals) <sup>№te 2</sup>
		4	COM0 to COM3		128 (32 segment signals, 4 common signals) <sup>№te 3</sup>

Notes 1. 4-digit LCD panel, each digit having an 8-segment  $\mathcal{B}$  configuration.

- **2.** 12-digit LCD panel, each digit having a 3-segment  $\mathcal{B}$  configuration.
- 3. 16-digit LCD panel, each digit having a 2-segment  $\ensuremath{\mathcal{B}}$  configuration.

## (c) *µ*PD78F0842, 78F0843, 78F0848, 78F0849

LCD Driver Voltage Generator	Bias Mode	Number of Time Slices	Common Signals Used	Number of Segments	Maximum Number of Pixels
Internal resistance division	-	Static	COM0 (COM1 to COM3)	28	28 (28 segment signals, 1 common signal) <sup>№te 1</sup>
	1/3	3	COM0 to COM2		84 (28 segment signals, 3 common signals) <sup>№te 2</sup>
		4	COM0 to COM3		112 (28 segment signals, 4 common signals) <sup>№te 3</sup>

**Notes 1.** 4-digit LCD panel, each digit having an 8-segment  $\mathcal{B}$  configuration.

- **2.** 12-digit LCD panel, each digit having a 3-segment  $\mathcal{B}$  configuration.
- 3. 16-digit LCD panel, each digit having a 2-segment  $\ensuremath{\mathcal{B}}$  configuration.



# (d) $\mu$ PD78F0836, 78F0837, 78F0844, 78F0845

LCD Driver Voltage Generator	Bias Mode	Number of Time Slices	Common Signals Used	Number of Segments	Maximum Number of Pixels
<ul> <li>Internal resistance division</li> </ul>	-	Static	COM0 (COM1 to COM3)	24	24 (24 segment signals, 1 common signal) <sup>№te 1</sup>
	1/3	3	COM0 to COM2		72 (24 segment signals, 3 common signals) <sup>№te 2</sup>
		4	COM0 to COM3		96 (24 segment signals, 4 common signals) <sup>№te 3</sup>

Notes 1. 3-digit LCD panel, each digit having an 8-segment  $\ensuremath{\mathcal{B}}$  configuration.

**2.** 9-digit LCD panel, each digit having a 3-segment  $\mathcal{B}$  configuration.

**3.** 12-digit LCD panel, each digit having a 2-segment  $\mathcal{B}$  configuration.



# 17.2 Configuration of LCD Controller/Driver

The LCD controller/driver consists of the following hardware.

Item	Configuration					
Display outputs	μPD78F0838, 78F0839	40 segment signals (SEG0 to SEG39), 4 common signals (COM0 to COM3)				
	μPD78F0840, 78F0841, 78F0846, 78F0847	32 segment signals (SEG0 to SEG31), 4 common signals (COM0 to COM3)				
	μPD78F0842, 78F0843, 78F0848, 78F0849	28 segment signals (SEG0 to SEG27), 4 common signals (COM0 to COM3)				
	μPD78F0836, 78F0837, 78F0844, 78F0845	24 segment signals (SEG0 to SEG23), 4 common signals (COM0 to COM3)				
Control registers	LCD mode register (LCDMD)					
	LCD display mode register (LCDM)					
	LCD clock control register (LCDC0)					
	LCD port function register 0 (LCDPF0)					
	LCD port function register 3 (LCDPF3)					
	LCD port function register ALL (LCDPFALL)					





Figure 17-1. Block Diagram of LCD Controller/Driver



# 17.3 Registers Controlling LCD Controller/Driver

The following ten registers are used to control the LCD controller/driver.

- LCD mode register (LCDMD)
- LCD display mode register (LCDM)
- LCD clock control register (LCDC0)
- LCD port function register 0 (LCDPF0)
- LCD port function register 3 (LCDPF3)
- LCD port function register ALL (LCDPFALL)

## (1) LCD mode register (LCDMD)

LCDMD sets the LCD drive voltage generator.

LCDMD is set using a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets LCDMD to 00H.

#### Figure 17-2. Format of LCD Mode Register

Address	: FF5AH	After reset: 00H	R/W					
Symbol	7	6	5	4	3	2	1	0
LCDMD	0	0	MDSET1	MDSET0	0	0	0	0

MDSET1	MDSET0	LCD drive voltage generator selection			
0	0	No internal resistor connection (power save mode).			
0	1	ernal resistance division method, internal resistor connection			
		(no step-down transforming, Used when $V_{LCD} = V_{DD}$ )			
1	1	Internal resistance division method, internal resistor connection			
		(step-down transforming, Used when $V_{LCD} = 3/5V_{DD}$ )			
Other than above		Setting prohibited			

Caution Bits 0 to 3, 6 and 7 must be set to 0.



# (2) LCD display mode register (LCDM)

LCDM specifies whether to enable display operation. It also specifies whether to enable segment pin/common pin output, gate booster circuit control, and the display mode. LCDM is set using a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets LCDM to 00H.

# Figure 17-3. Format of LCD Display Mode Register

Address	: FF5BH A	fter reset: 00H	R/W					
Symbol	<7>	<6>	5	4	3	2	1	0
LCDM	LCDON	SCOC	0	0	0	LCDM2	0	LCDM0

LCDON	LCD display enable/disable			
0	isplay off (all segment outputs are deselected.)			
1	Display on			

SCOC	Segment pin/common pin output control <sup>Note</sup>			
0	output ground level to segment/common pin			
1	Output deselect level to segment pin and LCD waveform to common pin			

LCDM2	LCDM0	LCD controller/driver display mode selection				
		Resistance division method				
		Number of time slices	Bias mode			
0	0	4	1/3			
0	1	3	1/3			
1	0	Static				
Other than above		Setting prohibited				

**Note** When LCD display is not to be performed or not required, power consumption can be reduced by using the following settings.

- <1> Set SCOC (bit 6 of the LCD display mode register (LCDM)) to 0.
- <2> Set MDSET0 and MDSET1 (bits 4 and 5 of the LCD mode register (LCDMD)) to 0. (The current flowing to the internal resistors can be reduced.)

Cautions 1. Bits 1, 3 to 5 must be set to 0.

 When displaying in a mode with a large number of COMs, such as 4 COM, V<sub>LC0</sub> may not be able to obtain sufficient contrast under the low-voltage conditions, depending on the panel characteristics. Use the LCD controller/driver after having performed thorough LCD display evaluation and confirmed that there are no problems regarding the display quality.



# (3) LCD clock control register (LCDC0)

LCDC0 specifies the LCD source clock and LCD clock.

The frame frequency is determined according to the LCD clock and the number of time slices.

LCDC0 is set using a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets LCDC0 to 00H.

# Figure 17-4. Format of LCD Clock Control Register

Address	: FF5CH	After reset: 00H	R/W					
Symbol	7	6	5	4	3	2	1	0
LCDC0	0	LCDC6	LCDC5	LCDC4	0	LCDC2	LCDC1	LCDC0

LCDC6	LCDC5	LCDC4	LCD source clock (fLCD) selection
0	0	0	fsuв (32.768 kHz)
0	0	1	fprs/2 <sup>7</sup>
0	1	0	fprs/2 <sup>8</sup>
0	1	1	fprs/2°
1	0	0	fosc/2 <sup>3</sup>
Other than above			Setting prohibited

LCDC2	LCDC1	LCDC0	LCD clock (LCDCL) selection
0	0	0	fLCD/2 <sup>4</sup>
0	0	1	fLCD/2 <sup>5</sup>
0	1	0	fLCD/2 <sup>6</sup>
0	1	1	flcd/2 <sup>7</sup>
1	0	0	fLCD/2 <sup>8</sup>
1	0	1	fLCD/2 <sup>9</sup>
Other than abo	ove		Setting prohibited

# Caution Bits 3 and 7 must be set to 0.

- Remarks 1. fsub: XT1 clock oscillation frequency
  - 2. fPRS: Peripheral hardware clock frequency
  - 3. fosc: Internal low-speed oscillation clock frequency



# (4) LCD port function register 0 (LCDPF0)

This register sets whether to use pins P00 to P07 as port pins (other than segment output pins) or segment output pins.

LCDPF0 is set using a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets LCDPF0 to 00H.

# Figure 17-5. Format of LCD Port Function Register 0

Symbol         7         6         5         4         3	2 1 0
LCDPF0 PF07 PF06 PF05 PF04 PF0	3 PF02 PF01 PF00

PF0n	Port/segment output specification			
0	Jsed as port (other than segment output)			
1	Jsed as segment output			

**Remark** n = 0 to 7

# (5) LCD port function register 3 (LCDPF3)

This register sets whether to use pins P30 to P37 as port pins (other than segment output pins) or segment output pins.

LCDPF3 is set using a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets LCDPF3 to 00H.

#### Figure 17-6. Format of LCD Port Function Register 3

#### Address: FF0DH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
LCDPF3	PF37	PF36	PF35	PF34	PF33	PF32	PF31	PF30

PF3n	Port/segment output specification			
0	Jsed as port (other than segment output)			
1	Used as segment output			

**Remark** n = 0 to 7



# (6) LCD port function register ALL (LCDPFALL)

This register sets whether to use pins P74 to P77, P13 to P16, P8 and P9 as port pins (other than segment output pins) or segment output pins.

LCDPFALL is set using a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets LCDPFALL to 00H.

# Figure 17-7. Format of LCD Port Function Register ALL

Address: FF1AH	After reset: 00H	R/W
Audiess. FFTAIT		n/ v v

Symbol	7	6	5	4	3	2	1	0
LCDPF	PF7UPNIB	PF16	PF15	PF14	PF13	PF9ALL	PF8ALL	0
ALL								

PF7UPNIB	Port/segment output specification			
0	Jsed as port (other than segment output)			
1	Used as segment output			

PF1n	Port/segment output specification
0	Used as port (other than segment output)
1	Used as segment output

#### **Remark** n = 3 to 6

PFnALL	Port/segment output specification			
0	Used as port (other than segment output)			
1	Used as segment output			

**Remark** n = 8, 9



# 17.4 Setting LCD Controller/Driver

Set the LCD controller/driver using the following procedure:

- <1> Set the LCD drive method via MDSET0 and MDSET1 (bits 4 and 5 of the LCD mode register (LCDMD)).
- <2> Set the pins to be used as segment outputs to the port function registers (LCDPF0, LCDPF3, LCDALL).
- <3> Set an initial value to the RAM for LCD display.
- <4> Set the number of time slices via LCDM0 to LCDM2 (bits 0 to 2 of the LCD display mode register (LCDM)).
- <5> Set the LCD source clock and LCD clock via LCD clock control register (LCDC0).
- <6> Set SCOC (bit 6 of the LCD display mode register (LCDM)) to 1.
- <7> Start output corresponding to each data memory by setting LCDON (bit 7 of the LCD display mode register (LCDM)) to 1.

Subsequent to this procedure, set the data to be displayed in the data memory.

- **Remark** Use the following procedure to set to the display-off state and disconnect the internal resistors when using the internal resistance division method.
  - <1> Clear LCDON (bit 7 of LCDM) (LCDON = 0). Deselect signals are output from all segment pins and common pins, and a non-display state is entered.
  - <2> Clear SCOC (bit 6 of the LCD display mode register (LCDM)) (SCOC = 0). Ground levels are output from all segment pins and common pins.
  - <3> Assume MDSET0, MDSET1 (bits 4 and 5 of the LCD mode register (LCDMD)) = (0, 0) and set to no internal resistor connection (power save mode).
- Caution When displaying in a mode with a large number of COMs, such as 4 COM, V<sub>LC0</sub> may not be able to obtain sufficient contrast under the low-voltage conditions, depending on the panel characteristics. Use the LCD controller/driver after having performed thorough LCD display evaluation and confirmed that there are no problems regarding the display quality.



# 17.5 LCD Display Data Memory

The LCD display data memory is mapped at addresses F9D0H to F9F7H. Data in the LCD display data memory can be displayed on the LCD panel using the LCD controller/driver.

Figure 17-8 shows the relationship between the contents of the LCD display data memory and the segment/common outputs.

The areas not to be used for display can be used as normal RAM.

Figure 17-8.	Relationship between LCD Display Data Memory Contents and Segment/Common Outputs (1/2)
	(a) μPD78F0838, 78F0839



(b) *µ*PD78F0840, 78F0841, 78F0846, 78F0847

	b7	b6	b5	b4	b3	b2	b1	b0	
F9EFH	0	0	0	0					SEG31
F9EEH	0	0	0	0					SEG30
F9ECH	0	0	0	0					SEG29
F9D5H	0	0	0	0					SEG5
F9D4H	0	0	0	0					SEG4
F9D3H	0	0	0	0					SEG3
F9D2H	0	0	0	0					SEG2
F9D1H	0	0	0	0					SEG1
F9D0H	0	0	0	0					SEG0
					COM3	COM2	COM1	COM0	

Caution No memory is allocated to the higher 4 bits. Be sure to set there bits to 0.

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#### b7 b6 b5 b4 b3 b2 b1 b0 F9EBH 0 0 0 0 SEG27 F9EAH 0 0 0 0 SEG26 F9E9H 0 0 0 0 SEG25 F9D5H SEG5 0 0 0 0 F9D4H 0 0 0 0 SEG4 F9D3H 0 0 0 0 SEG3 F9D2H SEG2 0 0 0 0 F9D1H 0 0 0 0 SEG1 F9D0H 0 0 0 0 SEG0 COM3 COM2 COM1 COM0

# Figure 17-8. Relationship between LCD Display Data Memory Contents and Segment/Common Outputs (2/2) (c) μPD78F0842, 78F0843, 78F0848, 78F0849





Caution No memory is allocated to the higher 4 bits. Be sure to set there bits to 0.



# 17.6 Common and Segment Signals

Each pixel of the LCD panel turns on when the potential difference between the corresponding common and segment signals becomes higher than a specific voltage (LCD drive voltage,  $V_{LCD}$ ). The pixels turn off when the potential difference becomes lower than  $V_{LCD}$ .

Applying DC voltage to the common and segment signals of an LCD panel causes deterioration. To avoid this problem, this LCD panel is driven by AC voltage.

# (1) Common signals

Each common signal is selected sequentially according to a specified number of time slices at the timing listed in **Table 17-3**. In the static display mode, the same signal is output to COM0 to COM3. In the three-time-slice mode, leave the COM3 pin open.

COM Signal Number of Time Slices	COM0	COM1	COM2	СОМЗ
Static display mode				
Three-time-slice mode				Open
Four-time-slice mode	4			

## Table 17-3. COM Signals



# (2) Segment signals

# (a) *μ*PD78F0838, 78F0839

The segment signals correspond to 40 bytes of the LCD display data memory (F9D0H to F9F7H) during an LCD display period, bits 0, 1, 2, and 3 of each byte are read in synchronization with COM0, COM1, COM2, and COM3, respectively. If a bit is 1, it is converted to the select voltage, and if it is 0, it is converted to the deselect voltage. The conversion results are output to the segment pins (SEG0 to SEG39).

# (b) *μ*PD78F0840, 78F0841, 78F0846, 78F0847

The segment signals correspond to 32 bytes of the LCD display data memory (F9D0H to F9EFH) during an LCD display period, bits 0, 1, 2, and 3 of each byte are read in synchronization with COM0, COM1, COM2, and COM3, respectively. If a bit is 1, it is converted to the select voltage, and if it is 0, it is converted to the deselect voltage. The conversion results are output to the segment pins (SEG0 to SEG31).

# (c) *µ*PD78F0842, 78F0843, 78F0848, 78F0849

The segment signals correspond to 28 bytes of the LCD display data memory (F9D0H to F9EBH) during an LCD display period, bits 0, 1, 2, and 3 of each byte are read in synchronization with COM0, COM1, COM2, and COM3, respectively. If a bit is 1, it is converted to the select voltage, and if it is 0, it is converted to the deselect voltage. The conversion results are output to the segment pins (SEG0 to SEG27).

# (d) μPD78F0836, 78F0837, 78F0844, 78F0845

The segment signals correspond to 24 bytes of the LCD display data memory (F9D0H to F9E7H) during an LCD display period, bits 0, 1, 2, and 3 of each byte are read in synchronization with COM0, COM1, COM2, and COM3, respectively. If a bit is 1, it is converted to the select voltage, and if it is 0, it is converted to the deselect voltage. The conversion results are output to the segment pins (SEG0 to SEG23).

Check, with the information given above, what combination of front-surface electrodes (corresponding to the segment signals) and rear-surface electrodes (corresponding to the common signals) forms display patterns in the LCD display data memory, and write the bit data that corresponds to the desired display pattern on a one-to-one basis.

LCD display data memory bits 1 to 3, and bit 3 are not used for LCD display in the static display, three-time slot modes, respectively. So these bits can be used for purposes other than display. The higher 4 bits of "F9D0H to F9D3H" are fixed to 0.



# (3) Output waveforms of common signals and segment signals during LCD display signal output period

The voltages shown in **Table 17-4** are output to the common signals and segment signals during the LCD display signal output period.

When both common and segment signals are at the select voltage, a display on-voltage of  $\pm V_{LCD}$  is obtained. The other combinations of the signals correspond to the display off-voltage.

#### Table 17-4. LCD Drive Voltage

#### (a) Static display mode (during LCD display signal output period)

Segment Sig	gnal Select Signal Level	Deselect Signal Level
Common Signal	Vss/VLC0	VLC0/VSS
VLC0/VSS	-VLCD/+VLCD	0 V/0 V

## (b) 1/3 bias method (during LCD display signal output period)

	Segment Signal	Select Signal Level	Deselect Signal Level
Common Signal		Vss/VLC0	VLC1/VLC2
Select signal level	VLC0/VSS	-VLCD/+VLCD	$-\frac{1}{3}V_{LCD}/+\frac{1}{3}V_{LCD}$
Deselect signal level	VLC2/VLC1	$-\frac{1}{3}V_{LCD}/+\frac{1}{3}V_{LCD}$	$+\frac{1}{3}V_{LCD}/-\frac{1}{3}V_{LCD}$



Figure 17-9 shows the common signal waveforms, and Figure 17-10 shows the voltages and phases of the common and segment signals.





T: One LCD clock period TF: Frame frequency





# Figure 17-10. Voltages and Phases of Common and Segment Signals

T: One LCD clock period

## (b) 1/3 bias method



T: One LCD clock period



# 17.7 Display Modes

# 17.7.1 Static display example

**Figure 17-12** shows how the three-digit LCD panel having the display pattern shown in **Figure 17-11** is connected to the segment signals (SEG0 to SEG23) and the common signal (COM0) of the 78K0/Dx2 chip. This example displays data "12.3" in the LCD panel. The contents of the display data memory (F9D0H to F9E7H) correspond to this display.

The following description focuses on numeral "2." ( ⊇. ) displayed in the second digit. To display "2." in the LCD panel, it is necessary to apply the select or deselect voltage to the SEG8 to SEG15 pins according to **Table 17-5** at the timing of the common signal COM0; see **Figure 17-11** for the relationship between the segment signals and LCD segments.

Table 17-5.	Select and	Deselect	Voltages	(COM0)
-------------	------------	----------	----------	--------

Segment Common	SEG8	SEG9	SEG10	SEG11	SEG12	SEG13	SEG14	SEG15
COM0	Select	Deselect	Select	Select	Deselect	Select	Select	Select

According to **Table 17-5**, it is determined that the bit-0 pattern of the display data memory locations (F9D8H to F9DFH) must be 10110111.

**Figure 17-13** shows the LCD drive waveforms of SEG11 and SEG12, and COM0. When the select voltage is applied to SEG11 at the timing of COM0, an alternate rectangle waveform, +VLCD/-VLCD, is generated to turn on the corresponding LCD segment.

COM1 to COM3 are supplied with the same waveform as for COM0. So, COM0 to COM3 may be connected together to increase the driving capacity.







Remark n = 0 to 2





Figure 17-12. Example of Connecting Static LCD Panel

Data memory address





# Figure 17-13. Static LCD Drive Waveform Examples



# 17.7.2 Three-time-slice display example

**Figure 17-15** shows how the 8-digit LCD panel having the display pattern shown in **Figure 17-14** is connected to the segment signals (SEG0 to SEG23) and the common signals (COM0 to COM2) of the 78K0/Dx2 chip. This example displays data "123456.78" in the LCD panel. The contents of the display data memory (addresses F9D0H to F9E7H) correspond to this display.

The following description focuses on numeral "6." ( $\Xi$ .) displayed in the third digit. To display "6." in the LCD panel, it is necessary to apply the select or deselect voltage to the SEG6 to SEG8 pins according to **Table 17-6** at the timing of the common signals COM0 to COM2; see **Figure 17-14** for the relationship between the segment signals and LCD segments.

Segment	SEG6	SEG7	SEG8
Common			
COM0	Deselect	Select	Select
COM1	Select	Select	Select
COM2	Select	Select	-

Table 17-6. Select and Deselect Voltages (COM0 to COM2)

According to **Table 17-6**, it is determined that the display data memory location (F9D6H) that corresponds to SEG6 must contain x110.

**Figure 17-16** shows an example of LCD drive waveforms between the SEG6 signal and each common signal in the 1/3 bias method. When the select voltage is applied to SEG6 at the timing of COM1 or COM2, an alternate rectangle waveform,  $+V_{LCD}/-V_{LCD}$ , is generated to turn on the corresponding LCD segment.







Remark n = 0 to 7





Figure 17-15. Example of Connecting Three-Time-Slice LCD Panel

×': Can be used to store any data because there is no corresponding segment in the LCD panel.

 $\times:$  Can always be used to store any data because the three-time-slice mode is being used.

Data memory address





Figure 17-16. Three-Time-Slice LCD Drive Waveform Examples (1/3 Bias Method)

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# 17.7.3 Four-time-slice display example

**Figure 17-18** shows how the 12-digit LCD panel having the display pattern shown in **Figure 17-17** is connected to the segment signals (SEG0 to SEG23) and the common signals (COM0 to COM3) of the 78K0/Dx2 chip. This example displays data "123456.789012" in the LCD panel. The contents of the display data memory (addresses F9D0H to F9E7H) correspond to this display.

The following description focuses on numeral "6." ( $\Xi$ .) displayed in the seventh digit. To display "6." in the LCD panel, it is necessary to apply the select or deselect voltage to the SEG12 and SEG13 pins according to **Table 17-7** at the timing of the common signals COM0 to COM3; see **Figure 17-17** for the relationship between the segment signals and LCD segments.

Segment	SEG12	SEG13
Common		
COM0	Select	Select
COM1	Deselect	Select
COM2	Select	Select
СОМЗ	Select	Select

Table 17-7. Select and Deselect Voltages (COM0 to COM3)

According to **Table 17-7**, it is determined that the display data memory location (F9DCH) that corresponds to SEG12 must contain 1101.

Figure 17-19 shows examples of LCD drive waveforms between the SEG12 signal and each common signal. When the select voltage is applied to SEG12 at the timing of COM0, an alternate rectangle waveform,  $+V_{LCD}/-V_{LCD}$ , is generated to turn on the corresponding LCD segment.





COM0

сом2 сом3

COM1

Remark n = 0 to 11





Figure 17-18. Example of Connecting Four-Time-Slice LCD Panel

Data memory address





Figure 17-19. Four-Time-Slice LCD Drive Waveform Examples (1/3 Bias Method)





# 17.8 Supplying LCD Drive Voltages VLC0, VLC1, and VLC2

With the 78K0/Dx2, a LCD drive power supply is generated using internal resistance division method.

The 78K0/Dx2 incorporates voltage divider resistors for generating LCD drive power supplies. Using internal voltage divider resistors, a LCD drive power supply that meet each bias method listed in **Table 17-8** can be generated, without using external voltage divider resistors.

Bias Method	No Bias	1/3 Bias Method
LCD Drive Voltage Pin	(Static)	
VLCO	VLCD	VLCD
VLC1	$\frac{2}{3}V_{LCD}$	$\frac{2}{3}$ VLCD
VLC2	$\frac{1}{3}V_{LCD}$	

Table 17-8. LCD Drive Voltages (with On-Chip Voltage Divider Resistors)

Figure 17-20 shows examples of generating LCD drive voltages internally according to Table 17-8.

Figure 17-20. Examples of LCD Drive Power Connections

- (a) 1/3 bias method and static display mode (MDSET1, MDSET0 = 0, 1) (example of  $V_{DD} = 5 V$ ,  $V_{LC0} = 5 V$ )
- (b) 1/3 bias method and static display mode (MDSET1, MDSET0 = 1, 1) (example of  $V_{DD} = 5 V$ ,  $V_{LC0} = 3 V$ )







# CHAPTER 18 SOUND GENERATOR

The Sound Generator generates an audio-frequency tone signal and a high-frequency pulse-width modulated (PWM) signal. The duty cycle of the PWM signal defines the volume.

By default, the two signal components are routed to separate pins. But both signals can also be combined to generate a composite signal that can be used to drive a loudspeaker circuit.

# 18.1 Overview

The Sound Generator consists of a programmable square wave tone generator and a programmable pulse-width modulator.

# Features

- Programmable tone frequency (250 Hz to 6 kHz with a minimum step size of 20 Hz)
- Programmable volume level (9 bit resolution)
- Wide range of PWM signal frequency (32 kHz to 64 kHz)
- Sound can be stopped or retriggered
- Composite or separated frequency/volume output for external circuitry variation
- Hardware-optimized update of frequency and volume to avoid audible artifacts

## 18.1.1 Description

The following figure provides a functional block diagram of the Sound Generator.



#### Figure 18-1. Sound Generator Block Diagram



The Sound Generator's input clock frequency fsgoclk is the 10 MHz clock which is divided the peripheral hardware clock oscillation frequency fprs in two.

#### **Tone generator**

The tone generator consists of two up-counters with compare registers. The values written to the frequency registers are automatically copied to compare buffers. The counters are reset to zero when their values match the contents of the associated compare buffers.

The 9-bit counter SG0FL generates a clock with a frequency between 32 kHz and 64 kHz. This clock constitutes the PWM frequency.

It is also the input of the second 6-bit counter SG0FH. The resulting tone signal behind the by-two-divider has a frequency between 250 Hz and 6 kHz and a 50 % duty cycle.

#### **PWM generator**

The PWM generator modulates the duty cycle according to the desired volume. It is controlled by the volume register SG0PWM. The value written to this register is automatically copied to the associated volume compare buffer.

The PWM generator continually compares the value of the counter SG0FL with the contents of its volume compare buffer.

The RS flipflop of the PWM generator is set by the pulses generated by the counter SG0FL. It is reset when the SG0FL counter value matches the contents of the volume buffer. Thus, the PWM output signal can have a duty cycle between 0 % (null volume) and 100 % (maximum volume).

The PWM frequency is above 32 kHz and hence outside the audible range.

#### Outputs

The Sound Generator is connected to the pins SGO and SGOA. By default, pin SGO provides the tone signal SG0OF and pin SGOA the PWM signal SG0OA that holds the volume ("amplitude") information.

If bit SG0CTL.OS is set, pin SGO provides the composite signal SG0O that can directly control a speaker circuit.



## 18.1.2 Principle of operation

The software-controlled registers SG0FL, SG0FH, and SG0PWM are equipped with hardware buffers. The Sound Generator operates on these buffers.

This approach eliminates audible artifacts, because the buffers are only updated in synchronization with the generated tone waveform.

Remark This section provides an overview. For details please refer to 18.3 Sound Generator Operation.

## (1) Generation of the tone frequency

The tone frequency is determined by two counters and their associated compare register values. Two counters are necessary to keep the tone pulse and the PWM signal synchronized.

The first counter (SG0FL) provides the input to the second (SG0FH) and also to the PWM generator. It is used to keep the PWM frequency outside the audio range (above 30 kHz) and within the signal bandwidth of the external sound system (usually below 64 kHz). Its match value defines also the 100 % volume level.

The second counter (SG0FH) generates the tone frequency (250 Hz to 6 kHz).

**Remark** If the target values of the counters SG0FL/SG0FH are changed to generate a different tone frequency, the volume register SG0PWM has to be adjusted to keep the same volume.

#### (2) Generation of the volume information

The volume information (the "amplitude" of the audible signal) is provided as a high-frequency PWM signal. In composite mode, the PWM signal is ANDed with the tone signal, as illustrated in the following figure.

#### Figure 18-2. Generation of the Composite Output Signal

Tone signal		
PWM signal, duty cycle 66 %		
Composite signal		
Analog 66% audio signal 0%	 \/	

After low-pass filtering, the analog signal amplitude corresponds to the duty cycle of the PWM signal. Low-pass filtering (averaging) is an inherent characteristic of a loudspeaker system.

The duty cycle can vary between 0 % and 100 %. Its generation is controlled by the counter register SG0FL and the volume register SG0PWM.

When the volume register SG0PWM is cleared, the sound stops immediately.



# **18.2 Sound Generator Registers**

The Sound Generator is controlled by means of the following registers:

Register name	Shortcut	Address
SG0 control register	SG0CTL	FFA5H
SG0 frequency low register	SG0FL	FFA8H
SG0 frequency high register	SG0FH	FFAAH
SG0 volume register	SG0PWM	FFA6H

#### Table 18-1. Sound Generator Registers Overview

#### (1) SG0 control register (SG0CTL)

The 8-bit SG0CTL register controls the operation of the Sound Generator. This register can be read/written in 8-bit or 1-bit units. This register is cleared by any reset.

#### Figure 18-3. Format of SG0 Control Register (SG0CTL)

Address: FF	A5H After	reset: 00H	R/W						
Symbol	7	6	5	4	3	2	1	0	
SG0CTL	0	0	0	PWR	0	0	OS	0	

PWR	Power save mode selection
0	Clock input switched off (the Sound Generator is disabled and does not operate).
1	Clock input switched on (the Sound Generator is enabled and ready to use).

OS	SG0 output mode selection
0	Selects SGOF and SGOA outputs (frequency and amplitude separated).
1	Selects SGO output (frequency and amplitude mixed).

## Cautions 1. Bit 0 must be set to 0.

2. Change the contents of this register only when the sound is stopped (register SG0PWM cleared).



#### (2) SG0 frequency low register (SG0FL)

The 16-bit SG0FL register is used to specify the target value for the PWM frequency. It holds the target value for the 9-bit counter SG0FL.

This register can be read/written in 16-bit units. It cannot be written if bit SG0CTL.PWR = 0. This register is cleared by any reset.

Address: FF	A8H	After	reset:	0000H	R/W	1										
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SG0FL	0	0	0	0	0	0	0	Counter SG0FL target value								

For the calculation of the resulting PWM frequency refer to 18.3.2 (2) PWM calculations.

The value written to SG0FL defines also the reference value for the maximum sound amplitude (100% PWM duty cycle). A 100 % duty cycle (continually high) will be generated if the SG0PWM value is higher than the SG0FL value. For details see **18.3.2 (2) PWM calculations**.

**Remarks 1.** The bits SG0FL[15:9] are not used.

- 2. The maximum value to be written is 510 (01FEH). This yields a PWM frequency of 19.7 kHz in case of the sound generator input clock SG0CLK 10 MHz. The minimum value to be written depends on the capability of the external circuit. A value of 255 (00FFH) would yield a PWM frequency of 39.1 kHz in case of the sound generator input clock SG0CLK 10 MHz.
- **3.** The value read from this register does not necessarily reflect the current PWM frequency, because this frequency is determined by the frequency compare buffer value. The buffer might not be updated yet.

For details see 18.3.1 (1) Updating the frequency buffer values.

#### (3) SG0 frequency high register (SG0FH)

The 16-bit SG0FH register is used to specify the final tone frequency. It holds the target value for the 6-bit counter SG0FH.

This register can be read/written in 16-bit units. It cannot be written if bit SG0CTL.PWR = 0. This register is cleared by any reset.

Address: FF	After	reset:	0000H	R/W	R/W								
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3

Symbol	15	14	13	12		10	. 9	8	. /	6	5	4	3	2	I	0
SG0FH	0	0	0	0	0	0	0	0	0	0	(	Counte	r SG0F	H targe	et value	)

For the calculation of the resulting tone frequency refer to 18.3.1 (2) Tone frequency calculation.

Remarks 1. The bits SG0FH[15:6] are not used.

- 2. Legal values depend on the contents of register SG0FL which defines the frequency of the input pulse. For example: If the counter SG0FL generates a frequency of 32.4 kHz, a value of 63 would generate a tone frequency of 253 Hz.
- **3.** The value read from this register does not necessarily reflect the current tone frequency, because this frequency is determined by the frequency compare buffer value. The buffer might not be updated yet.

For details see 18.3.1 (1) Updating the frequency buffer values.

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# (4) SG0 volume register (SG0PWM)

The 16-bit register SG0PWM is used to specify the sound volume. It holds the target value for the sound amplitude that is given by the duty cycle of the PWM signal.

This register can be read/written in 16-bit units. It cannot be written if bit SG0CTL.PWR = 0. This register is cleared by any reset.

Address: FF	A6H	After	reset:	0000H	R/W	/										
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SG0PWM	0	0	0	0	0	0	0	Sound volume target value								

The value written to this register must be considered in conjunction with the contents of register SG0FL. The register SG0FL specifies the maximum value of the counter SG0FL.

For the calculation of the resulting duty cycle refer to 18.3.2 (2) PWM calculations.

The setting takes effect after the SG0PWM buffer has been updated (see **18.3.2 (1) Updating the volume buffer value**).

Remarks 1. The bits SG0PWM[15:9] are not used.

- 2. The value read from this register does not necessarily reflect the current volume, because the value of counter SG0FL is compared with the contents of the volume buffer. The buffer might not be updated yet.
- **3.** The sound stops immediately when this register is cleared.


## 18.3 Sound Generator Operation

This section explains the details of the Sound Generator.

#### 18.3.1 Generating the tone

The tone signal is generated by the compare match signal of the SG0FH counter value with the value of the SG0FH buffer, followed by a by-two-divider. At each compare match, the counter is reset to zero.

Remember that the SG0FH counter is clocked by the output of the SG0FL counter.

## (1) Updating the frequency buffer values

The values of the frequency buffers can be changed by writing to the associated frequency registers SG0FL and SG0FH.

Changing the value of the SG0FL (equivalent to SG0F[15:0]) register would also yield a change of the PWM frequency, i.e. the sound volume. Therefore it is obligatory to write the correct PWM value to SG0PWM before a new SG0FL value is copied to the frequency buffers.

The following figure shows an example (not to scale).



## Figure 18-4. Update Timing of the Frequency Buffers

If SG0FL is set to 01AEH and a 193 Hz tone is generated, as in the above example, the time span between writing to the SG0PWM register and updating the buffer can be up to 5.17 ms.



## (2) Tone frequency calculation

```
The tone frequency can be calculated as:

f_{tone} = f_{SGOCLK} / (([SGOFL buffer] + 1) \times ([SGOFH buffer] + 1) \times 2)
where:

f_{SGOCLK} : Frequency of Sound Generator's input clock
f_{SGOCLK} = f_{PRS} / 2
[SGOFL buffer] : Contents of the SGOFL buffer
[SGOFH buffer] : Contents of the SGOFH buffer
```

## Example

- If:
- fprs = 20 MHz
- $f_{SGOCLK} = f_{PRS} / 2 = 10 \text{ MHz}$
- [SG0FL buffer] = 255 (00FFH) (this yields a PWM frequency of 39.01 kHz)
- [SG0FH buffer] = 32 (0020H)

```
then:
```

```
- ftone = 592 Hz
```

**Remark** Note that the buffer contents can differ from the contents of the associated register until the next compare match.

## 18.3.2 Generating the volume information

The sound volume information is generated by comparing the SG0FL counter value with the contents of the SG0PWM volume buffer. An RS flipflop is set when the counter matches the SG0FL buffer and reset when the counter reaches the value of the volume buffer SG0PWM.



#### Figure 18-5. PWM Signal Generation

The duty cycle of the PWM signal is determined by the difference between the contents of the SG0FL counter buffer and the contents of the SG0PWM volume buffer. The larger the difference, the smaller the duty cycle.

The PWM signal is continually high when the value of the volume buffer is higher than the value of the frequency compare buffer.

Remark To achieve 100 % duty cycle for all PWM frequencies, SGOFL must not be set to a value above 1FEH.

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The PWM signal is continually low when the value of the volume buffer is zero-the sound has stopped.

## (1) Updating the volume buffer value

The value of the volume compare buffer can be changed by writing to the volume register SG0PWM.

- If the register is cleared by writing 0000H, the register value is copied to the volume compare buffer with the next rising edge of SG0CLK.
- As a result, the sound stops at the latest after one period of SG0CLK.
- If a non-zero value is written to the register, the buffer is updated with the next falling or rising edge of the tone frequency (match between SG0FH counter value and SG0FH buffer value).

## (2) PWM calculations

#### **PWM frequency**

The PWM frequency is generated by the counter SG0FL. It can be calculated as:

```
fPWM = fsgoclk / (([SG0FL buffer] + 1)
```

where:

fsgoclk : Frequency of Sound Generator's input clock

fsgoclk = fprs / 2

[SG0FL buffer] : Contents of the SG0FL buffer

## Duty cycle

The duty cycle of the PWM signal is calculated as follows:

- If [SG0PWM buffer] > [SG0FL buffer]: Duty cycle = 100 %
- If  $0 \le [SG0PWM buffer] \le [SG0FL buffer]$ : Duty cycle = [SG0PWM buffer] / ([SG0FL buffer] + 1)

where:

[SG0PWM buffer] : Contents of SG0PWM buffer [SG0FL buffer] : Contents of SG0FL buffer

## Example

If [SG0FL] is set to 240 (00F0H), the following table applies:

[SG0PWM]	Calculation	Duty cycle [%]
01FFH		100
		100
00F1H	241 / 241	100
00F0H	240 / 241	99.6
00EFH	239 / 241	99.2
0001H	1 / 241	0.41
0000H	0 / 241	0

#### Table 18-2. Duty Cycle Calculation Example

The table shows, how the contents of register SG0FL affects the achievable volume resolution.



## **18.4 Sound Generator Application Hints**

This section provides supplementary programming information.

#### 18.4.1 Initialization

To enable the Sound Generator, set SG0CTL.PWR to 1. This connects the SG0 to the clock SG0CLK. Check bit SG0CTL.OS.

When SG0CTL.OS is 0, the signal at pin SGO is a symmetrical square waveform with the frequency ftone. When SG0CTL.OS is 1, the signal at pin SGO is composed of the tone signal and PWM pulses.

The frequency data registers SG0FL and SG0FH provide the buffer values for the counters. The combined value represents the frequency of the tone.

#### 18.4.2 Start and stop sound

The sound is started by writing a non-zero value to the volume register SG0PWM.

Before starting the sound, all other register settings must be made.

The sound is stopped by writing 0000H to the volume register SG0PWM. The sound is stopped regardless of the current value of amplitude output or frequency output. Thus, the sound can be stopped quickly, even if a very low sound frequency is chosen.

#### 18.4.3 Change sound volume

The sound volume is changed by writing a new value to register SG0PWM.

The new volume takes effect with the next edge of the tone pulse (rising or falling).

#### 18.4.4 Generate special sounds

To generate special sounds (like blinker clicks etc.), frequency and volume can be changed simultaneously.

To change the frequency of a sound that has already started:

1. Write to the frequency registers SG0FL and SG0FH separately in 16-bit mode.

2. Write to the volume register SG0PWM.



## **CHAPTER 19 INTERRUPT FUNCTIONS**

## **19.1 Interrupt Function Types**

The following two types of interrupt functions are used.

## (1) Maskable interrupts

These interrupts undergo mask control. Maskable interrupts can be divided into a high interrupt priority group and a low interrupt priority group by setting the priority specification flag registers (PR0L, PR0H, PR1L, PR1H).

Multiple interrupt servicing can be applied to low-priority interrupts when high-priority interrupts are generated. If two or more interrupt requests, each having the same priority, are simultaneously generated, then they are processed according to the priority of vectored interrupt servicing. For the priority order, see **Table 19-1**.

A standby release signal is generated and STOP and HALT modes are released.

8 external interrupt requests and 27 internal interrupt requests are provided as maskable interrupts.

## (2) Software interrupt

This is a vectored interrupt generated by executing the BRK instruction. It is acknowledged even when interrupts are disabled. The software interrupt does not undergo interrupt priority control.

## **19.2 Interrupt Sources and Configuration**

A total of 36 interrupt sources exist for maskable and software interrupts. In addition, they also have up to four reset sources (see **Table 19-1**).



Interrunt	Default		Interrupt Source	Internal/	Vector	Basic
Туре	Priority <sup>Note 1</sup>	Namo		External	Table	Configuration
		Name	l rigger		Address	Type <sup>Note 2</sup>
Maskable	0	INTLVI	Low-voltage detection <sup>Note 3</sup>	Internal	0004H	(A)
	1	INTP0	Pin input edge detection	External	0006H	(B)
	2	INTP1	Pin input edge detection	External	0008H	(B)
	 	INTIICO	End of IIC0 communication	Internal		(A)
1	3	INTP3	Pin input edge detection	External	000AH	(B)
		INTP4	Pin input edge detection	1		
	4	INTTP0CC0	Match between TMP0 and CCR0 (when compare register is specified), TIOP00 pin valid edge detection (when capture register is specified)	Internal	000CH	(A)
	5	INTTP0CC1	Match between TMP0 and CCR1 (when compare register is specified), TIOP01 pin valid edge detection (when capture register is specified)		000EH	
	6	INTTP1CC0	Match between TMP1 and CCR0 (when compare register is specified), TIOP10 pin valid edge detection (when capture register is specified)		0010H	
	7	INTTP1CC1	Match between TMP1 and CCR1 (when compare register is specified), TIOP11 pin valid edge detection (when capture register is specified)		0012H	
	8	INTC0ERR	AFCAN0 error occurrence <sup>Note 4</sup>	1	0014H	
		INTC0WUP	AFCAN0 wakeup <sup>Note 4</sup>	1		
	9	INTCOREC	AFCAN0 reception completion <sup>Note 4</sup>	1	0016H	
	10	INTC0TRX	AFCAN0 transmission completion <sup>Note 4</sup>	1	0018H	
	11	INTPR60	UART60 pin input edge detection	1	001AH	
	12	INTSR60	End of UART60 reception/ UART60 reception error		001CH	
	13	INTST60	End of UART60 transmission	1	001EH	
	14	INTP2	Pin input edge detection	External	0020H	(B)
	INTCSI10 End of CSI10 transmission					(A)

## Table 19-1. Interrupt Source List (1/3)

**Notes 1.** The default priority is the priority applicable when two or more maskable interrupt are generated simultaneously. 0 is the highest priority, and 28 is the lowest.

- 2. Basic configuration types (A) to (C) correspond to (A) to (C) in Figure 19-1.
- 3. When bit 1 (LVIMD) of the low-voltage detection register (LVIM) is set to 0.
- 4. Products with CAN only.

Table 19-1.	Interrupt Source	List (2/3)
-------------	------------------	------------

Interrupt	Default		Interrupt Source			Basic
lype	Priority	Name	Trigger	External	l able Address	Configuration Type <sup>Note 2</sup>
Maskable	15	INTPR61	UART61 pin input edge detection <sup>Note 3</sup>	Internal	0022H	(A)
	16	INTSR61	End of UART61 reception/ UART61 reception error <sup>Note 3</sup>		0024H	
	17	INTST61	End of UART61 transmission <sup>Note 3</sup>		0026H	
	18	INTCSI11	End of CSI11 communication		0028H	
	19	INTTM50	Match between TM50 and CR50 (when compare register is specified)		002AH	
		INTTP2OV	TMP2 overflow			
	20	INTTP2CC0	Match between TMP2 and CCR0 (when compare register is specified), TIOP20 pin valid edge detection (when capture register is specified)		002CH	
	21	INTTP2CC1	Match between TMP2 and CCR1 (when compare register is specified), TIOP21 pin valid edge detection (when capture register is specified)		002EH	
	22	INTAD	End of A/D conversion		0030H	
	23	ΙΝΤΨΤΙ	Watch timer reference time interval signal		0032H	
		INTWT	Watch timer overflow			
	24	INTTM51	Match between TM51 and CR51 (when compare register is specified)		0034H	
		INTTP3OV	TMP3 overflow			
	25	INTTP3CC0	Match between TMP3 and CCR0 (when compare register is specified), TIOP30 pin valid edge detection (when capture register is specified)		0036H	
	26	INTTP3CC1	Match between TMP3 and CCR1 (when compare register is specified), TIOP31 pin valid edge detection (when capture register is specified)		0038H	
	27	INTTP4CC0	Match between TMP4 and CCR0 (when compare register is specified), TIOP40 pin valid edge detection (when capture register is specified)		003AH	
	28	INTTP4CC1	Match between TMP4 and CCR1 (when compare register is specified), TIOP41 pin valid edge detection (when capture register is specified)		003CH	

**Notes 1.** The default priority is the priority applicable when two or more maskable interrupt are generated simultaneously. 0 is the highest priority, and 28 is the lowest.

- 2. Basic configuration types (A) to (C) correspond to (A) to (C) in Figure 19-1.
- 3. 78K0/DF2 only.

Interrupt	Default	It Interrupt Source		Internal/	Vector	Basic
Туре	Priority	Name	Trigger	External	Address	Configuration Type <sup>Note 2</sup>
Software	-	BRK	BRK instruction execution	-	003EH	(C)
Non- maskable	_	INTCK2	Address break generation before OCD execution	-	0002H	-
Reset	-	RESET	Reset input	-	0000H	-
		POC	Power-on clear			
		LVI	Low-voltage detection <sup>Note 3</sup>			
		WDT	WDT overflow			

 Table 19-1. Interrupt Source List (3/3)

- **Notes 1.** The default priority is the priority applicable when two or more maskable interrupt are generated simultaneously. 0 is the highest priority, and 28 is the lowest.
  - 2. Basic configuration types (A) to (C) correspond to (A) to (C) in Figure 19-1.
  - 3. When bit 1 (LVIMD) of the low-voltage detection register (LVIM) is set to 1.



## Figure 19-1. Basic Configuration of Interrupt Function

## (A) Internal maskable interrupt



#### (B) External maskable interrupt (INTP0 to INTP7)



#### (C) Software interrupt





## **19.3 Registers Controlling Interrupt Functions**

The following 6 types of registers are used to control the interrupt functions.

- Interrupt request flag register (IF0L, IF0H, IF1L, IF1H)
- Interrupt mask flag register (MK0L, MK0H, MK1L, MK1H)
- Priority specification flag register (PR0L, PR0H, PR1L, PR1H)
- External interrupt rising edge enable register (EGP)
- External interrupt falling edge enable register (EGN)
- Program status word (PSW)

**Table 19-2** shows a list of interrupt request flags, interrupt mask flags, and priority specification flags corresponding to interrupt request sources.



Interrupt	Interr	upt Reques	t Flag	Int	errupt Mask F	-lag	Priority Specification		n Flag
Request			Register			Register			Register
INTLVI	LVIIF		IF0L	LVIMK		MKOL	LVIPR		PROL
INTP0	PIF0			PMK0			PPR0		
INTP1	PIF1	DUALIF0		PMK1	DUALMK0		PPR1	DUALPR0	
INTIIC0	IICIF0	Note 1		IICMK0	Note 2		IICPR0	Note 2	
INTP3	PIF3	DUALIF1		РМК3	DUALMK1		PPR3	DUALPR1	
INTP4	PIF4	Note 1		PMK4	Note 2		PPR4	Note 2	
INTTP0CC0	TP0CC0IF			TPOCCOM	K		TP0CC0PF	ł	
INTTP0CC1	TP0CC1IF			TP0CC1M	K		TP0CC1PF	ł	
INTTP1CC0	TP1CC0IF			TP1CC0M	K		TP1CC0PF	ł	
INTTP1CC1	TP1CC1IF			TP1CC1M	K		TP1CC1PF	ł	
INTC0ERR	<b>COERRIF</b>	DUALIF2	IF0H	C0ERRMK	DUALMK2	МКОН	C0ERRPR	DUALPR2	PR0H
<b>INTCOWUP</b>	COWUPIF	Note 1		C0WUPMK	Note 2		<b>COWUPPR</b>	Note 2	
INTCOREC	CORECIF			CORECMK			CORECPR		
INTC0TRX	COTRXIF			COTRXMK			C0TRXPR		
INTPR60	PIF60			PMK60			PPR60		
INTSR60	SRIF60			SRMK60			SRPR60		
INTST60	STIF60			STMK60			STPR60		
INTP2	PIF2	DUALIF3		PMK2	DUALMK3		PPR2	DUALPR3	
INTCSI10	CSIIF10	Note 1		CSIMK10	Note 2	-	CSIPR10	Note 2	
INTPR61	PIF61			PMK61			PPR61		
INTSR61	SRIF61		IF1L	SRMK61		MK1L	SRPR61		PR1L
INTST61	STIF61			STMK61		-	STPR61		
INTCSI11	CSIIF11			CSIMK11			CSIPR11		
INTTM50	TMIF50	DUALIF4		TMMK50	DUALMK4		TMPR50	DUALPR4	
INTTP2OV	TP2OVIF	Note 1		TP2OVMK	Note 2	-	TP2OVPR	Note 2	
INTTP2CC0	TP2CC0IF			TP2CC0M	K		TP2CC0PF	1	
INTTP2CC1	TP2CC1IF			TP2CC1M	K	-	TP2CC1PF	1	
INTAD	ADIF			ADMK		-	ADPR		
INTWT	WTIF	DUALIF5		WTMK	DUALMK5		WTPR	DUALPR5	
INTWTI	WTIIF	Note I		WTIMK	Note 2		WTIPR	NOTE 2	
INTTM51	TMIF51	DUALIF6	IF1H	TMMK51	DUALMK6	MK1H	TMPR51	DUALPR6	PR1H
INTTP3OV	<b>TP3OVIF</b>	Note 1		<b>TP3OVMK</b>	Note 2	-	TP3OVPR	NOTE 2	
INTTP3CC0	TP3CC0IF			TP3CC0MK		-	TP3CC0PR		
INTTP3CC1	TP3CC1IF			TP3CC1M	K		TP3CC1PF	1	
INTTP4CC0	TP4CC0IF			TP4CC0M	K		TP4CC0PF	ł	
INTTP4CC1	TP4CC1IF			TP4CC1M	K		TP4CC1PR		

## Table 19-2. Flags Corresponding to Interrupt Request Sources

**Notes 1.** If either of the two types of interrupt sources is generated, these flags are set (1).

2. Both types of interrupt sources are supported.



#### (1) Interrupt request flag registers (IF0L, IF0H, IF1L, IF1H)

The interrupt request flags are set to 1 when the corresponding interrupt request is generated or an instruction is executed. They are cleared to 0 when an instruction is executed upon acknowledgment of an interrupt request or upon reset signal generation.

When an interrupt is acknowledged, the interrupt request flag is automatically cleared and then the interrupt routine is entered.

IF0L, IF0H, IF1L, and IF1H are set by a 1-bit or 8-bit memory manipulation instruction. When IF0L and IF0H, and IF1L and IF1H are combined to form 16-bit registers IF0 and IF1, they are read with a 16-bit memory manipulation instruction.

Reset signal generation clears these registers to 00H.

#### Figure 19-2. Format of Interrupt Request Flag Registers (IF0L, IF0H, IF1L, IF1H)

Address: FFI	EUH Allerres	et oon R/W								
Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>		
IFOL	TP1CC1IF	TP1CC0IF	TP0CC1IF	TP0CC0IF	DUALIF1 PIF3 PIF4	DUALIF0 PIF1 IICIF0	PIF0	LVIIF		
Address: FFI	E1H After r	eset: 00H I	R/W							
Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>		
IF0H	PIF61	DUALIF3 PIF2 CSIIF10	STIF60	SRIF60	PIF60	COTRXIF	CORECIF	DUALIF2 C0ERRIF C0WUPIF		
Address: FFI	Address: FFE2H After reset: 00H R/W									
Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>		
IF1L	DUALIF5 WTIF WTIIF	ADIF	TP2CC1IF	TP2CC0IF	DUALIF4 TMIF50 TP2OVIF	CSIIF11	STIF61	SRIF61		
Address: FFI	E3H After r	eset: 00H I	R/W							
Symbol	7	6	5	<4>	<3>	<2>	<1>	<0>		
IF1H	0	0	0	TP4CC1IF	TP4CC0IF	TP3CC1IF	TP3CC0IF	DUALIF6 TMIF51 TP3OVIF		
	XXIFX			Inte	rrupt request	flag				
	0	No interrupt	request signa	I is generated						
	1	Interrupt req	nterrupt request is generated, interrupt request status							

Address: FFE0H After reset: 00H R/W

Cautions 1. Be sure to set bits 5 to 7 of IF1H to 0.

2. When operating a timer, serial interface, or A/D converter after standby release, operate it once after clearing the interrupt request flag. An interrupt request flag may be set by noise.

RENESAS

Cautions 3. When manipulating a flag of the interrupt request flag register, use a 1-bit memory manipulation instruction (CLR1). When describing in C language, use a bit manipulation instruction such as "IF0L.0 = 0;" or "\_asm("clr1 IF0L, 0");" because the compiled assembler must be a 1-bit memory manipulation instruction (CLR1).

If a program is described in C language using an 8-bit memory manipulation instruction such as "IF0L &= 0xfe;" and compiled, it becomes the assembler of three instructions.

mov a, IF0L and a, #0FEH mov IF0L, a

In this case, even if the request flag of another bit of the same interrupt request flag register (IF0L) is set to 1 at the timing between "mov a, IF0L" and "mov IF0L, a", the flag is cleared to 0 at "mov IF0L, a". Therefore, care must be exercised when using an 8-bit memory manipulation instruction in C language.



## (2) Interrupt mask flag registers (MK0L, MK0H, MK1L, MK1H)

The interrupt mask flags are used to enable/disable the corresponding maskable interrupt servicing.

MK0L, MK0H, MK1L, and MK1H are set by a 1-bit or 8-bit memory manipulation instruction. When MK0L and MK0H, and MK1L and MK1H are combined to form 16-bit registers MK0 and MK1, they are set with a 16-bit memory manipulation instruction.

Reset signal generation sets these registers to FFH.

## Figure 19-3. Format of Interrupt Mask Flag Registers (MK0L, MK0H, MK1L, MK1H)

Address: FFE	E4H After re	əset: FFH	R/W						
Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>	
MKOL	TP1CC1MK	TP1CC0MK	TP0CC1MK	TP0CC0MK	DUALMK1 PMK3 PMK4	DUALMK0 PMK1 IICMK0	РМКО	LVIMK	
Address: FF	E5H After re	eset: FFH	R/W						
Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>	
МКОН	PMK61	DUALMK3 PMK2 CSIMK10	STMK60	SRMK60	PMK60	COTRXMK	CORECMK	DUALMK2 COERRMK COWUPMK	
Address: FFE6H After reset: FFH R/W									
MK1L	DUALMK5 WTMK WTIMK	ADMK	TP2CC1MK	TP2CC0MK	DUALMK4 TMMK50 TP2OVMK	CSIMK11	STMK61	SRMK61	
Address: FFE Symbol	E7H After re	eset: FFH F	R/W 5	<4>	<3>	<2>	<1>	<0>	
MK1H	1	1	1	TP4CC1MK	TP4CC0MK	TP3CC1MK	TP3CC0MK	DUALMK6 TMMK51 TP3OVMK	
	ХХМКХ			Interru	upt servicing c	ontrol			
	0	Interrupt ser	vicing enabled	d					
	1	Interrupt serv	nterrupt servicing disabled						

Caution Be sure to set bits 5 to 7 of MK1H to 1.



## (3) Priority specification flag registers (PR0L, PR0H, PR1L, PR1H)

The priority specification flag registers are used to set the corresponding maskable interrupt priority order. PR0L, PR0H, PR1L, and PR1H are set by a 1-bit or 8-bit memory manipulation instruction. If PR0L and PR0H, and PR1L and PR1H are combined to form 16-bit registers PR0 and PR1, they are set with a 16-bit memory manipulation instruction.

Reset signal generation sets these registers to FFH.

## Figure 19-4. Format of Priority Specification Flag Registers (PR0L, PR0H, PR1L, PR1H)

Address: FFE	E8H After re	eset: FFH I	R/W						
Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>	
PROL	TP1CC1PR	TP1CC0PR	TP0CC1PR	TP0CC0PR	DUALPR1 PPR3 PPR4	DUALPR0 PPR1 IICPR0	PPR0	LVIPR	
Address: FFI	E9H After re	eset: FFH I	R/W						
Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>	
PR0H	PPR61	DUALPR3 PPR2 CSIPR10	STPR60	SRPR60	PPR60	COTRXPR	CORECPR	DUALPR2 COERRPR COWUPPR	
Address: FFE	Address: FFEAH After reset: FFH R/W								
Symbol		<0>	<0>	<4>	<3>	<2>	<1>	<0>	
PR1L	DUALPR5 WTPR WTIPR	ADPR	TP2CC1PR	TP2CC0PR	DUALPR4 TMPR50 TP2OVPR	CSIPR11	STPR61	SRPR61	
Address: FFI	EBH After r	eset: FFH	R/W		0	0		0	
Symbol	/	6	5	<4>	<3>	<2>	<1>	<0>	
PR1H	1	1	1	TP4CC1PR	TP4CC0PR	TP3CC1PR	TP3CC0PR	DUALPR6 TMPR51 TP3OVPR	
	XXPRX			Prio	rity level seled	ction			
	0	High priority	level						
	1	Low priority	evel						

Caution Be sure to set bit 5 to 7 of PR1H to 1.



(4) External interrupt rising edge enable register (EGP), external interrupt falling edge enable register (EGN)
 These registers specify the valid edge for INTP0 to INTP4, INTP6, INTP7.

 EGP and EGN are set by a 1-bit or 8-bit memory manipulation instruction.
 Reset signal generation clears these registers to 00H.

## Figure 19-5. Format of External Interrupt Rising Edge Enable Register (EGP) and External Interrupt Falling Edge Enable Register (EGN)

Address:	FF48H	After re	eset: 00H	R/W					
Symbol		7	6	5	4	3	2	1	0
EGP	E	GP7	EPG6	0	EGP4	EGP3	EGP2	EGP1	EGP0
Adduces		<b>A f h a u u u</b>							
Address:	FF49H	After re	eset: 00H	R/VV					
Symbol		7	6	5	4	3	2	1	0

EGN EGN7 EGN6 0 EGN4 EGN3 EGN2 EGN1 EGN0

EGPn	EGNn	INTPn pin valid edge selection $(n = 0 \text{ to } 7)$
0	0	Edge detection disabled
0	1	Falling edge
1	0	Rising edge
1	1	Both rising and falling edges

#### Caution Be sure to set bit 5 of EGP and bit 5 of EGN to 0.

Table 19-3 shows the ports corresponding to EGPn and EGNn.

Detection Enable Register		Edge Detection Port	External Request Signal
EGP0	EGN0	P17	INTP0
EGP1	EGN1	P60	INTP1
EGP2	EGN2	P12	INTP2
EGP3	EGN3	P61	INTP3
EGP4	EGN4	P10	INTP4
EGP6	EGN6	P14 (ISC7 = 0) P70 (ISC7 = 1)	INTPR60
EGP7 <sup>Note</sup>	EGN7 <sup>Note</sup>	P11 <sup>Note</sup>	INTPR61 <sup>Note</sup>

Table 19-3.	Ports	Corresponding	to	EGPn	and	EGNn
-------------	-------	---------------	----	------	-----	------

Note 78K0/DF2 only.

Caution Select the port mode by clearing EGPn and EGNn to 0 because an edge may be detected when the external interrupt function is switched to the port function.

**Remark** n = 0 to 4, 6, 7



## (5) Program status word (PSW)

The program status word is a register used to hold the instruction execution result and the current status for an interrupt request. The IE flag that sets maskable interrupt enable/disable and the ISP flag that controls multiple interrupt servicing are mapped to the PSW.

Besides 8-bit read/write, this register can carry out operations using bit manipulation instructions and dedicated instructions (EI and DI). When a vectored interrupt request is acknowledged, if the BRK instruction is executed, the contents of the PSW are automatically saved into a stack and the IE flag is reset to 0. If a maskable interrupt request is acknowledged, the contents of the priority specification flag of the acknowledged interrupt are transferred to the ISP flag. The PSW contents are also saved into the stack with the PUSH PSW instruction. They are restored from the stack with the RETI, RETB, and POP PSW instructions.

Reset signal generation sets PSW to 02H.



#### Figure 19-6. Format of Program Status Word



## **19.4 Interrupt Servicing Operations**

#### 19.4.1 Maskable interrupt acknowledgement

A maskable interrupt becomes acknowledgeable when the interrupt request flag is set to 1 and the mask (MK) flag corresponding to that interrupt request is cleared to 0. A vectored interrupt request is acknowledged if interrupts are in the interrupt enabled state (when the IE flag is set to 1). However, a low-priority interrupt request is not acknowledged during servicing of a higher priority interrupt request (when the ISP flag is reset to 0). The times from generation of a maskable interrupt request until interrupt servicing is performed are listed in **Table 19-4** below.

For the interrupt request acknowledgement timing, see Figures 19-8 and 19-9.

	Minimum Time	Maximum Time <sup>™ote</sup>		
When ××PR = 0	7 clocks	32 clocks		
When $\times$ PR = 1	8 clocks	33 clocks		

	Гable 19-4.	Time from	Generation	of Maskable	Interrupt (	until Servicin	g
--	-------------	-----------	------------	-------------	-------------	----------------	---

Note If an interrupt request is generated just before a divide instruction, the wait time becomes longer.

Remark 1 clock: 1/fcpu (fcpu: CPU clock)

If two or more maskable interrupt requests are generated simultaneously, the request with a higher priority level specified in the priority specification flag is acknowledged first. If two or more interrupts requests have the same priority level, the request with the highest default priority is acknowledged first.

An interrupt request that is held pending is acknowledged when it becomes acknowledgeable.

Figure 19-7 shows the interrupt request acknowledgement algorithm.

If a maskable interrupt request is acknowledged, the contents are saved into the stacks in the order of PSW, then PC, the IE flag is reset (0), and the contents of the priority specification flag corresponding to the acknowledged interrupt are transferred to the ISP flag. The vector table data determined for each interrupt request is the loaded into the PC and branched.

Restoring from an interrupt is possible by using the RETI instruction.





Figure 19-7. Interrupt Request Acknowledgement Processing Algorithm

- $\times \times IF$ : Interrupt request flag
- ××MK: Interrupt mask flag
- ××PR: Priority specification flag
- IE: Flag that controls acknowledgement of maskable interrupt request (1 = Enable, 0 = Disable)
- ISP: Flag that indicates the priority level of the interrupt currently being serviced (0 = high-priority interrupt servicing, 1 = No interrupt request acknowledged, or low-priority interrupt servicing)







Remark 1 clock: 1/fcpu (fcpu: CPU clock)

#### Figure 19-9. Interrupt Request Acknowledgement Timing (Maximum Time)



Remark 1 clock: 1/fcpu (fcpu: CPU clock)

## 19.4.2 Software interrupt request acknowledgement

A software interrupt acknowledge is acknowledged by BRK instruction execution. Software interrupts cannot be disabled.

If a software interrupt request is acknowledged, the contents are saved into the stacks in the order of the program status word (PSW), then program counter (PC), the IE flag is reset (0), and the contents of the vector table (003EH, 003FH) are loaded into the PC and branched.

Restoring from a software interrupt is possible by using the RETB instruction.

#### Caution Do not use the RETI instruction for restoring from the software interrupt.



#### 19.4.3 Multiple interrupt servicing

Multiple interrupt servicing occurs when another interrupt request is acknowledged during execution of an interrupt. Multiple interrupt servicing does not occur unless the interrupt request acknowledgement enabled state is selected (IE = 1). When an interrupt request is acknowledged, interrupt request acknowledgement becomes disabled (IE = 0). Therefore, to enable multiple interrupt servicing, it is necessary to set (1) the IE flag with the EI instruction during interrupt servicing to enable interrupt acknowledgement.

Moreover, even if interrupts are enabled, multiple interrupt servicing may not be enabled, this being subject to interrupt priority control. Two types of priority control are available: default priority control and programmable priority control. Programmable priority control is used for multiple interrupt servicing.

In the interrupt enabled state, if an interrupt request with a priority equal to or higher than that of the interrupt currently being serviced is generated, it is acknowledged for multiple interrupt servicing. If an interrupt with a priority lower than that of the interrupt currently being serviced is generated during interrupt servicing, it is not acknowledged for multiple interrupt servicing. Interrupt requests that are not enabled because interrupts are in the interrupt disabled state or because they have a lower priority are held pending. When servicing of the current interrupt ends, the pending interrupt request is acknowledged following execution of at least one main processing instruction execution.

 Table 19-5 shows relationship between interrupt requests enabled for multiple interrupt servicing and Figure 19-10 shows multiple interrupt servicing examples.

# Table 19-5. Relationship Between Interrupt Requests Enabled for Multiple Interrupt Servicing During Interrupt Servicing

Multiple Interru	pt Request		Maskable Interrupt Request					
	PR = 0		PR = 1		Interrupt			
Interrupt Being Serviced	IE = 1	IE = 0	IE = 1	IE = 0	Request			
Maskable interrupt	ISP = 0	0	×	×	×	0		
	ISP = 1	0	×	0	×	0		
Software interrupt		0	×	0	×	0		

**Remarks 1.** O: Multiple interrupt servicing enabled

- 2. x: Multiple interrupt servicing disabled
- 3. ISP and IE are flags contained in the PSW.
  - ISP = 0: An interrupt with higher priority is being serviced.
  - ISP = 1: No interrupt request has been acknowledged, or an interrupt with a lower priority is being serviced.
  - IE = 0: Interrupt request acknowledgement is disabled.
  - IE = 1: Interrupt request acknowledgement is enabled.
- 4. PR is a flag contained in PR0L, PR0H, PR1L, and PR1H.
  - PR = 0: Higher priority level
  - PR = 1: Lower priority level



## Figure 19-10. Examples of Multiple Interrupt Servicing (1/2)

#### Example 1. Multiple interrupt servicing occurs twice



During servicing of interrupt INTxx, two interrupt requests, INTyy and INTzz, are acknowledged, and multiple interrupt servicing takes place. Before each interrupt request is acknowledged, the El instruction must always be issued to enable interrupt request acknowledgment.





Interrupt request INTyy issued during servicing of interrupt INTxx is not acknowledged because its priority is lower than that of INTxx, and multiple interrupt servicing does not take place. The INTyy interrupt request is held pending, and is acknowledged following execution of one main processing instruction.

- PR = 0: Higher priority level
- PR = 1: Lower priority level
- IE = 0: Interrupt request acknowledgment disabled



## Figure 19-10. Examples of Multiple Interrupt Servicing (2/2)

## Example 3. Multiple interrupt servicing does not occur because interrupts are not enabled



Interrupts are not enabled during servicing of interrupt INTxx (EI instruction is not issued), therefore, interrupt request INTyy is not acknowledged and multiple interrupt servicing does not take place. The INTyy interrupt request is held pending, and is acknowledged following execution of one main processing instruction.

- PR = 0: Higher priority level
- IE = 0: Interrupt request acknowledgement disabled



## 19.4.4 Interrupt request hold

There are instructions where, even if an interrupt request is issued for them while another instruction is being executed, request acknowledgement is held pending until the end of execution of the next instruction. These instructions (interrupt request hold instructions) are listed below.

- MOV PSW, #byte
- MOV A, PSW
- MOV PSW, A
- MOV1 PSW. bit, CY
- MOV1 CY, PSW. bit
- AND1 CY, PSW. bit
- OR1 CY, PSW. bit
- XOR1 CY, PSW. bit
- SET1 PSW. bit
- CLR1 PSW. bit
- RETB
- RETI
- PUSH PSW
- POP PSW
- BT PSW. bit, \$addr16
- BF PSW. bit, \$addr16
- BTCLR PSW. bit, \$addr16
- El
- DI
- Manipulation instructions for the IF0L, IF0H, IF1L, IF1H, MK0L, MK0H, MK1L, MK1H, PR0L, PR0H, PR1L, and PR1H registers.
  - Caution The BRK instruction is not one of the above-listed interrupt request hold instructions. However, the software interrupt activated by executing the BRK instruction causes the IE flag to be cleared. Therefore, even if a maskable interrupt request is generated during execution of the BRK instruction, the interrupt request is not acknowledged.

Figure 19-11 shows the timing at which interrupt requests are held pending.

#### Figure 19-11. Interrupt Request Hold

CPU processing	Instruction N	Instruction M	PSW and PC saved, jump to interrupt servicing	Interrupt servicing program
××IF				

Remarks 1. Instruction N: Interrupt request hold instruction

- 2. Instruction M: Instruction other than interrupt request hold instruction
- 3. The xxPR (priority level) values do not affect the operation of xxIF (instruction request).



## **CHAPTER 20 STANDBY FUNCTION**

## 20.1 Standby Function and Configuration

#### 20.1.1 Standby function

The standby function is designed to reduce the operating current of the system. The following two modes are available.

## (1) HALT mode

HALT instruction execution sets the HALT mode. In the HALT mode, the CPU operation clock is stopped. If the high-speed system clock oscillator, internal high-speed oscillator, internal low-speed oscillator, or subsystem clock oscillator is operating before the HALT mode is set, oscillation of each clock continues. In this mode, the operating current is not decreased as much as in the STOP mode, but the HALT mode is effective for restarting operation immediately upon interrupt request generation and carrying out intermittent operations.

#### (2) STOP mode

STOP instruction execution sets the STOP mode. In the STOP mode, the high-speed system clock oscillator and internal high-speed oscillator stop, stopping the whole system, thereby considerably reducing the CPU operating current.

Because this mode can be cleared by an interrupt request, it enables intermittent operations to be carried out. However, because a wait time is required to secure the oscillation stabilization time after the STOP mode is released, select the HALT mode if it is necessary to start processing immediately upon interrupt request generation.

In either of these two modes, all the contents of registers, flags and data memory just before the standby mode is set are held. The I/O port output latches and output buffer statuses are also held.

- Cautions 1. The STOP mode can be used only when the CPU is operating on the main system clock. The subsystem clock oscillation cannot be stopped. The HALT mode can be used when the CPU is operating on either the main system clock or the subsystem clock.
  - 2. When shifting to the STOP mode, be sure to stop the peripheral hardware operation operating with main system clock before executing STOP instruction.
  - 3. The following sequence is recommended for operating current reduction of the A/D converter when the standby function is used: First clear bit 7 (ADCS) and bit 0 (ADCE) of the A/D converter mode register (ADM) to 0 to stop the A/D conversion operation, and then execute the STOP instruction.

#### 20.1.2 Registers controlling standby function

The standby function is controlled by the following two registers.

- Oscillation stabilization time counter status register (OSTC)
- Oscillation stabilization time select register (OSTS)

**Remark** For the registers that start, stop, or select the clock, see **CHAPTER 5 CLOCK GENERATOR**.



#### (1) Oscillation stabilization time counter status register (OSTC)

This is the register that indicates the count status of the X1 clock oscillation stabilization time counter. When X1 clock oscillation starts with the internal high-speed oscillation clock or subsystem clock used as the CPU clock, the X1 clock oscillation stabilization time can be checked.

OSTC can be read by a 1-bit or 8-bit memory manipulation instruction.

When reset is released (reset by RESET input, POC, LVI and WDT), the STOP instruction and MSTOP (bit 7 of MOC register) = 1 clear OSTC to 00H.

#### Figure 20-1. Format of Oscillation Stabilization Time Counter Status Register (OSTC)

Address: FFA3H After reset: 00H R

S

Symbol	7	6	5	4	3	2	1	0
OSTC	0	0	0	MOST11	MOST13	MOST14	MOST15	MOST16

MOST	MOST	MOST	MOST	MOST	Oscillation stabilization time status				
11	13	14	15	16		fx = 2 MHz	fx = 5 MHz	fx = 10 MHz	fx = 20 MHz
0	0	0	0	0	Less than 2 <sup>11</sup> /fx	Less than 1.02 ms	Less than 409.6 <i>μ</i> s	Less than 204.8 <i>µ</i> s	Less than 102.4 <i>µ</i> s
1	0	0	0	0	2 <sup>11</sup> /fx min.	1.02 ms min.	409.6 <i>µ</i> s min.	204.8 <i>µ</i> s min.	102.4 <i>μ</i> s min.
1	1	0	0	0	2 <sup>13</sup> /fx min.	4.10 ms min.	1.64 ms min.	819.2 <i>µ</i> s min.	409.6 <i>µ</i> s min.
1	1	1	0	0	2 <sup>14</sup> /fx min.	8.19 ms min.	3.27 ms min.	1.64 ms min.	819.2 <i>µ</i> s min.
1	1	1	1	0	215/fx min.	16.38 ms min.	6.55 ms min.	3.27 ms min.	1.64 ms min.
1	1	1	1	1	2 <sup>16</sup> /fx min.	32.77 ms min.	13.11 ms min.	6.55 ms min.	3.27 ms min.

- Cautions 1. After the above time has elapsed, the bits are set to 1 in order from MOST11 and remain 1.
  - 2. The oscillation stabilization time counter counts up to the oscillation stabilization time set by OSTS. If the STOP mode is entered and then released while the internal high-speed oscillation clock is being used as the CPU clock, set the oscillation stabilization time as follows.
    - Desired OSTC oscillation stabilization time < Oscillation stabilization time set by OSTS

Note, therefore, that only the status up to the oscillation stabilization time set by OSTS is set to OSTC after STOP mode is released.

3. The X1 clock oscillation stabilization time does not include the time until clock oscillation starts ("a" below).



Remark fx: X1 clock oscillation frequency



#### (2) Oscillation stabilization time select register (OSTS)

This register is used to select the X1 clock oscillation stabilization time when the STOP mode is released. When the X1 clock is selected as the CPU clock, the operation waits for the time set using OSTS after the STOP mode is released.

When the internal high-speed oscillation clock is selected as the CPU clock, confirm with OSTC that the desired oscillation stabilization time has elapsed after the STOP mode is released. The oscillation stabilization time can be checked up to the time set using OSTC.

OSTS can be set by an 8-bit memory manipulation instruction.

Reset signal generation sets OSTS to 05H.

#### Figure 20-2. Format of Oscillation Stabilization Time Select Register (OSTS)

Address: FFA4H After reset: 05H R/W

Symbol	7	6	5	4	3	2	1	0
OSTS	0	0	0	0	0	OSTS2	OSTS1	OSTS0

OSTS2	OSTS1	OSTS0		Oscillation stabilization time selection				
				fx = 2 MHz	fx = 5 MHz	fx = 10 MHz	fx = 20 MHz	
0	0	1	2 <sup>11</sup> /fx	1.02 ms	409.6 <i>µ</i> s	204.8 <i>µ</i> s	102.4 <i>μ</i> s	
0	1	0	2 <sup>13</sup> /fx	4.10 ms	1.64 ms	819.2 <i>μ</i> s	409.6 <i>μ</i> s	
0	1	1	2 <sup>14</sup> /fx	8.19 ms	3.27 ms	1.64 ms	819.2 <i>μ</i> s	
1	0	0	2 <sup>15</sup> /fx	16.38 ms	6.55 ms	3.27 ms	1.64 ms	
1	0	1	2 <sup>16</sup> /fx	32.77 ms	13.11 ms	6.55 ms	3.27 ms	
Other than above Setting p			Setting pro	hibited				

- Cautions 1. To set the STOP mode when the X1 clock is used as the CPU clock, set OSTS before executing the STOP instruction.
  - 2. Do not change the value of the OSTS register during the X1 clock oscillation stabilization time.
  - The oscillation stabilization time counter counts up to the oscillation stabilization time set by OSTS. If the STOP mode is entered and then released while the internal high-speed oscillation clock is being used as the CPU clock, set the oscillation stabilization time as follows.
    - Desired OSTC oscillation stabilization time ≤ Oscillation stabilization time set by OSTS

Note, therefore, that only the status up to the oscillation stabilization time set by OSTS is set to OSTC after STOP mode is released.

4. The X1 clock oscillation stabilization time does not include the time until clock oscillation starts ("a" below).







## 20.2 Standby Function Operation

#### 20.2.1 HALT mode

## (1) HALT mode

The HALT mode is set by executing the HALT instruction. HALT mode can be set regardless of whether the CPU clock before the setting was the high-speed system clock, internal high-speed oscillation Clock, or subsystem clock.

The operating statuses in the HALT mode are shown below.



HALT Mode Setting		When HALT Instruction Is Executed While CPU Is Operating on Main System Clock						
		When CPU Is Operating on	When CPU is Operating on	When CPU is Operating on				
		Internal High-Speed	X1 Clock (fx)	External Main System Clock				
Item		Oscillation Clock (fosca)		(fext)				
System clock		Clock supply to the CPU is stop	oped					
Main system cl	ock fosca	Operation continues (cannot	Status before HALT mode was	set is retained				
		be stopped)	be stopped)					
	fx	Status before HALT mode was set is retained	Operation continues (cannot be stopped)	Status before HALT mode was set is retained				
	fext	Operates or stops by external of	lock input	Operation continues (cannot				
				be stopped)				
Subsystem cloo	ck fxt	Status before HALT mode was	set is retained					
	<b>f</b> EXTS	Status before HALT mode was	set is retained					
fosc		Status before HALT mode was	set is retained. Operation continu	ues (cannot be stopped) when				
		"internal low-speed oscillator ca	annot be stopped by software" is	set by option byte.				
CPU		Operation stopped						
Flash memory		Operation stopped						
RAM		Status before HALT mode was	set is retained					
Regulator		Operates in normal mode						
Port (latch)		Status before HALT mode was set is retained						
16-bit timer/event	TMP0	Operable						
counter	TMP1	-						
	TMP2	-						
	TMP3	-						
	TMP4	-						
8-bit timer/event	TM50							
counter	TM51							
Watch timer								
Watchdog timer		Operable. Clock supply to watchdog timer stops when "internal low-speed oscillator can be stopped by software" is set by option byte.						
Clock output		Operable						
Buzzer output								
A/D converter								
Serial interface	UART60							
	UART61							
CSI10 CSI11								
IICO								
FCAN controller								
Multiplier/divider								
Stepper motor C/D	(with ZPD)							
LCD C/D								
Sound generator								
Power-on-clear fun	ction							
Low-voltage detect	ion function							
External interrupt								

Table 20-1.	Operating	Statuses	in HALT	Mode	(1/2)
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HALT Mode Setting		Sotting	When HALT Instruction to Executed While	a CPULIa Operating on Subouttom Clock				
	HALTI	vioue	Setting					
lto	-			When CPU Is Operating on X11 Clock (fxr)	When CPU Is Operating on External Subsystem Clock (fexts)			
System clock			Clock supply to the CPU is stopped					
Main system clock Tosca		fosca	Status before HALT mode was set is retained					
		ŀ	fx					
			fext	Operates or stops by external clock input				
	Subsystem clo	ck	fхт	Operation continues (cannot be stopped)	Status before HALT mode was set is retained			
			fexts	Operates or stops by external clock input	Operation continues (cannot be stopped)			
	fosc			Status before HALT mode was set is retained. C "internal low-speed oscillator cannot be stopped	Operation continues (cannot be stopped) when by software" is set by option byte.			
CF	บ			Operation stopped				
Fla	ish memory			Operation stopped				
RA	M			Status before HALT mode was set is retained				
Re	gulator			Operates in low power consumption mode when	fosce stops			
				Operates in normal mode when fosce operates				
Po	rt (latch)			Status before HALT mode was set is retained				
16	-bit timer/event	TMP	0 <sup>Note</sup>	Operable				
со	unter	TMP	1 <sup>Note</sup>					
TMP2 <sup>Note</sup> TMP3 <sup>Note</sup> TMP4 <sup>Note</sup>		2 <sup>Note</sup>						
		3 <sup>Note</sup>						
		P4 <sup>Note</sup>						
8-bit timer/event TM50 <sup>Note</sup>		0 Note						
counter TM51 Note		1 Note						
W	atch timer		•					
W	atchdog timer			Operable Clock supply to watchdog timer stops	s when "internal low-speed oscillator can be			
				stopped by software" is set by option byte.				
Clo	ock output			Operable				
Bu	zzer output			Operable. However, operation disabled when peripheral hardware clock (fPRs) is stopped				
A/I	O converter							
Se	rial interface	UAR	RT60	Operable				
		UAR	RT61					
		CSI1	10 <sup>Note</sup>					
		CSI1	11 <sup>Note</sup>					
		IIC0						
FCAN controller								
Multiplier/divider								
Stepper motor C/D (with ZPD)		ZPD)						
LCD C/D								
Sound generator								
Po	wer-on-clear fun	ction						
Lo	w-voltage detect	ion fu	nction					
Ex	ternal interrupt							

## Table 20-1. Operating Statuses in HALT Mode (2/2)



**Note** When the CPU is operating on the subsystem clock and the internal high-speed oscillation clock has been stopped, do not start operation of these functions on the external clock input from peripheral hardware pins.

- fx: X1 clock
- fEXT: External main system clock
- fxT: XT1 clock
- fEXTS: External subsystem clock
- fosc: Internal low-speed oscillation clock



## (2) HALT mode release

The HALT mode can be released by the following two sources.

## (a) Release by unmasked interrupt request

When an unmasked interrupt request is generated, the HALT mode is released. If interrupt acknowledgement is enabled, vectored interrupt servicing is carried out. If interrupt acknowledgement is disabled, the next address instruction is executed.





**Note** The wait time is as follows:

- When vectored interrupt servicing is carried out: 11 or 12 clocks
- When vectored interrupt servicing is not carried out: 4 or 5 clocks
- **Remark** The broken lines indicate the case when the interrupt request which has released the standby mode is acknowledged.



## (b) Release by reset signal generation

When the reset signal is generated, HALT mode is released, and then, as in the case with a normal reset operation, the program is executed after branching to the reset vector address.

Figure 20-4. HALT Mode Release by Reset



## (2) When internal high-speed oscillation clock is used as CPU clock







Release Source	MK××	PR××	IE	ISP	Operation
Maskable interrupt request	0	0	0	×	Next address instruction execution
	0	0	1	×	Interrupt servicing execution
	0	1	0	1	Next address instruction execution
	0	1	×	0	
	0	1	1	1	Interrupt servicing execution
	1	×	×	×	HALT mode held
Reset signal input	_	_	×	×	Reset processing

Table 20-2. Operation in Response to Interrupt Request in HALT Mode

×: don't care

#### 20.2.2 STOP mode

#### (1) STOP mode setting and operating statuses

The STOP mode is set by executing the STOP instruction, and it can be set only when the CPU clock before the setting was the main system clock.

Caution Because the interrupt request signal is used to clear the standby mode, if there is an interrupt source with the interrupt request flag set and the interrupt mask flag reset, the standby mode is immediately cleared if set. Thus, the STOP mode is reset to the HALT mode immediately after execution of the STOP instruction and the system returns to the operating mode as soon as the wait time set using the oscillation stabilization time select register (OSTS) has elapsed.

The operating statuses in the STOP mode are shown below.



STOP Mode Setting			Setting	When STOP Instruction Is Executed While CPU Is Operating on Main System Clock							
				When CPU Is Operating on	When CPU Is Operating on	When CPU Is Operating on					
				Internal High-Speed	X1 Clock (fx)	External Main System Clock					
Ite	m			Oscillation Clock (fosca)		(fext)					
Sy	stem clock			Clock supply to the CPU is stopped							
Main system clock fosca fx		fosca	Stopped								
		fx									
			fext	Input invalid							
Subsystem cloc		ck	fx⊤	Status before STOP mode was set is retained							
			<b>f</b> EXTS	Status before STOP mode was set is retained							
fosc			Status before STOP mode was set is retained. Operation continues (cannot be stopped) when								
				"internal low-speed oscillator cannot be stopped by software" is set by option byte.							
CPU				Operation stopped							
Fla	ash memory			Operation stopped							
RAM				Status before STOP mode was set is retained							
Re	gulator			Operates in low power consumption mode							
Po	rt (latch)	T		Status before STOP mode was set is retained							
16	-bit timer/event	TMP	0 <sup>Note</sup>	Operation stopped							
counter TMI		TMP	1 <sup>Note</sup>								
		TMP	2 <sup>Note</sup>								
		TMP	3 <sup>Note</sup>								
TMP4			<sup>9</sup> 4								
8-bit timer/event TM50 <sup>Note</sup>		0 <sup>Note</sup>	Operable only when TI50, fosc base is selected as the count clock								
counter TM51 <sup>Note</sup>		1 <sup>Note</sup>	Operable only when TI51 is selected as the count clock								
Watch timer			Operable only when fsub is selected as the count clock								
Watchdog timer				Operable. Clock supply to watchdog timer stops when "internal low-speed oscillator can be							
				stopped by software" is set by option byte.							
Clock output				Operable only when fsuB is selected as the count clock							
Bu	zzer output			Operation stopped							
A/I	O converter										
Serial interface		UAR	RT60	Operable only when TO50 is selected as the serial clock during 8-bit timer/event counter TM							
		UAR	RT61	operation							
		CSI1	10 <sup>Note</sup>	Operable only when external clo	ock is selected as the serial clock	(					
		CSI1	11 <sup>Note</sup>								
		IIC0									
FCAN controller				Operable. Can be woken up from sleep mode.							
Stepper motor C/D (with ZPD)			ZPD)	Operation stopped							
LCD C/D				Operable only when fsub, fosc is selected as the operation clock							
Sound Generator				Operation stopped							
Power-on-clear function				Operable							
Low-voltage detection function			nction	1							
External interrupt				1							

## Table 20-3. Operating Statuses in STOP Mode

**Note** Do not start operation of these functions on the external clock input from peripheral hardware pins in the stop mode.

Remark	fosca:	Internal high-speed oscillation clock
	fx:	X1 clock
	fext:	External main system clock
	fx⊤:	XT1 clock
	fexts:	External subsystem clock
	fosc:	Internal low-speed oscillation clock

- Cautions 1. To use the peripheral hardware that stops operation in the STOP mode, and the peripheral hardware for which the clock that stops oscillating in the STOP mode after the STOP mode is released, restart the peripheral hardware.
  - 2. Even if "internal low-speed oscillator can be stopped by software" is selected by the option byte, the internal low-speed oscillator continues in the STOP mode in the status before the STOP mode is set. To stop the internal low-speed oscillator in the STOP mode, stop it by software and then execute the STOP instruction.
  - 3. To shorten oscillation stabilization time after the STOP mode is released when the CPU operates with the high-speed system clock (X1 oscillation), temporarily switch the CPU clock to the internal high-speed oscillator internal oscillation Clock before the next execution of the STOP instruction. Before changing the CPU clock from the internal high-speed oscillator to the high-speed system clock (X1 oscillation) after the STOP mode is released, check the oscillation stabilization time with the oscillation stabilization time counter status register (OSTC).
  - 4. If the STOP instruction is executed when AMPH = 1, supply of the CPU clock is stopped for 4.06 to 16.12  $\mu$ s after the STOP mode is released when the internal high-speed oscillation clock is selected as the CPU clock, or for the duration of 160 external clocks when the high-speed system clock (external clock input) is selected as the CPU clock.


## (2) STOP mode release

78K0/Dx2





**Notes 1.** When AMPH = 1

**2.** The wait time is as follows:

- When vectored interrupt servicing is carried out: 17 or 18 clocks
- When vectored interrupt servicing is not carried out: 11 or 12 clocks

The STOP mode can be released by the following two sources.



#### (a) Release by unmasked interrupt request

When an unmasked interrupt request is generated, the STOP mode is released. After the oscillation stabilization time has elapsed, if interrupt acknowledgment is enabled, vectored interrupt servicing is carried out. If interrupt acknowledgment is disabled, the next address instruction is executed.

#### Figure 20-6. STOP Mode Release by Interrupt Request Generation (1/2)

#### (1) When high-speed system clock (X1 oscillation) is used as CPU clock



#### (2) When high-speed system clock (external clock input) is used as CPU clock (1/2)

• When AMPH = 1



**Note** The wait time is as follows:

- When vectored interrupt servicing is carried out: 17 or 18 clocks
- When vectored interrupt servicing is not carried out: 11 or 12 clocks
- **Remark** The broken lines indicate the case when the interrupt request that has released the standby mode is acknowledged.



#### Figure 20-6. STOP Mode Release by Interrupt Request Generation (2/2)

#### (2) When high-speed system clock (external clock input) is used as CPU clock (2/2)

• When AMPH = 0



- When vectored interrupt servicing is carried out: 17 or 18 clocks
- When vectored interrupt servicing is not carried out: 11 or 12 clocks
- **Remark** The broken lines indicate the case when the interrupt request that has released the standby mode is acknowledged.

RENESAS

#### (b) Release by reset signal generation

When the reset signal is generated, STOP mode is released, and then, as in the case with a normal reset operation, the program is executed after branching to the reset vector address.

Figure 20-7. STOP Mode Release by Reset



#### (2) When internal high-speed oscillation clock is used as CPU clock



Remark fx: X1 clock oscillation frequency



Release Source	MK××	PR××	IE	ISP	Operation
Maskable interrupt request	0	0	0	×	Next address instruction execution
	0	0	1	×	Interrupt servicing execution
	0	1	0	1	Next address
	0	1	×	0	instruction execution
	0	1	1	1	Interrupt servicing execution
	1	×	×	×	STOP mode held
Reset signal input	-	-	×	×	Reset processing

×: don't care



#### CHAPTER 21 RESET FUNCTION

The following four operations are available to generate a reset signal.

- (1) External reset input via RESET pin
- (2) Internal reset by watchdog timer program loop detection
- (3) Internal reset by comparison of supply voltage and detection voltage of power-on-clear (POC) circuit
- (4) Internal reset by comparison of supply voltage and detection voltage of low-power-supply detector (LVI)

External and internal resets have no functional differences. In both cases, program execution starts at the address at 0000H and 0001H when the reset signal is generated.

A reset is applied when a low level is input to the RESET pin, the watchdog timer overflows, or by POC and LVI circuit voltage detection, and each item of hardware is set to the status shown in **Tables 21-1** and **21-2**. Each pin is high impedance during reset signal generation or during the oscillation stabilization time just after a reset release.

When a low level is input to the  $\overrightarrow{RESET}$  pin, the device is reset. It is released from the reset status when a high level is input to the  $\overrightarrow{RESET}$  pin and program execution is started with the internal high-speed oscillation clock after reset processing. A reset by the watchdog timer is automatically released, and program execution starts using the internal high-speed oscillation clock (see **Figures 21-2** to **21-4**) after reset processing. Reset by POC and LVI circuit power supply detection is automatically released when  $V_{DD} \ge V_{POC}$  or  $V_{DD} \ge V_{LVI}$  after the reset, and program execution starts using the internal high-speed oscillation clock (see **CHAPTER 23 POWER-ON-CLEAR CIRCUIT** and **CHAPTER 24 LOW-VOLTAGE DETECTOR**) after reset processing.

Cautions 1. For an external reset, input a low level for 10  $\mu$ s or more to the **RESET** pin.

- 2. During reset input, the X1 clock, XT1 clock, internal high-speed oscillation clock, and internal low-speed oscillation clock stop oscillating. External main system clock input and external subsystem clock input become invalid.
- 3. When the STOP mode is released by a reset, the STOP mode contents are held during reset input. However, the port pins become high-impedance.









Figure 21-2. Timing of Reset by RESET Input

Caution A watchdog timer internal reset resets the watchdog timer.





#### Figure 21-4. Timing of Reset in STOP Mode by RESET Input

Remark For the reset timing of the power-on-clear circuit and low-voltage detector, see CHAPTER 23 POWER-ON-CLEAR CIRCUIT and CHAPTER 24 LOW-VOLTAGE DETECTOR.



	Item		Status during Reset Period		
Sy	stem clock		Clock supply to the CPU is stopped.		
Main system clock fosca		fosca	Operation stopped		
		fx	Operation stopped (pin is I/O port mode)		
		fext	Clock input invalid (pin is I/O port mode)		
	Subsystem clock	fхт	Operation stopped (pin is I/O port mode)		
		<b>f</b> EXTS	Clock input invalid (pin is I/O port mode)		
	fosc		Operation stopped		
CF	บ				
Fla	ash memory				
RA	M				
Re	gulator		Operable		
Po	rt (latch)		Operation stopped		
16	-bit timer/event	00			
со	unter P	01			
		02			
		03			
		04			
8-I	oit timer/event	50			
со	unter	51			
W	atch timer				
W	atchdog timer				
Cl	ock output				
Βι	zzer output				
A/	D converter				
Se	rial interface	UART60			
		UART61			
	_	CSI10			
		CSI11			
		IIC0			
CA	N controller				
М	ultiplier/divider				
St	epper motor C/D (w	ith ZPD)			
LC	D controller/driver				
Sc	und generator				

#### Table 21-1. Operation Statuses during Reset Period (1/2)

Remark fosce: Internal high-speed oscillation clock

- fx: X1 oscillation clock
- fEXT: External main system clock
- fxT: XT1 oscillation clock
- fEXTS: External subsystem clock
- fosc: Internal low-speed oscillation clock



Item	Status during Reset Period
Power-on-clear function	Operable
Low-voltage detection function	Operation stopped
External interrupt	

#### Table 21-1. Operation Statuses during Reset Period (2/2)



	Hardware					
Program counter (PC)	The contents of the reset vector table (0000H, 0001H) are set.					
Stack pointer (SP)		Undefined				
Program status word (	PSW)	02H				
RAM	Data memory	Undefined <sup>Note 2</sup>				
	General-purpose registers	Undefined <sup>Note 2</sup>				
Port registers (P0 to P	Port registers (P0 to P3, P6 to P9, P12) (output latches)					
Port mode registers	PM0 to PM3, PM6 to PM9, PM12	FFH				
Pull-up resistor option	00H					
Internal expansion RA	0CH <sup>Note 3</sup>					
Internal memory size s	CFH <sup>Note 3</sup>					
Processor clock control	01H					
Clock operation mode	00H					
Internal oscillator mod	e register (RCM)	00H <sup>Note 4</sup>				
Main clock mode regis	ster (MCM)	00H				
Main OSC control regi	ster (MOC)	80H				
Oscillation stabilization	n time select register (OSTS)	05H				
Oscillation stabilization	n time counter status register (OSTC)	00H				
16-bit timer/event	Control registers 0, 1 (TP0CTL0-TP4CTL0, TP0CTL1-TP4CTL1)	00H				
counters P0-P4	I/O control registers 0-2 (TP0CTL0-TP4CTL0, TP0CTL1-TP4CTL1, TP0CTL2- TP4CTL2)	00H				
	Option registers 0 (TP0OPT0-TP4OPT0)	00H				
	Capture/compare registers 0, 1 (TP0CCR0-TP4CCR0, TP0CCR1-TP4CCR1)	0000H				
	Counter read buffer registers (TP0CNT-TP4CNT)	0000H				

Table 21-2. Hardware Statuses after Reset Acknowledgment (1/3)

- **Notes 1.** During reset signal generation or oscillation stabilization time wait, only the PC contents among the hardware statuses become undefined. All other hardware statuses remain unchanged after reset.
  - 2. When a reset is executed in the standby mode, the pre-reset status is held even after reset.
  - 3. The initial values of the internal memory size switching register (IMS) and internal expansion RAM size switching register (IXS) after a reset release are constant (IMS = CFH, IXS = 0CH) in all the 78K0/Dx2 products, regardless of the internal memory capacity. Therefore, after a reset is released, be sure to set the following values for each product.

Fla	sh Memory Version	IMS	IXS
78K0/DE2	78K0/DF2		
μPD78F0836	μPD78F0838, 78F0840, 78F0842	C6H	0AH
μPD78F0844	μPD78F0846, 78F0848	C8H	
μPD78F0837	μPD78F0839, 78F0841, 78F0843	ССН	08H
μPD78F0845	μPD78F0847, 78F0849	CFH	

4. The value of this register is 00H immediately after a reset release but automatically changes to 80H after internal high-speed oscillation has been stabilized.

	Hardware	Status after Reset Acknowledgment <sup>Note 1</sup>
8-bit timer/event counters	Timer counters 50, 51 (TM50, TM51)	00H
50, 51	Compare registers 50, 51 (CR50, CR51)	00H
	Timer clock selection registers 50, 51 (TCL50, TCL51)	00H
	Mode control registers 50, 51 (TMC50, TMC51)	00H
Watch timer	Operation mode register (WTM)	00H
Clock output/buzzer output controller	Clock output selection register (CKS)	00H
Watchdog timer	Enable register (WDTE)	1AH/9AH <sup>Note 2</sup>
A/D converter	10-bit A/D conversion result register (ADCR)	0000H
	8-bit A/D conversion result register (ADCRH)	00H
	Mode register (ADM)	00H
	Analog input channel specification register (ADS)	00H
	A/D port configuration register (ADPC)	00H
Serial interfaces UART60,	Receive buffer registers 60, 61 (RXB60, RXB61)	FFH
UART61	Transmit buffer registers 60, 61 (TXB60, TXB61)	FFH
	Asynchronous serial interface operation mode registers 60, 61 (ASIM60, ASIM61)	01H
	Asynchronous serial interface reception error status registers 60, 61 (ASIS60, ASIS61)	00H
	Asynchronous serial interface transmission status registers 60, 61 (ASIF60, ASIF61)	00H
	Clock selection registers 60, 61 (CKSR60, CKSR61)	00H
	Baud rate generator control registers 60, 61 (BRGC60, BRGC61)	FFH
	Asynchronous serial interface control registers 60, 61 (ASICL60, ASICL61)	16H
	Input switch control register (ISC)	00H
Serial interfaces CSI10,	Transmit buffer registers 10, 11 (SOTB10, SOTB11)	00H
CSI11	Serial I/O shift registers 10, 11 (SIO10, SIO11)	00H
	Serial operation mode registers 10, 11 (CSIM10, CSIM11)	00H
	Serial clock selection registers 10, 11 (CSIC10, CSIC11)	00H
Serial interface IIC0	IIC shift register 0 (IIC0)	00H
	Slave address register 0 (SVA0)	00H
	IIC control register 0 (IICC0)	00H
	IIC flag register 0 (IICF0)	00H
	IIC status register 0 (IICS0)	00H
	IIC clock selection register 0 (IICCL0)	00H
	IIC function expansion register 0 (IICX0)	00H

Table 21-2.	Hardware Statuses	after Reset A	Acknowledgment (2/3)
			· · · · · · · · · · · · · · · · · · ·

- **Notes 1.** During reset signal generation or oscillation stabilization time wait, only the PC contents among the hardware statuses become undefined. All other hardware statuses remain unchanged after reset.
  - **2.** The reset value of WDTE is determined by the option byte setting.

	Hardware	Status after Reset Acknowledgment <sup>Note 1</sup>
Multiplier/divider	Remainder data register 0 (SDR0)	0000H
	Multiplication/division data registers A0 (MDA0H, MDA0L)	0000H
	Multiplication/division data register B0 (MDB0)	0000H
	Multiplier/divider control register 0 (DMUC0)	00H
Stepper motor C/D	Timer mode control registers (MCNTC0)	00H
(with ZPD)	Compare registers (MCMP10, MCMP11, MCMP20, MCMP21, MCMP30, MCMP31, MCMP40, MCMP41)	00H
	Combined compare registers (MCMP1HW, MCMP2HW, MCMP3HW, MCMP4HW)	0000H
	Compare control registers (MCMPC1, MCMPC2, MCMPC3, MCMPC4)	00H
	Stepper motor port mode control register (SMPC)	00H
	ZPD detection voltage setting registers (ZPDS0, ZPDS1)	00H
	ZPD flag detection clock setting register (CMPCTL)	00H
	ZPD operational control register (ZPDEN)	00H
LCD controller/driver	LCD mode register (LCDMD)	00H
	LCD display mode register (LCDM)	00H
	LCD clock control register (LCDC0)	00H
	LCD port function registers 0, 3, ALL (LCDPF0, LCDPF3, LCDPFALL)	00H
Sound generator	SG0 control register (SG0CTL)	00H
	SG0 frequency low register (SG0FL)	0000H
	SG0 frequency high register (SG0FH)	0000H
	SG0 volume register (SG0PWM)	0000H
Reset function	Reset control flag register (RESF)	00H <sup>Note 2</sup>
Low-voltage detector	Low-voltage detection register (LVIM)	00H <sup>Note 2</sup>
	Low-voltage detection level selection register (LVIS)	00H <sup>Note 2</sup>
Interrupt	Request flag registers 0L, 0H, 1L, 1H (IF0L, IF0H, IF1L, IF1H)	00H
	Mask flag registers 0L, 0H, 1L, 1H (MK0L, MK0H, MK1L, MK1H)	FFH
	Priority specification flag registers 0L, 0H, 1L, 1H (PR0L, PR0H, PR1L, PR1H)	FFH
	External interrupt rising edge enable register (EGP)	00H
	External interrupt falling edge enable register (EGN)	00H

Table 21-2.	Hardware	Statuses	after Reset	Acknowledgment	(3/3)
-------------	----------	----------	-------------	----------------	-------

**Notes 1.** During reset signal generation or oscillation stabilization time wait, only the PC contents among the hardware statuses become undefined. All other hardware statuses remain unchanged after reset.

2. These values vary depending on the reset source.

	Reset Source	RESET Input	Reset by POC	Reset by WDT	Reset by LVI
Register					
RESF	WDTRF bit	Cleared (0)	Cleared (0)	Set (1)	Held
	LVIRF bit			Held	Set (1)
LVIM		Cleared (00H)	Cleared (00H)	Cleared (00H)	Held
LVIS					



#### 21.1 Register for Confirming Reset Source

Many internal reset generation sources exist in the 78K0/Dx2. The reset control flag register (RESF) is used to store which source has generated the reset request.

RESF can be read by an 8-bit memory manipulation instruction.

RESET input, reset input by power-on-clear (POC) circuit, and reading RESF clear RESF to 00H.

#### Figure 21-5. Format of Reset Control Flag Register (RESF)

Address: FF/	ACH After r	eset: 00H <sup>Note</sup>	R					
Symbol	7	6	5	4	3	2	1	0
RESF	0	0	0	WDTRF	0	0	0	LVIRF

WDTRF	Internal reset request by watchdog timer (WDT)			
0	Internal reset request is not generated, or RESF is cleared.			
1	Internal reset request is generated.			

LVIRF	Internal reset request by low-voltage detector (LVI)						
0	Internal reset request is not generated, or RESF is cleared.						
1	Internal reset request is generated.						

Note The value after reset varies depending on the reset source.

#### Caution Do not read data by a 1-bit memory manipulation instruction.

The status of RESF when a reset request is generated is shown in Table 21-3.

#### Table 21-3. RESF Status When Reset Request Is Generated

Reset Source	RESET Input	Reset by POC	Reset by WDT	Reset by LVI
Flag				
WDTRF	Cleared (0)	Cleared (0)	Set (1)	Held
LVIRF			Held	Set (1)



### CHAPTER 22 MULTIPLIER/DIVIDER

#### 22.1 Functions of Multiplier/Divider

The multiplier/divider has the following functions.

- 16 bits × 16 bits = 32 bits (multiplication)
- 32 bits ÷ 16 bits = 32 bits, 16-bit remainder (division)

#### 22.2 Configuration of Multiplier/Divider

The multiplier/divider includes the following hardware.

ltem	Configuration
Registers	Remainder data register 0 (SDR0) Multiplication/division data registers A0 (MDA0H, MDA0L) Multiplication/division data register B0 (MDB0)
Control register	Multiplier/divider control register 0 (DMUC0)

#### Table 22-1. Configuration of Multiplier/Divider

Figure 22-1 shows the block diagram of the multiplier/divider.



DMUSELO DMULE DMUSELO DMULE E-bit Ceear counter CPU clc	
Internal bus Internal bus Multiplication/division data register BO (MDB0I + MDB0L) (MDB0 (MDB0H + MDB0L)) (MDB0 (MDB0H + MDB0L)) (MDB0 (MDB0H + MDB0L)) (MDB0(MDB0H + MDB0L)) (MDB0(MDB0H + MDB0L)) (MDB0(MDB0H + MDB0L)) (MDB0(MDB0H + MDB0L)) (MDB0(MDB0H + MDB0L)) (MDB0(H + MDB0L)) (MDB0	Controller



78K0/Dx2

RENESAS

#### (1) Remainder data register 0 (SDR0)

SDR0 is a 16-bit register that stores a remainder. This register stores 0 in the multiplication mode and the remainder of an operation result in the division mode.

SDR0 can be read by an 8-bit or 16-bit memory manipulation instruction.

Reset signal generation clears SDR0 to 0000H.

#### Figure 22-2. Format of Remainder Data Register 0 (SDR0)



# Cautions 1. The value read from SDR0 during operation processing (while bit 7 (DMUE) of multiplier/divider control register 0 (DMUC0) is 1) is not guaranteed.

2. SDR0 is reset when the operation is started (when DMUE is set to 1).

#### (2) Multiplication/division data register A0 (MDA0H, MDA0L)

MDA0 is a 32-bit register that sets a 16-bit multiplier A in the multiplication mode and a 32-bit dividend in the division mode, and stores the 32-bit result of the operation (higher 16 bits: MDA0H, lower 16 bits: MDA0L).

#### Figure 22-3. Format of Multiplication/Division Data Register A0 (MDA0H, MDA0L)

Address:	ss: FF62H, FF63H, FF64H, FF65H After reset: 0000H, 0000H R/W															
Symbol	FF65H (MDA0HH)								FF64H (MDA0HL)							
	_								_							
	(							)	1							)
MDA0H	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA
	031	030	029	028	027	026	025	024	023	022	021	020	019	018	017	016
Symbol			FF	=63H (N	/DA0LI	H)					F	F62H (I	MDA0L	L)		
	_								_							
	(							J	(							)
MDA0L	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA	MDA
	015	014	013	012	011	010	009	800	007	006	005	004	003	002	001	000

Cautions 1. MDA0H is cleared to 0 when an operation is started in the multiplication mode (when multiplier/divider control register 0 (DMUC0) is set to 81H).

- 2. Do not change the value of MDA0 during operation processing (while bit 7 (DMUE) of multiplier/divider control register 0 (DMUC0) is 1). Even in this case, the operation is executed, but the result is undefined.
- 3. The value read from MDA0 during operation processing (while DMUE is 1) is not guaranteed.

The functions of MDA0 when an operation is executed are shown in the table below.

DMUSEL0	Operation Mode	Setting	Operation Result
0	Division mode	Dividend	Division result (quotient)
1	Multiplication mode	Higher 16 bits: 0, Lower 16 bits: Multiplier A	Multiplication result (product)

Table 22-2.	Functions of MDA0 Duri	ng Operation Execution
-------------	------------------------	------------------------

The register configuration differs between when multiplication is executed and when division is executed, as follows.

- Register configuration during multiplication
   <Multiplier A> <Multiplier B> <Product>
   MDA0 (bits 15 to 0) × MDB0 (bits 15 to 0) = MDA0 (bits 31 to 0)
- Register configuration during division

<Dividend> <Divisor> <Quotient> <Remainder> MDA0 (bits 31 to 0) ÷ MDB0 (bits 15 to 0) = MDA0 (bits 31 to 0) ... SDR0 (bits 15 to 0)

MDA0 fetches the calculation result as soon as the clock is input, when bit 7 (DMUE) of multiplier/divider control register 0 (DMUC0) is set to 1.

MDA0H and MDA0L can be set by an 8-bit or 16-bit memory manipulation instruction. Reset signal generation clears MDA0H and MDA0L to 0000H.

#### (3) Multiplication/division data register B0 (MDB0)

MDB0 is a register that stores a 16-bit multiplier B in the multiplication mode and a 16-bit divisor in the division mode.

MDB0 can be set by an 8-bit or 16-bit memory manipulation instruction. Reset signal generation clears MDB0 to 0000H.

Address:	dress: FF66H, FF67H After reset: 0000H R/W																
Symbol	ol FF67H (MDB0H)						FF66H (MDB0L)										
								$\overline{}$	(							$\overline{}$	
MDB0	MDB	MDB	MDB	MDB	MDB	MDB	MDB	MDB	MDB	MDB	MDB	MDB	MDB	MDB	MDB	MDB	
	015	014	013	012	011	010	009	008	007	006	005	004	003	002	001	000	

#### Figure 22-4. Format of Multiplication/Division Data Register B0 (MDB0)

- Cautions 1. Do not change the value of MDB0 during operation processing (while bit 7 (DMUE) of multiplier/divider control register 0 (DMUC0) is 1). Even in this case, the operation is executed, but the result is undefined.
  - 2. Do not clear MDB0 to 0000H in the division mode. If set, undefined operation results are stored in MDA0 and SDR0.



#### 22.3 Register Controlling Multiplier/Divider

The multiplier/divider is controlled by multiplier/divider control register 0 (DMUC0).

#### (1) Multiplier/divider control register 0 (DMUC0)

DMUC0 is an 8-bit register that controls the operation of the multiplier/divider. DMUC0 can be set by a 1-bit or 8-bit memory manipulation instruction. Reset signal generation clears DMUC0 to 00H.

#### Figure 22-5. Format of Multiplier/Divider Control Register 0 (DMUC0)

Address: FF68H After reset: 00H R/W

Symbol	<7>	6	5	4	3	2	1	0
DMUC0	DMUE	0	0	0	0	0	0	DMUSEL0

DMUE <sup>Note</sup>	Operation start/stop
0	Stops operation
1	Starts operation

DMUSEL0	Operation mode (multiplication/division) selection
0	Division mode
1	Multiplication mode

- **Note** When DMUE is set to 1, the operation is started. DMUE is automatically cleared to 0 after the operation is complete.
- Cautions 1. If DMUE is cleared to 0 during operation processing (when DMUE is 1), the operation result is not guaranteed. If the operation is completed while the clearing instruction is being executed, the operation result is guaranteed, provided that the interrupt flag is set.
  - 2. Do not change the value of DMUSEL0 during operation processing (while DMUE is 1). If it is changed, undefined operation results are stored in multiplication/division data register A0 (MDA0) and remainder data register 0 (SDR0).
  - 3. If DMUE is cleared to 0 during operation processing (while DMUE is 1), the operation processing is stopped. To execute the operation again, set multiplication/division data register A0 (MDA0), multiplication/division data register B0 (MDB0), and multiplier/divider control register 0 (DMUC0), and start the operation (by setting DMUE to 1).



#### 22.4 Operations of Multiplier/Divider

#### 22.4.1 Multiplication operation

- Initial setting
  - Set operation data to multiplication/division data register A0L (MDA0L) and multiplication/division data register B0 (MDB0).
  - 2. Set bits 0 (DMUSEL0) and 7 (DMUE) of multiplier/divider control register 0 (DMUC0) to 1. Operation will start.
- During operation
  - 3. The operation will be completed when 16 peripheral hardware clocks (fPRs) have been issued after the start of the operation (intermediate data is stored in the MDA0L and MDA0H registers during operation, and therefore the read values of these registers are not guaranteed).
- End of operation
  - 4. The operation result data is stored in the MDA0L and MDA0H registers.
- 5. DMUE is cleared to 0 (end of operation).
- Next operation
  - 6. To execute multiplication next, start from the initial setting in **22.4.1** Multiplication operation.
  - 7. To execute division next, start from the initial setting in **22.4.2** Division operation.



Figure 22-6. Timing Chart of Multiplication Operation (00DAH imes 0093H)





#### 22.4.2 Division operation

- Initial setting
  - 1. Set operation data to multiplication/division data register A0 (MDA0L and MDA0H) and multiplication/division data register B0 (MDB0).
- 2. Set bits 0 (DMUSEL0) and 7 (DMUE) of multiplier/divider control register 0 (DMUC0) to 0 and 1, respectively. Operation will start.
- During operation
- The operation will be completed when 32 peripheral hardware clocks (fPRs) have been issued after the start of the operation (intermediate data is stored in the MDA0L and MDA0H registers and remainder data register 0 (SDR0) during operation, and therefore the read values of these registers are not guaranteed).
- End of operation
  - 4. The result data is stored in the MDA0L, MDA0H, and SDR0 registers.
- 5. DMUE is cleared to 0 (end of operation).
- Next operation
- 6. To execute multiplication next, start from the initial setting in **22.4.1** Multiplication operation.
- 7. To execute division next, start from the initial setting in 22.4.2 Division operation.



78K0/Dx2





#### CHAPTER 23 POWER-ON-CLEAR CIRCUIT

#### 23.1 Functions of Power-on-Clear Circuit

The power-on-clear circuit (POC) has the following functions.

- Generates internal reset signal at power on.
   In the 1.59 V POC mode (option byte: LVISTART = 0), the reset signal is released when the supply voltage (V<sub>DD</sub>) exceeds 1.59 V ±0.15 V.
   In the 2.7 V/1.59 V POC mode (option byte: LVISTART = 1), the reset signal is released when the supply voltage (V<sub>DD</sub>) exceeds 2.7 V ±0.2 V.
- Compares supply voltage (V<sub>DD</sub>) and detection voltage (V<sub>POC</sub> = 1.59 V ±0.15 V), generates internal reset signal when V<sub>DD</sub> < V<sub>POC</sub>.
  - Caution If an internal reset signal is generated in the POC circuit, the reset control flag register (RESF) is cleared to 00H.
  - **Remark** The 78K0/Dx2 incorporates multiple hardware functions that generate an internal reset signal. A flag that indicates the reset cause is located in the reset control flag register (RESF) for when an internal reset signal is generated by the watchdog timer (WDT) or low-voltage-detector (LVI). RESF is not cleared to 00H and the flag is set to 1 when an internal reset signal is generated by WDT or LVI. For details of RESF, see **CHAPTER 21 RESET FUNCTION**.



#### 23.2 Configuration of Power-on-Clear Circuit

The block diagram of the power-on-clear circuit is shown in **Figure 23-1**.





#### 23.3 Operation of Power-on-Clear Circuit

#### (1) In 1.59 V POC mode (option byte: LVISTART = 0)

- An internal reset signal is generated on power application. When the supply voltage (V<sub>DD</sub>) exceeds the detection voltage (V<sub>POC</sub> = 1.59 V ±0.15 V), the reset status is released.
- The supply voltage (V<sub>DD</sub>) and detection voltage (V<sub>POC</sub> = 1.59 V ±0.15 V) are compared. When V<sub>DD</sub> < V<sub>POC</sub>, the internal reset signal is generated. It is released when V<sub>DD</sub> ≥ V<sub>POC</sub>.

#### (2) In 2.7 V/1.59 V POC mode (option byte: LVISTART = 1)

- An internal reset signal is generated on power application. When the supply voltage (VDD) exceeds the detection voltage (VDDPOC = 2.7 V ±0.2 V), the reset status is released.
- The supply voltage (V<sub>DD</sub>) and detection voltage (V<sub>POC</sub> = 1.59 V ±0.15 V) are compared. When V<sub>DD</sub> < V<sub>POC</sub>, the internal reset signal is generated. It is released when V<sub>DD</sub> ≥ V<sub>DDPOC</sub>.

The timing of generation of the internal reset signal by the power-on-clear circuit and low-voltage detector is shown below.







- The guaranteed operation range for the (A) grade products is 1.8 V  $\leq$  V<sub>DD</sub>  $\leq$  5.5 V, and 2.7 V  $\leq$  V<sub>DD</sub>  $\leq$ Notes 1. 5.5 V for the (A2) grade products. To set the voltage range below the guaranteed operation range to the reset state when the supply voltage falls, use the reset function of the low-voltage detector, or input a low level to the RESET pin.
  - 2. With the (A) grade products, if the voltage rises to 1.8 V at a rate slower than 0.5 V/ms (MIN.) on power application, input a low level to the RESET pin after power application and before the voltage reaches 1.8 V, or set the 2.7 V/1.59 V POC mode by using an option byte (LVISTART = 1).
  - 3. The internal voltage stabilization time includes the oscillation accuracy stabilization time of the internal high-speed oscillation clock.
  - 4. The internal high-speed oscillation clock and a high-speed system clock or subsystem clock can be selected as the CPU clock. To use the X1 clock, use the OSTC register to confirm the lapse of the oscillation stabilization time. To use the XT1 clock, use the timer function for confirmation of the lapse of the stabilization time.

#### Caution Set the low-voltage detector by software after the reset status is released (see CHAPTER 24 LOW-VOLTAGE DETECTOR).

- Remark VLVI : LVI detection voltage
  - : POC detection voltage VPOC







#### (2) In 2.7 V / 1.59V POC mode (option byte: LVISTART = 1)

- Notes 1. The guaranteed operation range for the (A) grade products is 1.8 V ≤ V<sub>DD</sub> ≤ 5.5 V, and 2.7 V ≤ V<sub>DD</sub> ≤ 5.5 V for the (A2) grade products. To set the voltage range below the guaranteed operation range to the reset state when the supply voltage falls, use the reset function of the low-voltage detector, or input a low level to the RESET pin.
  - 2. The internal high-speed oscillation clock and a high-speed system clock or subsystem clock can be selected as the CPU clock. To use the X1 clock, use the OSTC register to confirm the lapse of the oscillation stabilization time. To use the XT1 clock, use the timer function for confirmation of the lapse of the stabilization time.
- Cautions 1. Set the low-voltage detector by software after the reset status is released (see CHAPTER 24 LOW-VOLTAGE DETECTOR).
  - 2. A voltage oscillation stabilization time of 1.93 to 5.39 ms is required after the supply voltage reaches 1.59 V (TYP.). If the supply voltage rises from 1.59 V (TYP.) to 2.7 V (TYP.) within 1.93 ms, the power supply oscillation stabilization time of 0 to 5.39 ms is automatically generated before reset processing.
- Remark VLVI : LVI detection voltage
  - VPOC : POC detection voltage



#### 23.4 Cautions for Power-on-Clear Circuit

In a system where the supply voltage ( $V_{DD}$ ) fluctuates for a certain period in the vicinity of the POC detection voltage ( $V_{POC}$ ), the system may be repeatedly reset and released from the reset status. In this case, the time from release of reset to the start of the operation of the microcontroller can be arbitrarily set by taking the following action.

#### <Action>

After releasing the reset signal, wait for the supply voltage fluctuation period of each system by means of a software counter that uses a timer, and then initialize the ports.

#### Figure 23-3. Example of Software Processing After Reset Release (1/2)

• If supply voltage fluctuation is 50 ms or less in vicinity of POC detection voltage





2. A flowchart is shown on the next page.





Checking reset cause





### CHAPTER 24 LOW-VOLTAGE DETECTOR

#### 24.1 Functions of Low-Voltage Detector

The low-voltage detector (LVI) has the following functions.

- The LVI circuit compares the supply voltage (V<sub>DD</sub>) with the detection voltage (V<sub>LVI</sub>) or the input voltage from an external input pin (EXLVI) with the detection voltage (V<sub>EXLVI</sub> = 1.21 V (TYP.): fixed), and generates an internal reset or internal interrupt signal.
- The supply voltage (VDD) or input voltage from an external input pin (EXLVI) can be selected by software.
- Reset or interrupt function can be selected by software.
- Detection levels (11 levels) of supply voltage can be changed by software.
- Operable in STOP mode.

The reset and interrupt signals are generated as follows depending on selection by software.

Selection of Level Detecti (LVIS	on of Supply Voltage (V□□) EL = 0)	Selection Level Detection of Input Voltage from External Input Pin (EXLVI) (LVISEL = 1)				
Selects reset (LVIMD = 1).	Selects interrupt (LVIMD = 0).	Selects reset (LVIMD = 1).	Selects interrupt (LVIMD = 0).			
Generates an internal reset signal when $V_{DD} < V_{LVI}$ and releases the reset signal when $V_{DD} \ge V_{LVI}$ .	Generates an internal interrupt signal when $V_{DD}$ drops lower than $V_{LVI}$ ( $V_{DD} < V_{LVI}$ ) or when $V_{DD}$ becomes $V_{LVI}$ or higher ( $V_{DD} \ge V_{LVI}$ ).	Generates an internal reset signal when EXLVI < $V_{EXLVI}$ and releases the reset signal when EXLVI $\geq V_{EXLVI}$ .	Generates an internal interrupt signal when EXLVI drops lower than $V_{EXLVI}$ (EXLVI < $V_{EXLVI}$ ) or when EXLVI becomes $V_{EXLVI}$ or higher (EXLVI $\ge V_{EXLVI}$ ).			

Remark LVISEL: Bit 2 of low-voltage detection register (LVIM) LVIMD: Bit 1 of LVIM

While the low-voltage detector is operating, whether the supply voltage or the input voltage from an external input pin is more than or less than the detection level can be checked by reading the low-voltage detection flag (LVIF: bit 0 of LVIM).

When the low-voltage detector is used to reset, bit 0 (LVIRF) of the reset control flag register (RESF) is set to 1 if reset occurs. For details of RESF, see **CHAPTER 21 RESET FUNCTION**.



#### 24.2 Configuration of Low-Voltage Detector

The block diagram of the low-voltage detector is shown in Figure 24-1.





#### 24.3 Registers Controlling Low-Voltage Detector

The low-voltage detector is controlled by the following registers.

- Low-voltage detection register (LVIM)
- Low-voltage detection level selection register (LVIS)
- Port mode register 12 (PM12)



#### (1) Low-voltage detection register (LVIM)

This register sets low-voltage detection and the operation mode.

This register can be set by a 1-bit or 8-bit memory manipulation instruction.

The generation of a reset signal other than an LVI reset clears this register to 00H.

#### Figure 24-2. Format of Low-Voltage Detection Register (LVIM)

Address:	FFBEH	After reset: 00	H R/W <sup>Note 1</sup>						
Symbol	<7>	6	5	4	3	<2>	<1>	<0>	
LVIM	LVION	٥ ا	0	0	0	LVISEL	LVIMD	LVIF	

LVION <sup>Notes 2, 3</sup>	Enables low-voltage detection operation
0	Disables operation
1	Enables operation

LVISEL <sup>Note 2</sup>	Voltage detection selection			
0	Detects level of supply voltage (VDD)			
1	Detects level of input voltage from external input pin (EXLVI)			

LVIMD <sup>Note 2</sup>	Low-voltage detection operation mode (interrupt/reset) selection
0	• LVISEL = 0: Generates an internal interrupt signal when the supply voltage ( $V_{DD}$ ) drops
	lower than the detection voltage (VLVI) (VDD < VLVI) or when VDD becomes
	$V_{LVI}$ or higher ( $V_{DD} \ge V_{LVI}$ ).
	• LVISEL = 1: Generates an interrupt signal when the input voltage from an external
	input pin (EXLVI) drops lower than the detection voltage (VEXLVI) (EXLVI $<$
	$V_{\text{EXLVI}}$ ) or when EXLVI becomes $V_{\text{EXLVI}}$ or higher (EXLVI $\ge V_{\text{EXLVI}}$ ).
1	• LVISEL = 0: Generates an internal reset signal when the supply voltage ( $V_{DD}$ ) <
	detection voltage (V_LVI) and releases the reset signal when $V_{\text{DD}} \geq V_{\text{LVI}}.$
	• LVISEL = 1: Generates an internal reset signal when the input voltage from an
	external input pin (EXLVI) < detection voltage (VEXLVI) and releases the
	reset signal when EXLVI $\geq$ VEXLVI.

LVIF <sup>Note 4</sup>	Low-voltage detection flag
0	<ul> <li>LVISEL = 0: Supply voltage (V<sub>DD</sub>) ≥ detection voltage (V<sub>LVI</sub>), or when operation is disabled</li> </ul>
	<ul> <li>LVISEL = 1: Input voltage from external input pin (EXLVI) ≥ detection voltage (V<sub>EXLVI</sub>), or when operation is disabled</li> </ul>
1	<ul> <li>LVISEL = 0: Supply voltage (V<sub>DD</sub>) &lt; detection voltage (V<sub>LVI</sub>)</li> <li>LVISEL = 1: Input voltage from external input pin (EXLVI) &lt; detection voltage (V<sub>EXLVI</sub>)</li> </ul>

Notes 1. Bit 0 is read-only.

- 2. LVION, LVIMD, and LVISEL are cleared to 0 in the case of a reset other than an LVI reset. These are not cleared to 0 in the case of an LVI reset.
- **3.** When LVION is set to 1, operation of the comparator in the LVI circuit is started. Use software to wait for an operation stabilization time (10  $\mu$ s (MIN.)) and minimum pulse width from when LVION is set to 1 until operation is stabilized. After operation has stabilized, 200  $\mu$ s (MIN.) are required from when a state below LVI detection voltage has been entered, until LVIF is set (1).
- **4.** The value of LVIF is output as the interrupt request signal INTLVI when LVION = 1 and LVIMD = 0.

#### Cautions 1. To stop LVI, follow either of the procedures below.

- When using 8-bit memory manipulation instruction: Write 00H to LVIM.
- When using 1-bit memory manipulation instruction: Clear LVION to 0.
- 2. Input voltage from external input pin (EXLVI) must be EXLVI < VDD.
- 3. After an LVI reset has been generated, do not write values to LVIS and LVIM when LVION = 1.
- 4. When using LVI as an interrupt, if LVION is cleared (0) in a state below the LVI detection voltage, an INTLVI signal is generated and LVIIF becomes 1.

#### (2) Low-voltage detection level selection register (LVIS)

This register selects the low-voltage detection level.

This register can be set by a 1-bit or 8-bit memory manipulation instruction.

The generation of a reset signal other than an LVI reset clears this register to 00H.

#### Figure 24-3. Format of Low-Voltage Detection Level Selection Register (LVIS)

Symbol	7	6	5	4	3	2	1	0	
LVIS	0	0	0	0	LVIS3	LVIS2	LVIS1	LVIS0	
		-	-		-				
	LVIS3	LVIS2	LVIS1	LVIS0	Detection level				
	0	0	0	0	VLVI0 (4.24 V ±0.1 V)				
	0	0	0	1	V <sub>LVI1</sub> (4.09 V ±0.1 V)				
	0	0	1	0	VLVI2 (3.93 V ±0.1 V)				
	0	0	1	1	VLVI3 (3.78 V ±0.1 V)				
	0	1	0	0	VLVI4 (3.62 V ±0.1 V)				
	0	1	0	1	VLVI5 (3.47 V ±0.1 V)				

0

1

0

1

0

Address: FFBFH After reset: 00H Note R/W

0

0

1

1

1

Note The value of LVIS is not reset but retained as is, upon a reset by LVI. It is cleared to 00H upon other resets.

VLVI6 (3.32 V ±0.1 V)

VLVI7 (3.16 V ±0.1 V)

VLVI8 (3.01 V ±0.1 V)

VLVI9 (2.85 V ±0.1 V)

VLVI10 (2.70 V ±0.1 V)

Cautions 1. Be sure to clear bits 4 to 7 to 0.

1

1

0

0

0

1

1

0

0

1

- 2. Do not change the value of LVIS during LVI operation.
- 3. When an input voltage from the external input pin (EXLVI) is detected, the detection voltage (VEXLVI = 1.21 V (TYP.)) is fixed. Therefore, setting of LVIS is not necessary.
- 4. After an LVI reset has been generated, do not write values to LVIS and LVIM when LVION = 1.

#### (3) Port mode register 12 (PM12)

When using the P120/EXLVI pin for external low-voltage detection potential input, set PM120 to 1. At this time, the output latch of P120 may be 0 or 1.

PM12 can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets PM12 to FFH.



Figure 24-4. Format of Port Mode Register 12 (PM12)

#### 24.4 Operation of Low-Voltage Detector

The low-voltage detector can be used in the following two modes.

#### (1) Used as reset (LVIMD = 1)

- If LVISEL = 0, compares the supply voltage (V<sub>DD</sub>) and detection voltage (V<sub>LVI</sub>), generates an internal reset signal when V<sub>DD</sub> < V<sub>LVI</sub>, and releases internal reset when V<sub>DD</sub> ≥ V<sub>LVI</sub>.
- If LVISEL = 1, compares the input voltage from external input pin (EXLVI) and detection voltage (V<sub>EXLVI</sub> = 1.21 V (TYP.)), generates an internal reset signal when EXLVI < V<sub>EXLVI</sub>, and releases internal reset when EXLVI ≥ V<sub>EXLVI</sub>.

#### (2) Used as interrupt (LVIMD = 0)

- If LVISEL = 0, compares the supply voltage (VDD) and detection voltage (VLVI). When VDD drops lower than VLVI (VDD < VLVI) or when VDD becomes VLVI or higher (VDD ≥ VLVI), generates an interrupt signal (INTLVI).</li>
- If LVISEL = 1, compares the input voltage from external input pin (EXLVI) and detection voltage (VEXLVI = 1.21 V (TYP.)). When EXLVI drops lower than VEXLVI (EXLVI < VEXLVI) or when EXLVI becomes VEXLVI or higher (EXLVI ≥ VEXLVI), generates an interrupt signal (INTLVI).</li>

While the low-voltage detector is operating, whether the supply voltage or the input voltage from an external input pin is more than or less than the detection level can be checked by reading the low-voltage detection flag (LVIF: bit 0 of LVIM).



Remark LVIMD: Bit 1 of low-voltage detection register (LVIM) LVISEL: Bit 2 of LVIM

#### 24.4.1 When used as reset

- (1) When detecting level of supply voltage (VDD)
  - When starting operation
    - <1> Mask the LVI interrupt (LVIMK = 1).
    - <2> Clear bit 2 (LVISEL) of the low-voltage detection register (LVIM) to 0 (detects level of supply voltage (VDD)) (default value).
    - <3> Set the detection voltage using bits 3 to 0 (LVIS3 to LVIS0) of the low-voltage detection level selection register (LVIS).
    - <4> Set bit 7 (LVION) of LVIM to 1 (enables LVI operation).
    - <5> Use software to wait for an operation stabilization time (10 µs (MIN.)) and minimum pulse width.
    - <6> Wait until it is checked that (supply voltage ( $V_{DD}$ )  $\geq$  detection voltage ( $V_{LVI}$ )) by bit 0 (LVIF) of LVIM.
    - <7> Set bit 1 (LVIMD) of LVIM to 1 (generates reset when the level is detected).

**Figure 24-5** shows the timing of the internal reset signal generated by the low-voltage detector. The numbers in this timing chart correspond to <1> to <7> above.

- Cautions 1. <1> must always be executed. When LVIMK = 0, an interrupt may occur immediately after the processing in <4>.
  - If supply voltage (V<sub>DD</sub>) ≥ detection voltage (V<sub>LVI</sub>) when LVIMD is set to 1, an internal reset signal is not generated.
- When stopping operation Either of the following procedures must be executed.
  - When using 8-bit memory manipulation instruction: Write 00H to LVIM.
  - When using 1-bit memory manipulation instruction: Clear LVIMD to 0 and then LVION to 0.







#### (1) In 1.59 V POC mode setup (option byte: LVISTART = 0)

**Notes 1.** The LVIMK flag is set to "1" by reset signal generation.

- 2. The LVIF flag may be set (1).
- 3. LVIRF is bit 0 of the reset control flag register (RESF). For details of RESF, see CHAPTER 21 RESET FUNCTION.
- **Remark** <1> to <7> in **Figure 24-5** above correspond to <1> to <7> in the description of "When starting operation" in **24.4.1 (1) When detecting level of supply voltage (V**<sub>DD</sub>).




## (2) In 2.7/1.59 V POC mode setup (option byte: LVISTART = 1)

**Notes 1.** The LVIMK flag is set to "1" by reset signal generation.

- 2. The LVIF flag may be set (1).
- 3. LVIRF is bit 0 of the reset control flag register (RESF). For details of RESF, see CHAPTER 21 RESET FUNCTION.
- **Remark** <1> to <7> in **Figure 24-5** above correspond to <1> to <7> in the description of "When starting operation" in **24.4.1 (1) When detecting level of supply voltage (V**<sub>DD</sub>).

## (2) When detecting level of input voltage from external input pin (EXLVI)

- When starting operation
  - <1> Mask the LVI interrupt (LVIMK = 1).
  - <2> Set bit 2 (LVISEL) of the low-voltage detection register (LVIM) to 1 (detects level of input voltage from external input pin (EXLVI)).
  - <3> Set bit 7 (LVION) of LVIM to 1 (enables LVI operation).
  - <4> Use software to wait for an operation stabilization time (10 µs (MIN.)) and minimum pulse width.
  - <5> Wait until it is checked that (input voltage from external input pin (EXLVI) ≥ detection voltage (V<sub>EXLVI</sub> = 1.21 V (TYP.))) by bit 0 (LVIF) of LVIM.
  - <6> Set bit 1 (LVIMD) of LVIM to 1 (generates reset signal when the level is detected).

**Figure 24-6** shows the timing of the internal reset signal generated by the low-voltage detector. The numbers in this timing chart correspond to <1> to <6> above.

- Cautions 1. <1> must always be executed. When LVIMK = 0, an interrupt may occur immediately after the processing in <3>.
  - If input voltage from external input pin (EXLVI) ≥ detection voltage (V<sub>EXLVI</sub> = 1.21 V (TYP.)) when LVIMD is set to 1, an internal reset signal is not generated.
  - 3. Input voltage from external input pin (EXLVI) must be EXLVI < VDD.
- When stopping operation

Either of the following procedures must be executed.

- When using 8-bit memory manipulation instruction: Write 00H to LVIM.
- When using 1-bit memory manipulation instruction: Clear LVIMD to 0 and then LVION to 0.





# Figure 24-6. Timing of Low-Voltage Detector Internal Reset Signal Generation (Detects Level of Input Voltage from External Input Pin (EXLVI))

- Notes 1. The LVIMK flag is set to "1" by reset signal generation.
  - 2. The LVIF flag may be set (1).
  - **3.** LVIRF is bit 0 of the reset control flag register (RESF). For details of RESF, see **CHAPTER 21 RESET FUNCTION**.
- **Remark** <1> to <6> in **Figure 24-6** above correspond to <1> to <6> in the description of "When starting operation" in **24.4.1 (2) When detecting level of input voltage from external input pin (EXLVI)**.



## 24.4.2 When used as interrupt

- (1) When detecting level of supply voltage (VDD)
  - When starting operation
    - <1> Mask the LVI interrupt (LVIMK = 1).
    - <2> Clear bit 2 (LVISEL) of the low-voltage detection register (LVIM) to 0 (detects level of supply voltage (VDD)) (default value).
    - <3> Set the detection voltage using bits 3 to 0 (LVIS3 to LVIS0) of the low-voltage detection level selection register (LVIS).
    - <4> Set bit 7 (LVION) of LVIM to 1 (enables LVI operation).
    - <5> Use software to wait for an operation stabilization time (10 µs (MIN.)) and minimum pulse width.
    - <6> Confirm that "supply voltage (VDD) ≥ detection voltage (VLVI)" when detecting the falling edge of VDD, or "supply voltage (VDD) < detection voltage (VLVI)" when detecting the rising edge of VDD, at bit 0 (LVIF) of LVIM.
    - <7> Clear the interrupt request flag of LVI (LVIIF) to 0.
    - <8> Release the interrupt mask flag of LVI (LVIMK).
    - <9> Clear bit 1 (LVIMD) of LVIM to 0 (generates interrupt signal when the level is detected) (default value).
    - <10> Execute the EI instruction (when vector interrupts are used).

**Figure 24-7** shows the timing of the interrupt signal generated by the low-voltage detector. The numbers in this timing chart correspond to <1> to <9> above.

When stopping operation

Either of the following procedures must be executed.

- When using 8-bit memory manipulation instruction: Write 00H to LVIM.
- When using 1-bit memory manipulation instruction: Clear LVION to 0.







## (1) In 1.59 V POC mode setup (option byte: LVISTART = 0)

Notes 1. The LVIMK flag is set to "1" by reset signal generation.

- 2. The interrupt request signal (INTLVI) is generated and the LVIF and LVIIF flags may be set (1).
- **3.** If LVION is cleared (0) in state below the LVI detection voltage, an INTLVI signal is generated and LVIIF becomes 1.
- **Remark** <1> to <9> in **Figure 24-7** above correspond to <1> to <9> in the description of "When starting operation" in **24.4.2 (1) When detecting level of supply voltage (V**<sub>DD</sub>).





## (2) In 2.7/1.59 V POC mode setup (option byte: LVISTART = 1)

Notes 1. The LVIMK flag is set to "1" by reset signal generation.

- 2. The interrupt request signal (INTLVI) is generated and the LVIF and LVIIF flags may be set (1).
- **3.** If LVION is cleared (0) in state below the LVI detection voltage, an INTLVI signal is generated and LVIIF becomes 1.
- **Remark** <1> to <9> in **Figure 24-7** above correspond to <1> to <9> in the description of "When starting operation" in **24.4.2 (1) When detecting level of supply voltage (V**<sub>DD</sub>).

#### (2) When detecting level of input voltage from external input pin (EXLVI)

- When starting operation
  - <1> Mask the LVI interrupt (LVIMK = 1).
  - <2> Set bit 2 (LVISEL) of the low-voltage detection register (LVIM) to 1 (detects level of input voltage from external input pin (EXLVI)).
  - <3> Set bit 7 (LVION) of LVIM to 1 (enables LVI operation).
  - <4> Use software to wait for an operation stabilization time (10  $\mu$ s (MIN.)) and minimum pulse width.
  - <5> Confirm that "input voltage from external input pin (EXLVI) ≥ detection voltage (V<sub>EXLVI</sub> = 1.21 V (TYP.)" when detecting the falling edge of EXLVI, or "input voltage from external input pin (EXLVI) < detection voltage (V<sub>EXLVI</sub> = 1.21 V (TYP.))" when detecting the rising edge of EXLVI, at bit 0 (LVIF) of LVIM.
  - <6> Clear the interrupt request flag of LVI (LVIIF) to 0.
  - <7> Release the interrupt mask flag of LVI (LVIMK).
  - <8> Clear bit 1 (LVIMD) of LVIM to 0 (generates interrupt signal when the level is detected) (default value).
  - <9> Execute the El instruction (when vector interrupts are used).

**Figure 24-8** shows the timing of the interrupt signal generated by the low-voltage detector. The numbers in this timing chart correspond to <1> to <8> above.

Caution Input voltage from external input pin (EXLVI) must be EXLVI < VDD.

- When stopping operation Either of the following procedures must be executed.
  - When using 8-bit memory manipulation instruction: Write 00H to LVIM.
  - When using 1-bit memory manipulation instruction: Clear LVION to 0.







- Notes 1. The LVIMK flag is set to "1" by reset signal generation.
  - 2. The interrupt request signal (INTLVI) is generated and the LVIF and LVIIF flags may be set (1).
  - **3.** If LVION is cleared (0) in state below the LVI detection voltage, an INTLVI signal is generated and LVIIF becomes 1.
- **Remark** <1> to <8> in **Figure 24-8** above correspond to <1> to <8> in the description of "When starting operation" in **24.4.2 (2) When detecting level of input voltage from external input pin (EXLVI)**.

## 24.5 Cautions for Low-Voltage Detector

In a system where the supply voltage ( $V_{DD}$ ) fluctuates for a certain period in the vicinity of the LVI detection voltage ( $V_{LVI}$ ), the operation is as follows depending on how the low-voltage detector is used.

## (1) When used as reset

The system may be repeatedly reset and released from the reset status. In this case, the time from release of reset to the start of the operation of the microcontroller can be arbitrarily set by taking action (1) below.

## (2) When used as interrupt

Interrupt requests may be frequently generated. Take (b) of action (2) below.

#### <Action>

## (1) When used as reset

After releasing the reset signal, wait for the supply voltage fluctuation period of each system by means of a software counter that uses a timer, and then initialize the ports (see **Figure 24-9**).

## (2) When used as interrupt

- (a) Confirm that "supply voltage (V<sub>DD</sub>) ≥ detection voltage (V<sub>LVI</sub>)" when detecting the falling edge of V<sub>DD</sub>, or "supply voltage (V<sub>DD</sub>) < detection voltage (V<sub>LVI</sub>)" when detecting the rising edge of V<sub>DD</sub>, in the servicing routine of the LVI interrupt by using bit 0 (LVIF) of the low-voltage detection register (LVIM). Clear bit 0 (LVIIF) of interrupt request flag register 0L (IF0L) to 0.
- (b) In a system where the supply voltage fluctuation period is long in the vicinity of the LVI detection voltage, wait for the supply voltage fluctuation period, confirm that "supply voltage (V<sub>DD</sub>) ≥ detection voltage (V<sub>LVI</sub>)" when detecting the falling edge of V<sub>DD</sub>, or "supply voltage (V<sub>DD</sub>) < detection voltage (V<sub>LVI</sub>)" when detecting the rising edge of V<sub>DD</sub>, using the LVIF flag, and clear the LVIIF flag to 0.
  - **Remark** If bit 2 (LVISEL) of the low voltage detection register (LVIM) is set to "1", the meanings of the above words change as follows.
    - Supply voltage (V<sub>DD</sub>)  $\rightarrow$  Input voltage from external input pin (EXLVI)
    - Detection voltage (VLVI)  $\rightarrow$  Detection voltage (VEXLVI = 1.21 V)





• If supply voltage fluctuation is 50 ms or less in vicinity of LVI detection voltage



**Note** A flowchart is shown on the next page.





Checking reset cause





## CHAPTER 25 OPTION BYTE

## 25.1 Functions of Option Bytes

The flash memory at 0080H to 0084H of the 78K0/Dx2 is an option byte area. When power is turned on or when the device is restarted from the reset status, the device automatically references the option bytes and sets specified functions. When using the product, be sure to set the following functions by using the option bytes.

When the boot swap operation is used during self-programming, 0080H to 0084H are switched to 1080H to 1084H. Therefore, set values that are the same as those of 0080H to 0084H to 1080H to 1084H in advance.

# Caution Be sure to set 00H to 0082H and 0083H (0082H/1082H and 0083H/1083H when the boot swap function is used).

#### (1) 0080H/1080H

- O Internal low-speed oscillator operation
  - Can be stopped by software
  - Cannot be stopped
- O Watchdog timer interval time setting
- O Watchdog timer counter operation
  - Enabled counter operation
  - Disabled counter operation
- O Watchdog timer window open period setting

# Caution Set a value that is the same as that of 0080H to 1080H because 0080H and 1080H are switched during the boot swap operation.

#### (2) 0081H/1081H

- O Selecting POC mode
  - During 2.7 V POC mode operation (LVISTART = 1)

The device is in the reset state upon power application and until the supply voltage reaches 2.7 V (TYP.). It is released from the reset state when the voltage exceeds 2.7 V (TYP.). After that, POC is detected at 2.7 V (TYP.), in the same manner as on power application.

- During LVI operation stop mode (LVISTART = 0) The LVI operation stops.
- Caution LVISTART can only be written by using a dedicated flash memory programmer. It cannot be set during self-programming or boot swap operation during self-programming (at this time, LVI operation stop mode (default) is set). However, because the value of 1081H is copied to 0081H during the boot swap operation, it is recommended to set a value that is the same as that of 0081H to 1081H when the boot swap function is used.



## (3) 0084H/1084H

O On-chip debug operation control

- Disabling on-chip debug operation
- Enabling on-chip debug operation and erasing data of the flash memory in case authentication of the onchip debug security ID fails
- Enabling on-chip debug operation and not erasing data of the flash memory even in case authentication of the on-chip debug security ID fails
- Caution To use the on-chip debug function, set 02H or 03H to 0084H. Set a value that is the same as that of 0084H to 1084H because 0084H and 1084H are switched during the boot operation.



## 25.2 Format of Option Byte

The format of the option byte is shown below.

#### Figure 25-1. Format of Option Byte (1/2)

Address: 0080H/1080H<sup>Note</sup>

7	6	5	4	3	2	1	0	
0	WINDOW1	WINDOW0	WDTON	WDCS2	WDCS1	WDCS0	LSROSC	
WINDOW1	WINDOW0	Watchdog timer window open period						
0	0	25%						
0	1	50%						
1	0	75%						
1	1	100%						

WDTON	Operation control of watchdog timer counter/illegal access detection
0	Counter operation disabled (counting stopped after reset), illegal access detection operation disabled
1	Counter operation enabled (counting started after reset), illegal access detection operation enabled

WDCS2	WDCS1	WDCS0	Watchdog timer overflow time
0	0	0	2 <sup>10</sup> /fosc (4.27 ms)
0	0	1	2 <sup>11</sup> /fosc (8.53 ms)
0	1	0	2 <sup>12</sup> /fosc (17.07 ms)
0	1	1	2 <sup>13</sup> /fosc (34.13 ms)
1	0	0	2 <sup>14</sup> /fosc (68.27 ms)
1	0	1	2 <sup>15</sup> /fosc (136.53 ms)
1	1	0	2 <sup>16</sup> /fosc (273.07 ms)
1	1	1	2 <sup>17</sup> /fosc (546.13 ms)

LSROSC	Internal low-speed oscillator operation
0	Can be stopped by software (stopped when 1 is written to bit 0 (LSRSTOP) of RCM register)
1	Cannot be stopped (not stopped even if 1 is written to LSRSTOP bit)

- **Note** Set a value that is the same as that of 0080H to 1080H because 0080H and 1080H are switched during the boot swap operation.
- Cautions 1. The combination of WDCS2 = WDCS1 = WDCS0 = 0 and WINDOW1 = WINDOW0 = 0 is prohibited.
  - 2. The watchdog timer continues its operation during self-programming and EEPROM emulation of the flash memory. During processing, the interrupt acknowledge time is delayed. Set the overflow time and window size taking this delay into consideration.
  - 3. If LSROSC = 0 (oscillation can be stopped by software), the count clock is not supplied to the watchdog timer in the HALT and STOP modes, regardless of the setting of bit 0 (LSRSTOP) of the internal oscillator mode register (RCM).
  - 4. Be sure to clear bit 7 to 0.

#### Remarks 1. fosc: Internal low-speed oscillation clock frequency

**2.** (): fosc = 264 kHz (MAX.)



## Figure 25-1. Format of Option Byte (2/2)

#### Address: 0081H/1081H<sup>Notes 1, 2</sup>

7	6	5	4	3	2	1	0		
0	0	0	0	0	0	0	LVISTART		
LVISTART	POC mode selection								
0	LVI operation stop mode (default)								
1	2.7 V POC mode								

- **Notes 1.** LVISTART can only be written by using a dedicated flash memory programmer. It cannot be set during self-programming or boot swap operation during self-programming (at this time, LVI operation stop mode (default) is set). However, because the value of 1081H is copied to 0081H during the boot swap operation, it is recommended to set a value that is the same as that of 0081H to 1081H when the boot swap function is used.
  - 2. To change the setting for the POC mode, set the value to 0081H again after batch erasure (chip erasure) of the flash memory. The setting cannot be changed after the memory of the specified block is erased.

#### Caution Be sure to clear bits 7 to 1 to "0".

Address: 0082H/1082H, 0083H/1083H<sup>Note</sup>

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0

**Note** Be sure to set 00H to 0082H and 0083H, as these addresses are reserved areas. Also set 00H to 1082H and 1083H because 0082H and 0083H are switched with 1082H and 1083H when the boot swap operation is used.

Address: 0084H/1084H<sup>Note</sup>

7	6	5	4	3	2	1	0
0	0	0	0	0	0	OCDEN1	OCDEN0

OCDEN1	OCDEN0	On-chip debug operation control
0	0	Operation disabled
0	1	Setting prohibited
1	0	Operation enabled. Does not erase data of the flash memory in case authentication of the on-chip debug security ID fails.
1	1	Operation enabled. Erases data of the flash memory in case authentication of the on-chip debug security ID fails.

**Note** To use the on-chip debug function, set 02H or 03H to 0084H. Set a value that is the same as that of 0084H to 1084H because 0084H and 1084H are switched during the boot swap operation.

Remark For the on-chip debug security ID, see CHAPTER 27 ON-CHIP DEBUG FUNCTION.



Γ

Here is an example of description of the software for setting the option bytes.

OPT	CSEG	AT 0080H	
OPTION:	DB	30H	; Enables watchdog timer operation (illegal access detection operation),
			; Window open period of watchdog timer: 50%,
			; Overflow time of watchdog timer: 210/fosc,
			; Internal low-speed oscillator can be stopped by software.
	DB	00H	; LVI operation stop mode
	DB	00H	; Reserved area
	DB	00H	; Reserved area
	DB	00H	; On-chip debug operation disabled

**Remark** Referencing of the option byte is performed during reset processing. For the reset processing timing, see **CHAPTER 21 RESET FUNCTION**.



## CHAPTER 26 FLASH MEMORY

The 78K0/Dx2 incorporates the flash memory to which a program can be written, erased, and overwritten while mounted on the board.

## 26.1 Internal Memory Size Switching Register

The internal memory capacity can be selected using the internal memory size switching register (IMS). IMS is set by an 8-bit memory manipulation instruction. Reset signal generation sets IMS to CFH.

```
Caution Be sure to set each product to the values shown in Table 26-1 after a reset release.
```

5

#### Figure 26-1. Format of Internal Memory Size Switching Register (IMS)

4

Address: FFF0H After reset: CFH R/W Symbol 7 6

IMS

RAM2	RAM1	RAM0	0	ROM3	ROM2	ROM1	ROM0
BAM2	RAM1	BAMO	Ir	ternal high-sr	heed BAM ca	nacity selectio	n

RAM2	RAM1	RAM0	Internal high-speed RAM capacity selection			
1	1	0	1024 bytes			
C	ther than abo	ve	Setting prohibited			

3

2

1

0

ROM3	ROM2	ROM1	ROM0	Internal ROM capacity selection
0	1	1	0	24 KB
1	0	0	0	32 KB
1	1	0	0	48 KB
1	1	1	1	60 KB
Other than above				Setting prohibited

# Caution To set the memory size, set IMS and then IXS. Set the memory size so that the internal ROM and internal expansion RAM areas do not overlap.

Table 26-1.	Internal Memory	/ Size Swi	itchina Rea	aister Settinas
	internal memor		torning neg	gister octaings

Fla	sh Memory Version	IMS Setting
78K0/DE2	78K0/DF2	
μPD78F0836	μPD78F0838, 78F0840, 78F0842	C6H
μPD78F0844	μPD78F0846, 78F0848	C8H
μPD78F0837	μPD78F0839, 78F0841, 78F0843	ССН
μPD78F0845	μPD78F0847, 78F0849	CFH



## 26.2 Internal Expansion RAM Size Switching Register

The internal expansion RAM capacity can be selected using the internal expansion RAM size switching register (IXS).

IXS is set by an 8-bit memory manipulation instruction.

Reset signal generation sets IXS to 0CH.

#### Caution Be sure to set each product to the values shown in Table 26-2 after a reset release.

#### Figure 26-2. Format of Internal Expansion RAM Size Switching Register (IXS)

Address: FFF4H After reset: 0CH R/W

Symbo

IXS

bl	7	6	5	4	3	2	1	0
	0	0	0	IXRAM4	IXRAM3	IXRAM2	IXRAM1	IXRAM0

IXRAM4	IXRAM3	IXRAM2	IXRAM1	IXRAM0	Internal expansion RAM capacity selection
0	1	0	1	0	1024 bytes
0	1	0	0	0	2048 bytes
	C	Other than abc	Setting prohibited		

# Caution To set memory size, set IMS and then IXS. Set memory size so that the internal ROM area and internal expansion RAM area do not overlap.

#### Table 26-2. Internal Expansion RAM Size Switching Register Settings

Fla	sh Memory Version	IXS Setting
78K0/DE2	78K0/DF2	
μPD78F0836	μPD78F0838, 78F0840, 78F0842	0AH
μPD78F0844	μPD78F0846, 78F0848	
μPD78F0837	μPD78F0839, 78F0841, 78F0843	08H
μPD78F0845	μPD78F0847, 78F0849	



## 26.3 Writing with Flash Memory Programmer

Data can be written to the flash memory on-board or off-board, by using a dedicated flash memory programmer.

## (1) On-board programming

The contents of the flash memory can be rewritten after the 78K0/Dx2 has been mounted on the target system. The connectors that connect the dedicated flash memory programmer must be mounted on the target system.

## (2) Off-board programming

Data can be written to the flash memory with a dedicated program adapter (FA series) before the 78K0/Dx2 is mounted on the target system.

Remark The FA series is a product of Naito Densei Machida Mfg. Co., Ltd.

## Table 26-3. Wiring between 78K0/Dx2 and Dedicated Flash Memory Programmer

Pin Configuration of Dedicated Flash Memory Programmer			With CSI10			With UART60		
Signal Name	I/O	Pin Function	Pin Name	Pin No.		Pin Name	Pin No.	
				DE2	DF2		DE2	DF2
SI/RxD	Input	Receive signal	SO10/P12/INTP2	62	25	TxD60/P13/SEG23/ TIOP30	19	31
SO/TxD	Output	Transmit signal	SI10/RxD61 <sup>Note 1</sup> / P11/INTPR61 <sup>Note 1</sup>	63	24	RxD60/P14/SEG22/ TIOP20/INTPR60	20	32
SCK	Output	Transfer clock	SCK10/TxD61 <sup>Note 1</sup> / P10/INTP4	64	23	-	-	-
CLK	Output	Clock to 78K0/Dx2	_Note 2	-	_	Note 3	No	te 3
/RESET	Output	Reset signal	RESET	8	12	RESET	8	12
FLMD0	Output	Mode signal	FLMD0	11	15	FLMD0	11	15
VDD	I/O	VDD voltage generation/	VDD/EVDD	16	20	VDD/EVDD	16	20
		power monitoring	AVREF	47	59	AVREF	47	59
GND	_	Ground	Vss/EVss	15	19	Vss/EVss	15	19
			AVss	48	60	AVss	48	60

Notes 1. 78K0/DF2 only.

2. Only the internal high-speed oscillation clock (fosc8) can be used when CSI10 is used.

3. Only the X1 clock (fx) or external main system clock (fEXT) can be used when UART60 is used. When using the clock output of the dedicated flash memory programmer, pin connection varies depending on the type of the dedicated flash memory programmer used.

• PG-FP5, FL-PR5: Connect CLK of the programmer to EXCLK/X2/P122/OCD0B.

Caution The flash memory writings with pins No.10 and No.11 (UART60), pins No. 23 and No. 24 (UART61) in 78K0/DF2 are unsupported.



Examples of the recommended connection when using the adapter for flash memory writing are shown below.

## Figure 26-3. Example of Wiring Adapter for Flash Memory Writing in 3-Wire Serial I/O (CSI10) Mode







#### Figure 26-4. Example of Wiring Adapter for Flash Memory Writing in UART (UART60) Mode





## 26.4 Programming Environment

The environment required for writing a program to the flash memory of the 78K0/Dx2 is illustrated below.

## Figure 26-5. Environment for Writing Program to Flash Memory



A host machine that controls the dedicated flash memory programmer is necessary.

Either CSI10 or a UART60 interface can optionally be used for the communication between the dedicated flash programmer and the microcontroller. To write the flash memory off-board, a dedicated program adapter (FA series) is necessary.

## 26.5 Communication Mode

Communication between the dedicated flash memory programmer and the 78K0/Dx2 is established by serial communication via CSI10 or UART60 of the 78K0/Dx2.

## (1) CSI10

Transfer rate: 2.4 kHz to 2.5 MHz







## (2) UART60

Transfer rate: 115200 bps



#### Figure 26-7. Communication with Dedicated Flash Memory Programmer (UART60)

Note The above figure illustrates an example of wiring when using the clock output from the PG-FP5 or FL-PR5.

The dedicated flash memory programmer generates the following signals for the 78K0/Dx2. For details, refer to the user's manual for the PG-FP5 or FL-PR5.

	Dedica	78K0/Dx2	Conn	ection	
Signal Name	I/O	Pin Function	Pin Name	CSI10	UART60
FLMD0	Output	Mode signal	FLMD0	O	O
VDD	I/O	VDD voltage generation/power monitoring	VDD, EVDD, AVREF	0	O
GND	-	Ground	Vss, EVss, AVss	O	O
CLK	Output	Clock output to 78K0/Dx2	Note 1	× <sup>Note 2</sup>	O <sup>Note 1</sup>
/RESET	Output	Reset signal	RESET	0	O
SI/RxD	Input	Receive signal	SO10/TxD60	0	O
SO/TxD	Output	Transmit signal	SI10/RxD60	0	0
SCK	Output	Transfer clock	SCK10	O	×

## Table 26-4. Pin Connection

**Notes 1.** Only the X1 clock (fx) or external main system clock (fEXT) can be used when UART60 is used. When using the clock output of the dedicated flash memory programmer, pin connection varies depending on the type of the dedicated flash memory programmer used.

• PG-FP5, FL-PR5: Connect CLK of the programmer to EXCLK/X2/P122/OCD0B.

2. Only the internal high-speed oscillation clock (fosca) can be used when CSI10 is used.

**Remark**  $\bigcirc$ : Be sure to connect the pin.

- O: The pin does not have to be connected if the signal is generated on the target board.
- $\times\!\!:$  The pin does not have to be connected.



## 26.6 Connection of Pins on Board

To write the flash memory on-board, connectors that connect the dedicated flash memory programmer must be provided on the target system. First provide a function that selects the normal operation mode or flash memory programming mode on the board.

When the flash memory programming mode is set, all the pins not used for programming the flash memory are in the same status as immediately after reset. Therefore, if the external device does not recognize the state immediately after reset, the pins must be handled as described below.

## 26.6.1 FLMD0 pin

In the normal operation mode, 0 V is input to the FLMD0 pin. In the flash memory programming mode, the  $V_{DD}$  write voltage is supplied to the FLMD0 pin. An FLMD0 pin connection example is shown below.



## Figure 26-8. FLMD0 Pin Connection Example

#### 26.6.2 Serial interface pins

The pins used by each serial interface are listed below.

#### Table 26-5. Pins Used by Each Serial Interface

Serial Interface	Pins Used		
CSI10	SO10, SI10, SCK10		
UART60	TxD60, RxD60		

To connect the dedicated flash memory programmer to the pins of a serial interface that is connected to another device on the board, care must be exercised so that signals do not collide or that the other device does not malfunction.



## (1) Signal collision

If the dedicated flash memory programmer (output) is connected to a pin (input) of a serial interface connected to another device (output), signal collision takes place. To avoid this collision, either isolate the connection with the other device, or make the other device go into an output high-impedance state.





In the flash memory programming mode, the signal output by the device collides with the signal sent from the dedicated flash memory programmer. Therefore, isolate the signal of the other device.

## (2) Malfunction of other device

If the dedicated flash memory programmer (output or input) is connected to a pin (input or output) of a serial interface connected to another device (input), a signal may be output to the other device, causing the device to malfunction. To avoid this malfunction, isolate the connection with the other device.





If the signal output by the 78K0/Dx2 in the flash memory programming mode affects the other device, isolate the signal of the other device.



If the signal output by the dedicated flash memory programmer in the flash memory programming mode affects the other device, isolate the signal of the other device.



#### 26.6.3 RESET pin

If the reset signal of the dedicated flash memory programmer is connected to the RESET pin that is connected to the reset signal generator on the board, signal collision takes place. To prevent this collision, isolate the connection with the reset signal generator.

If the reset signal is input from the user system while the flash memory programming mode is set, the flash memory will not be correctly programmed. Do not input any signal other than the reset signal of the dedicated flash memory programmer.

Figure 26-11. Signal Collision (RESET Pin)



In the flash memory programming mode, the signal output by the reset signal generator collides with the signal output by the dedicated flash memory programmer. Therefore, isolate the signal of the reset signal generator.

#### 26.6.4 Port pins

When the flash memory programming mode is set, all the pins not used for flash memory programming enter the same status as that immediately after reset. If external devices connected to the ports do not recognize the port status immediately after reset, the port pin must be connected to VDD or VSS via a resistor.

#### 26.6.5 REGC pin

Connect the REGC pin to GND via a capacitor (0.47 to 1  $\mu$ F: recommended) in the same manner as during normal operation.

#### 26.6.6 Other signal pins

Connect X1 and X2 in the same status as in the normal operation mode when using the on-board clock. To input the operating clock from the dedicated flash memory programmer, however, connect as follows.

• PG-FP5, FL-PR5: Connect CLK of the programmer to EXCLK/X2/P122/OCD0B.

Cautions 1. Only the internal high-speed oscillation clock (fosca) can be used when CSI10 is used.

- 2. Only the X1 clock (fx) or external main system clock (fEXT) can be used when UART60 is used.
- 3. Connect P121/X1/OCD0A as follows when writing the flash memory with a flash memory programmer.
  - P121/X1/OCD0A: When using this pin as a port, connect it to Vss via a resistor (10 k $\Omega$ : recommended) (in the input mode) or leave it open (in the output mode).

The above connection is not necessary when writing the flash memory by means of self programming.

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## 26.6.7 Power supply

To use the supply voltage output of the flash memory programmer, connect the V<sub>DD</sub> pin to V<sub>DD</sub> of the flash memory programmer, and the V<sub>SS</sub> pin to GND of the flash memory programmer.

To use the on-board supply voltage, connect in compliance with the normal operation mode.

However, be sure to connect the  $V_{DD}$  and  $V_{SS}$  pins to  $V_{DD}$  and GND of the flash memory programmer to use the power monitor function with the flash memory programmer, even when using the on-board supply voltage.

Supply the same other power supplies (EVDD, EVSS, AVREF, and AVSS) as those in the normal operation mode.



## 26.7 Programming Method

#### 26.7.1 Controlling flash memory

The following figure illustrates the procedure to manipulate the flash memory.



#### Figure 26-12. Flash Memory Manipulation Procedure

#### 26.7.2 Flash memory programming mode

To rewrite the contents of the flash memory by using the dedicated flash memory programmer, set the 78K0/Dx2 in the flash memory programming mode. To set the mode, set the FLMD0 pin to VDD and clear the reset signal.

Change the mode by using a jumper when writing the flash memory on-board.





#### Table 26-6. Relationship between FLMD0 Pin and Operation Mode after Reset Release

FLMD0	Operation Mode	
0	Normal operation mode	
VDD	Flash memory programming mode	



## 26.7.3 Selecting communication mode

In the 78K0/Dx2, a communication mode is selected by inputting pulses (up to 8 pulses) to the FLMD0 pin after the dedicated flash memory programming mode is entered. These FLMD0 pulses are generated by the flash memory programmer.

The following table shows the relationship between the number of pulses and communication modes.

Communication		Standard Settir	ng <sup>Note 1</sup>		Pins Used	Peripheral	Number of
Mode	Port	Speed	Frequency	Multiply Rate		Clock	FLMD0 Pulses
UART	UART-Ext-Osc	115200 bps <sup>Note 2</sup>	2 to 20 MHz <sup>Note 3</sup>	1.0	TxD60,	fx	0
(UART60)	UART-Ext-FP5CK				RxD60	fext	3
3-wire serial I/O (CSI10)	CSI-Internal-Osc	2.4 kHz to 2.5 MHz	-		SO10, SI10, SCK10	fosca	8

#### Table 26-7. Communication Modes

Notes 1. Selection items for Standard settings on GUI of the flash memory programmer.

**2.** Because factors other than the baud rate error, such as the signal waveform slew, also affect UART communication, thoroughly evaluate the slew as well as the baud rate error.

**3.** The possible setting range differs depending on the voltage. For details, refer to the chapter of electrical specifications.

# Caution When UART60 is selected, the receive clock is calculated based on the reset command sent from the dedicated flash memory programmer after the FLMD0 pulse has been received.

Remark fx: X1 clock

fEXT: External main system clock

fosca: Internal high-speed oscillation clock



## 26.7.4 Communication commands

The 78K0/Dx2 communicates with the dedicated flash memory programmer by using commands. The signals sent from the flash memory programmer to the 78K0/Dx2 are called commands, and the signals sent from the 78K0/Dx2 to the dedicated flash memory programmer are called response.

Figure 26-14. Communication Commands



Dedicated flash memory programmer

The flash memory control commands of the 78K0/Dx2 are listed in the table below. All these commands are issued from the programmer and the 78K0/Dx2 perform processing corresponding to the respective commands.

Classification	Command Name	Function
Verify	Verify	Compares the contents of a specified area of the flash memory with data transmitted from the programmer.
Erase	Chip Erase	Erases the entire flash memory.
	Block Erase	Erases a specified area in the flash memory.
Blank check	Block Blank Check	Checks if a specified block in the flash memory has been correctly erased.
Write	Programming	Writes data to a specified area in the flash memory.
Getting information	Status	Gets the current operating status (status data).
	Silicon Signature	Gets 78K0/Dx2 information (such as the part number and flash memory configuration).
	Version Get	Gets the 78K0/Dx2 version and firmware version.
	Checksum	Gets the checksum data for a specified area.
Security	Security Set	Sets security information.
Others	Reset	Used to detect synchronization status of communication.
	Oscillating Frequency Set	Specifies an oscillation frequency.

The 78K0/Dx2 return a response for the command issued by the dedicated flash memory programmer. The response names sent from the 78K0/Dx2 are listed below.

#### Table 26-9. Response Names

Command Name	Function
ACK	Acknowledges command/data.
NAK	Acknowledges illegal command/data.



## 78K0/Dx2

## 26.8 Security Settings

The 78K0/Dx2 supports a security function that prohibits rewriting the user program written to the internal flash memory, so that the program cannot be changed by an unauthorized person.

The operations shown below can be performed using the security set command. The security setting is valid when the programming mode is set next.

• Disabling batch erase (chip erase)

Execution of the block erase and batch erase (chip erase) commands for entire blocks in the flash memory is prohibited by this setting during on-board/off-board programming. Once execution of the batch erase (chip erase) command is prohibited, all of the prohibition settings (including prohibition of batch erase (chip erase)) can no longer be cancelled.

## Caution After the security setting for the batch erase is set, erasure cannot be performed for the device. In addition, even if a write command is executed, data different from that which has already been written to the flash memory cannot be written, because the erase command is disabled.

#### • Disabling block erase

Execution of the block erase command for a specific block in the flash memory is prohibited during on-board/offboard programming. However, blocks can be erased by means of self programming.

• Disabling write

Execution of the write and block erase commands for entire blocks in the flash memory is prohibited during onboard/off-board programming. However, blocks can be written by means of self programming.

• Disabling rewriting boot cluster 0

Execution of the batch erase (chip erase) command, block erase command, and write command on boot cluster 0 (0000H to 0FFFH) in the flash memory is prohibited by this setting.

# Caution If a security setting that rewrites boot cluster 0 has been applied, boot cluster 0 of that device will not be rewritten.

The batch erase (chip erase), block erase, write commands, and rewriting boot cluster 0 are enabled by the default setting when the flash memory is shipped. Security can be set by on-board/off-board programming and self programming. Each security setting can be used in combination.

Prohibition of erasing blocks and writing is cleared by executing the batch erase (chip erase) command.

**Table 26-10** shows the relationship between the erase and write commands when the 78K0/Dx2 security function is enabled.



## Table 26-10. Relationship Between Enabling Security Function and Command

## (1) During on-board/off-board programming

Valid Security	Executed Command		
	Batch Erase (Chip Erase)	Block Erase	Write
Prohibition of batch erase (chip erase)	Cannot be erased in batch	Blocks cannot be	Can be performed <sup>Note</sup> .
Prohibition of block erase	Can be erased in batch.	erased.	Can be performed.
Prohibition of writing			Cannot be performed.
Prohibition of rewriting boot cluster 0	Cannot be erased in batch	Boot cluster 0 cannot be erased.	Boot cluster 0 cannot be written.

**Note** Confirm that no data has been written to the write area. Because data cannot be erased after batch erase (chip erase) is prohibited, do not write data if the data has not been erased.

## (2) During self programming

Valid Security	Executed Command	
	Block Erase	Write
Prohibition of batch erase (chip erase)	Blocks can be erased.	Can be performed.
Prohibition of block erase		
Prohibition of writing		
Prohibition of rewriting boot cluster 0	Boot cluster 0 cannot be erased.	Boot cluster 0 cannot be written.

Table 26-11 shows how to perform security settings in each programming mode.

## Table 26-11. Setting Security in Each Programming Mode

#### (1) On-board/off-board programming

Security	Security Setting	How to Disable Security Setting
Prohibition of batch erase (chip erase)	Set via GUI of dedicated flash memory	Cannot be disabled after set.
Prohibition of block erase	programmer, etc.	Execute batch erase (chip erase)
Prohibition of writing		command
Prohibition of rewriting boot cluster 0		Cannot be disabled after set.

#### (2) Self programming

Security	Security Setting	How to Disable Security Setting
Prohibition of batch erase (chip erase)	Set by using information library.	Cannot be disabled after set.
Prohibition of block erase		Execute batch erase (chip erase)
Prohibition of writing		command during on-board/off-board programming (cannot be disabled during self programming)
Prohibition of rewriting boot cluster 0		Cannot be disabled after set.



## 26.9 Processing Time for Each Command When PG-FP5 Is Used (Reference)

The following table shows the processing time for each command (reference) when the PG-FP5 is used as a dedicated flash memory programmer.

## Table 26-12. Processing Time for Each Command When PG-FP5 Is Used (Reference)

## • μPD78F0849 (internal ROM capacity: 60 KB)

Command of	Port: CSI-Internal-OSC	Port: UART-Ext-FP5CK (Exter	rnal main system clock (fext)),
PG-FP5	(Internal high-speed	Speed: 11	5,200 bps
oscillation clock (fosca)), Speed: 2.5 MHz	Frequency: 2.0 MHz	Frequency: 20 MHz	
Signature	0.5 s (TYP.)	0.5 s (TYP.)	0.5 s (TYP.)
Blankcheck	1 s (TYP.)	1 s (TYP.)	1 s (TYP.)
Erase	1 s (TYP.)	1 s (TYP.)	1 s (TYP.)
Program	5 s (TYP.)	9 s (TYP.)	9 s (TYP.)
Verify	2 s (TYP.)	6.5 s (TYP.)	6.5 s (TYP.)
E.P.V	6 s (TYP.)	10.5 s (TYP.)	10.5 s (TYP.)
Checksum	0.5 s (TYP.)	1 s (TYP.)	1 s (TYP.)
Security	0.5 s (TYP.)	0.5 s (TYP.)	0.5 s (TYP.)

Caution When executing boot swapping, do not use the E.P.V. command with the dedicated flash memory programmer.



## 26.10 Flash Memory Programming by Self-Programming

The 78K0/Dx2 supports a self-programming function that can be used to rewrite the flash memory via a user program. Because this function allows a user application to rewrite the flash memory by using the 78K0/Dx2 self-programming library, it can be used to upgrade the program in the field.

If an interrupt occurs during self-programming, self-programming can be temporarily stopped and interrupt servicing can be executed. To execute interrupt servicing, restore the normal operation mode after self-programming has been stopped, and execute the EI instruction. After the self-programming mode is later restored, self-programming can be resumed.

- **Remark** For details of the self-programming function and the 78K0/Dx2 self-programming library, refer to a separate document to be published (document name: 78K0/Dx2 Application Note, release schedule: Pending).
- Cautions 1. The self-programming function cannot be used when the CPU operates with the subsystem clock.
  - 2. Input a high level to the FLMD0 pin during self-programming.
  - Be sure to execute the DI instruction before starting self-programming. The self-programming function checks the interrupt request flags (IF0L, IF0H, IF1L, and IF1H). If an interrupt request is generated, self-programming is stopped.
  - 4. Self-programming is also stopped by an interrupt request that is not masked even in the DI status. To prevent this, mask the interrupt by using the interrupt mask flag registers (MK0L, MK0H, MK1L, and MK1H).
  - 5. Self-programming is executed with the internal high-speed oscillation clock. If the CPU operates with the X1 clock or external main system clock, the oscillation stabilization wait time of the internal high-speed oscillation clock elapses during self-programming.

(Caution 6 is listed on the next page.)



## Cautions 6. Allocate the entry program for self-programming in the common area of 0000H to 7FFFH.



#### Figure 26-15. Operation Mode and Memory Map for Self-Programming (µPD78F0849)



The following figure illustrates a flow of rewriting the flash memory by using a self programming library.






The following table shows the processing time and interrupt response time for the self programming library.

## Table 26-13. Processing Time for Self Programming Library (1/3)

# (1) When internal high-speed oscillation clock is used and entry RAM is located outside short direct addressing range

Librar	y Name	Processing Time (µs)				
		Normal Model	of C Compiler	Static Model of C Compiler/Assembler		
		Min.	Max.	Min.	Max.	
Self programming start li	brary		4.:	25		
Initialize library			977	.75		
Mode check library		753	.875	753	.125	
Block blank check library	,	1277	0.875	12765.875		
Block erase library		36909.5	356318	36904.5	356296.25	
Word write library		1214 (1214.375) 2409 (2409.375)		1207 (1207.375)	2402 (2402.375)	
Block verify library		2561	8.875	25613.875		
Self programming end lik	orary	4.25				
Get information library	Option value: 03H	871.25 (	871.375)	866 (86	66.125)	
	Option value: 04H	863.375 (863.5)		858.125 (858.25)		
	Option value: 05H	1024.75 (	1043.625)	1037.5 (1038.375)		
Set information library		105524.75	790809.375	105523.75	790808.375	
EEPROM write library		1496.5 (1496.875)	2691.5 (2691.875)	1489.5 (1489.875)	2684.5 (2684.875)	

## (2) When internal high-speed oscillation clock is used and entry RAM is located in short direct addressing range

Librar	y Name		Processing	j Time (μs)			
		Normal Model	of C Compiler	Static Model of C Compiler/Assembler			
		Min.	Max.	Min.	Max.		
Self programming start li	brary		4.	25			
Initialize library			44	3.5			
Mode check library		219	.625	218	.875		
Block blank check library	1	1223	6.625	1223	1.625		
Block erase library		36363.25	355771.75	36358.25	355750		
Word write library		679.75	1874.75	672.75	1867.75		
		(680.125)	(1875.125)	(673.125)	(1868.125)		
Block verify library		2507	2.625	25067.625			
Self programming end lit	orary	4.25					
Get information library	Option value: 03H	337 (33	37.125)	331.75 (331.875)			
	Option value: 04H	329.125	329.125 (239.25)		5 (324)		
	Option value: 05H 502.25 (503.125)		503.125)	497 (497.875)			
Set information library		104978.5	541143.125	104977.5	541142.125		
EEPROM write library		962.25	2157.25	955.25	2150.25		
		(962.625)	(2157.625)	(955.625)	(2150.625)		

## **Remarks 1.** Values in parentheses indicate values when a write start address structure is located other than in the internal high-speed RAM.

- The above processing times are those during stabilized operation of the internal high-speed oscillator (RSTS = 1).
- 3. RSTS: Bit 7 of the internal oscillation mode register (RCM)

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### Table 26-13. Processing Time for Self Programming Library (2/3)

# (3) When high-speed system clock (X1 oscillation or external clock input) is used and entry RAM is located outside short direct addressing range

Library	/ Name	Processing Time ( $\mu$ s)					
		Normal Model	of C Compiler	Static Model of C Compiler/Assembler			
		Min.	Max.	Min.	Max.		
Self programming start I	ibrary		34/	fcpu			
Initialize library			49/fcpu +	485.8125			
Mode check library		<b>35/f</b> срин	+ 374.75	<b>29/f</b> сри н	+ 374.75		
Block blank check library	/	<b>174/f</b> сри +	6382.0625	<b>134/f</b> сри +	6382.0625		
Block erase library		174/fсри + 31093.875	174/fcpu + 298948.125	134/fcpu + 31093.875	134/fcpu + 298948.125		
Word write library		318 (321)/fcթu + 644.125	318 (321)/fcթu + 1491.625	262 (265)/fcpu + 644.125	262 (265)/fcթu + 1491.625		
Block verify library		174/fcpu + 13448.5625 134/fcpu + 13448.5625					
Self programming end lil	orary	34/fcpu					
Get information library	Option value: 03H	171 (172 )/fcr	⊳u + 432.4375	129 (130)/fcpu + 432.4375			
	Option value: 04H	181 (182)/fcpu + 427.875		139 (140)/fcpu + 427.875			
	Option value: 05H	404 (411)/fc	ри + 496.125	<b>362 (369)/f</b> c	ри + 496.125		
Set information library		75/fcpu + 79157.6875	75/fcpu + 652400	67fсри + 79157.6875	67fсри + 652400		
EEPROM write library		318 (321)/fсри + 799.875	318 (321)/fcթu + 1647.375	262 (265)/fсри + 799.875	262 (265)/fcpu + 1647.375		

- **Remarks 1.** Values in parentheses indicate values when a write start address structure is located other than in the internal high-speed RAM.
  - 2. The above processing times are those during stabilized operation of the internal high-speed oscillator (RSTS = 1).
  - 3. fcpu: CPU operation clock frequency
  - 4. RSTS: Bit 7 of the internal oscillation mode register (RCM)



#### Table 26-13. Processing Time for Self Programming Library (3/3)

## (4) When high-speed system clock (X1 oscillation or external clock input) is used and entry RAM is located in short direct addressing range

Library	/ Name	Processing Time (µs)					
		Normal Model	of C Compiler	Static Model of C Compiler/Assembler			
		Min.	Max.	Min.	Max.		
Self programming start I	ibrary		34/	fcpu			
Initialize library			49/fcpu +	224.6875			
Mode check library		<b>35/f</b> сри +	113.625	<b>29/f</b> сри +	113.625		
Block blank check library	/	174/fcpu +	6120.9375	134/fcpu +	6120.9375		
Block erase library		174/fcpu + 30820.75	174/fcpu + 298675	134/fcpu + 30820.75	134/fсеџ + 298675		
Word write library		318 (321)/fcpu + 383	318 (321)/fcթu + 1230.5	262 (265)/fcpu + 383	262 (265)/fcpu + 1230.5		
Block verify library		174/fcpu + 13175.4375 134/fcpu + 13175.4375			13175.4375		
Self programming end lil	brary	34/fcpu					
Get information library	Option value: 03H	171 (172)/fcr	vu + 171.3125	129 (130)/fcpu + 171.3125			
	Option value: 04H	181 (182)/fcpu + 166.75		139 (140)/fcpu + 166.75			
	Option value: 05H	404 (411)/fc	ри + 231.875	362 (369)/fcpu + 231.875			
Set information library		75/fcpu + 78884.5625	75/fcpu + 527566.875	67fсри + 78884.5625	67fсрu + 527566.875		
EEPROM write library		318 (321)/fcpu + 538.75	318 (321)/fcpu + 1386.25	262 (265)/fсри + 538.75	262 (265)/fсри + 1386.25		

- **Remarks 1.** Values in parentheses indicate values when a write start address structure is located other than in the internal high-speed RAM.
  - 2. The above processing times are those during stabilized operation of the internal high-speed oscillator (RSTS = 1).
  - 3. fcpu: CPU operation clock frequency
  - 4. RSTS: Bit 7 of the internal oscillation mode register (RCM)



## Table 26-14. Interrupt Response Time for Self Programming Library (1/2)

Library Name		Interrupt Respons	e Time (μs (Max.))			
	Normal Model of C Compiler		Static Model of C Cor	Static Model of C Compiler/Assembler		
	Entry RAM location is outside short direct addressing range	Entry RAM location is in short direct addressing range	Entry RAM location is outside short direct addressing range	Entry RAM location is in short direct addressing range		
Block blank check library	933.6	668.6	927.9	662.9		
Block erase library	1026.6	763.6	1020.9	757.9		
Word write library	2505.8	1942.8	2497.8	1934.8		
Block verify library	958.6	693.6	952.9	687.9		
Set information library	476.5	211.5	475.5	210.5		
EEPROM write library	2760.8	2168.8	2759.5	2167.5		

#### (1) When internal high-speed oscillation clock is used

- **Remarks 1.** The above interrupt response times are those during stabilized operation of the internal high-speed oscillator (RSTS = 1).
  - 2. RSTS: Bit 7 of the internal oscillation mode register (RCM)

#### (2) When high-speed system clock is used (normal model of C compiler)

Library Name	Interrupt Response Time (µs (Max.))				
	RSTOP = 0, RSTS = 1		RSTOP = 1		
	Entry RAM location is outside short direct addressing range	Entry RAM location is in short direct addressing range	Entry RAM location is outside short direct addressing range	Entry RAM location is in short direct addressing range	
Block blank check library	179/fcpu + 507	179/fcpu + 407	179/fcpu + 1650	179/fcpu + 714	
Block erase library	179/fcpu + 559	179/fcpu + 460	179/fcpu + 1702	179/fcpu + 767	
Word write library	333/fcpu + 1589	333/fcpu + 1298	333/fcpu + 2732	333/fcpu + 1605	
Block verify library	179/fcpu + 518	179/fcpu + 418	179/fcpu + 1661	179/fcpu + 725	
Set information library	80/fcpu + 370	80/fcpu + 165	80/fcpu + 1513	80/fcpu + 472	
EEPROM write library <sup>Note</sup>	29/fcpu + 1759	29/fсрu + 1468	29/fсри + 1759	29/fcpu + 1468	
	333/fcpu + 834	333/fcpu + 512	333/fcpu + 2061	333/fcpu + 873	

- **Note** The longer value of the EEPROM write library interrupt response time becomes the Max. value, depending on the value of fcPu.
- Remarks 1. fcpu: CPU operation clock frequency
  - 2. RSTOP: Bit 0 of the internal oscillation mode register (RCM)
  - 3. RSTS: Bit 7 of the internal oscillation mode register (RCM)



## Table 26-14. Interrupt Response Time for Self Programming Library (2/2)

Library Name	Interrupt Response Time (µs (Max.))					
	RSTOP = 0, RSTS = 1		RSTOP = 1			
	Entry RAM location is outside short direct addressing range	Entry RAM location is in short direct addressing range	Entry RAM location is outside short direct addressing range	Entry RAM location is in short direct addressing range		
Block blank check library	136/fcpu + 507	136/fcpu + 407	136/fcpu + 1650	136/fcpu + 714		
Block erase library	136/fcpu + 559	136/fcpu + 460	136/fcpu + 1702	136/fcpu + 767		
Word write library	272/fcpu + 1589	272/fcpu + 1298	272/fcpu + 2732	272/fcpu + 1605		
Block verify library	136/fcpu + 518	136/fcpu + 418	136/fcpu + 1661	136/fcpu + 725		
Set information library	72/fcpu + 370	72/fcpu + 165	72/fcpu + 1513	72/fcpu + 472		
EEPROM write library <sup>Note</sup>	19/fсрџ + 1759	19/fсри + 1468	19/fсрџ + 1759	19/fсрџ + 1468		
	268/fcpu + 834	268/fcpu + 512	268/fcpu + 2061	268/fcpu + 873		

#### (3) When high-speed system clock is used (static model of C compiler/assembler)

**Note** The longer value of the EEPROM write library interrupt response time becomes the Max. value, depending on the value of fcpu.

#### Remarks 1. fcpu: CPU operation clock frequency

- 2. RSTOP: Bit 0 of the internal oscillation mode register (RCM)
- 3. RSTS: Bit 7 of the internal oscillation mode register (RCM)



## 26.11 Boot Swap Function

If rewriting the boot area has failed during self-programming due to a power failure or some other cause, the data in the boot area may be lost and the program may not be restarted by resetting.

The boot swap function is used to avoid this problem.

Before erasing boot cluster 0<sup>Note</sup>, which is a boot program area, by self-programming, write a new boot program to boot cluster 1 in advance. When the program has been correctly written to boot cluster 1, swap this boot cluster 1 and boot cluster 0 by using the set information function of the firmware of the 78K0/Dx2, so that boot cluster 1 is used as a boot area. After that, erase or write the original boot program area, boot cluster 0.

As a result, even if a power failure occurs while the boot programming area is being rewritten, the program is executed correctly because it is booted from boot cluster 1 to be swapped when the program is reset and started next.

If the program has been correctly written to boot cluster 0, restore the original boot area by using the set information function of the firmware of the 78K0/Dx2.

**Note** A boot cluster is a 4 KB area and boot clusters 0 and 1 are swapped by the boot swap function.

Boot cluster 0 (0000H to 0FFFH): Original boot program area Boot cluster 1 (1000H to 1FFFH): Area subject to boot swap function

## Caution When executing boot swapping, do not use the E.P.V command with the dedicated flash memory programmer.





Remark Boot cluster 1 becomes 0000H to 0FFFH when a reset is generated after the boot flag has been set.

RENESAS





Booted by boot cluster 0



## 26.12 Creating ROM Code to Place Order for Programmed Flash Product

Before placing an order with Renesas Electronics for a previously written product, the ROM code for the order must be created.

To create the ROM code, use the Hex Consolidation Utility (hereafter abbreviated to HCU) on the finished programs (hex files) and optional data (such as security settings for flash memory programs).

The HCU is a software to generate a ROM code that is necessary for ordering the flash product programmed by Renesas Electronics.

The HCU can be downloaded at the Renesas Electronics website.

#### (1) Website

 $\texttt{http://www.necel.com/micro/en/ods} \rightarrow \texttt{Click Version-up Service}.$ 

#### (2) Downloading the HCU

To download the HCU software, click Programmed\_Flash\_Products\_Software and then HCU\_GUI.

**Remark** For details about how to install and use the HCU, see the materials (the user's manual) that comes with the HCU at the above website.

#### 26.12.1 Procedures for ROM code ordering process using HCU

Use the HCU to create the ROM code by following the procedure below, and then place your order with Renesas Electronics. For details, see the ROM Code Ordering Method Information (C10302J).





## CHAPTER 27 ON-CHIP DEBUG FUNCTION

#### 27.1 Outline of Functions

The 78K0/Dx2 uses the V<sub>DD</sub>, FLMD0, RESET, X1 (or P31), X2 (or P32), and V<sub>ss</sub> pins to communicate with the host machine via an on-chip debug emulator (QB-MINI2). Whether X1 and P31, or X2 and P32 are used can be selected.

Caution The 78K0/Dx2 has an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.



#### 78K0/Dx2

## 27.2 Connection with QB-MINI2

In order to connect QB-MINI2, it is necessary to mount the connector for emulator connection, and the circuit for connection on a target system.

The connector for OCD (a two-row 2.54 pitch type connector, with reverse-insertion blocker) is described below.

 Recommended connectors: (straight) HIF3FC-10PA-2.54DSA (manufactured by Hirose Electric Co., Ltd.) (right angle) HIF3FC-10PA-2.54DS (manufactured by Hirose Electric Co., Ltd.))

Pin No.	Name	IN/OUT	Remark
1	RESET_IN	IN	Target reset input signal
2	RESET_OUT	OUT	Reset signal output to target device
3	FLMD0	OUT	Output signal <sup>Note</sup> used to control on-chip debugging functions
4	Vdd_IN	IN	This signal is used to generate an interface output signal when the target system's $V_{\text{DD}}$ is detected.
5	X2	IN/OUT	Bidirectional signal used for data communications
6	GND	-	Connected to GND.
7	X1	OUT	Output signal used for clock supply
8	GND	-	Connected to GND.
9	RESERVED	-	Open
10	RESERVED	_	Open

**Note** FLMD0 is at high level during on-chip debugging.

Figure 27-1. Connector Pin Layout





## 27.3 Connection Circuit Examples

The following are examples of circuits required when connecting the QB-MINI2 to the target system.



Figure 27-2. Connection Example of QB-MINI2 and 78K0/Dx2 (When X1 and X2 Are Used)

- **Notes 1.** This connection is designed assuming that the reset signal is output from the N-ch open-drain buffer (output resistance:  $100 \Omega$  or less). For details, refer to **QB-MINI2 User's Manual (U18371E)**.
  - **2.** Make pull-down resistor 470  $\Omega$  or more (10 k $\Omega$ : recommended).
- Cautions 1. Input the clock from the X1 pin during on-chip debugging.
  - 2. Control the X1 and X2 pins by externally pulling down the P31 pin.





## Figure 27-3. Connection Example of QB-MINI2 and 78K0/Dx2 (When P31 and P32 Are Used)

- **Notes 1.** This connection is designed assuming that the reset signal is output from the N-ch open-drain buffer (output resistance: 100  $\Omega$  or less). For details, refer to **QB-MINI2 User's Manual (U18371E)**.
  - 2. This is the processing of the pin when P32 is set as the input port (to prevent the pin from being left opened when not connected to QB-MINI2).
  - **3.** Make pull-down resistor 470  $\Omega$  or more (10 k $\Omega$ : recommended).

Connect the FLMD0 pin as follows when performing self programming by means of on-chip debugging.

#### Figure 27-4. Connection of FLMD0 Pin for Self Programming by Means of On-Chip Debugging





## 27.4 Reserved Area Used by QB-MINI2

QB-MINI2 uses the reserved areas shown in **Figure 27-5** below to implement communication with the 78K0/Dx2, or each debug function. The shaded reserved areas are used for the respective debug functions to be used, and the other areas are always used for debugging. These reserved areas can be secured by using user programs and compiler options.

When using a boot swap operation during self programming, set the same value to boot cluster 1 beforehand. For details on reserved area, refer to **QB-MINI2 User's Manual (U18371E)**.



#### Figure 27-5. Reserved Area Used by QB-MINI2

 Remark
 Shaded reserved areas:
 Area used for the respective debug functions to be used

 Other reserved areas:
 Areas always used for debugging



#### 27.5 On-Chip Debug Security ID

The 78K0/Dx2 has an on-chip debug operation control flag in the flash memory at 0084H (see **CHAPTER 25 OPTION BYTE**) and an on-chip debug security ID setting area at 0085H to 008EH.

When the boot swap function is used, also set a value that is the same as that of 1084H and 1085H to 108EH in advance, because 0084H, 0085H to 008EH and 1084H, and 1085H to 108EH are switched.

For details on the on-chip debug security ID, refer to the QB-MINI2 User's Manual (U18731E).

Table 25-1.	On-Chip	Debug	Security	ID
-------------	---------	-------	----------	----

Address	On-Chip Debug Security ID
0085H to 008EH	Any ID code of 10 bytes
1085H to 108EH	

#### 27.6 Restrictions and Cautions on On-Chip Debug Function

When setting to on-chip debugging mode via the normal port, without using pins X1 and X2, two of the user ports will be unavailable for use.

In order to realize on-chip debug function, use the following user resource.

#### (a) Flash memory area

- OAddresses 0x02 and 0x03
- OAddresses 0x7E and 0x7F (when using a software break)
- OAddress 0x84
- OAddresses 0x85 to 0x8E
- OAddresses 0x8F to 0x18F: Standard value of program
  - (+256 bytes when using pseudo real-time RAM monitor function)
  - (when using a device with 10 or more SFRs the can be accessed in 16-bit units: +n (the number of exceeding registers x 6 bytes))

#### (b) Internal extended RAM area

- OAddresses 0xF7F0 to 0xF7FF
  - (when using pseudo real-time RAM monitor function)

#### (c) Internal high-speed RAM area

- O7 bytes as stack area: Standard value of stack
  - (+2 bytes when using software breaks)
  - (+7 bytes when using pseudo real-time RAM monitor function)

For details, refer to the QB-MINI2 User's Manual (U18731E).



## CHAPTER 28 INSTRUCTION SET

This chapter lists each instruction set of 78K0/Dx2 in table form. For details of each operation and operation code, refer to the separate document **78K/0 Series Instructions User's Manual (U12326E)**.

#### 28.1 Conventions Used in Operation List

#### 28.1.1 Operand identifiers and specification methods

Operands are written in the "Operand" column of each instruction in accordance with the specification method of the instruction operand identifier (refer to the assembler specifications for details). When there are two or more methods, select one of them. Upper case letters and the symbols #, !, \$ and [] are keywords and must be written as they are. Each symbol has the following meaning.

- #: Immediate data specification
- !: Absolute address specification
- \$: Relative address specification
- []: Indirect address specification

In the case of immediate data, describe an appropriate numeric value or a label. When using a label, be sure to write the #, !, \$, and [] symbols.

For operand register identifiers r and rp, either function names (X, A, C, etc.) or absolute names (names in parentheses in the table below, R0, R1, R2, etc.) can be used for specification.

Identifier	Specification Method
r	X (R0), A (R1), C (R2), B (R3), E (R4), D (R5), L (R6), H (R7),
rp	AX (RP0), BC (RP1), DE (RP2), HL (RP3)
sfr	Special function register symbol <sup>Note</sup>
sfrp	Special function register symbol (16-bit manipulatable register even addresses only) <sup>Note</sup>
saddr	FE20H to FF1FH Immediate data or labels
saddrp	FE20H to FF1FH Immediate data or labels (even address only)
addr16	0000H to FFFFH Immediate data or labels
	(Only even addresses for 16-bit data transfer instructions)
addr11	0800H to 0FFFH Immediate data or labels
addr5	0040H to 007FH Immediate data or labels (even address only)
word	16-bit immediate data or label
byte	8-bit immediate data or label
bit	3-bit immediate data or label
RBn	RB0 to RB3

#### Table 28-1. Operand Identifiers and Specification Methods

**Note** Addresses from FFD0H to FFDFH cannot be accessed with these operands.

Remark For special function register symbols, see Table 3-7. Special Function Register List.



## 28.1.2 Description of operation column

- A: A register; 8-bit accumulator
- X: X register
- B: B register
- C: C register
- D: D register
- E: E register
- H: H register
- L: L register
- AX: AX register pair; 16-bit accumulator
- BC: BC register pair
- DE: DE register pair
- HL: HL register pair
- PC: Program counter
- SP: Stack pointer
- PSW: Program status word
- CY: Carry flag
- AC: Auxiliary carry flag
- Z: Zero flag
- RBS: Register bank select flag
- IE: Interrupt request enable flag
- (): Memory contents indicated by address or register contents in parentheses
- XH, XL: Higher 8 bits and lower 8 bits of 16-bit register
- ∧: Logical product (AND)
- v: Logical sum (OR)
- +: Exclusive logical sum (exclusive OR)
- ----: Inverted data
- addr16: 16-bit immediate data or label
- jdisp8: Signed 8-bit data (displacement value)

#### 28.1.3 Description of flag operation column

- (Blank): Not affected
- 0: Cleared to 0
- 1: Set to 1
- ×: Set/cleared according to the result
- R: Previously saved value is restored



## 78K0/Dx2

## 28.2 Operation List

Instruction	Mnomonio	Operande	Butoc	Clocks		Operation		Flag	
Group	WITEITIONIC	Operands	Dytes	Note 1	Note 2	r ← byte		AC	CY
8-bit data	MOV	r, #byte	2	4		$r \leftarrow byte$			
transfer		saddr, #byte	3	6	7	$(saddr) \leftarrow byte$			
		sfr, #byte	3	_	7	$sfr \leftarrow byte$			
		A, r	1	2	I	A ← r			
		r, A Note 3	1	2	-	r ← A			
		A, saddr	2	4	5	$A \leftarrow (saddr)$			
		saddr, A	2	4	5	$(saddr) \leftarrow A$			
		A, sfr	2	_	5	$A \leftarrow sfr$			
		sfr, A	2	-	5	$sfr \leftarrow A$			
		A, laddr16	3	8	9	$A \leftarrow (addr16)$			
		!addr16, A	3	8	9	$(addr16) \leftarrow A$			
		PSW, #byte	3	-	7	$PSW \leftarrow byte$	×	×	×
		A, PSW	2	-	5	$A \leftarrow PSW$			
		PSW, A	2	_	5	PSW ← A	×	×	x
		A, [DE]	1	4	5	$A \leftarrow (DE)$			
		[DE], A	1	4	5	$(DE) \leftarrow A$			
		A, [HL]	1	4	5	$A \leftarrow (HL)$			
		[HL], A	1	4	5	(HL) ← A			
		A, [HL + byte]	2	8	9	$A \leftarrow (HL + byte)$			
		[HL + byte], A	2	8	9	(HL + byte) ← A			
		A, [HL + B]	1	6	7	$A \leftarrow (HL + B)$			
		[HL + B], A	1	6	7	$(HL + B) \leftarrow A$			
		A, [HL + C]	1	6	7	$A \leftarrow (HL + C)$			
		[HL + C], A	1	6	7	$(HL + C) \leftarrow A$			
	хсн	A, r	1	2	-	$A \leftrightarrow r$			
		A, saddr	2	4	6	$A \leftrightarrow (saddr)$			
		A, sfr	2	-	6	$A \leftrightarrow (sfr)$			
		A, !addr16	3	8	10	$A \leftrightarrow (addr16)$			
		A, [DE]	1	4	6	$A \leftrightarrow (DE)$			
		A, [HL]	1	4	6	$A \leftrightarrow (HL)$			
		A, [HL + byte]	2	8	10	$A \leftrightarrow (HL + byte)$			
		A, [HL + B]	2	8	10	$A \leftrightarrow (HL + B)$			
		A, [HL + C]	2	8	10	$A \leftrightarrow (HL + C)$			

Notes 1. When the internal high-speed RAM area is accessed or for an instruction with no data access

2. When an area except the internal high-speed RAM area is accessed

3. Except "r = A"

**Remarks 1.** One instruction clock cycle is one cycle of the CPU clock (fcPu) selected by the processor clock control register (PCC).

Instruction	Masaasia	On even de		Dutes	С	locks	Or cretion	Flag	
Group	winemonic	Operands		bytes	Note 1	Note 2	Operation	ZACO	CY
16-bit data	MOVW	rp, #word		3	6		$rp \leftarrow word$		
transfer		saddrp, #word		4	8	10	$(saddrp) \leftarrow word$		
		sfrp, #word		4	-	10	$sfrp \leftarrow word$		
		AX, saddrp		2	6	8	$AX \leftarrow (saddrp)$		
		saddrp, AX		2	6	8	$(saddrp) \leftarrow AX$		
		AX, sfrp		2	-	8	$AX \leftarrow sfrp$		
		sfrp, AX		2	-	8	sfrp ← AX		
		AX, rp	Note 3	1	4	-	AX ← rp		
		rp, AX	Note 3	1	4	-	$rp \leftarrow AX$		
		AX, !addr16		3	10	12	$AX \leftarrow (addr16)$		
		!addr16, AX		3	10	12	$(addr16) \leftarrow AX$		
	хснw	AX, rp	Note 3	1	4	I	$AX \leftrightarrow rp$		
8-bit	ADD	A, #byte		2	4	-	A, CY $\leftarrow$ A + byte	× ×	×
operation		saddr, #byte		3	6	8	(saddr), CY $\leftarrow$ (saddr) + byte	× ×	×
		A, r	Note 4	2	4	-	A, CY ← A + r	× ×	×
		r, A		2	4	-	r, CY ← r + A	× ×	×
		A, saddr		2	4	5	A, CY $\leftarrow$ A + (saddr)	× ×	×
		A, laddr16		3	8	9	A, CY $\leftarrow$ A + (addr16)	× ×	×
		A, [HL]		1	4	5	A, CY $\leftarrow$ A + (HL)	× ×	×
		A, [HL + byte]		2	8	9	A, CY $\leftarrow$ A + (HL + byte)	× ×	×
		A, [HL + B]		2	8	9	$A,CY \leftarrow A + (HL + B)$	× ×	×
		A, [HL + C]		2	8	9	$A,CY \leftarrow A + (HL + C)$	× ×	×
	ADDC	A, #byte		2	4	-	A, CY $\leftarrow$ A + byte + CY	× ×	×
		saddr, #byte		3	6	8	(saddr), CY $\leftarrow$ (saddr) + byte + CY	× ×	×
		A, r	Note 4	2	4		$A,CY \leftarrow A + r + CY$	× ×	×
		r, A		2	4	I	r, CY ← r + A + CY	× ×	×
		A, saddr		2	4	5	A, CY $\leftarrow$ A + (saddr) + CY	× ×	×
		A, laddr16		3	8	9	A, CY $\leftarrow$ A + (addr16) + C	× ×	×
	A, [HL]			1	4	5	$A,CY \leftarrow A + (HL) + CY$	× ×	×
		A, [HL + byte]		2	8	9	A, CY $\leftarrow$ A + (HL + byte) + CY	× ×	×
		A, [HL + B]		2	8	9	$A, CY \leftarrow A + (HL + B) + CY$	× ×	×
		A, [HL + C]		2	8	9	A, CY $\leftarrow$ A + (HL + C) + CY	× ×	×

2. When an area except the internal high-speed RAM area is accessed

3. Only when rp = BC, DE or HL

4. Except "r = A"

**Remarks 1.** One instruction clock cycle is one cycle of the CPU clock (fcPu) selected by the processor clock control register (PCC).



Instruction	Maamania	Operanda	Putoo	С	locks	Operation		Fla	g
Group	WITEITIONIC	Operands	Dytes	Note 1	Note 2	Operation	Ζ	AC	CY
8-bit	SUB	A, #byte	2	4	I	A, CY $\leftarrow$ A – byte	×	×	×
operation		saddr, #byte	3	6	8	(saddr), CY $\leftarrow$ (saddr) – byte	×	×	×
		A, r	2	4	I	A, CY $\leftarrow$ A – r	×	×	×
		r, A	2	4	I	r, CY ← r − A	×	×	×
		A, saddr	2	4	5	A, CY $\leftarrow$ A – (saddr)	×	×	×
		A, !addr16	3	8	9	A, CY $\leftarrow$ A – (addr16)	×	×	×
		A, [HL]	1	4	5	$A, CY \leftarrow A - (HL)$	×	×	×
		A, [HL + byte]	2	8	9	A, CY $\leftarrow$ A – (HL + byte)	×	×	×
		A, [HL + B]	2	8	9	$A,CY \leftarrow A - (HL + B)$	×	×	×
		A, [HL + C]	2	8	9	$A, CY \leftarrow A - (HL + C)$	×	×	×
SUBC		A, #byte	2	4	I	A, CY $\leftarrow$ A – byte – CY	×	×	×
		saddr, #byte	3	6	8	(saddr), CY $\leftarrow$ (saddr) – byte – CY	×	×	×
	-	A, r	2	4	I	$A,CY \leftarrow A-r-CY$	×	×	×
		r, A	2	4	I	$r,CY \leftarrow r-A-CY$	×	×	×
		A, saddr	2	4	5	A, CY $\leftarrow$ A – (saddr) – CY	×	×	×
		A, !addr16	3	8	9	A, CY $\leftarrow$ A – (addr16) – CY	×	×	×
		A, [HL]	1	4	5	$A, CY \leftarrow A - (HL) - CY$	×	×	×
		A, [HL + byte]	2	8	9	A, CY $\leftarrow$ A – (HL + byte) – CY	×	×	×
		A, [HL + B]	2	8	9	$A,CY \leftarrow A - (HL + B) - CY$	×	×	×
		A, [HL + C]	2	8	9	$A,CY \leftarrow A - (HL + C) - CY$	×	×	×
	AND	A, #byte	2	4	-	$A \leftarrow A \land byte$	×		
		saddr, #byte	3	6	8	$(saddr) \leftarrow (saddr) \land byte$	×		
		A, r	2	4	-	$A \leftarrow A \wedge r$	×		
		r, A	2	4	-	$r \leftarrow r \wedge A$	×		
		A, saddr	2	4	5	$A \leftarrow A \land (saddr)$	×		
		A, !addr16	3	8	9	$A \leftarrow A \land (addr16)$	×		
		A, [HL]	1	4	5	$A \leftarrow A \land [HL]$	×		
		A, [HL + byte]	2	8	9	$A \leftarrow A \land [HL + byte]$	×		
		A, [HL + B]	2	8	9	$A \leftarrow A \land [HL + B]$	×		
		A, [HL + C]	2	8	9	$A \leftarrow A \land [HL + C]$	×		

2. When an area except the internal high-speed RAM area is accessed

3. Except "r = A"

**Remarks 1.** One instruction clock cycle is one cycle of the CPU clock (fcPu) selected by the processor clock control register (PCC).



Instruction	Mnomonio	Operande	Butoc	С	locks	Operation	Flag
Group	WITEITIOTIIC	Operands	Dytes	Note 1	Note 2	Operation	Z AC CY
8-bit	OR	A, #byte	2	4	I	$A \leftarrow A \lor byte$	×
operation		saddr, #byte	3	6	8	$(saddr) \leftarrow (saddr) \lor byte$	×
		A, r	2	4	-	$A \leftarrow A \lor r$	×
		r, A	2	4	I	$r \leftarrow r \lor A$	×
		A, saddr	2	4	5	$A \leftarrow A \lor (saddr)$	×
		A, !addr16	3	8	9	$A \leftarrow A \lor (addr16)$	×
		A, [HL]	1	4	5	$A \leftarrow A \lor (HL)$	×
		A, [HL + byte]	2	8	9	$A \leftarrow A \lor (HL + byte)$	×
		A, [HL + B]	2	8	9	$A \leftarrow A \lor (HL + B)$	×
		A, [HL + C]	2	8	9	$A \leftarrow A \lor (HL + C)$	×
	XOR	A, #byte	2	4	_	$A \leftarrow A + byte$	×
		saddr, #byte	3	6	8	$(saddr) \leftarrow (saddr) + byte$	×
		A, r	2	4	-	$A \leftarrow A \nleftrightarrow r$	×
		r, A	2	4	_	$r \leftarrow r \nleftrightarrow A$	×
		A, saddr	2	4	5	$A \leftarrow A \leftrightarrow (saddr)$	×
		A, !addr16	3	8	9	$A \leftarrow A \leftrightarrow (addr16)$	×
		A, [HL]	1	4	5	$A \leftarrow A \nleftrightarrow (HL)$	×
		A, [HL + byte]	2	8	9	$A \leftarrow A \nleftrightarrow (HL + byte)$	×
		A, [HL + B]	2	8	9	$A \leftarrow A \nleftrightarrow (HL + B)$	×
		A, [HL + C]	2	8	9	$A \leftarrow A \nleftrightarrow (HL + C)$	×
	СМР	A, #byte	2	4	-	A – byte	$\times$ $\times$ $\times$
		saddr, #byte	3	6	8	(saddr) – byte	× × ×
		A, r	2	4	-	A – r	× × ×
		r, A	2	4	-	r – A	× × ×
		A, saddr	2	4	5	A – (saddr)	$\times$ $\times$ $\times$
		A, !addr16	3	8	9	A – (addr16)	× × ×
		A, [HL]	1	4	5	A – (HL)	× × ×
		A, [HL + byte]	2	8	9	A – (HL + byte)	× × ×
		A, [HL + B]	2	8	9	A – (HL + B)	× × ×
		A, [HL + C]	2	8	9	A – (HL + C)	× × ×

2. When an area except the internal high-speed RAM area is accessed

3. Except "r = A"

**Remarks 1.** One instruction clock cycle is one cycle of the CPU clock (fcPu) selected by the processor clock control register (PCC).



Instruction	Maria	O a serie da	D. I.	С	locks	Quanting		Flag	l
Group	winemonic	Operands	Bytes	Note 1	Note 2	Operation	Ζ	AC	СҮ
16-bit	ADDW	AX, #word	3	6	-	AX, CY $\leftarrow$ AX + word	×	×	×
operation	SUBW	AX, #word	3	6	_	AX, CY $\leftarrow$ AX – word	×	×	×
	CMPW	AX, #word	3	6	-	AX – word	×	×	×
Multiply/	MULU	х	2	16	_	$AX \leftarrow A \times X$			
divide	DIVUW	С	2	25	_	AX (Quotient), C (Remainder) $\leftarrow$ AX $\div$ C			
Increment/	INC	r	1	2	_	r ← r + 1	×	×	
decrement		saddr	2	4	6	$(saddr) \leftarrow (saddr) + 1$	×	×	
	DEC	r	1	2	_	r ← r – 1	×	×	
		saddr	2	4	6	$(saddr) \leftarrow (saddr) - 1$	×	×	
INCW rp 1		4	_	$rp \leftarrow rp + 1$					
	DECW	rp	1	4	-	rp ← rp – 1			
Rotate	ROR	A, 1	1	2	-	(CY, A <sub>7</sub> $\leftarrow$ A <sub>0</sub> , A <sub>m - 1</sub> $\leftarrow$ A <sub>m</sub> ) $\times$ 1 time			×
	ROL	A, 1	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			×			
	RORC	A, 1	1	2	_	$(CY \leftarrow A_0, A_7 \leftarrow CY, A_{m-1} \leftarrow A_m) \times 1$ time			×
ROLC		A, 1	1	2	_	$(CY \leftarrow A_7, A_0 \leftarrow CY, A_{m+1} \leftarrow A_m) \times 1$ time			×
	ROR4	[HL]	2	10	12	A <sub>3-0</sub> ← (HL) <sub>3-0</sub> , (HL) <sub>7-4</sub> ← A <sub>3-0</sub> , (HL) <sub>3-0</sub> ← (HL) <sub>7-4</sub>			
	ROL4	[HL]	2	10	12	A <sub>3-0</sub> ← (HL) <sub>7-4</sub> , (HL) <sub>3-0</sub> ← A <sub>3-0</sub> , (HL) <sub>7-4</sub> ← (HL) <sub>3-0</sub>			
BCD	ADJBA		2	4	_	Decimal Adjust Accumulator after Addition	×	х	×
adjustment	ADJBS		2	4	_	Decimal Adjust Accumulator after Subtract	×	х	×
Bit	MOV1	CY, saddr.bit	3	6	7	$CY \leftarrow (saddr.bit)$			×
manipulate		CY, sfr.bit	3	-	7	CY ← sfr.bit			×
		CY, A.bit	2	4	_	CY ← A.bit			×
		CY, PSW.bit	3	-	7	CY ← PSW.bit			×
		CY, [HL].bit	2	6	7	$CY \leftarrow (HL).bit$			×
		saddr.bit, CY	3	6	8	(saddr.bit) ← CY			
		sfr.bit, CY	3	-	8	sfr.bit ← CY			
		A.bit, CY	2	4	_	A.bit ← CY			
		PSW.bit, CY	3	-	8	PSW.bit ← CY	×	×	
		[HL].bit, CY	2	6	8	(HL).bit ← CY			

2. When an area except the internal high-speed RAM area is accessed

**Remarks 1.** One instruction clock cycle is one cycle of the CPU clock (fcPu) selected by the processor clock control register (PCC).



Instruction	Magazia	Onevende	Distan	С	locks	Or cretion	Flag
Group	whemonic	Operands	bytes	Note 1	Note 2	Operation	Z AC CY
Bit	AND1	CY, saddr.bit	3	6	7	$CY \leftarrow CY \land saddr.bit)$	×
manipulate		CY, sfr.bit	3	-	7	$CY \leftarrow CY \land sfr.bit$	×
		CY, A.bit	2	4		$CY \leftarrow CY \land A.bit$	×
		CY, PSW.bit	3	-	7	$CY \leftarrow CY \land PSW.bit$	×
		CY, [HL].bit	2	6	7	$CY \leftarrow CY \land (HL).bit$	×
	OR1	CY, saddr.bit	3	6	7	$CY \leftarrow CY \lor \text{(saddr.bit)}$	×
		CY, sfr.bit	3	-	7	$CY \leftarrow CY \lor sfr.bit$	×
		CY, A.bit	2	4	-	$CY \leftarrow CY \lor A.bit$	×
		CY, PSW.bit	3	-	7	$CY \leftarrow CY \lor PSW.bit$	×
		CY, [HL].bit	2	6	7	$CY \leftarrow CY \lor (HL).bit$	×
	XOR1	CY, saddr.bit	3	6	7	$CY \leftarrow CY + (saddr.bit)$	×
		CY, sfr.bit	3	-	7	$CY \leftarrow CY + sfr.bit$	×
		CY, A.bit	2	4	-	$CY \leftarrow CY \neq A.bit$	×
		CY, PSW. bit	3	-	7	$CY \leftarrow CY + PSW.bit$	×
		CY, [HL].bit	2	6	7	$CY \leftarrow CY \leftrightarrow (HL).bit$	×
	SET1	saddr.bit	2	4	6	(saddr.bit) $\leftarrow 1$	
		sfr.bit	3	-	8	sfr.bit ← 1	
		A.bit	2	4	I	A.bit ← 1	
		PSW.bit	2	-	6	PSW.bit ← 1	× × ×
		[HL].bit	2	6	8	(HL).bit ← 1	
	CLR1	saddr.bit	2	4	6	(saddr.bit) $\leftarrow 0$	
		sfr.bit	3	-	8	sfr.bit ← 0	
		A.bit	2	4	-	A.bit ← 0	
		PSW.bit	2	-	6	PSW.bit ← 0	× × ×
		[HL].bit	2	6	8	(HL).bit ← 0	
	SET1	CY	1	2	_	CY ← 1	1
CL	CLR1	CY	1	2	_	CY ← 0	0
	NOT1	CY	1	2	-	$CY \leftarrow \overline{CY}$	×

2. When an area except the internal high-speed RAM area is accessed

- **Remarks 1.** One instruction clock cycle is one cycle of the CPU clock (fcPu) selected by the processor clock control register (PCC).
  - 2. This clock cycle applies to the internal ROM program.



Instruction	Manager	Orangel	D. J.	С	locks	S Operation		=lag	
Group	winemonic	Operands	Bytes	Note 1	Note 2	Operation	Z	AC	CY
Call/return	CALL	!addr16	3	7	-	$(SP - 1) \leftarrow (PC + 3)_{H}, (SP - 2) \leftarrow (PC + 3)_{L},$ PC $\leftarrow$ addr16, SP $\leftarrow$ SP - 2			
	CALLF	!addr11	2	5	_	$(SP - 1) \leftarrow (PC + 2)H$ , $(SP - 2) \leftarrow (PC + 2)L$ , PC <sub>15-11</sub> $\leftarrow$ 00001, PC <sub>10-0</sub> $\leftarrow$ addr11, SP $\leftarrow$ SP - 2			
	CALLT	[addr5]	1	6	_	$\begin{split} (SP-1) \leftarrow (PC+1)_{H},  (SP-2) \leftarrow (PC+1)_{L}, \\ PC_{H} \leftarrow (addr5+1), \\ PC_{L} \leftarrow (addr5), \\ SP \leftarrow SP-2 \end{split}$			
	BRK		1	6	_	$(SP - 1) \leftarrow PSW, (SP - 2) \leftarrow (PC + 1)_{H},$ $(SP - 3) \leftarrow (PC + 1)_{L}, PC_{H} \leftarrow (003FH),$ $PC_{L} \leftarrow (003EH), SP \leftarrow SP - 3, IE \leftarrow 0$			
RET			1	6	-	$PCH \leftarrow (SP + 1), PCL \leftarrow (SP),$ $SP \leftarrow SP + 2$			
	RETI		1	6	-	PC <sub>H</sub> ← (SP + 1), PC <sub>L</sub> ← (SP), PSW ← (SP + 2), SP ← SP + 3	R	R	R
	RETB		1	6	-	PC <sub>H</sub> ← (SP + 1), PC <sub>L</sub> ← (SP), PSW ← (SP + 2), SP ← SP + 3	R	R	R
Stack	PUSH	PSW	1	2	_	$(SP - 1) \leftarrow PSW, SP \leftarrow SP - 1$			
manipulate		rp	1	4	-	$(SP - 1) \leftarrow rp_H, (SP - 2) \leftarrow rp_L,$ $SP \leftarrow SP - 2$			
	POP	PSW	1	2	-	$PSW \leftarrow (SP),  SP \leftarrow SP + 1$	R	R	R
		rp	1	4	_	rp <sub>H</sub> ← (SP + 1), rp <sub>L</sub> ← (SP), SP ← SP + 2			
	MOVW	SP, #word	4	_	10	$SP \leftarrow word$			
		SP, AX	2	-	8	$SP \leftarrow AX$			
		AX, SP	2	-	8	$AX \leftarrow SP$			
Unconditional	BR	!addr16	3	6	-	PC ← addr16			
branch		\$addr16	2	6	_	$PC \leftarrow PC + 2 + jdisp8$			
		AX	2	8	_	$PCH \leftarrow A, PC \leftarrow X$			
Conditional	вс	\$addr16	2	6		$PC \leftarrow PC + 2 + jdisp8$ if $CY = 1$			
branch	BNC	\$addr16	2	6	_	$PC \leftarrow PC + 2 + jdisp8$ if $CY = 0$			
	BZ	\$addr16	2	6	-	$PC \leftarrow PC + 2 + jdisp8$ if $Z = 1$			
	BNZ	\$addr16	2	6	-	$PC \leftarrow PC + 2 + jdisp8$ if $Z = 0$			

2. When an area except the internal high-speed RAM area is accessed

**Remarks 1.** One instruction clock cycle is one cycle of the CPU clock (fcPu) selected by the processor clock control register (PCC).



Instruction	Maamania	Operanda	Putoo	С	locks	Operation	Flag
Group	winemonic	Operands	bytes	Note 1	Note 2	Operation	Z AC CY
Conditional	вт	saddr.bit, \$addr16	3	8	9	$PC \leftarrow PC + 3 + jdisp8 if(saddr.bit) = 1$	
branch		sfr.bit, \$addr16	4	-	11	$PC \leftarrow PC + 4 + jdisp8$ if sfr.bit = 1	
		A.bit, \$addr16	3	8	-	$PC \leftarrow PC + 3 + jdisp8$ if A.bit = 1	
		PSW.bit, \$addr16	3	-	9	$PC \leftarrow PC + 3 + jdisp8$ if PSW.bit = 1	
		[HL].bit, \$addr16	3	10	11	$PC \leftarrow PC + 3 + jdisp8$ if (HL).bit = 1	
	BF	saddr.bit, \$addr16	4	10	11	$PC \leftarrow PC + 4 + jdisp8 if(saddr.bit) = 0$	
		sfr.bit, \$addr16	4	-	11	$PC \leftarrow PC + 4 + jdisp8$ if sfr.bit = 0	
		A.bit, \$addr16	3	8	_	$PC \leftarrow PC + 3 + jdisp8$ if A.bit = 0	
		PSW.bit, \$addr16	4	-	11	$PC \leftarrow PC + 4 + jdisp8$ if PSW. bit = 0	
		[HL].bit, \$addr16	3	10	11	$PC \leftarrow PC + 3 + jdisp8$ if (HL).bit = 0	
	BTCLR	saddr.bit, \$addr16	4	10	12	$PC \leftarrow PC + 4 + jdisp8$	
						if(saddr.bit) = 1	
						then reset(saddr.bit)	
		sfr.bit, \$addr16	4	-	12	$PC \leftarrow PC + 4 + jdisp8$ if sfr.bit = 1	
		A bit \$addr16	3	8		$\frac{1}{1000} = \frac{1}{1000} = 1$	
			5	0	_	then reset A.bit	
		PSW.bit, \$addr16	4	_	12	$PC \leftarrow PC + 4 + jdisp8$ if PSW.bit = 1	× × ×
						then reset PSW.bit	
		[HL].bit, \$addr16	3	10	12	$PC \leftarrow PC + 3 + jdisp8$ if (HL).bit = 1	
						then reset (HL).bit	
	DBNZ	B, \$addr16	2	6	-	$B \leftarrow B - 1$ , then	
						$PC \leftarrow PC + 2 + jdisp8$ if $B \neq 0$	
		C, \$addr16	2	6	-	$C \leftarrow C - 1$ , then	
		Soddr Coddr16	2	0	10	$PC \leftarrow PC + 2 + Julspo ii C \neq 0$	
		Sadur, şaddr 16	3	0	10	$(saddr) \leftarrow (saddr) - 1, then PC \leftarrow PC + 3 + idisp8 if(saddr) \neq 0$	
CPU	SEL	RBn	2	4	_	RBS1. 0 ← n	
control	NOP		1	2	_	No Operation	
	EI		2	_	6	IE $\leftarrow$ 1(Enable Interrupt)	
	DI		2	_	6	IE $\leftarrow$ 0(Disable Interrupt)	
	HALT		2	6	-	Set HALT Mode	
	STOP		2	6	_	Set STOP Mode	

2. When an area except the internal high-speed RAM area is accessed

**Remarks 1.** One instruction clock cycle is one cycle of the CPU clock (fcPu) selected by the processor clock control register (PCC).



## 28.3 Instructions Listed by Addressing Type

#### (1) 8-bit instructions

MOV, XCH, ADD, ADDC, SUB, SUBC, AND, OR, XOR, CMP, MULU, DIVUW, INC, DEC, ROR, ROL, RORC, ROLC, ROR4, ROL4, PUSH, POP, DBNZ

Second Operand	#byte	A	r <sup>Note</sup>	sfr	saddr	!addr16	PSW	[DE]	[HL]	[HL+byte]	\$addr16	1	None
First Operand										[HL + B] [HL + C]			
A	ADD ADDC SUB SUBC AND OR XOR CMP		MOV XCH ADD ADDC SUB SUBC AND OR XOR CMP	MOV XCH	MOV XCH ADD ADDC SUB SUBC AND OR XOR CMP	MOV XCH ADD ADDC SUB SUBC AND OR XOR CMP	MOV	MOV XCH	MOV XCH ADD ADDC SUB SUBC AND OR XOR CMP	MOV XCH ADD ADDC SUB SUBC AND OR XOR CMP		ROR ROL RORC ROLC	
r	MOV	MOV ADD ADDC SUB SUBC AND OR XOR CMP											INC DEC
B, C											DBNZ		
sfr	MOV	MOV	$\square$	$\square$	<u> </u>	<u> </u>	<u> </u>	<u> </u>	<u> </u>	$\square$		ļ	
saddr	MOV ADD ADDC SUB SUBC AND OR XOR CMP	MOV									DBNZ		INC DEC
!addr16		MOV	<u> </u>	<u> </u>	<u> </u>	<b> </b>	<b> </b>	<u> </u>	<b> </b>	<u> </u>			
PSW	MOV	MOV											PUSH POP
[DE]		MOV											
[HL]		MOV											ROR4 ROL4
[HL + byte] [HL + B] [HL + C]		MOV											
x		<u> </u>	<u> </u>	<u> </u>	<u> </u>	<b> </b>	<b> </b>	<u> </u>	<u> </u>	<u> </u>			MULU
С													DIVUW

Note Except "r = A"



## (2) 16-bit instructions

MOVW, XCHW, ADDW, SUBW, CMPW, PUSH, POP, INCW, DECW

Second Operand	#word	AX	rp <sup>Note</sup>	sfrp	saddrp	!addr16	SP	None
AX	ADDW SUBW CMPW		MOVW XCHW	MOVW	MOVW	MOVW	MOVW	
rp	MOVW	MOVW <sup>Note</sup>						INCW DECW PUSH POP
Sfrp	MOVW	MOVW						
saddrp	MOVW	MOVW						
!addr16		MOVW						
SP	MOVW	MOVW						

**Note** Only when rp = BC, DE, HL

#### (3) Bit manipulation instructions

MOV1, AND1, OR1, XOR1, SET1, CLR1, NOT1, BT, BF, BTCLR

Second Operand	A.bit	sfr.bit	saddr.bit	PSW.bit	[HL].bit	CY	\$addr16	None
First Operand	,'	<u> </u>	<u> </u>	<u> </u>				
A.bit						MOV1	BT BF BTCLR	SET1 CLR1
sfr.bit						MOV1	BT BF BTCLR	SET1 CLR1
saddr.bit						MOV1	BT BF BTCLR	SET1 CLR1
PSW.bit						MOV1	BT BF BTCLR	SET1 CLR1
[HL].bit						MOV1	BT BF BTCLR	SET1 CLR1
СҮ	MOV1 AND1 OR1 XOR1	MOV1 AND1 OR1 XOR1	MOV1 AND1 OR1 XOR1	MOV1 AND1 OR1 XOR1	MOV1 AND1 OR1 XOR1			SET1 CLR1 NOT1



## (4) Call instructions/branch instructions

CALL, CALLF, CALLT, BR, BC, BNC, BZ, BNZ, BT, BF, BTCLR, DBNZ

Second Operand	AX	!addr16	!addr11	[addr5]	\$addr16
First Operand					
Basic instruction	BR	CALL BR	CALLF	CALLT	BR BC BNC BZ BNZ
Compound instruction					BT BF BTCLR DBNZ

## (5) Other instructions

ADJBA, ADJBS, BRK, RET, RETI, RETB, SEL, NOP, EI, DI, HALT, STOP



## CHAPTER 29 ELECTRICAL SPECIFICATIONS ((A) GRADE PRODUCTS)

Caution The 78K0/Dx2 has an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.

#### 29.1 Absolute Maximum Ratings

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage	VDD		–0.5 to +6.5	V
	EVDD		–0.5 to +6.5	V
	Vss		–0.5 to +0.3	V
	EVss		–0.5 to +0.3	V
	SMVDD		–0.5 to +6.5	v
	SMVss		–0.5 to +0.3	V
	AVREF		-0.5 to V <sub>DD</sub> +0.3 <sup>Note</sup>	V
	AVss		-0.5 to +0.3	v
REGC pin Input voltage	VREGC		$-0.5 \text{ to } +3.6$ and $\leq V_{\text{DD}}$	V
Input voltage	VI1	P00 to P07, P13 to P16, P30 to P37, P60, P61, P70 to P77, P120 to P124, (78K0/DF2) P10 to P12, P17, X1, X2, XT1, XT2, RESET, FLMD0	-0.3 to V <sub>DD</sub> +0.3 <sup>Note</sup>	V
	V <sub>12</sub>	P20 to P27	$-0.3$ to AV_{REF} +0.3 $^{\text{Note}}$ and $-0.3$ to V_DD +0.3 $^{\text{Note}}$	V
	Vıз	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	$-0.3$ to SMV_DD +0.3 $^{\text{Note}}$ and $-0.3$ to V_DD +0.3 $^{\text{Note}}$	V
Output voltage	V <sub>01</sub>	P00 to P07, P13 to P16, P30 to P37, P60, P61, P70 to P77, P120 to P124, (78K0/DF2) P10 to P12, P17	-0.3 to V <sub>DD</sub> +0.3 <sup>Note</sup>	V
	V <sub>O2</sub>	P20 to P27	-0.3 to AVREF +0.3 Note	V
	Vo3	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	-0.3 to SMV <sub>DD</sub> +0.3 <sup>Note</sup>	V
Analog input voltage	Van	ANI0 to ANI7	$-0.3$ to $AV_{\text{REF}}$ +0.3 $^{\text{Note}}$ and $-0.3$ to $V_{\text{DD}}$ +0.3 $^{\text{Note}}$	V

#### Absolute Maximum Ratings (T<sub>A</sub> = 25°C) (1/2)

Note Must be 6.5 V or lower.

- Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.
- **Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.

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## Absolute Maximum Ratings (T<sub>A</sub> = 25°C) (2/2)

Parameter	Symbol		Conditions	Ratings	Unit
ZPD detection input voltage	Vzpd	ZPD14, ZPD24, 2	ZPD34, ZPD44	-0.3 to SMV_DD +0.3 $^{\text{Note}}$ and -0.3 to V_DD +0.3 $^{\text{Note}}$	V
Output current, high	Іон1	Per pin	P00 to P07, P13 to P16, P30 to P37, P70 to P72 , P74 to P77, P120, (78K0/DF2) P10 to P12, P17	-10	mA
	Іон5	Per pin	P73	-20	mA
		Total of above	P70 to P72, P120, P73	-25	mA
		pins –80 mA	P00 to P07, P13 to P16, P30 to P37, P74 to P77, (78K0/DF2) P10 to P12, P17	-55	
	Іон2	Per pin	P20 to P27	-0.5	mA
		Total of all pins		-2	
	Іонз	Per pin	P121 to P124	-1	mA
		Total of all pins		-4	
	Іон4	Per pin	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	-45	mA
		Total of all pins	P80 to P87, P90 to P93 ((78K0/DE2) P10 to P12, P17)	-190	
			P94 to P97	-105	
Output current, low	Iol1	Per pin	P00 to P07, P13 to P16, P30 to P37, P70 to P72, P74 to P77, P120, (78K0/DF2) P10 to P12, P17	30	mA
	Iol5	Per pin	P73	20	mA
		Total of above	P70 to P72, P120, P73	60	mA
		pins 200 mA	P00 to P07, P13 to P16, P30 to P37, P74 to P77, (78K0/DF2) P10 to P12, P17	140	
	IOL2	Per pin	P20 to P27	1	mA
		Total of all pins		5	
	Iol3	Per pin	P121 to P124	4	mA
		Total of all pins		10	
	Iol4	Per pin	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	45	mA
		Total of all pins	P80 to P87, P90 to P93 ((78K0/DE2) P10 to P12, P17)	180	
			P94 to P97	105	
Operating ambient	TA	In normal operation	on mode	-40 to +85	°C
temperature		In flash memory p	programming mode	-40 to +85	
Storage temperature	Tstg			-65 to +150	°C

Note Must be 6.5 V or lower.

- Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.
- **Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.

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## 29.2 Oscillator Characteristics

(1) Main System Clock (Crystal/Ceramic) Oscillator Characteristics

 $(T_A = -40 \text{ to } +85^{\circ}C, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$ 

Resonator	Recommended Circuit	Parameter	Conditions	MIN.	TYP.	MAX.	Unit
Ceramic resonator		X1 clock oscillation frequency (fx) <sup>Note</sup>	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$	4.0		20	MHz
			$2.7~V \leq V_{\text{DD}} < 4.0~V$	4.0		10	
Crystal resonator		X1 clock oscillation frequency (fx) <sup>Note</sup>	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$	4.0		20	MHz
			$2.7 \text{ V} \leq \text{V}_{\text{DD}} < 4.0 \text{ V}$	4.0		10	

Note Indicates only oscillator characteristics. Refer to AC Characteristics for instruction execution time.

Cautions 1. When using the X1 oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
- Do not cross the wiring with the other signal lines.
- Do not route the wiring near a signal line through which a high fluctuating current flows.
- Always make the ground point of the oscillator capacitor the same potential as Vss.
- Do not ground the capacitor to a ground pattern through which a high current flows.
- Do not fetch signals from the oscillator.
- 2. Since the CPU is started by the 8 MHz internal oscillator after reset, check the oscillation stabilization time of the main system clock using the oscillation stabilization time counter status register (OSTC). Determine the oscillation stabilization time of the OSTC register and oscillation stabilization time select register (OSTS) after sufficiently evaluating the oscillation stabilization time with the resonator to be used.
- **Remark** For the resonator selection and oscillator constant, customers are requested to either evaluate the oscillation themselves or apply to the resonator manufacturer for evaluation.



#### (2) On-chip Internal Oscillator Characteristics

 $(T_A = -40 \text{ to } +85^{\circ}C, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$ 

Resonator	Parameter		Conditions	MIN.	TYP.	MAX.	Unit
8 MHz internal oscillator	Internal high-speed oscillation	RSTS = 1	$2.7~V \leq V_{\text{DD}} \leq 5.5~V$	7.6	8	8.4	MHz
	clock frequency (foscs) Note	RSTS = 0		2.48	5	9.86	
240 kHz internal oscillator	Internal low-speed oscillation clock frequency (fosc)	$2.7 \text{ V} \leq V_{\text{DD}}$	≤ 5.5 V	216	240	264	kHz

Note Indicates only oscillator characteristics. Refer to AC Characteristics for instruction execution time.

Remark RSTS: Bit 7 of the internal oscillation mode register (RCM)

#### (3) Subsystem Clock Oscillator Characteristics

 $(T_A = -40 \text{ to } +85^{\circ}C, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$ 

Resonator	Recommended Circuit	Parameter	Conditions	MIN.	TYP.	MAX.	Unit
Crystal resonator	Vss XT2 XT1 Rd C4 = C3 = ₩	XT1 clock oscillation frequency (f <sub>XT</sub> ) <sup>Note</sup>		32	32.768	35	kHz

Note Indicates only oscillator characteristics. Refer to AC Characteristics for instruction execution time.

Cautions 1. When using the XT1 oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
- Do not cross the wiring with the other signal lines.
- Do not route the wiring near a signal line through which a high fluctuating current flows.
- Always make the ground point of the oscillator capacitor the same potential as Vss.
- Do not ground the capacitor to a ground pattern through which a high current flows.
- Do not fetch signals from the oscillator.
- The subsystem clock oscillator is designed as a low-amplitude circuit for reducing power consumption, and is more prone to malfunction due to noise than the high-speed system clock oscillator. Particular care is therefore required with the wiring method when the subsystem clock is used.
- **Remark** For the resonator selection and oscillator constant, customers are requested to either evaluate the oscillation themselves or apply to the resonator manufacturer for evaluation.



## 29.3 DC Characteristics

## DC Characteristics (1/7)

## $(T_A = -40 \text{ to } +85^{\circ}C, 2.7 \text{ V} \le V_{DD} = EV_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le AV_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le SMV_{DD} \le 5.5 \text{ V}, V_{SS} = EV_{SS} = AV_{SS} = SMV_{SS} = 0 \text{ V})$

Parameter	Symbol	Con	ditions		MIN.	TYP.	MAX.	Unit
Output current, high Note 1	Іон1	Per pin for P00 to P07, P13	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$				-3.0	mA
		to P16, P30 to P37, P60, 61,	$2.7~V \leq V_{\text{DD}} < 4.0~V$				-2.5	
		P70 to P72, P74 to P77,						
		(78K0/DF2) P10 to P12, P17						
	Іон4	P73	$4.5 V < V_{DD} < 5.5 V$				-15.0	mA
			$2.7 V < V_{DD} < 4.5 V$				-9	
		Total of pins P70 to P72,	$4.5 V \le V_{DD} \le 5.5 V$				24	mA
		P120, P73	$2.7 V < V_{DD} < 4.5 V$				16	
		Total of pins P00 to P07,	$4.5 V < V_{DD} < 5.5 V$				16	mA
		P13 to P16, P30 to P37, P74	$2.7 V \le V_{DD} < 4.5 V$				11	
		to P77, (78K0/DE2) P10 to P12_P17						
		Total of pins <sup>Note 2</sup>	$4.5 V \le V_{DD} \le 5.5 V$				-23	mA
			$2.7 \text{ V} \le \text{V}_{\text{DD}} < 4.5 \text{ V}$				-18	
	Іон2	Per pin for P20 to P27	$AV_{REF} = V_{DD}$				-100	μA
		Per pin for P121 to P124						1
	Іонз	Per pin for P80 to P87, P90	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$	85°C			-27	mA
		to P97, (78K0/DE2) P10 to		25°C			-30	
		P12, P17		-40°C			-40	
			$2.7 \text{ V} \leq SMV_{DD} < 4.5 \text{ V}$	85°C			-19	
				25°C			-23	
				-40°C			-26	
		Total of pins Note 2 P80 to P87	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$	85°C			-81	
				25°C			-90	
				-40°C			-120	
			$2.7~V \leq SMV_{\text{DD}} < 4.5~V$	85°C			-64	
				25°C			-70	
				-40°C			-78	
		Total of pins Note 2 P90 to P97	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$	85°C			-81	
				25°C			-90	
			ļ	-40°C			-120	
			$2.7~V \leq SMV_{\text{DD}} < 4.5~V$	85°C			-64	
				25°C			-70	
				-40°C			-78	

**Notes 1.** Value of current at which the device operation is guaranteed even if the current flows from V<sub>DD</sub> to an output pin.

- 2. Specification under conditions where the duty factor is 70% (time for which current is output is  $0.7 \times t$  and time for which current is not output is  $0.3 \times t$ , where t is a specific time). The total output current of the pins at a duty factor of other than 70% can be calculated by the following expression.
  - Where the duty factor of IoH is n%: Total output current of pins =  $(IoH \times 0.7) / (n \times 0.01)$

<Example> Where the duty factor is 50%, Ioн = 20.0 mA

Total output current of pins = (20.0  $\times$  0.7) / (50  $\times$  0.01) = 28.0 mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.



#### DC Characteristics (2/7)

$(T_A = -40)$	to	+85°C,	2.7	۷	≤	Vdd	=	EVDD	≤	5.5	V,	2.7	v	≤	AVREF	≤	5.5	V,	2.7	v	≤	SMVDD	≤	5.5	V,
Vss = EVss	= A\	/ss = SN	//Vss	= 0	• V)	)																			

Parameter	Symbol	Con	ditions		MIN.	TYP.	MAX.	Unit
Output current, low Note 1	IOL1	Per pin for P00 to P07, P13	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$				8.5	mA
		to P16,	$2.7~V \leq V_{\text{DD}} < 4.0~V$				5.0	
		P30 to P37, P60, 61, P70 to P72, P74 to P77, P120						
		(78K0/DF2) P10 to P12. P17						
	IOL4	P73	$4.5 \text{ V} \leq \text{V}_{\text{DD}} \leq 5.5 \text{ V}$				15.0	mA
			$2.7 \text{ V} \leq \text{V}_{\text{DD}} < 4.5 \text{ V}$				8.5	
		Total of pins P70 to P72,	$4.5~V \le V_{\text{DD}} \le 5.5~V$				42	mA
		P120, P73	$2.7 \text{ V} \leq \text{V}_{\text{DD}} < 4.5 \text{ V}$				23	
		Total of pins P00 to P07,	$4.5~V \le V_{\text{DD}} \le 5.5~V$				33	mA
		P13 to P16, P30 to P37,	$2.7 \text{ V} \le \text{V}_{\text{DD}} < 4.5 \text{ V}$				27	
		P74 to P77,	_					
		(78K0/DF2) PT0 t0 PT2, P17						
		Total of pins Note 2	$4.0 V < V_{DD} < 5.5 V$				65	mA
			$2.7 V \le V_{DD} \le 4.0 V$				50	
	OL2	Per pin for P20 to P27	$AV_{REF} = V_{DD}$				400	μA
		Per pin for P121 to P124						
	Юз	Per pin for P80 to P87, P90	$4.5 V < SMV_{DD} < 5.5 V$	85°C			27	mA
	1020	to P97, (78K0/DE2) P10 to		25°C			30	
		P12, P17		_40°C			40	
			$2.7 V < SMV_{DD} < 4.5 V$	85°C			15	
				25°C			19	
				-40°C			23	
		Total of pins Note 2 P80 to P87	$4.5 \text{ V} \leq \text{SMV}_{\text{DD}} \leq 5.5 \text{ V}$	85°C			81	
				25°C			90	
				-40°C			120	
			$2.7 \text{ V} \leq SMV_{DD} < 4.5 \text{ V}$	85°C			50	
				25°C			58	
				-40°C			70	
		Total of pins Note 2 P90 to P97	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$	85°C			81	ĺ
				25°C			90	
				-40°C			120	
			$2.7 \text{ V} \leq SMV_{DD} < 4.5 \text{ V}$	85°C			50	
				25°C			58	
				-40°C			70	

**Notes 1.** Value of current at which the device operation is guaranteed even if the current flows from an output pin to GND.

- **2.** Specification under conditions where the duty factor is 70% (time for which current is output is  $0.7 \times t$  and time for which current is not output is  $0.3 \times t$ , where t is a specific time). The total output current of the pins at a duty factor of other than 70% can be calculated by the following expression.
  - Where the duty factor of IoH is n%: Total output current of pins = (IoH  $\times$  0.7) / (n  $\times$  0.01) <Example> Where the duty factor is 50%, IoH = 20.0 mA

Total output current of pins =  $(20.0 \times 0.7) / (50 \times 0.01) = 28.0 \text{ mA}$ 

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.



#### DC Characteristics (3/7)

$(T_A = -40)$	to	+85°C,	2.7	ν:	≤ V	DD =	EVDD	≤	5.5	٧,	2.7	V	≤	AVREF	≤	5.5	V,	2.7	۷	≤	SMVDD	≤	5.5	V,
Vss = EVss	= A'	Vss = SN	<b>NV</b> ss	= 0	V)																			

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
Input voltage, high	VIH1	P71 to P73, P7	76, P121 to P124, P3	0, P36	0.7V <sub>DD</sub>		VDD	V
	VIH2	P00 to P07, P1 P70, P74, P75 EXCLKS, (78K0/DF2) P1	3 to P16, P31 to P3 , P77, P120, RESET	5, P37, P60, P61, , EXCLK,	0.8Vdd		Vdd	V
	VIH3	P20 to P27		$AV_{REF} = V_{DD}$	0.7AVREF		AVREF	V
	VIH4	P80 to P87, P8	90 to P97	SMVDD = VDD	0.7SMVDD		SMVDD	V
	VIH5	(78K0/DE2) P1	0 to P12, P17	SMVDD = VDD	0.8SMVDD		SMVDD	V
Input voltage, low	VIL1	P71 to P73, P7		0, P36	0		0.3Vdd	V
	VIL2	P00 to P07, P1 P70, P74, P75 EXCLKS, (78K0/DF2) P1	3 to P16, P31 to P3 , P77, P120, RESET	5, P37, P60, P61, , EXCLK,	0		0.2Vdd	V
	VIL3	P20 to P27		$AV_{\text{REF}} = V_{\text{DD}}$	0		0.3AVREF	V
	VIL4	P80 to P87, P8	90 to P97	$SMV_{DD} = V_{DD}$	0		0.3SMVDD	V
	VIL5	(78K0/DE2) P1	0 to P12, P17	$SMV_{DD} = V_{DD}$	0		0.2SMVDD	V
Output voltage, high	V <sub>OH1</sub>	Іон = -3.0 mA	P00 to P07,	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$	V <sub>DD</sub> - 0.7			V
		Іон = −2.5 mA	P13 to P16, P30 to P37, P60, P61, P70 to P72, P74 to P77, P120, (78K0/DF2) P10 to P12, P17	$2.7~V \leq V_{DD} < 5.5~V$	$V_{\text{DD}}-0.5$			
	V <sub>OH2</sub>	Іон = -100 <i>µ</i> А	P20 to P27	$AV_{REF} = V_{DD}$	$V_{\text{DD}}-0.5$			٧
			P121 to P124					
	Vонз	$\begin{aligned} & \text{I}_{\text{OH}} = -27.0 \text{ mA} \\ & (\text{T}_{\text{A}} = 85^{\circ}\text{C}) \\ & \text{I}_{\text{OH}} = -30.0 \text{ mA} \\ & (\text{T}_{\text{A}} = 25^{\circ}\text{C}) \\ & \text{I}_{\text{OH}} = -40.0 \text{ mA} \\ & (\text{T}_{\text{A}} = 40^{\circ}\text{C}) \end{aligned}$	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	$4.5 \text{ V} \leq SMV_{\text{DD}} \leq 5.5 \text{ V}$	SMV <sub>DD</sub> – 0.5			V
		$\begin{split} & \text{Ioh} = -19.0 \text{ mA} \\ & (\text{T}_{\text{A}} = 85^{\circ}\text{C}) \\ & \text{Ioh} = -23.0 \text{ mA} \\ & (\text{T}_{\text{A}} = 25^{\circ}\text{C}) \\ & \text{Ioh} = -26.0 \text{ mA} \\ & (\text{T}_{\text{A}} = 40^{\circ}\text{C}) \end{split}$		$2.7 \text{ V} \le \text{SMV}_{\text{DD}} \le 5.5 \text{ V}$	SMV <sub>DD</sub> – 0.5			
	Vон4	Іон = -15.0 mA Іон = -9.0 mA	P73	$4.5 \text{ V} \leq \text{V}_{\text{DD}} \leq 5.5 \text{ V}$ $2.7 \text{ V} \leq \text{SMV}_{\text{DD}} \leq 5.5 \text{ V}$	$V_{DD} - 0.7$ $V_{DD} - 0.7$			V

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.



DC Charac	teris	stics (4/7	7)																						
$(T_A = -40)$	to	+85°C,	2.7	V	≤	Vdd	=	EVDD	≤	5.5	V,	2.7	V	≤	$\mathbf{AV}_{REF}$	≤	5.5	V,	2.7	V	≤	SMVDD	≤	5.5	V,
Vss = EVss	= A'	Vss = SN	/IVss	= 0	) V)																				

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
Output voltage, low	V <sub>OL1</sub>	lo∟ = 5.0 mA	P00 to P07,	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$			0.7	V
		lo <sub>L</sub> = 3.0 mA	P13 to P16, P30 to P37, P60, P61, P70 to P72, P74 to P77, P120, (78K0/DF2) P10 to P12, P17	$2.7 \text{ V} \le \text{V}_{\text{DD}} < 5.5 \text{ V}$			0.7	V
	Vol2	lol = 400 μA	P20 to P27	AVREF = VDD			0.4	V
			P121 to P124					
	Vol3	$\begin{array}{l} \text{IoL} = 27.0 \text{ mA} \\ (T_A = 85^{\circ}\text{C}) \\ \\ \text{IoL} = 30.0 \text{ mA} \\ (T_A = 25^{\circ}\text{C}) \\ \\ \text{IoL} = 40.0 \text{ mA} \\ (T_A = 40^{\circ}\text{C}) \end{array}$	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	$4.5 \text{ V} \le \text{SMV}_{\text{DD}} \le 5.5 \text{ V}$			0.5	V
		lo∟ = 15.0 mA (TA = 85°C)		$2.7~V \leq SMV_{DD} \leq 5.5~V$			0.5	V
		lo∟ = 19.0 mA (TA = 25°C)						
		lo∟ = 23.0 mA (T <sub>A</sub> = 40°C)						
	Vol4	lo∟ = 15.0 mA	P73	$4.5~V \leq V_{\text{DD}} \leq 5.5~V$			0.7	V
		loL = 8.5 mA		$2.7~V \leq SMV_{\text{DD}} \leq 5.5~V$			0.7	

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.



## DC Characteristics (5/7) (T<sub>A</sub> = -40 to +85°C, 2.7 V $\leq$ V<sub>DD</sub> = EV<sub>DD</sub> $\leq$ 5.5 V, 2.7 V $\leq$ AV<sub>REF</sub> $\leq$ 5.5 V, 2.7 V $\leq$ SMV<sub>DD</sub> $\leq$ 5.5 V, V<sub>SS</sub> = EV<sub>SS</sub> = AV<sub>SS</sub> = SMV<sub>SS</sub> = 0 V)

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
Input leakage current, high	Іция	$V_{\text{I}} = V_{\text{DD}}$	P71 to P73, P60, P61, F (78K0/DF2) P10 to P12	P120, RESET, , P17, FLMD0			1	μA
	Ilih2	$V_{\text{I}} = V_{\text{DD}}$	P74 to P77, P13 to P16 to P37	, P00 to P07, P30			10	μA
	Ілнз	$V_I = AV_{REF}$	P20 to P27	AVREF = VDD			1	μA
	ILIH4	$V_{\text{I}} = V_{\text{DD}}$	P121 to P124	I/O port mode			1	μA
			(X1, X2, XT1, XT2)	OSC mode			20	
	Ілны	VI = SMVDD	P80 to P87, P90 to P97 (78K0/DE2) P10 to P12	, , P17			10	μA
Input leakage current, low	Ilili	$V_{I} = V_{SS}$	P71 to P73, P60, P61, F (78K0/DF2) P10 to P12	P120, RESET, , P17, FLMD0			-1	μA
	Ilil2		P74 to P77, P13 to P16 to P37	, P00 to P07, P30			-10	μA
	Ililis		P20 to P27	AVREF = VDD			-1	μA
	ILIL4		P121 to P124	I/O port mode			-1	μA
			(X1, X2, XT1, XT2)	OSC mode			-20	
	Ilils		P80 to P87, P90 to P97 (78K0/DE2) P10 to P12	, , P17			-10	μA
Pull-up resistor	Ruı	Vı = Vss	P00 to P07, P13 to P16 P60, P61, P70 to P77, F (78K0/DF2) P10 to P12	5, P30 to P37, P120, , P17	10	20	100	kΩ
	Ru2	VI = SMVss	(78K0/DE2) P10 to P12	, P17	10	20	100	kΩ
Pull-down resistor	RD1	$V_{\text{I}} = SMV_{\text{DD}}$	P80 to P87, P90 to P97 (78K0/DE2) P10 to P12	, , P17	100			kΩ
	R <sub>D2</sub>	$V_{I} = V_{DD}$	P74 to P77, P13 to P16 to P37, SEG0 to SEG3	, P00 to P07, P30	100			kΩ
FLMD0 supply voltage	Vı∟	In normal of	operation mode		0		0.2VDD	V
	VIH	In self proo	gramming mode		0.8VDD		Vdd	V

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.


# DC Characteristics (6/7) (T<sub>A</sub> = -40 to +85°C, 2.7 V $\leq$ V<sub>DD</sub> = EV<sub>DD</sub> $\leq$ 5.5 V, 2.7 V $\leq$ AV<sub>REF</sub> $\leq$ 5.5 V, 2.7 V $\leq$ SMV<sub>DD</sub> $\leq$ 5.5 V, V<sub>SS</sub> = EV<sub>SS</sub> = AV<sub>SS</sub> = SMV<sub>SS</sub> = 0 V)

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
Supply current <sup>Note 1</sup>		Operating	$f_{IN} = 20 \text{ MHz}^{Note 2},$	Square wave input		3.4	7.6	mA
		mode	$V_{DD} = 5.0 V$	Resonator connection		4.7	8.9	
			$f_{IN} = 10 \text{ MHz}^{Notes 2, 3},$	Square wave input		1.8	4.4	
			V <sub>DD</sub> = 5.0 V	Resonator connection		2.7	5.5	
		$f_{IN} = 10 \text{ MHz}^{\text{Notes 2, 3}},$		Square wave input		1.7	4.3	
			$V_{DD} = 3.0 V$	Resonator connection		2.4	4.7	
			$f_{IN} = 5 \text{ MHz}^{Notes 2, 3},$	Square wave input		1.0	2.4	
			$V_{DD} = 3.0 V$	Resonator connection		1.4	2.7	
			fosca = 8 MHz <sup>Note 4</sup> , VDD = 5	5.0 V		1.9	3.1	
			fsuв = 32.768 kHz <sup>Note 5</sup> ,	Square wave input		6.1	40	μA
			$V_{DD} = 5.0 V$	Resonator connection		15.4	45	
	IDD2	HALT mode	$f_{IN} = 20 \text{ MHz}^{Note 2},$	Square wave input		1.1	4.7	mA
			$V_{DD} = 5.0 V$	Resonator connection		2.2	6.2	
			$f_{IN} = 10 \text{ MHz}^{Notes 2, 3},$	Square wave input		0.6	2.7	
			V <sub>DD</sub> = 5.0 V	Resonator connection		1.2	3.6	
			$f_{IN} = 5 \text{ MHz}^{Notes 2, 3},$	Square wave input		0.3	1.3	
			V <sub>DD</sub> = 3.0 V	Resonator connection		0.6	1.8	
			fosca = 8 MHz <sup>Note 4</sup> , VDD = 5	5.0 V		0.5	1.9	
			fsub = 32.768 kHz <sup>Note 5</sup> ,	Square wave input		3.1	35	μA
			$V_{DD} = 5.0 V$	Resonator connection		12.4	40	

Notes 1. Total current flowing into the internal power supply (V<sub>DD</sub>, EV<sub>DD</sub>, SMV<sub>DD</sub>), including the peripheral operation current and the input leakage current flowing when the level of the input pin are fixed to V<sub>DD</sub> or V<sub>SS</sub>. However, the current flowing into the pull-up resistors and the output current of the port is not included.

- 2. Not including the operating current of the 8 MHz internal oscillator, XT1 oscillation, 240 kHz internal oscillator and the current flowing into the A/D converter, watchdog timer, LVI circuit, LCD controller/driver and ZPD.
- **3.** When AMPH (bit 0 of clock operation mode select register (OSCCTL)) = 0.
- Not including the operating current of the X1 oscillation, XT1 oscillation and 240 kHz internal oscillator. Not
  including the current flowing into the A/D converter, watchdog timer, LVI circuit, LCD controller/driver and
  ZPD.
- 5. Not including the operating current of the X1 oscillation, 8 MHz internal oscillator and 240 kHz internal oscillator, and the current flowing into the A/D converter, watchdog timer, LVI circuit, LCD controller/driver and ZPD.
- Remarks 1. fin: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. fosca: Internal high-speed oscillation clock frequency
  - 3. fsub: Subsystem clock frequency (XT1 clock oscillation frequency or external subsystem clock frequency)

# DC Characteristics (7/7) (TA = -40 to +85°C, 2.7 V $\leq$ VDD = EVDD $\leq$ 5.5 V, 2.7 V $\leq$ AVREF $\leq$ 5.5 V, 2.7 V $\leq$ SMVDD $\leq$ 5.5 V, Vss = EVss = AVss = SMVss = 0 V)

Parameter	Symbol	Conditions				TYP.	MAX.	Unit
Supply current Note 1	DD3 Note 2	STOP mode	V <sub>DD</sub> = 5.0 V	$T_A = -40 \text{ to } +70^{\circ}\text{C}$		1	10	μA
			(CREG+POC)	$T_A = -40 \text{ to } +85^{\circ}\text{C}$		1	20	
Watchdog timer operating current	WDT Note 3	During 240 kHz internal low-speed oscillation clock operation				5	10	μA
LVI operating current	LVI Note 4					9	18	μA
A/D converter operating current	ADC Note 5					0.86	1.9	mA
LCD controller/driver	LCD1 Note 6	fPRS = 20 MHz LC	LCD non-display	$V_{DD} = 5.0 V$		180	350	μA
operating current	g current LCD source	LCD source	waveform output	$V_{DD} = 3.0 V$		120	250	
	LCD2 Note 6	$f_{PRS}/2^7$	LCD display waveform output	$V_{DD} = 5.0 V$		180	350	μA
		$f_{PRS}/2^7$ LCD clock = $f_{LCD}/2^4$ Four-time-slice display		$V_{DD} = 3.0 V$		120	250	
ZPD operating current	Izpd	One ZPD circu	it operating	VDD = 5.0 V		0.15	0.6	mA
				$V_{DD} = 3.0 V$		0.12	0.5	
		Four ZPD circu	its operating	$V_{DD} = 5.0 V$		0.5	2.0	
				$V_{DD} = 3.0 V$		0.4	1.6	

**Notes 1.** Total current flowing into the internal power supply (VDD, EVDD, SMVDD), including the peripheral operation current and the input leakage current flowing when the level of the input pin are fixed to VDD or Vss. However, the current flowing into the pull-up resistors and the output current of the port is not included.

- **2.** Not including the operating current of the 240 kHz internal oscillator and XT1 oscillation, and the current flowing into the A/D converter, watchdog timer, LVI circuit, LCD controller/driver and ZPD.
- **3.** Current flowing only to the watchdog timer (V<sub>DD</sub>-pin) (including the operating current of the 240 kHz internal oscillator). The current value of the 78K0/Dx2 is the sum of I<sub>DD2</sub> or I<sub>DD3</sub> and IWDT when the watchdog timer operates in the HALT or STOP mode.
- 4. Current flowing only to the LVI circuit (V<sub>DD</sub>-pin). The current value of the 78K0/Dx2 is the sum of I<sub>DD2</sub> or I<sub>DD3</sub> and ILVI when the LVI circuit operates in the HALT or STOP mode.
- 5. Current flowing only to the A/D converter (AVREF-pin). The current value of the 78K0/Dx2 is the sum of IDD1 or IDD2 and IADC when the A/D converter operates in an operation mode or the HALT mode.
- 6. Including the operating current flowing in the internal division resistor.



# 29.4 AC Characteristics

# (1) Basic operation

# $(T_{\text{A}} = -40 \text{ to } +85^{\circ}\text{C}, 2.7 \text{ V} \leq \text{V}_{\text{DD}} = \text{EV}_{\text{DD}} \leq 5.5 \text{ V}, 2.7 \text{ V} \leq \text{AV}_{\text{REF}} \leq 5.5 \text{ V}, \text{Vss} = \text{EV}_{\text{SS}} = \text{AV}_{\text{SS}} = \text{SMV}_{\text{SS}} = 0 \text{ V})$

Parameter	Symbol	Conditio	ons	MIN.	TYP.	MAX.	Unit
Instruction cycle (minimum	Тсү	Main system clock	$4.0~V \leq V_{DD} \leq 5.5~V$	0.1		32	μS
instruction execution time)		(fmain) operation	$2.7~V \leq V_{\text{DD}} < 4.0~V$	0.2		32	
		Subsystem clock (fs	suв) operation	114	122	125	
Peripheral hardware clock	fprs	XSEL = 1	$4.0~V \leq V_{DD} \leq 5.5~V$			20	MHz
frequency			$2.7~V \leq V_{\text{DD}} < 4.0~V$			10	
		XSEL = 0	$2.7~V \leq V_{\text{DD}} < 4.0~V$	7.6		8.4	
External main system clock	fext	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$		4.0		20	MHz
frequency		$2.7~V \leq V_{\text{DD}} < 4.0~V$		4.0		10	
External clock input high level width, low level width	fexth, fextl			(1/fext×1/2)-1			ns
External subsystem clock frequency	fexts			32	32.768	35	kHz
External sub clock input high level width, low level width,	fextsн, fextsl			(1/fexts×1/2)-5			ns
TIOP00, 01, 10, 11, 20, 21, 30,	ft15	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$				10	MHz
31, 40, 41, TIO50, 51 input frequency		$2.7~V \leq V_{\text{DD}} < 4.0~V$				10	
TIOP00, 01, 10, 11, 20, 21, 30,	tтiнs,	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$		50			ns
31, 40, 41, TIO50, 51 input high- level width, low-level width	t⊤ı∟₅	$2.7~V \leq V_{\text{DD}} < 4.0~V$		50			
Interrupt input high-level width, low-level width	tınıн, tını∟			1			μS
RESET low-level width	trsl			10			μs





TCY vs. VDD (Main System Clock Operation)



0.2Vdd

#### AC Timing Test Points (Excluding X1, XT1)



### External clock input timing



**TI Timing** 



#### **Interrupt Request Input Timing**





#### (2) Serial interface

 $(T_A = -40 \text{ to } +85^{\circ}C, 2.7 \text{ V} \le V_{DD} = EV_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le AV_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le SMV_{DD} \le 5.5 \text{ V}, V_{SS} = EV_{SS} = AV_{SS} = SMV_{SS} = 0 \text{ V})$ 

#### (a) UART6n (Dedicated baud rate generator output)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Transfer rate					625	kbps

#### (b) IIC0

Parameter	Symbol	Conditions	;	Standard Mode		High-Speed Mode		Unit
				MIN.	MAX.	MIN.	MAX.	
SCL0 clock frequency	fськ			0	100	0	400	kHz
Setup time of start/restart condition	tsu: sta			4.7		0.6		μS
Hold time <sup>Note 1</sup>	thd: STA			4.0		0.6		μS
Hold time when SCL0 = "L"	<b>t</b> LOW			4.7		1.3		μS
Hold time when SCL0 = "H"	<b>t</b> high			4.0		0.6		μS
Data setup time (reception)	tsu: dat			250		100		ns
Data hold time (transmission) <sup>Note</sup>	thd: dat	$f_W = f_{IN}/2^N$	DFC0 =	0	3.45	0	0.9 <sup>Note 4</sup>	μS
2		selected <sup>Note 3</sup>	0				1.0 <sup>Note 5</sup>	
			DFC0 =			0	0.9 <sup>Note 6</sup>	
			1				1.125 <sup>Note</sup> 7	
		$f_W = f_{OSC8}/2^N$ selected <sup>Note 3</sup>	DFC0 = 0	0	3.45	0	1.05	
			DFC0 = 1			0	1.184	
Setup time of stop condition	tsu: sto			4.0		0.6		μS
Bus free time between stop and start conditions	t <sub>BUF</sub>			4.7		1.3		μS

Notes 1. The first clock pulse is generated after this period when the start/restart condition is detected.

2. The maximum value (MAX.) of the during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

- 3. fw indicates the IIC0 transfer clock selected by the IICCL and IICX0 registers.
- **4.** When  $fw \ge 4$  MHz is selected
- 5. When fw < 4 MHz is selected
- 6. When  $fw \ge 5$  MHz is selected
- 7. When fw < 5 MHz is selected

 $\textbf{Remark} \quad n=0,\ 1$ 



Parameter	Symbol	Condition	Conditions		TYP.	MAX.	Unit
SCK1n cycle time	tксүт	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$	78K0/DE2	250			ns
			78K0/DF2	200			ns
		$2.7~V \leq V_{\text{DD}} < 4.0~V$	78K0/DE2	500			ns
			78K0/DF2	400			ns
SCK1n high-/low-level width Note 1	tкнı,	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$		tксү1/2 – 20			ns
	tĸ∟ı	$2.7~V \leq V_{\text{DD}} < 4.0~V$		tксү1/2 – 30			ns
SI1n setup time (to SCK1n↑)	tsik1	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$		70			ns
		$2.7~V \leq V_{\text{DD}} < 4.0~V$		100			ns
SI1n hold time (from SCK1n↑)	tksi1			30			ns
Delay time from $\overline{\text{SCK1n}}\downarrow$ to	tkso1	C = 50 pF Note 2	78K0/DE2			50	ns
SO1n output			78K0/DF2			40	ns

# (c) CSI1n (Master mode, SCK1n... internal clock output)

Notes 1. It is value at the time of fx use. Keep in mind that spec different at the time of fosce use.

**2.** C is the load capacitance of the  $\overline{\text{SCK1n}}$  and SO1n output lines.

# (d) CSI1n (Slave mode, SCK1n... external clock input)

Parameter	Symbol	Conditio	ons	MIN.	TYP.	MAX.	Unit
SCK1n cycle time	<b>t</b> ксү2	78K0/DE2		800			ns
		78K0/DF2		400			ns
SCK1n high-/low-level width	tкн2,			tксү2/2			ns
	tĸL2						
SI1n setup time (to SCK1n↑)	tsik2			80			ns
SI1n hold time (from $\overline{\text{SCK1n}}$ )	tksi2			50			ns
Delay time from $\overline{\text{SCK1n}}\downarrow$ to	tkso2	$C = 50 \text{ pF}^{\text{Note}}$	78K0/DE2			380	ns
SO1n output			78K0/DF2			120	ns

**Note** C is the load capacitance of the SO1n output line.

**Remark** n = 0, 1



#### Serial Transfer Timing

IIC0:



CSI1n:



# $\textbf{Remark} \quad m=1,\,2$

n = 0, 1



# 78K0/Dx2

#### (3) CAN controller

 $(T_A = -40 \text{ to } +85^{\circ}C, 2.7 \text{ V} \le V_{DD} = EV_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le AV_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le SMV_{DD} \le 5.5 \text{ V}, V_{SS} = EV_{SS} = AV_{SS} = SMV_{SS} = 0 \text{ V})$ 

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Transfer rate					1	Mbps
Internal delay time	<b>t</b> NODE				100	ns



Internal delay time (tNODE) = Internal Transfer Delay (toutput) + Internal Receive Delay (tinput)

Note CAN Internal clock (fcan): CAN baud rate clock





# (4) A/D Converter Characteristics

 $(T_A = -40 \text{ to } +85^{\circ}C, 2.7 \text{ V} \le V_{DD} = EV_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le AV_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le SMV_{DD} \le 5.5 \text{ V}, V_{SS} = EV_{SS} = AV_{SS} = SMV_{SS} = 0 \text{ V})$ 

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Resolution	RES				10	bit
Overall error <sup>Notes 1, 2</sup>	AINL	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±0.4	%FSR
		$2.7 \text{ V} \le \text{AV}_{\text{REF}} < 5.5 \text{ V}$			±0.6	
Conversion time	<b>t</b> CONV	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$	6.1		36.7	μS
		$2.7~V \leq AV_{\text{REF}} < 5.5~V$	6.1		36.7	
Zero-scale error <sup>Notes 1, 2</sup>	Ezs	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±0.4	%FSR
		$2.7~V \leq AV_{\text{REF}} < 5.5~V$			±0.6	
Full-scale error <sup>Notes 1, 2</sup>	EFS	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±0.4	%FSR
		$2.7 \text{ V} \le \text{AV}_{\text{REF}} < 5.5 \text{ V}$			±0.6	
Integral non-linearity error <sup>Note 1</sup>	ILE	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±2.5	LSB
		$2.7 \text{ V} \leq AV_{\text{REF}} < 5.5 \text{ V}$			±4.5	
Differential non-linearity error Note 1	Dle	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±1.5	LSB
		$2.7 \text{ V} \leq \text{AV}_{\text{REF}} < 5.5 \text{ V}$			±2.0	
Analog input voltage	VAIN		AVss		AVREF	V

**Notes 1.** Excludes quantization error ( $\pm 1/2$  LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.



#### (5) Meter controller/driver and ZPD characteristics

 $(T_A = -40 \text{ to } +85^{\circ}C, 2.7 \text{ V} \le V_{DD} = EV_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le AV_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le SMV_{DD} \le 5.5 \text{ V}, V_{SS} = EV_{SS} = AV_{SS} = SMV_{SS} = 0 \text{ V})$ 

Parameter	Symbol		Conditions	MIN.	TYP.	MAX.	Unit
Meter controller/driver input	fmc Note 1	V <sub>DD</sub> = 4.5 V to 5	V <sub>DD</sub> = 4.5 V to 5.5 V			20	MHz
frequency						10	
PWM output rise time	tR	$C=50 \text{ pF}^{\text{Note 2}}$	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$	30	60	90	ns
		(10% - 90%)	$2.7~V \leq SMV_{\text{DD}} \leq 5.5~V$	60	120	250	
PWM output fall time	t⊨	$C=50 \ pF^{Note \ 2}$	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$	30	60	90	ns
		(10% - 90%)	$2.7~V \leq SMV_{\text{DD}} \leq 5.5~V$	60	140	250	
Peak cross current Note 3	Icross					50	mA
Output pulse width Note 4	tмо			125			ns
Output pulse length deviation Note 5	<b>t</b> SMDEV			-40		+10	ns
Symmetry performance Note 6	ΔHSPmn	Іон = –27 mA				50	mV
		∆HSPmn =  Vон	[(SMmn)max-(SMmn)min]				
	∆HSPmn	lo∟ = 27 mA ΔHSPmn =  Vo∟	[(SMmn)max-(SMmn)min]			50	mV

Notes 1. Source clock of the free-running counter.

- 2. C is the load capacitance of the PWM output line.
- 3. The slew rate control generates a cross current in the output stage to control the energy of the external inductive load. The cross current flows only during the output transition time t<sub>R</sub>, t<sub>F</sub>. It flows in addition to the output current. The cross current is not tested, but derived from simulation.
- **4.** The output buffer can not generate high or low pulses shorter than this time, because of its slew rate control system. This value is not tested, but derived from simulation.
- **5.** The slew rate control function causes a deviation of output pulse time compared to the ideal selected output pulse setting. This value is not tested, but derived from simulation.
- 6. Indicates the dispersion of up to 16 PWM output voltages. Not tested in production, specified by design.

**Remark** m = 1 to 4, n = 1 to 4

#### Meter Controller/Driver Output Timing





Parameter	Symbol	С	conditions	MIN.	TYP.	MAX.	Unit
Threshold voltage	Vzpd	0-point detection 000	80	150	220	mV	
		0-point detection 001	180	250	320		
		0-point detection 010	280	350	420		
		0-point detection 011	0-point detection voltage setting (ZPDSn) = 011			520	
		0-point detection 100	voltage setting (ZPDSn) =	480	550	620	
Detection delay	tzpdd	100 mV step, 50 mV overdrive	SMV <sub>DD</sub> = 4.75 V to 5.25 V			100 <sup>Note</sup>	ns
		(see the figure below)	SMV <sub>DD</sub> = 2.7 V to 5.5 V			100 <sup>Note</sup>	
Operation stabilization wait time	tzpdw	Reference voltage comparator stabil	e stabilization + ZPD ization			1+5 = 6	μS

Note Not tested in production, specified by design.

#### **ZPD** Timing





#### (6) Sound generator characteristics

 $(T_A = -40 \text{ to } +85^{\circ}C, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$ 

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Sound generator input frequency	fsgo	V <sub>DD</sub> = 4.5 V to 5.5 V				10	MHz
						5	MHz
SGO output rise time	tR	C = 100 pF	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$			200	ns
			$2.7~V \leq SMV_{\text{DD}} \leq 5.5~V$			200	ns
SGO output fall time	t⊧	C = 100 pF	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$			200	ns
			$2.7~V \leq SMV_{\text{DD}} \leq 5.5~V$			200	ns

# Sound Generator Output Timing





# (7) POC circuit characteristics

(T <sub>A</sub> = -40 to +85°C, Vss = E	$(1_{A} = -40 \text{ to } +85^{\circ}\text{C}, \text{ Vss} = \text{EVss} = 0 \text{ V})$							
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit		
Detection voltage	V <sub>POC0</sub>		1.44	1.59	1.74	V		
Power supply rise time	<b>t</b> PTH	VDD: 0 V $\rightarrow$ VPOCO			0.5	V/ms		
Minimum pulse width Note	tew	When the voltage drops	200			μS		

**Note** When the voltage drops in shorter width than the minimum pulse width, the operation of POC detection isn't guaranteed.

### **POC Circuit Timing**





# (8) LVI circuit characteristics

(TA = -40 to +85°C, VPOC  $\leq$  VDD = EVDD  $\leq$  5.5 V, Vss = EVss = 0 V)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection	Supply voltage level	VLVIO		4.14	4.24	4.34	V
voltage		VLVI1		3.99	4.09	4.19	V
		VLVI2		3.83	3.93	4.03	V
		VLVI3		3.68	3.78	3.88	V
		VLVI4		3.52	3.62	3.72	V
		VLVI5		3.37	3.47	3.57	V
		VLVI6		3.22	3.32	3.42	V
		VLVI7		3.06	3.16	3.26	V
		VLVI8		2.91	3.01	3.11	V
		VLVI9		2.75	2.85	2.95	V
		VLVI10		2.60	2.70	2.80	V
	External input pin <sup>Note 1</sup>	EXLVI	$\text{EX}_{\text{LVI}} < \text{V}_{\text{DD}},  2.7   \text{V} \leq \text{V}_{\text{DD}} \leq 5.5   \text{V}$	1.11	1.21	1.31	V
	Detection voltage on application of supply voltage	VDDLVI	LVISTART (option byte) = 1	2.50	2.70	2.90	V
Minimum pulse width		t∟w		200			μS
Operation st	abilization wait time <sup>Note 2</sup>	tlwait1				10	μS

Notes 1. External input pin is alternate P120 pin.

2. Time required from setting LVION to 1 to operation stabilization.

**Remark**  $V_{LVI(n-1)} > V_{LVIn} (n = 1 \text{ to } 10)$ 

#### LVI Circuit Timing





#### (9) Power supply starting time

 $(T_A = -40 \text{ to } +85^{\circ}C, V_{SS} = EV_{SS} = 0 \text{ V})$ 

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Starting maximum time to $V_{DD}$ min (2.7 V) <sup>Note</sup>	tPUP1	LVI starting option invalid			3.6	ms
(V <sub>DD</sub> : 0 V→2.7 V)		When pin RESET intact				
Starting maximum time to VDD min (2.7 V)Note	tPUP2	LVI starting option invalid			1.9	ms
(pin RESET release→V <sub>DD</sub> : 2.7 V)		When pin RESET use				

Note Start a power supply in time shorter than this when LVI staring option invalid.



Pin RESET intact

Pin RESET use



#### (10) LCD circuit characteristics

## (a) Static display mode

 $(T_A = -40 \text{ to } +85^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} \le \text{EV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = 0 \text{ V})$ 

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
LCD drive voltage	VLCD				VDD	V
LCD divider resistor Note 1	RLCD		5	15	45	kΩ
LCD output resistor (Common)Note 2	Rodc				40	kΩ
LCD output resistor (Segment) <sup>Note 3</sup>	Rods				200	kΩ

#### (b) 1/3 bias method

#### $(T_A = -40 \text{ to } +85^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} \le \text{EV}_{DD} \le 5.5 \text{ V}, \text{ V}_{SS} = \text{EV}_{SS} = 0 \text{ V})$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
LCD drive voltage	VLCD				VDD	V
LCD divider resistor Note 1	RLCD		5	15	45	kΩ
LCD output resistor (Common)Note 2	Rodc				40	kΩ
LCD output resistor (Segment) <sup>Note 3</sup>	Rods				200	kΩ

**Notes 1.** Internal resistance division method only.

- 2. The output resistor is consisted by the internal equivalent resistance from COM pin and the buffer resistance of common IO.
- **3.** The output resistor is consisted by the internal equivalent resistance from SEG pin and the buffer resistance of segment IO.



#### 29.5 Data Retention Characteristics

#### Data Memory STOP Mode Low Supply Voltage Data Retention Characteristics (T<sub>A</sub> = -40 to +85°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention supply voltage	VDDDR		1.44 <sup>Note</sup>		5.5	V

**Note** The value depends on the POC detection voltage. When the voltage drops, the data is retained until a POC reset is effected, but data is not retained when a POC reset is effected.

#### **Data Retention Timing**





# 29.6 Flash EEPROM Programming Characteristics

# (1) Basic characteristics

```
(TA = -40 to +85°C, 2.7 V \leq VDD = EVDD \leq 5.5 V, Vss = EVss = 0 V)
```

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
VDD supply current	IDD					4.5	11.0	mA
Number of rewrites per chip <sup>Note</sup>	of rewrites per C <sub>erwr</sub> 1 erase + When a 1 write program after erase librarie = 1 rewrite Electro		When a flash memory programmer is used, and the libraries provided by Renesas Electronics are used	Retention: 15 years	1000			Times
			When the EEPROM emulation libraries provided by Renesas Electronics are used, and the rewritable ROM size is 4 KB	Retention: 5 years	10000			Times

**Note** When a product is first written after shipment, "erase  $\rightarrow$  write" and "write only" are both taken as one rewrite.



#### CHAPTER 30 ELECTRICAL SPECIFICATIONS ((A2) GRADE PRODUCTS)

Caution The 78K0/Dx2 has an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.

#### **30.1 Absolute Maximum Ratings**

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage	VDD		-0.5 to +6.5	V
	EVDD		-0.5 to +6.5	v
	Vss		–0.5 to +0.3	V
	EVss		–0.5 to +0.3	V
	SMVDD		–0.5 to +6.5	v
	SMVss		–0.5 to +0.3	V
	AVREF		-0.5 to V <sub>DD</sub> +0.3 <sup>Note</sup>	V
	AVss		-0.5 to +0.3	v
REGC pin Input voltage	VREGC		$-0.5 \text{ to } +3.6$ and $\leq V_{\text{DD}}$	V
Input voltage	Vii	P00 to P07, P13 to P16, P30 to P37, P60, P61, P70 to P77, P120 to P124, (78K0/DF2) P10 to P12, P17, X1, X2, XT1, XT2, RESET, FLMD0	-0.3 to V <sub>DD</sub> +0.3 <sup>Note</sup>	V
	V <sub>12</sub>	P20 to P27	$-0.3$ to AVREF +0.3 $^{\text{Note}}$ and $-0.3$ to V_DD +0.3 $^{\text{Note}}$	V
	V <sub>I3</sub>	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	$-0.3$ to SMV_DD +0.3 $^{\text{Note}}$ and $-0.3$ to V_DD +0.3 $^{\text{Note}}$	V
Output voltage	Vo1	P00 to P07, P13 to P16, P30 to P37, P60, P61, P70 to P77, P120 to P124, (78K0/DF2) P10 to P12, P17	-0.3 to V <sub>DD</sub> +0.3 <sup>Note</sup>	V
	V <sub>O2</sub>	P20 to P27	-0.3 to AVREF +0.3 Note	V
	V <sub>O3</sub>	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	-0.3 to SMV <sub>DD</sub> +0.3 <sup>Note</sup>	V
Analog input voltage	Van	ANI0 to ANI7	$-0.3$ to $AV_{\text{REF}}$ +0.3 $^{\text{Note}}$ and $-0.3$ to $V_{\text{DD}}$ +0.3 $^{\text{Note}}$	V

#### Absolute Maximum Ratings (T<sub>A</sub> = 25°C) (1/2)

Note Must be 6.5 V or lower.

- Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.
- **Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.

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#### Absolute Maximum Ratings (T<sub>A</sub> = 25°C) (2/2)

Parameter	Symbol		Conditions	Ratings	Unit	
ZPD detection input voltage	Vzpd	ZPD14, ZPD24, 2	ZPD34, ZPD44	-0.3 to SMV_DD +0.3 $^{\text{Note}}$ and -0.3 to V_DD +0.3 $^{\text{Note}}$	V	
Output current, high	Іон1	Per pin	P00 to P07, P13 to P16, P30 to P37, P70 to P72 , P74 to P77, P120, (78K0/DF2) P10 to P12, P17	-10	mA	
	Іон5	Per pin	P73	-20	mA	
		Total of above	P70 to P72, P120, P73	-25	mA	
		pins –80 mA	P00 to P07, P13 to P16, P30 to P37, P74 to P77, (78K0/DF2) P10 to P12, P17	-55		
	Іон2	Per pin	P20 to P27	-0.5	mA	
		Total of all pins		-2		
	Іонз	Per pin	P121 to P124	-1	mA	
		Total of all pins		-4		
	Іон4	Per pin	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	-45	mA	
		Total of all pins	P80 to P87, P90 to P93 ((78K0/DE2) P10 to P12, P17)	-190		
			P94 to P97	-105		
Output current, low	Iol1	Per pin	P00 to P07, P13 to P16, P30 to P37, P70 to P72, P74 to P77, P120, (78K0/DF2) P10 to P12, P17	30	mA	
	Iol5	Per pin	P73	20	mA	
		Total of above	P70 to P72, P120, P73	60	mA	
		pins 200 mA	P00 to P07, P13 to P16, P30 to P37, P74 to P77, (78K0/DF2) P10 to P12, P17	140		
	IOL2	Per pin	P20 to P27	1	mA	
		Total of all pins		5		
	Iol3	Per pin	P121 to P124	4	mA	
		Total of all pins		10		
	Iol4	Per pin	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	45	mA	
		Total of all pins	P80 to P87, P90 to P93 ((78K0/DE2) P10 to P12, P17)	180		
			P94 to P97	105		
Operating ambient	Та	In normal operation	on mode	-40 to +105	°C	
temperature		In flash memory p	programming mode	-40 to +105		
Storage temperature	Tstg			–65 to +150	°C	

Note Must be 6.5 V or lower.

- Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.
- **Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.

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#### **30.2 Oscillator Characteristics**

(1) Main System Clock (Crystal/Ceramic) Oscillator Characteristics

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$ 

Resonator	Recommended Circuit	Parameter	Conditions	MIN.	TYP.	MAX.	Unit
Ceramic resonator	X1 clock oscillation frequency (fx) <sup>Note</sup>	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$	4.0		20	MHz	
		$2.7~V \leq V_{\text{DD}} < 4.0~V$	4.0		10		
Crystal resonator	X1 clock oscillation frequency (fx) <sup>Note</sup>	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$	4.0		20	MHz	
		$2.7 \text{ V} \leq \text{V}_{\text{DD}} < 4.0 \text{ V}$	4.0		10		

Note Indicates only oscillator characteristics. Refer to AC Characteristics for instruction execution time.

Cautions 1. When using the X1 oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
- Do not cross the wiring with the other signal lines.
- Do not route the wiring near a signal line through which a high fluctuating current flows.
- Always make the ground point of the oscillator capacitor the same potential as Vss.
- Do not ground the capacitor to a ground pattern through which a high current flows.
- Do not fetch signals from the oscillator.
- 2. Since the CPU is started by the 8 MHz internal oscillator after reset, check the oscillation stabilization time of the main system clock using the oscillation stabilization time counter status register (OSTC). Determine the oscillation stabilization time of the OSTC register and oscillation stabilization time select register (OSTS) after sufficiently evaluating the oscillation stabilization time with the resonator to be used.
- **Remark** For the resonator selection and oscillator constant, customers are requested to either evaluate the oscillation themselves or apply to the resonator manufacturer for evaluation.



#### (2) On-chip Internal Oscillator Characteristics

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$ 

Resonator	Parameter	Conditions		MIN.	TYP.	MAX.	Unit
8 MHz internal oscillator	Internal high-speed oscillation	RSTS = 1	$2.7~V \leq V_{\text{DD}} \leq 5.5~V$	7.6	8	8.4	MHz
	clock frequency (foscs) Note	RSTS = 0	2.48	5	9.86		
240 kHz internal oscillator	Internal low-speed oscillation clock frequency (fosc)	$2.7~V \leq V_{\text{DD}} \leq 5.5~V$		216	240	264	kHz

Note Indicates only oscillator characteristics. Refer to AC Characteristics for instruction execution time.

Remark RSTS: Bit 7 of the internal oscillation mode register (RCM)

#### (3) Subsystem Clock Oscillator Characteristics

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$ 

Resonator	Recommended Circuit	Parameter	Conditions	MIN.	TYP.	MAX.	Unit
Crystal resonator	Vss XT2 XT1 Rd C4 = C3 = ₩	XT1 clock oscillation frequency (f <sub>XT</sub> ) <sup>Note</sup>		32	32.768	35	kHz

Note Indicates only oscillator characteristics. Refer to AC Characteristics for instruction execution time.

Cautions 1. When using the XT1 oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
- Do not cross the wiring with the other signal lines.
- Do not route the wiring near a signal line through which a high fluctuating current flows.
- Always make the ground point of the oscillator capacitor the same potential as Vss.
- Do not ground the capacitor to a ground pattern through which a high current flows.
- Do not fetch signals from the oscillator.
- 2. The subsystem clock oscillator is designed as a low-amplitude circuit for reducing power consumption, and is more prone to malfunction due to noise than the high-speed system clock oscillator. Particular care is therefore required with the wiring method when the subsystem clock is used.
- **Remark** For the resonator selection and oscillator constant, customers are requested to either evaluate the oscillation themselves or apply to the resonator manufacturer for evaluation.



#### **30.3 DC Characteristics**

#### DC Characteristics (1/7)

# $(T_A = -40 \text{ to } +105^{\circ}C, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$

Parameter	Symbol	Con	ditions		MIN.	TYP.	MAX.	Unit
Output current, high Note 1	Іон1	Per pin for P00 to P07, P13	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$				-2.5	mA
		to P16, P30 to P37, P60, 61,	$2.7 \text{ V} \leq \text{V}_{\text{DD}} < 4.0 \text{ V}$				-2.0	
		P70 to P72, P74 to P77,						
		P120,						
		(78K0/DF2) P10 to P12, P17						
	IOH4	P73	$4.5 V \leq V DD \leq 5.5 V$				-13.0	mΑ
		<b>T</b>	$2.7 \text{ V} \leq \text{V}_{DD} < 4.5 \text{ V}$				-7.5	
		Total of pins P70 to P72,	$4.5 \text{ V} \leq \text{V}_{\text{DD}} \leq 5.5 \text{ V}$				20	mA
		P120, P73	$2.7 \text{ V} \leq \text{V}_{DD} < 4.5 \text{ V}$				12	
		Total of pins P00 to P07,	$4.5 \text{ V} \leq \text{V}_{\text{DD}} \leq 5.5 \text{ V}$				15	mA
		P13 to P16, P30 to P37, P74	$2.7 V \le V_{DD} < 4.5 V$				10	
		(78K0/DE2) P10 to P12 P17						
		Total of pins <sup>Note 2</sup>	$45V \le V_{DD} \le 55V$				_16	mA
			$27V \le V_{DD} \le 3.5V$				_14	
	Он2	Per pin for P20 to P27					_100	Δ
	10112	Per pin for P121 to P124					100	μη
	Юнз	Per pin for P80 to P87 P90	$45V \leq SMV_{DD} \leq 55V$	105°C			_21	mA
	10110	to P97. (78K0/DE2) P10 to		85°C			_27	
		P12, P17		25°C			_30	
				_40°C			-40	
			$27 \text{ V} \leq \text{SMV}_{DD} \leq 45 \text{ V}$	105°C			-19	
				85°C			-19	
				25°C			-23	
				_40°C			-26	
		Total of pins Note 2 P80 to P87	$4.5 V < SMV_{DD} < 5.5 V$	105°C			-63	
				85°C			-81	
				25°C			-90	
				-40°C			-120	
			$2.7 \text{ V} \le \text{SMV}_{\text{DD}} < 4.5 \text{ V}$	105°C			-58	
				85°C			-64	
				25°C			-70	
				-40°C			-78	
		Total of pins Note 2 P90 to P97	$4.5 \text{ V} \leq \text{SMV}_{\text{DD}} \leq 5.5 \text{ V}$	105°C			-63	
		·		85°C			-81	
				25°C			-90	
				_40°C			-120	
			$2.7 \text{ V} \leq SMV_{DD} < 4.5 \text{ V}$	105°C			-58	
				85°C			-64	
				25°C			-70	
				-40°C			-78	

Notes 1. Value of current at which the device operation is guaranteed even if the current flows from VDD to an output pin.

2. Specification under conditions where the duty factor is 70% (time for which current is output is  $0.7 \times t$  and time for which current is not output is  $0.3 \times t$ , where t is a specific time). The total output current of the pins at a duty factor of other than 70% can be calculated by the following expression.

• Where the duty factor of IoH is n%: Total output current of pins = (IoH  $\times$  0.7) / (n  $\times$  0.01)

<Example> Where the duty factor is 50%, Іон = 20.0 mA

Total output current of pins =  $(20.0 \times 0.7) / (50 \times 0.01) = 28.0 \text{ mA}$ 

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.



#### DC Characteristics (2/7)

$(T_A = -40)$	to +105°C,	2.7	V ≤	Vdd	=	EVDD	≤	5.5	۷,	2.7	V	≤	AVREF	≤	5.5	۷,	2.7	V	≤	SMVDD	≤	5.5	V,
Vss = EVss	= AVss = SM	Vss =	0 V)																				

Parameter	Symbol	Con	ditions		MIN.	TYP.	MAX.	Unit
Output current, low Note 1	IOL1	Per pin for P00 to P07, P13	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$				5.0	mA
		to P16,	$2.7~V \leq V_{\text{DD}} < 4.0~V$				3.0	
		P30 to P37, P60, 61, P70 to						
		P72, P74 to P77, P120,	,					
	1.0.1	(/8K0/DF2) PIU to PI2, PI/					12.0	m۸
	IOL4	P73	$4.5 V \leq V DD \leq 5.5 V$				7.0	IIIA
		Total of pipe P70 to P72	$2.7 V \le V DD < 4.5 V$				7.0	m ^
		10tal 01 pins P/0 10 P/2,	$4.5 V \leq V DD \leq 5.5 V$			<b></b>	20	IIIA
			$2.7 V \le V_{DD} < 4.5 V$				16	L
		Total of pins P00 to P07,	$4.5 \text{ V} \leq \text{V}_{\text{DD}} \leq 5.5 \text{ V}$				31	mΑ
		P13 to P16, P30 to P37,	$2.7~V \leq V_{\text{DD}} < 4.5~V$				18	
		(78K0/DF2) P10 to P12						
		P17						
		Total of pins Note 2	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$			1	38	mA
		-	$2.7 \text{ V} \le \text{V}_{\text{DD}} < 4.0 \text{ V}$			1	30	
	IOL2	Per pin for P20 to P27	AVREF = VDD			1	400	μA
		Per pin for P121 to P124						<i>r</i> .
	IOL3	Per pin for P80 to P87, P90	$4.5 \text{ V} \leq \text{SMV}_{\text{DD}} \leq 5.5 \text{ V}$	105°C		1	21	mA
		to P97, (78K0/DE2) P10 to		85°C		1	27	1
		P12, P17		25°C		1	30	-
				_40°C		1	40	-
			$2.7 V \le SMV_{DD} < 4.5 V$	105°C		1	15	-
				85°C		1	15	-
				25°C		1	19	-
				-40°C		1	23	
		Total of pins <sup>Note 2</sup> P80 to P87	$4.5 \text{ V} \leq SMV_{DD} \leq 5.5 \text{ V}$	105°C			63	
				85°C			81	1
				25°C			90	1
				-40°C			120	1
			$2.7 \text{ V} \leq SMV_{DD} < 4.5 \text{ V}$	105°C			46	1
				85°C			50	
				25°C		1	58	
				-40°C			70	1
		Total of pins <sup>Note 2</sup> P90 to P97	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$	105°C			63	1
				85°C		1	81	1
				25°C			90	1
				-40°C		1	120	
			$2.7 \text{ V} \leq SMV_{DD} < 4.5 \text{ V}$	105°C			46	1
				85°C			50	1
				25°C			58	1
				-40°C			70	1

**Notes 1.** Value of current at which the device operation is guaranteed even if the current flows from an output pin to GND.

- **2.** Specification under conditions where the duty factor is 70% (time for which current is output is  $0.7 \times t$  and time for which current is not output is  $0.3 \times t$ , where t is a specific time). The total output current of the pins at a duty factor of other than 70% can be calculated by the following expression.
  - + Where the duty factor of IoH is n%: Total output current of pins = (IoH  $\times$  0.7) / (n  $\times$  0.01)

<Example> Where the duty factor is 50%, IoH = 20.0 mA

Total output current of pins =  $(20.0 \times 0.7) / (50 \times 0.01) = 28.0 \text{ mA}$ 

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.



#### DC Characteristics (3/7)

$(T_A = -40)$	to +105°C,	2.7	V ≤	Vdd	=	EVDD	≤	5.5	۷,	2.7	V	≤	AVREF	≤	5.5	۷,	2.7	V	≤	SMVDD	≤	5.5	V,
Vss = EVss	= AVss = SM	Vss =	0 V)																				

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
Input voltage, high	VIH1	P71 to P73, P7	76, P121 to P124, P3	80, P36	0.7VDD		VDD	V
	VIH2	P00 to P07, P1 P70, P74, P75 EXCLKS, (78K0/DF2) P1	3 to P16, P31 to P3 , P77, P120, RESET 0 to P12, P17	5, P37, P60, P61, , EXCLK,	0.8Vdd		Vdd	V
	VIH3	P20 to P27		$AV_{REF} = V_{DD}$	0.7AVREF		AVREF	V
	VIH4	P80 to P87, P8	90 to P97	SMVDD = VDD	0.7SMVDD		SMVDD	V
	VIH5	(78K0/DE2) P1	10 to P12, P17	SMVDD = VDD	0.8SMVDD		SMVDD	V
Input voltage, low	VIL1	P71 to P73, P7	76, P121 to P124, P3	80, P36	0		0.3VDD	V
	VIL2	P00 to P07, P1 P70, P74, P75 EXCLKS, (78K0/DF2) P1	13 to P16, P31 to P3 , P77, P120, RESET 0 to P12, P17	5, P37, P60, P61, , EXCLK,	0		0.2V <sub>DD</sub>	V
	VIL3	P20 to P27		$AV_{REF} = V_{DD}$	0		0.3AVREF	V
	VIL4	P80 to P87, P8	90 to P97	SMVDD = VDD	0		0.3SMVDD	V
	VIL5	(78K0/DE2) P1	10 to P12, P17	$SMV_DD = V_DD$	0		0.2SMVDD	V
Output voltage, high	V <sub>OH1</sub>	Iон = -3.0 mA	P00 to P07,	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$	$V_{\text{DD}}-0.7$			V
		lон = −2.5 mA	P13 to P16, P30 to P37, P60, P61, P70 to P72, P74 to P77, P120, (78K0/DF2) P10 to P12, P17	$2.7~V \leq V_{DD} < 5.5~V$	$V_{\text{DD}} - 0.5$			
	V <sub>OH2</sub>	Іон = -100 <i>µ</i> А	P20 to P27	$AV_{REF} = V_{DD}$	$V_{\text{DD}}-0.5$			V
			P121 to P124					
	Vонз	$\begin{array}{l} \mbox{loh} = -21.0 \mbox{ mA} \\ \mbox{(Ta} = 105^{\circ}\mbox{C}) \\ \mbox{loh} = -27.0 \mbox{ mA} \\ \mbox{(Ta} = 85^{\circ}\mbox{C}) \\ \mbox{loh} = -30.0 \mbox{ mA} \\ \mbox{(Ta} = 25^{\circ}\mbox{C}) \\ \mbox{loh} = -40.0 \mbox{ mA} \\ \mbox{(Ta} = 40^{\circ}\mbox{C}) \end{array}$	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	$4.5 \text{ V} \leq \text{SMV}_{\text{DD}} \leq 5.5 \text{ V}$	SMV <sub>DD</sub> – 0.5			V
		$\begin{array}{l} \mbox{I} \mbox{OH} = -21.0 \mbox{ mA} \\ \mbox{(Ta} = 105^{\circ}\mbox{C}) \\ \mbox{I} \mbox{OH} = -19.0 \mbox{ mA} \\ \mbox{(Ta} = 85^{\circ}\mbox{C}) \\ \mbox{I} \mbox{OH} = -23.0 \mbox{ mA} \\ \mbox{(Ta} = 25^{\circ}\mbox{C}) \\ \mbox{I} \mbox{OH} = -26.0 \mbox{ mA} \\ \mbox{(Ta} = 40^{\circ}\mbox{C}) \end{array}$		$2.7 \text{ V} \le \text{SMV}_{\text{DD}} \le 5.5 \text{ V}$	SMV <sub>DD</sub> – 0.5			
	Voh4	$I_{OH} = -13.0 \text{ mA}$ $(T_A = -40 \text{ to} + 105^{\circ}\text{C})$ $I_{OH} = -15.0 \text{ mA}$ $(T_A = -40 \text{ to} + 85^{\circ}\text{C})$ $I_{OH} = -7.5 \text{ mA}$	P73	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	V <sub>DD</sub> - 0.7			V
		$(T_A = -40 \text{ to} + 105^{\circ}\text{C})$ IOH = -9.0 mA $(T_A = -40 \text{ to} + 85^{\circ}\text{C})$		$2.7 \text{ V} \le \text{SMV}_{\text{DD}} \le 5.5 \text{ V}$	Vdd - 0.7			

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.



# DC Characteristics (4/7) (TA = -40 to +105°C, 2.7 V $\leq$ VDD = EVDD $\leq$ 5.5 V, 2.7 V $\leq$ AVREF $\leq$ 5.5 V, 2.7 V $\leq$ SMVDD $\leq$ 5.5 V, Vss = EVss = AVss = SMVss = 0 V)

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
Output voltage, low	Vol1	lo∟ = 5.0 mA	P00 to P07,	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$			0.7	V
		loL = 3.0 mA	P13 to P16, P30 to P37, P60, P61, P70 to P72, P74 to P77, P120, (78K0/DF2) P10 to P12, P17	$2.7~V \le V_{DD} < 5.5~V$			0.7	V
	Vol2	lol = 400 μA	P20 to P27	$AV_{REF} = V_{DD}$			0.4	V
			P121 to P124					
	Vol3	$\begin{array}{l} \text{lol} = 21.0 \text{ mA} \\ (T_{A} = 105^{\circ}\text{C}) \\ \text{lol} = 27.0 \text{ mA} \\ (T_{A} = 85^{\circ}\text{C}) \\ \text{lol} = 30.0 \text{ mA} \\ (T_{A} = 25^{\circ}\text{C}) \\ \text{lol} = 40.0 \text{ mA} \\ (T_{A} = 40^{\circ}\text{C}) \end{array}$	P80 to P87, P90 to P97, (78K0/DE2) P10 to P12, P17	$4.5~V \leq SMV_{DD} \leq 5.5~V$			0.5	>
		$\begin{array}{l} \mbox{loc} = 15.0 \mbox{ mA} \\ \mbox{($T_{A} = 105^{\circ}C$)$} \\ \mbox{loc} = 15.0 \mbox{ mA} \\ \mbox{($T_{A} = 85^{\circ}C$)$} \\ \mbox{loc} = 19.0 \mbox{ mA} \\ \mbox{($T_{A} = 25^{\circ}C$)$} \\ \mbox{loc} = 23.0 \mbox{ mA} \\ \mbox{($T_{A} = 40^{\circ}C$)$} \end{array}$		$2.7 \text{ V} \leq SMV_{DD} \leq 5.5 \text{ V}$			0.5	V
	Vol4	$I_{OL} = 13.0 \text{ mA}$ $(T_A = -40 \text{ to} + 105^{\circ}\text{C})$ $I_{OL} = 15.0 \text{ mA}$ $(T_A = -40 \text{ to} + 85^{\circ}\text{C})$	P73	$4.5~V \leq V_{\text{DD}} \leq 5.5~V$			0.7	V
		$I_{OL} = 7.0 \text{ mA}$ ( $T_{A} = -40 \text{ to} + 105^{\circ}\text{C}$ ) $I_{OL} = 8.5 \text{ mA}$ ( $T_{A} = -40 \text{ to} + 85^{\circ}\text{C}$ )		$2.7~V \leq SMV_{DD} \leq 5.5~V$			0.7	

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.



#### DC Characteristics (5/7)

<b>(T</b> ∧	=	-40	to	+105°C,	2.7	v	≤	Vdd	=	EVDD	≤	5.5	۷,	2.7	V	≤	AVREF	≤	5.5	V,	2.7	V	≤	SMVDD	≤	5.5	V,
Vss	= E	EVss	= A	Vss = SN	IVss =	= 0	V)																				

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
Input leakage current, high	Ілні	$V_{I} = V_{DD}$	P71 to P73, P60, P61, I (78K0/DF2) P10 to P12	P120, RESET, , P17, FLMD0			3	μA
	Ilih2	VI = VDD	P74 to P77, P13 to P16 to P37	, P00 to P07, P30			10	μA
	Ілнз	$V_I = AV_{REF}$	P20 to P27	AVREF = VDD			3	μA
	Ілн4	VI = VDD	P121 to P124	I/O port mode			3	μA
			(X1, X2, XT1, XT2)	OSC mode			20	
	Ішна	VI = SMVDD	P80 to P87, P90 to P97 (78K0/DE2) P10 to P12	, , P17			10	μA
Input leakage current, low	Ішт	VI = Vss	P71 to P73, P60, P61, I (78K0/DF2) P10 to P12	P120, RESET, , P17, FLMD0			-3	μA
	Ilil2		P74 to P77, P13 to P16 to P37	, P00 to P07, P30			-10	μA
	Ililis		P20 to P27	AVREF = VDD			-3	μA
	Ilil4		P121 to P124	I/O port mode			-3	μA
			(X1, X2, XT1, XT2)	OSC mode			-20	
	Ilils		P80 to P87, P90 to P97 (78K0/DE2) P10 to P12	, , P17			-10	μA
Pull-up resistor	Ruı	VI = Vss	P00 to P07, P13 to P16 P60, P61, P70 to P77, I (78K0/DF2) P10 to P12	5, P30 to P37, P120, , P17	10	20	100	kΩ
	Ru2	VI = SMVss	(78K0/DE2) P10 to P12	, P17	10	20	100	kΩ
Pull-down resistor	R <sub>D1</sub>	$V_{\text{I}} = SMV_{\text{DD}}$	P80 to P87, P90 to P97 (78K0/DE2) P10 to P12	, , P17	100			kΩ
	R <sub>D2</sub>	VI = VDD	P74 to P77, P13 to P16 to P37, SEG0 to SEG3	, P00 to P07, P30	100			kΩ
FLMD0 supply voltage	Vı∟	In normal of	operation mode		0		0.2VDD	V
	VIH	In self pro	gramming mode		0.8Vdd		VDD	V

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of port pins.



# DC Characteristics (6/7) (TA = -40 to +105°C, 2.7 V $\leq$ VDD = EVDD $\leq$ 5.5 V, 2.7 V $\leq$ AVREF $\leq$ 5.5 V, 2.7 V $\leq$ SMVDD $\leq$ 5.5 V, Vss = EVss = AVss = SMVss = 0 V)

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
Supply current <sup>Note 1</sup>	IDD1	Operating	$f_{IN} = 20 \text{ MHz}^{Note 2},$	Square wave input		3.4	8.2	mA
		mode	$V_{DD} = 5.0 V$	Resonator connection		4.7	9.9	
			$f_{IN} = 10 \text{ MHz}^{Notes 2, 3},$	Square wave input		1.8	5.3	
			$V_{DD} = 5.0 V$	Resonator connection		2.7	6.6	
			$f_{IN} = 10 \text{ MHz}^{Notes 2, 3},$	Square wave input		1.7	5.0	
			$V_{DD} = 3.0 V$	Resonator connection		2.4	5.7	
			$f_{IN} = 5 \text{ MHz}^{Notes 2, 3},$	Square wave input		1.0	2.7	
			VDD = 3.0 V	Resonator connection		1.4	3.2	
			fosca = 8 MHz <sup>Note 4</sup> , VDD = 5	5.0 V		1.9	3.5	
			fs∪в = 32.768 kHz <sup>№te 5</sup> ,	Square wave input		6.1	98	μA
			$V_{DD} = 5.0 V$	Resonator connection		15.4	102	
	IDD2	HALT mode	$f_{IN} = 20 \text{ MHz}^{Note 2},$	Square wave input		1.1	5.6	mA
			$V_{DD} = 5.0 V$	Resonator connection		2.2	7.7	
			$f_{IN} = 10 \text{ MHz}^{Notes 2, 3},$	Square wave input		0.6	3.1	
			$V_{DD} = 5.0 V$	Resonator connection		1.2	4.4	
			$f_{IN} = 5 \text{ MHz}^{Notes 2, 3},$	Square wave input		0.3	1.5	
			V <sub>DD</sub> = 3.0 V	Resonator connection		0.6	2.2	
			$fosc_8 = 8 MHz^{Note 4}, V_{DD} = 5$	5.0 V		0.5	2.2	
			fsuв = 32.768 kHz <sup>Note 5</sup> ,	Square wave input		3.1	92	μA
			$V_{DD} = 5.0 V$	Resonator connection		12.4	97	

Notes 1. Total current flowing into the internal power supply (V<sub>DD</sub>, EV<sub>DD</sub>, SMV<sub>DD</sub>), including the peripheral operation current and the input leakage current flowing when the level of the input pin are fixed to V<sub>DD</sub> or V<sub>SS</sub>. However, the current flowing into the pull-up resistors and the output current of the port is not included.

- 2. Not including the operating current of the 8 MHz internal oscillator, XT1 oscillation, 240 kHz internal oscillator and the current flowing into the A/D converter, watchdog timer, LVI circuit, LCD controller/driver and ZPD.
- **3.** When AMPH (bit 0 of clock operation mode select register (OSCCTL)) = 0.
- Not including the operating current of the X1 oscillation, XT1 oscillation and 240 kHz internal oscillator. Not
  including the current flowing into the A/D converter, watchdog timer, LVI circuit, LCD controller/driver and
  ZPD.
- 5. Not including the operating current of the X1 oscillation, 8 MHz internal oscillator and 240 kHz internal oscillator, and the current flowing into the A/D converter, watchdog timer, LVI circuit, LCD controller/driver and ZPD.
- Remarks 1. fin: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. fosca: Internal high-speed oscillation clock frequency
  - 3. fsub: Subsystem clock frequency (XT1 clock oscillation frequency or external subsystem clock frequency)

#### DC Characteristics (7/7)

(TA =	-40	to	+105°C,	2.7	V	≤	Vdd	=	EVDD	≤	5.5	V,	2.7	V	≤	AVREF	≤	5.5	V,	2.7	V	≤	SMVDD	≤	5.5	V,
Vss = I	EVss	= A	Vss = SM	Vss :	= 0	V)																				

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
Supply current Note 1	DD3 Note 2	STOP mode	V <sub>DD</sub> = 5.0 V	$T_A = -40 \text{ to } +70^{\circ}\text{C}$		1	10	μA
			(CREG+POC)	$T_A = -40 \text{ to } +105^{\circ}\text{C}$		1	60	
Watchdog timer operating current	WDT Note 3	During 240 kHz	z internal low-speed oscilla	ation clock operation		5	13	μA
LVI operating current	LVI Note 4					9	24	μA
A/D converter operating current	ADC Note 5					0.86	1.9	mA
LCD controller/driver	LCD1 Note 6	fprs = 20 MHz	LCD non-display	VDD = 5.0 V		180	350	μA
operating current		LCD source	waveform output	VDD = 3.0 V		120	250	
	LCD2 Note 6	$f_{PRS}/2^7$	LCD display waveform	VDD = 5.0 V		180	350	μA
		LCD clock = f <sub>LCD</sub> /2 <sup>4</sup> Four-time- slice display	output	$V_{DD} = 3.0 V$		120	250	
ZPD operating current	IZPD	One ZPD circu	it operating	$V_{DD} = 5.0 V$		0.15	0.6	mA
				$V_{DD} = 3.0 V$		0.12	0.5	
		Four ZPD circu	its operating	$V_{DD} = 5.0 V$		0.5	2.0	
				$V_{DD} = 3.0 V$		0.4	1.6	

**Notes 1.** Total current flowing into the internal power supply (VDD, EVDD, SMVDD), including the peripheral operation current and the input leakage current flowing when the level of the input pin are fixed to VDD or Vss. However, the current flowing into the pull-up resistors and the output current of the port is not included.

- **2.** Not including the operating current of the 240 kHz internal oscillator and XT1 oscillation, and the current flowing into the A/D converter, watchdog timer, LVI circuit, LCD controller/driver and ZPD.
- **3.** Current flowing only to the watchdog timer (V<sub>DD</sub>-pin) (including the operating current of the 240 kHz internal oscillator). The current value of the 78K0/Dx2 is the sum of I<sub>DD2</sub> or I<sub>DD3</sub> and IWDT when the watchdog timer operates in the HALT or STOP mode.
- 4. Current flowing only to the LVI circuit (V<sub>DD</sub>-pin). The current value of the 78K0/Dx2 is the sum of I<sub>DD2</sub> or I<sub>DD3</sub> and ILVI when the LVI circuit operates in the HALT or STOP mode.
- 5. Current flowing only to the A/D converter (AV<sub>REF</sub>-pin). The current value of the 78K0/Dx2 is the sum of IDD1 or IDD2 and IADC when the A/D converter operates in an operation mode or the HALT mode.
- 6. Including the operating current flowing in the internal division resistor.



# **30.4 AC Characteristics**

# (1) Basic operation

#### $(T_{\text{A}} = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{\text{DD}} = \text{EV}_{\text{DD}} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{\text{REF}} \le 5.5 \text{ V}, \text{V}_{\text{SS}} = \text{EV}_{\text{SS}} = \text{AV}_{\text{SS}} = \text{SMV}_{\text{SS}} = 0 \text{ V})$

Parameter	Symbol	Conditio	ons	MIN.	TYP.	MAX.	Unit
Instruction cycle (minimum	Тсү	Main system clock	$4.0~V \leq V_{DD} \leq 5.5~V$	0.1		8	μs
instruction execution time)		(fmain) operation	$2.7~V \leq V_{\text{DD}} < 4.0~V$	0.2		8	
		Subsystem clock (fs	suв) operation	114	122	125	
Peripheral hardware clock	fprs	XSEL = 1	$4.0~V \leq V_{DD} \leq 5.5~V$			20	MHz
frequency			$2.7~V \leq V_{\text{DD}} < 4.0~V$			10	
		XSEL = 0	$2.7~V \leq V_{DD} < 4.0~V$	7.6		8.4	
External main system clock	fext	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$		4.0		20	MHz
frequency		$2.7~V \leq V_{\text{DD}} < 4.0~V$		4.0		10	
External clock input high level width, low level width	fexth, fextl			(1/fext×1/2)-1			ns
External subsystem clock frequency	fexts			32	32.768	35	kHz
External sub clock input high level width, low level width	fextsн, fextsl			(1/fexts×1/2)-5			ns
TIOP00, 01, 10, 11, 20, 21, 30,	fTI5	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$				10	MHz
31, 40, 41, TIO50, 51 input frequency		$2.7~V \leq V_{\text{DD}} < 4.0~V$				10	
TIOP00, 01, 10, 11, 20, 21, 30,	tтiнs,	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$		50			ns
31, 40, 41, TIO50, 51 input high- level width, low-level width	t⊤i∟5	$2.7~V \leq V_{\text{DD}} < 4.0~V$		50			
Interrupt input high-level width, low-level width	tınıн, tını∟			1			μS
RESET low-level width	trsl			10			μs





TCY vs. VDD (Main System Clock Operation)



#### AC Timing Test Points (Excluding X1, XT1)



### External clock input timing



**TI Timing** 



#### **Interrupt Request Input Timing**





#### (2) Serial interface

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$ 

#### (a) UART6n (Dedicated baud rate generator output)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Transfer rate					625	kbps

### (b) IIC0

Parameter	Symbol	Conditions		Standard Mode		High-Speed Mode		Unit
				MIN.	MAX.	MIN.	MAX.	
SCL0 clock frequency	fclк			0	100	0	400	kHz
Setup time of start/restart condition	tsu: sta			4.7		0.6		μS
Hold time <sup>Note 1</sup>	thd: STA			4.0		0.6		μS
Hold time when SCL0 = "L"	<b>t</b> LOW			4.7		1.3		μS
Hold time when SCL0 = "H"	<b>t</b> high			4.0		0.6		μS
Data setup time (reception)	tsu: dat			250		100		ns
Data hold time (transmission) <sup>Note</sup>	thd: dat	$f_W = f_{IN}/2^N$	DFC0 =	0	3.45	0	0.9 <sup>Note 4</sup>	μS
2		selected <sup>Note 3</sup>	0				1.0 <sup>Note 5</sup>	
			DFC0 =			0	0.9 <sup>Note 6</sup>	
			1				1.125 <sup>Note</sup> 7	
		$f_W = f_{OSC8}/2^N$ selected <sup>Note 3</sup>	DFC0 = 0	0	3.45	0	1.05	
			DFC0 = 1			0	1.184	
Setup time of stop condition	tsu: sto			4.0		0.6		μS
Bus free time between stop and start conditions	<b>t</b> BUF			4.7		1.3		μS

Notes 1. The first clock pulse is generated after this period when the start/restart condition is detected.

2. The maximum value (MAX.) of the during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

- 3. fw indicates the IIC0 transfer clock selected by the IICCL and IICX0 registers.
- **4.** When  $fw \ge 4$  MHz is selected
- 5. When fw < 4 MHz is selected
- 6. When  $fw \ge 5$  MHz is selected
- 7. When fw < 5 MHz is selected

 $\textbf{Remark} \quad n=0, \ 1$ 



Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
SCK1n cycle time	<b>t</b> ксү1	$4.0~V \leq V_{\text{DD}} \leq 5.5~V \qquad 78 \text{K0/DE2}$		250			ns
			78K0/DF2	200			ns
		$2.7~V \leq V_{\text{DD}} < 4.0~V$	78K0/DE2	500			ns
			78K0/DF2	400			ns
SCK1n high-/low-level width Note 1	tкнı,	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$		tксү1/2 – 20			ns
	tĸ∟1	$2.7~V \leq V_{\text{DD}} < 4.0~V$		tксү1/2 – 30			ns
SI1n setup time (to SCK1n↑)	tsik1	$4.0~V \leq V_{\text{DD}} \leq 5.5~V$		70			ns
		$2.7~V \leq V_{\text{DD}} < 4.0~V$		100			ns
SI1n hold time (from $\overline{\text{SCK1n}}$ )	tksi1			30			ns
Delay time from $\overline{\text{SCK1n}}\downarrow$ to	tkso1	C = 50 pF Note 2	78K0/DE2			50	ns
SO1n output			78K0/DF2			40	ns

# (c) CSI1n (Master mode, SCK1n... internal clock output)

**Notes 1.** It is value at the time of fx use. Keep in mind that spec different at the time of fosce use.

**2.** C is the load capacitance of the  $\overline{\text{SCK1n}}$  and SO1n output lines.

# (d) CSI1n (Slave mode, SCK1n... external clock input)

Parameter	Symbol	Conditi	MIN.	TYP.	MAX.	Unit	
SCK1n cycle time	<b>t</b> ксү2	78K0/DE2	800			ns	
		78K0/DF2	400			ns	
SCK1n high-/low-level width	tкн2,		tксү2/2			ns	
	tĸL2						
SI1n setup time (to SCK1n↑)	tsik2		80			ns	
SI1n hold time (from SCK1n↑)	tksi2			50			ns
Delay time from $\overline{\text{SCK1n}}\downarrow$ to	tkso2	$C = 50 \text{ pF}^{\text{Note}}$	78K0/DE2			380	ns
SO1n output			78K0/DF2			120	ns

**Note** C is the load capacitance of the SO1n output line.

**Remark** n = 0, 1



#### Serial Transfer Timing

IIC0:



CSI1n:



# $\textbf{Remark} \quad m=1,\,2$

n = 0, 1


### 78K0/Dx2

### (3) CAN controller

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{\text{DD}} = \text{EV}_{\text{DD}} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{\text{REF}} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{\text{DD}} \le 5.5 \text{ V}, \text{V}_{\text{SS}} = \text{EV}_{\text{SS}} = \text{AV}_{\text{SS}} = \text{SMV}_{\text{SS}} = 0 \text{ V})$ 

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Transfer rate					1	Mbps
Internal delay time	<b>t</b> NODE				100	ns



Internal delay time (tNODE) = Internal Transfer Delay (toutput) + Internal Receive Delay (tinput)

Note CAN Internal clock (fcan): CAN baud rate clock





### (4) A/D Converter Characteristics

 $(T_A = -40 \text{ to } +105^{\circ}C, 2.7 \text{ V} \le V_{DD} = EV_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le AV_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le SMV_{DD} \le 5.5 \text{ V}, V_{SS} = EV_{SS} = AV_{SS} = SMV_{SS} = 0 \text{ V})$ 

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Resolution	RES				10	bit
Overall error <sup>Notes 1, 2</sup>	AINL	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±0.4	%FSR
		$2.7 \text{ V} \leq AV_{\text{REF}} < 5.5 \text{ V}$			±0.6	
Conversion time	tCONV	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$	6.1		36.7	μs
		$2.7~V \leq AV_{\text{REF}} < 5.5~V$	6.1		36.7	
Zero-scale error <sup>Notes 1, 2</sup>	Ezs	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±0.4	%FSR
		$2.7~V \leq AV_{\text{REF}} < 5.5~V$			±0.6	
Full-scale error <sup>Notes 1, 2</sup>	Ers	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±0.4	%FSR
		$2.7 \text{ V} \leq AV_{\text{REF}} < 5.5 \text{ V}$			±0.6	
Integral non-linearity error <sup>Note 1</sup>	ILE	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±2.5	LSB
		$2.7~V \leq AV_{\text{REF}} < 5.5~V$			±4.5	
Differential non-linearity error Note 1	DLE	$4.0~V \leq AV_{\text{REF}} \leq 5.5~V$			±1.5	LSB
		$2.7 \text{ V} \leq \text{AV}_{\text{REF}} < 5.5 \text{ V}$			±2.0	
Analog input voltage	VAIN		AVss		AVREF	V

**Notes 1.** Excludes quantization error ( $\pm 1/2$  LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.



### (5) Meter controller/driver and ZPD characteristics

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{AV}_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le \text{SMV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = \text{AV}_{SS} = \text{SMV}_{SS} = 0 \text{ V})$ 

Parameter	Symbol		Conditions	MIN.	TYP.	MAX.	Unit
Meter controller/driver input	fmc Note 1	$V_{DD} = 4.5 \text{ V to } 5$	V <sub>DD</sub> = 4.5 V to 5.5 V			20	MHz
frequency						10	
PWM output rise time	tR	$C = 50 \text{ pF}^{Note 2}$	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$	30	60	90	ns
		(10% - 90%)	$2.7~V \leq SMV_{\text{DD}} \leq 5.5~V$	60	120	250	
PWM output fall time	t⊧	$C=50 \ pF^{Note 2}$	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$	30	60	90	ns
		(10% - 90%)	$2.7~V \leq SMV_{\text{DD}} \leq 5.5~V$	60	140	250	
Peak cross current Note 3	ICROSS					50	mA
Output pulse width Note 4	tмo			125			ns
Output pulse length deviation Note 5	<b>t</b> SMDEV			-40		+10	ns
Symmetry performance Note 6	∆HSPmn	Іон = –27 mA				50	mV
		ΔHSPmn =  Vor	[(SMmn)max-(SMmn)min]				
	∆HSPmn	loι = 27 mA ΔHSPmn =  Voι	[(SMmn)max-(SMmn)min]			50	mV

Notes 1. Source clock of the free-running counter.

- 2. C is the load capacitance of the PWM output line.
- **3.** The slew rate control generates a cross current in the output stage to control the energy of the external inductive load. The cross current flows only during the output transition time t<sub>R</sub>, t<sub>F</sub>. It flows in addition to the output current. The cross current is not tested, but derived from simulation.
- **4.** The output buffer can not generate high or low pulses shorter than this time, because of its slew rate control system. This value is not tested, but derived from simulation.
- **5.** The slew rate control function causes a deviation of output pulse time compared to the ideal selected output pulse setting. This value is not tested, but derived from simulation.
- 6. Indicates the dispersion of up to 16 PWM output voltages. Not tested in production, specified by design.

**Remark** m = 1 to 4, n = 1 to 4

### Meter Controller/Driver Output Timing





Parameter	Symbol	С	onditions	MIN.	TYP.	MAX.	Unit
Threshold voltage	Vzpd	0-point detection 000	voltage setting (ZPDSn) =	80	150	220	mV
		0-point detection voltage setting (ZPDSn) = 001		180	250	320	
		0-point detection voltage setting (ZPDSn) = 010		280	350	420	
		0-point detection voltage setting (ZPDSn) = 011		380	450	520	
		0-point detection voltage setting (ZPDSn) = 100		480	550	620	
Detection delay tzPDD	tzpdd	100 mV step, 50 mV overdrive	SMV <sub>DD</sub> = 4.75 V to 5.25 V			100 <sup>Note</sup>	ns
		(see the figure below)	SMV <sub>DD</sub> = 2.7 V to 5.5 V			100 <sup>Note</sup>	
Operation stabilization wait time	tzpdw	Reference voltage comparator stabil	e stabilization + ZPD ization			1+5 = 6	μS

Note Not tested in production, specified by design.

### **ZPD** Timing





### (6) Sound generator characteristics

 $(T_A = -40 \text{ to } +105^{\circ}C, 2.7 \text{ V} \le V_{DD} = EV_{DD} \le 5.5 \text{ V}, 2.7 \text{ V} \le AV_{REF} \le 5.5 \text{ V}, 2.7 \text{ V} \le SMV_{DD} \le 5.5 \text{ V}, V_{SS} = EV_{SS} = AV_{SS} = SMV_{SS} = 0 \text{ V})$ 

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Sound generator input frequency	fsgo	V <sub>DD</sub> = 4.5 V to 5.5 V				10	MHz
						5	MHz
SGO output rise time	tR	C = 100 pF	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$			200	ns
			$2.7~V \leq SMV_{\text{DD}} \leq 5.5~V$			200	ns
SGO output fall time	t⊧	C = 100 pF	$4.5~V \leq SMV_{\text{DD}} \leq 5.5~V$			200	ns
			$2.7~V \leq SMV_{\text{DD}} \leq 5.5~V$			200	ns

# Sound Generator Output Timing





# (7) POC circuit characteristics

$(1_{A} = -40 \text{ to } +105^{\circ}\text{C}, \text{ Vss} = \text{EVss} = 0 \text{ V})$										
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit				
Detection voltage	VPOC0		1.44	1.59	1.74	V				
Power supply rise time	tртн	VDD: 0 V $\rightarrow$ VPOCO			0.5	V/ms				
Minimum pulse width Note	tew	When the voltage drops	200			μS				

**Note** When the voltage drops in shorter width than the minimum pulse width, the operation of POC detection isn't guaranteed.

### **POC Circuit Timing**





# (8) LVI circuit characteristics

```
(T_A = -40 \text{ to } +105^{\circ}\text{C}, \text{V}_{POC} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = 0 \text{ V})
```

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection	Supply voltage level	VLVIO		4.14	4.24	4.34	V
voltage		VLVI1		3.99	4.09	4.19	V
		VLVI2		3.83	3.93	4.03	V
		VLVI3		3.68	3.78	3.88	V
		VLVI4		3.52	3.62	3.72	V
		VLVI5		3.37	3.47	3.57	V
		VLVI6		3.22	3.32	3.42	V
		VLVI7		3.06	3.16	3.26	V
		VLVI8		2.91	3.01	3.11	V
		VLVI9		2.75	2.85	2.95	V
		VLVI10		2.60	2.70	2.80	V
	External input pin <sup>Note 1</sup>	EXLVI	$\text{EX}_{\text{LVI}} < \text{V}_{\text{DD}},  2.7   \text{V} \leq \text{V}_{\text{DD}} \leq 5.5   \text{V}$	1.11	1.21	1.31	V
	Detection voltage on application of supply	VDDlvi	LVISTART (option byte) = 1	2.50	2.70	2.90	V
	voltage						
Minimum pu	lse width	t∟w		200			μS
Operation st	abilization wait time Note 2	tLWAIT1				10	μs

Notes 1. External input pin is alternate P120 pin.

2. Time required from setting LVION to 1 to operation stabilization.

**Remark**  $V_{LVI (n-1)} > V_{LVIn} (n = 1 \text{ to } 10)$ 

### LVI Circuit Timing





### (9) Power supply starting time

(T<sub>A</sub> = -40 to +105°C, Vss = EVss = 0 V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Starting maximum time to $V_{DD}$ min (2.7 V) <sup>Note</sup>	tPUP1	LVI starting option invalid			3.6	ms
(V <sub>DD</sub> : 0 V→2.7 V)		When pin RESET intact				
Starting maximum time to VDD min (2.7 V)Note	tpup2	LVI starting option invalid			1.9	ms
(pin RESET release→V <sub>DD</sub> : 2.7 V)		When pin RESET use				

Note Start a power supply in time shorter than this when LVI staring option invalid.



Pin RESET intact

Pin RESET use



### (10) LCD circuit characteristics

### (a) Static display mode

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} \le \text{EV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = 0 \text{ V})$ 

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
LCD drive voltage	VLCD				VDD	V
LCD divider resistor Note 1	RLCD		5	15	45	kΩ
LCD output resistor (Common) <sup>Note 2</sup>	Rodc				40	kΩ
LCD output resistor (Segment) <sup>Note 3</sup>	Rods				200	kΩ

### (b) 1/3 bias method

### $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} \le \text{EV}_{DD} \le 5.5 \text{ V}, \text{ V}_{SS} = \text{EV}_{SS} = 0 \text{ V})$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
LCD drive voltage	VLCD				VDD	V
LCD divider resistor Note 1	RLCD		5	15	45	kΩ
LCD output resistor (Common) <sup>Note 2</sup>	Rodc				40	kΩ
LCD output resistor (Segment) <sup>Note 3</sup>	Rods				200	kΩ

**Notes 1.** Internal resistance division method only.

- 2. The output resistor is consisted by the internal equivalent resistance from COM pin and the buffer resistance of common IO.
- **3.** The output resistor is consisted by the internal equivalent resistance from SEG pin and the buffer resistance of segment IO.



### 30.5 Data Retention Characteristics

### Data Memory STOP Mode Low Supply Voltage Data Retention Characteristics (T<sub>A</sub> = -40 to +105°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention supply voltage	VDDDR		1.44 <sup>Note</sup>		5.5	V

**Note** The value depends on the POC detection voltage. When the voltage drops, the data is retained until a POC reset is effected, but data is not retained when a POC reset is effected.

### **Data Retention Timing**





### 30.6 Flash EEPROM Programming Characteristics

### (1) Basic characteristics

```
(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.7 \text{ V} \le \text{V}_{DD} = \text{EV}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = \text{EV}_{SS} = 0 \text{ V})
```

Parameter	Symbol		Conditions		MIN.	TYP.	MAX.	Unit
VDD supply current	loo					4.5	14.0	mA
Number of rewrites per chip <sup>Note</sup>	Cerwr	1 erase + 1 write after erase = 1 rewrite	When a flash memory programmer is used, and the libraries provided by Renesas Electronics are used	Retention: 15 years	1000			Times
			When the EEPROM emulation libraries provided by Renesas Electronics are used, and the rewritable ROM size is 4 KB	Retention: 5 years	10000			Times

**Note** When a product is first written after shipment, "erase  $\rightarrow$  write" and "write only" are both taken as one rewrite.



### 78K0/Dx2

### CHAPTER 31 PACKAGE DRAWINGS

μPD78F0836GBA-GAH-G, 78F0836GBA2-GAH-G, 78F0837GBA-GAH-G, 78F0837GBA2-GAH-G, 78F0844GBA-GAH-G, 78F0844GBA2-GAH-G, 78F0845GBA-GAH-G, 78F0845GBA2-GAH-G

# 64-PIN PLASTIC LQFP(FINE PITCH)(10x10)



Each lead centerline is located within 0.08 mm of its true position at maximum material condition.

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• μPD78F0838GKA-GAK-G, 78F0838GKA2-GAK-G, 78F0839GKA-GAK-G, 78F0839GKA2-GAK-G, 78F0840GKA-GAK-G, 78F0840GKA2-GAK-G, 78F0841GKA-GAK-G, 78F0841GKA2-GAK-G, 78F0842GKA-GAK-G, 78F0842GKA2-GAK-G, 78F0843GKA-GAK-G, 78F0843GKA2-GAK-G, 78F0846GKA-GAK-G, 78F0846GKA2-GAK-G, 78F0847GKA-GAK-G, 78F0847GKA2-GAK-G, 78F0848GKA-GAK-G, 78F0848GKA2-GAK-G, 78F0849GKA-GAK-G, 78F0849GKA2-GAK-G

# 80-PIN PLASTIC LQFP (FINE PITCH) (12x12)



Each lead centerline is located within 0.08 mm of its true position at maximum material condition.

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### CHAPTER 32 RECOMMENDED SOLDERING CONDITIONS

These products should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an Renesas Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

### Table 32-1. Surface Mounting Type Soldering Conditions

• 64-pin plastic LQFP (10 × 10)

μPD78F0836GBA-GAH-G, 78F0836GBA2-GAH-G, 78F0837GBA-GAH-G, 78F0837GBA2-GAH-G, 78F0844GBA-GAH-G, 78F0844GBA2-GAH-G, 78F0845GBA-GAH-G, 78F0845GBA2-GAH-G

### • 80-pin plastic LQFP (12 × 12)

μPD78F0838GKA-GAK-G, 78F0838GKA2-GAK-G, 78F0839GKA-GAK-G, 78F0839GKA2-GAK-G, 78F0840GKA-GAK-G, 78F0840GKA2-GAK-G, 78F0841GKA-GAK-G, 78F0841GKA2-GAK-G, 78F0842GKA-GAK-G, 78F0842GKA2-GAK-G, 78F0843GKA-GAK-G, 78F0843GKA2-GAK-G, 78F0846GKA2-GAK-G, 78F0846GKA2-GAK-G, 78F0847GKA-GAK-G, 78F0847GKA2-GAK-G, 78F0848GKA-GAK-G, 78F0848GKA2-GAK-G, 78F0849GKA2-GAK-G, 78F0849GKA2-GAK-G

	Soldering Method	Soldering Conditions	Recommended Condition Symbol
<r></r>	Infrared reflow	Package peak temperature: 260°C, Time: 60 seconds max. (at 220°C or higher), Count: 3 times or less, Exposure limit: 7 days <sup>Note</sup> (after that, prebake at 125°C for 10 to 72 hours)	IR60-107-3
	Partial heating	Pin temperature: 350°C max., Time: 3 seconds max. (per pin row)	_

Note After opening the dry pack, store it at 25°C or less and 65% RH or less for the allowable storage period.

### Caution Do not use different soldering methods together (except for partial heating).



### CHAPTER 33 CAUTIONS FOR WAIT

### 33.1 Cautions for Wait

This product has two internal system buses.

One is a CPU bus and the other is a peripheral bus that interfaces with the low-speed peripheral hardware.

Because the clock of the CPU bus and the clock of the peripheral bus are asynchronous, unexpected illegal data may be passed if an access to the CPU conflicts with an access to the peripheral hardware.

When accessing the peripheral hardware that may cause a conflict, therefore, the CPU repeatedly executes processing, until the correct data is passed.

As a result, the CPU does not start the next instruction processing but waits. If this happens, the number of execution clocks of an instruction increases by the number of wait clocks (for the number of wait clocks, see **Table 33-1**). This must be noted when real-time processing is performed.



### 33.2 Peripheral Hardware That Generates Wait

Table 33-1 lists the registers that issue a wait request when accessed by the CPU, and the number of CPU wait clocks.

Peripheral Hardware	Register	Access	Number of Wait Clocks	
16-bit	TPnCNT	Read	1 clock (fixed)	
timer/event	TPnCCR0, TPnCCR1 <sup>Note 1</sup>	Read	1 clock (fixed)	
(n = 0  to  4)	TPnCCR0, TPnCCR1 <sup>Note 2</sup>	Write	0	
Serial interface UART60	ASIS60	Read	1 clock (fixed)	
Serial interface UART61	ASIS61	Read	1 clock (fixed)	
Serial interface IIC0	IICSO	Read	1 clock (fixed)	
A/D converter	ADM	Write	1 to 5 clocks (when $f_{AD} = f_{PRS}/2$ is selected)	
	ADS	Write	1 to 7 clocks (when $f_{AD} = f_{PRS}/3$ is selected)	
	ADPC	Write	1 to 9 clocks (when $f_{AD} = f_{PRS}/4$ is selected)	
	ADCB	Bead	2 to 13 clocks (when $f_{AD} = f_{PRS}/6$ is selected)	
	Abon	nead	2 to 17 clocks (when $I_{AD} = IPRS/8$ is selected) 2 to 25 clocks (when $I_{AD} = IPRS/12$ is selected)	
	<ul> <li>The above number of clocks is when the same source clock is selected for fcPU and fPRS. The number of wait clocks can be calculated by the following expression and under the following conditions.</li> <li><calculating clocks="" number="" of="" wait=""> <ul> <li>Number of wait clocks = 2 fcPU</li> <li>faD</li> <li>t</li> </ul> </calculating></li> <li>Fraction is truncated if the number of wait clocks ≤ 0.5 and rounded up if the number of wait clocks &gt; 0.5. fAD: A/D conversion clock frequency (fPRS/2 to fPRS/12) fcPU: CPU clock frequency (fcPU to fcPU/16) fPRS: Peripheral hardware clock frequency</li> <li><conditions clocks="" for="" maximum="" minimum="" number="" of="" wait=""></conditions></li> <li>Maximum number of times: Maximum speed of CPU (fcPU), lowest speed of A/D conversion clock (fPRS/12)</li> </ul>			

 Table 33-1. Registers That Generate Wait and Number of CPU Wait Clocks (1/2)

Notes 1. During capture operation.

2. During compare operation.

Caution When the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped, do not access the registers listed above using an access method in which a wait request is issued.

Remark The clock is the CPU clock (fcPu).



Peripheral Hardware	Register	Access	Number of Wait Clocks		
Stepper motor controller/driver (with ZPD)	MCNTC0 MCMPCn (n = 1 to 4)	Write Write	1 to 3 clocks (when $f_{MC0} = f_{PRS}$ is selected) 1 to 5 clocks (when $f_{MC0} = f_{PRS}/2$ is selected) 1 to 9 clocks (when $f_{MC0} = f_{PRS}/2^2$ is selected) 2 to 17 clocks (when $f_{MC0} = f_{PRS}/2^3$ is selected) 3 to 33 clocks (when $f_{MC0} = f_{PRS}/2^4$ is selected) 5 to 65 clocks (when $f_{MC0} = f_{PRS}/2^5$ is selected) 9 to 129 clocks (when $f_{MC0} = f_{PRS}/2^6$ is selected) 17 to 266 clocks (when $f_{MC0} = f_{PRS}/2^7$ is selected)		
	The above number of clocks is when the same source clock is selected for fcPU and fPRS. The number of wait clocks can be calculated by the following expression and under the following conditions. <calculating clocks="" number="" of="" wait=""> • Number of wait clocks =2 fcPU/fMc0 + 1 * Fraction is truncated. fMc0: Stepping motor controller/driver clock frequency (fPRS to fPRS/2<sup>7</sup>) fcPU: CPU clock frequency (fcPU to fcPU/16) fPRS: Peripheral hardware clock frequency <conditions clocks="" for="" maximum="" minimum="" number="" of="" wait=""> • Maximum number of times: Maximum speed of CPU (fcPU, lowest speed of Stepper motor controller/driver clock (fPRS/2<sup>7</sup>) • Minimum number of times: Minimum speed of CPU (fcPU/16), highest speed of Stepper motor controller/driver clock (fPRS)</conditions></calculating>				
Sound generator	SG0FL       Write       1 to 5 clocks (when fsc0 = fPRs/2 is selected)         SG0FH       SG0PWM       1         The above number of clocks is when the same source clock is selected for fcPU and fPRs. The number of wait clocks can be calculated by the following expression and under the following conditions.       1         O to built in the following conditions.       1       1				
	<ul> <li>Number of wait clocks =2 fcpu/fsg0 + 1</li> <li>Fraction is truncated.</li> <li>fsg0: Sound Generator clock frequency (fps/2)</li> <li>fcpu: CPU clock frequency (fcpu to fcpu/16)</li> <li>fprs: Peripheral hardware clock frequency</li> <li><conditions clocks="" for="" maximum="" minimum="" number="" of="" wait=""></conditions></li> <li>Maximum number of times: Maximum speed of CPU (fcpu), lowest speed of Sound Generator clock (fprs/2)</li> <li>Minimum number of times: Minimum speed of CPU (fcpu/16), highest speed of Sound Generator clock (fprs/2)</li> </ul>				

### Table 33-1. Registers That Generate Wait and Number of CPU Wait Clocks (2/2)

# Caution When the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped, do not access the registers listed above using an access method in which a wait request is issued.

**Remark** The clock is the CPU clock (fcPu).



Peripheral	Register	Access	Number of Wait Clocks		Cause
Hardware			MIN.	MAX.	
CAN	Global Reg.	Read/Write	1	1	Synchronizaition of NPB signals with VPCLK
	CANmodule				<calculating clocks="" number="" of="" wait=""></calculating>
	Reg.				MIN. ROUNDUP[(1/FVPCLK) × 1/(1/FVPSTB)]
					MAX. ROUNDUP[(1/FVPCLK) × 2/(1/FVPSTB)]
	CORGPT	Read	2	14	Synchronization of NPB signals with VPCLK
	COLIPT				RAM access delay (1 RAM – RD access)
	COTGPT				<calculating clocks="" number="" of="" wait=""></calculating>
	COLOPT				MIN. ROUNDUP[(1/FCANCLK) × 3/(1/FVPSTB)]
	Message Buf.				MAX. ROUNDUP[(1/FCANCLK) × 4/(1/FVPSTB)]
	Message Buf.	Write(8 bit)	2	17	Synchronization of NPB signals with VPCLK
					RAM access delay (1RAM – RD + 1RAM – WR
					access)
					<calculating clocks="" number="" of="" wait=""></calculating>
					MIN. ROUNDUP[(1/FCANCLK) × 4/(1/FVPSTB)]
					MAX. ROUNDUP[(1/FCANCLK) × 5/(1/FVPSTB)]
	Message Buf.	Write(16 bit)	1	11	Synchronization of NPB signals with VPCLK
					RAM access delay (1 RAM – WR access)
					<calculating clocks="" number="" of="" wait=""></calculating>
					MIN. ROUNDUP[(1/FCANCLK) × 2/(1/FVPSTB)]
					MAX. ROUNDUP[(1/FCANCLK) × 3/(1/FVPSTB)]

### Table 33-2. RAM Access That Generate Wait and Number of CPU Wait Clocks

Caution When Value is  $\Phi_{CANMOD}(CAN \text{ module system clock}) \ge 2 \text{ MHz}.$ 

Remark FVPCLK: VPCLK frequency

FVPSTB: VPSTB frequency

FCANCLK: AFCAN macro frequency



### 33.3 Example of Wait Occurrence

- Serial interface UART61
  - <On execution of MOV A, ASIS61> Number of execution clocks: 6
  - (5 clocks when data is read from a register that does not issue a wait (MOV A, sfr).)



# APPENDIX A DEVELOPMENT TOOLS

The following development tools are available for the development of systems that employ the 78K0/Dx2. **Figure A-1** shows the development tool configuration.





### (1) When using the in-circuit emulator QB-78K0DX2



- **Notes 1.** Download the device file for 78K0/Dx2 microcontrollers (DF780849) and the integrated debugger ID78K0-QB from the download site for development tools (http://www.necel.com/micro/en/ods/index.html).
  - 2. SM+ for 78K0 (instruction simulation version) is included in the software package.
  - The project manager PM+ is included in the assembler package.
     PM+ cannot be used other than with Windows<sup>™</sup>.
  - **4.** QB-78K0DX2 is supplied with the integrated debugger ID78K0-QB, a USB interface cable, the on-chip debug emulator with programming function QB-MINI2, connection cables (10-pin and 16-pin cables), and the 78K0-OCD board. Any other products are sold separately.



### (2) When using the on-chip debug emulator with programming function QB-MINI2



- **Notes 1.** Download the device file for 78K0/Dx2 microcontrollers (DF780849) and the integrated debugger ID78K0-QB from the download site for development tools (http://www.necel.com/micro/en/ods/index.html).
  - 2. SM+ for 78K0 (instruction simulation version) is included in the software package.
  - The project manager PM+ is included in the assembler package. PM+ cannot be used other than with Windows.
  - 4. QB-MINI2 is supplied with USB interface cable, connection cables (10-pin cable and 16-pin cable), and 78K0-OCD board. Any other products are sold separately. In addition, download the software for operating the QB-MINI2 from the download site for development tools (http://www.necel.com/micro/en/ods/index.html).

### A.1 Software Package

SP78K0	Development tools (software) common to the 78K0 microcontrollers are combined in this
78K0 microcontroller software	package.
package	

### A.2 Language Processing Software

RA78K0 <sup>Note 1</sup> Assembler package	This assembler converts programs written in mnemonics into object codes executable with a microcontroller. This assembler is also provided with functions capable of automatically creating symbol tables and branch instruction optimization. This assembler should be used in combination with a device file (DF780849). < <b>Precaution when using RA78K0 in PC environment&gt;</b> This assembler package is a DOS-based application. It can also be used in Windows, however, by using the Project Manager (PM+) on Windows. PM+ is included in assembler package.
CC78K0 <sup>Note 1</sup> C compiler package	This compiler converts programs written in C language into object codes executable with a microcontroller. This compiler should be used in combination with an assembler package and device file. < <b>Precaution when using CC78K0 in PC environment&gt;</b> This C compiler package is a DOS-based application. It can also be used in Windows, however, by using the Project Manager (PM+) on Windows. PM+ is included in assembler package.
DF780849 <sup>Note 2</sup> Device file	This file contains information peculiar to the device. This device file should be used in combination with a tool (RA78K0, CC78K0, ID78K0- QB, and the system simulator). The corresponding OS and host machine differ depending on the tool to be used.

- **Notes 1.** If the versions of RA78K0 and CC78K0 are Ver.4.00 or later, different versions of RA78K0 and CC78K0 can be installed on the same machine.
  - The DF780849 can be used in common with the RA78K0, CC78K0, ID78K0-QB, and the system simulator. Download the DF780849 from the download site for development tools (http://www.necel.com/micro/en/ods/index.html).



### A.3 Flash Memory Programming Tools

### A.3.1 When using flash memory programmer PG-FP5 and FL-PR5

PG-FP5, FL-PR5 Flash memory programmer	Flash memory programmer dedicated to microcontrollers with on-chip flash memory.
FA-64GB-GAH-B, FA-80GK-GAK-B Flash memory programming adapter	Flash memory programming adapter used connected to the flash memory programmer for use. • FA-64GB-GAH-B: 64-pin plastic LQFP (GB-GAH type) • FA-80GK-GAK-B: 80-pin plastic LQFP (GK-GAK type)

- Remarks 1. FL-PR5, FA-64GB-GAH-B, and FA-80GK-GAK-B are products of Naito Densei Machida Mfg. Co., Ltd (http://www.ndk-m.co.jp/, TEL: +81-42-750-4172).
  - 2. Use the latest version of the flash memory programming adapter.

### A.3.2 When using on-chip debug emulator with programming function QB-MINI2

QB-MINI2 On-chip debug emulator with programming function	This is a flash memory programmer dedicated to microcontrollers with on-chip flash memory. It is available also as on-chip debug emulator which serves to debug hardware and software when developing application systems using the 78K0/Dx2. When using this as flash memory programmer, it should be used in combination with a connection cable (16-pin cable) and a USB interface cable that is used to connect the host machine.
Target connector specifications	16-pin general-purpose connector (2.54 mm pitch)

- **Remarks 1.** The QB-MINI2 is supplied with a USB interface cable and connection cables (10-pin cable and 16-pin cable), and the 78K0-OCD board. A connection cable (10-pin cable) and the 78K0-OCD board are used only when using the on-chip debug function.
  - 2. Download the software for operating the QB-MINI2 from the download site for development tools (http://www.necel.com/micro/en/ods/index.html).



### A.4 Debugging Tools (Hardware)

### A.4.1 When using in-circuit emulator QB-78K0DX2

QB-78K0DX2 In-circuit emulator	The in-circuit emulator serves to debug hardware and software when developing application systems using the 78K0/Dx2. It supports the integrated debugger (ID78K0-QB). This emulator should be used in combination with a power supply unit and emulation probe, and the USB is used to connect this emulator to the host machine.
QB-144-CA-01 Check pin adapter	This adapter is used in waveform monitoring using the oscilloscope, etc.
QB-80-EP-01T Emulation probe	This emulation probe is flexible type and used to connect the in-circuit emulator and target system.
QB-64GB-EA-10T QB-80GK-EA-01T Exchange adapter	<ul> <li>This adapter is used to perform the pin conversion from the in-circuit emulator to the target connector.</li> <li>QB-64GB-EA-10T: For 64-pin plastic LQFP (GB-GAH type)</li> <li>QB-80GK-EA-01T: For 80-pin plastic LQFP (GK-GAK type)</li> </ul>
QB-64GB-YS-01T QB-80GK-YS-01T Space adapter	<ul> <li>This space adapter is used to adjust the height between the target system and in-circuit emulator.</li> <li>QB-64GB-YS-01T: For 64-pin plastic LQFP (GB-GAH type)</li> <li>QB-80GK-YS-01T: For 80-pin plastic LQFP (GK-GAK type)</li> </ul>
QB-64GB-YQ-01T QB-80GK-YQ-01T YQ connector	<ul> <li>This YQ connector is used to connect the target connector and exchange adapter.</li> <li>QB-64GB-YQ-01T: For 64-pin plastic LQFP (GB-GAH type)</li> <li>QB-80GK-YQ-01T: For 80-pin plastic LQFP (GK-GAK type)</li> </ul>
QB-64GB-HQ-01T QB-80GK-HQ-01T Mount adapter	<ul> <li>This mount adapter is used to mount the target device with socket.</li> <li>QB-64GB-HQ-01T: For 64-pin plastic LQFP (GB-GAH type)</li> <li>QB-80GK-HQ-01T: For 80-pin plastic LQFP (GK-GAK type)</li> </ul>
QB-64GB-NQ-01T QB-80GK-NQ-01T Target connector	<ul> <li>This target connector is used to mount on the target system.</li> <li>QB-64GB-NQ-01T: For 64-pin plastic LQFP (GB-GAH type)</li> <li>QB-80GK-NQ-01T: For 80-pin plastic LQFP (GK-GAK type)</li> </ul>

Remarks 1. The QB-78K0DX2 is supplied with the integrated debugger ID78K0-QB, a USB interface cable, the on-chip debug emulator QB-MINI2, connection cables (10-pin and 16-pin cables), and the 78K0-OCD board.

Download the software for operating the QB-MINI2 from the download site for development tools (http://www.necel.com/micro/en/ods/index.html) when using the QB-MINI2.

**2.** The packed contents differ depending on the part number, as follows.

Package Contents	In-Circuit Emulator	Emulation Probe	Exchange Adapter	YQ Connector	Target Connector
Part Number					
QB-78K0DX2-ZZZ (-EE)	QB-78K0DX2	Not included			
QB-78K0DX2-T64GB		QB-80-EP-01T	QB-64GB-EA-10T	QB-64GB-YQ-01T	QB-64GB-NQ-01T
QB-78K0DX2-T80GK			QB-80GK-EA-01T	QB-80GK-YQ-01T	QB-80GK-NQ-01T



QB-MINI2 On-chip debug emulator with programming function	This on-chip debug emulator serves to debug hardware and software when developing application systems using the 78K0/Dx2. It is available also as flash memory programmer dedicated to microcontrollers with on-chip flash memory. When using this as on-chip debug emulator, it should be used in combination with a connection cable (10-pin cable or 16-pin cable), a USB interface cable that is used to connect the host machine, and the 78K0-OCD board.
Target connector specifications	10-pin general-purpose connector (2.54 mm pitch) or 16-pin general-purpose connector (2.54 mm pitch)

### A.4.2 When using on-chip debug emulator with programming function QB-MINI2

- **Remarks 1.** The QB-MINI2 is supplied with a USB interface cable and connection cables (10-pin cable and 16-pin cable), and the 78K0-OCD board. A connection cable (10-pin cable) and the 78K0-OCD board are used only when using the on-chip debug function.
  - Download the software for operating the QB-MINI2 from the download site for development tools (http://www.necel.com/micro/en/ods/index.html).



### A.5 Debugging Tools (Software)

ID78K0-QB <sup>№™</sup>	This debugger supports the in-circuit emulators for the 78K0 microcontrollers. The ID78K0-QB is Windows-based software.
Integrated debugger	It has improved C-compatible debugging functions and can display the results of tracing with the source program using an integrating window function that associates the source program, disassemble display, and memory display with the trace result. It should be used in combination with the device file (DF780849).
SM+ for 78K0 System simulator	<ul> <li>System simulator is Windows-based software.</li> <li>It is used to perform debugging at the C source level or assembler level while simulating the operation of the target system on a host machine.</li> <li>Use of system simulator allows the execution of application logical testing and performance testing on an independent basis from hardware development, thereby providing higher development efficiency and software quality.</li> <li>System simulator should be used in combination with the device file (DF780849).</li> <li>The following one type of system simulators supporting the 78K0/Dx2 microcontrollers is available.</li> <li>SM+ for 78K0 (instruction simulation version)</li> <li>This can only simulate a CPU. It is included in the software package.</li> </ul>

**Note** Download the ID78K0-QB from the download site for development tools (http://www.necel.com/micro/en/ods/index.html).



### APPENDIX B NOTES ON TARGET SYSTEM DESIGN

This chapter shows areas on the target system where component mounting is prohibited and areas where there are component mounting height restrictions when the QB-78K0DX2 is used.

### (a) Case of 64-pin GB package





Exchange adapter area: Components up to 17.45 mm in height can be mounted<sup>Note</sup>
 Emulation probe tip area: Components up to 24.45 mm in height can be mounted<sup>Note</sup>

Note Height can be adjusted by using space adapters (each adds 2.4 mm)



### (b) Case of 80-pin GK package



Figure B-2. The Restriction Domain on a Target System (Case of 80-pin GK Package)

Exchange adapter area: Components up to 17.45 mm in height can be mounted<sup>Note</sup>
 Emulation probe tip area: Components up to 24.45 mm in height can be mounted<sup>Note</sup>

**Note** Height can be adjusted by using space adapters (each adds 2.4 mm)



# APPENDIX C REGISTER INDEX

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ZPD flag detection clock setting register (CMPCTL)	.681
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ADCR: 10-bit A/D conversion result register	359
ADCRH: 8-bit A/D conversion result register	
ADM: A/D converter mode register	356
ADPC: A/D port configuration register	
ADS: Analog input channel specification register	
ASICL60: Asynchronous serial interface control register 60	
ASICL61: Asynchronous serial interface control register 61	
ASIF60: Asynchronous serial interface transmission status register 60	
ASIF61: Asynchronous serial interface transmission status register 61	
ASIM60: Asynchronous serial interface operation mode register 60	
ASIM61: Asynchronous serial interface operation mode register 61	
ASIS60: Asynchronous serial interface reception error status register 60	
ASIS61: Asynchronous serial interface reception error status register 61	
[B]	007
BRGC60: Baud rate generator control register 60	
BRGC61: Baud rate generator control register 61	
[C]	
C0BRP: CAN module bit rate prescaler register	
C0BTR: CAN module bit rate register	589
C0CTRL: CAN module control register	578
C0ERC: CAN module error counter register	584
COGMABT: CAN global automatic block transmission control register	573
C0GMABTD: CAN global automatic block transmission delay setting register	575
C0GMCS: CAN global clock selection register	572
C0GMCTRL: CAN global control register	570
C0IE: CAN module interrupt enable register	
C0INFO: CAN module information register	
COINTS: CAN module interrupt status register	
COLEC: CAN module last error code register	
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C0LOPT: CAN module last out-pointer register	
C0MASK1H: CAN module mask 1 register H	576
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COMCTRLm: CAN message control register m	602
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COMDATA1m: CAN message data byte 1 register m	
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COMDATA3m: CAN message data byte 3 register m	
C0MDATA45m: CAN message data byte 45 register m	
COMDATA4m: CAN message data byte 4 register m	
COMDATA5m: CAN message data byte 5 register m	
COMDATA67m: CAN message data byte 67 register m	
COMDATA6m: CAN message data byte 6 register m	
COMDATA7m: CAN message data byte 7 register m	
COMDLCm: CAN message data length register m	
C0MIDHm: CAN message ID register Hm	601
COMIDLm: CAN message ID register Lm	601
CORGPT: CAN module receive history list register	
C0TGPT: CAN module transmit history list register	
COTS: CAN module time stamp register	
CKS: Clock output selection register	
CKSR60: Clock selection register 60	
CKSR61: Clock selection register 61	
CMPCTL: ZPD flag detection clock setting register	
CR50: 8-bit timer compare register 50	
CR51: 8-bit timer compare register 51	
CSIC10: Serial clock selection register 10	
CSIC11: Serial clock selection register 11	
CSIM10: Serial operation mode register 10	
CSIM11: Serial operation mode register 11	
נחז	
DMUCO: Multiplier/divider control register 0	775
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[E]	
EGN: External interrupt falling edge enable register	
EGP: External interrupt rising edge enable register	736
[I]	
IF0H: Interrupt request flag register 0H	
IF0L: Interrupt request flag register 0L	
IF1H: Interrupt request flag register 1H	
IF1L: Interrupt request flag register 1L	
IIC0: IIC shift register 0	
IICC0: IIC control register 0	
IICCL0: IIC clock selection register 0	
IICF0: IIC flag register 0	
IICS0: IIC status register 0	
IICX0: IIC function expansion register 0	
IMS: Internal memory size switching register	
ISC: Input switch control register	
IXS: Internal expansion RAM size switching register	
[1]	
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I CDM: I CD display mode register	
	e02
LCDMD: LCD mode register	



# APPENDIX C REGISTER INDEX

LCDPF0: LCD port function register 0	
LCDPF3: LCD port function register 3	
LCDPFALL: LCD port function register ALL	
LVIM: Low-voltage detection register	
LVIS: Low-voltage detection level selection register	

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MCM: Main clock mode register	179
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MDA0H: Multiplication/division data register A0H	773
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MDB0: Multiplication/division data register B0	774
MK0H: Interrupt mask flag register 0H	734
MK0L: Interrupt mask flag register 0L	734
MK1H: Interrupt mask flag register 1H	734
MK1L: Interrupt mask flag register 1L	734
MOC: Main OSC control register	

### [0]

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OSTC: Oscillation stabilization time counter status register	183,	746
OSTS: Oscillation stabilization time select register	184,	747

# [P]

P0: Port register 0	154
P1: Port register 1	154
P12: Port register 12	154
2: Port register 2	154
P3: Port register 3	154
P6: Port register 6	154
P7: Port register 7	154
P8: Port register 8	154
29: Port register 9	154
PCC: Processor clock control register	176
PM0: Port mode register 0	2, 323



PM1: Port mode register 1	152, 405, 439
PM12: Port mode register 12.	
PM2: Port mode register 2	
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PM6: Port mode register 6	
PM7: Port mode register 7	152, 351, 405, 439
PM8: Port mode register 8	
PM9: Port mode register 9	
POM6: Port output mode control register 6	
PR0H: Priority specification flag register 0H	735
PR0L: Priority specification flag register 0L	735
PR1H: Priority specification flag register 1H	735
PR1L: Priority specification flag register 1L	735
PU0: Pull-up resistor option register 0	
PU1: Pull-up resistor option register 1	
PU12: Pull-up resistor option register 12	
PU3: Pull-up resistor option register 3	
PU6: Pull-up resistor option register 6	
PU7: Pull-up resistor option register 7	

### [R]

RCM: Internal oscillator mode register	178
RESF: Reset control flag register	770
RXB60: Receive buffer register 60	
RXB61: Receive buffer register 61	
RXS60: Receive shift register 60	
RXS61: Receive shift register 61	

# [S]

SDR0: Remainder data register 0	773
SG0CTL: SG0 control register	718
SG0FH: SG0 frequency high register	719
SG0FL: SG0 frequency low register	719
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## [T]

TCL50: Timer clock selection register 50	319
TCL51: Timer clock selection register 51	319
TIPNF0: TMP0, TMP1 input noise filter control register 0	237
TIPNF1: TMP2, TMP3 input noise filter control register 1	237
TIPNF2: TMP4 input noise filter control register 2	237
TM50: 8-bit timer counter 50	317
TM51: 8-bit timer counter 51	317
TMC50: 8-bit timer mode control register 50	321
TMC51: 8-bit timer mode control register 51	321



TP0CCR0: TMP0 capture/compare register 0	224
TP0CCR1: TMP0 capture/compare register 1	226
TP0CNT: TMP0 counter read buffer register	228
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TP0CTL1: TMP0 control register 1	218
TP0IOC0: TMP0 I/O control register 0	220
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TP0IOC2: TMP0 I/O control register 2	222
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TP1CCR0: TMP1 capture/compare register 0	224
TP1CCR1: TMP1 capture/compare register 1	226
TP1CNT: TMP1 counter read buffer register	228
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TP4IOC1: TMP4 I/O control register 1	221
TP4IOC2: TMP4 I/O control register 2	222
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TXB60: Transmit buffer register 60	384
TXB61: Transmit buffer register 61	384
TXS60: Transmit shift register 60	384
TXS61: Transmit shift register 61	384



[W]	
WDTE: Watchdog timer enable register	
WTM: Watch timer operation mode register	
[Z]	
ZPDEN: ZPD operational control register	681
ZPDS0: ZPD detection voltage setting register 0	
ZPDS1: ZPD detection voltage setting register 1	680



#### APPENDIX D LIST OF CAUTIONS

This appendix lists cautions described in this document. "Classification (hard/soft)" in table is as follows.

#### Hard: Cautions for microcontroller internal/external hardware

Soft: Cautions for software such as register settings or programs

					(1	/36)							
Chapter	Classification	Function	Details of Function	Cautions	Page	3							
Chapter 1	Hard	On-chip debug function	_	The 78K0/Dx2 has an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.	p. 19								
		Pin function	AVss	Make AVss the same potential as Vss.	pp. 21 to 24								
			REGC	Connect the REGC pin to Vss via a capacitor (0.47 to 1 $\mu$ F: recommended).	pp. 21 to 24								
			ANI0/P20 to ANIn/P2n	ANI0/P20 to ANIn/P2n are set in the analog input mode after release of reset.	pp. 21 to 24								
oter 2	Hard	Pin function	Pin function	면 Pin function	ANI0/P20 to ANI7/P27	ANI0/P20 to ANI7/P27 are set in the analog input mode after release of reset.	p. 54						
Chap		-						P31/SEG5/ OCD1A	Be sure to pull the P31/SEG5/OCD1A pin down before a reset release, to prevent malfunction.	p. 54			
											P121/X1 Connect P121/X1 as follows when writing the programmer. - P121/X1: When using this pin as a port, con recommended) (in the input mode) or leave it The above connection is not necessary when of self programming.	Connect P121/X1 as follows when writing the flash memory with a flash programmer. - P121/X1: When using this pin as a port, connect it to VSS via a resistor (10 kΩ: recommended) (in the input mode) or leave it open (in the output mode). The above connection is not necessary when writing the flash memory by means of self programming.	p. 58
			REGC pin	Keep the wiring length as short as possible for the broken-line part in the above figure.	p. 59								
Chapter 3	Soft	Soft	Soft	Soft	Soft	Soft	Soft	Soft	5 Memory space	IMS, IXS: Internal memory size switching register, internal expansion RAM	Regardless of the internal memory capacity, the initial values of the internal memory size switching register (IMS) and internal expansion RAM size switching register (IXS) of all products in the 78K0/Dx2 microcontrollers are fixed (IMS = CFH, IXS = 0CH). Therefore, set the value corresponding to each product as indicated below.	p. 73	
						size switching register	To set the memory size, set IMS and then IXS. Set the memory size so that the internal ROM and internal expansion RAM areas do not overlap.	p. 73					
			SFR: Special function register	Do not access addresses to which SFRs are not assigned.	p. 81								
					EFR: Extendedl function register	Do not access addresses to which EFRs are not assigned.	pp. 81, 98						
										SP: Stack pointer	Since reset signal generation makes the SP contents undefined, be sure to initialize the SP before using the stack.	p. 87	



					(2/	36												
Chapter	Classification	Function	Details of Function	Cautions	Page													
Chapter 4	Soft	Port function	P00 to P07	When using P00 to P07 as an alternate function in output mode, set the corresponding port latch to 0. When using P00 to P07 as general-purpose ports, specify the port settings so that the alternate-function outputs are fixed to 0.	p. 118													
			P10/SCK10/INTP 4/TxD61, P12/SO10/INTP2	To use P10/SCK10/INTP4/TxD61 and P12/SO10/INTP2 as general-purpose ports, set serial operation mode register 10 (CSIM10) and serial clock selection register 10 (CSIC10) to the default status (00H)	p. 119													
			P10/SCK10/INTP 4/TxD61, P13/SEG23/TIOP 30/TxD60	To use P10/SCK10/INTP4/TxD61 and P13/SEG23/TIOP30/TxD60 as general- purpose port, clear bit 0 (TXDLV60, TXDLV61) of asynchronous serial interface control registers 60, 61 (ASICL60, ASICL61) to 0 (normal output of TxD60, TxD61).	p. 119													
			P10, P71, P74	When using Pxx as an alternate function in output mode, set the port latch to 1. When using Pxx as a general-purpose port, specify the port settings so that the alternate-function outputs are fixed to 1.	pp. 119, 130, 132, 133													
			P16, P60, P61, P72, P73, P76, P77, P80 to P87, P90 to P97 P12 P12 P12 P12 P12 P12 P12 P12 P12 P12	When using Pxx as an alternate function in output mode, set the port latch to 0. When using Pxx as a general-purpose port, specify the port settings so that the alternate-function outputs are fixed to 0.	pp. 121, 123, 128, 131, 136 to 140, 142, 145, 147													
															P13	When using the alternate function TIOP30, set the port latch to 0. When using the alternate function TxD60, set the port latch to 1. When using P13 as a general-purpose port, specify the port settings so that the alternate-function outputs are fixed to 1.	p. 122	
	Hard		Port 2	Make the AV_{\text{REF}} pin the same potential as the V_DD pin when port 2 is used as a digital port.	p. 124													
			P31/SEG5/ OCD1A	Be sure to pull the P31/SEG5/OCD1A pin down before a reset release, to prevent malfunction.	p. 126													
	Soft		P74/SCK11, P76/SO11,	To use P74/SCK11 and P76/SO11 as general-purpose ports, set serial operation mode register 11 (CSIM10) and serial clock selection register 11 (CSIC10) to the default status (00H).	p. 129													
	Hard		P77/SSI11/SEG	To use P77/SSI11/SEG27 as general-purpose ports, set serial operation mode register 11 (CSIM11) to the default status (00H)	p. 129													



						(3	8/36)
Chapter	Classification	Function	Details of Function	Cautions		Pag	9
Chapter 4	Soft	Port function	P121/X1/OCD0A, P122/X2/EXCLK/ OCD0B, P123/XT1, P124/XT2/EXCLKS	When using the P121 to P124 pins to connect a resonator for the main system clock (X1, X2) or subsystem clock (XT1, XT2), or to input an external clock for the main system clock (EXCLK) or subsystem clock (EXCLKS), the X1 oscillation mode, XT1 oscillation mode, or external clock input mode must be set by using the clock operation mode select register (OSCCTL) (for details, see 5.3 (5) Clock operation mode select register (OSCCTL)). The reset value of OSCCTL is 00H (all of the P121 to P124 pins are I/O port pins). At this time, setting of the PM121 to PM124 and P121 to P124 pins is not necessary.	p.	148	
				Connect P121/X1 as follows when writing the flash memory with a flash programmer. - P121/X1: When using this pin as a port, connect it to Vss via a resistor (10 k $\Omega$ : recommended) (in the input mode) or leave it open (in the output mode). The above connection is not necessary when writing the flash memory by means of self programming.	p.	148	
			LCD port function register ALL (LCDPFALL)	$\mu$ PD78D0838, 78F0839: Set PF7UPPNIB to 0. $\mu$ PD78DF0840, 78F0841, 78F0846, 78F0847: Set PF7UPPNIB and PF9ALL to 0. $\mu$ PD78DF0842, 78F0843, 78F0848, 78F0849: Set PF8ALL and PF9ALL to 0.	p.	158	
			Stepper motor port mode control register (SMPC)	Set port registers (Pn) and port mode registers (PMn) whose pins are not in the PWM mode to 00H in the PWM full bridge mode.	p.	159	
			ADPC: A/D port configuration	Set the channel used for A/D conversion to the input mode by using port mode register 2 (PM2).	p.	160	
			register	Do not set the pin set by ADPC as digital I/O by analog input channel specification register (ADS).	p.	160	
				If data is written to ADPC, a wait cycle is generated. Do not write data to ADPC when the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p.	160	
			1-bit manipulation instruction for port register n (Pn)	When a 1-bit manipulation instruction is executed on a port that provides both input and output functions, the output latch value of an input port that is not subject to manipulation may be written in addition to the targeted bit. Therefore, it is recommended to rewrite the output latch when switching a port from input mode to output mode.	p.	171	



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Chapter	Classification	Function	Details of Function	Cautions	Pa	ge
napter 5	Soft	Clock generator	PCC: Processor clock control register	Be sure to clear bits 1 to 3 to 0.	p. 176	، <u>ا</u>
ō			RCM: Internal oscillation mode register	<ul> <li>When setting RSTOP to 1, be sure to confirm that the CPU operates with a clock other than the internal high-speed oscillation clock. Specifically, set under either of the following conditions.</li> <li>When MCS = 1 (when CPU operates with the high-speed system clock)</li> <li>When CLS = 1 (when CPU operates with the subsystem clock)</li> </ul>	p. 178	, 🗌
			MCM: Main	XSEL can be changed only once after a reset release.	p. 179	,
			clock mode register	The peripheral hardware cannot operate when the peripheral hardware clock is stopped. To resume the operation of the peripheral hardware after the peripheral hardware clock has been stopped, initialize the peripheral hardware.	p. 179	<b>)</b>
	Hard			<ul> <li>A clock other than fPBS is supplied to the following peripheral functions regardless of the setting of XSEL and MCM0.</li> <li>Watchdog timer</li> <li>When "fosc", "fosc/2<sup>7</sup>", or "fosc/2<sup>9</sup>" is selected as the count clock for 8-bit timer TM50</li> <li>Peripheral hardware selects the external clock as the clock source</li> </ul>	p. 17§	
				It takes one clock to change the CPU clock.	p. 179	)
	Soft		MOC: Main OSC control register	<ul> <li>When setting MSTOP to 1, be sure to confirm that the CPU operates with a clock other than the high-speed system clock. Specifically, set under either of the following conditions.</li> <li>When MCS = 0 (when CPU operates with the internal high-speed oscillation clock)</li> <li>When CLS = 1 (when CPU operates with the subsystem clock)</li> <li>In addition, stop peripheral hardware that is operating on the high-speed system clock before setting MSTOP to 1</li> </ul>	p. 180	
				Do not clear MSTOP to 0 while bit 6 (OSCSEL) of the clock operation mode select register (OSCCTL) is 0 (I/O port mode).	p. 180	)
			OSCCTL: Clock operation mode	The peripheral hardware cannot operate when the peripheral hardware clock is stopped. To resume the operation of the peripheral hardware after the peripheral hardware clock has been stopped, initialize the peripheral hardware.	p. 180	)
				Be sure to set AMPH to 1 if the high-speed system clock oscillation frequency exceeds 10 MHz.	p. 181	
			select register	Set AMPH before setting the main clock mode register (MCM).	p. 181	
				Set AMPH before setting the peripheral functions after a reset release. The value of AMPH can be changed only once after a reset release. When the high-speed system clock (X1 oscillation) is selected as the CPU clock, supply of the CPU clock is stopped for 4.06 to $16.12 \mu s$ after AMPH is set to 1. When the high-speed system clock (external clock input) is selected as the CPU clock, supply of the CPU clock is stopped for the duration of 160 external clocks after AMPH is set to 1.	p. 181	
	Hard			If the STOP instruction is executed when AMPH = 1, supply of the CPU clock is stopped for 4.06 to 16.12 $\mu$ s after the STOP mode is released when the internal high-speed oscillation clock is selected as the CPU clock, or for the duration of 160 external clocks when the high-speed system clock (external clock input) is selected as the CPU clock. When the high-speed system clock (X1 oscillation) is selected as the CPU clock, the oscillation stabilization time is counted after the STOP mode is released.	p. 181	
1	oft	]		AMPH can be changed only once after a reset release.	p. 181	
	Ň			To change the value of EXCLK and OSCSEL, be sure to confirm that bit 7 (MSTOP) of the main OSC control register (MOC) is 1 (the X1 oscillator stops or the external clock from the EXCLK pin is disabled).	p. 182	2
				To change the value of EXCLKS and OSCSELS, confirm that bit 5 (CLS) of the processor clock control register (PCC) is 0 (the CPU is operating with the high-speed system clock).	p. 182	<u>'</u>



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Chapter	Classification	Function	Details of Function	Cautions		Page	9
ter 5	Soft	Clock generator	OSTC: Oscillation	After the above time has elapsed, the bits are set to 1 in order from MOST11 and remain 1.	p.	183	
Chap			stabilization time counter status register	<ul> <li>The oscillation stabilization time counter counts up to the oscillation stabilization time set by OSTS. If the STOP mode is entered and then released while the internal high-speed oscillation clock is being used as the CPU clock, set the oscillation stabilization time as follows.</li> <li>Desired OSTC oscillation stabilization time ≤ Oscillation stabilization time set by OSTS</li> </ul>	p.	183	
	ard			Note, therefore, that only the status up to the oscillation stabilization time set by OSTS is set to OSTC after STOP mode is released.			
	Hard			The X1 clock oscillation stabilization wait time does not include the time until clock oscillation starts ("a" below).	p.	183	
	Soft		OSTS: Oscillation	To set the STOP mode when the X1 clock is used as the CPU clock, set OSTS before executing the STOP instruction.	p.	184	
			stabilization time select register	Do not change the value of the OSTS register during the X1 clock oscillation stabilization time.	p.	184	
				<ul> <li>The oscillation stabilization time counter counts up to the oscillation stabilization time set by OSTS. If the STOP mode is entered and then released while the internal high-speed oscillation clock is being used as the CPU clock, set the oscillation stabilization time as follows.</li> <li>Desired OSTC oscillation stabilization time ≤ Oscillation stabilization time set by OSTS</li> <li>Note, therefore, that only the status up to the oscillation stabilization time set by OSTS is set to OSTC after STOP mode is released.</li> </ul>	p.	184	
	Hard			The X1 clock oscillation stabilization wait time does not include the time until clock oscillation starts ("a" below).	p.	184	
		X1/XT1 oscillator		<ul> <li>When using the X1 oscillator and XT1 oscillator, wire as follows in the area enclosed by the broken lines in the Figures 5-9 and 5-10 to avoid an adverse effect from wiring capacitance.</li> <li>Keep the wiring length as short as possible.</li> <li>Do not cross the wiring with the other signal lines. Do not route the wiring near a signal line through which a high fluctuating current flows.</li> <li>Always make the ground point of the oscillator capacitor the same potential as Vss. Do not ground the capacitor to a ground pattern through which a high current flows.</li> <li>Do not fetch signals from the oscillator.</li> <li>Note that the XT1 oscillator is designed as a low-amplitude circuit for reducing power consumption.</li> <li>When X2 and XT1 are wired in parallel, the crosstalk noise of X2 may increase</li> </ul>	р. р.	186	



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Chapter	Classification	Function	Details of Function	Cautions		Pag	e					
Chapter 5	Hard	Clock generator operation when power supply	_	When the standup of voltage until it reaches 1.8 V from the time of a power supply injection is looser than 0.5 V/ms (MIN.), input a low level into RESET pin, or set up 2.7 V/1.59 V POC mode (LVISTART = 1) from an option byte until it reaches 1.8 V from the time of a power supply injection (refer to Figure 5-13). When a low level is inputted into RESET pin until it reaches 1.8 V, after the reset release by RESET pin operates to the same timing as <2> of Figure 5-12 or subsequent ones.	p.	191						
		voltage is turned on		When using the external clock input from EXCLK pin and EXCLKS pin, oscillation stable waiting time is unnecessary.	p.	191						
		Controlling		A voltage oscillation stabilization time of 1.93 to 5.39 ms is required after the power supply voltage reaches 1.59 V (TYP.). If the supply voltage rises from 1.59 V (TYP.) to 2.7 V (TYP.) within 1.93 ms, the power supply oscillation stabilization time of 0 to 5.39 ms is automatically generated before reset processing.	p.	192						
					It is not necessary to wait for the oscillation stabilization time when an external clock input from the EXCLK and EXCLKS pins is used.	p.	192					
	Soft	Controlling high-speed	X1/P121 and X2/EXCLK/P122	The X1/P121 and X2/EXCLK/P122 pins are in the I/O port mode after a reset release.	p.	193						
		system	X1 clock	Do not change the value of EXCLK and OSCSEL while the X1 clock is operating.	p.	194						
		CIOCK		Set the X1 clock after the supply voltage has reached the operable voltage of the clock to be used (see CHAPTER 29 ELECTRICAL SPECIFICATIONS ((A) GRADE PRODUCTS).	p.	194						
			External main system clock	Do not change the value of EXCLK and OSCSEL while the external main systerm clock is operating.	p.	195						
				Set the external main system clock after the supply voltage has reached the operable voltage of the clock to be used (see CHAPTER 29 ELECTRICAL SPECIFICATIONS ((A) GRADE PRODUCTS).	p.	195						
			Main sys clock High-spe system c Internal h speed os clock	Main system clock	If the high-speed system clock is selected as the main system clock, a clock other than the high-speed system clock cannot be set as the peripheral hardware clock.	p.	196					
				High-speed system clock	Be sure to confirm that MCS = 0 or CLS = 1 when setting MSTOP to 1. In addition, stop peripheral hardware that is operating on the high-speed system clock.	p.	197					
										Internal high- speed oscillation clock	Be sure to confirm that MCS = 1 or CLS = 1 when setting RSTOP to 1. In addition, stop peripheral hardware that is operating on the internal high-speed oscillation clock.	p.
			XT1/P123, XT2/EXCLKS/ P124	The XT1/P123 and XT2/EXCLKS/P124 pins are in the I/O port mode after a reset release.	p.	200						
			XT1 clock, external subsystem clock	Do not change the value of EXCLKS, and OSCSELS while the subsystem clock is operating.	p.	200						
			Subsystem clock	Be sure to confirm that CLS = 0 when clearing OSCSELS to 0. In addition, stop the watch timer if it is operating on the subsystem clock.	p.	201						
1				The subsystem clock oscillation cannot be stopped using the STOP instruction.	p.	201						
		Controlling internal low-speed oscillation clock	Internal low- speed oscillation clock	If "Internal low-speed oscillator cannot be stopped" is selected by the option byte, oscillation of the internal low-speed oscillation clock cannot be controlled.	p.	202						



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Chapter	Classification	Function	Details of Function	Cautions		Page	9
Chapter 5	Soft	CPU clock	_	Selection of the main system clock cycle division factor (PCC0 to PCC2) and switchover from the main system clock to the subsystem clock (changing CSS from 0 to 1) should not be set simultaneously. Simultaneous setting is possible, however, for selection of the main system clock cycle division factor (PCC0 to PCC2) and switchover from the subsystem clock to the main system clock (changing CSS from 1 to 0).	p.	210	
				When switching the internal high-speed oscillation clock to the high-speed system clock, bit 2 (XSEL) of MCM must be set to 1 in advance. The value of XSEL can be changed only once after a reset release.	p.	211	
hapter 6	Soft	16-bit timer/event counter P	TPnCTL0: TMPn control register 0	Set the TPnCKS2 to TPnCKS0 bits when the TPnCE bit = 0. When the value of the TPnCE bit is changed from 0 to 1, the TPnCKS2 to TPnCKS0 bits can be set simultaneously.	p.	217	
Ö		(TMP)		Be sure to clear bits 3 to 6 to "0".	p.	217	
	Hard		TPnCTL1: TMPn control register 1	The TPnEST bit is valid only in the external trigger pulse output mode or one- shot pulse output mode. In any other mode, writing 1 to this bit is ignored.	p.	219	
				External event count input is selected in the external event count mode regardless of the value of the TPnEEE bit.	p.	219	
	Soft			Set the TPnEEE and TPnMD2 to TPnMD0 bits when the TPnCTL0.TPnCE bit = 0. (The same value can be written when the TPnCE bit = 1.) The operation is not guaranteed when rewriting is performed with the TPnCE bit = 1. If rewriting was mistakenly performed, clear the TPnCE bit to 0 and then set the bits again.	p.	219	
				Be sure to clear bits 3, 4, and 7 to "0".	p.	219	
			TPnIOC0: TMPn I/O control register 0	Rewrite the TPnOL1, TPnOE1, TPnOL0, and TPnOE0 bits when the TPnCTL0.TPnCE bit = 0. (The same value can be written when the TPnCE bit = 1.) If rewriting was mistakenly performed, clear the TPnCE bit to 0 and then set the bits again.	p.	221	
	Hard			Even if the TPnOLm bit is manipulated when the TPnCE and TPnOEm bits are 0, the TIOPnm pin output level varies ( $m = 0, 1$ ).	p.	221	
	Soft		TPnIOC1: TMPn I/O control register 1	Rewrite the TPnIS3 to TPnIS0 bits when the TPnCTL0.TPnCE bit = 0. (The same value can be written when the TPnCE bit = 1.) If rewriting was mistakenly performed, clear the TPnCE bit to 0 and then set the bits again.	p.	221	
	Hard			The TPnIS3 to TPnIS0 bits are valid only in the free-running timer mode and the pulse width measurement mode. In all other modes, a capture operation is not possible.	p.	221	
	Soft		TPnIOC2: TMPn I/O control register 2	Rewrite the TPnEES1, TPnEES0, TPnETS1, and TPnETS0 bits when the TPnCTL0.TPnCE bit = 0. (The same value can be written when the TPnCE bit = 1.) If rewriting was mistakenly performed, clear the TPnCE bit to 0 and then set the bits again.	p.	222	
	Hard			The TPnEES1 and TPnEES0 bits are valid only when the TPnCTL1.TPnEEE bit = 1 or when the external event count mode (TPnCTL1.TPnMD2 to TPnCTL1.TPnMD0 bits = 001) has been set.	p.	222	
				The TPnETS1 and TPnETS0 bits are valid only when the external trigger pulse output mode (TPnCTL1.TPnMD2 to TPnCTL1.TPnMD0 bits = 010) or the one-shot pulse output mode (TPnCTL1.TPnMD2 to TPnCTL1.TPnMD0 = 011) is set.	p.	222	
	Soft		TPnOPT0: TMPn option register 0	Rewrite the TPnCCS1 and TPnCCS0 bits when the TPnCE bit = 0. (The same value can be written when the TPnCE bit = 1.) If rewriting was mistakenly performed, clear the TPnCE bit to 0 and then set the bits again.	p.	223	
1	1			Be sure to clear hits 1 to 3_6_and 7 to "0"	n	223	



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Chapter	Classification	Function	Details of Function	Cautions		Page	9	
Chapter 6	Soft	16-bit timer/event counter P (TMP)	TPnCCR0: TMPn capture/compare register 0	<ul> <li>Accessing the TPnCCR0 register is prohibited in the following statuses.</li> <li>When the CPU operates with the subclock and the main clock oscillation is stopped</li> <li>When the CPU operates with the internal oscillation clock</li> </ul>	p. 2	224		
			TPnCCR1: TMPn capture/compare register 1	<ul> <li>When the CPU operates with the internal oscillation clock</li> <li>When the CPU operates with the subclock and the main clock oscillation is stopped</li> <li>When the CPU operates with the internal oscillation clock</li> </ul>	p. 2	226		
			TPnCNT: TMPn counter read buffer register	<ul> <li>Accessing the TPnCNT register is prohibited in the following statuses.</li> <li>When the CPU operates with the subclock and the main clock oscillation is stopped</li> <li>When the CPU operates with the internal oscillation clock</li> </ul>	p. 2	228		
			TIPNF2 TIPNF2 input nc control	TIPNF0 to TIPNF2: TMPn input noise filter control registers	To use the noise filter, proceed as follows: <1> Enable the noise filter by setting TIPNFn. <2> Wait for 3 sampling clocks. <3> Enable the timer operation by setting TPnCTL0.	p. 2	237	
			0102	To stop the operation TMPn and noise filter, proceed as follows: <1> Disable the timer operation by setting TPnCTL0. <2> Disable the noise filter by setting TIPNFn.	p. 2	237		
					After the sampling clock has been changed, it takes 3 sampling clocks to initialize the digital noise rejection. If one of the external event counter mode, external trigger plus output mode, and capture trigger function is used, the operation of TMPn should be enabled after over 3 sampling clocks.	p. 2	237	
				Select the same sample clock as selected in TPnCKS2 to TPnCKS0.	p. 2	238		
			Timer Conjunction Function	In the external event counter mode, the pulse must not be input before the TMP operation enabled.	p. 2	239		
	Hard		Timer Synchronous	The timer synchronous operation mode is enabled or disabled by the TPnSYE bit of the TPnCTL1 register. For TMP0, TMP1 to TMP4 can be specified as slaves.	p. 2	240		
	Soft		Operation Function	Set the timer synchronous operation mode using the following procedure: <1> Set the TPnSYE bit of the TPnCTL1 register of the slave timer to enable the timer synchronous operation. Set the TPnMD2 to TPnMD0 bits of the TPnCTL1 register of the slave timer to the free-running mode.	p. 2	240		
				<ul> <li>&lt;2&gt; Set the timer mode by using the TPnMD2 to TPnMD0 bits of the TPnCTL1 register. At this time, do not set the TPnSYE bit of the TPnCTL1 register of the master timer.</li> <li>&lt;3&gt; Set the compare register value of the master and slave timers.</li> <li>&lt;4&gt; Set the TPnCE bit of the TPnCTL0 register of the slave timer to enable operation on the internal operating clock.</li> <li>&lt;5&gt; Set the TPnCE bit of the TPnCTL0 register of the master timer to enable operation on the internal operating clock.</li> </ul>				
		F T r	F - 1	Rewriting TPnCCR0 register	To change the value of the TPnCCR0 register to a smaller value, stop counting once and then change the set value. If the value of the TPnCCR0 register is rewritten to a smaller value during counting, the 16-bit counter may overflow.	p. 2	250	



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Chapter	Classification	Function	Details of Function	Cautions		Page	Э										
Chapter 6	Soft	16-bit timer/event counter P (TMP)	External event count mode	When an external clock is used as the count clock, the external clock can be input only from the TIOPn0 pin. At this time, set the TPnIOC1.TPnIS1 and TPnIOC1.TPnIS0 bits to 00 (capture trigger input (TIOPn0 pin): no edge detection).	p. 2	256											
				In the external event count mode, do not set the TPnCCR0 register to 0000H.	p. 2	258											
				In the external event count mode, use of the timer output is disabled. If performing timer output using external event count input, set the interval timer mode, and select the operation enabled by the external event count input for the count clock (TPnCTL1.TPnMD2 to TPnCTL1.TPnMD0 bits = 000, TPnCTL1.TPnEEE bit = 1).	p. 2	258											
			External trigger pulse output mode	To change the PWM waveform while the counter is operating, write the TPnCCR1 register last. Rewrite the TPnCCRm register after writing the TPnCCR1 register after the INTTPnCC0 signal is detected.	p. 2	268											
	Hard		One-shot pulse output mode	One-shot pulses are not output even in the one-shot pulse output mode, if the value set in the TPnCCR1 register is greater than that set in the TPnCCR0 register.	p. 2	277											
	Soft		Rewriting TPnCCRm register	To change the set value of the TPnCCRm register to a smaller value, stop counting once, and then change the set value. If the value of the TPnCCRm register is rewritten to a smaller value during counting, the 16-bit counter may overflow.	p. 2	279											
	Hard		Capture operation	When the capture operation is used and a slow clock is selected as the count clock, FFFFH, not 0000H, may be captured in the TPnCCR0 and TPnCCR1 registers if the capture trigger is input immediately after the TPnCE bit is set to 1.	р. З	314											
oter 7	Soft	8-bit timer/event counters 50, 51	CR5n: 8-bit timer compare	In the mode in which clear & start occurs on a match of TM5n and CR5n (TMC5n6 = 0), do not write other values to CR5n during operation.	p. 3	318											
Chal			Dunters register 5n D, 51	In PWM mode, make the CR5n rewrite period 3 count clocks of the count clock (clock selected by TCL5n) or more.	p. 3	318											
			TCL50: Timer	When rewriting TCL50 to other data, stop the timer operation beforehand.	р. З	319											
			clock selection register 50	Be sure to clear bits 3 to 7 to "0".	p. 3	319											
			TCL51: Timer	When rewriting TCL51 to other data, stop the timer operation beforehand.	р. З	320											
			clock selection register 51	Be sure to clear bits 3 to 7 to "0".	p. 3	320											
			TMC5n: 8-bit	The settings of LVS5n and LVR5n are valid in other than PWM mode.	р. 3	322											
													timer mode control register 5n	Perform <1> to <4> below in the following order, not at the same time.         <1> Set TMC5n1, TMC5n6:       Operation mode setting         <2> Set TOE5n to enable output:       Timer output enable         <3> Set LVS5n, LVR5n (see Caution 1):       Timer F/F setting         <4> Set TCE5n       Set TCE5n	p. 3	322	
				Stop operation before rewriting TMC5n6.	р. З	322											
ĺ			Interval timer	Do not write other values to CR5n during operation.	р. З	324											
			Square-wave output	Do not write other values to CR5n during operation.	p. 3	327											
			PWM output	In PWM mode, make the CR5n rewrite period 3 count clocks of the count clock (clock selected by TCL5n) or more.	p. 3	328											
				When reading from CR5n between <1> and <2> in Figure 7-14, the value read differs from the actual value (read value: M, actual value of CR5n: N).	р. 3	331											
			Timer start error	An error of up to one clock may occur in the time required for a match signal to be generated after timer start. This is because 8-bit timer counters 50 and 51 (TM50, TM51) are started asynchronously to the count clock.	р. З	332											



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Chapter	Classification	Function	Details of Function	Cautions		Page												
napter 8	Soft	Watch timer	WTM: Watch timer operation mode register	Do not change the count clock and interval time (by setting bits 4 to 7 (WTM4 to WTM7) of WTM) during watch timer operation.	p. 3	336												
Ċ	Hard		Interrupt request	When operation of the watch timer and 5-bit counter is enabled by the watch timer mode control register (WTM) (by setting bits 0 (WTM0) and 1 (WTM1) of WTM to 1), the interval until the first interrupt request signal (INTWT) is generated after the register is set does not exactly match the specification made with bits 2 and 3 (WTM2, WTM3) of WTM. Subsequently, however, the INTWT signal is generated at the specified intervals.	p. 3	339												
Chapter 9	Soft	Watchdog timer	WDTE: Watchdog timer enable register	If a value other than ACH is written to WDTE, an internal reset signal is generated. If the source clock to the watchdog timer is stopped, however, an internal reset signal is generated when the source clock to the watchdog timer resumes operation.	p. 3	342												
				If a 1-bit memory manipulation instruction is executed for WDTE, an internal reset signal is generated. If the source clock to the watchdog timer is stopped, however, an internal reset signal is generated when the source clock to the watchdog timer resumes operation.	p. 3	342												
				The value read from WDTE is 9AH/1AH (this differs from the written value (ACH)).	p. 3	342												
			Operation control	The first writing to WDTE after a reset release clears the watchdog timer, if it is made before the overflow time regardless of the timing of the writing, and the watchdog timer starts counting again.	p. 3	343												
				If the watchdog timer is cleared by writing "ACH" to WDTE, the actual overflow time may be different from the overflow time set by the option byte by up to 2/fosc seconds.	p. 3	343												
				The watchdog timer can be cleared immediately before the count value overflows (FFFFH).	р. З	343												
				The operation of the watchdog timer in the HALT and STOP modes differs as follows depending on the set value of bit 0 (LSROSC) of the option byte (see Table on p. 344). If LSROSC = 0, the watchdog timer resumes counting after the HALT or STOP mode is released. At this time, the counter is not cleared to 0 but starts counting from the value at which it was stopped. If oscillation of the internal low-speed oscillator is stopped by setting LSRSTOP (bit 1 of the internal oscillation mode register (RCM) = 1) when LSROSC = 0, the watchdog timer stops operating. At this time, the counter is not cleared to 0.	p. 3	344												
																	The watchdog timer continues its operation during self-programming and EEPROMTM emulation of the flash memory. During processing, the interrupt acknowledge time is delayed. Set the overflow time and window size taking this delay into consideration.	p. 3
			Setting overflow time of watchdog	The combination of WDCS2 = WDCS1 = WDCS0 = 0 and WINDOW1 = WINDOW0 = 0 is prohibited.	рр. 346	345, 3												
			timer, Setting window open period of watchdog time	The watchdog timer continues its operation during self-programming and EEPROM emulation of the flash memory. During processing, the interrupt acknowledge time is delayed. Set the overflow time and window size taking this delay into consideration.	рр. 346	345, 3												
				The first writing to WDTE after a reset release clears the watchdog timer, if it is made before the overflow time regardless of the timing of the writing, and the watchdog timer starts counting again.	p. 3	346												
10	oft	Clock	CKS: clock	Set CCS3 to CCS0 while the clock output operation is stopped (CLOE = 0).	р. З	350												
Chapter		output/ buzzer output controller	output select register	Set BCS1 and BCS0 when the buzzer output operation is stopped ( $\overrightarrow{\text{BZOE}} = 0$ ).	p. 3	350												



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Chapter	Classification	Function	Details of Function	Cautions		Pag	e
Chapter 11	Soft	A/D converter	ADCR: 10-bit A/D conversion register, ADCRH: 8-bit A/D conversion register	When data is read from ADCR and ADCRH, a wait cycle is generated. Do not read data from ADCR and ADCRH when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p.	355	
			ADM: A/D converter mode register	A/D conversion must be stopped before rewriting bits FR0 to FR2, LV1, and LV0 to values other than the identical data.	p.	357	
				If data is written to ADM, a wait cycle is generated. Do not write data to ADM when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p.	357	
			A/D conversion timer selection	<ul> <li>Set the conversion times with the following conditions.</li> <li>4.0 V ≤ AVREF ≤ 5.5 V: f<sub>AD</sub> = 0.6 to 3.6 MHz</li> <li>2.7 V ≤ AVREF &lt; 4.0 V: f<sub>AD</sub> = 0.6 to 1.8 MHz</li> </ul>	p.	358	
				When rewriting FR2 to FR0, LV1, and LV0 to other than the same data, stop A/D conversion once (ADCS = 0) beforehand.	p.	358	
				The above conversion time does not include clock frequency errors. Select conversion time, taking clock frequency errors into consideration.	p.	358	
			ADCR: 10-bit A/D conversion register	When writing to the A/D converter mode register (ADM), analog input channel specification register (ADS), and A/D port configuration register (ADPC), the contents of ADCR may become undefined. Read the conversion result following conversion completion before writing to ADM, ADS, and ADPC. Using timing other than the above may cause an incorrect conversion result to be read.	p.	359	
				If data is read from ADCR, a wait cycle is generated. Do not read data from ADCR when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p.	359	



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Chapter	Classification	Function	Details of Function	Cautions		Page	9													
Chapter 11	Soft	A/D converter	ADCRH: 8-bit A/D conversion register	When writing to the A/D converter mode register (ADM), analog input channel specification register (ADS), and A/D port configuration register (ADPC), the contents of ADCRH may become undefined. Read the conversion result following conversion completion before writing to ADM, ADS, and ADPC. Using timing other than the above may cause an incorrect conversion result to be read.	р.	360														
				If data is read from ADCRH, a wait cycle is generated. Do not read data from ADCRH when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p.	360														
			ADS: Analog	Be sure to clear bits 3 to 7 to 0.	p.	361														
			input channel specification register	Because ADS and ADPC do not control input and output, set the channel used for A/D conversion in the input mode by using port mode register 2 (PM2). If the channel is set in the output mode, selection of ADPC is disabled.	p.	361														
				Do not set a pin to be used as a digital input pin with ADPC with ADS.	p.	361														
				If data is written to ADS, a wait cycle is generated. Do not write data to ADS when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p.	361														
			ADPC: A/D port configuration	Set a channel to be used for A/D conversion in the input mode by using port mode register 2 (PM2).	p.	362														
			register (ADPC)	If data is written to ADPC, a wait cycle is generated. Do not write data to ADPC when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p.	362														
			Basic operations of A/D converter	Make sure the period of <1> to <5> is 1 $\mu$ s or more.	p.	364														
			A/D conversion operation	Make sure the period of <1> to <5> is 1 $\mu$ s or more.	p.	368														
				<1> may be done between <2> and <4>.	p.	368														
				<1> can be omitted. However, ignore data of the first conversion after <5> in this case.	p.	368														
				The period from <6> to <9> differs from the conversion time set using bits 5 to 1 (FR2 to FR0, LV1, LV0) of ADM. The period from <8> to <9> is the conversion time set using FR2 to FR0, LV1, and LV0.	p.	368														
						ř										Operating current in STOP mode	The A/D converter stops operating in the STOP mode. At this time, the operating current can be reduced by clearing bit 7 (ADCS) and bit 0 (ADCE) of the A/D converter mode register (ADM) to 0. To restart from the standby status, clear bit 0 (ADIF) of interrupt request flag register 1L (IF1L) to 0 and start operation.	p.	371	
	Hard		Input range of ANI0 to ANI7	Observe the rated range of the ANI0 to ANI7 input voltage. If a voltage of $AV_{REF}$ or higher and $AV_{SS}$ or lower (even in the range of absolute maximum ratings) is input to an analog input channel, the converted value of that channel becomes undefined. In addition, the converted values of the other channels may also be affected.	р.	371														
	Soft		Conflicting operations	If conflict occurs between A/D conversion result register (ADCR, ADCRH) write and ADCR or ADCRH read by instruction upon the end of conversion, ADCR or ADCRH read has priority. After the read operation, the new conversion result is written to ADCR or ADCRH.	p.	371														
							If conflict occurs between ADCR or ADCRH write and A/D converter mode register (ADM) write, analog input channel specification register (ADS), or A/D port configuration register (ADPC) write upon the end of conversion, ADM, ADS, or ADPC write has priority. ADCR or ADCRH write is not performed, nor is the conversion end interrupt signal (INTAD) generated.	p.	371											



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Chapter	Classification	Function	Details of Function	Cautions		Page	Ð
Chapter 11	Hard	A/D converter	Noise countermeasure s	<ul> <li>To maintain the 10-bit resolution, attention must be paid to noise input to the AV<sub>REF</sub> pin and pins ANI0 to ANI7.</li> <li>&lt;1&gt; Connect a capacitor with a low equivalent resistance and a good frequency response to the power supply.</li> <li>&lt;2&gt; The higher the output impedance of the analog input source, the greater the influence. To reduce the noise, connecting external C as shown in Figure 11-20 is recommended.</li> <li>&lt;3&gt; Do not switch these pins with other pins during conversion.</li> <li>&lt;4&gt; The accuracy is improved if the HALT mode is set immediately after the start of conversion.</li> </ul>	р. 3	371	
			ANI0/P20 to ANI7/P27	The analog input pins (ANI0 to ANI7) are also used as input port pins (P20 to P27). When A/D conversion is performed with any of ANI0 to ANI7 selected, do not access P20 to P27 while conversion is in progress; otherwise the conversion resolution may be degraded. It is recommended to select pins used as P20 to P27 starting with the ANI0/P20 that is the furthest from AV <sub>REF</sub> .	p. 3	372	
				If a digital pulse is applied to the pins adjacent to the pins currently used for A/D conversion, the expected value of the A/D conversion may not be obtained due to coupling noise. Therefore, do not apply a pulse to the pins adjacent to the pin undergoing A/D conversion.	p. 3	372	
			Input impedance of ANI0 to ANI7 pins	This A/D converter charges a sampling capacitor for sampling during sampling time. Therefore, only a leakage current flows when sampling is not in progress, and a current that charges the capacitor flows during sampling. Consequently, the input impedance fluctuates depending on whether sampling is in progress, and on the other states. To make sure that sampling is effective, however, it is recommended to keep the output impedance of the analog input source to within 10 k $\Omega$ , and to connect a capacitor of about 100 pF to the ANI0 to ANI7 pins (see Figure 11-20. Analog Input Pin Connection).	р. 3	372	
			AVREF pin input impedance	A series resistor string of several tens of k $\Omega$ is connected between the AV <sub>REF</sub> and AV <sub>ss</sub> pins. Therefore, if the output impedance of the reference voltage source is high, this will result in a series connection to the series resistor string between the AV <sub>REF</sub> and AV <sub>ss</sub> pins, resulting in a large reference voltage error.	p. 3	372	
	Soft		Interrupt request flag (ADIF)	The interrupt request flag (ADIF) is not cleared even if the analog input channel specification register (ADS) is changed. Therefore, if an analog input pin is changed during A/D conversion, the A/D conversion result and ADIF for the pre- change analog input may be set just before the ADS rewrite. Caution is therefore required since, at this time, when ADIF is read immediately after the ADS rewrite, ADIF is set despite the fact A/D conversion for the post-change analog input has not ended. When A/D conversion is stopped and then resumed, clear ADIF before the A/D conversion operation is resumed.	p. 3	373	
			Conversion results just after A/D conversion start	The first A/D conversion value immediately after A/D conversion starts may not fall within the rating range if the ADCS bit is set to 1 within 1 $\mu$ s after the ADCE bit was set to 1, or if the ADCS bit is set to 1 with the ADCE bit = 0. Take measures such as polling the A/D conversion end interrupt request (INTAD) and removing the first conversion result.	p. 3	373	
			A/D conversion result register (ADCR, ADCRH) read operation	When a write operation is performed to the A/D converter mode register (ADM), analog input channel specification register (ADS), and A/D port configuration register (ADPC), the contents of ADCR and ADCRH may become undefined. Read the conversion result following conversion completion before writing to ADM, ADS, and ADPC. Using a timing other than the above may cause an incorrect conversion result to be read.	p. 3	373	



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Chapter	Classification	Function	Details of Function	Cautions	P	age
12	oft	Serial	-	Serial interface UART61 is for 78K0/DF2 only.	p. 37	5
Chapter	S	interface UART60, UART61	UART mode	The TxD6n output inversion function inverts only the transmission side and not the reception side. To use this function, the reception side must be ready for reception of inverted data.	p. 37	5
				If clock supply to serial interface UART60 and UART61 is not stopped (e.g., in the HALT mode), normal operation continues. If clock supply to serial interface UART60 and UART61 is stopped (e.g., in the STOP mode), each register stops operating, and holds the value immediately before clock supply was stopped. The TxD6n pin also holds the value immediately before clock supply was stopped and outputs it. However, the operation is not guaranteed after clock supply is resumed. Therefore, reset the circuit so that POWER6n = 0, RXE6n = 0, and TXE6n = 0.	p. 37	5
					Set POWER6n = 1 and then set TXE6n = 1 (transmission) or RXE6n = 1 (reception) to start communication.	p. 37
				TXE6n and RXE6n are synchronized by the base clock (fxcLK6) set by CKSR6n. To enable transmission or reception again, set TXE6n or RXE6n to 1 at least two clocks of the base clock after TXE6n or RXE6n has been cleared to 0. If TXE6n or RXE6n is set within two clocks of the base clock, the transmission circuit or reception circuit may not be initialized.	p. 37	5 🗌
				Set transmit data to TXB6n at least one base clock (fxclk6) after setting TXE6n = 1.	p. 37	6
				If data is continuously transmitted, the communication timing from the stop bit to the next start bit is extended two operating clocks of the macro. However, this does not affect the result of communication because the reception side initializes the timing when it has detected a start bit. Do not use the continuous transmission function if the interface is used in LIN communication operation.	p. 37	6
			TXB6n: Transmit buffer register 6	Do not write data to TXB6n when bit 1 (TXBF6n) of asynchronous serial interface transmission status register 6n (ASIF6n) is 1.	p. 38	4
				Do not refresh (write the same value to) TXB6n by software during a communication operation (when bits 7 and 6 (POWER6n, TXE6n) of asynchronous serial interface operation mode register 6n (ASIM6n) are 1 or when bits 7 and 5 (POWER6n, RXE6n) of ASIM6n are 1).	p. 38	4
				Set transmit data to TXB6n at least one base clock (fxcLK6) after setting TXE6n = 1.	p. 38	4



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Chanter	Classification	Function	Details of Function	Cautions	Pag	e
0	i Ħ	Serial	ASIM60:	Be sure to set bit 0 to 1.	p. 387	
anter 1	Sol	interface UART60,	Asynchronous serial interface	To start the transmission, set POWER60 to 1 and then set TXE60 to 1. To stop the transmission, clear TXE60 to 0, and then clear POWER60 to 0.	p. 387	
Ċ	5	UARIOI	register 60	To start the reception, set POWER60 to 1 and then set RXE60 to 1. To stop the reception, clear RXE60 to 0, and then clear POWER60 to 0.	p. 387	
				Set POWER60 to 1 and then set RXE60 to 1 while a high level is input to the RxD60 pin. If POWER60 is set to 1 and RXE60 is set to 1 while a low level is input, reception is started.	p. 387	
				TXE60 and RXE60 are synchronized by the base clock (fxcLK6) set by CKSR60. To enable transmission or reception again, set TXE60 or RXE60 to 1 at least two clocks of the base clock after TXE60 or RXE60 has been cleared to 0. If TXE60 or RXE60 is set within two clocks of the base clock, the transmission circuit or reception circuit may not be initialized.	p. 387	
				Set transmit data to TXB60 at least one base clock ( $f_{XCLK6}$ ) after setting TXE60 = 1.	p. 387	
				Clear the TXE60 and RXE60 bits to 0 before rewriting the PS610, PS600, and CL60 bits.	p. 387	
				Fix the PS610 and PS600 bits to 0 when used in LIN communication operation.	p. 387	
				Clear TXE60 to 0 before rewriting the SL60 bit. Reception is always performed with "the number of stop bits = 1", and therefore, is not affected by the set value of the SL60 bit.	p. 387	
			ASIM61: Asynchronous serial interface operation mode register 61	Be sure to set bit 0 to 1.	p. 389	
				To start the transmission, set POWER61 to 1 and then set TXE61 to 1. To stop the transmission, clear TXE61 to 0, and then clear POWER61 to 0.	p. 389	
				To start the reception, set POWER61 to 1 and then set RXE61 to 1. To stop the reception, clear RXE61 to 0, and then clear POWER61 to 0.	p. 389	
				Set POWER61 to 1 and then set RXE61 to 1 while a high level is input to the RxD61 pin. If POWER61 is set to 1 and RXE61 is set to 1 while a low level is input, reception is started.	p. 389	
			TXE6 To en clocks or RX recep	TXE61 and RXE61 are synchronized by the base clock (fxcLk6) set by CKSR61. To enable transmission or reception again, set TXE61 or RXE61 to 1 at least two clocks of the base clock after TXE61 or RXE61 has been cleared to 0. If TXE61 or RXE61 is set within two clocks of the base clock, the transmission circuit or reception circuit may not be initialized.	p. 389	
				Set transmit data to TXB61 at least one base clock (fxcLK6) after setting TXE61 = 1.	p. 389	
				Clear the TXE61 and RXE61 bits to 0 before rewriting the PS611, PS601, and CL61 bits.	p. 389	
				Fix the PS611 and PS601 bits to 0 when used in LIN communication operation.	p. 389	
				Clear TXE61 to 0 before rewriting the SL61 bit. Reception is always performed with "the number of stop bits = 1", and therefore, is not affected by the set value of the SL61 bit.	p. 389	



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Chapter	Classification	Function	Details of Function	Cautions	Pa	je
apter 12	Soft	Serial interface UART60,	ASIS60: Asynchronous serial interface	The operation of the PE60 bit differs depending on the set values of the PS610 and PS600 bits of asynchronous serial interface operation mode register 60 (ASIM60).	p. 390	
Ö		UART61	reception error status register	For the stop bit of the receive data, only the first bit is checked regardless of the number of stop bits.	p. 390	
			60	If an overrun error occurs, the next receive data is not written to receive buffer register 6 (RXB60) but discarded.	p. 390	
				If data is read from ASIS60, a wait cycle is generated. Do not read data from ASIS60 when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p. 390	
			ASIS61: Asynchronous serial interface	The operation of the PE61 bit differs depending on the set values of the PS611 and PS601 bits of asynchronous serial interface operation mode register 61 (ASIM61).	p. 391	
			status register 61	For the stop bit of the receive data, only the first bit is checked regardless of the number of stop bits.	p. 391	
			01	If an overrun error occurs, the next receive data is not written to receive buffer register 6 (RXB61) but discarded.	p. 391	
			ASIF60: Asynchronous serial interface transmission status register 60 ASIF61: Asynchronous serial interface transmission status register	If data is read from ASIS61, a wait cycle is generated. Do not read data from ASIS61 when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p. 391	
				To transmit data continuously, write the first transmit data (first byte) to the TXB60 register. Be sure to check that the TXBF60 flag is "0". If so, write the next transmit data (second byte) to the TXB60 register. If data is written to the TXB60 register while the TXBF60 flag is "1", the transmit data cannot be guaranteed.	p. 392	
				To initialize the transmission unit upon completion of continuous transmission, be sure to check that the TXSF60 flag is "0" after generation of the transmission completion interrupt, and then execute initialization. If initialization is executed while the TXSF60 flag is "1", the transmit data cannot be guaranteed.	p. 392	
				To transmit data continuously, write the first transmit data (first byte) to the TXB61 register. Be sure to check that the TXBF61 flag is "0". If so, write the next transmit data (second byte) to the TXB61 register. If data is written to the TXB61 register while the TXBF61 flag is "1", the transmit data cannot be guaranteed.	p. 393	
			61	To initialize the transmission unit upon completion of continuous transmission, be sure to check that the TXSF61 flag is "0" after generation of the transmission completion interrupt, and then execute initialization. If initialization is executed while the TXSF61 flag is "1", the transmit data cannot be guaranteed.	p. 393	
			CKSR60: Clock selection register 60	Make sure POWER60 = 0 when rewriting TPS630 to TPS600.	p. 395	
			CKSR61: Clock selection register 61	Make sure POWER61 = 0 when rewriting TPS631 to TPS601.	p. 396	
			BRGC60: Baud rate generator	Make sure that bit 6 (TXE60) and bit 5 (RXE60) of the ASIM60 register = 0 when rewriting the MDL670 to MDL600 bits.	p. 3 <mark>9</mark> 7	
	Hard		control register 60	The baud rate is the output clock of the 8-bit counter divided by 2.	p. 397	
	Soft		BRGC61: Baud rate generator	Make sure that bit 6 (TXE61) and bit 5 (RXE61) of the ASIM61 register = 0 when rewriting the MDL671 to MDL601 bits.	p. 398	
	Hard		control register 61	The baud rate is the output clock of the 8-bit counter divided by 2.	p. 398	



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Chapter	Classification	Function	Details of Function	Cautions	Pag	e	
Chapter 12	Soft	Serial interface UART60, UART61	ASICL6n: Asynchronous serial interface control register 6n	ASICL6n can be refreshed (the same value is written) by software during a communication operation (when bits 7 and 6 (POWER6n, TXE6n) of ASIM6 = 1 or bits 7 and 5 (POWER6n, RXE6n) of ASIM6n = 1). However, do not set both SBRT6n and SBTT6n to 1 by a refresh operation during SBF reception (SBRT6n = 1) or SBF transmission (until INTST6n occurs since SBTT6n has been set (1)), because it may re-trigger SBF reception or SBF transmission.	p. 399		
			ASICL60: Asynchronous	In the case of an SBF reception error, the mode returns to the SBF reception mode. The status of the SBRF60 flag is held (1).	p. 400		
			serial interface control register 60	Before setting the SBRT60 bit, make sure that bit 7 (POWER60) and bit 5 (RXE60) of ASIM60 = 1. After setting the SBRT60 bit to 1, do not clear it to 0 before SBF reception is completed (before an interrupt request signal is generated).	p. 400		
				The read value of the SBRT60 bit is always 0. SBRT60 is automatically cleared to 0 after SBF reception has been correctly completed.	p. 400		
				Before setting the SBTT60 bit to 1, make sure that bit 7 (POWER60) and bit 6 (TXE60) of ASIM60 = 1. After setting the SBTT60 bit to 1, do not clear it to 0 before SBF transmission is completed (before an interrupt request signal is generated).	p. 400		
				The read value of the SBTT60 bit is always 0. SBTT60 is automatically cleared to 0 at the end of SBF transmission	p. 400		
				Do not set the SBRT60 bit to 1 during reception, and do not set the SBTT60 bit to 1 during transmission.	p. 400		
				Before rewriting the DIR60 and TXDLV60 bits, clear the TXE60 and RXE60 bits to 0.	p. 400		
				When the TXDLV60 bit is set to 1 (inverted TxD60 output), the TxD60/P13/SEG23/TIOP30 pin cannot be used as a general-purpose port, regardless of the settings of POWER60 and TXE60. When using the TxD60/P13/SEG23/TIOP30 pin as a general-purpose port, clear the TXDLV60 bit to 0 (normal TxD60 output).	p. 400		
			ASICL61: Asynchronous serial interface control register 61	In the case of an SBF reception error, the mode returns to the SBF reception mode. The status of the SBRF61 flag is held (1).	p. 402		
				Before setting the SBRT61 bit, make sure that bit 7 (POWER61) and bit 5 (RXE61) of ASIM61 = 1. After setting the SBRT61 bit to 1, do not clear it to 0 before SBF reception is completed (before an interrupt request signal is generated).	p. 402		
				The read value of the SBRT61 bit is always 0. SBRT61 is automatically cleared to 0 after SBF reception has been correctly completed.	p. 402		
				Before setting the SBTT61 bit to 1, make sure that bit 7 (POWER61) and bit 6 (TXE61) of ASIM61 = 1. After setting the SBTT61 bit to 1, do not clear it to 0 before SBF transmission is completed (before an interrupt request signal is generated).	p. 402		
				The read value of the SBTT61 bit is always 0. SBTT61 is automatically cleared to 0 at the end of SBF transmission	p. 402		
				Do not set the SBRT61 bit to 1 during reception, and do not set the SBTT61 bit to 1 during transmission.	p. 402		
				Before rewriting the DIR61 and TXDLV61 bits, clear the TXE61 and RXE61 bits to 0.	p. 402		
				When the TXDLV61 bit is set to 1 (inverted TxD61 output), the TxD61/SCK10/P10/INTP4 pin cannot be used as a general-purpose port, regardless of the settings of POWER61 and TXE61. When using the TxD61/SCK10/P10/INTP4 pin as a general-purpose port, clear the TXDLV61 bit to 0 (normal TxD61 output).	p. 402		
				POWER6n, TXE6n, RXE6n: Bits 7, 6, 5 of	Clear POWER6n to 0 after clearing TXE6n and RXE6n to 0 to stop the operation. To start the communication, set POWER6n to 1, and then set TXE6n or RXE6n to 1.	p. 406	

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Chantar	Classification	Function	Details of Function	Cautions	Pag	le	
or 10	Soft	Serial interface	UART mode	Take relationship with the other party of communication when setting the port mode register and port register.	p. 407		
Chant		UART60, UART61	Parity types and operation	Fix the PS61n and PS60n bits to 0 when the device is used in LIN communication operation.	p. 411		
			Continuous transmission	The TXBF6n and TXSF6n flags of the ASIF6n register change from "10" to "11", and to "01" during continuous transmission. To check the status, therefore, do not use a combination of the TXBF6n and TXSF6n flags for judgment. Read only the TXBF6n flag when executing continuous transmission.	p. 413		
					When the device is use in LIN communication operation, the continuous transmission function cannot be used. Make sure that asynchronous serial interface transmission status register 6 (ASIF6n) is 00H before writing transmit data to transmit buffer register 6 (TXB6n).	p. 413	
				To transmit data continuously, write the first transmit data (first byte) to the TXB6n register. Be sure to check that the TXBF6n flag is "0". If so, write the next transmit data (second byte) to the TXB6n register. If data is written to the TXB6n register while the TXBF6n flag is "1", the transmit data cannot be guaranteed.	p. 413		
				To initialize the transmission unit upon completion of continuous transmission, be sure to check that the TXSF6n flag is "0" after generation of the transmission completion interrupt, and then execute initialization. If initialization is executed while the TXSF6n flag is "1", the transmit data cannot be guaranteed.	p. 413		
				During continuous transmission, the next transmission may complete before execution of INTST6n interrupt servicing after transmission of one data frame. As a countermeasure, detection can be performed by developing a program that can count the number of transmit data and by referencing the TXSF6n flag.	p. 413		
			Normal reception	If a reception error occurs, read ASIS6n and then RXB6n to clear the error flag. Otherwise, an overrun error will occur when the next data is received, and the reception error status will persist.	p. 417		
				Reception is always performed with the "number of stop bits = 1". The second stop bit is ignored.	p. 417		
				Be sure to read asynchronous serial interface reception error status register 6n (ASIS6n) before reading RXB6n.	p. 417		
			Error of baud rate	Keep the baud rate error during transmission to within the permissible error range at the reception destination.	p. 423		
				Make sure that the baud rate error during reception satisfies the range shown in (4) Permissible baud rate range during reception.	p. 42 <mark>3</mark>		
			Permissible baud rate range during reception	Make sure that the baud rate error during reception is within the permissible error range, by using the calculation expression shown below.	p. 425		



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Chapter	Classification	Function	Details of Function	Cautions		Pag	e	
13	oft	Serial	-	Serial interface CSI11 is for 78K0/DF2 only.	p.	428		
ter	S	interface	SOTB1n:	Do not access SOTB1n when CSOT1n = 1 (during serial communication).	p.	431		
Chap		CSI11	Transmit buffer register 1n	In the slave mode, transmission/rece <u>ption</u> is started when data is written to SOTB11 with a low level input to the SSI11 pin. For details on the transmission/reception operation, see 13.4.2 (2) Communication operation.	p.	431		
			SIO1n: Serial I/O	Do not access SIO1n when CSOT1n = 1 (during serial communication).	p.	433		
				shift register 1n	In the slave mode, reception is started when data is read from SIO11 with a low level input to the SSI11 pin. For details of the reception operation, see 13.4.2 (2) Communication operation.	p.	433	
			CSIM10: Serial operation mode register 10	Be sure to clear bit 5 to 0.	p.	433		
			CSIC10: Serial	Do not write to CSIC10 while CSIE10 = 1 (operation enabled).	p.	436		
			clock selection register 10	To use P10/SCK10/INTP4/TXD61 and P12/SO10/INTP2 as general-purpose ports, set CSIC10 in the default status (00H). (The TxD61 function is for 78K0/DF2 only.)	p.	436		
				The phase type of the data clock is type 1 after reset.	p.	436		
			CSIC11: Serial	Do not write to CSIC11 while CSIE11 = 1 (operation enabled).	p.	438		
				clock selection register 11	To use P74/SCK11/SEG24 and P76/SO11/SEG26 as general-purpose ports, set CSIC11 in the default status (00H). (The SEG24 and SEG26 functions are for $\mu$ PD78F0842, 78F0843, 78F0848, and 78F0849 only.)	p.	438	
				The phase type of the data clock is type 1 after reset.	p.	438		
			3-wire serial I/O mode	Take relationship with the other party of communication when setting the port mode register and port register.	p.	442		
			Communication operation	Do not access the control register and data register when CSOT1n = 1 (during serial communication).	p.	445		
				When using serial interface CSI11, wait for the duration of at least one clock before the clock operation is started to change the level of the SSI11 pin in the slave mode; otherwise, malfunctioning may occur.	p.	445		
			SO1n output	If a value is written to CSIE1n, TRMD1n, DAP1n, and DIR1n, the output value of SO1n changes.	p.	453		



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Chapter	Classification	Function	Details of Function	Cautions		Page	)						
apter 14	Soft	Serial interface IIC0	_	Do not use serial interface IIC0 and the multiplier/divider simultaneously, because various flags corresponding to interrupt request sources are shared among serial interface IIC0 and the multiplier/divider.	p. /	454							
Ŝ			IIC0: IIC shift	Do not write data to IIC0 during data transfer.	p. 4	457							
			register 0	Write or read IIC0 only during the wait period. Accessing IIC0 in a communication state other than during the wait period is prohibited. When the device serves as the master, however, IIC0 can be written only once after the communication trigger bit (STT0) is set to 1.	p	457							
			IICC0: IIC control register 0	The start condition is detected immediately after $I^2C$ is enabled to operate (IICE0 = 1) while the SCL0 line is at high level and the SDA0 line is at low level. Immediately after enabling $I^2C$ to operate (IICE0 = 1), set LREL0 (1) by using a 1-bit memory manipulation instruction.	p. /	461							
										When bit 3 (TRC0) of IIC status register 0 (IICS0) is set to 1, WREL0 is set to 1 during the ninth clock and wait is canceled, after which TRC0 is cleared and the SDA0 line is set to high impedance.	p	464	
			IICS0: IIC status register 0	If data is read from IICS0, a wait cycle is generated. Do not read data from IICS0 when the peripheral hardware clock (fPRs) is stopped. For details, see CHAPTER 33 CAUTIONS FOR WAIT.	p	465							
			IICF0: IIC flag	Write to STCEN only when the operation is stopped (IICE0 = 0).	р	469							
				register 0	As the bus release status (IICBSY = 0) is recognized regardless of the actual bus status when $STCEN = 1$ , when generating the first start condition ( $STT0 = 1$ ), it is necessary to verify that no third party communications are in progress in order to prevent such communications from being destroyed.	p. •	469						
				Write to IICRSV only when the operation is stopped (IICE0 = $0$ ).	р. 4	469							
			Selection clock setting	Determine the transfer clock frequency of $I^2C$ by using CLX0, SMC0, CL01, and CL00 before enabling the operation (by setting bit 7 (IICE0) of IIC control register 0 (IICC0) to 1). To change the transfer clock frequency, clear IICE0 once to 0.	p. /	473							
			When STCEN = 0	Immediately after I <sup>2</sup> C operation is enabled (IICE0 = 1), the bus communication status (IICBSY (bit 6 of IICF0) = 1) is recognized regardless of the actual bus status. When changing from a mode in which no stop condition has been detected to a master device communication mode, first generate a stop condition to release the bus, then perform master device communication. When using multiple masters, it is not possible to perform master device communication when the bus has not been released (when a stop condition has not been detected). Use the following sequence for generating a stop condition. <1> Set IIC clock selection register 0 (IICCL0). <2> Set bit 7 (IICE0) of IIC control register 0 (IICC0) to 1. <3> Set bit 0 (SPT0) of IICC0 to 1.	p. ·	491							
								N S	When STCEN = 1	Immediately after $l^2C$ operation is enabled (IICE0 = 1), the bus released status (IICBSY = 0) is recognized regardless of the actual bus status. To generate the first start condition (STT0 (bit 1 of IIC control register 0 (IICC0)) = 1), it is necessary to confirm that the bus has been released, so as to not disturb other communications.	p. /	491	



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Chapter	Classification	Function	Details of Function	Cautions	Pag	e
Chapter 14	Soft	Serial interface IIC0	If other I <sup>2</sup> C communications are already in progress	If I <sup>2</sup> C operation is enabled and the device participates in communication already in progress when the SDA0 pin is low and the SCL0 pin is high, the macro of I <sup>2</sup> C recognizes that the SDA0 pin has gone low (detects a start condition). If the value on the bus at this time can be recognized as an extension code, ACK is returned, but this interferes with other I <sup>2</sup> C communications. To avoid this, start I <sup>2</sup> C in the following sequence. <1> Clear bit 4 (SPIE0) of IICC0 to 0 to disable generation of an interrupt request signal (INTIIC0) when the stop condition is detected. <2> Set bit 7 (IICE0) of IICC0 to 1 to enable the operation of I <sup>2</sup> C. <3> Wait for detection of the start condition. <4> Set bit 6 (LREL0) of IICC0 to 1 before ACK is returned (4 to 80 clocks after setting IICE0 to 1), to forcibly disable detection.	p. 491	
			Transfer clock frequency setting	Determine the transfer clock frequency by using SMC0, CL01, CL00 (bits 3, 1, and 0 of IICL0), and CLX0 (bit 0 of IICX0) before enabling the operation (IICE0 = 1). To change the transfer clock frequency, clear IICE0 to 0 once.	p. 491	
			STT0, SPT0: Bits 1, 0 of IIC control register 0 (IICC0)	Setting STT0 and SPT0 (bits 1 and 0 of IICC0) again after they are set and before they are cleared to 0 is prohibited.	p. 492	
			Transmission reserve	When transmission is reserved, set SPIE0 (bit 4 of IICL0) to 1 so that an interrupt request is generated when the stop condition is detected. Transfer is started when communication data is written to IIC0 after the interrupt request is generated. Unless the interrupt is generated when the stop condition is detected, the device stops in the wait state because the interrupt request is not generated when communication is started. However, it is not necessary to set SPIE0 to 1 when MSTS0 (bit 7 of IICS0) is detected by software.	p. 492	



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Chapter	Classification	Function	Details of Function	Cautions		Page							
er 15	Soft	CAN controller	_	To use the CAN controller, set P70 to 1.	p. 5	529							
apte	ard		Description of	ID28 to ID18 are identifiers.	p. 5	534							
Ϋ́	Н		fields	An identifier is transmitted MSB first.	p. 5	534							
				In the remote frame, there is no data field even if the data length code is not 0000B.	p. 5	535							
			Priority of data frame and remote frame	If the extended-format data frame and the standard-format remote frame conflict on the bus (if ID28 to ID18 of both of them are the same), the standard-format remote frames takes priority.	p. 5	542							
						Occurrence of bit error in intermission	If an error occurs, the error flag output (active or passive) is controlled according to the contents of the transmission error counter and reception error counter before the error occurred. The value of the error counter is incremented after the error flag has been output.	p. 5	546				
			Recovery operation from bus-off state through normal recovery sequence	If the Bus-off Recovery Sequence is interrupted by entering Initialization Mode and re-entering any Operation Mode, the Bus-off Recovery Sequence will restart from the beginning, and the waiting phase will be again 128 times 11 recessive- level bits, counted from this point.	p. 5	547							
				In the bus-off recovery sequence, REC [6:0] counts up (+1) each time 11 consecutive recessive-level bits have been detected. Even during the bus-off period, the CAN module can enter the CAN sleep mode or CAN stop mode. To start the bus-off recovery sequence, it is necessary to transit to the initialization mode once. However, when the CAN module is in either CAN sleep mode or CAN stop mode, transition request to the initialization mode is not accepted, thus you have to release the CAN sleep mode first. In this case, as soon as the CAN sleep mode is released, the bus-off recovery sequence starts and no transition to initialization mode is necessary. If the CAN module detects a dominant edge on the CAN bus while in sleep mode even during bus-off, the sleep mode will be left and the bus-off recovery sequence will start (in the state that the CAN clock is supplied, it is necessary to clear the PSMODE by software after dominant edge detection).	p. 5	547							
			Forced recovery operation that skips bus-off recovery sequence	This function is not defined by the CAN protocol ISO 11898. When using this function, thoroughly evaluate its effect on the network system.	p. 5	548							
			sequence Initializing CAN module error counter register	This function is enabled only in the initialization mode. Even if the CCERC bit is set to 1 in a CAN operation mode, the C0ERC and C0INFO registers are not initialized.	p. 5	548							
			(C0ERC) in initialization mode	The CCERC bit can be set at the same time as the request to enter a CAN operation mode.	p. 5	548							
									Register bit configuration	The actual register address is calculated as follows: Register Address = Global Register Area Offset (CH dependent) + Offset Address as listed in the table above	pp. to 5	564 567	



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Chantar	Classification	Function	Details of Function	Cautions		Pag	e
Chantar 15	Hard	CAN controller	COGMCTRL: CAN global control register	While the MBON bit is cleared (to 0), software access to the message buffers (C0MDATA0m, C0MDATA1m, C0MDATA01m, C0MDATA2m, C0MDATA3m, C0MDATA23m, C0MDATA4m, C0MDATA5m, C0MDATA45m, C0MDATA6m, C0MDATA7m, C0MDATA67m, C0MDLCm, C0MCONFm, C0MIDLm, C0MIDHm, and C0MCTRLm), or registers related to transmit history or receive history (C0LOPT, C0TGPT, C0LIPT, and C0RGPT) is disabled.	p.	570	
				This bit is read-only. Even if 1 is written to MBON while it is 0, the value of MBON does not change, and access to the message buffer registers, or registers related to transmit history or receive history remains disabled.	p.	570	
				To request forced shutdown, the GOM bit must be cleared to 0 in a subsequent, immediately following write access after the EFSD bit has been set to 1. If access to another register (including reading the COGMCTRL register) is executed without clearing the GOM bit immediately after the EFSD bit has been set to 1, the EFSD bit is forcibly cleared to 0, and the forced shutdown request is invalid.	p.	571	
		_		The GOM bit can be cleared only in the initialization mode or immediately after EFSD bit is set (to 1).	p.	571	
	Soft			Set GOM bit and ESFD bit always separately.	p.	571	
			COGMABT: CAN global automatic block transmission	Before changing the normal operation mode with ABT to the initialization mode, be sure to set the COGMABT register to the default value (0000H) and confirm the COGMABT register is surely initialized to the default value (0000H).	p.	573	
			transmission control register	Do not set the ABTTRG bit (ABTTRG = 1) in the initialization mode. If the ABTTRG bit is set in the initialization mode, the operation is not guaranteed after the CAN module has entered the normal operation mode with ABT. Do not set the ABTTRG bit (1) while the COCTRL.TSTAT bit is set (1). Confirm TSTAT = 0 directly in advance before setting ABTTRG bit.	p.	573	
	Hard			While receiving a message from another node or transmitting the messages other than the ABT messages (message buffer 8 to 15), there is a possibility not to begin immediately the transmission even if the ABTTRG bit is set to 1. Transmission is not aborted even if the ABTTRG bit is cleared to 0, until the transmission of the ABT message, which is currently being transmitted is completed (successfully or not). After that, the transmission is aborted.	p.	574	
	Soft		C0GMABTD: CAN global	Do not change the contents of the C0GMABTD register while the ABTTRG bit is set to 1.	p.	575	
	Hard		automatic block transmission delay setting register	The timing at which the ABT message is actually transmitted onto the CAN bus differs depending on the status of transmission from the other station or how a request to transmit a message other than an ABT message (message buffers 8 to 15) is made.	p.	575	
	Soft		C0CTRL: CAN module control	Transition to and from the CAN stop mode must be made via CAN sleep mode. A request for direct transition to and from the CAN stop mode is ignored.	p.	580	
			register	The MBON flag of C0GMCTRL must be checked after releasing a power save mode, prior to access the message buffers again.	p.	580	
	Hard			CAN Sleep mode requests are kept pending, until cancelled by software or entered on appropriate bus condition (bus idle). Software can check the actual status by reading PSMODE.	p.	580	
	Soft			Transit to initialization mode or power saving modes may take some time. Be sure to verify the success of mode change by reading the values, before proceeding.	p.	580	
			COINTS: CAN module interrupt status register	Please clear the status bit of this register with software when the confirmation of each status is necessary in the interrupt processing, because these bits are not cleared automatically.	p.	587	



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Chapter	Classification	Function	Details of Function	Cautions	F	Page	) )
Chapter 15	Hard	CAN controller	C0BRP: CAN module bit rate prescaler register	The C0BRP register can be write-accessed only in the initialization mode.	p. 58	38	
-	Soft		COMDLCm: CAN message	Be sure to set bits 7 to 4 0000B.	p. 59	99	
	Hard	-	data length register m	Receive data is stored in as many COMDATAxm as the number of bytes (however, the upper limit is 8) corresponding to DLC of the received frame. COMDATAxm in which no data is stored is undefined.	p. 59	99	
	Soft		COMCONFm: CAN message configuration register	Be sure to write 0 to bits 2 and 1.	p. 60	01	
			C0MIDLm,	Be sure to write 0 to bits 14 and 13 of the C0MIDHm register.	p. 60	01	
			C0MIDHm: CAN message id register m	Be sure to align the ID value according to the given bit positions into this registers. Note that for standard ID, the ID value must be shifted to fit into ID28 to ID11 bit positions.	p. 60	01	
			C0MCTRLm: CAN message	Do not set the TRQ bit and the RDY bit (1) at the same time. Set the RDY bit (1) before setting the TRQ bit.	p. 60	03	
			m	Do not clear the RDY bit (0) during message transmission. Follow the transmission abort process about clearing the RDY bit (0) for redefinition of the message buffer.	p. 60	03	
				Clear again when RDY bit is not cleared even if this bit is cleared.	p. 60	03	
				Be sure that RDY is cleared before writing to the message buffer registers. Perform this confirmation by reading back the RDY bit. However, setting the TRQ bit, clearing the DN bit, setting the RDY bit or clearing the MOW bit of the C0MCTRLm register need not be confirmed.	p. 60	03	
				Set IE bit and RDY bit always separately.	p. 60	03	
				Do not set the DN bit to 1 by software. Be sure to write 0 to bit 10.	p. 60	03	
	Hard			While receiving a message from another node or transmitting the messages, there is a possibility of not to begin immediately the transmission even if the TRQ bit is set to 1. The transmission is not aborted even if the TRQ bit is cleared to 0. The transmission is continued if a message is currently being transmitted and until the transmission is completed (successfully or not).	p. 60	04	
	Soft			Set IE bit and RDY bit always separately.	p. 60	04	
	Hard		To redefine message buffer during transmission	When a message is received, reception filtering is performed in accordance with the ID and mask set to each receive message buffer. If the procedure in Figure 15-40. Message Buffer Redefinition is not observed, the contents of the message buffer after it has been redefined may contradict the result of reception (result of reception filtering). If this happens, check that the ID and IDE received first and stored in the message buffer following redefinition are those stored after the message buffer has been redefined. If no ID and IDE are stored after redefinition, redefine the message buffer again.	p. 60	06	
				When a message is transmitted, the transmission priority is checked in accordance with the ID, IDE, and RTR bits set to each transmit message buffer to which a transmission request was set. The transmit message buffer having the highest priority is selected for transmission. If the procedure in Figure 15-41. Message Buffer Redefinition during Transmission is not observed, a message with an ID not having the highest priority may be transmitted after redefinition.	p. 60	06	



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Chapter	Classification	Function	Details of Function	Cautions		Page	9
Chapter 15	Hard	CAN controller	Receive history list function	If the history list is in the overflow condition (ROVF is set), reading the history list contents is still possible, until the history list is empty (indicated by RHPM flag set). Nevertheless, the history list remains in the overflow condition, until ROVF is cleared by software. If ROVF is not cleared, the RHPM flag will also not be updated (cleared) upon a message storage of newly received frame. This may lead to the situation, that RHPM indicates an empty history list, although a reception has taken place, while the history list is in the overflow state (ROVF and RHPM are set).	p. 6	510	
			Multi buffer receive block function	MBRB can be configured for each of the same message buffer types. Therefore, even if a message buffer of another MBRB whose ID matches but whose message buffer type is different has a vacancy, the received message is not stored in that message buffer, but instead discarded.	p. 6	614	
				MBRB does not have a ring buffer structure. Therefore, after a message is stored in the message buffer having the highest number in the MBRB configuration, a newly received message will not be stored in the message buffer having the lowest message buffer number.	p. 6	614	
				MBRB operates based on the reception and storage conditions; there are no settings dedicated to MBRB, such as function enable bits. By setting the same message buffer type and ID to two or more message buffers, MBRB is automatically configured.	p. 6	614	
				With MBRB, "matching ID" means "matching ID after mask". Even if the ID set to each message buffer is not the same, if the ID that is masked by the mask register matches, it is considered a matching ID and the buffer that has this ID is treated as the storage destination of a message.	p. 6	514	
				The priority between MBRBs is mentioned in 15.9.1 Message reception.	p. 6	614	
			Remote frame reception	When a message buffer is searched for receiving and storing a remote frame, overwrite control by the OWS bit of the COMCONFm register of the message buffer and the DN bit of the COMCTRLm register are not affected. The setting of OWS is ignored, and DN is set in any case. If more than one transmit message buffer has the same ID and the ID of the received remote frame matches that ID, the remote frame is stored in the transmit message buffer with the lowest message buffer number.	p. 6	515	
			Transmit history list function	If the history list is in the overflow condition (TOVF is set), reading the history list contents is still possible, until the history list is empty (indicated by THPM flag set). Nevertheless, the history list remains in the overflow condition, until TOVF is cleared by software. If TOVF is not cleared, the THPM flag will also not be updated (cleared) upon successful transmission of a new message. This may lead to the situation, that THPM indicates an empty history list, although a successful transmission has taken place, while the history list is in the overflow state (TOVF and THPM are set).	p. 6	518	



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Chapter	Classification	Function	Details of Function	Cautions		Page	e
apter 15	Soft	CAN controller	Automatic block transmission (ABT)	Set the ABTCLR bit to 1 while the ABTTRG bit is cleared to 0 in order to resume ABT operation at buffer No.0. If the ABTCLR bit is set to 1 while the ABTTRG bit is set to 1, the subsequent operation is not guaranteed.	p.	621	
Ch				If the automatic block transmission engine is cleared by setting the ABTCLR bit to 1, the ABTCLR bit is automatically cleared immediately after the processing of the clearing request is completed.	p.	621	
				Do not set the ABTTRG bit in the initialization mode. If the ABTTRG bit is set in the initialization mode, the proper operation is not guaranteed after the mode is changed from the initialization mode to the ABT mode.	p.	621	
				Do not set TRQ bit of the ABT message buffers to 1 by software in the normal operation mode with ABT. Otherwise, the operation is not guaranteed.	p.	621	
	Hard			The COGMABTD register is used to set the delay time that is inserted in the period from completion of the preceding ABT message to setting of the TRQ bit for the next ABT message when the transmission requests are set in the order of message numbers for each message for ABT that is successively transmitted in the ABT mode. The timing at which the messages are actually transmitted onto the CAN bus varies depending on the status of transmission from other stations and the status of the setting of the transmission request for messages other than the ABT messages (message buffer 8 to 15).	p.	621	
			If a transmiss if no delay tim are automatic may be trans	If a transmission request is made for a message other than an ABT message and if no delay time is inserted in the interval in which transmission requests for ABT are automatically set (C0GMABTD = 00H), messages other than ABT messages may be transmitted not depending on the priority of the ABT message.	p.	621	
	Soft			Do not clear the RDY bit to 0 when ABTTRG = 1.	p.	621	
				If a message is received from another node while normal operation mode with ABT is active, the TX-message from the ABT-area may be transmitted with delay of one frame although COGMABTD register was set up with 00H.	p.	621	
			Transmission abort process	Be sure to abort ABT by clearing ABTTRG to 0. The operation is not guaranteed if aborting transmission is requested by clearing RDY bit.	p.	622	
	Hard		CAN sleep mode	Even if the falling edge belongs to the SOF of a receive message, this message will not be received and stored. If the CPU has turned off the clock to the CAN while the CAN was in sleep mode, even subsequently the CAN sleep mode will not be released and PSMODE [1:0] will continue to be 01B unless the clock to the CAN is supplied again. In addition to this, the receive message will not be received after that.	p.	624	
	Soft			If the falling edge on the CAN reception pin (CRxD) is detected in the state that the CAN clock is supplied, it is necessary to clear the PSMODE0 bit by software (for details, refer to the processing in Figure 15-54. Setting CAN Sleep Mode/Stop Mode).	p.	624	
	Hard			Be aware that the release of CAN sleep mode by CAN bus event, and thus the wake up interrupt may happen at any time, even right after requesting sleep mode, if a CAN bus event occurs.	p.	624	
	Soft		CAN stop mode	To set the CAN module to the CAN stop mode, the module must be in the CAN sleep mode. To confirm that the module is in the sleep mode, check that PSMODE [1:0] = 01B, and then request the CAN stop mode. If a bus change occurs at the CAN reception pin (CRxD) while this process is being performed, the CAN sleep mode is automatically released. In this case, the CAN stop mode transition request cannot be acknowledged (However, in the state that the CAN clock is supplied, it is necessary to clear the PSMODE0 bit by software after a bus change occurs at the CAN reception pin (CRxD)).	p.	625	



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	Chapter	Classification	Function	Details of Function	Cautions	Page	*
	Chapter 15	Hard	CAN controller	Receive-only mode	If only two CAN nodes are connected to the CAN bus and one of them is operating in the receive-only mode, there is no ACK on the CAN bus. Due to the missing ACK, the transmitting node will transmit an active error flag, and repeat transmitting a message frame. The transmitting node becomes error passive after transmitting the message frame 16 times (assuming that the error counter was 0 in the beginning and no other errors have occurred). After the message frame for the 17th time is transmitted, the transmitting node generates a passive error flag. The receiving node in the receive-only mode detects the first valid message frame at this point, and the VALID bit is set to 1 for the first time.	p. 629	
				Single-shot mode	The AL bit is only valid in Single-shot mode. It does not influence the operation of re-transmission upon arbitration loss in the other operation modes.	p. 629	
				Time stamp function	The time stamp function using TSLOCK bit is to stop toggle of TSOUT bit by receiving a data frame in message buffer 0. Therefore, message buffer 0 must be set as a receive message buffer. Since a receive message buffer cannot receive a remote frame, toggle of TSOUT bit cannot be stopped by reception of a remote frame. Toggle of TSOUT bit does not stop when a data frame is received in a message buffer other than message buffer 0. For these reasons, a data frame cannot be received in message buffer 0 when the CAN module is in the normal operation mode with ABT, because message buffer 0 must be set as a transmit message buffer. In this operation mode, therefore, the function to stop toggle of TSOUT bit by TSLOCK bit cannot be used.	p. 633	
			-	Baud rate settings	The values in Table 15-22 (Table 15-23/Table 15-24) do not guarantee the operation of the network system. Thoroughly check the effect on the network system, taking into consideration oscillation errors and delays of the CAN bus and CAN transceiver.	pp. 637 to 641	
		Soft		Re-initialization	After setting the CAN module to the initialization mode, avoid setting the module to another operation mode immediately after. If it is necessary to immediately set the module to another operation mode, be sure to access registers other than the C0CTRL and C0GMCTRL registers (e.g. set a message buffer).	p. 643	
				Message Buffer	Before a message buffer is initialized, the RDY bit must be cleared.	p. 644	
				Initialization	Make the following settings for message buffers not used by the application. - Clear the RDY, TRQ, and DN bits of the C0MCTRLm register to 0. - Clear the MA0 bit of the C0MCONFm register to 0.	р. 644	
				Message Transmit Processing,	The TRQ bit should be set after the RDY bit is set.	pp. 647, 649 to 651	
				Transmission via Interrupt (Using COLOPT register), Transmit via Interrupt (Using COTGPT register), Transmission via Software Polling	The RDY bit and TRQ bit should not be set at the same time.	pp. 647, 649 to 651	
				ABT Message Transmit Processing	The ABTTRG bit should be set to 1 after the TSTAT bit is cleared to 0. Checking the TSTAT bit and setting the ABTTRG bit to 1 must be processed continuously.	p. 648	



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	Classification	Function	Details of Function	Cautions	Page	
1	Soft	CAN controller	Transmission Abort	Execute transmission request abort processing by clearing the TRQ bit, not the RDY bit.	pp. 652, 653	
1000	Cilapi		Processing (Except Normal	Before making a sleep mode transition request, confirm that there is no transmission request left using this processing.	pp. 652, 653	
			with ABT), Transmission	The TSTAT bit can be periodically checked by a user application or can be checked after the transmit completion interrupt.	pp. 652, 653	
			Abort Processing	Do not execute the new transmission request including in the other message buffers while transmission abort processing is in progress.	pp. 652, 653	
	Hard		Except for ABT Transmission (Normal Operation Mode with ABT)	There is a possibility that contradiction is caused in the judgment whether the transmission abort request was successful when the transmission from the same message buffer is consecutive or only one message buffer is used. In that case, judge it by using the history information etc. that the COTGPT register indicates.	pp. 652, 654	
	Soft		ABT Transmission	Do not set any transmission requests while ABT transmission abort processing is in progress.	pp. 655, 656	
			Abort Processing (Normal Operation Mode with ABT), ABT Transmission Request Abort Processing (Normal Operation Mode with ABT)	Make a CAN sleep mode/CAN stop mode transition request after ABTTRG bit is cleared (after ABT mode is aborted) following the procedure shown in Figure 15-49 or 15-50. When clearing a transmission request in an area other than the ABT area, follow the procedure shown in Figure 15-47. Transmission Abort Processing (Except Normal Operation Mode with ABT).	pp. 655, 656	
			Setting CAN Sleep Mode/Stop Mode	To abort transmission before making a request for the CAN sleep mode, perform processing according to Figures 15-47 to 15-50.	p. 660	
			Bus-Off Recovery (Expect Normal Operation Mode with ABT)	When the transmission from the initialization mode to any operation modes is requested to execute bus-off recovery sequence again in the bus-off recovery sequence, reception error counter is cleared. Therefore it is necessary to detect 11 consecutive recessive-level bits 128 times on the bus again.	pp. 662, 663	
			Forced Shutdown Process	Do not read- or write-access any registers by software between setting the EFSD bit and clearing the GOM bit.	p. 665	
			Setting CPU Standby (from CAN Sleep Mode)	Before the CPU is set in the CPU standby mode, please check the CAN sleep mode or not. However, after check of the CAN sleep mode, until the CPU is set in the CPU standby mode, the CAN sleep mode may be cancelled by wakeup from CAN bus.	p. 667	
			Setting CPU Standby (from CAN Stop Mode)	The CAN stop mode can only be released by writing 01B to the PSMODE[1:0] bit of the COCTRL register and not by a change in the CAN bus state.	p. 668	



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Chapter	Classification	Function	Details of Function	Cautions	Pa	je				
apter 16	Soft	Stepper motor controller/dr	MCNTC0: Timer mode control register	Bit 6 must be 0.	p. 674					
Che		iver	SMPC: Stepper motor port mode control register	Set port registers (Pn) and port mode registers (PMn) whose pins are not in the PWM mode to 00H in the PWM full bridge mode.	p. 679					
er 17	Soft	LCD controller/dr	LCDMD: LCD mode register	Bits 0 to 3, 6 and 7 must be set to 0.	p. 692					
apt		iver	LCDM: LCD	Bits 1, 3 to 5 must be set to 0.	p. 693					
Ch			display mode register When displaying in a mode with a large number of COMs, such as 4 of may not be able to obtain sufficient contrast under the low-voltage co- depending on the panel characteristics. Use the LCD controller/drive having performed thorough LCD display evaluation and confirmed that no problems regarding the display quality.	When displaying in a mode with a large number of COMs, such as 4 COM, VLco may not be able to obtain sufficient contrast under the low-voltage conditions, depending on the panel characteristics. Use the LCD controller/driver after having performed thorough LCD display evaluation and confirmed that there are no problems regarding the display quality.	pp. 69 697	3, 🗌				
								LCDC0: LCD clock control register	Bits 3 and 7 must be set to 0.	p. 694
			LCD display data memory	No memory is allocated to the higher 4 bits. Be sure to set there bits to 0.	pp. 69 699	8, 🗌				
18	oft	Sound	SG0CTL: SG0	Bit 0 must be set to 0.	p. 718					
Chapter 1	ŭ	generator	generator control register	Change the contents of this register only when the sound is stopped (register SG0PWM cleared).	p. 718					
19	oft	Interrupt function	1F0L, 1F0L,	Be sure to set bits 5 to 7 of IF1H to 0.	p. 732					
Chapter	S		function 1F1L, 1F1H: Interrupt request flag registers When operating a timer, serial ir operate it once after clearing the may be set by noise. When manipulating a flag of the memory manipulation instruction bit manipulation instruction such because the compiled assemble instruction (CLR1). If a program is described in C la instruction such as "IF0L &= 0xft three instructions. mov a, IF0L and a, #0FEH mov IF0L, a In this case, even if the request flag register (IF0L) is set to 1 at a", the flag is cleared to 0 at "mov	When operating a timer, serial interface, or A/D converter after standby release, operate it once after clearing the interrupt request flag. An interrupt request flag may be set by noise.	p. 732					
				When manipulating a flag of the interrupt request flag register, use a 1-bit memory manipulation instruction (CLR1). When describing in C language, use a bit manipulation instruction such as "IF0L.0 = 0;" or "_asm("clr1 IF0L, 0");" because the compiled assembler must be a 1-bit memory manipulation instruction (CLR1). If a program is described in C language using an 8-bit memory manipulation instruction such as "IF0L &= 0xfe;" and compiled, it becomes the assembler of three instructions. mov a, IF0L and a, #0FEH mov IF0L, a In this case, even if the request flag of another bit of the same interrupt request flag register (IF0L) is set to 1 at the timing between "mov a, IF0L" and "mov IF0L, a", the flag is cleared to 0 at "mov IF0L, a". Therefore, care must be exercised when using an 8-bit memory manipulation instruction in C language.	p. 733					
			MK0L, MK0H, MK1L, MK1H: Interrupt mask flag registers	Be sure to set bits 5 to 7 of MK1H to 1.	p. 734					
			PROL, PROH, PR1L, PR1H: Priority specification flag registers	Be sure to set bits 5 to 7 of PR1H to 1.	p. 735					

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Chantor	Classification	Function	Details of Function	Cautions		Pag	e	
ç	oft	Interrupt	EGP, EGN:	Be sure to set bit 5 of EGP and bit 5 of EGN to 0.	p.	736		
Chapter	S	function	Inction External Se interrupt rising de edge, falling edge enable registers	Select the port mode by clearing EGPn and EGNn to 0 because an edge may be detected when the external interrupt function is switched to the port function.	p.	736		
			Software interrupt request	Do not use the RETI instruction for restoring from the software interrupt.	p.	740		
				BRK instruction	The BRK instruction is not one of the above-listed interrupt request hold instructions. However, the software interrupt activated by executing the BRK instruction causes the IE flag to be cleared. Therefore, even if a maskable interrupt request is generated during execution of the BRK instruction, the interrupt request is not acknowledged.	p.	744	
hantor 20	Soft	5 Standby function	Standby function	The STOP mode can be used only when the CPU is operating on the main system clock. The subsystem clock oscillation cannot be stopped. The HALT mode can be used when the CPU is operating on either the main system clock or the subsystem clock.	p.	745		
Γ				When shifting to the STOP mode, be sure to stop the peripheral hardware operation operating with main system clock before executing STOP instruction.	p.	745		
				The following sequence is recommended for operating current reduction of the A/D converter when the standby function is used: First clear bit 7 (ADCS) and bit 0 (ADCE) of the A/D converter mode register (ADM) to 0 to stop the A/D conversion operation, and then execute the STOP instruction.	p.	745		
			OSTC:       After the above time has elapsed, the bits are set to 1 in order from I remain 1.         Stabilization time counter status register       The oscillation stabilization time counter counts up to the oscillation internal high-speed oscillation clock is being used as the CPU clock, oscillation stabilization time as follows.         • Desired OSTC oscillation stabilization time ≤ Oscillation stabilization time set to OSTC sis set to OSTC after STOP mode is released.         The X1 clock oscillation stabilization wait time does not include the ticlock oscillation starts ("a" below).         OSTS:       To set the STOP mode when the X1 clock is used as the CPU clock before executing the STOP instruction.         Do not change the value of the OSTS register during the X1 clock os stabilization time.	After the above time has elapsed, the bits are set to 1 in order from MOST11 and remain 1.	p.	746		
				<ul> <li>The oscillation stabilization time counter counts up to the oscillation stabilization time set by OSTS. If the STOP mode is entered and then released while the internal high-speed oscillation clock is being used as the CPU clock, set the oscillation stabilization time as follows.</li> <li>Desired OSTC oscillation stabilization time ≤ Oscillation stabilization time set by OSTS</li> <li>Note, therefore, that only the status up to the oscillation stabilization time set by OSTS is set to OSTC after STOP mode is released.</li> </ul>	p.	746		
	Hard			The X1 clock oscillation stabilization wait time does not include the time until clock oscillation starts ("a" below).	p.	746		
	Soft			To set the STOP mode when the X1 clock is used as the CPU clock, set OSTS before executing the STOP instruction.	p.	747		
				Do not change the value of the OSTS register during the X1 clock oscillation stabilization time.	p.	747		
				<ul> <li>The oscillation stabilization time counter counts up to the oscillation stabilization time set by OSTS. If the STOP mode is entered and then released while the internal high-speed oscillation clock is being used as the CPU clock, set the oscillation stabilization time as follows.</li> <li>Desired OSTC oscillation stabilization time ≤ Oscillation stabilization time set by OSTS</li> <li>Note, therefore, that only the status up to the oscillation stabilization time set by OSTS is set to OSTC after STOP mode is released.</li> </ul>	p.	747		
	Hard			The X1 clock oscillation stabilization wait time does not include the time until clock oscillation starts ("a" below).	p.	747		



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Chapter	Classification	Function	Details of Function	Cautions		Pag	je	
Chapter 20	Soft	Standby function	STOP mode	Because the interrupt request signal is used to clear the standby mode, if there is an interrupt source with the interrupt request flag set and the interrupt mask flag reset, the standby mode is immediately cleared if set. Thus, the STOP mode is reset to the HALT mode immediately after execution of the STOP instruction and the system returns to the operating mode as soon as the wait time set using the oscillation stabilization time select register (OSTS) has elapsed.	p.	754		
				To use the peripheral hardware that stops operation in the STOP mode, and the peripheral hardware for which the clock that stops oscillating in the STOP mode after the STOP mode is released, restart the peripheral hardware.	p.	756		
				Eve the the in th	Even if "internal low-speed oscillator can be stopped by software" is selected by the option byte, the internal low-speed oscillator continues in the STOP mode in the status before the STOP mode is set. To stop the internal low-speed oscillator in the STOP mode, stop it by software and then execute the STOP instruction.	р.	756	
			To sh the Cl switch Clock CPU ( (X1 or stabili (OST)	To shorten oscillation stabilization time after the STOP mode is released when the CPU operates with the high-speed system clock (X1 oscillation), temporarily switch the CPU clock to the internal high-speed oscillator internal oscillation Clock before the next execution of the STOP instruction. Before changing the CPU clock from the internal high-speed oscillator to the high-speed system clock (X1 oscillation) after the STOP mode is released, check the oscillation stabilization time with the oscillation stabilization time counter status register (OSTC).	p.	756		
				If the STOP instruction is executed when AMPH = 1, supply of the CPU clock is stopped for 4.06 to 16.12 $\mu$ s after the STOP mode is released when the internal high-speed oscillation clock is selected as the CPU clock, or for the duration of 160 external clocks when the high-speed system clock (external clock input) is selected as the CPU clock.	p.	756		
21	ard	Reset	-	For an external reset, input a low level for 10 $\mu$ s or more to the RESET pin.	p.	761		
Chapter	На	function		During reset input, the X1 clock, XT1 clock, internal high-speed oscillation clock, and internal low-speed oscillation clock stop oscillating. External main system clock input and external subsystem clock input become invalid.	p.	761		
ľ			When the STOF during reset input	When the STOP mode is released by a reset, the STOP mode contents are held during reset input. However, the port pins become high-impedance.	p.	761		
			Block diagram of reset function	An LVI circuit internal reset does not reset the LVI circuit.	p.	762		
			Watchdog timer overflow	A watchdog timer internal reset resets the watchdog timer.	p.	763		
	Soft		RESF: Reset control flag register	Do not read data by a 1-bit memory manipulation instruction.	p.	770		


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Chapter	Classification	Function	Details of Function	Cautions		Page	Ð
er 22	Soft	Multiplier/ divider	SDR0: Remainder data	The value read from SDR0 during operation processing (while bit 7 (DMUE) of multiplier/divider control register 0 (DMUC0) is 1) is not guaranteed.	p.	773	
lapt			register 0	SDR0 is reset when the operation is started (when DMUE is set to 1).	p.	773	
ч			MDA0H, MDA0L:	MDA0H is cleared to 0 when an operation is started in the multiplication mode (when multiplier/divider control register 0 (DMUC0) is set to 81H).	p.	773	
			Multiplication/ division data register A0	Do not change the value of MDA0 during operation processing (while bit 7 (DMUE) of multiplier/divider control register 0 (DMUC0) is 1). Even in this case, the operation is executed, but the result is undefined.	р.	773	
				The value read from MDA0 during operation processing (while DMUE is 1) is not guaranteed.	p.	773	
			MDB0: Multiplication/ division data	Do not change the value of MDB0 during operation processing (while bit 7 (DMUE) of multiplier/divider control register 0 (DMUC0) is 1). Even in this case, the operation is executed, but the result is undefined.	р.	774	
			register B0	Do not clear MDB0 to 0000H in the division mode. If set, undefined operation results are stored in MDA0 and SDR0.	p.	774	
			DMUC0: Multiplier/divider control register 0	If DMUE is cleared to 0 during operation processing (when DMUE is 1), the operation result is not guaranteed. If the operation is completed while the clearing instruction is being executed, the operation result is guaranteed, provided that the interrupt flag is set.	p.	775	
				Do not change the value of DMUSEL0 during operation processing (while DMUE is 1). If it is changed, undefined operation results are stored in multiplication/division data register A0 (MDA0) and remainder data register 0 (SDR0).	p.	775	
				If DMUE is cleared to 0 during operation processing (while DMUE is 1), the operation processing is stopped. To execute the operation again, set multiplication/division data register A0 (MDA0), multiplication/division data register B0 (MDB0), and multiplier/divider control register 0 (DMUC0), and start the operation (by setting DMUE to 1).	p.	775	
ter 23	Soft	Power-on- clear circuit	_	If an internal reset signal is generated in the POC circuit, the reset control flag register (RESF) is cleared to 00H.	p.	780	
Chapt				Set the low-voltage detector by software after the reset status is released (see CHAPTER 24 LOW-VOLTAGE DETECTOR).	рр 78	). 782, 3	, 🗆
			In 2.7 V/1.59 V POC mode	A voltage oscillation stabilization time of 1.93 to 5.39 ms is required after the supply voltage reaches 1.59 V (TYP.). If the supply voltage rises from 1.59 V (TYP.) to 2.7 V (TYP.) within 1.93 ms, the power supply oscillation stabilization time of 0 to 5.39 ms is automatically generated before reset processing.	p.	783	
			Cautions for power-on-clear circuit	In a system where the supply voltage ( $V_{DD}$ ) fluctuates for a certain period in the vicinity of the POC detection voltage ( $V_{POC}$ ), the system may be repeatedly reset and released from the reset status. In this case, the time from release of reset to the start of the operation of the microcontroller can be arbitrarily set by taking the following action.	p.	784	



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Chapter	Classification	Function	Details of Function	Cautions		Pag	e
apter 24	Soft	Low- voltage detector	LVIM: Low- voltage detection register	<ul> <li>To stop LVI, follow either of the procedures below.</li> <li>When using 8-bit memory manipulation instruction: Write 00H to LVIM.</li> <li>When using 1-bit memory manipulation instruction: Clear LVION to 0.</li> </ul>	p.	789	
ch	Hard			Input voltage from external input pin (EXLVI) must be EXLVI < VDD.	p.	789	
	Soft			After an LVI reset has been generated, do not write values to LVIS and LVIM when LVION = 1.	p.	789	
				When using LVI as an interrupt, if LVION is cleared (0) in a state below the LVI detection voltage, an INTLVI signal is generated and LVIIF becomes 1.	p.	789	
			LVIS: Low-	Be sure to clear bits 4 to 7 to 0.	p.	789	
			voltage detection	Do not change the value of LVIS during LVI operation.	p.	789	
			register	When an input voltage from the external input pin (EXLVI) is detected, the detection voltage ( $V_{EXLVI} = 1.21 \text{ V}$ (TYP.)) is fixed. Therefore, setting of LVIS is not necessary.	p.	789	
				After an LVI reset has been generated, do not write values to LVIS and LVIM when LVION = 1.	p.	789	
			When used as reset (When	<1> must always be executed. When LVIMK = 0, an interrupt may occur immediately after the processing in <4>.	p.	791	
			detecting level of supply voltage (VDD))	If supply voltage (V_DD) $\geq$ detection voltage (V_LVI) when LVIMD is set to 1, an internal reset signal is not generated.	p.	791	
			When used as reset (When	<1> must always be executed. When LVIMK = 0, an interrupt may occur immediately after the processing in <3>.	p.	794	
			detecting level of input voltage	If input voltage from external input pin (EXLVI) $\geq$ detection voltage (V <sub>EXLVI</sub> = 1.21 V (TYP.)) when LVIMD is set to 1, an internal reset signal is not generated.	p.	794	
	Hard		input pin (EXLVI))	Input voltage from external input pin (EXLVI) must be EXLVI < VDD.	p.	794	
			When used as interrupt (When detecting level of input voltage from external input pin (EXLVI))	Input voltage from external input pin (EXLVI) must be EXLVI < VDD.	p.	799	
	Soft		Cautions for low- voltage detector	<ul> <li>In a system where the supply voltage (V<sub>DD</sub>) fluctuates for a certain period in the vicinity of the LVI detection voltage (V<sub>LVI</sub>), the operation is as follows depending on how the low-voltage detector is used.</li> <li>(1) When used as reset The system may be repeatedly reset and released from the reset status. In this case, the time from release of reset to the start of the operation of the microcontroller can be arbitrarily set by taking action (1) below. </li> <li>(2) When used as interrupt Interrupt requests may be frequently generated. Take (b) of action (2) below. </li> </ul>	p.	801	



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Chapter	Classification	Function	Details of Function	Cautions		Page	~
er 25	Soft	Option byte	0082H, 0083H/ 1082H, 1083H	Be sure to set 00H to 0082H and 0083H (0082H/1082H and 0083H/1083H when the boot swap function is used).	p. 8	04	
Chapt			0080H/1080H	Set a value that is the same as that of 0080H to 1080H because 0080H and 1080H are switched during the boot swap operation.	p. 8	04	
			0081H/1081H	LVISTART can only be written by using a dedicated flash memory programmer. It cannot be set during self-programming or boot swap operation during self- programming (at this time, LVI operation stop mode (default) is set). However, because the value of 1081H is copied to 0081H during the boot swap operation, it is recommended to set a value that is the same as that of 0081H to 1081H when the boot swap function is used.	p. 8	04	
			0084H/1084H	To use the on-chip debug function, set 02H or 03H to 0084H. Set a value that is the same as that of 0084H to 1084H because 0084H and 1084H are switched during the boot operation.	p. 8	05	
			0080H/1080H	The combination of WDCS2 = WDCS1 = WDCS0 = 0 and WINDOW1 = WINDOW0 = 0 is prohibited.	p. 8	05	
				The watchdog timer continues its operation during self-programming and p. EEPROM emulation of the flash memory. During processing, the interrupt acknowledge time is delayed. Set the overflow time and window size taking this delay into consideration.		05	
				If LSROSC = 0 (oscillation can be stopped by software), the count clock is not supplied to the watchdog timer in the HALT and STOP modes, regardless of the setting of bit 0 (LSRSTOP) of the internal oscillation mode register (RCM).	p. 8	05	
				Be sure to clear bit 7 to 0.	p. 8	05	
			0081H/1081H	Be sure to clear bits 7 to 1 to "0".	p. 8	07	
ter 26	Soft	Flash memory	IMS: Internal memory size	Be sure to set each product to the values shown in Table 26-1 after a reset release.	p. 8	09	
Chap			switching register,	Be sure to set each product to the values shown in Table 26-2 after a reset release.	p. 8	10	
			expansion RAM size switching register	To set the memory size, set IMS and then IXS. Set the memory size so that the internal ROM and internal expansion RAM areas do not overlap.	рр. 810	809,	
			Writing with Flash Memory Programmer	The flash memory writings with pins No.10 and No.11 (UART60), pins No. 23 and No. 24 (UART61) in 78K0/DF2 are unsupported.	p. 8	11	
			Operation clock	Only the internal high-speed oscillation clock (fosce) can be used when CSI10 is used.	p. 8	18	
				Only the X1 clock (fx) or external main system clock ( $f_{\text{EXT}}$ ) can be used when UART60 is used.	p. 8	18	
			Processing of X1, P31 pins	<ul> <li>Connect P121/X1/OCD0A as follows when writing the flash memory with a flash memory programmer.</li> <li>P121/X1/OCD0A: When using this pin as a port, connect it to Vss via a resistor (10 kΩ: recommended) (in the input mode) or leave it open (in the output mode).</li> </ul>	p. 8	18	
				The above connection is not necessary when writing the flash memory by means of self programming.			
			Selecting communication mode	When UART60 is selected, the receive clock is calculated based on the reset command sent from the dedicated flash memory programmer after the FLMD0 pulse has been received.	p. 8	21	
	Hard		Security Settings	After the security setting for the batch erase is set, erasure cannot be performed for the device. In addition, even if a write command is executed, data different from that which has already been written to the flash memory cannot be written, because the erase command is disabled.	p. 8	23	
1				If a security setting that rewrites boot cluster 0 has been applied, boot cluster 0 of that device will not be rewritten, and the device will not be erased in batch.	p. 8	23	



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Chapter	Classification	Function	Details of Function	Cautions	Ρα	je
er 26	Hard	Flash memory	E.P.V. command usage	When executing boot swapping, do not use the E.P.V. command with the dedicated flash memory programmer.	pp. 828 834	5, 🗌
Chapte			Flash memory programming by	The self-programming function cannot be used when the CPU operates with the subsystem clock.	p. 826	
			self-	Input a high level to the FLMD0 pin during self-programming.	p. 826	
	Soft		programming	Be sure to execute the DI instruction before starting self-programming. The self-programming function checks the interrupt request flags (IF0L, IF0H, IF1L, and IF1H). If an interrupt request is generated, self-programming is stopped.	p. 826	
				Self-programming is also stopped by an interrupt request that is not masked even in the DI status. To prevent this, mask the interrupt by using the interrupt mask flag registers (MK0L, MK0H, MK1L, and MK1H).	p. 826	
				Self-programming is executed with the internal high-speed oscillation clock. If the CPU operates with the X1 clock or external main system clock, the oscillation stabilization wait time of the internal high-speed oscillation clock elapses during self-programming.	p. 826	
				Allocate the entry program for self-programming in the common area of 0000H to 7FFFH.	p. 827	
Chapter 27	Hard	On-chip debug function	_	The 78K0/Dx2 has an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.	p. 837	
			When	Input the clock from the X1 pin during on-chip debugging.	p. 839	
			OCD0A/X1 and OCD0B/X2 are used	Control the X1 and X2 pins by externally pulling down the P31 pin.	p. 839	
				<ul> <li>When setting to on-chip debugging mode via the normal port, without using pins X1 and X2, two of the user ports will be unavailable for use.</li> <li>In order to realize on-chip debug function, use the following user resource.</li> <li>(a) Flash memory area</li> <li>Addresses 0x02 and 0x03</li> <li>Addresses 0x7E and 0x7F (when using a software break)</li> <li>Addresses 0x84</li> <li>Addresses 0x85 to 0x8E</li> <li>Addresses 0x8F to 0x18F: Standard value of program <ul> <li>(+256 bytes when using pseudo real-time RAM monitor function)</li> <li>(when using a device with 10 or more SFRs the can be accessed in 16-bit units: +n (the number of exceeding registers x 6 bytes))</li> <li>(b) Internal extended RAM area</li> <li>Addresses 0xF7F0 to 0xF7FF <ul> <li>(when using pseudo real-time RAM monitor function)</li> <li>(c) Internal high-speed RAM area</li> </ul> </li> <li>7 bytes as stack area: Standard value of stack <ul> <li>(+2 bytes when using software breaks)</li> <li>(+2 bytes when using pseudo real-time RAM monitor function)</li> </ul> </li> </ul></li></ul>	p. 842	



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Chapter	Classification	Function	Details of Function	Cautions	Page	
Chapters 29, 30	Hard	Electrical specificatio ns	_	The 78K0/Dx2 has an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.	pp. 856, 884	
			Absolute maximum ratings	Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.	pp. 856, 857, 884, 885	
			X1 oscillator characteristics	<ul> <li>When using the X1 oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.</li> <li>Keep the wiring length as short as possible.</li> <li>Do not cross the wiring with the other signal lines.</li> <li>Do not route the wiring near a signal line through which a high fluctuating current flows.</li> <li>Always make the ground point of the oscillator capacitor the same potential as Vss.</li> <li>Do not ground the capacitor to a ground pattern through which a high current flows.</li> <li>Do not fetch signals from the oscillator.</li> </ul>	pp. 858, 886	
				Since the CPU is started by the 8 MHz internal oscillation clock after a reset release, check the X1 clock oscillation stabilization time using the oscillation stabilization time counter status register (OSTC). Determine the oscillation stabilization time of the OSTC register and oscillation stabilization time select register (OSTS) after sufficiently evaluating the oscillation stabilization time with the resonator to be used.	pp. 858, 887	
			XT1 oscillator characteristics	<ul> <li>When using the XT1 oscillator, wire as follows in the area enclosed by the broken lines in the above figure to avoid an adverse effect from wiring capacitance</li> <li>Keep the wiring length as short as possible.</li> <li>Do not cross the wiring with the other signal lines.</li> <li>Do not route the wiring near a signal line through which a high fluctuating current flows.</li> <li>Always make the ground point of the oscillator capacitor the same potential as Vss.</li> <li>Do not ground the capacitor to a ground pattern through which a high current flows.</li> <li>Do not fetch signals from the oscillator.</li> </ul>	pp. 859, 887	
				The subsystem clock oscillator is designed as a low-amplitude circuit for reducing power consumption, and is more prone to malfunction due to noise than the high- speed system clock oscillator. Particular care is therefore required with the wiring method when the subsystem clock clock is used.	pp. 859, 887	
			DC Characteristics	The pins mounted depend on the product.	pp. 860 to 864, 888 to 892	
Chapter 32	Hard	Recommen ded soldering conditions	_	Do not use different soldering methods together (except for partial heating).	p. 914	
apter 33	Soft	Wait	_	When the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped, do not access the registers listed above using an access method in which a wait request is issued.	p. 916, 917	
ų				When Value is $\Phi_{\text{CANMOD}}$ (CAN module system clock) $\geq$ 2 MHz.	p. 918	



## APPENDIX E REVISION HISTORY

### E.1 Main Revisions in this Edition

Page	Description	Classification		
CHAPTER 29	CHAPTER 29 ELECTRICAL SPECIFICATIONS ((A) GRADE PRODUCTS)			
p. 883	Deletion of 29.6 (2) Serial write operation characteristics and (3) Self write operation characteristics.	(c)		
CHAPTER 30	CHAPTER 30 ELECTRICAL SPECIFICATIONS ((A2) GRADE PRODUCTS)			
p. 911	Deletion of <b>30.6 (2) Serial write operation characteristics</b> and <b>(3) Self write operation</b> characteristics.	(c)		
CHAPTER 32	RECOMMENDED SOLDERING CONDITIONS			
p. 914	Addition of Infrared reflow in Table 32-1. Surface Mounting Type Soldering Conditions.	(c)		

Remark "Classification" in the above table classifies revisions as follows.

(a): Error correction, (b): Addition/change of specifications, (c): Addition/change of description or note,(d): Addition/change of package, part number, or management division, (e): Addition/change of related documents



#### E.2 Revision History up to Previous Editions

		(1/4)
Page	Description	Classification
Throughout	Deletion of PG-FP4, FL-PR4.	(b)
	Deletion of MINICUBE (QB-78K0MINI).	
	Deletion of SM+ for 78K0/Dx2.	
CHAPTER 1	OUTLINE	
pp. 22 to 24	Change of <b>1.4 Pin Configuration (Top View)</b> . (I/O direction of pin no. 30, $O \rightarrow I/O$ )	(c)
pp. 30, 32, 34, 36	Change of "Timer outputs" in <b>1.6 Outline of Functions</b> .	(c)
p. 38	Change of "• Outline of timers" in <b>1.6 Outline of Functions</b> .	(c)
CHAPTER 2	PIN FUNCTIONS	
p. 54	Deletion of Caution 2 in 2.2.4 (2) (a) SEG4 to SEG11.	(c)
pp. 60, 62, 64, 66	Deletion of Note 3 in Table 2-6. Pin I/O Circuit Types.	(c)
CHAPTER 3	CPU ARCHITECTURE	
p. 93	Addition of Note in Table 3-7. Special Function Register List.	(c)
p. 98	Addition of 3.2.4 Extended Function Registers (EFRs).	(c)
CHAPTER 4	PORT FUNCTIONS	
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